查询PIC18F86K90供应商

2010 Microchip Technology Inc.

dzsc.com

# MICROCHIP

# PIC18F87K90 Family Data Sheet

64/80-Pin, High-Performance Microcontrollers with LCD Driver and nanoWatt XLP Technology



### 查询PIC18F86K90供应商

#### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION. QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

# QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV ISO/TS 16949:2002

#### Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC<sup>32</sup> logo, rfPIC and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Octopus, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

 $\ensuremath{\mathsf{SQTP}}$  is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2010, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.



#### ISBN: 978-1-60932-224-3

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



# 64/80-Pin, High-Performance Microcontrollers with LCD Driver and nanoWatt XLP Technology

### Low-Power Features:

- Power-Managed modes:
  - Run: CPU on, peripherals on
  - Idle: CPU off, peripherals on
  - Sleep: CPU off, peripherals off
- Two-Speed Oscillator Start-up
- Fail-Safe Clock Monitor
- Power-Saving Peripheral Module Disable (PMD)
- Ultra Low-Power Wake-up
- Fast Wake-up, 2 μs Typical
- · Low-Power WDT, 300 nA Typical
- Ultra Low 50 nA Input Leakage
- Run mode Currents Down to very low 5.5 μA, Typical
- Idle mode Currents Down to very low 2.2 μA, Typical
- Sleep mode Current Down to very low 20 nA, Typical
- RTCC Current Down to very low 700 nA, Typical
- LCD Current Down to very low 300 nA, Typical

### LCD Driver and Keypad Features:

- Direct LCD Panel Drive Capability:
  - Can drive LCD panel while in Sleep mode
- Up to 48 Segments and 192 Pixels, Software-Selectable
- Programmable LCD Timing module:
  - Multiple LCD timing sources available
  - Up to four commons: static, 1/2, 1/3 or 1/4 multiplex
  - Bias configuration: Static, 1/2 or 1/3
- Low-Power Resistor Bias Network for LCD

### **Peripheral Highlights:**

- Ten or eight CCP/ECCP modules:
  - Seven Capture/Compare/PWM (CCP) modules
  - Three Enhanced Capture/Compare/PWM (ECCP) modules
- Eleven 8/16-Bit Timer/Counter modules:
  - Timer0 8/16-bit timer/counter with 8-bit programmable prescaler
  - Timer1,3,5,7 16-bit timer/counter
  - Timer2,4,6,8,10,12 8-bit timer/counter
- Three Analog Comparators
- Configurable Reference Clock Output
- Hardware Real-Time Clock and Calendar (RTCC) module with Clock, Calendar and Alarm Functions
   Time-out from 0.5s to 1 year
- Charge Time Measurement Unit (CTMU):
  - Capacitance measurement for mTouch™ Sensing
  - Time measurement with 1 ns typical resolution
- High-Current Sink/Source 25 mA/25 mA (PORTB and PORTC)
- Up to Four External Interrupts
- Two Master Synchronous Serial Port (MSSP) modules:
  - 3/4-wire SPI (supports all four SPI modes)
  - I<sup>2</sup>C<sup>™</sup> Master and Slave mode

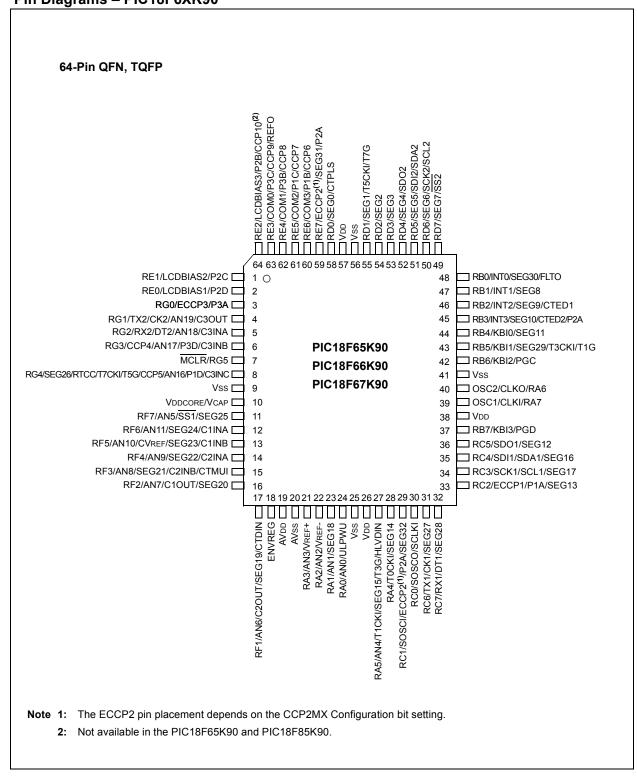
Device	Flash Program Memory (Bytes)	SRAM Data Memory (Bytes)	EEPROM (Bytes)	I/O	LCD Pixels	Timers 8/16-Bit	CCP/ ECCP	SPI	l²C™	EUSART	12-Bit A/D (Channels)	Comparators	стми	RTCC
PIC18F65K90	32K	2K	1K	53	132	4/4	5/3	Yes	Yes	2	16	3	Y	Y
PIC18F66K90	64K	4K	1K	53	132	6/5	7/3	Yes	Yes	2	16	3	Y	Y
PIC18F67K90	128K	4K	1K	53	132	6/5	7/3	Yes	Yes	2	16	3	Υ	Y
PIC18F85K90	32K	2K	1K	69	192	4/4	5/3	Yes	Yes	2	24	3	Υ	Y
PIC18F86K90	64K	4K	1K	69	192	6/5	7/3	Yes	Yes	2	24	3	Y	Y
PIC18F87K90	128K	4K	1K	69	192	6/5	7/3	Yes	Yes	2	24	3	Y	Y

# 查询PIC18F86K90供应商

- Special Microcontroller Features:
- Operating Voltage Range: 1.8V to 5.5V
- On-Chip 3.3V Regulator
- Operating Speed up to 64 MHz
- Up to 128 Kbytes On-Chip Flash Program Memory
- Data EEPROM of 1,024 Bytes
- 4K x 8 General Purpose Registers (SRAM)
- 10,000 Erase/Write Cycle Flash Program Memory, Typical
- 1,000,000 Erase/write Cycle Data EEPROM Memory, Typical
- Flash Retention 40 Years, Minimum
- Three Internal Oscillators: LF-INTRC (31 kHz), MF-INTOSC (500 kHz) and HF-INTOSC (16 MHz)
- Self-Programmable under Software Control

- Priority Levels for Interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
- Programmable period from 4 ms to 4,194s (about 70 minutes)
- In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>) via Two Pins
- In-Circuit Debug via Two Pins
- Programmable:
  - BOR
  - LVD
- Two Enhanced Addressable USART modules:
  - LIN/J2602 support
  - Auto-Baud Detect (ABD)
- 12-Bit A/D Converter with up to 24 Channels:
  - Auto-acquisition and Sleep operation
  - Differential Input mode of operation

#### 查询PIC18F86K90供应商 Pin Diagrams – PIC18F6XK90



© 2010 Microchip Technology Inc.

### 查询PIC18F86K90供应商 **Pin Diagrams – PIC18F8XK90**

#### 80-Pin TQFP RE3/COM0/P3C/CCP9<sup>(3)</sup>/REFO RE2/LCDBIAS3/P2B/CCP10<sup>(2)</sup> DRE7/ECCP2<sup>(1)</sup>/P2A/SEG3<sup>·</sup> DRD0/SEG0/CTPLS DVDD BRE6/COM2/P1C/CCP7<sup>(3)</sup> BRE6/COM3/P1B/CCP6<sup>(3)</sup> RE4/COM1/P3B/CCP8<sup>(3)</sup> DRD6/SEG6/SCK2/SCL2 DRD1/SEG1/T5CKI/T7G DRD2/SEG2 DRD5/SEG5/SDI2/SDA2 RH0/SEG47/AN23 RH1/SEG46/AN22 RD4/SEG4/SDO2 **JRD7/SEG7/SS2** JRJ0 JRJ1/SEG33 RD2/SEG2 RD3/SEG3 **J**VSS 80 79 78 77 76 75 74 73 72 71 70 69 68 67 66 65 64 63 62 61 60 RJ2/SEG34 RH2/SEG45/AN21 RH3/SEG44/AN20 59 RJ3/SEG35 2 RE1/LCDBIAS2/P2C 3 58 RB0/INT0/SEG30/FLT0 4 57 RB1/INT1/SEG8 RE0/LCDBIAS1/P2D RG0/ECCP3/P3A 5 56 RB2/INT2/SEG9/CTED1 RG1/TX2/CK2/AN19/C3OUT 6 55 RB3/INT3/SEG10/CTED2/P2A 54 RB4/KBI0/SEG11 RG2/RX2/DT2/AN18/C3INA 7 RG3/CCP4/AN17/P3D/C3INB 8 53 RB5/KBI1/SEG29/T3CKI/T1G PIC18F85K90 52 RB6/KBI2/PGC MCLR/RG5 9 RG4/SEG26/RTCC/T7CKI/T5G/CCP5/AN16/P1D/C3INC 0 10 51 Vss PIC18F86K90 50 OSC2/CLKO/RA6 Vss 🛙 11 PIC18F87K90 49 OSC1/CLKI/RA7 VDDCORE/VCAP 12 48 VDD RF7/AN5/SS1/SEG25 [ 13 47 RB7/KBI3/PGD RF6/AN11/SEG24/C1INA 14 46 RC5/SDO1/SEG12 RF5/AN10/CVREF/SEG23/C1INB 15 45 TRC4/SDI1/SDA1/SEG16 RF4/AN9/SEG22/C2INA RF3/AN8/SEG21/C2INB/CTMUI 44 RC3/SCK1/SCL1/SEG17 17 RF2/AN7/C10UT/SEG20 [ 18 RH7/SEG43/CCP6<sup>(3)</sup>/P1B/AN15 [ 19 43 RC2/ECCP1/P1A/SEG13 42 RJ7/SEG36 RH6/SEG42/CCP7<sup>(3)</sup>/P1C/AN14/C1INC 20 41 RJ6/SEG37 RF1/AN6/C2OUT/SEG19/CTDIN [] 25 RVDD [] 25 RVDD [] 25 RA3/AN3/YREF-1 [] 25 RA3/AN3/YREF-1 [] 25 RA2/AN3/YREF-1 [] 25 RA3/AN3/YREF-1 [] 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 RC7/RX1/DT1/SEG2805 RJ4/SEG3905 RJ5/SEG3805 RH5/SEG41/CCP8<sup>(3)</sup>/P3B/AN13/C2IND PH4/SFG40/CCP9<sup>(3)</sup>/P3C/AN12/C2INC D RC6/TX1/CK1/SEG27 RC1/SOSCI/ECCP2<sup>(1)</sup>I/SEG32/P2A RC0/SOSCO/SCKL Note 1: The ECCP2 pin placement depends on the CCP2MX Configuration bit setting. 2: Not available in the PIC18F65K90 and PIC18F85K90. The CCP6, CCP7, CCP8 and CCP9 pin placement depends on the ECCPMX Configuration bit setting 3:

#### 查询PIC18F86K90供应商 Table of Contents

IUN		
1.0	Device Overview	9
2.0	Guidelines for Getting Started with PIC18FXXKXX Microcontrollers	
3.0	Oscillator Configurations	39
4.0	Power-Managed Modes	51
5.0	Reset	67
6.0	Memory Organization	83
7.0	Flash Program Memory	109
8.0	Data EEPROM Memory	119
9.0	8 x 8 Hardware Multiplier	
10.0	Interrupts	127
11.0		
12.0		
13.0		
14.0		
15.0	Timer3/5/7 Modules	
16.0		
17.0		
18.0		
19.0		
20.0		
21.0		
22.0		
23.0		
25.0	· · · · · · · · · · · · · · · · · · ·	
26.0	5 5 ( )	
	Charge Time Measurement Unit (CTMU)	
	Special Features of the CPU	
	······································	
30.0	e e de la contra c	
31.0		
	Packaging Information	
	endix A: Revision History	
	endix B: Migration From PIC18F85J90 and PIC18F87J90 to PIC18F87K90	
	Χ	
	Microchip Web Site	
	tomer Change Notification Service	
	tomer Support	
	der Response	
Prod	luct Identification System	565

## 查询PIC18F86K90供应商

# TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com** or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

#### Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

#### Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; http://www.microchip.com
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

#### **Customer Notification System**

Register on our web site at www.microchip.com to receive the most current information on all of our products.

#### 查询PIC18F86K90供应商 **1.0 DEVICE OVERVIEW**

This document contains device-specific information for the following devices:

- PIC18F65K90 PIC18F85K90
- PIC18F66K90
   PIC18F86K90
- PIC18F67K90 PIC18F87K90

This family combines the traditional advantages of all PIC18 microcontrollers – namely, high computational performance and a rich feature set – with a versatile on-chip LCD driver, while maintaining an extremely competitive price point. These features make the PIC18F87K90 family a logical choice for many high-performance applications where price is a primary consideration.

### 1.1 Core Features

### 1.1.1 nanoWatt TECHNOLOGY

All of the devices in the PIC18F87K90 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- Alternate Run Modes: By clocking the controller from the Timer1 source or the internal RC oscillator, power consumption during code execution can be reduced.
- Multiple Idle Modes: The controller can also run with its CPU core disabled but the peripherals still active. In these states, power consumption can be reduced even further.
- **On-the-Fly Mode Switching:** The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- **nanoWatt XLP:** An extra low-power BOR, RTCC and low-power Watchdog Timer. Also, an ultra low-power regulator for Sleep mode is provided in regulator enabled modes.

### 1.1.2 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F87K90 family offer different oscillator options, allowing users a range of choices in developing application hardware. These include:

- External Resistor/Capacitor (RC); RA6 available
- External Resistor/Capacitor with Clock Out (RCIO)
- Three External Clock modes:
  - External Clock (EC); RA6 available
  - External Clock with Clock Out (ECIO)
  - External Crystal (XT, HS, LP)
- A Phase Lock Loop (PLL) frequency multiplier, available to the External Oscillator modes which allows clock speeds of up to 64 MHz. PLL can also be used with the internal oscillator.

- An internal oscillator block that provides a 16 MHz clock (±2% accuracy) and an INTRC source (approximately 31 kHz, stable over temperature and VDD)
  - Operates as HF-INTOSC or MF-INTOSC when block selected for 16 MHz or 500 kHz
  - Frees the two oscillator pins for use as additional general purpose I/O

The internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- Fail-Safe Clock Monitor: This option constantly monitors the main clock source against a reference signal provided by the internal oscillator. If a clock failure occurs, the controller is switched to the internal oscillator, allowing for continued low-speed operation or a safe application shutdown.
- **Two-Speed Start-up:** This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.

### 1.1.3 MEMORY OPTIONS

The PIC18F87K90 family provides ample room for application code, from 32 Kbytes to 128 Kbytes of code space. The Flash cells for program memory are rated to last up to 10,000 erase/write cycles. Data retention without refresh is conservatively estimated to be greater than 40 years.

The Flash program memory is readable and writable. During normal operation, the PIC18F87K90 family also provides plenty of room for dynamic application data with up to 3,828 bytes of data RAM.

### 1.1.4 EXTENDED INSTRUCTION SET

The PIC18F87K90 family implements the optional extension to the PIC18 instruction set, adding 8 new instructions and an Indexed Addressing mode. Enabled as a device configuration option, the extension has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as 'C'.

### 1.1.5 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals (except the 32-Kbyte parts, which have two less CCPs and three less Timers), allowing for a smooth migration path as applications grow and evolve.

The consistent pinout scheme, used throughout the entire family, also aids in migrating to the next larger device. This is true when moving between the 64-pin members, between the 80-pin members, or even jumping from 64-pin to 80-pin devices.

查询PIC18F86K90供应商 The PIC18F87K90 family is also largely pin-compatible with other PIC18 families, such as the PIC18F8720, PIC18F8722. PIC18F85J11. PIC18F8490. PIC18F85J90, PIC18F87J90 and PIC18F87J93 families of microcontrollers with LCD drivers. This allows a new dimension to the evolution of applications, allowing developers to select different price points within Microchip's PIC18 portfolio, while maintaining a similar feature set.

#### 1.2 LCD Driver

The on-chip LCD driver includes many features that ease the integration of displays in low-power applications. These include an integrated internal resistor ladder, so bias voltages can be generated internally. This enables software-controlled contrast control and eliminates the need for external bias voltage resistors.

#### 1.3 **Other Special Features**

- Communications: The PIC18F87K90 family incorporates a range of serial communication peripherals including two Enhanced USART, that support LIN/J2602, and two Master SSP modules capable of both SPI and  $I^2C^{TM}$  (Master and Slave) modes of operation.
- CCP Modules: PIC18F87K90 family devices incorporate up to seven or five Capture/ Compare/PWM (CCP) modules. Up to six different time bases can be used to perform several different operations at once.
- ECCP Modules: The PIC18F87K90 family has three Enhanced CCP (ECCP) modules to maximize flexibility in control applications:
  - Up to eight different time bases for performing several different operations at once
  - Up to four PWM outputs for each module, for a total of 12 PWMs
  - Other beneficial features, such as polarity selection, programmable dead time, auto-shutdown and restart, and Half-Bridge and Full-Bridge Output modes
- 12-Bit A/D Converter: The PIC18F87K90 family has differential ADC. It incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period, and thus, reducing code overhead.
- Charge Time Measurement Unit (CTMU): The CTMU is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation.

Together with other on-chip analog modules, the CTMU can precisely measure time, measure capacitance or relative changes in capacitance, or generate output pulses that are independent of the system clock.

- LP Watchdog Timer (WDT): This enhanced version incorporates a 22-bit prescaler, allowing an extended time-out range that is stable across operating voltage and temperature. See Section 31.0 "Electrical Characteristics" for time-out periods.
- **Real-Time Clock and Calendar Module (RTCC):** The RTCC module is intended for applications requiring that accurate time be maintained for extended periods of time with minimum to no intervention from the CPU.

The module is a 100-year clock and calendar with automatic leap year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099.

#### Details on Individual Family 1.4 Members

Devices in the PIC18F87K90 family are available in 64-pin and 80-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in these ways:

- Flash Program Memory -
  - PIC18FX5K90 (PIC18F65K90 and PIC18F85K90) - 32 Kbytes
  - PIC18FX6K90 (PIC18F66K90 and PIC18F86K90) - 64 Kbytes
  - PIC18FX7K90 (PIC18F67K90 and PIC18F87K90) - 128 Kbytes
- Data RAM
  - All devices except PIC18FX5K90 4 Kbytes
- PIC18FX5K90 2 Kbytes
- · I/O Ports
  - PIC18F6XK90 (64-pin devices) Seven bidirectional ports
  - PIC18F8XK90 (80-pin devices) Nine bidirectional ports
- · LCD Pixels:
  - PIC18F6XK90 132 pixels (33 SEGs x 4 COMs)
  - PIC18F8XK90 192 pixels (48 SEGs x 4 COMs)
- · CCP Module
  - All devices except PIC18FX5K90 have seven CCP modules, PIC18FX5K90 has only five CCP modules
- Timers
  - All devices except 18FX5K90 have six 8-bit timers and five 16-bit timers, PIC18FX5K90 has only four 8-bit timers and four 16-bit timers.
- · A/D Channels
  - All PIC18F8XK90 devices have 24 A/D channels, all PIC18F6XK90 devices have 16 A/D channels

All other features for devices in this family are identical. These are summarized in Table 1-1 and Table 1-2.

The pinouts for all devices are listed in Table 1-3 and Table 1-4.

# 查询PIC18F86K90供应商 TABLE 1-1: DEVICE FEATURES FOR THE PIC18F6XK90 (64-PIN DEVICES)

Features	PIC18F65K90	PIC18F66K90	PIC18F67K90				
Operating Frequency	DC – 64 MHz						
Program Memory (Bytes)	32K	64K	128K				
Program Memory (Instructions)	16,384	32,768	65,536				
Data Memory (Bytes)	2K	4K	4K				
Interrupt Sources	42	4	48				
I/O Ports		Ports A, B, C, D, E, F, G	) }				
LCD Driver (available pixels to drive)		132 (33 SEGs x 4 COMs)					
Timers	8	1					
Comparators	3						
СТМИ	Yes						
RTCC		Yes					
Capture/Compare/PWM (CCP) Modules	5	7	7				
Enhanced CCP (ECCP) Modules	3						
Serial Communications	Two MSSP and two Enhanced USART (EUSART)						
12-Bit Analog-to-Digital Module	16 Input Channels						
Resets (and Delays)	POR, BOR, RESET Inst	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, WDT (PWRT, OST)					
Instruction Set	75 Instructions, 83 with Extended Instruction Set Enabled						
Packages	64-Pin QFN, 64-Pin TQFP						

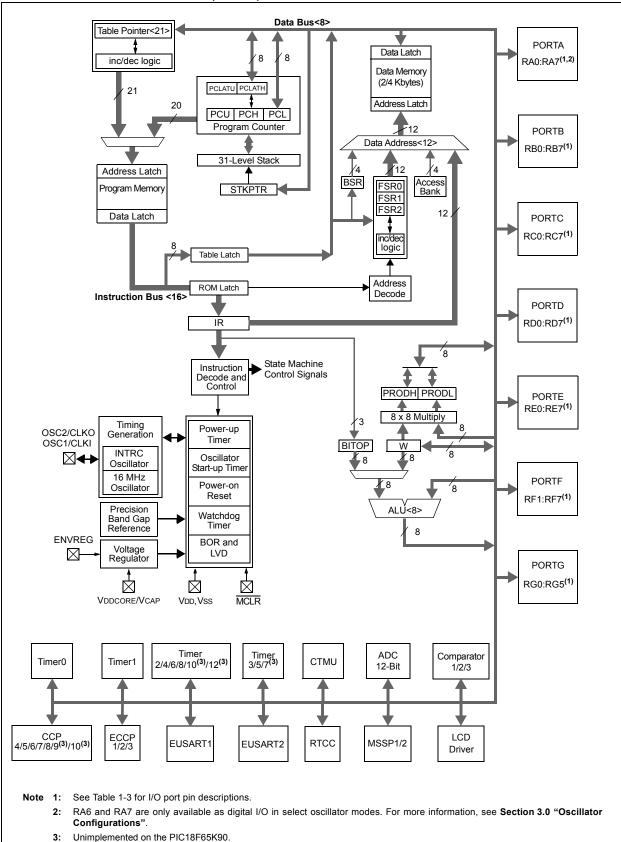
### TABLE 1-2: DEVICE FEATURES FOR THE PIC18F8XK90 (80-PIN DEVICES)

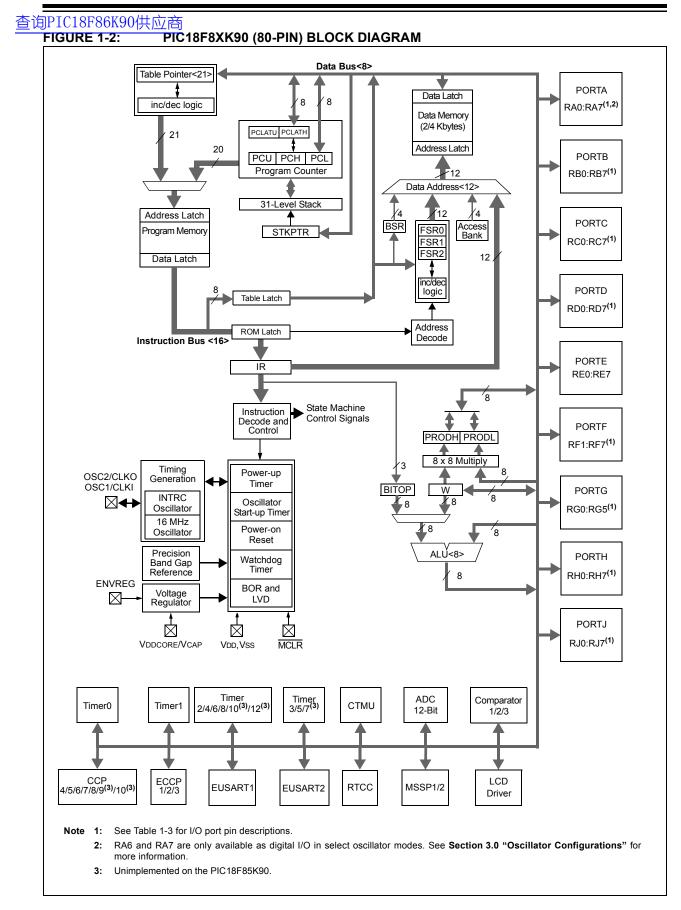
Features	PIC18F85K90	PIC18F86K90	PIC18F87K90				
Operating Frequency	DC – 64 MHz						
Program Memory (Bytes)	32K	64K	128K				
Program Memory (Instructions)	16,384	32,768	65,536				
Data Memory (Bytes)	2K	4K	4K				
Interrupt Sources	42	4	18				
I/O Ports	P	orts A, B, C, D, E, F, G, H	l, J				
LCD Driver (available pixels to drive)	192 (48 SEGs x 4 COMs)						
Timers	8	11					
Comparators	3						
СТМИ	Y						
RTCC	Y	es					
Capture/Compare/PWM (CCP) Modules	5	7	7				
Enhanced CCP (ECCP) Modules	3						
Serial Communications	Two MSSP and two Enhanced USART (EUSART)						
12-Bit Analog-to-Digital Module	24 Input Channels						
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, WD (PWRT, OST)						
Instruction Set	75 Instructions, 83 with Extended Instruction Set Enabled						
Packages	80-Pin TQFP						

© 2010 Microchip Technology Inc.

### 查询PIC18F86K90供应商

FIGURE 1-1: PIC18F6XK90 (64-PIN) BLOCK DIAGRAM





# 查询PIC18F86K90供应商

#### TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin Buffer	Buffer	Description			
Pin Name	QFN/TQFP	Туре	Туре	Description			
MCLR/RG5	7						
MCLR		I	ST	Master Clear (input) or programming voltage (input).			
				This pin is an active-low Reset to the device.			
RG5			ST	General purpose, input only pin.			
OSC1/CLKI/RA7	39			Oscillator crystal or external clock input.			
OSC1		I	CMOS	Oscillator crystal input.			
CLKI		I	CMOS	External clock source input. Always associated			
				with pin function, OSC1. (See related OSC1/CLKI,			
				OSC2/CLKO pins.)			
RA7		I/O	TTL	General purpose I/O pin.			
OSC2/CLKO/RA6	40			Oscillator crystal or clock output.			
OSC2		0	_	Oscillator crystal output. Connects to crystal or			
				resonator in Crystal Oscillator mode.			
CLKO		0	_	In certain oscillator modes, OSC2 pin outputs CLKO,			
				which has 1/4 the frequency of OSC1 and denotes the			
				instruction cycle rate.			
RA6		I/O	TTL	General purpose I/O pin.			
Legend: TTL = TTL o	compatible inpu	t		CMOS = CMOS compatible input or output			
ST = Schmitt Trigger input with CMOS levels Analog = Analog input							

= Output

= Open-Drain (no P diode to VDD)

0

OD

Ρ = Power

 $I^2C^{TM} = I^2C/SMBus$ 

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

# 查询PIC18F86K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
	QFN/TQFP	Туре	Туре	Description
				PORTA is a bidirectional I/O port.
RA0/AN0/ULPWU RA0 AN0 ULPWU	24	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 0. Ultra low-power wake-up input.
RA1/AN1/SEG18 RA1 AN1 SEG18	23	I/O I O	TTL Analog Analog	Digital I/O. Analog Input 1. SEG18 output for LCD.
RA2/AN2/VREF- RA2 AN2 VREF-	22	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	21	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 3. A/D reference voltage (high) input.
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	28	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.
RA5/AN4/SEG15/T1CKI/ T3G/HLVDIN RA5 AN4 SEG15 T1CKI T3G HLVDIN	27	I/O I 0 I I	TTL Analog Analog ST ST Analog	Digital I/O. Analog Input 4. SEG15 output for LCD. Timer1 clock input. Timer3 external clock gate input. High/Low-Voltage Detect (HLVD) input.
RA6				See the OSC2/CLKO/RA6 pin.
RA7				See the OSC1/CLKI/RA7 pin.
ST = Schm I = Input P = Powe $I^2C^{TM} = I^2C/SI$	MBus	: with C		CMOS = CMOS compatible input or output Analog = Analog input O = Output OD = Open-Drain (no P diode to VDD)

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

#### 查询PIC18F86K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	QFN/TQFP	Туре	Туре	Description		
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.		
RB0/INT0/SEG30/FLTO RB0 INT0 SEG30 FLTO	48	I/O I O I	TTL ST Analog ST	Digital I/O. External Interrupt 0. SEG30 output for LCD. Enhanced PWM Fault input for ECCP1/2/3.		
RB1/INT1/SEG8 RB1 INT1 SEG8	47	I/O I O	TTL ST Analog	Digital I/O. External Interrupt 1. SEG8 output for LCD.		
RB2/INT2/SEG9/CTED1 RB2 INT2 CTED1 SEG9	46	I/O I I O	TTL ST ST Analog	Digital I/O. External Interrupt 2. CTMU Edge 1 input. SEG9 output for LCD.		
RB3/INT3/SEG10/CTED2/ ECCP2/P2A RB3 INT3 SEG10 CTED2 ECCP2 P2A	45	I/O I 0 I/O 0	TTL ST Analog ST ST —	Digital I/O. External Interrupt 3. SEG10 output for LCD. CTMU Edge 2 input. Capture 2 input/Compare 2 output/PWM2. Enhanced PWM2 Output A.		
RB4/KBI0/SEG11 RB4 KBI0 SEG11	44	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG11 output for LCD.		
RB5/KBI1/SEG29/T3CKI/ T1G RB5 KBI1 SEG29 T3CKI T1G	43	I/O I O I	TTL TTL Analog ST ST	Digital I/O. Interrupt-on-change pin. SEG29 output for LCD. Timer3 clock input. Timer1 external clock gate input.		
RB6/KBI2/PGC RB6 KBI2 PGC	42	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin		
RB7/KBI3/PGD RB7 KBI3 PGD	37	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.		
ST = Schm I = Input P = Powe $I^2C^{TM} = I^2C/SN$	MBus	with C		CMOS = CMOS compatible input or output els Analog = Analog input O = Output OD = Open-Drain (no P diode to VDD)		

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

#### 查询PIC18F86K90供应商 PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED) TABLE 1-3

Din Nama	Pin Number	er Pin Buffer		Description		
Pin Name	QFN/TQFP	Туре	Туре	Description		
				PORTC is a bidirectional I/O port.		
RC0/SOSCO/SCLKI RC0 SOSCO SCLKI	30	I/O O I	ST — ST	Digital I/O. SOSC oscillator output. Digital SOSC input.		
RC1/SOSCI/ECCP2/P2A/ SEG32 RC1 SOSCI ECCP2 <sup>(1)</sup> P2A SEG32	29	I/O I I/O O	ST CMOS ST — Analog	Digital I/O. SOSC oscillator input. Capture 2 input/Compare 2 output/PWM2 output. Enhanced PWM2 Output A. SEG32 output for LCD.		
RC2/ECCP1/P1A/SEG13 RC2 ECCP1 P1A SEG13	33	I/O I/O O O	ST ST — Analog	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. Enhanced PWM1 Output A. SEG13 output for LCD.		
RC3/SCK1/SCL1/SEG17 RC3 SCK1 SCL1 SEG17	34	I/O I/O I/O O	ST ST I <sup>2</sup> C Analog	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I <sup>2</sup> C™ mode. SEG17 output for LCD.		
RC4/SDI1/SDA1/SEG16 RC4 SDI1 SDA1 SEG16	35	I/O I I/O O	ST ST I <sup>2</sup> C Analog	Digital I/O. SPI data in. I <sup>2</sup> C data I/O. SEG16 output for LCD.		
RC5/SDO1/SEG12 RC5 SDO1 SEG12	36	I/O O O	ST  Analog	Digital I/O. SPI data out. SEG12 output for LCD.		
RC6/TX1/CK1/SEG27 RC6 TX1 CK1 SEG27	31	I/O O I/O O	ST — ST Analog	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX1/DT1). SEG27 output for LCD.		
RC7/RX1/DT1/SEG28 RC7 RX1 DT1 SEG28	32	I/O I I/O O	ST ST ST Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX1/CK1). SEG28 output for LCD.		
Legend:TTL=TTL compatible inputCMOS=CMOS compatible input or outputST=Schmitt Trigger input with CMOS levelsAnalog=Analog inputI=InputO=OutputP=PowerOD=Open-Drain (no P diode to VDD)I2CIM=I2CIMI2CIMI2CIMI2CIM						

 $I^2C^{TM} = I^2C/SMBus$ 

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

# 查询PIC18F86K90供应商

## TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number		Description		
Pin Name	QFN/TQFP		Туре	Description	
				PORTD is a bidirectional I/O port.	
RD0/SEG0/CTPLS RD0 SEG0 CTPLS	58	I/O O O	ST Analog —	Digital I/O. SEG0 output for LCD. CTMU pulse generator output.	
RD1/SEG1/T5CKI/T7G RD1 SEG1 T5CKI T7G	55	I/O O I I	ST Analog ST ST	Digital I/O. SEG1 output for LCD. Timer5 clock input. Timer7 external clock gate input.	
RD2/SEG2 RD2 SEG2	54	I/O O	ST Analog	Digital I/O. SEG2 output for LCD.	
RD3/SEG3 RD3 SEG3	53	I/O O	ST Analog	Digital I/O. SEG3 output for LCD.	
RD4/SEG4/SDO2 RD4 SEG4 SDO2	52	I/O O O	ST Analog —	Digital I/O. SEG4 output for LCD. SPI data out.	
RD5/SEG5/SDI2/SDA2 RD5 SEG5 SDI2 SDA2	51	I/O O I I/O	ST Analog ST I <sup>2</sup> C	Digital I/O. SEG5 output for LCD. SPI data in. I <sup>2</sup> C™ data I/O.	
RD6/SEG6/SCK2/SCL2 RD6 SEG6 SCK2 SCL2	50	I/O O I/O I/O	ST Analog ST I <sup>2</sup> C	Digital I/O. SEG6 output for LCD. Synchronous serial clock. Synchronous serial clock for I <sup>2</sup> C mode.	
RD7/SEG7/SS2 RD7 SEG7 SS2	49	I/O O I	ST Analog TTL	Digital I/O. SEG7 output for LCD. SPI slave select input.	
Legend:TTL= TTL compatible inputCMOS = CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog = Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD)I= InputImputImputP= PowerImputImputI= InputImputImputP= PowerImputImputI= InputImputImputI= InputImp					

 $I^2C^{TM} = I^2C/SMBus$ 

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

#### 查询PIC18F86K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nama	Pin Number	Pin	Buffer Type	Description		
Pin Name	QFN/TQFP	Туре		Description		
				PORTE is a bidirectional I/O port.		
RE0/LCDBIAS1/P2D RE0 LCDBIAS1 P2D	2	I/O I O	ST Analog —	Digital I/O. BIAS1 input for LCD. EECP2 PWM Output D.		
RE1/LCDBIAS2/P2C RE1 LCDBIAS2 P2C	1	I/O I O	ST Analog —	Digital I/O. BIAS2 input for LCD. ECCP2 PWM Output C.		
RE2/LCDBIAS3/P2B/ CCP10 RE2 LCDBIAS3 P2B CCP10 <sup>(3)</sup>	64	I/O I O I/O	ST Analog — S/T	Digital I/O. BIAS3 input for LCD. ECCP2 PWM Output B. Capture 10 input/Compare 10 output/PWM10 output.		
RE3/COM0/P3C/CCP9/ REFO RE3 COM0 P3C CCP9 <sup>(3)</sup> REFO	63	I/O O O I/O O	ST Analog — S/T —	Digital I/O. COM0 output for LCD. ECCP3 PWM Output C. Capture 9 input/Compare 9 output/PWM9 output. Reference clock out.		
RE4/COM1/P3B/CCP8 RE4 COM1 P3B CCP8	62	I/O O O I/O	ST Analog — S/T	Digital I/O. COM1 output for LCD. ECCP3 PWM Output B. Capture 8 input/Compare 8 output/PWM8 output.		
RE5/COM2/P1C/CCP7 RE5 COM2 P1C CCP7	61	I/O O O I/O	ST Analog — S/T	Digital I/O. COM2 output for LCD. ECCP1 PWM Output C. Capture 7 input/Compare 7 output/PWM7 output.		
RE6/COM3/P1B/CCP6 RE6 COM3 P1B CCP6	60	I/O O O I/O	ST Analog — S/T	Digital I/O. COM3 output for LCD. ECCP1 PWM Output B. Capture 6 input/Compare 6 output/PWM6 output.		
RE7/ECCP2/SEG31/P2A RE7 ECCP2 <sup>(2)</sup> SEG31 P2A	59	I/O I/O O	ST ST Analog —	Digital I/O. Capture 2 input/Compare 2 output/PWM2 output. SEG31 Output for LCD. ECCP2 PWM output A.		
Legend:TTL=TTL compatible inputCMOS=CMOS compatible input or outputST=Schmitt Trigger input with CMOS levelsAnalogAnalog inputAnalogAnalog inputI=InputO=OutputP=PowerOD=Open-Drain (no P diode to VDD) $l^2 C^{TM}$ = $l^2 C/SMBus$ CMOS=Open-Drain (no P diode to VDD)						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

# 查询PIC18F86K90供应商

# TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	QFN/TQFP	Туре	Туре	Description		
				PORTF is a bidirectional I/O port.		
RF1/AN6/C2OUT/SEG19/ CTDIN	17	1/0	OT.			
RF1 AN6 C2OUT		I/O I O	ST Analog —	Digital I/O. Analog Input 6. Comparator 2 output.		
SEG19 CTDIN		0 	Analog ST	SEG19 output for LCD. CTMU pulse delay input.		
RF2/AN7/C1OUT/SEG20 RF2 AN7 C1OUT SEG20	16	I/O I O	ST Analog —	Digital I/O. Analog Input 7. Comparator 1 output.		
RF3/AN8/SEG21/C2INB/	15	0	Analog	SEG20 output for LCD.		
CTMUI RF3 AN8 SEG21 C2INB CTMUI		I/O I 0 I 0	ST Analog Analog Analog —	Digital I/O. Analog Input 8. SEG21 output for LCD. Comparator 2 Input B. CTMU pulse generator charger for the C2INB comparator input.		
RF4/AN9/SEG22/C2INA RF4 AN9 SEG22 C2INA	14	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 9. SEG22 output for LCD Comparator 2 Input A.		
RF5/AN10/CVREF/ SEG23/C1INB	13					
RF5 AN10 CVREF SEG23 C1INB		I/O I O I	ST Analog Analog Analog Analog	Digital I/O. Analog Input 10. Comparator reference voltage output. SEG23 output for LCD. Comparator 1 Input B.		
RF6/AN11/SEG24/C1INA RF6 AN11 SEG24 C1INA	12	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 11. SEG24 output for LCD Comparator 1 Input A.		
RF7/AN5/SS1/SEG25 RF7	11	I/O	ST	Digital I/O.		
<u>AN5</u> SS1 SEG25		0   0	AnalogT TL Analog	Analog Input 5. SPI1 slave select input. SEG25 output for LCD.		
Legend:TTL= TTL compatible inputCMOS= CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $I^2C^{TM}$ = I <sup>2</sup> C/SMBusOD						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

# 查询PIC18F86K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description	
Pin Name	QFN/TQFP	Туре	Туре	Description	
				PORTG is a bidirectional I/O port.	
RG0/ECCP3/P3A RG0 ECCP3 P3A	3	I/O I/O O	ST ST	Digital I/O. Capture 3 input/Compare 3 output/PWM3 output. ECCP3 PWM Output A.	
RG1/TX2/CK2/AN19/ C3OUT	4				
RG1 TX2 CK2 AN19 C3OUT		I/O O I/O I O	ST — ST Analog —	Digital I/O. USART asynchronous transmit. USART synchronous clock (see related RX2/DT2). Analog Input 19. Comparator 3 output.	
RG2/RX2/DT2/AN18/ C3INA RG2 RX2 DT2 AN18 C3INA	5	I/O I I/O I	ST ST ST Analog Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX2/CK2). Analog Input 18. Comparator 3 Input A.	
RG3/CCP4/AN17/P3D/ C3INB RG3 CCP4 AN17 P3D C3INB	6	I/O I/O I O I	ST S/T Analog — Analog	Digital I/O. Capture 4 input/Compare 4 output/PWM4 output. Analog Input 18. ECCP3 PWM Output D. Comparator 3 Input B.	
RG4/SEG26/RTCC/ T7CKI/T5G/CCP5/AN16/ P1D/C3INC RG4 SEG26 RTCC T7CKI <sup>(3)</sup> T5G CCP5 AN16 P1D C3INC	8	I/O O I I/O I O I	ST Analog — ST ST ST Analog — Analog	Digital I/O. SEG26 output for LCD. RTCC output Timer7 clock input. Timer5 external clock gate input. Capture 5 input/Compare 5 output/PWM5 output. Analog Input 16. ECCP1 PWM Output D. Comparator 3 Input C.	
RG5	7			See the MCLR/RG5 pin.	
Legend: TTL = TTL c	compatible inpu itt Trigger input		L CMOS lev	CMOS = CMOS compatible input or output	

= Power Ρ  $I^2C^{TM} = I^2C/SMBus$ 

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

OD

= Open-Drain (no P diode to VDD)

# 查询PIC18F86K90供应商

### TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Pin Buffer	Description	
	QFN/TQFP Type Ty	Туре	Description		
Vss	9, 25, 41, 56	Р		Ground reference for logic and I/O pins.	
Vdd	26, 38, 57	Р	_	Positive supply for logic and I/O pins.	
AVss	20	Р	-	Ground reference for analog modules.	
AVdd	19	Р	-	Positive supply for analog modules.	
ENVREG	18	Ι	ST	Enable for on-chip voltage regulator.	
VDDCORE/VCAP VDDCORE VCAP	10	Р	_	Core logic power or external filter capacitor connection. External filter capacitor connection (regulator enabled/disabled).	
Legend:       TTL       = TTL compatible input       CMOS       = CMOS compatible input or output         ST       = Schmitt Trigger input with CMOS levels       Analog       = Analog input         I       = Input       O       = Output					

= Power

Ρ  $I^2C^{TM} = I^2C/SMBus$ 

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

#### TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin	Buffer	Description
Fill Name	TQFP	Туре Туре		Description
MCLR/RG5	9			
		I	ST	Master Clear (input) or programming voltage (input).
				This pin is an active-low Reset to the device.
RG5		I	ST	General purpose, input only pin.
OSC1/CLKI/RA7	49			Oscillator crystal or external clock input.
OSC1		I	CMOS	Oscillator crystal input.
CLKI		I.	CMOS	External clock source input. Always associated
				with pin function, OSC1. (See related OSC1/CLKI,
				OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6	50			Oscillator crystal or clock output.
OSC2		0	—	Oscillator crystal output. Connects to crystal or
				resonator in Crystal Oscillator mode.
CLKO		0	—	In certain oscillator modes, OSC2 pin outputs CLKO,
				which has 1/4 the frequency of OSC1 and denotes the
				instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
Legend: TTL = TTL co	mpatible input			CMOS = CMOS compatible input or output
ST = Schmi	tt Trigger input	with C	MOS leve	els Analog = Analog input
I = Input				O = Output
P = Power				OD = Open-Drain (no P diode to VDD)
I <sup>2</sup> C™ = I <sup>2</sup> C/SN	1Bus			

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

#### 查询PIC18F86K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Bu	Buffer	Decerintian	
	TQFP	Туре	Туре	Description	
				PORTA is a bidirectional I/O port.	
RA0/AN0/ULPWU RA0 AN0 ULPWU	30	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 0. Ultra low-power wake-up input.	
RA1/AN1/SEG18 RA1 AN1 SEG18	29	I/O I O	TTL Analog Analog	Digital I/O. Analog Input 1. SEG18 output for LCD.	
RA2/AN2/VREF- RA2 AN2 VREF-	28	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 2. A/D reference voltage (low) input.	
RA3/AN3/VREF+ RA3 AN3 VREF+	27	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 3. A/D reference voltage (high) input.	
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	34	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.	
RA5/AN4/SEG15/T1CKI/ T3G/HLVDIN RA5 AN4 SEG15 T1CKI T3G HLVDIN	33	I/O I O I I	TTL Analog Analog ST ST Analog	Digital I/O. Analog Input 4. SEG15 output for LCD. Timer1 clock input. Timer3 external clock gate input. High/Low-Voltage Detect (HLVD) input.	
RA6				See the OSC2/CLKO/RA6 pin.	
RA7				See the OSC1/CLKI/RA7 pin.	
Legend:TTL = TTL compatible inputCMOS= CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $I^2C^{TM} = I^2C/SMBus$ Note 1:Default assignment for ECCP2 when the CCP2MX Configuration bit is set					

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

# 查询PIC18F86K90供应商

### TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.		
RB0/INT0/SEG30/FLT0 RB0 INT0 SEG30 FLT0	58	I/O I O I	TTL ST Analog ST	Digital I/O. External Interrupt 0. SEG30 output for LCD. Enhanced PWM Fault input for ECCP1/2/3.		
RB1/INT1/SEG8 RB1 INT1 SEG8	57	I/O I O	TTL ST Analog	Digital I/O. External Interrupt 1. SEG8 output for LCD.		
RB2/INT2/SEG9/CTED1 RB2 INT2 SEG9 CTED1	56	I/O I O I	TTL ST Analog ST	Digital I/O. External Interrupt 2. SEG9 output for LCD. CTMU Edge 1 input.		
RB3/INT3/SEG10/ CTED2/ECCP2/P2A RB3 INT3 SEG10 CTED2 ECCP2 P2A	55	I/O I 0 I I/O 0	TTL ST Analog ST ST ST	Digital I/O. External Interrupt 3. SEG10 output for LCD. CTMU Edge 2 input. Capture 2 input/Compare 2 output/PWM2 output. Enhanced PWM 2 Output A.		
RB4/KBI0/SEG11 RB4 KBI0 SEG11	54	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG11 output for LCD.		
RB5/KBI1/SEG29/T3CKI/ T1G RB5 KBI1 SEG29 T3CKI T1G	53	I/O I O I	TTL TTL Analog ST ST	Digital I/O. Interrupt-on-change pin. SEG29 output for LCD. Timer3 clock input. Timer1 external clock gate input.		
Legend:       TTL = TTL compatible input       CMOS = CMOS compatible input or output         ST = Schmitt Trigger input with CMOS levels       Analog = Analog input         I = Input       O = Output         P = Power       OD = Open-Drain (no P diode to VDD)						

P = Power $I^2C^{TM} = I^2C/SMBus$ 

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
RB6/KBI2/PGC	52					
RB6		I/O	TTL	Digital I/O.		
KBI2		I	TTL	Interrupt-on-change pin.		
PGC		I/O	ST	In-Circuit Debugger and ICSP™ programming clock p		
RB7/KBI3/PGD	47					
RB7		I/O	TTL	Digital I/O.		
KBI3		I	TTL	Interrupt-on-change pin.		
PGD		I/O	ST	In-Circuit Debugger and ICSP programming data pin.		
Legend: TTL = TTL c	ompatible input			CMOS = CMOS compatible input or output		
ST = Schmitt Trigger input with CMOS levels Analog = Analog input						
I = Input				O = Output		
P = Powe	r			OD = Open-Drain (no P diode to VDD)		
$I^2 C^{TM} = I^2 C/S$	MBus					

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

# 查询PIC18F86K90供应商

### TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Buffer		Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTC is a bidirectional I/O port.		
RC0/SOSCO/SCKLI RC0 SOSCO SCKLI	36	I/O O I	ST — ST	Digital I/O. SOSC oscillator output. Digital SOSC input.		
RC1/SOSCI/ECCP2/ SEG32/P2A RC1 SOSCI ECCP2 <sup>(1)</sup> SEG32 P2A	35	I/O I I/O O	ST CMOS ST Analog —	Digital I/O. SOSC oscillator input. Capture 2 input/Compare 2 output/PWM2 output. SEG32 output for LCD. Enhanced PWM 2 Output A.		
RC2/ECCP1/P1A/SEG13 RC2 ECCP1 P1A SEG13	43	I/O I/O O	ST ST — Analog	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. Enhanced PWM 1 Output A. SEG13 output for LCD.		
RC3/SCK1/SCL1/SEG17 RC3 SCK1 SCL1 SEG17	44	I/O I/O I/O O	ST ST ST Analog	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I <sup>2</sup> C™ mode. SEG17 output for LCD.		
RC4/SDI1/SDA1/SEG16 RC4 SDI1 SDA1 SEG16	45	I/O I I/O O	ST ST ST Analog	Digital I/O. SPI data in. I <sup>2</sup> C data I/O. SEG16 output for LCD.		
RC5/SDO1/SEG12 RC5 SDO1 SEG12	46	I/O O O	ST  Analog	Digital I/O. SPI data out. SEG12 output for LCD.		
RC6/TX1/CK1/SEG27 RC6 TX1 CK1 SEG27	37	I/O O I/O O	ST — ST Analog	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX1/DT1). SEG27 output for LCD.		
RC7/RX1/DT1/SEG28 RC7 RX1 DT1 SEG28	38	I/O I I/O O	ST ST ST Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX1/CK1). SEG28 output for LCD.		
Legend:TTL= TTL compatible inputCMOS= CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $l^2C^{TM} = l^2C/SMBus$ II						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

**2:** Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

#### 查询PIC18F86K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fiii Naille	TQFP	Туре	Туре			
				PORTD is a bidirectional I/O port.		
RD0/SEG0/CTPLS RD0 SEG0 CTPLS	72	I/O O O	ST Analog ST	Digital I/O. SEG0 output for LCD. CTMU pulse generator output.		
RD1/SEG1/T5CKI/T7G RD1 SEG1 T5CKI T7G	69	I/O O I I	ST Analog ST ST	Digital I/O. SEG1 output for LCD. Timer5 clock input. Timer7 external clock gate input.		
RD2/SEG2 RD2 SEG2	68	I/O O	ST Analog	Digital I/O. SEG2 output for LCD.		
RD3/SEG3 RD3 SEG3	67	I/O O	ST Analog	Digital I/O. SEG3 output for LCD.		
RD4/SEG4/SDO2 RD4 SEG4 SDO2	66	I/O O O	ST Analog —	Digital I/O. SEG4 output for LCD. SPI data out.		
RD5/SEG5/SDI2/SDA2 RD5 SEG5 SDI2 SDA2	65	I/O O I I/O	ST Analog ST I <sup>2</sup> C	Digital I/O. SEG5 output for LCD. SPI data in. I <sup>2</sup> C™ data in.		
RD6/SEG6/SCK2/SCL2 RD6 SEG6 SCK2 SCL2	64	I/O O I/O I/O	ST Analog ST I <sup>2</sup> C	Digital I/O. SEG6 output for LCD. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I <sup>2</sup> C™ mode.		
RD7/SEG7/ <del>SS2</del> RD7 <u>SEG</u> 7 SS2	63	I/O O I	ST Analog TTL	Digital I/O. SEG7 output for LCD. SPI slave select input.		
Legend:TTLTTL compatible inputSPI slave select input. $ST$ = TTL compatible inputCMOS= CMOS compatible input or output $ST$ = Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $I^2C^{TM}$ $I^2C/SMBus$ II						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

# 查询PIC18F86K90供应商

### TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Buffer		Description		
Pin Name	TQFP	Туре	Туре	Description		
				PORTE is a bidirectional I/O port.		
RE0/LCDBIAS1/P2D RE0 LCDBIAS1 P2D	4	I/O I O	ST Analog —	Digital I/O. BIAS1 input for LCD. ECCP2 PWM Output D.		
RE1/LCDBIAS2/P2C RE1 LCDBIAS2 P2C	3	I/O I O	ST Analog —	Digital I/O. BIAS2 input for LCD. ECCP2 PWM Output C.		
RE2/LCDBIAS3/P2B/ CCP10 RE2 LCDBIAS3 P2B CCP10 <sup>(3)</sup>	78	I/O I O I/O	ST Analog ST ST	Digital I/O. BIAS3 input for LCD. ECCP2 PWM Output B. Capture 10 input/Compare 10 output/PWM10 output.		
RE3/COM0/P3C/CCP9/ REFO RE3 COM0 P3C CCP9 <sup>(4)</sup> REFO	77	I/O O I/O O	ST Analog — S/T —	Digital I/O. COM0 output for LCD. ECCP3 PWM Output C. Capture 9 input/Compare 9 output/PWM9 output. Reference clock out.		
RE4/COM1/P3B/CCP8 RE4 COM1 P3B CCP8 <sup>(4)</sup>	76	I/O O O I/O	ST Analog — ST	Digital I/O. COM1 output for LCD. ECCP4 PWM Output B. Capture 8 input/Compare 8 output/PWM8 output.		
RE5/COM2/P1C/CCP7 RE5 COM2 P1C CCP7 <sup>(4)</sup>	75	I/O O O I/O	ST Analog — ST	Digital I/O. COM2 output for LCD. ECCP1 PWM Output C. Capture 7 input/Compare 7 output/PWM7 output.		
RE6/COM3/P1B/CCP6 RE6 COM3 P1B CCP6 <sup>(4)</sup>	74	I/O O O I/O	ST Analog — ST	Digital I/O. COM3 output for LCD. ECCP1 PWM Output B. Capture 6 input/Compare 6 output/PWM6 output.		
RE7/ECCP2/P2A/SEG31 RE7 ECCP2 <sup>(2)</sup> P2A SEG31	73	I/O I/O O	ST ST — Analog	Digital I/O. Capture 2 input/Compare 2 output/PWM2 output. ECCP2 PWM Output A. SEG31 output for LCD.		
SEG31OAnalogSEG31 output for LCD.Legend:TTL = TTL compatible inputCMOS= CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsAnalog= Analog inputIInputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $l^2 C^{TM} = l^2 C/SMBus$ Note 1:Default assignment for ECCP2 when the CCP2MX Configuration bit is set.						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

#### 查询PIC18F86K90供应商 PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED) TABLE 1-4

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTF is a bidirectional I/O port.		
RF1/AN6/C2OUT/SEG19/ CTDIN RF1 AN6 C2OUT SEG19 CTDIN	23	I/O I O I	ST Analog — Analog ST	Digital I/O. Analog Input 6. Comparator 2 output. SEG19 output for LCD. CTMU pulse delay input.		
RF2/AN7/C1OUT/ SEG20/CTMUI RF2 AN7 C1OUT SEG20 CTMUI	18	I/O I O O	ST Analog — Analog —	Digital I/O. Analog Input 7. Comparator 1 output. SEG20 output for LCD. CTMU pulse generator charger for the C2INB comparator input.		
RF3/AN8/SEG21/C2INB RF3 AN8 SEG21 C2INB	17	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 8. SEG21 output for LCD. Comparator 2 Input B.		
RF4/AN9/SEG22/C2INA RF4 AN9 SEG22 C2INA	16	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 9. SEG22 output for LCD. Comparator 2 Input A.		
RF5/AN10/CVREF/ SEG23/C1INB RF5 AN10 CVREF SEG23 C1INB	15	I/O I O I	ST Analog Analog Analog Analog	Digital I/O. Analog Input 10. Comparator reference voltage output. SEG23 output for LCD. Comparator 1 Input B.		
RF6/AN11/SEG24/C1INA RF6 AN11 SEG24 C1INA	14	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 11. SEG24 output for LCD. Comparator 1 Input A.		
RF7/AN5/SS1/SEG25 RF7 <u>AN5</u> SS1 SEG25	13	I/O O I O	ST Analog TTL Analog	Digital I/O. Analog Input 5. SPI slave select input. SEG25 output for LCD.		
Legend:       TTL       = TTL compatible input       CMOS       = CMOS compatible input or output         ST       = Schmitt Trigger input with CMOS levels       Analog       = Analog input         I       = Input       O       = Output         P       = Power       OD       = Open-Drain (no P diode to VDD)						

 $I^2C^{TM} = I^2C/SMBus$ 

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

# 查询PIC18F86K90供应商

### TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTG is a bidirectional I/O port.		
RG0/ECCP3/P3A RG0 ECCP3 P3A	5	I/O I/O O	ST ST	Digital I/O. Capture 3 input/Compare 3 output/PWM3 output. ECCP3 PWM Output A.		
RG1/TX2/CK2/AN19/ C3OUT RG1 TX2 CK2 AN19 C3OUT	6	I/O O I/O I O	ST — ST Analog —	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX2/DT2). Analog Input 19. Comparator 3 output.		
RG2/RX2/DT2/AN18/ C3INA RG2 RX2 DT2 AN18 C3INA	7	I/O    /O   	ST ST ST Analog Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX2/CK2). Analog Input 18. Comparator 3 Input A.		
RG3/CCP4/AN17/P3D/ C3INB RG3 CCP4 AN17 P3D C3INB	8	I/O I/O I O I	ST ST Analog — Analog	Digital I/O. Capture 4 input/Compare 4 output/PWM4 output. Analog Input 17. ECCP3 PWM Output D. Comparator 3 Input B.		
RG4/SEG26/RTCC/ T7CKI/T5G/CCP5/AN16/ P1D/C3INC RG4 SEG26 RTCC T7CKI <sup>(3)</sup> T5G CCP5 AN16 P1D C3INC	10	1/0 0 I I 1/0 I	ST Analog — ST ST ST Analog — Analog	Digital I/O. SEG26 output for LCD. RTCC output. Timer7 clock input. Timer5 external clock gate input. Capture 5 input/Compare 5 output/PWM5 output. Analog Input 16. ECCP1 PWM Output D. Comparator 3 Input C.		
RG5	9			See the MCLR/RG5 pin.		
RG59See the MCLR/RG5 pin.Legend:TTL = TTL compatible inputCMOS = CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsAnalog = Analog inputI = InputO = OutputP = PowerOD = Open-Drain (no P diode to VDD) $I^2C^{TM} = I^2C/SMBus$ OD = Open-Drain (no P diode to VDD)						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

**2:** Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

#### 查询PIC18F86K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

TABLE 1-4: PIC18F		1		RIPTIONS (CONTINUED)		
Pin Name	Pin Number	FIII		Description		
	TQFP	Туре	Туре			
				PORTH is a bidirectional I/O port.		
RH0/SEG47/AN23 RH0 SEG47 AN23	79	I/O O I	ST Analog Analog	Digital I/O. SEG47 output for LCD. Analog Input 23.		
RH1/SEG46/AN22 RH1 SEG46 AN22	80	I/O O I	ST Analog Analog	Digital I/O. SEG46 output for LCD. Analog Input 22.		
RH2/SEG45/AN21 RH2 SEG45 AN21	1	I/O O I	ST Analog Analog	Digital I/O. SEG45 output for LCD. Analog Input 21.		
RH3/SEG44/AN20 RH3 SEG44 AN20	2	I/O O I	ST Analog Analog	Digital I/O. SEG44 output for LCD. Analog Input 20.		
RH4/SEG40/CCP9/P3C/ AN12/C2INC RH4 SEG40 CCP9 <sup>(4)</sup> P3C AN12 C2INC	22	I/O O I/O O I	ST Analog ST — Analog Analog	Digital I/O. SEG40 output for LCD. Capture 9 input/Compare 9 output/PWM9 output. ECCP3 PWM Output C. Analog Input 12. Comparator 2 Input C.		
RH5/SEG41/CCP8/P3B/ AN13/C2IND RH5 SEG41 CCP8 <sup>(4)</sup> P3B AN13 C2IND	21	I/O O I/O I I	ST Analog ST — Analog Analog	Digital I/O. SEG41 output for LCD. Capture 8 input/Compare 8 output/PWM8 output. ECCP3 PWM Output B. Analog Input 13. Comparator 1 Input D.		
RH6/SEG42/CCP7/P1C/ AN14/C1INC RH6 SEG42 CCP7 <sup>(4)</sup> P1C AN14 C1INC Legend: TTL = TTL co	20	I/O O I/O O I I	ST Analog ST — Analog Analog	Digital I/O. SEG42 output for LCD. Capture 7 input/Compare 7 output/PWM7 output. ECCP1 PWM Output C. Analog Input 14. Comparator 1 Input C. CMOS = CMOS compatible input or output		
Legend:TTL= TTL compatible inputCMOS= CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $l^2C^{TM}$ = $l^2C/SMBus$ OD= Open-Drain (no P diode to VDD)						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

## 查询PIC18F86K90供应商

## TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Fill Naille	TQFP	Туре	Туре	Description
RH7/SEG43/CCP6/P1B/ AN15	19			
RH7		I/O	ST	Digital I/O.
SEG43		0	Analog	SEG43 output for LCD.
CCP6 <sup>(4)</sup>		I/O	ST	Capture 6 input/Compare 6 output/PWM6 output.
P1B		0	—	ECCP1 PWM Output B.
AN15		I	Analog	Analog Input 15.
Legend: TTL = TTL co	mpatible input			CMOS = CMOS compatible input or output
ST = Schmit	t Trigger input	with C	MOS level	s Analog = Analog input
I = Input				O = Output
$P = Power$ $I^2 C^{TM} = I^2 C/SN$				OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

#### 查询PIC18F86K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin		Description
	TQFP	Туре		
				PORTJ is a bidirectional I/O port.
RJ0	62	I/O	ST	Digital I/O.
RJ1/SEG33 RJ1 SEG33	61	I/O O	ST Analog	Digital I/O. SEG33 output for LCD.
RJ2/SEG34 RJ2 SEG34	60	I/O O	ST Analog	Digital I/O. SEG34 output for LCD.
RJ3/SEG35 RJ3 SEG35	59	I/O O	ST Analog	Digital I/O. SEG35 output for LCD.
RJ4/SEG39 RJ4 SEG39	39	I/O O	ST Analog	Digital I/O. SEG39 output for LCD.
RJ5/SEG38 RJ5 SEG38	40	I/O O	ST Analog	Digital I/O SEG38 output for LCD.
RJ6/SEG37 RJ6 SEG37	41	I/O O	ST Analog	Digital I/O. SEG37 output for LCD.
RJ7/SEG36 RJ7 SEG36	42	I/O O	ST Analog	Digital I/O. SEG36 output for LCD.
Vss	11, 31, 51, 70	Р	—	Ground reference for logic and I/O pins.
Vdd	32, 48, 71	Р	—	Positive supply for logic and I/O pins.
AVss	26	Р	—	Ground reference for analog modules.
AVDD	25	P		Positive supply for analog modules.
ENVREG Vddcore/Vcap	24 12	I	ST	Enable for on-chip voltage regulator. Core logic power or external filter capacitor connection.
VDDCORE/VCAP	12			
VCAP		Р	_	External filter capacitor connection (regulator enabled/disabled).
	er	with C	MOS leve	CMOS = CMOS compatible input or output

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F86K90供应商 NOTES:

# 查询PIC18F86K90供应商

# 2.0 GUIDELINES FOR GETTING STARTED WITH PIC18FXXKXX MICROCONTROLLERS

### 2.1 Basic Connection Requirements

Getting started with the PIC18F87K90 family family of 8-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and Vss pins (see Section 2.2 "Power Supply Pins")
- All AVDD and AVss pins, regardless of whether or not the analog device features are used (see Section 2.2 "Power Supply Pins")
- MCLR pin
   (see Section 2.3 "Master Clear (MCLR) Pin")
- ENVREG (if implemented) and VCAP/VDDCORE pins (see Section 2.4 "Voltage Regulator Pins (ENVREG and VCAP/VDDCORE)")

These pins must also be connected if they are being used in the end application:

- PGC/PGD pins used for In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>) and debugging purposes (see **Section 2.5 "ICSP Pins**")
- OSCI and OSCO pins when an external oscillator source is used

(see Section 2.6 "External Oscillator Pins")

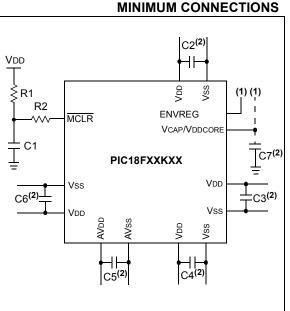
Additionally, the following pins may be required:

• VREF+/VREF- pins are used when external voltage reference for analog modules is implemented

**Note:** The AVDD and AVss pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

# FIGURE 2-1: RECOMMENDED



#### Key (all values are recommendations):

C1 through C6: 0.1  $\mu\text{F},$  20V ceramic R1: 10 k $\Omega$ 

R2: 100Ω to 470Ω

- Note 1: See Section 2.4 "Voltage Regulator Pins (ENVREG and VCAP/VDDCORE)" for explanation of ENVREG pin connections.
  - 2: The example shown is for a PIC18F device with five VDD/VSS and AVDD/AVSS pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

#### 查询PIC18F86K90供应商 2.2 Power Supply Pins

#### 2.2.1 DECOUPLING CAPACITORS

The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD and AVSS, is required.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A 0.1  $\mu$ F (100 nF), 10-20V capacitor is recommended. The capacitor should be a low-ESR device, with a resonance frequency in the range of 200 MHz and higher. Ceramic capacitors are recommended.
- Placement on the printed circuit board: The decoupling capacitors should be placed as close to the pins as possible. It is recommended to place the capacitors on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is no greater than 0.25 inch (6 mm).
- Handling high-frequency noise: If the board is experiencing high-frequency noise (upward of tens of MHz), add a second ceramic type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01  $\mu$ F to 0.001  $\mu$ F. Place this second capacitor next to each primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible (e.g., 0.1  $\mu$ F in parallel with 0.001  $\mu$ F).
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum, thereby reducing PCB trace inductance.

#### 2.2.2 TANK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a tank capacitor for integrated circuits, including microcontrollers, to supply a local power source. The value of the tank capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. In other words, select the tank capacitor so that it meets the acceptable voltage sag at the device. Typical values range from 4.7  $\mu$ F to 47  $\mu$ F.

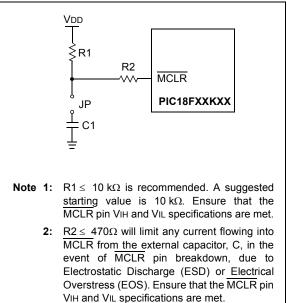
# 2.3 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions: Device Reset, and Device Programming and Debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented, depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the MCLR pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the  $\overline{\text{MCLR}}$  pin should be placed within 0.25 inch (6 mm) of the pin.

#### FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



#### 查询PIC18F86K90供应商

### 2.4 Voltage Regulator Pins (ENVREG and VCAP/VDDCORE)

The on-chip voltage regulator enable pin, ENVREG, must always be connected directly to either a supply voltage or to ground. Tying ENVREG to VDD enables the regulator, while tying it to ground disables the regulator. Refer to **Section 28.3 "On-Chip Voltage Regulator"** for details on connecting and using the on-chip regulator.

When the regulator is enabled, a low-ESR (< 5 $\Omega$ ) capacitor is required on the VCAP/VDDCORE pin to stabilize the voltage regulator output voltage. The VCAP/VDDCORE pin must not be connected to VDD and must use a capacitor of 10  $\mu$ F connected to ground. The type can be ceramic or tantalum. A suitable example is the Murata GRM21BF50J106ZE01 (10  $\mu$ F, 6.3V) or equivalent. Designers may use Figure 2-3 to evaluate ESR equivalence of candidate devices.

It is recommended that the trace length not exceed 0.25 inch (6 mm). Refer to **Section 31.0 "Electrical Characteristics"** for additional information.

When the regulator is disabled, a 0.1  $\mu$ F capacitor should be connected from the VCAP/VDDCORE pin to ground. This capacitor's characteristics must be similar to those of the "decoupling" capacitors explained in **Section 2.2.1 "Decoupling Capacitors**". For details on the VDD requirement, when the regulator is disabled, see parameter D001 in **Section 31.0** "**Electrical Characteristics**".

Some PIC18FXXKXX families or some devices within a family do not provide the option of enabling or disabling the on-chip voltage regulator:

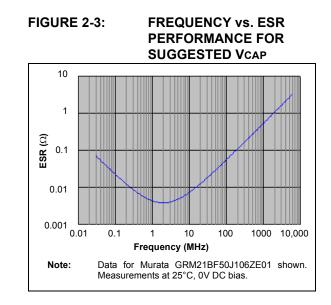
• Some devices (with the name, PIC18LFXXKXX) permanently disable the voltage regulator.

These devices' do not have the ENVREG pin and require a 0.1  $\mu$ F capacitor on the VCAP/VDDCORE pin. The VDD level of these devices must comply with the "voltage regulator disabled" specification for parameter D001, in **Section 31.0 "Electrical Characteristics"**.

• Some devices permanently enable the voltage regulator.

These devices also do not have the ENVREG pin. The  $10\mu$ F capacitor is still required on the VCAP/VDDCORE pin.

For details on all members of the PIC18F87K90 family, see **Section 28.3 "On-Chip Voltage Regulator"**.



#### 2.5 ICSP Pins

The PGC and PGD pins are used for In-Circuit Serial Programming<sup>TM</sup> (ICSP<sup>TM</sup>) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100 $\Omega$ .

Pull-up resistors, series diodes and capacitors on the PGC and PGD pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin input voltage high (VIH) and input low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" (i.e., PGCx/PGDx pins) programmed into the device matches the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 30.0 "Development Support"**.

#### 查询PIC18F86K90供应商 2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 3.0 "Oscillator Configurations"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-4. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins and other signals in close proximity to the oscillator are benign (i.e., free of high frequencies, short rise and fall times, and other similar noise).

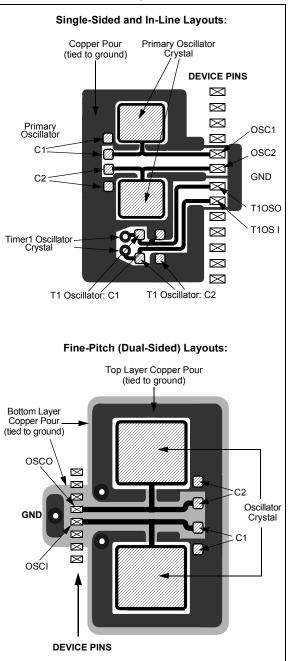
For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC<sup>™</sup> and PICmicro<sup>®</sup> Devices"
- AN849, "Basic PICmicro<sup>®</sup> Oscillator Design"
- AN943, "Practical PICmicro<sup>®</sup> Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"

#### 2.7 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 k $\Omega$  to 10 k $\Omega$  resistor to Vss on unused pins and drive the output to logic low.

#### FIGURE 2-4: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



#### 查询PIC18F86K90供应商 3.0 OSCILLATOR CONFIGURATIONS

#### 3.1 Oscillator Types

The PIC18F87K90 family of devices can be operated in the following oscillator modes:

- EC External Clock, RA6 available
- ECIO External Clock, Clock Out RA6 (Fosc/4 on RA6)
- HS High-Speed Crystal/Resonator
- XT Crystal/Resonator
- LP Low-Power Crystal
- RC External Resistor/Capacitor, RA6 available
- RCIO External Resistor/Capacitor, Clock Out RA6 (Fosc/4 on RA6)
- INTIO2 Internal Oscillator with I/O on RA6 and RA7
- INTIO1 Internal Oscillator with Fosc/4 Output on RA6 and I/O on RA7

There is also an option for running the 4xPLL on any of the clock sources in the input frequency range of 4 to 16 MHz.

The PLL is enabled by setting the PLLCFG bit (CONFIG1H<4>) or the PLLEN bit (OSCTUNE<6>).

For the EC and HS mode, the PLLEN (software) or PLLCFG (CONFIG) bit can be used to enable the PLL.

For the INTIOx modes (HF-INTOSC):

- Only the PLLEN can enable the PLL (PLLCFG is ignored).
- When the oscillator is configured for the internal oscillator (OSC<3:0> = 100x), the PLL can be enabled only when the HF-INTOSC frequency is 8 or 16 MHz.

When the RA6 and RA7 pins are not used for an oscillator function or CLKOUT function, they are available as general purpose I/Os. To optimize power consumption when using EC/HS/ XT/LP/RC as the primary oscillator, the frequency input range can be configured to yield an optimized power bias:

- Low-Power Bias External frequency less than 160 kHz
- Medium Power Bias External frequency between 160 kHz and 16 MHz
- High-Power Bias External frequency greater than 16 MHz

All of these modes are selected by the user by programming the OSC<3:0> Configuration bits (CONFIG1H<3:0>). In addition, PIC18F87K90 family devices can switch between different clock sources, either under software control or under certain conditions, automatically. This allows for additional power savings by managing device clock speed in real time without resetting the application. The clock sources for the PIC18F87K90 family of devices are shown in Figure 3-1.

For the HS and EC mode, there are additional power modes of operation – depending on the frequency of operation.

HS1 is the Medium Power mode with a frequency range of 4 MHz to 16 MHz. HS2 is the High-Power mode where the oscillator frequency can go from 16 MHz to 25 MHz. HS1 and HS2 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 426.)

EC mode has these modes of operation:

- EC1 For low power with a frequency range up to 160 kHz
- EC2 Medium power with a frequency range of 160 kHz to 16 MHz
- EC3 High power with a frequency range of 16 MHz to 64 MHz

EC1, EC2 and EC3 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 426.)

Table 3-1 shows the HS and EC modes' frequency range and OSC<3:0> settings.

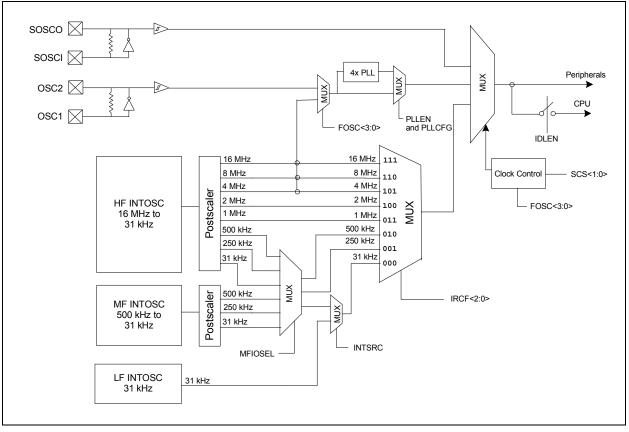
#### 查询PIC18F86K90供应商

#### TABLE 3-1: HS, EC, XT, LP AND RC MODES: RANGES AND SETTINGS

Mode	Frequency Range	OSC<3:0> Setting
EC1 (low power)		1101
(EC1 & EC1IO)	DC-160 kHz	1100
EC2 (medium power)		1011
(EC2 & EC2IO)	160 kHz-16 MHz	1010
EC3 (high power)		0101
(EC3 & EC3IO)	16 MHz-64 MHz	0100
HS1 (medium power)	4 MHz-16 MHz	0011
HS2 (high power)	16 MHz-25 MHz	0010
XT	100 kHz-4 MHz	0001
LP	31.25 kHz	0000
RC (External)	0-4 MHz	011x
INTIO	32 kHz-16 MHz	100x (and OSCCON, OSCCON2)



#### PIC18F87K90 FAMILY CLOCK DIAGRAM



#### <u>查询PIC18F86K90供应商</u> 3.2 Control Registers

The OSCCON register (Register 3-1) controls the main aspects of the device clock's operation. It selects the oscillator type to be used, which of the power-managed modes to invoke and the output frequency of the INTOSC source. It also provides status on the oscillators.

The OSCTUNE register (Register 3-3) controls the tuning and operation of the internal oscillator block. It also implements the PLLEN bit which controls the operation of the Phase Locked Loop (PLL) (see Section 3.5.2 "PLL Frequency Multiplier").

#### REGISTER 3-1: OSCCON: OSCILLATOR CONTROL REGISTER<sup>(1)</sup>

R/W-0	R/W-1	R/W-1	R/W-0	R <sup>(1)</sup>	R-0	R/W-0	R/W-0
IDLEN	IRCF2 <sup>(2)</sup>	IRCF1 <sup>(2)</sup>	IRCF0 <sup>(2)</sup>	OSTS	HFIOFS	SCS1 <sup>(4)</sup>	SCS0 <sup>(4)</sup>
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

<ul> <li>1 = Device enters an Idle mode when a SLEEP instruction is executed</li> <li>0 = Device enters Sleep mode when a SLEEP instruction is executed</li> <li>0 = Device enters Sleep mode when a SLEEP instruction is executed</li> <li>11 = HF-INTOSC: Output frequency used (16 MHz)</li> <li>11 = HF-INTOSC/2 output frequency used (20 MHz)</li> <li>10 = HF-INTOSC/3 output frequency used (20 MHz)</li> <li>11 = HF-INTOSC/3 output frequency used (31.25 KHz)</li> <li>11 = HF-INTOSC/32 output frequency used (31.25 KHz)</li> <li>11 = HF-INTOSC output frequency used (31.25 KHz)</li> <li>11 = MF-INTOSC output frequency used (300 KHz)</li> <li>11 = MF-INTOSC output frequency used (500 KHz)</li> <li>11 = MF-INTOSC output frequency used (500 KHz)</li> <li>11 = MF-INTOSC output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/32 output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/32 output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/2 output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/2 output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/2 output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/16 output frequency used (250 KHz)</li> <li>11 = MF-INTOSC/16 output frequency used (250 KHz)&lt;</li></ul>	bit 7	IDLEN: Idle Enable bit
<ul> <li>0 = Device enters Sleep mode when a SLEEP instruction is executed</li> <li>bit 6-4</li> <li>IRCF-2:0&gt;: Internal Oscillator Frequency Select bits<sup>(2)</sup></li> <li>111 = HF-INTOSC output frequency used (16 MHz)</li> <li>110 = HF-INTOSC/2 output frequency used (2 MHz)</li> <li>101 = HF-INTOSC/6 output frequency used (2 MHz)</li> <li>111 = HF-INTOSC/6 output frequency used (2 MHz)</li> <li>112 = HF-INTOSC/6 output frequency used (2 MHz)</li> <li>113 = HF-INTOSC/6 output frequency used (2 MHz)</li> <li>114 = HF-INTOSC/6 output frequency used (250 kHz)</li> <li>115 = HF-INTOSC/6 output frequency used (250 kHz)</li> <li>116 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>117 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>118 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>119 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>110 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>111 = HF-INTOSC/64 output frequency used (31.25 kHz)</li> <li>111 INTSRC = 1 and MFIOSEL = 1.<sup>(3,5)</sup></li> <li>111 = MF-INTOSC output frequency used (250 kHz)</li> <li>111 = MF-INTOSC fo output frequency used (250 kHz)</li> <li>111 = MF-INTOSC</li></ul>		1 = Device enters an Idle mode when a SLEEP instruction is executed
<ul> <li>111 = HF-INTOSC output frequency used (16 MHz)</li> <li>110 = HF-INTOSC/2 output frequency used (2 MHz)</li> <li>101 = HF-INTOSC/4 output frequency used (2 MHz)</li> <li>101 = HF-INTOSC/16 output frequency used (2 MHz)</li> <li>101 = HF-INTOSC/16 output frequency used (1 MHz)</li> <li>111 = HF-INTOSC/12 output frequency used (500 KHz)</li> <li>111 = HF-INTOSC/20 output frequency used (500 KHz)</li> <li>112 = HF-INTOSC/20 output frequency used (500 KHz)</li> <li>113 = HF-INTOSC/64 output frequency used (500 KHz)</li> <li>114 = HF-INTOSC/64 output frequency used (500 KHz)</li> <li>115 = HF-INTOSC/64 output frequency used (500 KHz)</li> <li>115 = HF-INTOSC/64 output frequency used (500 KHz)</li> <li>114 = H-INTOSC/64 output frequency used (500 KHz)</li> <li>115 = HF-INTOSC/64 output frequency used (500 KHz)</li> <li>114 = H-INTOSC/64 output frequency used (500 KHz)</li> <li>115 = HF-INTOSC/64 output frequency used (500 KHz)</li> <li>114 = H-INTOSC/20 output frequency used (500 KHz)</li> <li>115 = HF-INTOSC output frequency used (500 KHz)</li> <li>114 = HF-INTOSC/20 output frequency used (500 KHz)</li> <li>115 = MF-INTOSC output frequency used (500 KHz)</li> <li>116 = MF-INTOSC output frequency used (500 KHz)</li> <li>116 = MF-INTOSC/20 output frequency used (500 KHz)</li> <li>116 = MF-INTOSC/16 output frequency used (500 KHz)</li> <li>116 = MF-INTOSC/16 output frequency used (500 KHz)</li> <li>117 = MF-INTOSC/16 output frequency used (500 KHz)</li> <li>118 = HF-INTOSC/16 output frequency used (500 KHz)</li> <li>119 = MF-INTOSC/16 output frequency used (500 KHz)</li> <li>119 = MF-INTOSC/16 output frequency used (500 KHz)</li> <li>119 = MF-INTOSC/20 output frequency used (500 KHz)</li> <li>110 = MF-INTOSC/20 output frequency used (500 KHz)</li> <li>111 = Oscillator Start-up Timer (OST) time-out status bit<sup>(1)</sup></li> <li>11 = Oscillator Start-up Timer (OST) time-out is running: prima</li></ul>		0 = Device enters Sleep mode when a SLEEP instruction is executed
<ul> <li>110 = HF-INTOSC/2 output frequency used (8 MHz), default)</li> <li>111 = HF-INTOSC/4 output frequency used (2 MHz)</li> <li>112 = HF-INTOSC/16 output frequency used (2 MHz)</li> <li>113 = HF-INTOSC/16 output frequency used (1 MHz)</li> <li>114 = HF-INTOSC/16 output frequency used (1 MHz)</li> <li>115 = HF-INTOSC/2 output frequency used (250 KHz)</li> <li>110 = HF-INTOSC/30 output frequency used (250 KHz)</li> <li>111 = HF-INTOSC/32 output frequency used (250 KHz)</li> <li>111 = HF-INTOSC/32 output frequency used (250 KHz)</li> <li>112 = 111 = HF-INTOSC/32 output frequency used (250 KHz)</li> <li>114 = HF-INTOSC/32 output frequency used (250 KHz)</li> <li>115 = HF-INTOSC/32 output frequency used (250 KHz)</li> <li>116 = HF-INTOSC/512 output frequency used (250 KHz)</li> <li>117 = MF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>118 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>119 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>110 = MF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>110 = MF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>111 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>111 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>111 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>111 = HF-INTOSC / 40 tiput frequency used (500 KHz)</li> <li>111 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>112 = HF-INTOSC / 40 tiput frequency used (250 KHz)</li> <li>113 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>11 = Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>12 = Oscillator Start-up Timer (OST) time-out thas expired: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>114 Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>32 Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>43 Modifying these bits will cause an immediate clock source sw</li></ul>	bit 6-4	IRCF<2:0>: Internal Oscillator Frequency Select bits <sup>(2)</sup>
<ul> <li>101 = HF-INTOSC/4 output frequency used (4 MHz)</li> <li>100 = HF-INTOSC/8 output frequency used (2 MHz)</li> <li>011 = HF-INTOSC/16 output frequency used (1 MHz)</li> <li>If INTSRC = 0 and MFIOSEL = 0;<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/46 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 0;<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/32 output frequency used (250 kHz)</li> <li>000 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>001 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>000 = HF-INTOSC/64 output frequency used (31.25 kHz)</li> <li>If INTSRC = 0 and MFIOSEL = 1;<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (250 kHz)</li> <li>000 = HF-INTOSC output frequency used (250 kHz)</li> <li>000 = HF-INTOSC /2 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1;<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1;<sup>(3,5)</sup></li> <li>010 = MF-INTOSC /2 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1;<sup>(3,5)</sup></li> <li>010 = MF-INTOSC /16 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC/10 for the quency used (31.25 kHz)</li> <li>002 = Cacillator Start-up Timer (OST) time-out tas unning: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <l< th=""><th></th><th>111 = HF-INTOSC output frequency used (16 MHz)</th></l<></ul>		111 = HF-INTOSC output frequency used (16 MHz)
<ul> <li>100 = HF-INTOSC/8 output frequency used (2 MHz)</li> <li>011 = HF-INTOSC/16 output frequency used (1 MHz)</li> <li>If INTSRC = 0 and MFIOSEL = 0.<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 0.<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/32 output frequency used (250 kHz)</li> <li>001 = HF-INTOSC/32 output frequency used (250 kHz)</li> <li>001 = HF-INTOSC/512 output frequency used (250 kHz)</li> <li>001 = HF-INTOSC output frequency used (250 kHz)</li> <li>001 = MF-INTOSC output frequency used (250 kHz)</li> <li>010 = MF-INTOSC output frequency used (250 kHz)</li> <li>010 = MF-INTOSC output frequency used (250 kHz)</li> <li>001 = MF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>001 = MF-INTOSC output frequency used (250 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (21.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer (OST) time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state o</li></ul>		
<ul> <li>011 = HF-INTOSC/16 output frequency used (1 MHz)</li> <li>If INTSRC = 0 and MEIOSEL = 0.<sup>(3,6)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC (64 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MEIOSEL = 0.<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/64 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>001 = HF-INTOSC/64 output frequency used (31.25 kHz)</li> <li>If INTSRC = 0 and MEIOSEL = 1.<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC output frequency used (51.25 kHz)</li> <li>If INTSRC = 1 and MEIOSEL = 1.<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC/16 o</li></ul>		
If INTSRC = 0 and MFIOSEL = 0: <sup>(3,5)</sup> 010 = HF-INTOSC/32 output frequency used (500 kHz)         000 = LF-INTOSC output frequency used (250 kHz)         100 = HF-INTOSC output frequency used (31.25 kHz)         If INTSRC = 1 and MFIOSEL = 0: <sup>(3,5)</sup> 010 = HF-INTOSC/32 output frequency used (500 kHz)         001 = HF-INTOSC/32 output frequency used (250 kHz)         001 = HF-INTOSC/512 output frequency used (250 kHz)         010 = MF-INTOSC output frequency used (500 kHz)         011 = MF-INTOSC output frequency used (500 kHz)         010 = MF-INTOSC output frequency used (500 kHz)         010 = MF-INTOSC output frequency used (500 kHz)         010 = MF-INTOSC/16 output frequency used (250 kHz)         000 = MF-INTOSC/16 output fr		
<ul> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC (A output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 0:<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/64 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/64 output frequency used (31.25 kHz)</li> <li>If INTSRC = 0 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC/16 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC/16 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3</li> <li>OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> </ul> Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock		
<ul> <li>001 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 0:<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/512 output frequency used (250 kHz)</li> <li>000 = HF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 0 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC /2 output frequency used (21.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 0:<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/512 output frequency used (31.25 kHz)</li> <li>If INTSRC = 0 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC /2 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>000 = MF-INTOSC output frequency used (250 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC /2 output frequency used (250 kHz)</li> <li>001 = MF-INTOSC /46 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC /3 output frequency used (31.25 kHz)</li> <li>001 = MF-INTOSC /16 output frequency used (31.25 kHz)</li> <li>000 = MF-INTOSC /16 output frequency used (31.25 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (31.25 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (31.25 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = MF-INTOSC /3 output frequency used (500 kHz)</li> <li>000 = Oscillator Start</li></ul>		
<ul> <li>If INTSRC = 1 and MFIOSEL = 0:<sup>(3,5)</sup></li> <li>010 = HF-INTOSC/32 output frequency used (500 kHz)</li> <li>001 = HF-INTOSC/64 output frequency used (250 kHz)</li> <li>000 = HF-INTOSC/512 output frequency used (31.25 kHz)</li> <li>If INTSRC = 0 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/2 output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch. if the internal oscillator is providing these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>000 = HF-INTOSC/512 output frequency used (31.25 kHz) [f INTSRC = 0 and MFIOSEL = 1:<sup>(3,5)</sup> 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) [f INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup> 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup> 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt; 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
If INTSRC = 0 and MFIOSEL = 1: <sup>(3,5)</sup> 010 = MF-INTOSC output frequency used (500 kHz)         001 = MF-INTOSC/2 output frequency used (250 kHz)         000 = LF-INTOSC output frequency used (31.25 kHz)         If INTSRC = 1 and MFIOSEL = 1: <sup>(3,5)</sup> 010 = MF-INTOSC output frequency used (500 kHz)         001 = MF-INTOSC output frequency used (500 kHz)         001 = MF-INTOSC /2 output frequency used (250 kHz)         001 = MF-INTOSC /2 output frequency used (250 kHz)         001 = MF-INTOSC/2 output frequency used (250 kHz)         001 = MF-INTOSC /2 output frequency used (250 kHz)         001 = MF-INTOSC /2 output frequency used (250 kHz)         001 = MF-INTOSC/2 output frequency used (250 kHz)         001 = MF-INTOSC /2 output frequency used (250 kHz)         001 = MF-INTOSC /2 output frequency used (31.25 kHz)         DOTS: Oscillator Start-up Timer Time-out Status bit <sup>(1)</sup> 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0>         0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)         Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>).      <		
<ul> <li>10 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = LF-INTOSC output frequency used (31.25 kHz)</li> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>000 = LF-INTOSC output frequency used (31.25 kHz) <u>If INTSRC = 1 and MFIOSEL = 1:</u><sup>(3,5)</sup> 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup> 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt; 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>If INTSRC = 1 and MFIOSEL = 1:<sup>(3,5)</sup></li> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>010 = MF-INTOSC output frequency used (500 kHz)</li> <li>001 = MF-INTOSC/2 output frequency used (250 kHz)</li> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup></li> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup> 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>000 = MF-INTOSC/16 output frequency used (31.25 kHz)</li> <li>bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit<sup>(1)</sup> <ol> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;             <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> </li></ol> </li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ol> <li>1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ol>		
<ul> <li>OSC&lt;3:0&gt;</li> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>	bit 3	<b>OSTS:</b> Oscillator Start-up Timer Time-out Status bit <sup>(1)</sup>
<ul> <li>0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ul> <li>from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC)</li> <li>Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H&lt;7&gt;).</li> <li>2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>		
<ol> <li>Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.</li> <li>Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>Modifying these bits will cause an immediate clock source switch.</li> </ol>		
<ul> <li>the device clocks.</li> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>	Note 1:	Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>).
<ul> <li>3: Source selected by the INTSRC bit (OSCTUNE&lt;7&gt;).</li> <li>4: Modifying these bits will cause an immediate clock source switch.</li> </ul>	2:	
4: Modifying these bits will cause an immediate clock source switch.	3.	
	5.	

#### 查询PIC18F86K90供应商

#### **REGISTER 3-1:** OSCCON: OSCILLATOR CONTROL REGISTER<sup>(1)</sup> (CONTINUED)

- bit 2 **HFIOFS:** INTOSC Frequency Stable bit
  - 1 = HF-INTOSC oscillator frequency is stable
    - 0 = HF-INTOSC oscillator frequency is not stable
- bit 1-0 SCS<1:0>: System Clock Select bits<sup>(4)</sup>
  - 1x = Internal oscillator block (LF-INTOSC, MF-INTOSC or HF-INTOSC)
  - 01 = SOSC oscillator
  - 00 = Default primary oscillator (OSC1/OSC2 or HF-INTOSC with or without PLL. Defined by the OSC<3:0> Configuration bits, CONFIG1H<3:0>.)
- **Note 1:** Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>).
  - 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.
  - 3: Source selected by the INTSRC bit (OSCTUNE<7>).
  - 4: Modifying these bits will cause an immediate clock source switch.
  - **5**: INTSRC = OSCTUNE<7> and MFIOSEL = OSCCON2<0>.

#### REGISTER 3-2: OSCCON2: OSCILLATOR CONTROL REGISTER 2

U-0	R-0	U-0	U-0	R/W-0	U-0	R-x	R/W-0
—	SOSCRUN		—	SOSCGO	—	MFIOFS	MFIOSEL
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	SOSCRUN: SOSC Run Status bit
	<ul> <li>1 = System clock comes from a secondary SOSC</li> <li>0 = System clock comes from an oscillator other than SOSC</li> </ul>
bit 5-4	Unimplemented: Read as '0'
bit 3	SOSCGO: Oscillator Start Control bit
	<ul> <li>1 = Oscillator is running, even if no other sources are requesting it</li> <li>0 = Oscillator is shut off if no other sources are requesting it (When the SOSC is selected to run from a digital clock input, rather than an external crystal, this bit has no effect.)</li> </ul>
bit 2	Unimplemented: Read as '0'
bit 1	MFIOFS: MF-INTOSC Frequency Stable bit
	<ul> <li>1 = MF-INTOSC is stable</li> <li>0 = MF-INTOSC is not stable</li> </ul>
bit 0	MFIOSEL: MF-INTOSC Select bit 1 = MF-INTOSC is used in place of HF-INTOSC frequencies of 500 kHz, 250 kHz and 31.25 kHz 0 = MF-INTOSC is not used

#### 查询PIC18F86K90供应商 REGISTER 3-3: OSCTUNE: OSCILLATOR TUNING REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INTSRC	PLLEN	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	INTSRC: Internal Oscillator Low-Frequency Source Select bit 1 = 31.25 kHz device clock is derived from 16 MHz INTOSC source (divide-by-512 enabled, HF-INTOSC) 0 = 31 kHz device clock is derived from INTRC 31 kHz oscillator (LF-INTOSC)
bit 6	PLLEN: Frequency Multiplier PLL Enable bit 1 = PLL is enabled 0 = PLL is disabled
bit 5-0	TUN<5:0>: Fast RC Oscillator (INTOSC) Frequency Tuning bits 011111 = Maximum frequency • • • 000001 000000 = Center frequency. Fast RC oscillator is running at the calibrated frequency. 111111 • • 100000 = Minimum frequency

#### 3.3 Clock Sources and Oscillator Switching

Essentially, PIC18F87K90 family devices have these independent clock sources:

- Primary oscillators
- Secondary oscillators
- Internal oscillator

The **primary oscillators** can be thought of as the main device oscillators. These are any external oscillators connected to the OSC1 and OSC2 pins, and include the External Crystal and Resonator modes and the External Clock modes. If selected by the OSC<3:0> Configuration bits (CONFIG1H<3:0>), the internal oscillator block may be considered a primary oscillator. The internal oscillator block can be one of the following:

- 31 kHz LF-INTRC source
- 31 kHz to 500 kHz MF-INTOSC source
- 31 kHz to 16 MHz HF-INTOSC source

The particular mode is defined by the OSC Configuration bits. The details of these modes are covered in **Section 3.4 "External Oscillator Modes**".

The **secondary oscillators** are external clock sources that are not connected to the OSC1 or OSC2 pin. These sources may continue to operate, even after the controller is placed in a power-managed mode. PIC18F87K90 family devices offer the SOSC (Timer1/3/5/7) oscillator as a secondary oscillator source. This oscillator, in all power-managed modes, is often the time base for functions, such as a Real-Time Clock (RTC).

The SOSCEN bit in the corresponding timer should be set correctly for the enabled SOSC. The SOSCEL<1:0> bits (CONFIG1L<4:3>) decide the SOSC mode of operation:

- 11 = High-power SOSC circuit
- 10 = Digital (SCLKI) mode
- 01 = Low-power SOSC circuit

In addition to being a primary clock source in some circumstances, the **internal oscillator** is available as a power-managed mode clock source. The LF-INTOSC source is also used as the clock source for several special features, such as the WDT and Fail-Safe Clock Monitor. The internal oscillator block is discussed in more detail in **Section 3.6** "Internal Oscillator **Block**".

The PIC18F87K90 family includes features that allow the device clock source to be switched from the main oscillator, chosen by device configuration, to one of the alternate clock sources. When an alternate clock source is enabled, various power-managed operating modes are available.

#### 查询PIC18F86K90供应商 3.3.1 OSC1/OSC2 OSCILLATOR

The OSC1/OSC2 oscillator block is used to provide the oscillator modes and frequency ranges:

Mode	Design Operating Frequency
LP	31.25-100 kHz
XT	100 kHz to 4 MHz
HS	4 MHz to 25 MHz
EC	0 to 64 MHz (external clock)
EXTRC	0 to 4 MHz (external RC)

The crystal-based oscillators (XT, HS and LP) have a built-in start-up time. The operation of the EC and EXTRC clocks is immediate.

#### 3.3.2 CLOCK SOURCE SELECTION

The System Clock Select bits, SCS<1:>0 (OSCCON2<1:0>), select the clock source. The available clock sources are the primary clock defined by the OSC<3:0> Configuration bits, the secondary clock (SOSC oscillator) and the internal oscillator. The clock source changes after one or more of the bits is written to, following a brief clock transition interval.

The OSTS (OSCCON<3>) and SOSCRUN (OSCCON2<6>) bits indicate which clock source is currently providing the device clock. The OSTS bit indicates that the Oscillator Start-up Timer (OST) has timed out and the primary clock is providing the device clock in primary clock modes. The SOSCRUN bit indicates when the SOSC oscillator (from Timer1/3/5/7) is providing the device clock in secondary clock modes. In power-managed modes, only one of these bits will be set at any time. If neither of these bits is set, the INTRC is providing the clock, or the internal oscillator has just started and is not yet stable.

The IDLEN bit (OSCCON<7>) determines if the device goes into Sleep mode or one of the Idle modes when the SLEEP instruction is executed.

The use of the flag and control bits in the OSCCON register is discussed in more detail in **Section 4.0 "Power-Managed Modes"**.

- Note 1: The secondary oscillator must be enabled to select the secondary clock source. The SOSC oscillator is enabled by setting the SOSCGO bit in the OSCCON2 register (OSCCON<3>). If the SOSC oscillator is not enabled, then any attempt to select a secondary clock source when executing a SLEEP instruction will be ignored.
  - 2: It is recommended that the secondary oscillator be operating and stable before executing the SLEEP instruction or a very long delay may occur while the SOSC oscillator starts.

### 3.3.2.1 System Clock Selection and Device Resets

Since the SCS bits are cleared on all forms of Reset, this means the primary oscillator defined by the OSC<3:0> Configuration bits is used as the primary clock source on device Resets. This could either be the internal oscillator block by itself, or one of the other primary clock source (HS, EC, XT, LP, External RC and PLL-enabled modes).

In those cases when the internal oscillator block, without PLL, is the default clock on Reset, the Fast RC oscillator (INTOSC) will be used as the device clock source. It will initially start at 8 MHz; the postscaler selection that corresponds to the Reset value of the IRCF<2:0> bits ('110').

Regardless of which primary oscillator is selected, INTRC will always be enabled on device power-up. It serves as the clock source until the device has loaded its configuration values from memory. It is at this point that the OSC Configuration bits are read and the oscillator selection of the operational mode is made.

Note that either the primary clock source or the internal oscillator will have two bit setting options for the possible values of the SCS<1:0> bits, at any given time.

#### 3.3.3 OSCILLATOR TRANSITIONS

PIC18F87K90 family devices contain circuitry to prevent clock "glitches" when switching between clock sources. A short pause in the device clock occurs during the clock switch. The length of this pause is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Clock transitions are discussed in greater detail in **Section 4.1.2 "Entering Power-Managed Modes"**.

#### 3.4 External Oscillator Modes

### 3.4.1 CRYSTAL OSCILLATOR/CERAMIC RESONATORS (HS MODES)

In HS or HSPLL Oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 3-2 shows the pin connections.

The oscillator design requires the use of a crystal rated for parallel resonant operation.

Note: Use of a crystal rated for series resonant operation may give a frequency out of the crystal manufacturer's specifications.

#### 查询PIC18F86K90供应商 TABLE 3-2: CAPACITOR SELECTION FOR CERAMIC RESONATORS

Typical Capacitor Values Used:						
Mode	Freq.	OSC1	OSC2			
HS	8.0 MHz 16.0 MHz	27 pF 22 pF	27 pF 22 pF			

Capacitor values are for design guidance only.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application. Refer to the following application notes for oscillator-specific information:

- AN588, "PIC<sup>®</sup> Microcontroller Oscillator Design Guide"
- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC<sup>®</sup> and PIC<sup>®</sup> Devices"
- AN849, "Basic PIC<sup>®</sup> Oscillator Design"
- AN943, "Practical PIC<sup>®</sup> Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"

See the notes following Table 3-3 for additional information.

#### TABLE 3-3: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freq.	Typical Capa Tes	
	Fieq.	C1	C2
HS	4 MHz	27 pF	27 pF
	8 MHz	22 pF	22 pF
	20 MHz	15 pF	15 pF

Capacitor values are for design guidance only.

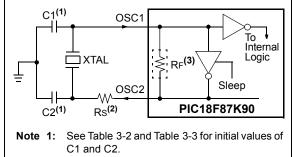
Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

Refer to the Microchip application notes cited in Table 3-2 for oscillator-specific information. Also see the notes following this table for additional information.

- Note 1: Higher capacitance increases the stability of oscillator but also increases the start-up time.
  - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
  - **3:** Rs may be required to avoid overdriving crystals with low drive level specification.
  - 4: Always verify oscillator performance over the VDD and temperature range that is expected for the application.

### FIGURE 3-2:

#### CRYSTAL/CERAMIC RESONATOR OPERATION (HS OR HSPLL CONFIGURATION)



- **2:** A series resistor (Rs) may be required for AT strip cut crystals.
- **3:** RF varies with the oscillator mode chosen.

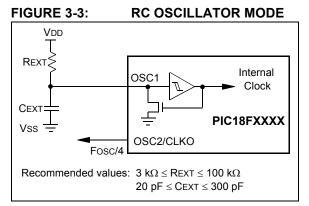
#### 3.5 RC Oscillator

For timing-insensitive applications, the RC and RCIO Oscillator modes offer additional cost savings. The actual oscillator frequency is a function of several factors:

- · Supply voltage
- Values of the external resistor (REXT) and capacitor (CEXT)
- Operating temperature Given the same device, operating voltage and temperature and component values, there will also be unit-to-unit frequency variations. These are due to factors such as:
  - normal manufacturing variation
  - difference in lead frame capacitance between package types (especially for low CEXT values)
  - variations within the tolerance of limits of  $\ensuremath{\mathsf{Rext}}$  and  $\ensuremath{\mathsf{Cext}}$

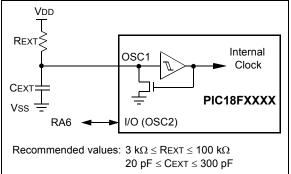
#### 查询PIC18F86K90供应商

In the RC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 3-3 shows how the R/C combination is connected.



The RCIO Oscillator mode (Figure 3-4) functions like the RC mode, except that the OSC2 pin becomes an additional general purpose I/O pin. The I/O pin becomes bit 6 of PORTA (RA6).



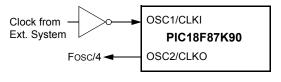


#### 3.5.1 EXTERNAL CLOCK INPUT (EC MODES)

The EC and ECPLL Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

In the EC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 3-5 shows the pin connections for the EC Oscillator mode.

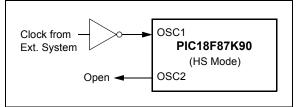
### FIGURE 3-5: EXTERNAL CLOCK INPUT OPERATION (EC CONFIGURATION)



An external clock source may also be connected to the OSC1 pin in the HS mode, as shown in Figure 3-6. In this configuration, the divide-by-4 output on OSC2 is not available. Current consumption in this configuration will be somewhat higher than EC mode, as the internal oscillator's feedback circuitry will be enabled (in EC mode, the feedback circuit is disabled).



#### EXTERNAL CLOCK INPUT OPERATION (HS OSC CONFIGURATION)



#### 3.5.2 PLL FREQUENCY MULTIPLIER

A Phase Lock Loop (PLL) circuit is provided as an option for users who want to use a lower frequency oscillator circuit, or to clock the device up to its highest rated frequency from a crystal oscillator. This may be useful for customers who are concerned with EMI due to high-frequency crystals, or users who require higher clock speeds from an internal oscillator.

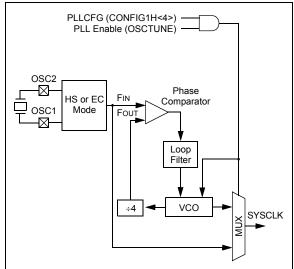
#### 3.5.2.1 HSPLL and ECPLL Modes

The HSPLL and ECPLL modes provide the ability to selectively run the device at four times the external oscillating source to produce frequencies up to 64 MHz.

The PLL is enabled by setting the PLLEN bit (OSCTUNE<6>) or the PLLCFG bit (CONFIG1H<4>). For the HF-INTOSC as primary, the PLL must be enabled with the PLLEN. This provides software control for the PLL, enabling even if PLLCFG is set to '1', so that the PLL is enabled only when the HF-INTOSC frequency is within the 4 MHz to 16 MHz input range.

This also enables additional flexibility for controlling the application's clock speed in software. The PLLEN should be enabled in HF-INTOSC mode only if the input frequency is in the range of 4 MHz-16 MHz.

#### 查询PIC18F86K90供应商 FIGURE 3-7: PLL BLOCK DIAGRAM



#### 3.5.2.2 PLL and HF-INTOSC

The PLL is available to the internal oscillator block when the internal oscillator block is configured as the primary clock source. In this configuration, the PLL is enabled in software and generates a clock output of up to 64 MHz.

The operation of INTOSC with the PLL is described in **Section 3.6.2 "INTPLL Modes"**. Care should be taken that the PLL is enabled only if the HF-INTOSC postscaler is configured for 4 MHz, 8 MHz or 16 MHz.

#### 3.6 Internal Oscillator Block

The PIC18F87K90 family of devices includes an internal oscillator block which generates two different clock signals. Either clock can be used as the micro-controller's clock source, which may eliminate the need for an external oscillator circuit on the OSC1 and/or OSC2 pins.

The internal oscillator consists of three blocks, depending on the frequency of operation. They are HF-INTOSC, MF-INTOSC and LF-INTRC.

In HF-INTOSC mode, the internal oscillator can provide a frequency, ranging from 31 KHz to 16 MHz, with the postscaler deciding the selected frequency (IRCF<2:0>).

The INTSRC bit (OSCTUNE<7>) and MFIOSEL bit (OSCCON2<0>) also decide which INTOSC provides the lower frequency (500 kHz to 31 KHz). For the HF-INTOSC to provide these frequencies, INTSRC = 1 and MFIOSEL = 0.

In HF-INTOSC, the postscaler (IRCF<2:0>) provides the frequency range of 31 kHz to 16 MHz. If HF-INTOSC is used with the PLL, the input frequency to the PLL should be 4 MHz to 16 MHz (IRCF<2:0> = 111, 110 or 101).

For MF-INTOSC mode to provide a frequency range of 500 kHz to 31 kHz, INTSRC = 1 and MFIOSEL = 1. The postscaler (IRCF<2:0>), in this mode, provides the frequency range of 31 kHz to 500 kHz.

The LF-INTRC can provide only 31 kHz if INTSRC = 0.

The LF-INTRC provides 31 kHz and is enabled if it is selected as the device clock source. The mode is enabled automatically when any of the following is enabled:

- Power-up Timer
- · Fail-Safe Clock Monitor
- Watchdog Timer
- Two-Speed Start-up

These features are discussed in greater detail in **Section 28.0 "Special Features of the CPU"**.

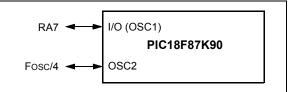
The clock source frequency (HF-INTOSC, MF-INTOSC or LF-INTRC direct) is selected by configuring the IRCF bits of the OSCCON register, as well the INTSRC and MFIOSEL bits. The default frequency on device Resets is 8 MHz.

#### 3.6.1 INTIO MODES

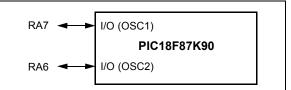
Using the internal oscillator as the clock source eliminates the need for up to two external oscillator pins, which can then be used for digital I/O. Two distinct oscillator configurations, which are determined by the OSC Configuration bits, are available:

- In INTIO1 mode, the OSC2 pin (RA6) outputs Fosc/4, while OSC1 functions as RA7 (see Figure 3-8) for digital input and output.
- In INTIO2 mode, OSC1 functions as RA7 and OSC2 functions as RA6 (see Figure 3-9). Both are available as digital input and output ports.

#### FIGURE 3-8: INTIO1 OSCILLATOR MODE



#### FIGURE 3-9: INTIO2 OSCILLATOR MODE



#### 查询PIC18F86K90供应商 3.6.2 INTPLL MODES

The 4x Phase Locked Loop (PLL) can be used with the HF-INTOSC to produce faster device clock speeds than are normally possible with the internal oscillator sources. When enabled, the PLL produces a clock speed of 16 MHz or 64 MHz.

PLL operation is controlled through software. The control bits, PLLEN (OSCTUNE<6>) and PLLCFG (CONFIG1H<4>), are used to enable or disable its operation. The PLL is available only to HF-INTOSC and the other oscillator is set with HS and EC modes. Additionally, the PLL will only function when the selected output frequency is either 4 MHz or 16 MHz (OSCCON<6:4> = 111, 110 or 101).

Like the INTIO modes, there are two distinct INTPLL modes available:

- In INTPLL1 mode, the OSC2 pin outputs Fosc/4, while OSC1 functions as RA7 for digital input and output. Externally, this is identical in appearance to INTIO1 (Figure 3-8).
- In INTPLL2 mode, OSC1 functions as RA7 and OSC2 functions as RA6, both for digital input and output. Externally, this is identical to INTIO2 (Figure 3-9).

#### 3.6.3 INTERNAL OSCILLATOR OUTPUT FREQUENCY AND TUNING

The internal oscillator block is calibrated at the factory to produce an INTOSC output frequency of 16 MHz. It can be adjusted in the user's application by writing to TUN<5:0> (OSCTUNE<5:0>) in the OSCTUNE register (Register 3-3).

When the OSCTUNE register is modified, the INTOSC (HF-INTOSC and MF-INTOSC) frequency will begin shifting to the new frequency. The oscillator will require some time to stabilize. Code execution continues during this shift and there is no indication that the shift has occurred.

The LF-INTOSC oscillator operates independently of the HF-INTOSC or the MF-INTOSC source. Any changes in the HF-INTOSC or the MF-INTOSC source, across voltage and temperature, are not necessarily reflected by changes in LF-INTOSC or vice versa. The frequency of LF-INTOSC is not affected by OSCTUNE.

#### 3.6.4 INTOSC FREQUENCY DRIFT

The INTOSC frequency may drift as VDD or temperature changes, and can affect the controller operation in a variety of ways. It is possible to adjust the INTOSC frequency by modifying the value in the OSCTUNE register. Depending on the device, this may have no effect on the LF-INTOSC clock source frequency. Tuning INTOSC requires knowing when to make the adjustment, in which direction it should be made, and in some cases, how large a change is needed. Three compensation techniques are shown here.

#### 3.6.4.1 Compensating with the EUSART

An adjustment may be required when the EUSART begins to generate framing errors or receives data with errors while in Asynchronous mode. Framing errors indicate that the device clock frequency is too high. To adjust for this, decrement the value in OSCTUNE to reduce the clock frequency. On the other hand, errors in data may suggest that the clock speed is too low. To compensate, increment OSCTUNE to increase the clock frequency.

#### 3.6.4.2 Compensating with the Timers

This technique compares device clock speed to some reference clock. Two timers may be used; one timer is clocked by the peripheral clock, while the other is clocked by a fixed reference source, such as the SOSC oscillator.

Both timers are cleared, but the timer clocked by the reference generates interrupts. When an interrupt occurs, the internally clocked timer is read and both timers are cleared. If the internally clocked timer value is much greater than expected, then the internal oscillator block is running too fast. To adjust for this, decrement the OSCTUNE register.

### 3.6.4.3 Compensating with the CCP Module in Capture Mode

A CCP module can use free-running Timer1 (or Timer3), clocked by the internal oscillator block and an external event with a known period (i.e., AC power frequency). The time of the first event is captured in the CCPRxH:CCPRxL registers and is recorded for use later. When the second event causes a capture, the time of the first event is subtracted from the time of the second event. Since the period of the external event is known, the time difference between events can be calculated.

If the measured time is much greater than the calculated time, the internal oscillator block is running too fast. To compensate, decrement the OSCTUNE register. If the measured time is much less than the calculated time, the internal oscillator block is running too slow. To compensate, increment the OSCTUNE register.

#### 查询PIC18F86K90供应商 3.7 Reference Clock Output

In addition to the FOSC/4 clock output in certain oscillator modes, the device clock in the PIC18F87K90 family can also be configured to provide a reference clock output signal to a port pin. This feature is available in all oscillator configurations and allows the user to select a greater range of clock submultiples to drive external devices in the application.

This reference clock output is controlled by the REFOCON register (Register 3-4). Setting the ROON bit (REFOCON<7>) makes the clock signal available on the REFO (RE3) pin. The RODIV<3:0> bits enable the selection of 16 different clock divider options.

The ROSSLP and ROSEL bits (REFOCON<5:4>) control the availability of the reference output during Sleep mode. The ROSEL bit determines if the oscillator on OSC1 and OSC2, or the current system clock source, is used for the reference clock output. The ROSSLP bit determines if the reference source is available on RE3 when the device is in Sleep mode.

To use the reference clock output in Sleep mode, both the ROSSLP and ROSEL bits must be set. The device clock must also be configured for an EC or HS mode; otherwise, the oscillator on OSC1 and OSC2 will be powered down when the device enters Sleep mode.

Clearing the ROSEL bit allows the reference output frequency to change as the system clock changes during any clock switches.

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ROON	—	ROSSLP	ROSEL <sup>(1)</sup>	RODIV3	RODIV2	RODIV1	RODIV0
bit 7							bit 0

#### REGISTER 3-4: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

Legend:					
R = Readable bit		W = Writable bit	U = Unimplemented bit	it, read as '0'	
-n = Value at	POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	
bit 7	1 = Refe	Reference Oscillator Output E rence oscillator output is avai rence oscillator output is disa	lable on REFO pin		
bit 6	Unimple	mented: Read as '0'			
bit 5	1 = Refe	P: Reference Oscillator Outpu rence oscillator continues to r rence oscillator is disabled in	un in Sleep		
bit 4	1 = Prim	Reference Oscillator Source ary oscillator (EC or HS) is us em clock is used as the base	ed as the base clock	clock switching of the device	
bit 3-0	<ul> <li>a Finitally oscillator (EC of HS) is used as the base clock</li> <li>a System clock is used as the base clock; base clock reflects any clock switching of the device</li> <li><b>RODIV&lt;3:0&gt;</b>: Reference Oscillator Divisor Select bits</li> <li>a Base clock value divided by 32,768</li> <li>b Base clock value divided by 16,384</li> <li>c Base clock value divided by 4,096</li> <li>c Base clock value divided by 2,048</li> <li>c Base clock value divided by 1,024</li> <li>c Base clock value divided by 256</li> <li>c Base clock value divided by 256</li> <li>c Base clock value divided by 40</li> <li>c Base clock value divided by 32</li> <li>c Base clock value divided by 32</li> <li>c Base clock value divided by 32</li> <li>c Base clock value divided by 40</li> </ul>				

**Note 1:** For ROSEL (REFOCON<4>), the primary oscillator is only available when configured as default via the FOSC settings (regardless of whether the device is in Sleep mode).

#### 查询PIC18F86K90供应商

#### 3.8 Effects of Power-Managed Modes on the Various Clock Sources

When PRI\_IDLE mode is selected, the designated primary oscillator continues to run without interruption. For all other power-managed modes, the oscillator using the OSC1 pin is disabled. The OSC1 pin (and OSC2 pin if used by the oscillator) will stop oscillating.

In secondary clock modes (SEC\_RUN and SEC\_IDLE), the SOSC oscillator is operating and providing the device clock. The SOSC oscillator may also run in all power-managed modes if required to clock SOSC.

In RC\_RUN and RC\_IDLE modes, the internal oscillator provides the device clock source. The 31 kHz LF-INTOSC output can be used directly to provide the clock and may be enabled to support various special features, regardless of the power-managed mode (see Section 28.2 "Watchdog Timer (WDT)" through Section 28.5 "Fail-Safe Clock Monitor" for more information on WDT, Fail-Safe Clock Monitor and Two-Speed Start-up).

If the Sleep mode is selected, all clock sources are stopped. Since all the transistor switching currents have been stopped, Sleep mode achieves the lowest current consumption of the device (only leakage currents).

Enabling any on-chip feature that will operate during Sleep will increase the current consumed during Sleep. The INTOSC is required to support WDT operation. The SOSC oscillator may be operating to support a Real-Time Clock (RTC). Other features may be operating that do not require a device clock source (i.e., MSSP slave, INTx pins and others). Peripherals that may add significant current consumption are listed in Section 31.2 "DC Characteristics: Power-Down and Supply Current PIC18F87K90 Family (Industrial)".

#### 3.9 Power-up Delays

Power-up delays are controlled by two timers, so that no external Reset circuitry is required for most applications. The delays ensure that the device is kept in Reset until the device power supply is stable under normal circumstances and the primary clock is operating and stable. For additional information on power-up delays, see **Section 5.6 "Power-up Timer (PWRT)**".

The first timer is the Power-up Timer (PWRT), which provides a fixed delay on power-up time of about 64 ms (parameter 33, Table 31-10); it is always enabled.

The second timer is the Oscillator Start-up Timer (OST), intended to keep the chip in Reset until the crystal oscillator is stable (HS, XT or LP modes). The OST does this by counting 1,024 oscillator cycles before allowing the oscillator to clock the device.

There is a delay of interval, TCSD (parameter 38, Table 31-10), following POR, while the controller becomes ready to execute instructions.

Oscillator Mode	OSC1 Pin	OSC2 Pin
EC, ECPLL	Floating, pulled by external clock	At logic low (clock/4 output)
HS, HSPLL	Feedback inverter disabled at quiescent voltage level	Feedback inverter disabled at quiescent voltage level
INTOSC, INTPLL1/2	I/O pin, RA6, direction controlled by TRISA<6>	I/O pin, RA6, direction controlled by TRISA<7>

 TABLE 3-4:
 OSC1 AND OSC2 PIN STATES IN SLEEP MODE

**Note:** See **Section 5.0** "**Reset**" for time-outs due to Sleep and MCLR Reset.

#### 查询PIC18F86K90供应商 4.0 POWER-MANAGED MODES

The PIC18F87K90 family of devices offers a total of seven operating modes for more efficient power management. These modes provide a variety of options for selective power conservation in applications where resources may be limited (such as battery-powered devices).

There are three categories of power-managed modes:

- Run modes
- Idle modes
- · Sleep mode

There is an Ultra Low-Power Wake-up (ULPWU) for waking from the Sleep mode.

These categories define which portions of the device are clocked, and sometimes, at what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block). The Sleep mode does not use a clock source.

The ULPWU mode, on the RA0 pin, enables a slow falling voltage to generate a wake-up, even from Sleep, without excess current consumption. (See Section 4.7 "Ultra Low-Power Wake-up".)

The power-managed modes include several powersaving features offered on previous PIC<sup>®</sup> devices. One is the clock switching feature, offered in other PIC18 devices. This feature allows the controller to use the SOSC oscillator instead of the primary one. Another power-saving feature is Sleep mode, offered by all PIC devices, where all device clocks are stopped.

#### 4.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions:

- · Will the CPU be clocked or not
- · What will be the clock source

The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS<1:0> bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 4-1.

#### 4.1.1 CLOCK SOURCES

The SCS<1:0> bits select one of three clock sources for power-managed modes. Those sources are:

- The primary clock, as defined by the OSC<3:0> Configuration bits
- The secondary clock (the SOSC oscillator)
- The internal oscillator block (for LF-INTOSC modes)

#### 4.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS<1:0> bits select the clock source and determine which Run or Idle mode is used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. These considerations are discussed in **Section 4.1.3 "Clock Transitions and Status Indicators"** and subsequent sections.

Entering the power-managed Idle or Sleep modes is triggered by the execution of a SLEEP instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current and impending mode, a change to a power-managed mode does not always require setting all of the previously discussed bits. Many transitions can be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a SLEEP instruction. If the IDLEN bit is already configured as desired, it may only be necessary to perform a SLEEP instruction to switch to the desired mode.

Mada	oscco	OSCCON Bits		Clocking	Available Cleak and Ocaillater Course
Mode	IDLEN<7>(1)	SCS<1:0>	CPU	Peripherals	Available Clock and Oscillator Source
Sleep	0	N/A	Off	Off	None – All clocks are disabled
PRI_RUN	N/A	00	Clocked	Clocked	Primary – XT, LP, HS, EC, RC and PLL modes. This is the normal, full-power execution mode.
SEC_RUN	N/A	01	Clocked	Clocked	Secondary – SOSC Oscillator
RC_RUN	N/A	1x	Clocked	Clocked	Internal oscillator block <sup>(2)</sup>
PRI_IDLE	1	00	Off	Clocked	Primary – LP, XT, HS, RC, EC
SEC_IDLE	1	01	Off	Clocked	Secondary – SOSC oscillator
RC_IDLE	1	1x	Off	Clocked	Internal oscillator block <sup>(2)</sup>

#### TABLE 4-1:POWER-MANAGED MODES

**Note 1:** IDLEN reflects its value when the **SLEEP** instruction is executed.

2: Includes INTOSC (HF-INTOSC and MG-INTOSC) and INTOSC postscaler, as well as the LF-INTISC source.

#### 查询PIC18F86K90供应商

#### 4.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable. The HF-INTOSC and MF-INTOSC are termed as INTOSC in this chapter.

Three bits indicate the current clock source and its status, as shown in Table 4-2. The three bits are:

- OSTS (OSCCON<3>)
- HFIOFS (OSCCON<2>)
- SOSCRUN (OSCCON2<6>)

#### TABLE 4-2:SYSTEM CLOCK INDICATOR

Main Clock Source	OSTS	HFIOFS or MFIOFS	SOSCRUN
Primary Oscillator	1	0	0
INTOSC (HF-INTOSC or MF-INTOSC)	0	1	0
Secondary Oscillator	0	0	1
MF-INTOSC or HF-INTOSC as Primary Clock Source	1	1	0
LF-INTOSC is Running or INTOSC is Not Yet Stable	0	0	0

When the OSTS bit is set, the primary clock is providing the device clock. When the HFIOFS or MFIOFS bit is set, the INTOSC output is providing a stable clock source to a divider that actually drives the device clock. When the SOSCRUN bit is set, the SOSC oscillator is providing the clock. If none of these bits are set, either the LF-INTOSC clock source is clocking the device or the INTOSC source is not yet stable.

If the internal oscillator block is configured as the primary clock source by the OSC<3:0> Configuration bits (CONFIG1H<3:0>). Then, the OSTS and HFIOFS or MFIOFS bits can be set when in PRI\_RUN or PRI\_IDLE modes. This indicates that the primary clock (INTOSC output) is generating a stable output. Entering another INTOSC power-managed mode at the same frequency would clear the OSTS bit.

- Note 1: Caution should be used when modifying a single IRCF bit. At a lower VDD, it is possible to select a higher clock speed than is supportable by that VDD. Improper device operation may result if the VDD/ Fosc specifications are violated.
  - 2: Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode or one of the Idle modes, depending on the setting of the IDLEN bit.

#### 4.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

#### 4.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

#### 4.2.1 PRI\_RUN MODE

The PRI\_RUN mode is the normal, full-power execution mode of the microcontroller. This is also the default mode upon a device Reset, unless Two-Speed Start-up is enabled. (For details, see **Section 28.4 "Two-Speed Start-up**".) In this mode, the OSTS bit is set. The HFIOFS or MFIOFS bit may be set if the internal oscillator block is the primary clock source. (See **Section 3.2 "Control Registers"**.)

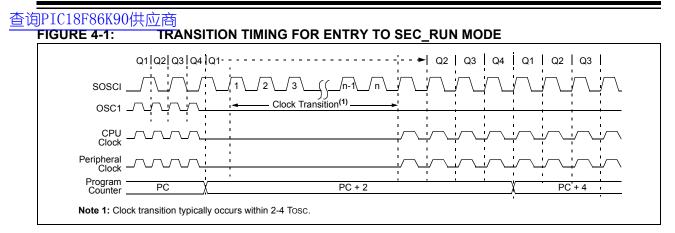
#### 4.2.2 SEC\_RUN MODE

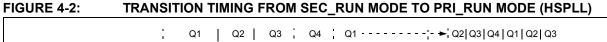
The SEC\_RUN mode is the compatible mode to the "clock-switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the SOSC oscillator. This enables lower power consumption while retaining a high-accuracy clock source.

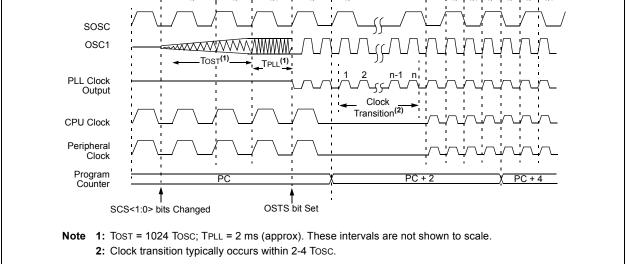
SEC\_RUN mode is entered by setting the SCS<1:0> bits to '01'. The device clock source is switched to the SOSC oscillator (see Figure 4-1), the primary oscillator is shut down, the SOSCRUN bit (OSCCON2<6>) is set and the OSTS bit is cleared.

Note:	The SOSC oscillator can be enabled by setting the SOSCGO bit (OSCCON2<3>).
	If this bit is set, the clock switch to the
	SEC_RUN mode can switch immediately
	once SCS<1:0> are set to '01'.

On transitions from SEC\_RUN mode to PRI\_RUN mode, the peripherals and CPU continue to be clocked from the SOSC oscillator while the primary clock is started. When the primary clock becomes ready, a clock switch back to the primary clock occurs (see Figure 4-2). When the clock switch is complete, the SOSCRUN bit is cleared, the OSTS bit is set and the primary clock is providing the clock. The IDLEN and SCS bits are not affected by the wake-up and the SOSC oscillator continues to run.







#### 4.2.3 RC\_RUN MODE

In RC\_RUN mode, the CPU and peripherals are clocked from the internal oscillator block using the INTOSC multiplexer. In this mode, the primary clock is shut down. When using the LF-INTOSC source, this mode provides the best power conservation of all the Run modes, while still executing code. It works well for user applications which are not highly timing-sensitive or do not require high-speed clocks at all times.

If the primary clock source is the internal oscillator block – either LF-INTOSC or INTOSC (MF-INTOSC or HF-INTOSC) – there are no distinguishable differences between the PRI\_RUN and RC\_RUN modes during execution. Entering or exiting RC\_RUN mode, however, causes a clock switch delay. Therefore, if the primary clock source is the internal oscillator block, using RC\_RUN mode is not recommended. This mode is entered by setting the SCS1 bit to '1'. To maintain software compatibility with future devices, it is recommended that the SCS0 bit also be cleared, even though the bit is ignored. When the clock source is switched to the INTOSC multiplexer (see Figure 4-3), the primary oscillator is shut down and the OSTS bit is cleared. The IRCF bits may be modified at any time to immediately change the clock speed.

Note: Caution should be used when modifying a single IRCF bit. At a lower VDD, it is possible to select a higher clock speed than is supportable by that VDD. Improper device operation may result if the VDD/ FOSC specifications are violated.

© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

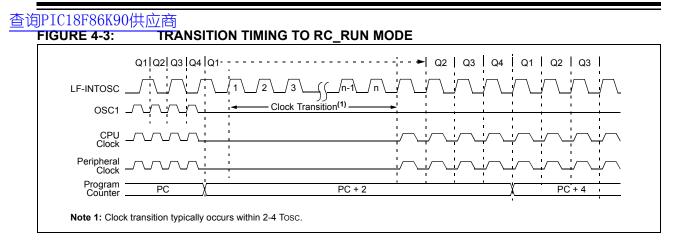
If the IRCF bits and the INTSRC bit are all clear, the INTOSC output (HF-INTOSC/MF-INTOSC) is not enabled and the HFIOFS and MFIOFS bits will remain clear. There will be no indication of the current clock source. The LF-INTOSC source is providing the device clocks. If the IRCF bits are changed from all clear (thus, enabling the INTOSC output) or if INTSRC or MFIOSEL is set, the HFIOFS or MFIOFS bit is set after the INTOSC output becomes stable. For details, see Table 4-3.

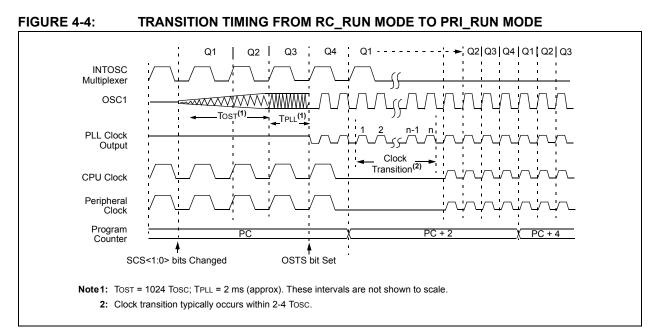
IRCF<2:0>	INTSRC	MFIOSEL	Status of MFIOFS or HFIOFS when INTOSC is Stable
000	0	x	MFIOFS = 0, HFIOFS = 0 and clock source is LF-INTOSC
000	1	0	MFIOFS = 0, HFIOFS = 1 and clock source is HF-INTOSC
000	1	1	MFIOFS = 1, HFIOFS = 0 and clock source is MF-INTOSC
Non-Zero	x	0	MFIOFS = 0, HFIOFS = 1 and clock source is HF-INTOSC
Non-Zero	x	1	MFIOFS = 1, HFIOFS = 0 and clock source is MF-INTOSC

#### TABLE 4-3: INTERNAL OSCILLATOR FREQUENCY STABILITY BITS

Clocks to the device continue while the INTOSC source stabilizes after an interval of TIOBST (parameter 39, Table 31-10).

If the IRCF bits were previously at a non-zero value, or if INTSRC was set before setting SCS1 and the INTOSC source was already stable, the HFIOFS or MFIOFS bit will remain set. On transitions from RC\_RUN mode to PRI\_RUN mode, the device continues to be clocked from the INTOSC multiplexer while the primary clock is started. When the primary clock becomes ready, a clock switch to the primary clock occurs (see Figure 4-4). When the clock switch is complete, the HFIOFS or MFIOFS bit is cleared, the OSTS bit is set and the primary clock is providing the device clock. The IDLEN and SCS bits are not affected by the switch. The LF-INTOSC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.





#### 查询PIC18F86K90供应商 4.3 Sleep Mode

The power-managed Sleep mode in the PIC18F87K90 family of devices is identical to the legacy Sleep mode offered in all other PIC devices. It is entered by clearing the IDLEN bit (the default state on device Reset) and executing the SLEEP instruction. This shuts down the selected oscillator (Figure 4-5). All clock source status bits are cleared.

Entering Sleep mode from any other mode does not require a clock switch. This is because no clocks are needed once the controller has entered Sleep. If the WDT is selected, the LF-INTOSC source will continue to operate. If the SOSC oscillator is enabled, it will also continue to run.

When a wake event occurs in Sleep mode (by interrupt, Reset or WDT time-out), the device will not be clocked until the clock source selected by the SCS<1:0> bits becomes ready (see Figure 4-6). Alternately, the device will be clocked from the internal oscillator block if either the Two-Speed Start-up or the Fail-Safe Clock Monitor is enabled (see **Section 28.0 "Special Features of the CPU"**). In either case, the OSTS bit is set when the primary clock is providing the device clocks. The IDLEN and SCS bits are not affected by the wake-up.

#### 4.4 Idle Modes

The Idle modes allow the controller's CPU to be selectively shut down while the peripherals continue to operate. Selecting a particular Idle mode allows users to further manage power consumption.

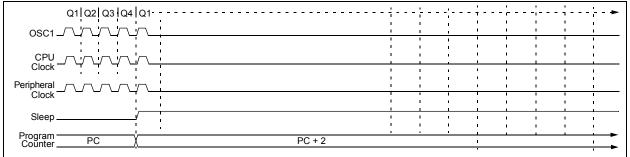
If the IDLEN bit is set to a '1' when a SLEEP instruction is executed, the peripherals will be clocked from the clock source selected using the SCS<1:0> bits. The CPU, however, will not be clocked. The clock source status bits are not affected. This approach is a quick method to switch from a given Run mode to its corresponding Idle mode.

If the WDT is selected, the LF-INTOSC source will continue to operate. If the SOSC oscillator is enabled, it will also continue to run.

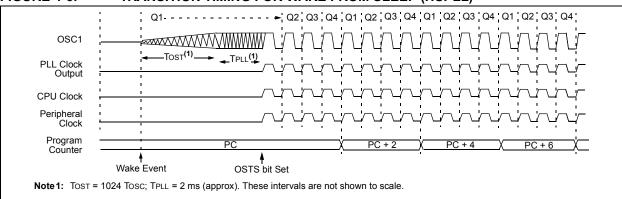
Since the CPU is not executing instructions, the only exits from any of the Idle modes are by interrupt, WDT time-out or a Reset. When a wake event occurs, CPU execution is delayed by an interval of TCSD (parameter 38, Table 31-10) while it becomes ready to execute code. When the CPU begins executing code, it resumes with the same clock source for the current Idle mode. For example, when waking from RC\_IDLE mode, the internal oscillator block will clock the CPU and peripherals (in other words, RC\_RUN mode). The IDLEN and SCS bits are not affected by the wake-up.

While in any Idle mode or Sleep mode, a WDT timeout will result in a WDT wake-up to the Run mode currently specified by the SCS<1:0> bits.

#### FIGURE 4-5: TRANSITION TIMING FOR ENTRY TO SLEEP MODE



#### FIGURE 4-6: TRANSITION TIMING FOR WAKE FROM SLEEP (HSPLL)



#### 查询PIC18F86K90供应商 4.4.1 PRI IDLE MODE

This mode is unique among the three low-power Idle modes, in that it does not disable the primary device clock. For timing-sensitive applications, this allows for the fastest resumption of device operation with its more accurate, primary clock source, since the clock source does not have to "warm-up" or transition from another oscillator.

PRI\_IDLE mode is entered from PRI\_RUN mode by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then clear the SCS bits and execute SLEEP. Although the CPU is disabled, the peripherals continue to be clocked from the primary clock source specified by the OSC<3:0> Configuration bits. The OSTS bit remains set (see Figure 4-7).

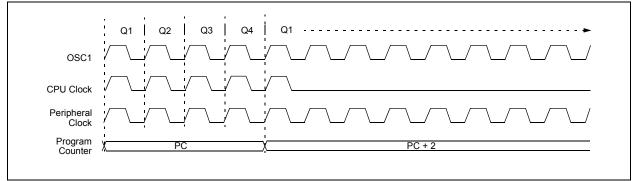
When a wake event occurs, the CPU is clocked from the primary clock source. A delay of interval, TCSD (parameter 39, Table 31-10), is required between the wake event and the start of code execution. This is required to allow the CPU to become ready to execute instructions. After the wake-up, the OSTS bit remains set. The IDLEN and SCS bits are not affected by the wake-up (see Figure 4-8).

#### 4.4.2 SEC\_IDLE MODE

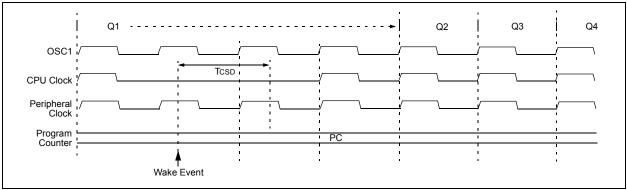
In SEC\_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the SOSC oscillator. This mode is entered from SEC\_RUN by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set the IDLEN bit first, then set the SCS<1:0> bits to '01' and execute SLEEP. When the clock source is switched to the SOSC oscillator, the primary oscillator is shut down, the OSTS bit is cleared and the SOSCRUN bit is set.

When a wake event occurs, the peripherals continue to be clocked from the SOSC oscillator. After an interval of TCSD following the wake event, the CPU begins executing code being clocked by the SOSC oscillator. The IDLEN and SCS bits are not affected by the wake-up and the SOSC oscillator continues to run (see Figure 4-8).

#### FIGURE 4-7: TRANSITION TIMING FOR ENTRY TO IDLE MODE



#### FIGURE 4-8: TRANSITION TIMING FOR WAKE FROM IDLE TO RUN MODE



#### 查询PIC18F86K90供应商 4.4.3 RC IDLE MODE

In RC\_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the internal oscillator block using the INTOSC multiplexer. This mode provides controllable power conservation during Idle periods.

From RC\_RUN, this mode is entered by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, first set IDLEN, then set the SCS1 bit and execute SLEEP. To maintain software compatibility with future devices, it is recommended that SCS0 also be cleared, though its value is ignored. The INTOSC multiplexer may be used to select a higher clock frequency by modifying the IRCF bits before executing the SLEEP instruction. When the clock source is switched to the INTOSC multiplexer, the primary oscillator is shut down and the OSTS bit is cleared.

If the IRCF bits are set to any non-zero value, or the INTSRC/MFIOSEL bit is set, the INTOSC output is enabled. The HFIOFS/MFIOFS bits become set, after the INTOSC output becomes stable after an interval of TIOBST (parameter 38, Table 31-10). (For information on the HFIOFS/MFIOFS bits, see Table 4-3.)

Clocks to the peripherals continue while the INTOSC source stabilizes. The HFIOFS/MFIOFS bits will remain set if the IRCF bits were previously at a non-zero value or if INTSRC was set before the SLEEP instruction was executed and the INTOSC source was already stable. If the IRCF bits and INTSRC are all clear, the INTOSC output will not be enabled, the HFIOFS/MFIOFS bits will remain clear and there will be no indication of the current clock source.

When a wake event occurs, the peripherals continue to be clocked from the INTOSC multiplexer. After a delay of TCSD (parameter 38, Table 31-10), following the wake event, the CPU begins executing code clocked by the INTOSC multiplexer. The IDLEN and SCS bits are not affected by the wake-up. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

#### 4.5 Selective Peripheral Module Control

Idle mode allows users to substantially reduce power consumption by stopping the CPU clock. Even so, peripheral modules still remain clocked, and thus, consume power. There may be cases where the application needs what this mode does not provide: the allocation of power resources to the CPU processing with minimal power consumption from the peripherals.

PIC18F87K90 family devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with two control bits:

- Peripheral Enable bit, generically named XXXEN Located in the respective module's main Control register
- Peripheral Module Disable (PMD) bit, generically named XXXMD – Located in one of the PMDx Control registers (PMD0, PMD1, PMD2 or PMD3)

Disabling a module by clearing its XXXEN bit disables the module's functionality, but leaves its registers available to be read and written to. This reduces power consumption, but not by as much as the second approach.

Most peripheral modules have an enable bit.

In contrast, setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, the control and status registers associated with the peripheral are also disabled, so writes to those registers have no effect and read values are invalid. Many peripheral modules have a corresponding PMD bit.

There are four PMD registers in PIC18F87K90 family devices: PMD0, PMD1, PMD2 and PMD3. These registers have bits associated with each module for disabling or enabling a particular peripheral.

#### 查询PIC18F86K90供应商 REGISTER 4-1: PMD3: PERIPHERAL MODULE DISABLE REGISTER 3 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 CCP10MD<sup>(1)</sup> CCP9MD<sup>(1)</sup> CCP8MD CCP7MD CCP6MD CCP5MD CCP4MD TMR12MD<sup>(1)</sup> bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown CCP10MD: PMD CCP10 Enable/Disable bit<sup>(1)</sup> bit 7 1 = Peripheral Module Disable (PMD) is enabled for CCP10, disabling all of its clock sources 0 = PMD is disabled for CCP10 **CCP9MD:** PMD CCP9 Enable/Disable bit<sup>(1)</sup> bit 6 1 = Peripheral Module Disable (PMD) is enabled for CCP9, disabling all of its clock sources 0 = PMD is disabled for CCP9 CCP8MD: PMD CCP8 Enable/Disable bit bit 5 1 = Peripheral Module Disable (PMD) is enabled for CCP8, disabling all of its clock sources 0 = PMD is disabled for CCP8 bit 4 CCP7MD: PMD CCP7 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP7, disabling all of its clock sources 0 = PMD is disabled for CCP7 bit 3 CCP6MD: PMD CCP6 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP6, disabling all of its clock sources 0 = PMD is disabled for CCP6 bit 2 CCP5MD: PMD CCP5 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP5, disabling all of its clock sources 0 = PMD is disabled for CCP5 bit 1 CCP4MD: PMD CCP4 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP4, disabling all of its clock sources 0 = PMD is disabled for CCP4 bit 0 TMR12MD: TMR12MD Disable bit<sup>(1)</sup> 1 = PMD is enabled and all TMR12MD clock sources are disabled

- 0 = PMD is disabled and TMR12MD is enabled
- Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

#### 查询PIC18F86K90供应商

#### **REGISTER 4-2: PMD2: PERIPHERAL MODULE DISABLE REGISTER 2**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR10MD <sup>(1)</sup>	TMR8MD	TMR7MD <sup>(1)</sup>	TMR6MD	TMR5MD	CMP3MD	CMP2MD	CMP1MD
bit 7							bit (
Legend:							
R = Readable	bit	W = Writable I	bit	U = Unimpler	nented bit, read	l as '0'	
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7		MR10MD Disa					
		al Module Disat lisabled and TM			TMR10MD clo	ck sources are	disabled
bit 6		/R8MD Disable					
Sit O		nabled and all		ck sources are	disabled		
	0 = PMD is d	lisabled and TM	IR8MD is ena	ibled			
bit 5	TMR7MD: TN	/IR7MD Disable	e bit <sup>(1)</sup>				
		nabled and all			disabled		
		lisabled and TM		bled			
bit 4		IR6MD Disable					
		nabled and all lisabled and TM			disabled		
bit 3		/R5MD Disable		iblea			
		nabled and all		ck sources are	disabled		
		lisabled and TM					
bit 2	CMP3MD: PN	<b>ND</b> Comparator	3 Enable/Dis	able bit			
		nabled for Com		abling all of its	clock sources		
		lisabled for Con	•				
bit 1		ID Comparator					
		nabled for Com		sabling all of its	clock sources		
bit 0		ID Comparator	•	able bit			
-		nabled for Corr			clock sources		
		lisabled for Con	•	Ŭ			

**Note 1:** Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

#### 查询PIC18F86K90供应商 REGISTER 4-3: PMD1: PERIPHERAL MODULE DISABLE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	CTMUMD	RTCCMD <sup>(1)</sup>	TMR4MD	TMR3MD	TMR2MD	TMR1MD	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	CTMUMD: PMD CTMU Enable/Disable bit
	<ul> <li>1 = Peripheral Module Disable (PMD) is enabled for CMTU, disabling all of its clock sources</li> <li>0 = PMD is disabled for CMTU</li> </ul>
bit 5	RTCCMD: PMD RTCC Enable/Disable bit <sup>(1)</sup>
	<ul><li>1 = PMD is enabled for RTCC, disabling all of its clock sources</li><li>0 = PMD is disabled for RTCC</li></ul>
bit 4	TMR4MD: TMR4MD Disable bit
	<ul><li>1 = PMD is enabled and all TMR4MD clock sources are disabled</li><li>0 = PMD is disabled and TMR4MD is enabled</li></ul>
bit 3	TMR3MD: TMR3MD Disable bit
	<ul><li>1 = PMD is enabled and all TMR3MD clock sources are disabled</li><li>0 = PMD is disabled and TMR3MD is enabled</li></ul>
bit 2	TMR2MD: TMR2MD Disable bit
	<ul><li>1 = PMD is enabled and all TMR2MD clock sources are disabled</li><li>0 = PMD is disabled and TMR2MD is enabled</li></ul>
bit 1	TMR1MD: TMR1MD Disable bit
	<ul><li>1 = PMD is enabled and all TMR1MD clock sources are disabled</li><li>0 = PMD is disabled and TMR1MD is enabled</li></ul>
bit 0	Unimplemented: Read as '0'

Note 1: RTCCMD can only be set to '1' after an EECON2 unlock sequence; refer to Section 17.0 "Real-Time Clock and Calendar (RTCC)" for the unlock sequence (see Example 17-1).

# 查询PIC18F86K90供应商 REGISTER 4-4: PMD0: PERIPHERAL MODULE DISABLE REGISTER 0

R/W-0	R/W-0 R/W-0		R/W-0 R/W-0		R/W-0	R/W-0	R/W-0
CCP3MD	CCP2MD	CCP2MD CCP1MD UART2MD		UART1MD	SSP2MD	SSP1MD	ADCMD
bit 7							bit 0

Legend:						
R = Readable bit		W = Writable bit	U = Unimplemented bit	, read as '0'		
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		
bit 7	1 = Perip	: PMD ECCP3 Enable/Disat pheral Module Disable (PMD is disabled for ECCP3	ole bit ) is enabled for ECCP3, disal	oling all of its clock sources		
bit 6	1 = PMD	: PMD ECCP2 Enable/Disat is enabled for ECCP2, disat is disabled for ECCP2				
bit 5	1 = PMD	: PMD ECCP1 Enable/Disat is enabled for ECCP1, disat is disabled for ECCP1				
bit 4	1 = PMD	<b>D:</b> PMD UART2 Enable/Disa is enabled for UART2, disab is disabled for UART2				
bit 3	1 = PMD	<b>D:</b> PMD UART1 Enable/Disa is enabled for UART1, disat is disabled for UART1				
bit 2	1 = PMD	: PMD MSSP2 Enable/Disab is enabled for MSSP2, disab is disabled for MSSP2				
bit 1	1 = PMD	: PMD MSSP1 Enable/Disab is enabled for MSSP1, disab is disabled for MSSP1				
bit 0	1 = PMD	PMD Analog/Digital Convert is enabled for Analog/Digita is disabled for Analog/Digita	l Converter, disabling all of its	s clock sources		

#### 查询PIC18F86K90供应商 4.6 Exiting Idle and Sleep Modes

An exit from Sleep mode or any of the Idle modes is triggered by an interrupt, a Reset or a WDT time-out. This section discusses the triggers that cause exits from power-managed modes. The clocking subsystem actions are discussed in each of the power-managed modes (see Section 4.2 "Run Modes", Section 4.3 "Sleep Mode" and Section 4.4 "Idle Modes").

#### 4.6.1 EXIT BY INTERRUPT

Any of the available interrupt sources can cause the device to exit from an Idle or Sleep mode to a Run mode. To enable this functionality, an interrupt source must be enabled by setting its enable bit in one of the INTCONx or PIEx registers. The exit sequence is initiated when the corresponding interrupt flag bit is set.

On all exits from Idle or Sleep modes by interrupt, code execution branches to the interrupt vector if the GIE/ GIEH bit (INTCON<7>) is set. Otherwise, code execution continues or resumes without branching (see **Section 10.0 "Interrupts"**).

#### 4.6.2 EXIT BY WDT TIME-OUT

A WDT time-out will cause different actions depending on which power-managed mode the device is in when the time-out occurs.

If the device is not executing code (all Idle modes and Sleep mode), the time-out will result in an exit from the power-managed mode (see Section 4.2 "Run Modes" and Section 4.3 "Sleep Mode"). If the device is executing code (all Run modes), the time-out will result in a WDT Reset (see Section 28.2 "Watchdog Timer (WDT)").

Executing a SLEEP or CLRWDT instruction clears the WDT timer and postscaler, loses the currently selected clock source (if the Fail-Safe Clock Monitor is enabled) and modifies the IRCF bits in the OSCCON register (if the internal oscillator block is the device clock source).

#### 4.6.3 EXIT BY RESET

Normally, the device is held in Reset by the Oscillator Start-up Timer (OST) until the primary clock becomes ready. At that time, the OSTS bit is set and the device begins executing code. If the internal oscillator block is the new clock source, the HFIOFS/MFIOFS bits are set instead.

The exit delay time from Reset to the start of code execution depends on both the clock sources before and after the wake-up, and the type of oscillator if the new clock source is the primary clock. Exit delays are summarized in Table 4-4.

Code execution can begin before the primary clock becomes ready. If either the Two-Speed Start-up (see Section 28.4 "Two-Speed Start-up") or Fail-Safe Clock Monitor (see Section 28.5 "Fail-Safe Clock Monitor") is enabled, the device may begin execution as soon as the Reset source has cleared. Execution is clocked by the INTOSC multiplexer driven by the internal oscillator block. Execution is clocked by the internal oscillator block. Execution is clocked by the internal oscillator block until either the primary clock becomes ready or a power-managed mode is entered before the primary clock becomes ready; the primary clock is then shut down.

#### 4.6.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. The two cases are:

- When in PRI\_IDLE mode, where the primary clock source is not stopped
- When the primary clock source is not any of the LP, XT, HS or HSPLL modes

In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI\_IDLE), or normally does not require an oscillator start-up delay (RC, EC and INTIO Oscillator modes). However, a fixed delay of interval, TCSD, following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

#### 查询PIC18F86K90供应商

#### 4.7 Ultra Low-Power Wake-up

The Ultra Low-Power Wake-up (ULPWU) on pin, RA0, allows a slow falling voltage to generate an interrupt without excess current consumption.

To use this feature:

- 1. Charge the capacitor on RA0 by configuring the RA0 pin to an output and setting it to '1'.
- 2. Stop charging the capacitor by configuring RA0 as an input.
- 3. Discharge the capacitor by setting the ULPEN and ULPSINK bits in the WDTCON register.
- 4. Configure Sleep mode.
- 5. Enter Sleep mode.

When the voltage on RA0 drops below VIL, the device wakes up and executes the next instruction.

This feature provides a low-power technique for periodically waking up the device from Sleep mode.

The time-out is dependent on the discharge time of the RC circuit on RA0.

When the ULPWU module wakes the device from Sleep mode, the ULPLVL bit (WDTCON<5>) is set. Software can check this bit upon wake-up to determine the wake-up source.

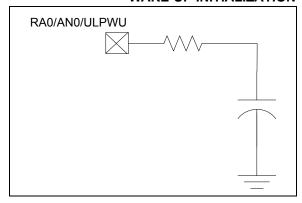
See Example 4-1 for initializing the ULPWU module.

#### EXAMPLE 4-1: ULTRA LOW-POWER WAKE-UP INITIALIZATION

```
//Charge the capacitor on RAO
       TRISAbits.TRISA0 = 0;
PORTAbits.RA0 = 1;
for(i = 0; i < 10000; i++) Nop();</pre>
       //Stop Charging the capacitor
       //on RAO
       TRISAbits.TRISA0 = 1;
       //Enable the Ultra Low Power
       //Wakeup module and allow
       //capacitor discharge
       WDTCONbits ULPEN = 1;
WDTCONbits.ULPSINK = 1;
       //For Sleep
OSCCONbits.IDLEN = 0;
       //Enter Sleep Mode
       11
Sleep();
       //for sleep, execution will
       //resume here
```

A series resistor, between RA0 and the external capacitor, provides overcurrent protection for the RA0/AN0/ ULPWU pin and enables software calibration of the time-out (see Figure 4-9).

FIGURE 4-9: ULTRA LOW-POWER WAKE-UP INITIALIZATION



A timer can be used to measure the charge time and discharge time of the capacitor. The charge time can then be adjusted to provide the desired delay in Sleep. This technique compensates for the affects of temperature, voltage and component accuracy. The peripheral can also be configured as a simple programmable Low-Voltage Detect (LVD) or temperature sensor.

Note:	For more information, see AN 879, "Using								
	the Microchip Ultra Low-Power Wake-up								
	Module" (DS00879).								

#### 查询PIC18F86K90供应商

#### TABLE 4-4: EXIT DELAY ON WAKE-UP BY RESET FROM SLEEP MODE OR ANY IDLE MODE (BY CLOCK SOURCES)

Power-Managed Mode	Clock Source <sup>(5)</sup>	Exit Delay	Clock Ready Status Bits		
	LP, XT, HS				
	HSPLL		OSTS		
	EC, RC	TCSD <sup>(1)</sup>			
PRI_IDLE mode	HF-INTOSC <sup>(2)</sup>		HFIOFS		
	MF-INTOSC <sup>(2)</sup>		MFIOFS		
	LF-INTOSC		None		
SEC_IDLE mode	SOSC	TCSD <sup>(1)</sup>	SOSCRUN		
	HF-INTOSC <sup>(2)</sup>		HFIOFS		
RC_IDLE mode	MF-INTOSC <sup>(2)</sup>	Tcsp <sup>(1)</sup>	MFIOFS		
	LF-INTOSC		None		
	LP, XT, HS	Tost <sup>(3)</sup>			
	HSPLL	Tost + t <sub>rc</sub> <sup>(3)</sup>	OSTS		
	EC, RC	TCSD <sup>(1)</sup>			
Sleep mode	HF-INTOSC <sup>(2)</sup>		HFIOFS		
	MF-INTOSC <sup>(2)</sup>	TIOBST <sup>(4)</sup>	MFIOFS		
	LF-INTOSC		None		

**Note 1:** TCSD (parameter 38, Table 31-10) is a required delay when waking from Sleep and all Idle modes, and runs concurrently with any other required delays (see **Section 4.4 "Idle Modes"**).

2: Includes postscaler derived frequencies. On Reset, INTOSC defaults to HF-INTOSC at 8 MHz.

**3:** TOST is the Oscillator Start-up Timer (parameter 32, Table 31-10). TRC is the PLL Lock-out Timer (parameter F12, Table 31-7); it is also designated as TPLL.

4: Execution continues during TIOBST (parameter 39, Table 31-10), the INTOSC stabilization period.

**5:** The clock source is dependent upon the settings of the SCS (OSCCON<1:0>), IRCF (OSCCON<6:4>) and FOSC (CONFIG1H<3:0>) bits.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商

#### 5.0 RESET

The PIC18F87K90 family of devices differentiates between various kinds of Reset:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during power-managed modes
- d) Watchdog Timer (WDT) Reset (during execution)
- e) Configuration Mismatch (CM) Reset
- f) Brown-out Reset (BOR)
- g) RESET Instruction
- h) Stack Full Reset
- i) Stack Underflow Reset

This section discusses Resets generated by MCLR, POR and BOR, and covers the operation of the various start-up timers. Stack Reset events are covered in Section 6.1.3.4 "Stack Full and Underflow Resets". WDT Resets are covered in Section 28.2 "Watchdog Timer (WDT)". A simplified block diagram of the on-chip Reset circuit is shown in Figure 5-1.

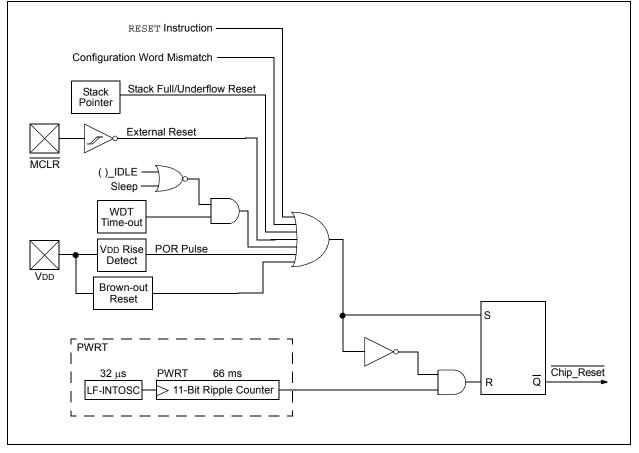
#### 5.1 RCON Register

Device Reset events are tracked through the RCON register (Register 5-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be set by the event and must be cleared by the application after the event.

The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 5.7** "**Reset State of Registers**".

The RCON register also has a control bit for setting interrupt priority (IPEN). Interrupt priority is discussed in **Section 10.0 "Interrupts"**.

#### FIGURE 5-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



#### 查询PIC18F86K90供应商

#### REGISTER 5-1: RCON: RESET CONTROL REGISTER

R/W-0	R/W-1	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0	
IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	
bit 7							bit	
Legend:								
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, rea	d as '0'		
-n = Value at POR		'1' = Bit is set		'0' = Bit is cle	x = Bit is unkr	is unknown		
bit 7		riority levels or	n interrupts	PIC16CXXX Co	empatibility mo	de)		
bit 6	<b>SBOREN:</b> BC <u>If BOREN&lt;1:(</u> 1 = BOR is c 0 = BOR is c <u>If BOREN&lt;1:(</u>	OR Software E <u>)&gt; = 01:</u> enabled	nable bit			,		
bit 5	<ul> <li>CM: Configuration Mismatch Flag bit</li> <li>1 = A Configuration Mismatch Reset has not occurred</li> <li>0 = A Configuration Mismatch Reset has occurred (must be set in software after a Configuration Mismatch Reset occurs)</li> </ul>							
bit 4	<ul> <li>RI: RESET Instruction Flag bit</li> <li>1 = The RESET instruction was not executed (set by firmware only)</li> <li>0 = The RESET instruction was executed, causing a device Reset (must be set in software after a Brown-out Reset occurs)</li> </ul>							
bit 3	TO: Watchdog Time-out Flag bit 1 = Set by power-up, CLRWDT instruction or SLEEP instruction 0 = A WDT time-out has occurred							
bit 2	<ul> <li>PD: Power-Down Detection Flag bit</li> <li>1 = Set by power-up or by the CLRWDT instruction</li> <li>0 = Set by execution of the SLEEP instruction</li> </ul>							
bit 1	<ul> <li>POR: Power-on Reset Status bit</li> <li>1 = A Power-on Reset has not occurred (set by firmware only)</li> <li>0 = A Power-on Reset has occurred (must be set in software after a Power-on Reset occurs)</li> </ul>							
bit 0	<ul> <li>BOR: Brown-out Reset Status bit</li> <li>1 = A Brown-out Reset has not occurred (set by firmware only)</li> <li>0 = A Brown-out Reset has occurred (must be set in software after a Brown-out Reset occurs)</li> </ul>							

Note 1: It is recommended that the POR bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.

2: Brown-out Reset is said to have occurred when BOR is '0' and POR is '1' (assuming that POR was set to '1' by software immediately after a Power-on Reset).

### 查询PIC18F86K90供应商

#### 5.2 Master Clear (MCLR)

The  $\overline{\text{MCLR}}$  pin provides a method for triggering a hard external Reset of the device. A Reset is generated by holding the pin low. PIC18 extended microcontroller devices have a noise filter in the  $\overline{\text{MCLR}}$  Reset path which detects and ignores small pulses.

The  $\overline{\text{MCLR}}$  pin is not driven low by any internal Resets, including the WDT.

#### 5.3 Power-on Reset (POR)

A Power-on Reset condition is generated on-chip whenever VDD rises above a certain threshold. This allows the device to start in the initialized state when VDD is adequate for operation.

To take advantage of the POR circuitry, tie the  $\overline{\text{MCLR}}$  pin through a resistor (1 k $\Omega$  to 10 k $\Omega$ ) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for VDD is specified (parameter D004). For a slow rise time, see Figure 5-2.

When the device starts normal operation (exiting the Reset condition), device operating parameters (such as voltage, frequency and temperature) must be met to ensure operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

Power-on Reset events are captured by the  $\overrightarrow{POR}$  bit (RCON<1>). The state of the bit is set to '0' whenever a Power-on Reset occurs and does not change for any other Reset event.  $\overrightarrow{POR}$  is not reset to '1' by any hardware event. To capture multiple events, the user manually resets the bit to '1' in software following any Power-on Reset.

#### 5.4 Brown-out Reset (BOR)

The PIC18F87K90 family has four BOR modes:

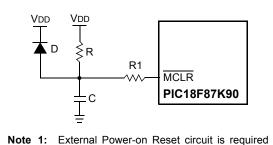
- High-Power BOR
- Medium Power BOR
- Low-Power BOR
- Zero-Power BOR

Each power mode is selected by the BORPWR<1:0> setting (CONFIG2L<6:5>). For low, medium and highpower BOR, the module monitors the VDD depending on the BORV<1:0> setting (CONFIG1L<3:2>). A BOR event re-arms the Power-on Reset. It also causes a Reset depending on which of the trip levels has been set: 1.8V, 2V, 2.7V or 3V. The typical ( $\Delta$ IBOR) for the Low and Medium Power BOR will be 0.75 µA and 3 µA. In Zero-Power BOR (ZPBORMV), the module monitors the VDD voltage and re-arms the POR at about 2V. ZPBORMV does not cause a Reset, but re-arms the POR.

The BOR accuracy varies with its power level. The lower the power setting, the less accurate the BOR trip levels are. So, the high-power BOR has the highest accuracy and the low-power has the lowest accuracy. The trip levels (BVDD, parameter D005), current consumption (Section 31.2 "DC Characteristics: Power-Down and Supply Current PIC18F87K90 Family (Industrial)") and time required below BVDD (TBOR, parameter 35) can all be found in Section 31.0 "Electrical Characteristics"

### FIGURE 5-2:

#### EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- Note 1: External Power-on Reset circuit is required only if the VDD power-up slope is too slow. The diode, D, helps discharge the capacitor quickly when VDD powers down.
  - 2:  $R < 40 \text{ k}\Omega$  is recommended to make sure that the voltage drop across R does not violate the device's electrical specification.

#### 5.4.1 DETECTING BOR

The BOR bit always resets to '0' on any Brown-out Reset or Power-on Reset event. This makes it difficult to determine if a Brown-out Reset event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR bit is reset to '1' in software immediately after any Power-on Reset event. If BOR is '0' while POR is '1', it can be reliably assumed that a Brown-out Reset event has occurred.

LP-BOR cannot be detected with the  $\overline{\text{BOR}}$  bit in the RCON register. LP-BOR can rearm the  $\overline{\text{POR}}$  and can cause a Power-on Reset.

#### 查询PIC18F86K90供应商

#### 5.5 Configuration Mismatch (CM)

The Configuration Mismatch (CM) Reset is designed to detect, and attempt to recover from, random, memory corrupting events. These include Electrostatic Discharge (ESD) events that can cause widespread, single bit changes throughout the device and result in catastrophic failure.

In PIC18F87K90 family Flash devices, the device Configuration registers (located in the configuration memory space) are continuously monitored during operation by comparing their values to complimentary shadow registers. If a mismatch is detected between the two sets of registers, a CM Reset automatically occurs. These events are captured by the CM bit (RCON<5>). The state of the bit is set to '0' whenever a CM event occurs and does not change for any other Reset event.

A CM Reset behaves similarly to a Master Clear Reset, RESET instruction, WDT time-out or Stack Event Reset. As with all hard and power Reset events, the device Configuration Words are reloaded from the Flash Configuration Words in program memory as the device restarts.

#### 5.6 Power-up Timer (PWRT)

PIC18F87K90 family devices incorporate an on-chip Power-up Timer (PWRT) to help regulate the Power-on Reset process. The PWRT is enabled by setting the PWRTEN bit (CONFIG2L<0>). The main function is to ensure that the device voltage is stable before code is executed.

The Power-up Timer (PWRT) of the PIC18F87K90 family devices is a 13-bit counter that uses the LF-INTOSC source as the clock input. This yields an approximate time interval of 2,048 x 32  $\mu$ s = 66 ms. While the PWRT is counting, the device is held in Reset.

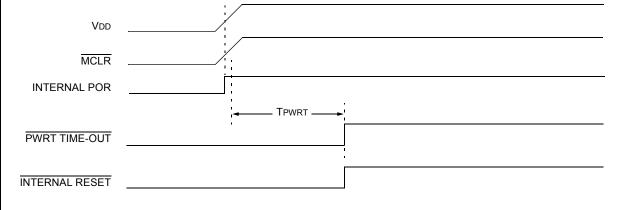
The power-up time delay depends on the LF-INTOSC clock and will vary from chip-to-chip due to temperature and process variation. See DC parameter 33 for details.

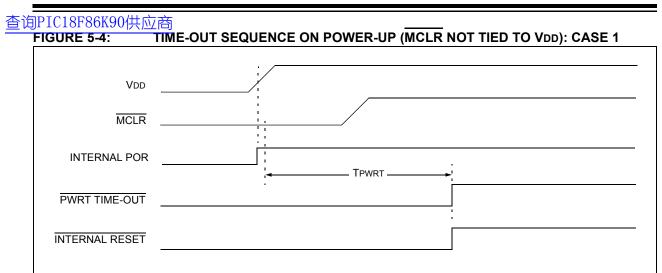
#### 5.6.1 TIME-OUT SEQUENCE

If enabled, the PWRT time-out is invoked after the POR pulse has cleared. The total time-out will vary based on the status of the PWRT. Figure 5-3, Figure 5-4, Figure 5-5 and Figure 5-6 all depict time-out sequences on power-up with the Power-up Timer enabled.

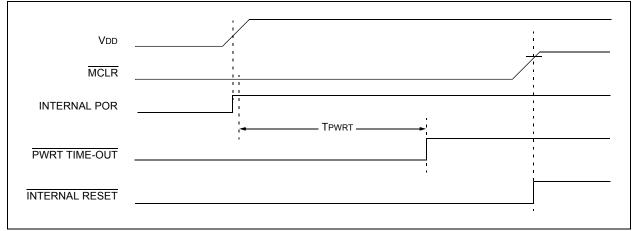
Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, the PWRT will expire. Bringing MCLR high will begin execution immediately (Figure 5-5). This is useful for testing purposes, or for synchronizing more than one PIC18 device operating in parallel.

# FIGURE 5-3: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD, VDD RISE < TPWRT)

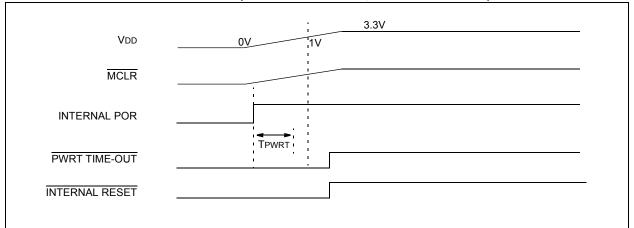




#### FIGURE 5-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2



#### FIGURE 5-6: SLOW RISE TIME (MCLR TIED TO VDD, VDD RISE > TPWRT)



### 查询PIC18F86K90供应商

#### 5.7 Reset State of Registers

Most registers are unaffected by a Reset. Their status is unknown on POR and unchanged by all other Resets. The other registers are forced to a "Reset state" depending on the type of Reset that occurred.

Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register ( $\overline{CM}$ ,  $\overline{RI}$ ,  $\overline{TO}$ ,  $\overline{PD}$ ,  $\overline{POR}$  and  $\overline{BOR}$ ) are set or cleared differently in

different Reset situations, as indicated in Table 5-1. These bits are used in software to determine the nature of the Reset.

Table 5-2 describes the Reset states for all of the Special Function Registers. These are categorized by Power-on and Brown-out Resets, Master Clear and WDT Resets, and WDT wake-ups.

### TABLE 5-1:STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR<br/>RCON REGISTER

Condition	Program	RCON Register						STKPTR Register	
Condition	Counter <sup>(1)</sup>	CM	RI	то	PD	POR	BOR	STKFUL	STKUNF
Power-on Reset	0000h	1	1	1	1	0	0	0	0
RESET instruction	0000h	u	0	u	u	u	u	u	u
Brown-out Reset	0000h	1	1	1	1	u	0	u	u
Configuration Mismatch Reset	0000h	0	u	u	u	u	u	u	u
MCLR Reset during power-managed Run modes	0000h	u	u	1	u	u	u	u	u
MCLR Reset during power- managed Idle modes and Sleep mode	0000h	u	u	1	0	u	u	u	u
MCLR Reset during full-power execution	0000h	u	u	u	u	u	u	u	u
Stack Full Reset (STVREN = 1)	0000h	u	u	u	u	u	u	1	u
Stack Underflow Reset (STVREN = 1)	0000h	u	u	u	u	u	u	u	1
Stack Underflow Error (not an actual Reset, STVREN = 0)	0000h	u	u	u	u	u	u	u	1
WDT time-out during full-power or power-managed Run modes	0000h	u	u	0	u	u	u	u	u
WDT time-out during power-managed Idle or Sleep modes	PC + 2	u	u	0	0	u	u	u	u
Interrupt exit from power-managed modes	PC + 2	u	u	u	0	u	u	u	u

Legend: u = unchanged

**Note 1:** When the wake-up is due to an interrupt and the GIEH or GIEL bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

### 查询PIC18F86K90供应商

### TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt	
TOSU	PIC18F6XK90	PIC18F8XK90	0 0000	0 0000	0 uuuu <sup>(1)</sup>	
TOSH	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu <sup>(1)</sup>	
TOSL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu <b>(1)</b>	
STKPTR	PIC18F6XK90	PIC18F8XK90	00-0 0000	uu-0 0000	uu-u uuuu <sup>(1)</sup>	
PCLATU	PIC18F6XK90	PIC18F8XK90	0 0000	0 0000	u uuuu	
PCLATH	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
PCL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	PC + 2 <sup>(2)</sup>	
TBLPTRU	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu	
TBLPTRH	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
TBLPTRL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
TABLAT	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
PRODH	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
PRODL	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	սսսս սսսս	uuuu uuuu	
INTCON	PIC18F6XK90	PIC18F8XK90	x000 000x	0000 000u	uuuu uuuu <sup>(3)</sup>	
INTCON2	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu <b>(3)</b>	
INTCON3	PIC18F6XK90	PIC18F8XK90	1100 0000	1100 0000	uuuu uuuu <sup>(3)</sup>	
INDF0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
POSTINC0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
POSTDEC0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
PREINC0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
PLUSW0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
FSR0H	PIC18F6XK90	PIC18F8XK90	xxx	uuuu	uuuu	
FSR0L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	uuuu uuuu	
WREG	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	uuuu uuuu	
INDF1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
POSTINC1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
POSTDEC1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
PREINC1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
PLUSW1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A	
FSR1H	PIC18F6XK90	PIC18F8XK90	xxxx	uuuu	uuuu	
FSR1L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu	
BSR	PIC18F6XK90	PIC18F8XK90	0000	0000	uuuu	

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

### 查询PIC18F86K90供应商

# TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicabl	e Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
INDF2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTINC2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTDEC2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PREINC2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PLUSW2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
FSR2H	PIC18F6XK90	PIC18F8XK90	xxxx	uuuu	uuuu
FSR2L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
STATUS	PIC18F6XK90	PIC18F8XK90	x xxxx	u uuuu	u uuuu
TMR0H	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
TMR0L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
TOCON	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
SPBRGH1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
OSCCON	PIC18F6XK90	PIC18F8XK90	0110 q000	0110 q000	uuuu quuu
IPR5	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
WDTCON	PIC18F6XK90	PIC18F8XK90	0-x0 -000	0-x0 -000	u-uu -uuu
RCON	PIC18F6XK90	PIC18F8XK90	0111 11qq	0uqq qquu	uuuu qquu
TMR1H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
TMR1L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
T1CON	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
TMR2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR2	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
T2CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
SSP1BUF	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
SSP1ADD	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP1STAT	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP1CON1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP1CON2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ADRESH	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
ADRESL	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
ADCON0	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
ADCON1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ADCON2	PIC18F6XK90	PIC18F8XK90	0-00 0000	0-00 0000	u-uu uuuu
ECCP1AS	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- **2:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 5-1 for Reset value for specific condition.

#### 查询PIC18F86K90供应商 TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

TABLE 5-2:	INITIALIZATION CONL	TIONS FOR ALL RE		
Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
ECCP1DEL	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
CCPR1H	PIC18F6XK90 PIC18F8XK9	0 xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	PIC18F6XK90 PIC18F8XK9	0 xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
PIR5	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
PIE5	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu <sup>(1)</sup>
IPR4	PIC18F6XK90 PIC18F8XK9	0 1111 1111	1111 1111	uuuu uuuu
PIR4	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu <sup>(1)</sup>
PIE4	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
CVRCON	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
CMSTAT	PIC18F6XK90 PIC18F8XK9	0 111	111	uuu
TMR3H	PIC18F6XK90 PIC18F8XK9	0 xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	PIC18F6XK90 PIC18F8XK9	0 xxxx xxxx	uuuu uuuu	uuuu uuuu
T3CON	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0x00	00x0 0x00
T3GCON	PIC18F6XK90 PIC18F8XK9	00x0 0000 <b>0</b>	0000 0x00	uuuu uuuu
SPBRG1	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
RCREG1	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
TXREG1	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
TXSTA1	PIC18F6XK90 PIC18F8XK9	0 0000 0010	0000 0010	uuuu uuuu
RCSTA1	PIC18F6XK90 PIC18F8XK9	00 0000 000x	0000 000x	uuuu uuuu
T1GCON	PIC18F6XK90 PIC18F8XK9	00x0 0000 <b>0</b>	0000 0x00	uuuu uuuu
IPR6	PIC18F6XK90 PIC18F8XK9	001 -111	1 -111	u -uuu
HLVDCON	PIC18F6XK90 PIC18F8XK9	0 0000 0101	0000 0101	uuuu uuuu
PIR6	PIC18F6XK90 PIC18F8XK9	000 -000	0 -000	u -uuu
IPR3	PIC18F6XK90 PIC18F8XK9	0 1111 1111	1111 1111	սսսս սսսս
PIR3	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
PIE3	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu
IPR2	PIC18F6XK90 PIC18F8XK9	0 1-11 1111	1-11 1111	u-uu uuuu
PIR2	PIC18F6XK90 PIC18F8XK9	00 0-00 0000	0-00 0000	u-uu uuuu
PIE2	PIC18F6XK90 PIC18F8XK9	0000000000	0-00 0000	u-uu uuuu
IPR1	PIC18F6XK90 PIC18F8XK9	0 -111 1111	-111 1111	-uuu uuuu
PIR1	PIC18F6XK90 PIC18F8XK9	00 -000 0000	-000 0000	-uuu uuuu
PIE1	PIC18F6XK90 PIC18F8XK9	00 -000 0000	-000 0000	-uuu uuuu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- **4:** See Table 5-1 for Reset value for specific condition.

### 查询PIC18F86K90供应商

# TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

TABLE 5-2:		IONS FOR ALL RE	MCLR Resets,	
Register	Applicable Devices	Power-on Reset, Brown-out Reset	WCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
PSTR1CON	PIC18F6XK90 PIC18F8XK90	00-0 0001	00-0 0001	uu-u uuuu
OSCTUNE	PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
TRISJ	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
TRISH	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
TRISG	PIC18F6XK90 PIC18F8XK90	1 1111	1 1111	u uuuu
TRISF	PIC18F6XK90 PIC18F8XK90	1111 111-	1111 111-	uuuu uuu-
TRISE	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
TRISD	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
TRISC	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
TRISB	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
TRISA	PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
LATJ	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATH	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATG	PIC18F6XK90 PIC18F8XK90	x xxxx	u uuuu	u uuuu
LATF	PIC18F6XK90 PIC18F8XK90	xxxx xxx-	uuuu uuu-	uuuu uuu-
LATE	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATD	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTJ	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	xxxx xxxx	uuuu uuuu
PORTH	PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PORTG	PIC18F6XK90 PIC18F8XK90	x0 000x	x0 000x	uu uuuu
PORTF	PIC18F6XK90 PIC18F8XK90	0000 000-	0000 000-	uuuu uuu-
PORTE	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	xxxx xxxx	uuuu uuuu
PORTD	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	xxxx xxxx	uuuu uuuu
PORTC	PIC18F6XK90 PIC18F8XK90	xxxx xxxx	xxxx xxxx	uuuu uuuu
PORTB	PIC18F6XK90 PIC18F8XK90	XXXX XXXX	xxxx xxxx	uuuu uuuu
PORTA	PIC18F6XK90 PIC18F8XK90	xx0x 0000	uu0u 0000	uuuu uuuu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

#### 查询PIC18F86K90供应商 TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

TABLE 5-2:			IONS FOR ALL RE	GISTERS (CONTINU	
Register	Applicable [	Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
EECON1	PIC18F6XK90 PI	IC18F8XK90	xx-0 x000	uu-0 u000	uu-u uuuu
EECON2	PIC18F6XK90 PI	IC18F8XK90	0000 0000	0000 0000	0000 0000
LCDDATA23	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA22	PIC18F6XK90 PI	IC18F8XK90	x	u	u
LCDDATA22	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA21	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA20	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA19	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA18	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA17	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA16	PIC18F6XK90 P	IC18F8XJ90	x	u	u
LCDDATA16	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA15	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA14	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA13	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA12	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA11	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA10	PIC18F6XK90 PI	IC18F8XK90	x	u	u
LCDDATA10	PIC18F6XK90 P	IC18F8XJ90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA9	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA8	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA7	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA6	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA5	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA4	PIC18F6XK90 P	IC18F8XJ90	x	u	u
LCDDATA4	PIC18F6XK90 PI	IC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA3	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA2	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA1	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA0	PIC18F6XK90 PI	IC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
BAUDCON1	PIC18F6XK90 PI	IC18F8XK90	0100 0-00	0100 0-00	uuuu u-uu
OSCCON2	PIC18F6XK90 PI	IC18F8XK90	-0 0-x0	-0 0-u0	-u u-uu
EEADRH	PIC18F6XK90 PI	IC18F8XK90	00	00	uu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- **4:** See Table 5-1 for Reset value for specific condition.

### 查询PIC18F86K90供应商

# TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicabl		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
EEADR	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
EEDATA	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PIE6	PIC18F6XK90	PIC18F8XK90	0 -000	0 -000	u -uuu
RTCCFG	PIC18F6XK90	PIC18F8XK90	0-00 0000	u-uu uuuu	u-uu uuuu
RTCCAL	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
RTCVALH	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
RTCVALL	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
ALRMCFG	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
ALRMRPT	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
ALRMVALH	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
ALRMVALL	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CTMUCONH	PIC18F6XK90	PIC18F8XK90	0-00 0000	0-00 0000	u-uu uuuu
CTMUCONL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 00xx	uuuu uuuu
CTMUICON	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CM1CON	PIC18F6XK90	PIC18F8XK90	0001 1111	0001 1111	uuuu uuuu
PADCFG1	PIC18F6XK90	PIC18F8XK90	00000-	uuuuu-	uuuuu-
ECCP2AS	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ECCP2DEL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CCPR2H	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR2L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ECCP3AS	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ECCP3DEL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CCPR3H	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR3L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP3CON	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CCPR8H	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR8L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP8CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR9H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR9L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP9CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR10H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	uuuu uuuu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

**2:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

#### 查询PIC18F86K90供应商 TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register         Applicable Devices         Brown-out Reset         Reset Instruction, Stack Resets, CM Resets         or Interrupt           CCPR10L         PIC18F6XK90         PIC18F8XK90        00<0000        00<0000        uu uuuu           CCPR10L         PIC18F6XK90         PIC18F8XK90        00<0000        uu uuuu         uuu	TABLE 5-2:	INITIALIZATION CO	NDITIONS FOR ALL R	EGISTERS (CONTINU	
CCP10CON         PIC18F6XK90         PIC18F8XK90        00         0000        uu uuuu           TMR7H         PIC18F6XK90         PIC18F8XK90         xxxx xxxx         uuuu uuuu         uuuu uuuu         uuuu uuuu           TMR7L         PIC18F6XK90         PIC18F8XK90         xxxx xxxx         uuuu uuuu         uuuu uuuu         uuuu uuuu           T7CON         PIC18F6XK90         PIC18F8XK90         0000         0000         0x00         uuuu uuuu         uuuu uuuu           TMR6         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         uuuu uuuu         uuuu uuuu           TR6         PIC18F6XK90         PIC18F8XK90         1111         1111         1111         uuuu uuuu         uuuu uuuu           TR76         PIC18F6XK90         PIC18F8XK90         -000         0000         -000         0000         -uuu uuuu           TR8         PIC18F6XK90         PIC18F8XK90         0000         0000         -uuu uuuu         TMUuuuuuuuuuuuuuuuuuuuuuuuuuuuuuuuuuuuu	Register	Applicable Devices	,	WDT Reset, RESET Instruction, Stack Resets,	Wake-up via WDT or Interrupt
TMR7H         PIC18F6XK90         PIC18F8XK90         xxxx xxxx         uuuu uuuu         uuuu uuuu           TMR7L         PIC18F6XK90         PIC18F8XK90         xxxx xxxx         uuuu uuuu         uuuu uuuu           T7CON         PIC18F6XK90         PIC18F8XK90         0000 0000         uuuu uuuu         uuuu uuuu           T7GCON         PIC18F6XK90         PIC18F8XK90         0000 0x00         0000 0x00         uuuu uuuu           TMR6         PIC18F6XK90         PIC18F8XK90         0000 0x00         0000         uuuu uuuu           TMR6         PIC18F6XK90         PIC18F8XK90         1111         1111         1111         uuuu uuuu           TMR8         PIC18F6XK90         PIC18F8XK90         0000         0000         -000         0000         -uuu uuuu           TMR8         PIC18F6XK90         PIC18F8XK90         1111         1111         1111         1111         uuuu uuuu         uuuu	CCPR10L	PIC18F6XK90 PIC18F8>	K90 xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR7L         PIC18F6XK90         PIC18F8XK90         xxxx         uuuu uuuu         uuuu uuuu           T7CON         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         0000         uuuu uuuu         uuuu uuuu           T7GON         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         0000         uuuu uuuu         uuuu uuuu         uuuu	CCP10CON	PIC18F6XK90 PIC18F8>	<b>K90</b> 00 0000	00 0000	uu uuuu
T7CON         PIC18F6XK90         PIC18F8XK90         0000         uuuu         uuuu <thuuu< th=""> <thuuu< th="">         uuuu</thuuu<></thuuu<>	TMR7H	PIC18F6XK90 PIC18F8>	K90 xxxx xxxx	uuuu uuuu	uuuu uuuu
TYGCON         PIC18F6XK90         PIC18F6XK90 <t< td=""><td>TMR7L</td><td>PIC18F6XK90 PIC18F8&gt;</td><td>K90 xxxx xxxx</td><td>uuuu uuuu</td><td>uuuu uuuu</td></t<>	TMR7L	PIC18F6XK90 PIC18F8>	K90 xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR6         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         uuuu         uuuu <thuuu< th=""> <thuuu< th="">         uuuu</thuuu<></thuuu<>	T7CON	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	uuuu uuuu	uuuu -uuu
PR6         PIC18F6XK90         PIC18F8XK90         11111 <td>T7GCON</td> <td>PIC18F6XK90 PIC18F8&gt;</td> <td><b>K90</b> 0000 0x00</td> <td>0000 0x00</td> <td>uuuu uuuu</td>	T7GCON	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0x00	0000 0x00	uuuu uuuu
T6CON         PIC18F6XK90         PIC18F8XK90         -000         0000         -000         0000         -uuu         uuuu           TMR8         PIC18F6XK90         PIC18F6XK90         0000         0000         0000         0000         uuuu	TMR6	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	0000 0000	uuuu uuuu
TMR8         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         uuuu         uuuu <thuuuu< th=""> <thuuuu< th="">         uuuu<td>PR6</td><td>PIC18F6XK90 PIC18F8&gt;</td><td><b>K90</b> 1111 1111</td><td>1111 1111</td><td>uuuu uuuu</td></thuuuu<></thuuuu<>	PR6	PIC18F6XK90 PIC18F8>	<b>K90</b> 1111 1111	1111 1111	uuuu uuuu
PR8         PIC18F6XK90         PIC18F8XK90         1111 <th1111< th=""> <th11111< th="">         1111111<!--</td--><td>T6CON</td><td>PIC18F6XK90 PIC18F8&gt;</td><td><b>K90</b> -000 0000</td><td>-000 0000</td><td>-uuu uuuu</td></th11111<></th1111<>	T6CON	PIC18F6XK90 PIC18F8>	<b>K90</b> -000 0000	-000 0000	-uuu uuuu
TBCON         PIC18F6XK90         PIC18F8XK90         -000         0000         -000         0000         -uuu uuuu           TMR10         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         0000         uuuu uuuu           PR10         PIC18F6XK90         PIC18F8XK90         1111         1111         1111         1111         uuuu uuuu           TMR10         PIC18F6XK90         PIC18F8XK90         -000         0000         -000         0000         -uuu uuuu           TMR12         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         -uuu uuuu         uuuu uuuu           T12CON         PIC18F6XK90         PIC18F8XK90         1111         1111         1111         1111         uuuu uuuu         uuuu uuuu         uuuu	TMR8	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	0000 0000	uuuu uuuu
TMR10         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         0000         uuuu uuuu           PR10         PIC18F6XK90         PIC18F8XK90         11111         11111         1111	PR8	PIC18F6XK90 PIC18F8>	<b>K90</b> 1111 1111	1111 1111	uuuu uuuu
PR10         PIC18F6XK90         PIC18F8XK90         11111 </td <td>T8CON</td> <td>PIC18F6XK90 PIC18F8&gt;</td> <td><b>K90</b> -000 0000</td> <td>-000 0000</td> <td>-uuu uuuu</td>	T8CON	PIC18F6XK90 PIC18F8>	<b>K90</b> -000 0000	-000 0000	-uuu uuuu
T10CON         PIC18F6XK90         PIC18F8XK90         -000         0000         -000         0000         -uuu uuuu           TMR12         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         0000         uuuu uuuu           PR12         PIC18F6XK90         PIC18F8XK90         1111         1111         1111         1111         uuuu uuuu           T12CON         PIC18F6XK90         PIC18F8XK90         -000         0000         -000         0000         -uuu uuuu           CM2CON         PIC18F6XK90         PIC18F8XK90         0001         1111         0001         1111         uuuu uuuu         uuuu uuuu         CM3CON         PIC18F6XK90         PIC18F8XK90         0001         1111         0001         1111         uuuu uuuu         uuuu uuuu         CCPTMRS0         PIC18F6XK90         PIC18F8XK90         0001         1111         uuuu uuuu         uuuu uuuu         uuuu	TMR10	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	0000 0000	uuuu uuuu
TMR12         PIC18F6XK90         PIC18F8XK90         0000         0000         0000         0000         uuuu         uuuu </td <td>PR10</td> <td>PIC18F6XK90 PIC18F8&gt;</td> <td><b>K90</b> 1111 1111</td> <td>1111 1111</td> <td>uuuu uuuu</td>	PR10	PIC18F6XK90 PIC18F8>	<b>K90</b> 1111 1111	1111 1111	uuuu uuuu
PR12         PIC18F6XK90         PIC18F8XK90         11111 </td <td>T10CON</td> <td>PIC18F6XK90 PIC18F8&gt;</td> <td><b>K90</b> -000 0000</td> <td>-000 0000</td> <td>-uuu uuuu</td>	T10CON	PIC18F6XK90 PIC18F8>	<b>K90</b> -000 0000	-000 0000	-uuu uuuu
T12CON         PIC18F6XK90         PIC18F8XK90         -000 0000         -000 0000         -uuu uuuu           CM2CON         PIC18F6XK90         PIC18F8XK90         0001 1111         0001 1111         uuuu uuuu           CM3CON         PIC18F6XK90         PIC18F8XK90         0001 1111         0001 1111         uuuu uuuu           CCPTMRS0         PIC18F6XK90         PIC18F8XK90         0000 0000         uuuu uuuu         uuuu uuuu           CCPTMRS1         PIC18F6XK90         PIC18F8XK90         00-0 -000         uu-u -uuu         uu-u -uuu           CCPTMRS2         PIC18F6XK90         PIC18F8XK90         00 -000        u -uuu        u -uuu           REFOCON         PIC18F6XK90         PIC18F8XK90         0-00 0000         uuuu         uuuu           ODCON1         PIC18F6XK90         PIC18F8XK90         0000         uuuu         uuuu         uuuu         uuuu uuuu           ODCON2         PIC18F6XK90         PIC18F8XK90         0000         uuu         uuu           ANCON0         PIC18F6XK90         PIC18F8XK90         1111 1111         uuuu uuuu         uuuu uuuu	TMR12	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	0000 0000	uuuu uuuu
CM2CON         PIC18F6XK90         PIC18F8XK90         0001         1111         0001         1111         uuuu         uuuu<	PR12	PIC18F6XK90 PIC18F8>	<b>K90</b> 1111 1111	1111 1111	uuuu uuuu
CM3CON         PIC18F6XK90         PIC18F8XK90         0001         1111         0001         1111         uuuu         uuuu<	T12CON	PIC18F6XK90 PIC18F8>	<b>K90</b> -000 0000	-000 0000	-uuu uuuu
CCPTMRS0         PIC18F6XK90         PIC18F8XK90         0000         uuuu         uuu	CM2CON	PIC18F6XK90 PIC18F8>	<b>K90</b> 0001 1111	0001 1111	uuuu uuuu
CCPTMRS1         PIC18F6XK90         PIC18F8XK90         00-0         -000         uu-u         uu-	CM3CON	PIC18F6XK90 PIC18F8>	<b>K90</b> 0001 1111	0001 1111	uuuu uuuu
CCPTMRS2         PIC18F6XK90         PIC18F8XK90        0         -000        u         -uuu        u         -uuu           REFOCON         PIC18F6XK90         PIC18F8XK90         0-00         0000         u-uu         uuu         u-uu         uuu           ODCON1         PIC18F6XK90         PIC18F8XK90         000-        0         uuu-        u         uuu-        u           ODCON2         PIC18F6XK90         PIC18F8XK90         0000         0000         uuuu	CCPTMRS0	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	uuuu uuuu	uuuu uuuu
REFOCON         PIC18F6XK90         PIC18F8XK90         0-00 0000         u-uu uuuu         uuuuu         uuuu         uuuu         uu	CCPTMRS1	PIC18F6XK90 PIC18F8>	<b>K90</b> 00-0 -000	uu-u -uuu	uu-u -uuu
ODCON1         PIC18F6XK90         PIC18F8XK90         0000         uuuu         uuuu           ODCON2         PIC18F6XK90         PIC18F8XK90         0000         0000         uuuu uuuu         uuuu uuuu           ODCON3         PIC18F6XK90         PIC18F8XK90         000         uuu         uuu           ANCON0         PIC18F6XK90         PIC18F8XK90         1111         1111         uuuu uuuu         uuuu uuuu           ANCON1         PIC18F6XK90         PIC18F8XK90         1111         1111         uuuu uuuu         uuuu uuuu	CCPTMRS2	PIC18F6XK90 PIC18F8>	<b>K90</b> 0 -000	u -uuu	u -uuu
ODCON2         PIC18F6XK90         PIC18F8XK90         0000 0000         uuuu uuuu         uuuu uuuu           ODCON3         PIC18F6XK90         PIC18F8XK90         000         uuu         uuu           ANCON0         PIC18F6XK90         PIC18F8XK90         1111         1111         uuuu uuuu           ANCON1         PIC18F6XK90         PIC18F8XK90         1111         1111         uuuu uuuu	REFOCON	PIC18F6XK90 PIC18F8>	<b>K90</b> 0-00 0000	u-uu uuuu	u-uu uuuu
ODCON3         PIC18F6XK90         PIC18F8XK90         00         uu         uu<	ODCON1	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000	uuuu	uuuu
ANCON0         PIC18F6XK90         PIC18F8XK90         1111         1111         uuuu         uuuuu	ODCON2	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0000	uuuu uuuu	սսսս սսսս
ANCON1 PIC18F6XK90 PIC18F8XK90 1111 1111 uuuu uuuu uuuu uuuu	ODCON3	PIC18F6XK90 PIC18F8>	<b>K90</b> 000	uuu	uuu
	ANCON0	PIC18F6XK90 PIC18F8>	<b>K90</b> 1111 1111	uuuu uuuu	սսսս սսսս
	ANCON1	PIC18F6XK90 PIC18F8>	K90 1111 1111	uuuu uuuu	սսսս սսսս
	ANCON2	PIC18F6XK90 PIC18F8>	<b>K90</b> 1111 1111	uuuu uuuu	սսսս սսսս
RCSTA2         PIC18F6XK90         PIC18F8XK90         0000 000x         0000 000x         uuuu uuuu	RCSTA2	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 000x	0000 000x	սսսս սսսս
TXSTA2         PIC18F6XK90         PIC18F8XK90         0000 0010         0000 0010         uuuu uuuu	TXSTA2	PIC18F6XK90 PIC18F8>	<b>K90</b> 0000 0010	0000 0010	սսսս սսսս
BAUDCON2 PIC18F6XK90 PIC18F8XK90 0100 0-00 0100 0-00 uuuu u-uu	BAUDCON2	PIC18F6XK90 PIC18F8>	<b>K90</b> 0100 0-00	0100 0-00	uuuu u-uu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- **4:** See Table 5-1 for Reset value for specific condition.

#### 查询PIC18F86K90供应商

# TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable	Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
SPBRGH2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SPBRG2	PIC18F6XK90 F	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
RCREG2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
TXREG2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PSTR2CON	PIC18F6XK90	PIC18F8XK90	00-0 0001	00-0 0001	uu-u uuuu
PSTR3CON	PIC18F6XK90	PIC18F8XK90	00-0 0001	00-0 0001	uu-u uuuu
PMD0	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PMD1	PIC18F6XK90	PIC18F8XK90	-000 000-	-000 000-	-uuu uuu-
PMD2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PMD3	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
TMR5H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
TMR5L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
T5CON	PIC18F6XK90 F	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
T5GCON	PIC18F6XK90	PIC18F8XK90	00x0 0x00	00x0 0x00	uuuu uuuu
CCPR4H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR4L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP4CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR5H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR5L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP5CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR6H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR6L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP6CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR7H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR7L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP7CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
TMR4	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR4	PIC18F6XK90	PIC18F8XK90	1111 1111	uuuu uuuu	uuuu uuuu
T4CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
SSP2BUF	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
SSP2ADD	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP2STAT	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP2CON1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- **2:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 5-1 for Reset value for specific condition.

# TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

-						
Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt	
SSP2CON2	PIC18F6XK90 PIC18F	8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDREF	PIC18F6XK90 PIC18F	8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDRL	PIC18F6XK90 PIC18F	8XK90	0000 -000	0000 -000	uuuu -uuu	
LCDSE5	PIC18F6XK90 PIC18F	8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDSE4	PIC18F6XK90 PIC18F	8XK90	0	u	u	
LCDSE4	PIC18F6XK90 PIC18F	8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDSE3	PIC18F6XK90 PIC18F	8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDSE2	PIC18F6XK90 PIC18F	8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDSE1	PIC18F6XK90 PIC18F	8XK90	0000 0000	սսսս սսսս	սսսս սսսս	
LCDSE0	PIC18F6XK90 PIC18F	8XK90	0000 0000	uuuu uuuu	սսսս սսսս	
LCDPS	PIC18F6XK90 PIC18F	8XK90	0000 0000	0000 0000	սսսս սսսս	
LCDCON	PIC18F6XK90 PIC18F	8XK90	000- 0000	000- 0000	uuu- uuuu	

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

查询PIC18F86K90供应商 NOTES:

### 查询PIC18F86K90供应商 6.0 MEMORY ORGANIZ

6.0 MEMORY ORGANIZATION

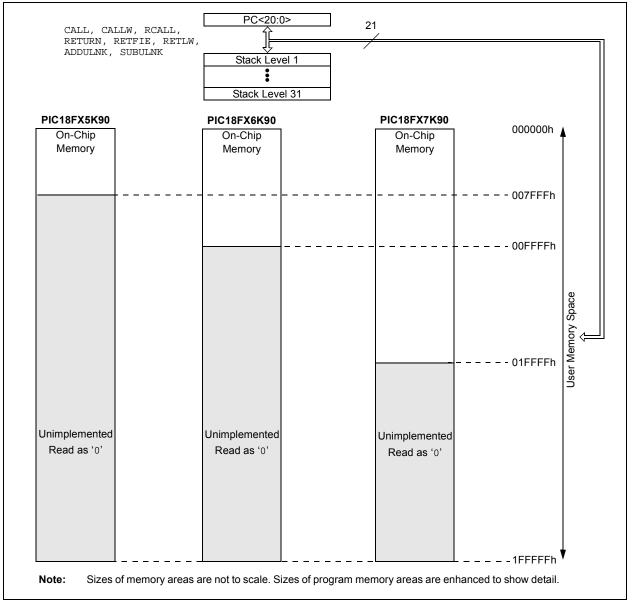
PIC18F87K90 family devices have these types of memory:

- Program Memory
- Data RAM
- Data EEPROM

As Harvard architecture devices, the data and program memories use separate busses. This enables concurrent access of the two memory spaces. The data EEPROM, for practical purposes, can be regarded as a peripheral device because it is addressed and accessed through a set of control registers.

Additional detailed information on the operation of the Flash program memory is provided in **Section 7.0 "Flash Program Memory"**. The data EEPROM is discussed separately in **Section 8.0 "Data EEPROM Memory"**.

# FIGURE 6-1: MEMORY MAPS FOR PIC18F87K90 FAMILY DEVICES



# 查询PIC18F86K90供应商

# 6.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter that is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address will return all '0's (a NOP instruction).

The entire PIC18F87K90 family offers a range of on-chip Flash program memory sizes, from 32 Kbytes (up to 16,384 single-word instructions) to 128 Kbytes (65,536 single-word instructions).

- PIC18F65K90 and PIC18F85K90 32 Kbytes of Flash memory, storing up to 16,384 single-word instructions
- PIC18F66K90 and PIC18F86K90 64 Kbytes of Flash memory, storing up to 32,768 single-word instructions
- PIC18F67K90 and PIC18F87K90 128 Kbytes of Flash memory, storing up to 65,536 single-word instructions

The program memory maps for individual family members are shown in Figure 6-1.

# 6.1.1 HARD MEMORY VECTORS

All PIC18 devices have a total of three hard-coded return vectors in their program memory space. The Reset vector address is the default value to which the program counter returns on all device Resets. It is located at 0000h.

PIC18 devices also have two interrupt vector addresses for handling high-priority and low-priority interrupts. The high-priority interrupt vector is located at 0008h and the low-priority interrupt vector is at 0018h. The locations of these vectors are shown, in relation to the program memory map, in Figure 6-2.

# FIGURE 6-2: HARD VECTOR FOR PIC18F87K90 FAMILY DEVICES

	Reset Vector	0000h
	High-Priority Interrupt Vector	0008h
	Low-Priority Interrupt Vector	0018h
	On-Chip Program Memory	
	Read '0'	
Le	of on-chip program n Figure 6-1 for device Shaded area represe	-specific values). ents unimplemented
	memory. Areas are n	

#### 查询PIC18F86K90供应商 6.1.2 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and contained in three separate 8-bit registers.

The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits and is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATH register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see **Section 6.1.5.1 "Computed** GOTO").

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by two to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

# 6.1.3 RETURN ADDRESS STACK

The return address stack enables execution of any combination of up to 31 program calls and interrupts. The PC is pushed onto the stack when a CALL or RCALL instruction is executed, or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction. The value also is pulled off the stack on ADDULNK and SUBULNK instructions, if the extended instruction set is enabled. PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack Special Function Registers. Data can also be pushed to, or popped from the stack, using these registers.

A CALL type instruction causes a push onto the stack. The Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack. The contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

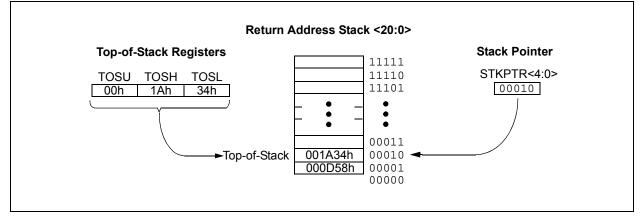
The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits indicate if the stack is full, has overflowed or has underflowed.

### 6.1.3.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, holds the contents of the stack location pointed to by the STKPTR register (Figure 6-3). This allows users to implement a software stack, if necessary. After a CALL, RCALL or interrupt (or ADDULNK and SUBULNK instructions, if the extended instruction set is enabled), the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

While accessing the stack, users must disable the global interrupt enable bits to prevent inadvertent stack corruption.

### FIGURE 6-3: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS



# 查询PIC18F86K90供应商

# 6.1.3.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 6-1) contains the Stack Pointer value, the STKFUL (Stack Full) status bit and the STKUNF (Stack Underflow) status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off the stack. On Reset, the Stack Pointer value will be zero.

The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return-stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a POR.

What happens when the stack becomes full depends on the state of the STVREN (Stack Overflow Reset Enable) Configuration bit. (For a description of the device Configuration bits, see **Section 28.1 "Configuration Bits"**.) If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and the STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and set the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note:

# 6.1.3.3 PUSH and POP Instructions

Since the Top-of-Stack is readable and writable, the ability to push values onto the stack and pull values off the stack, without disturbing normal program execution, is a desirable feature. The PIC18 instruction set includes two instructions, PUSH and POP, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The PUSH instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The POP instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

# REGISTER 6-1: STKPTR: STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL <sup>(1)</sup>	STKUNF <sup>(1)</sup>	_	SP4	SP3	SP2	SP1	SP0
bit 7							bit
Legend:		C = Clearable	bit				
R = Readab	le bit	W = Writable	bit	U = Unimplem	ented bit, read	d as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown
bit 7	<b>STKFUL:</b> Stack Full Flag bit <sup>(1)</sup> 1 = Stack became full or overflowed 0 = Stack has not become full or overflowed						
	1 = Stack bec	ame full or ove	rflowed	ed			
bit 6	1 = Stack bec 0 = Stack has STKUNF: Sta 1 = Stack und	ame full or ove	rflowed Il or overflowe lag bit <sup>(1)</sup> d	ed			
	1 = Stack bec 0 = Stack has STKUNF: Sta 1 = Stack und 0 = Stack und	ame full or ove not become fu ck Underflow F erflow occurred	rflowed II or overflowe Iag bit <sup>(1)</sup> d occur	ed			

**Note 1:** Bit 7 and bit 6 are cleared by user software or by a POR.

### 6.1.3.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit (CONFIG4L<0>). When STVREN is set, a full or underflow condition will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit, but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

### 6.1.4 FAST REGISTER STACK

A Fast Register Stack is provided for the STATUS, WREG and BSR registers to provide a "fast return" option for interrupts. This stack is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the Stack registers. The values in the registers are then loaded back into the working registers if the RETFIE, FAST instruction is used to return from the interrupt.

If both low and high-priority interrupts are enabled, the Stack registers cannot be used reliably to return from low-priority interrupts. If a high-priority interrupt occurs while servicing a low-priority interrupt, the Stack register values stored by the low-priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low-priority interrupt.

If interrupt priority is not used, all interrupts may use the Fast Register Stack for returns from interrupt. If no interrupts are used, the Fast Register Stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the Fast Register Stack for a subroutine call, a CALL label, FAST instruction must be executed to save the STATUS, WREG and BSR registers to the Fast Register Stack. A RETURN, FAST instruction is then executed to restore these registers from the Fast Register Stack.

Example 6-1 shows a source code example that uses the Fast Register Stack during a subroutine call and return.

#### EXAMPLE 6-1: FAST REGISTER STACK CODE EXAMPLE

CALL SUB1, FAST	;STATUS, WREG, BSR
•	;SAVED IN FAST REGISTER
SUB1	;STACK
RETURN FAST	;RESTORE VALUES SAVED ;IN FAST REGISTER STACK

# 6.1.5 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed GOTO
- Table Reads

# 6.1.5.1 Computed GOTO

A computed GOTO is accomplished by adding an offset to the program counter. An example is shown in Example 6-2.

A look-up table can be formed with an ADDWF PCL instruction and a group of RETLW nn instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW nn instructions that returns the value 'nn' to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of two (LSb = 0).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

#### EXAMPLE 6-2: COMPUTED GOTO USING AN OFFSET VALUE

	MOVF	OFFSET, W
	CALL	TABLE
ORG	nn00h	
TABLE	ADDWF	PCL
	RETLW	nnh
	RETLW	nnh
	RETLW	nnh
	•	

### 6.1.5.2 Table Reads

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word while programming. The Table Pointer (TBLPTR) specifies the byte address and the Table Latch (TABLAT) contains the data that is read from the program memory. Data is transferred from program memory one byte at a time.

The table read operation is discussed further in **Section 7.1 "Table Reads and Table Writes**".

### 查询PIC18F86K90供应商 6.2 PIC18 Instruction Cycle

### 6.2.1 CLOCKING SCHEME

The microcontroller clock input, whether from an internal or external source, is internally divided by four to generate four non-overlapping quadrature clocks (Q1, Q2, Q3 and Q4). Internally, the program counter is incremented on every Q1, with the instruction fetched from the program memory and latched into the Instruction Register (IR) during Q4.

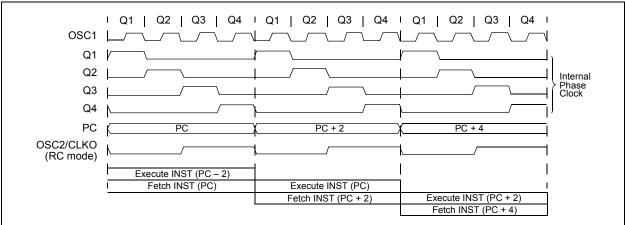
The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 6-4.

# 6.2.2 INSTRUCTION FLOW/PIPELINING

An "Instruction Cycle" consists of four Q cycles, Q1 through Q4. The instruction fetch and execute are pipelined in such a manner that a fetch takes one instruction cycle, while the decode and execute take another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction (such as GOTO) causes the program counter to change, two cycles are required to complete the instruction. (See Example 6-3.)

A fetch cycle begins with the Program Counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).



### FIGURE 6-4: CLOCK/INSTRUCTION CYCLE

### EXAMPLE 6-3: INSTRUCTION PIPELINE FLOW

Тсу0	TCY1	Tcy2	Tcy3	Tcy4	TcY5
1. MOVLW 55h Fetch 1	Execute 1		_		
2. MOVWF PORTB	Fetch 2	Execute 2		_	
3. BRA SUB_1		Fetch 3	Execute 3		
4. BSF PORTA, BIT3 (Forced NOP	)		Fetch 4	Flush (NOP)	
5. Instruction @ address SUB_1				Fetch SUB_1	Execute SUB_1

All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

### 6.2.3 INSTRUCTIONS IN PROGRAM MEMORY

The program memory is addressed in bytes. Instructions are stored as two or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSB = 0). To maintain alignment with instruction boundaries, the PC increments in steps of two and the LSB will always read '0' (see Section 6.1.2 "Program Counter").

Figure 6-5 shows an example of how instruction words are stored in the program memory.

The CALL and GOTO instructions have the absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1> which accesses the desired byte address in program memory. Instruction #2 in Figure 6-5 shows how the instruction, GOTO 0006h, is encoded in the program memory. Program branch instructions, which encode a relative address offset, operate in the same manner. The offset value stored in a branch instruction represents the number of single-word instructions that the PC will be offset by. For more details on the instruction set, see **Section 29.0 "Instruction Set Summary"**.

FIGURE 6-5:	INSTRUCTIONS IN PROGRAM MEMORY
-------------	--------------------------------

			LSB = 1	LSB = 0	Word Address $\downarrow$
	Program N	lemory			000000h
	Byte Locat	ions $\rightarrow$			000002h
					000004h
					000006h
Instruction 1:	MOVLW	055h	0Fh	55h	000008h
Instruction 2:	GOTO	0006h	EFh	03h	00000Ah
			F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 456h	C1h	23h	00000Eh
			F4h	56h	000010h
					000012h
					000014h

# 6.2.4 TWO-WORD INSTRUCTIONS

The standard PIC18 instruction set has four two-word instructions: CALL, MOVFF, GOTO and LSFR. In all cases, the second word of the instructions always has '1111' as its four Most Significant bits. The other 12 bits are literal data, usually a data memory address.

The use of '1111' in the 4 MSbs of an instruction specifies a special form of NOP. If the instruction is executed in proper sequence, immediately after the first word, the data in the second word is accessed and

used by the instruction sequence. If the first word is skipped for some reason, and the second word is executed by itself, a NOP is executed instead. This is necessary for cases when the two-word instruction is preceded by a conditional instruction that changes the PC. Example 6-4 shows how this works.

Note: For information on two-word instructions in the extended instruction set, see Section 6.5 "Program Memory and the Extended Instruction Set".

EXAMPLE 6-4:	TWO-WORD INSTRUCTIONS

CASE 1:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; No, skip this word
1111 0100 0101 0110		; Execute this word as a NOP
0010 0100 0000 0000	ADDWF REG3	; continue code
CASE 2:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; Yes, execute this word
1111 0100 0101 0110		; 2nd word of instruction
0010 0100 0000 0000	ADDWF REG3	; continue code

© 2010 Microchip Technology Inc.

# 查询PIC18F86K90供应商

# 6.3 Data Memory Organization

Note:	The operation of some aspects of data									
	memory are changed when the PIC18									
	extended instruction set is enabled. See									
	Section 6.6 "Data Memory and the									
	Extended Instruction Set" for more									
	information.									

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4,096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each. PIC18FX6K90 and PIC18FX7K90 devices implement all 16 complete banks, for a total of 4 Kbytes. PIC18FX5K90 devices implement only the first eight complete banks, for a total of 2 Kbytes.

Figure 6-6 and Figure 6-7 show the data memory organization for the devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this section.

To ensure that commonly used registers (select SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to select SFRs and the lower portion of GPR Bank 0 without using the Bank Select Register. For details on the Access RAM, see **Section 6.3.2 "Access Bank"**.

# 6.3.1 BANK SELECT REGISTER

Large areas of data memory require an efficient addressing scheme to make possible rapid access to any address. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit, low-order address and a four-bit Bank Pointer.

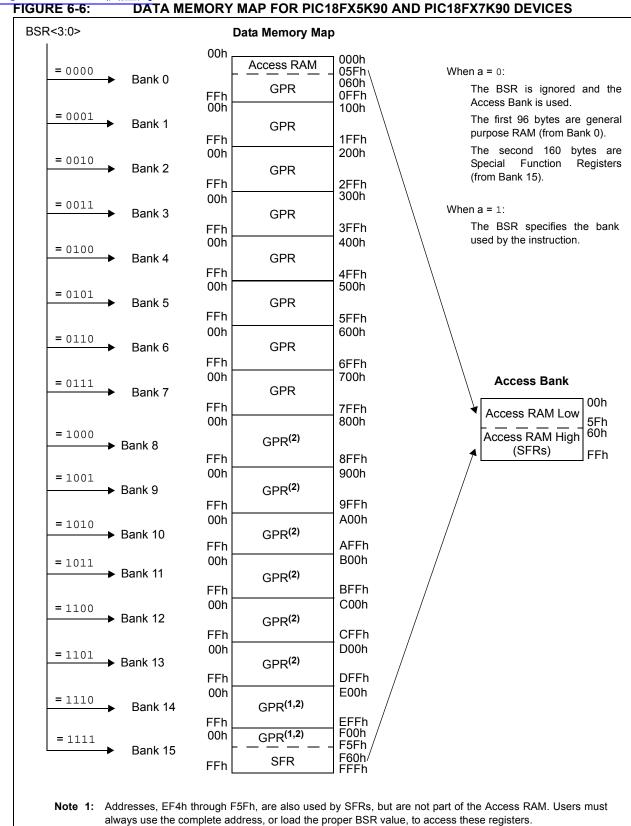
Most instructions in the PIC18 instruction set make use of the Bank Pointer, known as the Bank Select Register (BSR). This SFR holds the four Most Significant bits of a location's address. The instruction itself includes the eight Least Significant bits. Only the four lower bits of the BSR are implemented (BSR<3:0>). The upper four bits are unused, always read as '0' and cannot be written to. The BSR can be loaded directly by using the MOVLB instruction.

The value of the BSR indicates the bank in data memory. The eight bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is shown in Figure 6-7.

Since up to 16 registers may share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h while the BSR is 0Fh, will end up resetting the program counter.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 6-6 indicates which banks are implemented.

In the core PIC18 instruction set, only the MOVFF instruction fully specifies the 12-bit address of the source and target registers. When this instruction executes, it ignores the BSR completely. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.



2: These addresses are unused for devices with 32 Kbytes of program memory (PIC18FX5K90). For those devices, read these addresses at 00h.

#### 查询PIC18F86K90供应商 FIGURE 6-7: USE OF THE BANK SELECT REGISTER (DIRECT ADDRESSING) Data Memory From Opcode<sup>(2)</sup> BSR<sup>(1)</sup> 000h 7 0 7 0 00h Bank 0 0 0 0 1 0 1 0 0 0 1 1 1 1 1 1 1 FFh 100h 00h Bank 1 Bank Select<sup>(2)</sup> FFh 200h 00h Bank 2 FFh 300h 00h Bank 3 through Bank 13 FFh E00h 00h Bank 14 FFh F00h 00h Bank 15 FFFh FFh The Access RAM bit of the instruction can be used to force an override of the selected bank (BSR<3:0>) Note 1: to the registers of the Access Bank. 2: The MOVFF instruction embeds the entire 12-bit address in the instruction.

# 6.3.2 ACCESS BANK

While the use of the BSR, with an embedded 8-bit address, allows users to address the entire range of data memory, it also means that the user must ensure that the correct bank is selected. If not, data may be read from, or written to, the wrong location. This can be disastrous if a GPR is the intended target of an operation, but an SFR is written to instead. But verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 96 bytes of memory (00h-5Fh) in Bank 0 and the last 160 bytes of memory (60h-FFh) in Bank 15. The lower half is known as the "Access RAM" and is composed of GPRs. The upper half is where the device's SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 6-6).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the 'a' parameter in the instruction). When 'a' is equal to '1', the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When 'a' is '0', however, the instruction is forced to use the Access Bank address map. In that case, the current value of the BSR is ignored entirely.

Using this "forced" addressing allows the instruction to operate on a data address in a single cycle without updating the BSR first. For 8-bit addresses of 60h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 60h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables.

Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST Configuration bit = 1). This is discussed in more detail in Section 6.6.3 "Mapping the Access Bank in Indexed Literal Offset Mode".

### 6.3.3 GENERAL PURPOSE REGISTER FILE

PIC18 devices may have banked memory in the GPR area. This is data RAM which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upwards towards the bottom of the SFR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets.

6.3.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. SFRs start at the top of data memory (FFFh) and extend downward to occupy all of Bank 15 (F00h to FFFh) and the top part of Bank 14 (EF4h to EFFh).

A list of these registers is given in Table 6-1 and Table 6-2.

The SFRs can be classified into two sets: those associated with the "core" device functionality (ALU, Resets and interrupts) and those related to the peripheral functions. The Reset and Interrupt registers are described in their respective chapters, while the ALU's STATUS register is described later in this section. Registers related to the operation of the peripheral features are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as '0's.

TABLE 6-1:	PIC18F87K90 FAMILY SPECIAL FUNCTION REGISTER MAP <sup>(5)</sup>

Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name
FFFh	TOSU	FDFh	INDF2 <sup>(1)</sup>	FBFh	ECCP1AS	F9Fh	IPR1	F7Fh	EECON1	F5Fh	RTCCFG
FFEh	TOSH	FDEh	POSTINC2 <sup>(1)</sup>	FBEh	ECCP1DEL	F9Eh	PIR1	F7Eh	EECON2	F5Eh	RTCCAL
FFDh	TOSL	FDDh	POSTDEC2 <sup>(1)</sup>	FBDh	CCPR1H	F9Dh	PIE1	F7Dh	LCDDATA23 <sup>(3)</sup>	F5Dh	RTCVALH
FFCh	STKPTR	FDCh	PREINC2 <sup>(1)</sup>	FBCh	CCPR1L	F9Ch	PSTR1CON	F7Ch	LCDDATA22 <sup>(3)</sup>	F5Ch	RTCVALL
FFBh	PCLATU	FDBh	PLUSW2 <sup>(1)</sup>	FBBh	CCP1CON	F9Bh	OSCTUNE	F7Bh	LCDDATA21	F5Bh	ALRMCFG
FFAh	PCLATH	FDAh	FSR2H	FBAh	PIR5	F9Ah	TRISJ <sup>(3)</sup>	F7Ah	LCDDATA20	F5Ah	ALRMRPT
FF9h	PCL	FD9h	FSR2L	FB9h	PIE5	F99h	TRISH <sup>(3)</sup>	F79h	LCDDATA19	F59h	ALRMVALH
FF8h	TBLPTRU	FD8h	STATUS	FB8h	IPR4	F98h	TRISG	F78h	LCDDATA18	F58h	ALRMVALL
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	PIR4	F97h	TRISF	F77h	LCDDATA17 <sup>(3)</sup>	F57h	CTMUCONH
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	PIE4	F96h	TRISE	F76h	LCDDATA16 <sup>(3)</sup>	F56h	CTMUCONL
FF5h	TABLAT	FD5h	TOCON	FB5h	CVRCON	F95h	TRISD	F75h	LCDDATA15	F55h	CTMUICON
FF4h	PRODH	FD4h	SPBRGH1	FB4h	CMSTAT	F94h	TRISC	F74h	LCDDATA14	F54h	CMCON1
FF3h	PRODL	FD3h	OSCCON	FB3h	TMR3H	F93h	TRISB	F73h	LCDDATA13	F53h	PADCFG1
FF2h	INTCON	FD2h	IPR5	FB2h	TMR3L	F92h	TRISA	F72h	LCDDATA12	F52h	ECCP2AS
FF1h	INTCON2	FD1h	WDTCON	FB1h	T3CON	F91h	LATJ <sup>(3)</sup>	F71h	LCDDATA11 <sup>(3)</sup>	F51h	ECCP2DEL
FF0h	INTCON3	FD0h	RCON	FB0h	T3GCON	F90h	LATH <sup>(3)</sup>	F70h	LCDDATA10 <sup>(3)</sup>	F50h	CCPR2H
FEFh	INDF0 <sup>(1)</sup>	FCFh	TMR1H	FAFh	SPBRG1	F8Fh	LATG	F6Fh	LCDDATA9	F4Fh	CCPR2L
FEEh	POSTINC0 <sup>(1)</sup>	FCEh	TMR1L	FAEh	RCREG1	F8Eh	LATF	F6Eh	LCDDATA8	F4Eh	CCP2CON
FEDh	POSTDEC0 <sup>(1)</sup>	FCDh	T1CON	FADh	TXREG1	F8Dh	LATE	F6Dh	LCDDATA7	F4Dh	ECCP3AS
FECh	PREINC0 <sup>(1)</sup>	FCCh	TMR2	FACh	TXSTA1	F8Ch	LATD	F6Ch	LCDDATA6	F4Ch	ECCP3DEL
FEBh	PLUSW0 <sup>(1)</sup>	FCBh	PR2	FABh	RCSTA1	F8Bh	LATC	F6Bh	LCDDATA5 <sup>(3)</sup>	F4Bh	CCPR3H
FEAh	FSR0H	FCAh	T2CON	FAAh	T1GCON	F8Ah	LATB	F6Ah	LCDDATA4 <sup>(3)</sup>	F4Ah	CCPR3L
FE9h	FSR0L	FC9h	SSP1BUF	FA9h	IPR6	F89h	LATA	F69h	LCDDATA3	F49h	CCP3CON
FE8h	WREG	FC8h	SSP1ADD	FA8h	HLVDCON	F88h	PORTJ <sup>(3)</sup>	F68h	LCDDATA2	F48h	CCPR8H
FE7h	INDF1 <sup>(1)</sup>	FC7h	SSP1STAT	FA7h	(2)	F87h	PORTH <sup>(3)</sup>	F67h	LCDDATA1	F47h	CCPR8L
FE6h	POSTINC1 <sup>(1)</sup>	FC6h	SSP1CON1	FA6h	PIR6	F86h	PORTG	F66h	LCDDATA0	F46h	CCP8CON
FE5h	POSTDEC1 <sup>(1)</sup>	FC5h	SSP1CON2	FA5h	IPR3	F85h	PORTF	F65h	BAUDCON1	F45h	CCPR9H <sup>(4)</sup>
FE4h	PREINC1 <sup>(1)</sup>	FC4h	ADRESH	FA4h	PIR3	F84h	PORTE	F64h	OSCCON2	F44h	CCPR9L <sup>(4)</sup>
FE3h	PLUSW1 <sup>(1)</sup>	FC3h	ADRESL	FA3h	PIE3	F83h	PORTD	F63h	EEADRH	F43h	CCP9CON <sup>(4)</sup>
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC	F62h	EEADR	F42h	CCPR10H <sup>(4)</sup>
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB	F61h	EEDATA	F41h	CCPR10L <sup>(4)</sup>
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA	F60h	PIE6	F40h	CCP10CON <sup>(4)</sup>

**Note 1:** This is not a physical register.

2: Unimplemented registers are read as '0'.

**3:** This register is not available on 64-pin devices (PIC18F6XK90).

4: This register is not available on devices with a program memory of 32 Kbytes (PIC18FX5K90).

5: Addresses, EF4h through F5Fh, are also used by SFRs, but are not part of the Access RAM. Users must always load the proper BSR value to access these registers.

#### 查询PIC18F86K90供应意 TABLE 6-1: PIC18F87K90 FAMILY SPECIAL FUNCTION REGISTER MAP<sup>(5)</sup> (CONTINUED)

Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name
F3Fh	TMR7H <sup>(4)</sup>	F32h	TMR12 <sup>(4)</sup>	F25h	ANCON0	F18h	PMD1	F0Bh	CCPR6H	EFEh	SSP2CON2
F3Eh	TMR7L <sup>(4)</sup>	F31h	PR12 <sup>(4)</sup>	F24h	ANCON1	F17h	PMD2	F0Ah	CCPR6L	EFDh	LCDREF
F3Dh	T7CON <sup>(4)</sup>	F30h	T12CON <sup>(4)</sup>	F23h	ANCON2	F16h	PMD3	F09h	CCP6CON	EFCh	LCDRL
F3Ch	T7GCON <sup>(4)</sup>	F2Fh	CM2CON	F22h	RCSTA2	F15h	TMR5H	F08h	CCPR7H	EFBh	LCDSE5 <sup>(3)</sup>
F3Bh	TMR6	F2Eh	CM3CON	F21h	TXSTA2	F14h	TMR5L	F07h	CCPR7L	EFAh	LCDSE4
F3Ah	PR6	F2Dh	CCPTMRS0	F20h	BAUDCON2	F13h	T5CON	F06h	CCP7CON	EF9h	LCDSE3
F39H	T6CON	F2Ch	CCPTMRS1	F1Fh	SPBRGH2	F12h	T5GCON	F05h	TMR4	EF8h	LCDSE2
F38h	TMR8	F2Bh	CCPTMRS2	F1Eh	SPBRG2	F11h	CCPR4H	F04h	PR4	EF7h	LCDSE1
F37h	PR8	F2Ah	REFOCON	F1Dh	RCREG2	F10h	CCPR4L	F03h	T4CON	EF6h	LCDSE0
F36h	T8CON	F29H	ODCON1	F1Ch	TXREG2	F0Fh	CCP4CON	F02h	SSP2BUF	EF5h	LCDPS
F35h	TMR10 <sup>(4)</sup>	F28h	ODCON2	F1Bh	PSTR2CON	F0Eh	CCPR5H	F01h	SSP2ADD	EF4h	LCDCON
F34h	PR10 <sup>(4)</sup>	F27h	ODCON3	F1Ah	PSTR3CON	F0Dh	CCPR5L	F00h	SSP2STAT		
F33h	T10CON <sup>(4)</sup>	F26h	—	F19h	PMD0	F0Ch	CCP5CON	EFFh	SSP2CON1	]	

**Note 1:** This is not a physical register.

2: Unimplemented registers are read as '0'.

3: This register is not available on 64-pin devices (PIC18F6XK90).

4: This register is not available on devices with a program memory of 32 Kbytes (PIC18FX5K90).

5: Addresses, EF4h through F5Fh, are also used by SFRs, but are not part of the Access RAM. Users must always load the proper BSR value to access these registers.

#### 查询PIC18F86K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	
EF4h	LCDCON	LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0	000- 0000	
EF5h	LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	0000 0000	
EF6h	LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	0000 0000	
EF7h	LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	0000 0000	
EF8h	LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	0000 0000	
EF9h	LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	0000 0000	
EFAh	LCDSE4	SE39	SE38	S37	SE36	SE35	SE34	SE33	SE32	0000 0000	
EFBh	LCDSE5 <sup>(2)</sup>	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	0000 0000	
EFCh	LCDRL	LRLAP1	LRLAP0	LRLBP1	LRLBP0	_	LRLAT2	LRLAT1	LRLAT0	0000 -000	
EFDh	LCDREF	LCDIRE	LCDIRS	LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE	0000 0000	
EFEh	SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	
EFFh	SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	
F00h	SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	
F01h	SSP2ADD	MSSP Addres			Vode, SSP1 E	-				0000 0000	
F02h	SSP2BUF		SP Receive Buffer/Transmit Register								
F03h	T4CON	_	— T40UTPS3 T40UTPS2 T40UTPS1 T40UTPS0 TMR40N T4CKPS1 T4CKPS0								
F04h	PR4	Timer4 Perior	er4 Period Register								
F05h	TMR4	Timer4 Regis	•							0000 0000	
F06h	CCP7CON		— — DC7B1 DC7B0 CCP7M3 CCP7M2 CCP7M1 CCP7M0							00 0000	
F07h	CCPR7L	Capture/Com	nare/PWM Re	egister 7 Low			00171112	00171111	00171110	xxxx xxxx	
F08h	CCPR7H			egister7 High						XXXX XXXX	
F09h	CCP6CON			DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	00 0000	
F0Ah	CCPR6L	Capture/Com	nare/P\//M R	egister 6 Low			001 01012			xxxx xxxx	
F0Bh	CCPR6H			egister6 High						XXXX XXXX	
F0Ch	CCP5CON			DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	00 0000	
F0Dh	CCPR5L	Capture/Com	nare/P\//M R	egister 5 Low		001 51015				xxxx xxxx	
F0Eh	CCPR5H			egister 5 Low							
F0Fh	CCP4CON	Capture/Com		DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	00 0000	
	CCP4CON CCPR4L	- Conturo/Com		egister 4 Low		CCF4IVI3	CCF4IVIZ	CCF4IMI	CCF4IVIU		
F10h				egister 4 High						XXXX XXXX	
F11h F12h	CCPR4H T5GCON	TMR5GE	T5GPOL	T5GTM	T5GSPM	T5GGO/ T5DONE	T5GVAL	T5GSS1	T5GSS0	xxxx xxxx 0000 0000	
F13h	T5CON	TMR5CS1	TMR5CS0	T5CKPS1	T5CKPS0	SOSCEN	T5SYNC	RD16	TMR5ON	0000 0000	
F14h	TMR5L	Timer5 Regis		100101	100101 00	COODEN	1001110	RDTO	THIRDON	0000 0000	
	TMR5H	Timer5 Regis									
	PMD3	CCP10MD <sup>(3)</sup>	(*)	CCP8MD	CCP7MD	CCP6MD	CCP5MD	CCP4MD	TMR12MD <sup>(3)</sup>	xxxx xxxx	
	PMD2	TMR10MD <sup>(3)</sup>	TMR8MD	TMR7MD <sup>(3)</sup>	TMR6MD	TMR5MD	CMP3MD	CMP2MD	CMP1MD	0000 0000	
	PMD1		CTMUMD	RTCCMD	TMR4MD	TMR3MD	TMR2MD	TMR1MD		-000 000-	
	PMD0	CCP3MD	CCP2MD	CCP1MD	UART2MD	UART1MD	SSP2MD	SSP1MD	ADCMD	0000 0000	
				COPINID	STRSYNC						
	PSTR3CON	CMPL1	CMPL0			STRD	STRC STRC	STRB	STRA	00-0 0001	
F1Bh F1Ch	PSTR2CON TXREG2	CMPL1 Transmit Data		_	STRSYNC	STRD	JIRU	STRB	STRA	00-0 0001	
										XXXX XXXX	
	RCREG2	Receive Data		ator Low Dot-						0000 0000	
F1Eh	SPBRG2			ator Low Byte						0000 0000	
F1Fh	SPBRGH2			ator High Byte	1			14/1-1-		0000 0000	
	BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	-	WUE	ABDEN	0100 0-00	
F21h	TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	
	RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	
F23h	ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	1111 1111	

Pit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.
 Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

# 查询PIC18F86K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F24h	ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	1111 1111
F25h	ANCON0	ANSEL7	ANSEL6	ANSEL5	ANSEL4	ANSEL3	ANSEL2	ANSEL1	ANSEL0	1111 1111
	_	_	—		_	_	—	—	—	_
F27h	ODCON3	U2OD	U10D		_	_	_	_	CTMUDS	000
F28h	ODCON2	CCP100D	CCP9OD	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD	0000 0000
F29H	ODCON1	SSP10D	CCP2OD	CCP10D	_	_	—	—	SSP2OD	0000
F2Ah	REFOCON	ROON	_	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0	0-00 0000
F2Bh	CCPTMRS2	_	_	_	C10TSEL0	_	C9TSEL0	C8TSEL1	C8TSEL0	0 -000
F2Ch	CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0	00-0 -000
F2Dh	CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	0000 0000
F2Eh	CM3CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F2Fh	CM2CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F30h	T12CON	_	T12OUTPS3	T12OUTPS2	T12OUTPS1	T12OUTPS0	TMR12ON	T12CKPS1	T12CKPS0	-000 0000
F31h	PR12	Timer12 Peri	od Register					•	•	1111 1111
F32h	TMR12	TMR12 Regi	ster							0000 0000
F33h	T10CON	_	T10OUTPS3	T10OUTPS2	T10OUTPS1	T10OUTPS0	TMR100N	T10CKPS1	T10CKPS0	-000 0000
F34h	PR10	Timer10 Peri	od Register							1111 1111
F35h	TMR10	TMR10 Regi	ster							0000 0000
F36h	T8CON	_	T8OUTPS3	T8OUTPS2	T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	-000 0000
F37h	PR8	Timer8 Perio	Timer8 Period Register							
F38h	TMR8	Timer8 Register								0000 0000
F39H	T6CON	_	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	-000 0000
F3Ah	PR6	Timer6 Period Register								1111 1111
F3Bh	TMR6	Timerô Register							0000 0000	
F3Ch	T7GCON <sup>(3)</sup>	TMR7GE	T7GPOL	T7GTM	T7GSPM	T7GGO/ T7DONE	T7GVAL	T7GSS1	T7GSS0	0000 0x00
F3Dh	T7CON <sup>(3)</sup>	TMR7CS1	TMR7CS0	T7CKPS1	T7CKPS0	_	T7SYNC	RD16	TMR7ON	0000 0x00
F3Eh	TMR7L <sup>(3)</sup>	Timer7 Regis	ter Low Byte							xxxx xxxx
F3Fh	TMR7H <sup>(3)</sup>	Timer7 Regis	ter High Byte							xxxx xxxx
F40h	CCP10CON <sup>(3)</sup>	_	_	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	00 0000
F41h	CCPR10L <sup>(3)</sup>	Capture/Com	pare/PWM Re	egister 10 Low	v Byte					xxxx xxxx
F42h	CCPR10H <sup>(3)</sup>	Capture/Com	pare/PWM Re	egister 10 Hig	h Byte					XXXX XXXX
F43h	CCP9CON <sup>(3)</sup>	_	_	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	00 0000
F44h	CCPR9L <sup>(3)</sup>	Capture/Com	pare/PWM Re	egister 9 Low	Byte					XXXX XXXX
F45h	CCPR9H <sup>(3)</sup>	Capture/Com	pare/PWM Re	egister 9 High	Byte					XXXX XXXX
F46h	CCP8CON	_	_	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	00 0000
F47h	CCPR8L	Capture/Com	pare/PWM Re	egister 8 Low	Byte					XXXX XXXX
F48h	CCPR8H	Capture/Com	pare/PWM Re	egister 8 High	Byte					XXXX XXXX
F49h	CCP3CON	P3M1	P3M0	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	0000 0000
F4Ah	CCPR3L	Capture/Com	pare/PWM Re	egister 3 Low	Byte					xxxx xxxx
F4Bh	CCPR3H		pare/PWM Re	•						xxxx xxxx
F4Ch	ECCP3DEL	P3RSEN	P3DC6	P3DC5	P3DC4	P3DC3	P3DC2	P3DC1	P3DC0	0000 0000
F4Dh	ECCP3AS		ECCP3AS2			PSS3AC1	PSS3AC0	PSS3BD1	PSS3BD0	0000 0000
F4Eh	CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	0000 0000
F4Fh	CCPR2L		pare/PWM Re							xxxx xxxx

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

2: Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

# 查询PIC18F86K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F50h	CCPR2H	Capture/Com	pare/PWM Re	egister 2 High	Byte					XXXX XXXX
F51h	ECCP2DEL	P2RSEN	P2DC6	P2DC5	P2DC4	P2DC3	P2DC2	P2DC1	P2DC0	0000 0000
F52h	ECCP2AS	ECCP2ASE	ECCP2AS2	ECCP2AS1	ECCP2AS0	PSS2AC1	PSS2AC0	PSS2BD1	PSS2BD0	0000 0000
F53h	PADCFG1	RDPU	REPU	RJPU <sup>(2)</sup>	_	_	RTSECSEL1	RTSECSEL0	_	00000-
F54h	CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F55h	CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG1	0000 0000
F56h	CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	0000 0000
F57h	CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	0-00 0000
F58h	ALRMVALL		High Register		d on APTR<1					0000 000
-59h	ALRMVALH		High Register							xxxx xxx
F5Ah	ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	0000 000
F5Bh	ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	0000 000
=5Ch	RTCVALL		Low Register				7 (10) (0) (0)			0000 000
	RTCVALL		High Register							
F5Dh		CAL7	<u> </u>				041.0	CAL1	CAL0	XXXX XXX
F5Eh	RTCCAL		CAL6	CAL5	CAL4	CAL3	CAL2	CAL1		XXXX XXX
-5Fh	RTCCFG	RTCEN	_	RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	0-00 000
-60h	PIE6	—		—	EEIE	—	CMP3IE	CMP2IE	CMP1IE	0 -00
-61h	EEDATA	EEPROM Da	0							0000 000
-62h	EEADR		dress Registe	,						0000 000
-63h	EEADRH	EEPROM Ad	dress Registe	r High Byte						0
-64h	OSCCON2	—	SOSCRUN	—	—	SOSCGO	—	MFIOFS	MFIOSEL	-0 0-x
-65h	BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	0000 O-x
-66h	LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	XXXX XXX
-67h	LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	XXXX XXX
F68h	LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	XXXX XXX
F69h	LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	XXXX XXX
F6Ah	LCDDATA4	S39C0	S38C0	S37C0	S36C0	S35C0	S34C0	S33C0	S32C0	xxxx xxx
F6Bh	LCDDATA5	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	XXXX XXX
F6Ch	LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	XXXX XXX
F6Dh	LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	xxxx xxx
F6Eh	LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	XXXXXXXX
F6Fh	LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	xxxx xxx
F70h	LCDDATA10 <sup>(2)</sup>	S39C1 <sup>(2)</sup>	S38C1 <sup>(2)</sup>	S37C1 <sup>(2)</sup>	S36C1 <sup>(2)</sup>	S35C1 <sup>(2)</sup>	S34C1 <sup>(2)</sup>	S33C1 <sup>(2)</sup>	S32C1	XXXX XXX
F71h	LCDDATA11 <sup>(2)</sup>	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	xxxx xxx
F72h	LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	xxxx xxx
-73h	LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	xxxx xxx
-74h	LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	xxxx xxx
F75h	LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	XXXX XXX
-76h	LCDDATA16 <sup>(2)</sup>	S39C2 <sup>(2)</sup>	S38C2 <sup>(2)</sup>	S37C2 <sup>(2)</sup>	S36C2 <sup>(2)</sup>	S35C2 <sup>(2)</sup>	S34C2 <sup>(2)</sup>	S33C2 <sup>(2)</sup>	S32C2	XXXX XXX
=77h	LCDDATA17 <sup>(2)</sup>	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	XXXX XXX
F78h	LCDDATA17	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	
	LCDDATA18									xxxx xxx
=79h =74b		S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	xxxx xxx
F7Ah	LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	XXXX XXX
F7Bh	LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	XXXX XXX
F7Ch	LCDDATA22	S39C3 <sup>(2)</sup>	S38C3 <sup>(2)</sup>	S37C3 <sup>(2)</sup>	S36C3 <sup>(2)</sup>	S35C3 <sup>(2)</sup>	S34C3 <sup>(2)</sup>	S33C3 <sup>(2)</sup>	S32C3	XXXX XXX
F7Dh	LCDDATA23 <sup>(2)</sup>	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	XXXX XXXX
F7Eh	EECON2		ntrol Register	2 (not a phys	<b>,</b>				1	
F7Fh	EECON1	EEPGD	CFGS	—	FREE	WRERR	WREN	WR	RD	xx-0 x00
F80h	PORTA	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	XXXX XXX

2: Unimplemented on 64-pin devices (PIC18F6XK90).

Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

# 查询PIC18F86K90供应商

TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F81h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX XXXX
F82h	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	XXXX XXXX
F83h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	XXXX XXXX
F84h	PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	xxxx xxxx
F85h	PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	xxxx xxx-
F86h	PORTG	—	_	RG5 <sup>(1)</sup>	RG4	RG3	RG2	RG1	RG0	xx xxxx
F87h	PORTH <sup>(2)</sup>	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	XXXX XXXX
F88h	PORTJ <sup>(2)</sup>	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	XXXX XXXX
F89h	LATA	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	XXXX XXXX
F8Ah	LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	XXXX XXXX
F8Bh	LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	XXXX XXXX
F8Ch	LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	xxxx xxxx
F8Dh	LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	xxxx xxxx
F8Eh	LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	xxxx xxx-
F8Fh	LATG	_	_	_	LATG4	LATG3	LATG2	LATG1	LATG0	x xxxx
F90h	LATH <sup>(2)</sup>	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	xxxx xxxx
F91h	LATJ <sup>(2)</sup>	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	xxxx xxxx
F92h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111
F93h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111
F94h	TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111
F95h	TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	1111 1111
F96h	TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	1111 1111
F97h	TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1		1111 111-
F98h	TRISG				TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	1 1111
F99h	TRISH <sup>(2)</sup>	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	1111 1111
F9Ah	TRISJ <sup>(2)</sup>	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	1111 1111
F9Bh	OSCTUNE	INTSRC	PLLEN	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000 0000
F9Ch	PSTR1CON	CMPL1	CMPL0	-	STRSYNC	STRD	STRC	STRB	STRA	00-0 0001
F9Dh	PIE1		ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	-000 0000
F9Eh	PIR1		ADIF	RC1IF	TX1IE	SSP1IF	TMR1GIE	TMR2IE	TMR1IF	-000 0000
F9Fh	IPR1		ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	-111 1111
FA0h	PIE2	OSCFIE	ADII	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	0-10 0000
FA1h	PIR2	OSCFIF		SSP2IE SSP2IF	BCL2IE BCL2IF	BCL1IF	HLVDIE	TMR3IF	TMR3GIE TMR3GIF	0-10 0000
FA2h	IPR2	OSCFIP		SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	1-00 1110
	PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	0000 0000
FA4h	PIR3	TMR5GIE TMR5GIF	LCDIE	RC2IE RC2IF	TX2IE TX2IF	CTMUL	CCP2IE CCP2IF	CCP1IE CCP1IF	RTCCIE	0000 0000
	IPR3	TMR5GIP	LCDIP		TX2IP		CCP2IP	CCP1IP	RTCCIP	
FA5h FA6h	PIR6	TWINGGIP		RC2IP	EEIF	CTMUIP	CCP2IP CMP3IF	CCPTIP CMP2IF	CMP1IF	1111 1111
	FIRO	_					CIVIF3IF			
FA7h			-							
FA8h	HLVDCON	VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000 0000
FA9h	IPR6				EEIP	— T1000/	CMP3IP	CMP2IP	CMP1IP	1 -111
FAAh	T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ T1DONE	T1GVAL	T1GSS1	T1GSS0	0000 0x00
FABh	RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x
FACh	TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010
FADh	TXREG1	USART1 Trar	nsmit Register	-						XXXX XXXX
FAEh	RCREG1	USART1 Rec	eive Register							0000 0000
FAFh	SPBRG1	USART1 Bau	d Rate Gener	ator						0000 0000

**Note** 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

**2:** Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Valu POR
FB0h	T3GCON	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/ T3DONE	T3GVAL	T3GSS1	T3GSS0	0000
FB1h	T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	0000
FB2h	TMR3L	Timer3 Regis	ter Low Byte							xxxx
FB3h	TMR3H	Timer3 Regis	ter High Byte							xxxx
FB4h	CMSTAT	CMP3OUT	CMP2OUT	CMP10UT		_	_	_	_	111-
FB5h	CVRCON	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	0000
FB6h	PIE4	CCP10IE <sup>(3)</sup>	CCP9IE <sup>(3)</sup>	CCP8IE	CCP7IE <sup>(3)</sup>	CCP6IE	CCP5IE	CCP4IE	CCP3IE	0000
FB7h	PIR4	CCP10IF <sup>(3)</sup>	CCP9IF <sup>(3)</sup>	CCP8IF	CCP7IF <sup>(3)</sup>	CCP6IF	CCP5IF	CCP4IF	CCP3IF	0000
FB8h	IPR4	CCP10IP <sup>(3)</sup>	CCP9IP <sup>(3)</sup>	CCP8IP	CCP7IP <sup>(3)</sup>	CCP6IP	CCP5IP	CCP4IP	CCP3IP	1111
FB9h	PIE5	TMR7GIE <sup>(3)</sup>	TMR12IE <sup>(3)</sup>	TMR10IE <sup>(3)</sup>	TMR8IE	TMR7IE <sup>(3)</sup>	TMR6IE	TMR5IE	TMR4IE	0000
FBAh	PIR5	TMR7GIF <sup>(3)</sup>	TMR12IF <sup>(3)</sup>	TMR10IF <sup>(3)</sup>	TMR8IF	TMR7IF <sup>(3)</sup>	TMR6IF	TMR5IF	TMR4IF	0000
FBBh	CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000
FBCh	CCPR1L			egister 1 Low						xxxx
FBDh	CCPR1H			egister 1 High	,					xxxx
FBEh	ECCP1DEL	P1RSEN	P1DC6	P1DC5	P1DC4	P1DC3	P1DC2	P1DC1	P1DC0	0000
FBFh	ECCP1AS	ECCP1ASE	ECCP1AS2		ECCP1AS0	PSS1AC1	PSS1AC0	PSS1BD1	PSS1BD0	0000
FC0h	ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	0-00
FC1h	ADCON1	TRIGSEL1	TRIGSEL0	VCFG1	VCFG0	VNCFG	CHSN2	CHSN1	CHSN0	0000
FC2h	ADCON0	_	CHS4	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	-000
FC3h	ADRESL	A/D Result R			01102	0101	0100	CORDONE	Abon	xxxx
FC4h	ADRESH									
FC5h	SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	xxxx 0000
FC6h	SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000
FC7h	SSP1STAT	SMP	CKE		P	S	R/W	UA	BF	
FC8h	SSP13TAT SSP1ADD				Г Mode. SSP1 E					0000
FC9h	SSP1ADD SSP1BUF			Ismit Register			Jau Register		woue	0000
FCAh	T2CON	NISSF Recen		T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000
FCBh	PR2	Timer2 Period		12001F32	12001F31	12001F30	TWRZUN	1204531	120450	
FCCh	TMR2		0							1111
		Timer2 Regis		TIOUDOU	TIOUDOO	000051	<b>T</b> (0)(1)0	5544	-	0000
FCDh	T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	0000
FCEh	TMR1L	Timer1 Regis	,							XXXX
FCFh	TMR1H	Timer1 Regis								XXXX
FD0h	RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	0111
FD1h	WDTCON	REGSLP	- (2)	ULPLVL	SRETEN	- (2)	ULPEN	ULPSINK	SWDTEN	0-x0
FD2h	IPR5	TMR7GIP <sup>(3)</sup>	TMR12IP <sup>(3)</sup>		TMR8IP	TMR7IP <sup>(3)</sup>	TMR6IP	TMR5IP	TMR4IP	1111
FD3h	OSCCON	IDLEN	IRCF2	IRCF1	IRCF0	OSTS	HFIOFS	SCS1	SCS0	0110
FD4h	SPBRGH1			rator High Byte	1	_	_	_	_	0000
FD5h	TOCON	TMR00N	T08BIT	TOCS	TOSE	PSA	TOPS2	TOPS1	TOPS0	1111
FD6h	TMR0L	Timer0 Regis	,							XXXX
FD7h	TMR0H	Timer0 Regis	ter High Byte							0000
FD8h	STATUS		—	—	Ν	OV	Z	DC	С	2
FD9h	FSR2L	Indirect Data	Memory Addr	ess Pointer 2	Low Byte					xxxx
FDAh	FSR2H	—	—	—	—	Indirect Data	Memory Add	ress Pointer 2	High Byte	
FDBh	PLUSW2	Uses contents value of FSR		address data ı	memory – valu	ue of FSR2 pro	e-incremented	d (not a physic	cal register) –	
FDCh	PREINC2	Uses content	s of FSR2 to a	address data i	memory – valu	ue of FSR2 pro	eincremente	ed (not a physi	ical register)	

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

2: Unimplemented on 64-pin devices (PIC18F6XK90).

**3:** Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

# 查询PIC18F86K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
FDFh	INDF2	Uses content	s of FSR2 to a	address data	memory – val	ue of FSR2 no	t changed (no	ot a physical re	egister)	
FE0h	BSR	_	_	_	_	Bank Select F	Register			0000
FE1h	FSR1L	Indirect Data	Memory Addr	ess Pointer 1	Low Byte					XXXX XXXX
FE2h	FSR1H	_	_	_	_	Indirect Data	Memory Addr	ess Pointer 1	High Byte	xxxx
FE3h	PLUSW1		s of FSR1 to a 1 offset by W	address data	memory – val	ue of FSR1 pro	e-incremented	d (not a physic	cal register) –	
FE4h	PREINC1	Uses content	s of FSR1 to a	address data	memory – val	ue of FSR1 pr	e-incremented	d (not a physic	cal register)	
FE5h	POSTDEC1	Uses content	s of FSR1 to a	address data	memory – val	ue of FSR1 po	st-decrement	ed (not a phys	sical register)	
FE6h	POSTINC1	Uses content	s of FSR1 to a	address data	memory – val	ue of FSR1 po	st-incremente	ed (not a phys	ical register)	
FE7h	INDF1	Uses content	s of FSR1 to a	address data	memory - val	ue of FSR1 no	t changed (no	ot a physical re	egister)	
FE8h	WREG	Working Reg	ister							XXXX XXXX
FE9h	FSR0L	Indirect Data	Memory Addr	ess Pointer 0	Low Byte					XXXX XXXX
FEAh	FSR0H	_	—		_	Indirect Data	Memory Addr	ess Pointer 0	High Byte	xxxx
FEBh	PLUSW0		Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register) – value of FSR0 offset by W							
FECh	PREINC0	Uses content	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register)							
FEDh	POSTDEC0	Uses content	Uses contents of FSR0 to address data memory – value of FSR0 post-decremented (not a physical register)							
FEEh	POSTINC0	Uses content	Uses contents of FSR0 to address data memory – value of FSR0 post-incremented (not a physical register)							
FEFh	INDF0	Uses content	s of FSR0 to a	address data	memory – val	ue of FSR0 no	t changed (no	ot a physical r	egister)	
FF0h	INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	1100 0000
FF1h	INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	1111 1111
FF2h	INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INTOIF	RBIF	0000 0002
FF3h	PRODL	Product Regi	ster Low Byte							XXXX XXXX
FF4h	PRODH	Product Regi	ster High Byte	9						xxxxxxxx
FF5h	TABLAT	Program Mer	nory Table La	tch						0000 0000
FF6h	TBLPTRL	Program Mer	nory Table Po	inter Low Byt	e (TBLPTR<7	:0>)				0000 0000
FF7h	TBLPTRH	Program Mer	nory Table Po	inter High By	te (TBLPTR<1	5:8>)				0000 0000
FF8h	TBLPTRU	_	_	bit 21	Program Mei	nory Table Po	inter Upper B	yte (TBLPTR<	<20:16>)	00 0000
FF9h	PCL	PC Low Byte	(PC<7:0>)							0000 0000
FFAh	PCLATH	Holding Regi	ster for PC<1	5:8>						0000 0000
FFBh	PCLATU	-	—	—	Holding Regi	ster for PC<20	):16>			0 0000
FFCh	STKPTR	STKFUL	STKUNF	_	Return Stack	Pointer				uu-0 0000
FFDh	TOSL	Top-of-Stack	Low Byte (TO	S<7:0>)						0000 0000
FFEh	TOSH	+	High Byte (TC	,						0000 0000
FFFh	TOSU	· _ ·	_	_	Top-of-Stack	Upper Byte (T	OS<20.16>)			0 0000

Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented. Note 1:

Unimplemented on 64-pin devices (PIC18F6XK90). 2:

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

#### 查询PIC18F86K90供应商 6.3.5 STATUS REGISTER

The STATUS register, shown in Register 6-2, contains the arithmetic status of the ALU. The STATUS register can be the operand for any instruction, as with any other register. If the STATUS register is the destination

for an instruction that affects the Z, DC, C, OV or N bits, the write to these five bits is disabled.

These bits are set or cleared according to the device logic. Therefore, the result of an instruction with the STATUS register as destination may be different than intended. For example, CLRF STATUS will set the Z bit but leave the other bits unchanged. The STATUS register then reads back as '000u uluu'.

It is recommended, therefore, that only BCF, BSF, SWAPF, MOVFF and MOVWF instructions be used to alter the STATUS register because these instructions do not affect the Z, C, DC, OV or N bits in the STATUS register.

For other instructions not affecting any Status bits, see the instruction set summaries in Table 29-2 and Table 29-3.

Note: The C and DC bits operate, in subtraction, as borrow and digit borrow bits, respectively.

# REGISTER 6-2: STATUS REGISTER

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
		—	Ν	OV	Z	DC <sup>(1)</sup>	C <sup>(2)</sup>	
bit 7							bit (	
Legend:								
R = Read	lable bit	W = Writable	bit	U = Unimpler	nented bit, rea	d as '0'		
	e at POR	'1' = Bit is set		'0' = Bit is cle		x = Bit is unkr	nown	
bit 7-5	-	ented: Read as '	0.					
bit 4	(ALU MSB 1 = Result	used for signed a	rithmetic (2's c	omplement). It i	ndicates whet	her the result wa	as negative	
bit 3	which caus 1 = Overflo	ow bit used for signed an ses the sign bit (b ow occurred for si erflow occurred	it 7) to change	state.			bit magnitude	
bit 2		sult of an arithme sult of an arithme			<b>.</b> 0			
bit 1	<ul> <li>0 = The result of an arithmetic or logic operation is not zero</li> <li>DC: Digit Carry/Borrow bit<sup>(1)</sup></li> <li>For ADDWF, ADDLW, SUBLW and SUBWF instructions:</li> <li>1 = A carry-out from the 4th low-order bit of the result occurred</li> <li>0 = No carry-out from the 4th low-order bit of the result</li> </ul>							
bit 0	1 = A carry	orrow bit <sup>(2)</sup> , ADDLW, SUBI v-out from the Mo ry-out from the M	st Significant b	it of the result c				
Note 1: 2:	operand. For ro	polarity is reverse tate (RRF, RLF) polarity is revers tate (RRF, RLF	instructions, th ed. A subtracti	nis bit is loaded on is executed	with either bit 4 by adding the 2	or bit 3 of the s 2's complement	ource register of the second	

# 6.4 Data Addressing Modes

Note:	The execution of some instructions in the							
	core PIC18 instruction set are changed							
	when the PIC18 extended instruction set is							
	enabled. For more information, see							
	Section 6.6 "Data Memory and the							
	Extended Instruction Set".							

While the program memory can be addressed in only one way, through the program counter, information in the data memory space can be addressed in several ways. For most instructions, the addressing mode is fixed. Other instructions may use up to three modes, depending on which operands are used and whether or not the extended instruction set is enabled.

The addressing modes are:

- Inherent
- Literal
- Direct
- Indirect

An additional addressing mode, Indexed Literal Offset, is available when the extended instruction set is enabled (XINST Configuration bit = 1). For details on this mode's operation, see **Section 6.6.1 "Indexed Addressing with Literal Offset**".

# 6.4.1 INHERENT AND LITERAL ADDRESSING

Many PIC18 control instructions do not need any argument at all. They either perform an operation that globally affects the device or they operate implicitly on one register. This addressing mode is known as Inherent Addressing. Examples of this mode include SLEEP, RESET and DAW.

Other instructions work in a similar way, but require an additional explicit argument in the opcode. This method is known as the Literal Addressing mode because the instructions require some literal value as an argument. Examples of this include ADDLW and MOVLW which, respectively, add or move a literal value to the W register. Other examples include CALL and GOTO, which include a 20-bit program memory address.

### 6.4.2 DIRECT ADDRESSING

Direct Addressing specifies all or part of the source and/or destination address of the operation within the opcode itself. The options are specified by the arguments accompanying the instruction.

In the core PIC18 instruction set, bit-oriented and byte-oriented instructions use some version of Direct Addressing by default. All of these instructions include some 8-bit literal address as their Least Significant Byte. This address specifies the instruction's data source as either a register address in one of the banks of data RAM (see Section 6.3.3 "General Purpose Register File") or a location in the Access Bank (see Section 6.3.2 "Access Bank").

The Access RAM bit 'a' determines how the address is interpreted. When 'a' is '1', the contents of the BSR (Section 6.3.1 "Bank Select Register") are used with the address to determine the complete 12-bit address of the register. When 'a' is '0', the address is interpreted as being a register in the Access Bank. Addressing that uses the Access RAM is sometimes also known as Direct Forced Addressing mode.

A few instructions, such as MOVFF, include the entire 12-bit address (either source or destination) in their opcodes. In these cases, the BSR is ignored entirely.

The destination of the operation's results is determined by the destination bit, 'd'. When 'd' is '1', the results are stored back in the source register, overwriting its original contents. When 'd' is '0', the results are stored in the W register. Instructions without the 'd' argument have a destination that is implicit in the instruction, either the target register is being operated on or the W register.

# 6.4.3 INDIRECT ADDRESSING

Indirect Addressing allows the user to access a location in data memory without giving a fixed address in the instruction. This is done by using File Select Registers (FSRs) as pointers to the locations to be read or written to. Since the FSRs are themselves located in RAM as Special Function Registers, they can also be directly manipulated under program control. This makes FSRs very useful in implementing data structures such as tables and arrays in data memory.

The registers for Indirect Addressing are also implemented with Indirect File Operands (INDFs) that permit automatic manipulation of the pointer value with auto-incrementing, auto-decrementing or offsetting with another value. This allows for efficient code using loops, such as the example of clearing an entire RAM bank in Example 6-5. It also enables users to perform Indexed Addressing and other Stack Pointer operations for program memory in data memory.

#### EXAMPLE 6-5: HOW TO CLEAR RAM (BANK 1) USING INDIRECT ADDRESSING

	LFSR	FSR0, 100h	;	
NEXT	CLRF	POSTINC0	;	Clear INDF
			;	register then
			;	inc pointer
	BTFSS	FSROH, 1	;	All done with
			;	Bank1?
	BRA	NEXT	;	NO, clear next
CONTIN	UE		;	YES, continue

# 6.4.3.1 FSR Registers and the INDF Operand

At the core of Indirect Addressing are three sets of registers: FSR0, FSR1 and FSR2. Each represents a pair of 8-bit registers: FSRnH and FSRnL. The four upper bits of the FSRnH register are not used, so each FSR pair holds a 12-bit value. This represents a value that can address the entire range of the data memory in a linear fashion. The FSR register pairs, then, serve as pointers to data memory locations.

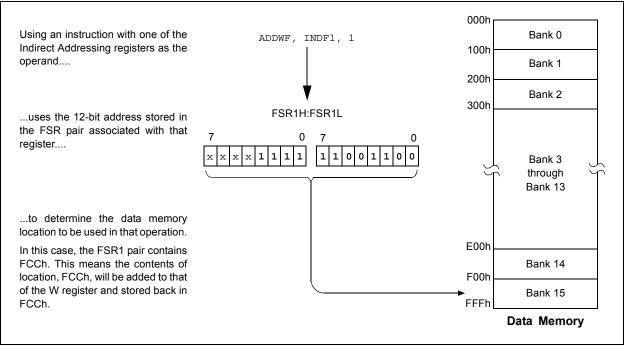
Indirect Addressing is accomplished with a set of Indirect File Operands, INDF0 through INDF2. These can be thought of as "virtual" registers. The operands

### FIGURE 6-8: INDIRECT ADDRESSING

are mapped in the SFR space, but are not physically implemented. Reading or writing to a particular INDF register actually accesses its corresponding FSR register pair. A read from INDF1, for example, reads the data at the address indicated by FSR1H:FSR1L.

Instructions that use the INDF registers as operands actually use the contents of their corresponding FSR as a pointer to the instruction's target. The INDF operand is just a convenient way of using the pointer.

Because Indirect Addressing uses a full 12-bit address, data RAM banking is not necessary. Thus, the current contents of the BSR and the Access RAM bit have no effect on determining the target address.



# 查询PIC18F86K90供应商

6.4.3.2 FSR Registers and POSTINC, POSTDEC, PREINC and PLUSW

In addition to the INDF operand, each FSR register pair also has four additional indirect operands. Like INDF, these are "virtual" registers that cannot be indirectly read or written to. Accessing these registers actually accesses the associated FSR register pair, but also performs a specific action on its stored value.

These operands are:

- POSTDEC Accesses the FSR value, then automatically decrements it by '1' afterwards
- POSTINC Accesses the FSR value, then automatically increments it by '1' afterwards
- PREINC Increments the FSR value by '1', then uses it in the operation
- PLUSW Adds the signed value of the W register (range of -127 to 128) to that of the FSR and uses the new value in the operation

In this context, accessing an INDF register uses the value in the FSR registers without changing them. Similarly, accessing a PLUSW register gives the FSR value, offset by the value in the W register – with neither value actually changed in the operation. Accessing the other virtual registers changes the value of the FSR registers.

Operations on the FSRs with POSTDEC, POSTINC and PREINC affect the entire register pair. Rollovers of the FSRnL register, from FFh to 00h, carry over to the FSRnH register. On the other hand, results of these operations do not change the value of any flags in the STATUS register (for example, Z, N and OV bits).

The PLUSW register can be used to implement a form of Indexed Addressing in the data memory space. By manipulating the value in the W register, users can reach addresses that are fixed offsets from pointer addresses. In some applications, this can be used to implement some powerful program control structure, such as software stacks, inside of data memory.

# 6.4.3.3 Operations by FSRs on FSRs

Indirect Addressing operations that target other FSRs or virtual registers represent special cases. For example, using an FSR to point to one of the virtual registers will not result in successful operations.

As a specific case, assume that the FSR0H:FSR0L registers contain FE7h, the address of INDF1. Attempts to read the value of the INDF1, using INDF0 as an operand, will return 00h. Attempts to write to INDF1, using INDF0 as the operand, will result in a NOP.

On the other hand, using the virtual registers to write to an FSR pair may not occur as planned. In these cases, the value will be written to the FSR pair, but without any incrementing or decrementing. Thus, writing to INDF2 or POSTDEC2 will write the same value to the FSR2H:FSR2L.

Since the FSRs are physical registers mapped in the SFR space, they can be manipulated through all direct operations. Users should proceed cautiously when working on these registers, however, particularly if their code uses Indirect Addressing.

Similarly, operations by Indirect Addressing are generally permitted on all other SFRs. Users should exercise the appropriate caution, so that they do not inadvertently change settings that might affect the operation of the device.

# 6.5 Program Memory and the Extended Instruction Set

The operation of program memory is unaffected by the use of the extended instruction set.

Enabling the extended instruction set adds five additional two-word commands to the existing PIC18 instruction set: ADDFSR, CALLW, MOVSF, MOVSS and SUBFSR. These instructions are executed as described in Section 6.2.4 "Two-Word Instructions".

# 6.6 Data Memory and the Extended Instruction Set

Enabling the PIC18 extended instruction set (XINST Configuration bit = 1) significantly changes certain aspects of data memory and its addressing. Using the Access Bank for many of the core PIC18 instructions introduces a new addressing mode for the data memory space. This mode also alters the behavior of Indirect Addressing using FSR2 and its associated operands.

What does not change is just as important. The size of the data memory space is unchanged, as well as its linear addressing. The SFR map remains the same. Core PIC18 instructions can still operate in both Direct and Indirect Addressing mode. Inherent and literal instructions do not change at all. Indirect Addressing with FSR0 and FSR1 also remains unchanged.

### 6.6.1 INDEXED ADDRESSING WITH LITERAL OFFSET

Enabling the PIC18 extended instruction set changes the behavior of Indirect Addressing using the FSR2 register pair and its associated file operands. Under the proper conditions, instructions that use the Access Bank – that is, most bit-oriented and byte-oriented instructions – can invoke a form of Indexed Addressing using an offset specified in the instruction. This special addressing mode is known as Indexed Addressing with Literal Offset or the Indexed Literal Offset mode.

When using the extended instruction set, this addressing mode requires the following:

- Use of the Access Bank ('a' = 0)
- A file address argument that is less than or equal to 5Fh

Under these conditions, the file address of the instruction is not interpreted as the lower byte of an address (used with the BSR in Direct Addressing) or as an 8-bit address in the Access Bank. Instead, the value is interpreted as an offset value to an Address Pointer specified by FSR2. The offset and the contents of FSR2 are added to obtain the target address of the operation.

# 6.6.2 INSTRUCTIONS AFFECTED BY INDEXED LITERAL OFFSET MODE

Any of the core PIC18 instructions that can use Direct Addressing are potentially affected by the Indexed Literal Offset Addressing mode. This includes all byte-oriented and bit-oriented instructions, or almost one-half of the standard PIC18 instruction set. Instructions that only use Inherent or Literal Addressing modes are unaffected.

Additionally, byte-oriented and bit-oriented instructions are not affected, if they do not use the Access Bank (Access RAM bit = 1) or include a file address of 60h or above. Instructions meeting these criteria will continue to execute as before. A comparison of the different possible addressing modes when the extended instruction set is enabled is shown in Figure 6-9.

Those who desire to use byte-oriented or bit-oriented instructions in the Indexed Literal Offset mode should note the changes to assembler syntax for this mode. This is described in more detail in **Section 29.2.1** "Extended Instruction Syntax".

# 查询PIC18F86K90供应商

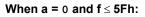
### FIGURE 6-9: COMPARING ADDRESSING OPTIONS FOR BIT-ORIENTED AND BYTE-ORIENTED INSTRUCTIONS (EXTENDED INSTRUCTION SET ENABLED)

### **EXAMPLE INSTRUCTION:** ADDWF, f, d, a (Opcode: 0010 01da ffff ffff)

### When a = 0 and $f \ge 60h$ :

The instruction executes in Direct Forced mode. 'f' is interpreted as a location in the Access RAM between 060h and FFFh. This is the same as locations, F60h to FFFh (Bank 15), of data memory.

Locations below 060h are not available in this addressing mode.

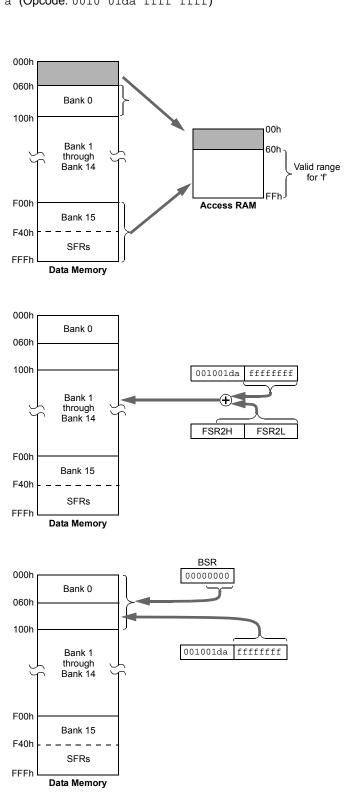


The instruction executes in Indexed Literal Offset mode. 'f' is interpreted as an offset to the address value in FSR2. The two are added together to obtain the address of the target register for the instruction. The address can be anywhere in the data memory space.

Note that in this mode, the correct syntax is now: ADDWF [k], d where 'k' is the same as 'f'.

#### When a = 1 (all values of f):

The instruction executes in Direct mode (also known as Direct Long mode). 'f' is interpreted as a location in one of the 16 banks of the data memory space. The bank is designated by the Bank Select Register (BSR). The address can be in any implemented bank in the data memory space.



### 查询PIC18F86K90供应商

### 6.6.3 MAPPING THE ACCESS BANK IN INDEXED LITERAL OFFSET MODE

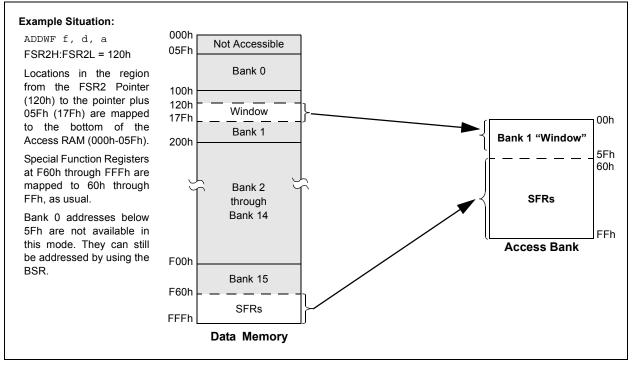
The use of Indexed Literal Offset Addressing mode effectively changes how the lower part of Access RAM (00h to 5Fh) is mapped. Rather than containing just the contents of the bottom part of Bank 0, this mode maps the contents from Bank 0 and a user-defined "window" that can be located anywhere in the data memory space.

The value of FSR2 establishes the lower boundary of the addresses mapped into the window, while the upper boundary is defined by FSR2 plus 95 (5Fh). Addresses in the Access RAM above 5Fh are mapped as previously described. (See **Section 6.3.2 "Access Bank**".) An example of Access Bank remapping in this addressing mode is shown in Figure 6-10. Remapping the Access Bank applies *only* to operations using the Indexed Literal Offset mode. Operations that use the BSR (Access RAM bit = 1) will continue to use Direct Addressing as before. Any Indirect or Indexed Addressing operation that explicitly uses any of the indirect file operands (including FSR2) will continue to operate as standard Indirect Addressing. Any instruction that uses the Access Bank, but includes a register address of greater than 05Fh, will use Direct Addressing and the normal Access Bank map.

# 6.6.4 BSR IN INDEXED LITERAL OFFSET MODE

Although the Access Bank is remapped when the extended instruction set is enabled, the operation of the BSR remains unchanged. Direct Addressing, using the BSR to select the data memory bank, operates in the same manner as previously described.

# FIGURE 6-10: REMAPPING THE ACCESS BANK WITH INDEXED LITERAL OFFSET ADDRESSING



查询PIC18F86K90供应商 NOTES:

### 查询PIC18F86K90供应商

7.0 FLASH PROGRAM MEMORY

The Flash program memory is readable, writable and erasable during normal operation over the entire VDD range.

A read from program memory is executed on one byte at a time. For execution of a write to or erasure of program memory:

- Memory of 32 Kbytes and 64 Kbytes (PIC18FX5K90 and PIC18FX6K90 devices) – Blocks of 64 bytes
- Memory of 128 Kbytes (PIC18FX7K90 devices) Blocks of 128 bytes

Writing or erasing program memory will cease instruction fetches until the operation is complete. The program memory cannot be accessed during the write or erase, therefore, code cannot execute. An internal programming timer terminates program memory writes and erases.

A value written to program memory does not need to be a valid instruction. Executing a program memory location that forms an invalid instruction results in a NOP.

#### 7.1 Table Reads and Table Writes

In order to read and write program memory, there are two operations that allow the processor to move bytes between the program memory space and the data RAM:

- Table Read (TBLRD)
- Table Write (TBLWT)

The program memory space is 16 bits wide, while the data RAM space is 8 bits wide. Table reads and table writes move data between these two memory spaces through an 8-bit register (TABLAT).

Table read operations retrieve data from program memory and place it into the data RAM space. Figure 7-1 shows the operation of a table read with program memory and data RAM.

Table write operations store data from the data memory space into holding registers in program memory. The procedure to write the contents of the holding registers into program memory is detailed in **Section 7.5** "Writing **to Flash Program Memory**". Figure 7-2 shows the operation of a table write with program memory and data RAM.

Table operations work with byte entities. A table block containing data, rather than program instructions, is not required to be word-aligned. Therefore, a table block can start and end at any byte address. If a table write is being used to write executable code into program memory, program instructions will need to be word-aligned.

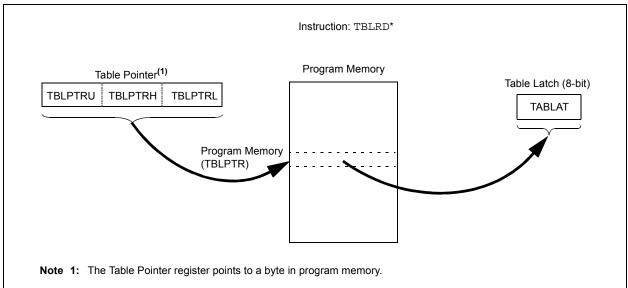
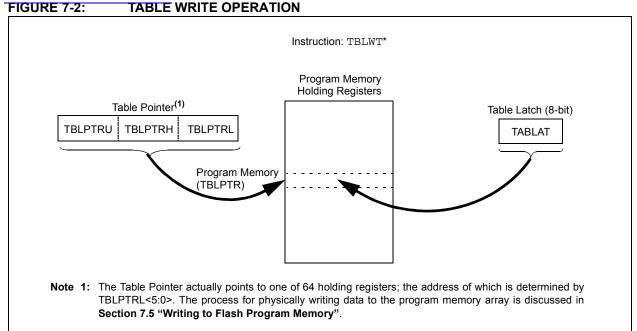


FIGURE 7-1: TABLE READ OPERATION

查询PIC18F86K90供应商



#### 7.2 Control Registers

Several control registers are used in conjunction with the  ${\tt TBLRD}$  and  ${\tt TBLWT}$  instructions. These include the:

- EECON1 register
- EECON2 register
- TABLAT register
- TBLPTR registers

#### 7.2.1 EECON1 AND EECON2 REGISTERS

The EECON1 register (Register 7-1) is the control register for memory accesses. The EECON2 register, not a physical register, is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

The EEPGD control bit determines if the access is a program or data EEPROM memory access. When clear, any subsequent operations operate on the data EEPROM memory. When set, any subsequent operations operate on the program memory.

The CFGS control bit determines if the access is to the Configuration/Calibration registers or to program memory/data EEPROM memory. When set, subsequent operations operate on Configuration registers regardless of EEPGD (see **Section 28.0 "Special Features of the CPU"**). When clear, memory selection access is determined by EEPGD. The FREE bit, when set, allows a program memory erase operation. When FREE is set, the erase operation is initiated on the next WR command. When FREE is clear, only writes are enabled.

The WREN bit, when set, allows a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WR bit is set and cleared when the internal programming timer expires and the write operation is complete.

Note:	During normal operation, the WRERR is
	read as '1'. This can indicate that a write
	operation was prematurely terminated by
	a Reset, or a write operation was
	attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software. It is cleared in hardware at the completion of the write operation.

Note: The EEIF interrupt flag bit (PIR6<4>) is set when the write is complete. It must be cleared in software.

#### 查询PIC18F86K90供应商 REGISTER 7-1: EECON1: EEPROM CONTROL REGISTER 1

R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0
EEPGD	CFGS	—	FREE	WRERR <sup>(1)</sup>	WREN	WR	RD
bit 7							bit 0

Legend:	S = Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	EEPGD: Flash Program or Data EEPROM Memory Select bit
	1 = Access Flash program memory
	0 = Access data EEPROM memory
bit 6	CFGS: Flash Program/Data EEPROM or Configuration Select bit
	1 = Access Configuration registers
	0 = Access Flash program or data EEPROM memory
bit 5	Unimplemented: Read as '0'
bit 4	FREE: Flash Block Erase Enable bit
	1 = Erase the program memory row addressed by TBLPTR on the next WR command
	(cleared by completion of erase operation)
	0 = Perform write-only
bit 3	WRERR: Flash Program/Data EEPROM Error Flag bit <sup>(1)</sup>
	1 = A write operation is prematurely terminated (any Reset during self-timed programming in normal
	operation or an improper write attempt)
	0 = The write operation completed
bit 2	WREN: Flash Program/Data EEPROM Write Enable bit
	1 = Allows write cycles to Flash program/data EEPROM
	0 = Inhibits write cycles to Flash program/data EEPROM
bit 1	WR: Write-Control bit
	1 = Initiates a data EEPROM erase/write cycle, or a program memory erase cycle or write cycle.
	(The operation is self-timed and the bit is cleared by hardware once write is complete.
	The WR bit can only be set (not cleared) in software.)
	0 = Write cycle to the EEPROM is complete
bit 0	RD: Read Control bit
	1 = Initiates an EEPROM read (Read takes one cycle. RD is cleared in hardware. The RD bit can only
	be set (not cleared) in software. RD bit cannot be set when EEPGD = 1 or CFGS = 1.)
	0 = Does not initiate an EEPROM read

**Note 1:** When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.

### 查询PIC18F86K90供应商

#### 7.2.2 TABLAT – TABLE LATCH REGISTER

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch register is used to hold 8-bit data during data transfers between program memory and data RAM.

#### 7.2.3 TBLPTR – TABLE POINTER REGISTER

The Table Pointer (TBLPTR) register addresses a byte within the program memory. The TBLPTR is comprised of three SFR registers: Table Pointer Upper Byte, Table Pointer High Byte and Table Pointer Low Byte (TBLPTRU:TBLPTRH:TBLPTRL). These three registers join to form a 22-bit wide pointer. The low-order 21 bits allow the device to address up to 2 Mbytes of program memory space. The 22nd bit allows access to the Device ID, the User ID and the Configuration bits.

The Table Pointer register, TBLPTR, is used by the TBLRD and TBLWT instructions. These instructions can update the TBLPTR in one of four ways, based on the table operation. These operations are shown in Table 7-1 and only affect the low-order 21 bits.

#### 7.2.4 TABLE POINTER BOUNDARIES

TBLPTR is used in reads, writes and erases of the Flash program memory.

When a TBLRD is executed, all 22 bits of the TBLPTR determine which byte is read from program memory into TABLAT.

When a TBLWT is executed, the six LSbs of the Table Pointer register (TBLPTR<5:0>) determine which of the 64 program memory holding registers is written to. When the timed write to program memory begins (via the WR bit), the 16 MSbs of the TBLPTR (TBLPTR<21:6>) determine which program memory block of 64 bytes is written to. For more detail, see **Section 7.5 "Writing to Flash Program Memory"**.

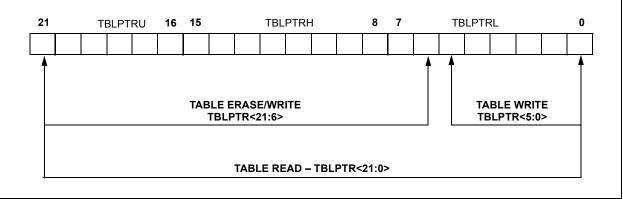
When an erase of program memory is executed, the 16 MSbs of the Table Pointer register (TBLPTR<21:6>) point to the 64-byte block that will be erased. The Least Significant bits (TBLPTR<5:0>) are ignored.

Figure 7-3 describes the relevant boundaries of TBLPTR based on Flash program memory operations.

#### TABLE 7-1: TABLE POINTER OPERATIONS WITH TBLRD AND TBLWT INSTRUCTIONS

Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

#### FIGURE 7-3: TABLE POINTER BOUNDARIES BASED ON OPERATION



#### 查询PIC18F86K90供应商

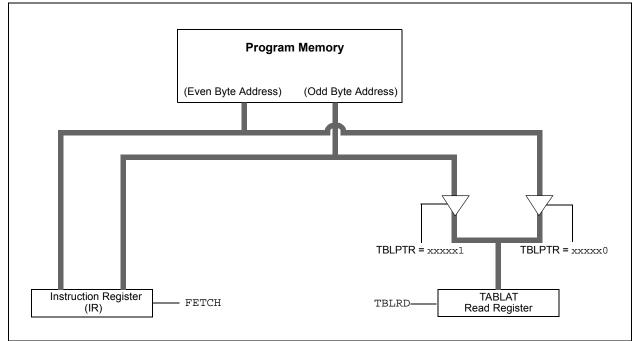
#### 7.3 Reading the Flash Program Memory

The TBLRD instruction is used to retrieve data from program memory and places it into data RAM. Table reads from program memory are performed one byte at a time.

TBLPTR points to a byte address in program space. Executing TBLRD places the byte pointed to into TABLAT. In addition, TBLPTR can be modified automatically for the next table read operation.

The internal program memory is typically organized by words. The Least Significant bit of the address selects between the high and low bytes of the word. Figure 7-4 shows the interface between the internal program memory and the TABLAT.

#### FIGURE 7-4: READS FROM FLASH PROGRAM MEMORY



#### EXAMPLE 7-1: READING A FLASH PROGRAM MEMORY WORD

	MOVLW MOVWF MOVLW	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH	; Load TBLPTR with the base ; address of the word
	MOVWF	TBLPTRH	
	MOVLW	CODE_ADDR_LOW	
	MOVWF	TBLPTRL	
READ_WORD			
	TBLRD*-	÷	; read into TABLAT and increment
	MOVF	TABLAT, W	; get data
	MOVWF	WORD_EVEN	
	TBLRD*-	÷	; read into TABLAT and increment
	MOVF	TABLAT, W	; get data
	MOVF	WORD_ODD	

#### 查询PIC18F86K90供应商

#### 7.4 Erasing Flash Program Memory

The erase block is 32 words or 64 bytes for the PIC18FX5K90 and PIC18FX6K90 devices, and 64 words or 128 bytes for the PIC18FX7K90 devices. Word erase in the Flash array is not supported.

When initiating an erase sequence from the microcontroller itself, a block of 64 or 128 bytes of program memory is erased. The Most Significant 16 bits of the TBLPTR<21:6> point to the block being erased. The TBLPTR<5:0> bits are ignored.

The EECON1 register commands the erase operation. The EEPGD bit must be set to point to the Flash program memory. The WREN bit must be set to enable write operations. The FREE bit is set to select an erase operation.

For protection, the write initiate sequence for EECON2 must be used.

A long write is necessary for erasing the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

#### 7.4.1 FLASH PROGRAM MEMORY ERASE SEQUENCE

The sequence of events for erasing a block of internal program memory location is:

- 1. Load the Table Pointer register with the address of row to be erased.
- 2. Set the EECON1 register for the erase operation:
  - · Set the EEPGD bit to point to program memory
  - Clear the CFGS bit to access program memory
  - · Set the WREN bit to enable writes
  - Set the FREE bit to enable the erase
- 3. Disable the interrupts.
- 4. Write 0x55 to EECON2.
- 5. Write 0xAA to EECON2.
- Set the WR bit. This begins the row erase cycle. The CPU will stall for the duration of the erase for TIW. (See parameter D133A.)
- 7. Re-enable interrupts.

	MOVLW MOVWF MOVLW	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH	; load TBLPTR with the base ; address of the memory block
	MOVWF MOVLW MOVWF	TBLPTRH CODE_ADDR_LOW TBLPTRL	
ERASE_ROW			
	BSF	EECON1, EEPGD	; point to Flash program memory
	BCF	EECON1, CFGS	; access Flash program memory
	BSF	EECON1, WREN	; enable write to memory
	BSF	EECON1, FREE	; enable Row Erase operation
	BCF	INTCON, GIE	; disable interrupts
Required	MOVLW	0x55	
Sequence	MOVWF	EECON2	; write 55h
	MOVLW	0xAA	
	MOVWF	EECON2	; write OAAh
	BSF	EECON1, WR	; start erase (CPU stall)
	BSF	INTCON, GIE	; re-enable interrupts

#### EXAMPLE 7-2: ERASING A FLASH PROGRAM MEMORY ROW

#### 查询PIC18F86K90供应商

#### 7.5 Writing to Flash Program Memory

The programming block is 32 words or 64 bytes for PIC18FX5K90 and PIC18FX6K90 devices, and 64 words or 128 bytes for PIC18FX7K90 devices. Word or byte programming is not supported.

Table writes are used internally to load the holding registers needed to program the Flash memory. There are 64 holding registers for PIC18FX5K90 and PIC18FX6K90 devices and 128 holding registers for PIC18FX7K90 used by the table writes for programming.

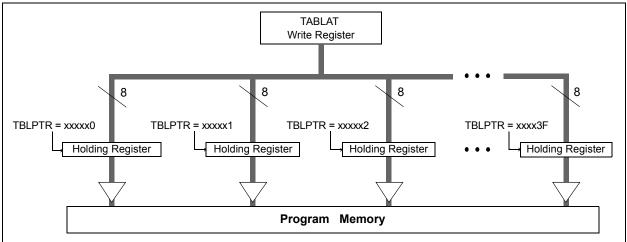
Since the Table Latch (TABLAT) is only a single byte, the TBLWT instruction may need to be executed 64 times for each programming operation. All of the table write operations will essentially be short writes because only the holding registers are written. At the end of updating the 64 or 128 holding registers, the EECON1 register must be written to in order to start the programming operation with a long write.

The long write is necessary for programming the internal Flash. Instruction execution is halted while in a long write cycle. The long write is terminated by the internal programming timer.

The EEPROM on-chip timer controls the write time. The write/erase voltages are generated by an on-chip charge pump, rated to operate over the voltage range of the device.

Note: The default value of the holding registers on device Resets and after write operations is FFh. A write of FFh to a holding register does not modify that byte. This means that individual bytes of program memory may be modified, provided that the change does not attempt to change any bit from a '0' to a '1'. When modifying individual bytes, it is not necessary to load all 64 or 128 holding registers before executing a write operation.





### 7.5.1 FLASH PROGRAM MEMORY WRITE SEQUENCE

The sequence of events for programming an internal program memory location should be:

- 1. Read the 64 or 128 bytes into RAM.
- 2. Update the data values in RAM as necessary.
- 3. Load the Table Pointer register with the address being erased.
- 4. Execute the row erase procedure.
- 5. Load the Table Pointer register with the address of the first byte being written.
- 6. Write the 64 or 128 bytes into the holding registers with auto-increment.
- 7. Set the EECON1 register for the write operation:
  - Set the EEPGD bit to point to program memory
  - Clear the CFGS bit to access program memory
  - Set WREN to enable byte writes
- 8. Disable the interrupts.
- 9. Write 0x55 to EECON2.

- 10. Write 0xAA to EECON2.
- 11. Set the WR bit. This will begin the write cycle. The CPU will stall for duration of the write for Tiw (see parameter D133A).
- 12. Re-enable the interrupts.
- 13. Verify the memory (table read).

An example of the required code is shown in Example 7-3 on the following page.

- **Note:** Before setting the WR bit, the Table Pointer address needs to be within the intended address range of the 64 or 128 bytes in the holding register.
- **Note:** Self-write execution to Flash and EEPROM memory cannot be done while running in LP Oscillator mode (Low-Power mode). Therefore, executing a self-write will put the device into High-Power mode.

#### 查询PIC18F86K90供应商

#### EXAMPLE 7-3: WRITING TO FLASH PROGRAM MEMORY

EXAMPLE 7-3:	VVRI	TING TO FLASH PROU	JK/	
	MOVLW	SIZE_OF_BLOCK	;	number of bytes in erase block
	MOVWF	COUNTER		
	MOVLW	BUFFER_ADDR_HIGH	;	point to buffer
	MOVWF	FSR0H		
	MOVLW	BUFFER_ADDR_LOW		
	MOVWF	FSROL		
	MOVLW	CODE_ADDR_UPPER		Load TBLPTR with the base
	MOVWF	TBLPTRU	;	address of the memory block
	MOVLW	CODE_ADDR_HIGH		
	MOVWF MOVLW	TBLPTRH		
	MOVLW MOVWF	CODE_ADDR_LOW TBLPTRL		
READ_BLOCK	MOVWF	IBLFIRL		
READ_BLOCK	TBLRD*+	F	;	read into TABLAT, and inc
	MOVF	TABLAT, W		get data
	MOVWF			store data
	DECFSZ	COUNTER		done?
	BRA	READ_BLOCK	;	repeat
MODIFY_WORD				
	MOVLW	DATA_ADDR_HIGH	;	point to buffer
	MOVWF	FSROH		
	MOVLW	DATA_ADDR_LOW		
	MOVWF	FSROL		
	MOVLW	NEW_DATA_LOW	;	update buffer word
	MOVWF	POSTINC0		
	MOVLW	NEW_DATA_HIGH		
	MOVWF	INDF0		
ERASE_BLOCK				
	MOVLW	CODE_ADDR_UPPER		load TBLPTR with the base
	MOVWF	TBLPTRU	;	address of the memory block
	MOVLW	CODE_ADDR_HIGH		
	MOVWF	TBLPTRH		
	MOVLW MOVWF	CODE_ADDR_LOW		
	BSF	TBLPTRL EECON1, EEPGD	;	point to Flash program memory
	BCF	EECON1, CFGS		access Flash program memory
	BSF	EECON1, WREN		enable write to memory
	BSF	EECON1, FREE		enable Row Erase operation
	BCF	INTCON, GIE		disable interrupts
	MOVLW	0x55		-
Required	MOVWF	EECON2	;	write 55h
Sequence	MOVLW	0xAA		
	MOVWF	EECON2	;	write OAAh
	BSF	EECON1, WR	;	start erase (CPU stall)
	BSF	INTCON, GIE	;	re-enable interrupts
	TBLRD*-	-		dummy read decrement
	MOVLW	BUFFER_ADDR_HIGH	;	point to buffer
	MOVWF	FSROH		
	MOVLW	BUFFER_ADDR_LOW		
	MOVWF	FSROL		
WRITE_BUFFER_B				
	MOVLW	SIZE_OF_BLOCK	;	number of bytes in holding register
	MOVWF	COUNTER		
WRITE_BYTE_TO_	-			act low but ocf buffor data
	MOVFF	POSTINCO, WREG TABLAT		get low byte of buffer data present data to table latch
	MOVWF TBLWT+*			write data, perform a short write
	IDTMI+,			to internal TBLWT holding register.
	DECEST	COUNTER		loop until buffers are full
	GOTO	WRITE_BYTE_TO_HREGS	,	TOOD AUGTT DALLELD ALE LATT
	0010			

#### 查询PIC18F86K90供应商 EXAMPLE 7-3: WRITING TO FLASH PROGRAM MEMORY (CONTINUED)

PROGRAM_MEMORY	7			
	BSF	EECON1, EE	PGD ;	point to Flash program memory
	BCF	EECON1, CF	GS ;	access Flash program memory
	BSF	EECON1, WRI	EN ;	enable write to memory
	BCF	INTCON, GI	E ;	disable interrupts
	MOVLW	0x55		
Required	MOVWF	EECON2	;	write 55h
Sequence	MOVLW	0xAA		
	MOVWF	EECON2	;	write OAAh
	BSF	EECON1, WR	;	start program (CPU stall)
	BSF	INTCON, GI	E ;	re-enable interrupts
	BCF	EECON1, WRI	EN ;	disable write to memory

#### 7.5.2 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

### 7.5.3 UNEXPECTED TERMINATION OF WRITE OPERATION

If a write is terminated by an unplanned event, such as loss of power or an unexpected Reset, the memory location just programmed should be verified and reprogrammed if needed. If the write operation is interrupted by a MCLR Reset or a WDT Time-out Reset during normal operation, the user can check the WRERR bit and rewrite the location(s) as needed.

#### 7.5.4 PROTECTION AGAINST SPURIOUS WRITES

To protect against spurious writes to Flash program memory, the write initiate sequence must also be followed. See Section 28.0 "Special Features of the CPU" for more detail.

#### 7.6 Flash Program Operation During Code Protection

See Section 28.6 "Program Verification and Code Protection" for details on code protection of Flash program memory.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TBLPTRU	—	—	bit 21 <sup>(1)</sup>	Program Me	emory Table I	Pointer Uppe	r Byte (TBLP	TR<20:16>)	73
TBPLTRH	Program Me	emory Table	Pointer H	ligh Byte (TE	BLPTR<15:8	>)			73
TBLPTRL	Program Me	Program Memory Table Pointer Low Byte (TBLPTR<7:0>)						73	
TABLAT	Program Me	Program Memory Table Latch						73	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
EECON2	EEPROM Control Register 2 (not a physical register)						77		
EECON1	EEPGD	CFGS	_	FREE	WRERR	WREN	WR	RD	77
IPR6	_	_	_	EEIP	_	CMP3IP	CMP2IP	CMP1IP	75
PIR6	_	_	_	EEIF	_	CMP3IF	CMP2IF	CMP1IF	75
PIE6	_	_	_	EEIE	_	CMP3IE	CMP2IE	CMP1IE	78

#### TABLE 7-2: REGISTERS ASSOCIATED WITH PROGRAM FLASH MEMORY

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used during Flash/EEPROM access.

**Note 1:** Bit 21 of TBLPTRU allows access to the device Configuration bits.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商 8.0 DATA EEPROM MEMORY

The data EEPROM is a nonvolatile memory array, separate from the data RAM and program memory, that is used for long-term storage of program data. The PIC18F87K90 family of devices has a 1024-byte data EEPROM. It is not directly mapped in either the register file or program memory space, but is indirectly addressed through the Special Function Registers (SFRs). The EEPROM is readable and writable during normal operation over the entire VDD range.

Five SFRs are used to read and write to the data EEPROM, as well as the program memory. They are:

- EECON1
- EECON2
- EEDATA
- EEADR
- EEADRH

The data EEPROM allows byte read and write. When interfacing to the data memory block, EEDATA holds the 8-bit data for read/write and the EEADRH:EEADR register pair holds the address of the EEPROM location being accessed.

The EEPROM data memory is rated for high erase/write cycle endurance. A byte write automatically erases the location and writes the new data (erase-before-write). The write time is controlled by an on-chip timer; it will vary with voltage and temperature, as well as from chip-to-chip. Please refer to parameter D122 (Table 31-1 in **Section 31.0 "Electrical Characteristics"**) for exact limits.

#### 8.1 EEADR and EEADRH Registers

The EEADRH:EEADR register pair is used to address the data EEPROM for read and write operations. EEADRH holds the two MSbs of the address; the upper 6 bits are ignored. The 10-bit range of the pair can address a memory range of 1024 bytes (00h to 3FFh).

#### 8.2 EECON1 and EECON2 Registers

Access to the data EEPROM is controlled by two registers: EECON1 and EECON2. These are the same registers which control access to the program memory and are used in a similar manner for the data EEPROM.

The EECON1 register (Register 8-1) is the control register for data and program memory access. Control bit, EEPGD, determines if the access will be to program memory or data EEPROM memory. When clear, operations will access the data EEPROM memory. When set, program memory is accessed.

Control bit, CFGS, determines if the access will be to the Configuration registers or to program memory/data EEPROM memory. When set, subsequent operations access Configuration registers. When CFGS is clear, the EEPGD bit selects either program Flash or data EEPROM memory.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WREN bit is set, and cleared, when the internal programming timer expires and the write operation is complete.

Note:	During normal operation, the WRERR is
	read as '1'. This can indicate that a write
	operation was prematurely terminated by
	a Reset or a write operation was
	attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software; it is cleared in hardware at the completion of the write operation.

Note:	The EEIF interrupt flag bit (PIR6<4>) is set
	when the write is complete. It must be
	cleared in software.

Control bits, RD and WR, start read and erase/write operations, respectively. These bits are set by firmware and cleared by hardware at the completion of the operation.

The RD bit cannot be set when accessing program memory (EEPGD = 1). Program memory is read using table read instructions. See **Section 7.1 "Table Reads and Table Writes"** regarding table reads.

The EECON2 register is not a physical register. It is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

#### 查询PIC18F86K90供应商

#### REGISTER 8-1: EECON1: DATA EEPROM CONTROL REGISTER 1

R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0		
EEPGD	CFGS		FREE	WRERR <sup>(1)</sup>	WREN	WR	RD		
bit 7				· · · · ·			bit (		
Legend:		S = Settable	bit						
R = Readable	e bit	W = Writable	bit	U = Unimplen	nented bit, rea	d as '0'			
-n = Value at	POR	'1' = Bit is set	t	'0' = Bit is clea	ared	x = Bit is unki	nown		
bit 7	EEPGD: Fla	ash Program or I	Data EEPROI	M Memory Sele	ct bit				
		Flash program r data EEPROM r							
bit 6	CFGS: Flas	h Program/Data	EEPROM or	Configuration S	Select bit				
		Configuration re		-					
	0 = Access	Flash program o	or data EEPR	OM memory					
bit 5	Unimpleme	ented: Read as '	0'						
bit 4	FREE: Flash Row Erase Enable bit								
	by com	he program mer pletion of an era	•	•	BLPTR on the	e next WR com	mand (cleare		
	0 = Perforn	,		(1)					
bit 3		RERR: Flash Program/Data EEPROM Error Flag bit <sup>(1)</sup>							
	operatio	<ul> <li>A write operation is prematurely terminated (any Reset during self-timed programming in normal operation or an improper write attempt)</li> </ul>							
	0 = The write operation completed								
bit 2	WREN: Flas	sh Program/Data	a EEPROM W	/rite Enable bit					
		write cycles to F write cycles to F							
bit 1	WR: Write-0	Control bit							
	operatio	a data EEPROM erase/write cycle or a program memory erase cycle or write cycle. (The on is self-timed and the bit is cleared by hardware once the write is complete. The WR bit (be set (not cleared) in software.)							
	0 = Write cycle to the EEPROM is complete								
bit 0	RD: Read C	Control bit							
		s an EEPROM re (not cleared) in s							
	be set (not cleared) in software. The RD bit cannot be set when EEPGD = 1 or CFGS = 1.) 0 = Does not initiate an EEPROM read								

### **Note 1:** When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.

#### 查询PIC18F86K90供应商

#### 8.3 Reading the Data EEPROM Memory

To read a data memory location, the user must write the address to the EEADRH:EEADR register pair, clear the EEPGD control bit (EECON1<7>) and then set control bit, RD (EECON1<0>). After one cycle, the data is available in the EEDATA register; therefore, it can be read after one NOP instruction. EEDATA will hold this value until another read operation, or until it is written to by the user (during a write operation). The basic process is shown in Example 8-1.

#### 8.4 Writing to the Data EEPROM Memory

To write an EEPROM data location, the address must first be written to the EEADRH:EEADR register pair and the data written to the EEDATA register. The sequence in Example 8-2 must be followed to initiate the write cycle.

The write will not begin if this sequence is not exactly followed (write 0x55 to EECON2, write 0xAA to EECON2, then set WR bit) for each byte. It is strongly recommended that interrupts be disabled during this code segment.

Additionally, the WREN bit in EECON1 must be set to enable writes. This mechanism prevents accidental writes to data EEPROM due to unexpected code

EXAMPLE 8-1: DATA EEPROM READ

execution (i.e., runaway programs). The WREN bit should be kept clear at all times, except when updating the EEPROM. The WREN bit is not cleared by hardware.

After a write sequence has been initiated, EECON1, EEADRH:EEADR and EEDATA cannot be modified. The WR bit will be inhibited from being set unless the WREN bit is set. The WREN bit must be set on a previous instruction. Both WR and WREN cannot be set with the same instruction.

At the completion of the write cycle, the WR bit is cleared in hardware and the EEPROM Interrupt Flag bit (EEIF) is set. The user may either enable this interrupt, or poll this bit. EEIF must be cleared by software.

#### 8.5 Write Verify

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

Note:	Self-write	execution	to	Flash	and	
	EEPROM	memory can	not t	be done	while	
	running in LP Oscillator mode (Low-Power					
	mode). Th	erefore, exe	cutin	g a self-	-write	
	will put the	e device into l	ligh-	Power m	node.	

MOVLW	DATA_EE_ADDRH	;
MOVWF	EEADRH	; Upper bits of Data Memory Address to read
MOVLW	DATA EE ADDR	;
MOVWF	EEADR	; Lower bits of Data Memory Address to read
BCF	EECON1, EEPGD	; Point to DATA memory
BCF	EECON1, CFGS	; Access EEPROM
BSF	EECON1, RD	; EEPROM Read
NOP MOVF	EEDATA, W	; $W = EEDATA$

#### EXAMPLE 8-2: DATA EEPROM WRITE

	MOVLW	DATA_EE_ADDRH		;
	MOVWF	EEADRH		; Upper bits of Data Memory Address to write
	MOVLW	DATA_EE_ADDR		;
	MOVWF	EEADR		; Lower bits of Data Memory Address to write
	MOVLW	DATA_EE_DATA		i
	MOVWF	EEDATA		; Data Memory Value to write
	BCF	EECON1, EEPGD		; Point to DATA memory
	BCF	EECON1, CFGS		; Access EEPROM
	BSF	EECON1, WREN		; Enable writes
	BCF	INTCON, GIE		; Disable Interrupts
	MOVLW	01100	;	
Required	MOVWF	EECON2		; Write 55h
Sequence	MOVLW	0xAA		;
	MOVWF	EECON2		; Write OAAh
	BTFSC	EECON1, WR		; Wait for write to complete
	GOTO	\$-2		
	BSF	INTCON, GIE		; Enable Interrupts
				; User code execution
	BCF	EECON1, WREN		; Disable writes on write complete (EEIF set)

#### 查询PIC18F86K90供应商

#### 8.6 Operation During Code-Protect

Data EEPROM memory has its own code-protect bits in Configuration Words. External read and write operations are disabled if code protection is enabled.

The microcontroller itself can both read and write to the internal data EEPROM regardless of the state of the code-protect Configuration bit. Refer to **Section 28.0 "Special Features of the CPU"** for additional information.

#### 8.7 Protection Against Spurious Write

There are conditions when the device may not want to write to the data EEPROM memory. To protect against spurious EEPROM writes, various mechanisms have been implemented. On power-up, the WREN bit is cleared. In addition, writes to the EEPROM are blocked during the Power-up Timer period (TPWRT, parameter 33).

The write initiate sequence, and the WREN bit together, help prevent an accidental write during brown-out, power glitch or software malfunction. The WREN bit is not cleared by hardware.

#### 8.8 Using the Data EEPROM

The data EEPROM is a high-endurance, byte addressable array that has been optimized for the storage of frequently changing information (e.g., program variables or other data that are updated often). Frequently changing values will typically be updated more often than specification, D124. If this is not the case, an array refresh must be performed. For this reason, variables that change infrequently (such as constants, IDs, calibration, etc.) should be stored in Flash program memory.

A simple data EEPROM refresh routine is shown in Example 8-3.

Note: If data EEPROM is only used to store constants and/or data that changes often, an array refresh is likely not required. See specification, D124.

EXAMPLE 8-3:	DATA EEPROM REFRESH ROUTINE

	CLRF	EEADR	; Start at address 0
	CLRF	EEADRH	;
	BCF	EECON1, CFGS	; Set for memory
	BCF	EECON1, EEPGD	; Set for Data EEPROM
	BCF	INTCON, GIE	; Disable interrupts
	BSF	EECON1, WREN	; Enable writes
LOOP			; Loop to refresh array
	BSF	EECON1, RD	; Read current address
	MOVLW	0x55	;
	MOVWF	EECON2	; Write 55h
	MOVLW	0xAA	;
	MOVWF	EECON2	; Write OAAh
	BSF	EECON1, WR	; Set WR bit to begin write
	BTFSC	EECON1, WR	; Wait for write to complete
	BRA	\$-2	
	INCFSZ	EEADR, F	; Increment address
	BRA	LOOP	; Not zero, do it again
	INCFSZ	EEADRH, F	; Increment the high address
	BRA	LOOP	; Not zero, do it again
	BCF	EECON1, WREN	; Disable writes
	BSF	INTCON, GIE	; Enable interrupts

### 查询PIC18F86K90供应商

TABLE 8-1: REGISTERS ASSOCIATED WITH DATA EEPROM MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
EEADRH	—		—	-	—	—	EEPROM Ac Register Hig	77	
EEADR	EEPROM Address Register Low Byte						78		
EEDATA	EEPROM Data Register						78		
EECON2	N2 EEPROM Control Register 2 (not a physical register)						77		
EECON1	EEPGD	CFGS	_	FREE	WRERR	WREN	WR	RD	77

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used during Flash/EEPROM access.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商 9.0 8 x 8 HARDWARE MULTIPLIER

#### 9.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows PIC18 devices to be used in many applications previously reserved for digital-signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 9-1.

#### 9.2 Operation

Example 9-1 shows the instruction sequence for an 8 x 8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 9-2 shows the sequence to do an 8 x 8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

#### EXAMPLE 9-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

MOVF	ARG1,	W	;	
MULWF	ARG2		;	ARG1 * ARG2 ->
			;	PRODH:PRODL

#### EXAMPLE 9-2: 8 x 8 SIGNED MULTIPLY ROLITINE

MOVF	ARG1, W		
MULWF	ARG2	; ARG1 * ARG2 ->	
		; PRODH:PRODL	
BTFSC	ARG2, SB	; Test Sign Bit	
SUBWF	PRODH, F	; PRODH = PRODH	
		; - ARG1	
MOVF	ARG2, W		
BTFSC	ARG1, SB	; Test Sign Bit	
SUBWF	PRODH, F	; PRODH = PRODH	
		; – ARG2	

		Program	Cycles	Time			
Routine	Multiply Method	Memory (Words)	(Max)	@ 64 MHz	@ 48 MHz	@ 10 MHz	@ 4 MHz
	Without hardware multiply	13	69	4.3 μs	5.7 μs	27.6 μs	69 μs
8 x 8 unsigned	Hardware multiply	1	1	62.5 ns	83.3 ns	400 ns	1 μs
	Without hardware multiply	33	91	5.6 μs	7.5 μs	36.4 μs	91 μs
8 x 8 signed	Hardware multiply	6	6	375 ns	500 ns	2.4 μs	6 μs
16 x 16	Without hardware multiply	21	242	15.1 μs	20.1 μs	96.8 μs	242 μs
unsigned	Hardware multiply	28	28	1.7 μs	2.3 μs	11.2 μs	28 μs
16 x 16 signed	Without hardware multiply	52	254	15.8 μs	21.2 μs	101.6 μs	254 μs
16 x 16 signed	Hardware multiply	35	40	2.5 μs	3.3 μs	16.0 μs	40 μs

#### TABLE 9-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

#### 查询PIC18F86K90供应商

Example 9-3 shows the sequence to do a 16 x 16 unsigned multiplication. Equation 9-1 shows the algorithm that is used. The 32-bit result is stored in four registers (RES3:RES0).

#### EQUATION 9-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

RES3:RES0	=	ARG1H:ARG1L • ARG2H:ARG2L
	=	$(ARG1H \bullet ARG2H \bullet 2^{16}) +$
		$(ARG1H \bullet ARG2L \bullet 2^8) +$
		$(ARG1L \bullet ARG2H \bullet 2^8) +$
		(ARG1L • ARG2L)

#### EXAMPLE 9-3:

#### 16 x 16 UNSIGNED MULTIPLY ROUTINE

	MOVF	ARG1L, W	
	MULWF	ARG2L	; ARG1L * ARG2L->
			; PRODH:PRODL
	MOVFF	PRODH, RES1	;
	MOVFF	PRODL, RESO	;
;			
	MOVF	ARG1H, W	
	MULWF	ARG2H	; ARG1H * ARG2H->
			; PRODH:PRODL
	MOVFF	PRODH, RES3	;
	MOVFF	PRODL, RES2	;
;			
	MOVF	ARG1L, W	
	MULWF	ARG2H	; ARG1L * ARG2H->
			; PRODH:PRODL
		PRODL, W	;
			; Add cross
		PRODH, W	; products
		RES2, F	;
	CLRF		;
	ADDWFC	RES3, F	;
;			
		ARG1H, W	;
	MULWF		; ARG1H * ARG2L->
			; PRODH:PRODL
		PRODL, W	;
		RES1, F	
			; products
		RES2, F	;
	CLRF		;
	ADDWFC	RES3, F	;

Example 9-4 shows the sequence to do a 16 x 16 signed multiply. Equation 9-2 shows the algorithm used. The 32-bit result is stored in four registers (RES3:RES0). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

#### EQUATION 9-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

RES3:RES0=	ARG1H:ARG1L • ARG2H:ARG2L
=	$(ARG1H \bullet ARG2H \bullet 2^{16}) +$
	$(ARG1H \bullet ARG2L \bullet 2^8) +$
	$(ARG1L \bullet ARG2H \bullet 2^8) +$
	$(ARG1L \bullet ARG2L) +$
	$(-1 \bullet ARG2H < 7 > \bullet ARG1H:ARG1L \bullet 2^{16}) +$
	$(-1 \bullet ARG1H \le 7 \ge \bullet ARG2H: ARG2L \bullet 2^{16})$

#### EXAMPLE 9-4: 16 x 16 SIGNED MULTIPLY ROUTINE

	MOVF	ARG1L,	W		
	MULWF	ARG2L		;	ARG1L * ARG2L ->
				;	PRODH:PRODL
	MOVFF	PRODH,	RES1	;	
		PRODL,			
;					
	MOVF	ARG1H,	W		
	MULWF			;	ARG1H * ARG2H ->
					PRODH:PRODL
	MOVFF	PRODH	RESS		
		PRODL,			
;	110 11 1	I RODE,	1000	'	
	MOVF	ARG1L,	W		
	MULWF		**		ARG1L * ARG2H ->
	NOTWI	ANGZII			PRODH:PRODL
	MOVF		TAT	;	
		RES1, F			Add cross
		PRODH,			products
		PRODE,	vv ,	;	products
	ADDWFC CLRF	KESZ, F			
				;	
	ADDWFC	RES3, F		;	
;	NOTE	10011			
		ARG1H,	W	;	
	MULWF	ARG2L			ARG1H * ARG2L ->
					PRODH:PRODL
		PRODL,		;	
		RES1, F			Add cross
		PRODH,			products
	ADDWFC		, ,	;	
		WREG		;	
	ADDWFC	RES3, F	, ,	;	
;					
					ARG2H:ARG2L neg?
	BRA SIC			;	no, check ARG1
		ARG1L,	W	;	
	SUBWF	RES2		;	
	MOVF	ARG1H,	W	;	
	SUBWFB	RES3		;	
SIC	GN_ARG1				
	BTFSS	ARG1H,	7	;	ARG1H:ARG1L neg?
	BRA	CONT_CC	DE	;	no, done
		ARG2L,	W	;	
	SUBWF	RES2		;	
		ARG2H,	W	;	
	SUBWFB	RES3			
;					
COI	NT_CODE				
	:				

#### 查询PIC18F86K90供应商 10.0 INTERRUPTS

Members of the PIC18F87K90 family of devices have multiple interrupt sources and an interrupt priority feature that allows most interrupt sources to be assigned a high-priority level or a low-priority level. The high-priority interrupt vector is at 0008h and the low-priority interrupt vector is at 0018h. High-priority interrupt events will interrupt any low-priority interrupts that may be in progress.

The registers for controlling interrupt operation are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2, PIR3
- PIE1, PIE2, PIE3
- IPR1, IPR2, IPR3

It is recommended that the Microchip header files supplied with MPLAB<sup>®</sup> IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

In general, interrupt sources have three bits to control their operation. They are:

- Flag bit Indicating that an interrupt event occurred
- Enable bit Enabling program execution to branch to the interrupt vector address when the flag bit is set
- **Priority bit** Specifying high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON<7>). When interrupt priority is enabled, there are two bits that enable interrupts globally. Setting the GIEH bit (INTCON<7>) enables all interrupts that have the priority bit set (high priority). Setting the GIEL bit (INTCON<6>) enables all interrupts that have the priority bit cleared (low priority). When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 0008h or 0018h, depending on the priority bit setting. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PIC<sup>®</sup> mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. INTCON<6> is the PEIE bit that enables/disables all peripheral interrupt sources. INTCON<7> is the GIE bit that enables/disables all interrupt sources. All interrupts branch to address 0008h in Compatibility mode.

When an interrupt is responded to, the global interrupt enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High-priority interrupt sources can interrupt a low-priority interrupt. Low-priority interrupts are not processed while high-priority interrupts are in progress.

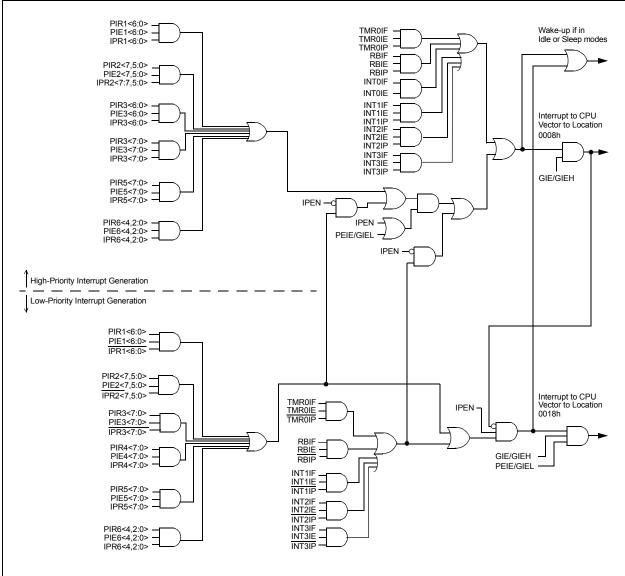
The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (0008h or 0018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used) that re-enables interrupts.

For external interrupt events, such as the INTx pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding enable bit or the GIE bit.

Note: Do not use the MOVFF instruction to modify any of the Interrupt Control registers while any interrupt is enabled. Doing so may cause erratic microcontroller behavior.

#### 查询PIC18F86K90供应商 FIGURE 10-1: PIC18F87K90 FAMILY INTERRUPT LOGIC



#### 查询PIC18F86K90供应商 10.1 INTCON Registers

The INTCON registers are readable and writable registers that contain various enable, priority and flag bits.

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

#### REGISTER 10-1: INTCON: INTERRUPT CONTROL REGISTER

GIE/GIEH         PEIE/GIEL         TMR0IE         INT0IE         RBIE         TMR0IF         INT0IF         RBIF <sup>(1)</sup> bit 7         bit 0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
bit 7 bit 0	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF <sup>(1)</sup>
	bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	GIE/GIEH: Global Interrupt Enable bit
	<u>When IPEN = 0:</u> 1 = Enables all unmasked interrupts
	0 = Disables all interrupts
	When IPEN = 1:
	<ol> <li>Enables all high-priority interrupts</li> <li>Disables all interrupts</li> </ol>
bit 6	PEIE/GIEL: Peripheral Interrupt Enable bit
bit 0	When IPEN = 0:
	1 = Enables all unmasked peripheral interrupts
	0 = Disables all peripheral interrupts
	<u>When IPEN = 1:</u> 1 = Enables all low-priority peripheral interrupts
	0 = Disables all low-priority peripheral interrupts
bit 5	TMR0IE: TMR0 Overflow Interrupt Enable bit
	1 = Enables the TMR0 overflow interrupt
	0 = Disables the TMR0 overflow interrupt
bit 4	INTOIE: INTO External Interrupt Enable bit
	<ol> <li>Enables the INT0 external interrupt</li> <li>Disables the INT0 external interrupt</li> </ol>
bit 3	<b>RBIE:</b> RB Port Change Interrupt Enable bit
bit o	1 = Enables the RB port change interrupt
	0 = Disables the RB port change interrupt
bit 2	TMR0IF: TMR0 Overflow Interrupt Flag bit
	1 = TMR0 register has overflowed (must be cleared in software)
	0 = TMR0 register did not overflow
bit 1	INTOIF: INTO External Interrupt Flag bit
	<ul> <li>1 = The INT0 external interrupt occurred (must be cleared in software)</li> <li>0 = The INT0 external interrupt did not occur</li> </ul>
bit 0	<b>RBIF:</b> RB Port Change Interrupt Flag bit <sup>(1)</sup>
	1 = At least one of the RB<7:4> pins changed state (must be cleared in software)
	0 = None of the RB<7:4> pins have changed state
Note 1:	A mismatch condition will continue to set this bit. Reading PORTB, and then waiting one additional instruction
Note 1:	A mismatch condition will continue to set this bit. Reading PORTB, and then waiting one additional instruction

cycle, will end the mismatch condition and allow the bit to be cleared.

#### 查询PIC18F86K90供应商

#### REGISTER 10-2: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	
bit 7							bit (	
Legend:								
R = Readable	e bit	W = Writable I	oit	U = Unimplem	ented bit, read	l as '0'		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ired	x = Bit is unkr	: = Bit is unknown	
	<ul> <li>1 = All PORTB pull-ups are disabled</li> <li>0 = PORTB pull-ups are enabled by individual port latch values</li> </ul>							
	0 = PORTB p	oull-ups are ena	bled by individ	lual port latch v	alues			
	INTEDG0: External Interrupt 0 Edge Select bit							
bit 6		•	J					
bit 6	1 = Interrupt	on rising edge on falling edge						
bit 6 bit 5	1 = Interrupt 0 = Interrupt	on rising edge	Ū					
	1 = Interrupt 0 = Interrupt INTEDG1: Ex 1 = Interrupt	on rising edge on falling edge	Ū					

	0 = Interrupt on falling edge
bit 5	INTEDG1: External Interrupt 1 Edge Select bit
	1 = Interrupt on rising edge
	0 = Interrupt on falling edge
bit 4	INTEDG2: External Interrupt 2 Edge Select bit
	1 = Interrupt on rising edge
	0 = Interrupt on falling edge
bit 3	<b>INTEDG3:</b> External Interrupt 3 Edge Select bit
	1 = Interrupt on rising edge
	0 = Interrupt on falling edge
bit 2	<b>TMR0IP:</b> TMR0 Overflow Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 1	<b>INT3IP:</b> INT3 External Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 0	<b>RBIP:</b> RB Port Change Interrupt Priority bit
	1 = High priority
	0 = Low priority

**Note:** Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

#### 查询PIC18F86K90供应商 REGISTER 10-3: INTCON3: INTERRUPT CONTROL REGISTER 3

R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF
bit 7							bit 0

L <b>egend:</b> R = Reada	able bit	W = Writable bit	U = Unimplemented bit	read as '0'
-n = Value		'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	INT2IP:	NT2 External Interrupt Priorit	y bit	
	1 = High	n priority		
	0 = Low	priority		
bit 6	INT1IP:	NT1 External Interrupt Priorit	y bit	
	1 = High			
	0 = Low			
bit 5		NT3 External Interrupt Enabl		
		bles the INT3 external interru	•	
		bles the INT3 external interru	·	
bit 4		NT2 External Interrupt Enabl		
		bles the INT2 external interru		
L:1 0		bles the INT2 external interru	•	
bit 3		NT1 External Interrupt Enabl		
		bles the INT1 external interru		
bit 2		NT3 External Interrupt Flag b	•	
			red (must be cleared in softwa	
		INT3 external interrupt did no	•	
bit 1		NT2 External Interrupt Flag b		
			red (must be cleared in softwa	are)
		INT2 external interrupt did no		
bit 0	INT1IF:	NT1 External Interrupt Flag b	vit	
			red (must be cleared in softwa	are)
	0 = The	INT1 external interrupt did no	ot occur	

are clear prior to enabling an interrupt. This feature allows for software polling.

#### 查询PIC18F86K90供应商 10.2 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are six Peripheral Interrupt Request (Flag) registers (PIR1 through PIR6).

- Note 1: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
  - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

#### REGISTER 10-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	ADIF: A/D Converter Interrupt Flag bit
	<ul> <li>1 = An A/D conversion completed (must be cleared in software)</li> <li>0 = The A/D conversion is not complete</li> </ul>
bit 5	RC1IF: EUSART Receive Interrupt Flag bit
	<ul> <li>1 = The EUSART receive buffer, RCREG1, is full (cleared when RCREG1 is read)</li> <li>0 = The EUSART receive buffer is empty</li> </ul>
bit 4	TX1IF: EUSART Transmit Interrupt Flag bit
	<ul> <li>1 = The EUSART transmit buffer, TXREG1, is empty (cleared when TXREG1 is written)</li> <li>0 = The EUSART transmit buffer is full</li> </ul>
bit 3	SSP1IF: Master Synchronous Serial Port Interrupt Flag bit
	<ul><li>1 = The transmission/reception is complete (must be cleared in software)</li><li>0 = Waiting to transmit/receive</li></ul>
bit 2	TMR1GIF: Timer1 Gate Interrupt Flag bit
	<ul> <li>1 = Timer gate interrupt has occurred (must be cleared in software)</li> <li>0 = No timer gate interrupt has occurred</li> </ul>
bit 1	TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
	<ul><li>1 = TMR2 to PR2 match has occurred (must be cleared in software)</li><li>0 = No TMR2 to PR2 match has occurred</li></ul>
bit 0	TMR1IF: TMR1 Overflow Interrupt Flag bit
	<ul> <li>1 = TMR1 register overflowed (must be cleared in software)</li> <li>0 = TMR1 register did not overflow</li> </ul>

#### 查询PIC18F86K90供应商 REGISTER 10-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
OSCFIF	—	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	OSCFIF: Oscillator Fail Interrupt Flag bit
	<ul> <li>1 = Device oscillator failed, clock input has changed to INTOSC (must be cleared in software)</li> <li>0 = Device clock operating</li> </ul>
bit 6	Unimplemented: Read as '0'
bit 5	SSP2IF: Master Synchronous Serial Port Interrupt Flag bit
	<ul> <li>1 = The transmission/reception has been completed. (must be cleared in software)</li> <li>0 = Waiting to transmit/receive</li> </ul>
bit 4	BCL2IF: Bus Collision Interrupt Flag bit
	<ul><li>1 = A bus collision occurred (must be cleared in software)</li><li>0 = No bus collision occurred</li></ul>
bit 3	BCL1IF: Bus Collision Interrupt Flag bit
	<ul> <li>1 = A bus collision occurred (must be cleared in software)</li> <li>0 = No bus collision occurred</li> </ul>
bit 2	HLVDIF: High/Low-Voltage Detect Interrupt Flag bit
	<ul> <li>1 = A high/low-voltage condition occurred (must be cleared in software)</li> <li>0 = The device voltage is above the regulator's low-voltage trip point</li> </ul>
bit 1	TMR3IF: TMR3 Overflow Interrupt Flag bit
	<ul> <li>1 = TMR3 register overflowed (must be cleared in software)</li> <li>0 = TMR3 register did not overflow</li> </ul>
bit 0	TMR3GIF: TMR3 Gate Interrupt Flag bit
	1 = Timer gate interrupt occurred (must be cleared in software)
	0 = No timer gate interrupt occurred

#### 查询PIC18F86K90供应商

#### REGISTER 10-6: PIR3: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 3

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0		
TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF		
bit 7		•	•				bit		
Legend:									
R = Readabl		W = Writable		U = Unimplen					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkı	nown		
bit 7	TMR5GIF: T	imer5 Gate Inte	rrupt Flag bit						
		ate interrupt occ r gate interrupt o		cleared in softv	vare)				
bit 6		Interrupt Flag b		Type-B wavefor	rm with Non-S	tatic mode is se	elected)		
	1 = LCD dat	ta of all COMs is ta of all COMs is	s output (must	be cleared in s			,		
bit 5		ART Receive Ir							
	1 = The EU	SART receive b	uffer, RCREG2		when RCRE	G2 is read)			
bit 4	<ul> <li>0 = The EUSART receive buffer is empty</li> <li>TX2IF: EUSART Transmit Interrupt Flag bit</li> </ul>								
	1 = The EU	SART transmit I SART transmit I	ouffer, TXREG		ared when TX	REG2 is written	))		
bit 3	CTMUIF: CTMU Interrupt Flag bit								
		nterrupt occured (must be cleared in software) IU interrupt occured							
bit 2	CCP2IF: EC	CP2 Interrupt F	lag bit						
		<u>de:</u> register capture R register captur		st be cleared in	software)				
	Compare mo		e match occur		eared in softwa	are)			
	<u>PWM mode:</u> Unused in th								
bit 1	CCP1IF: ECCP1 Interrupt Flag bit								
		<u>de:</u> register capture R register captur		st be cleared in	software)				
	Compare mo		e match occur	•	eared in softwa	are)			
	<u>PWM mode:</u> Unused in th								
bit 0	RTCCIF: RT	CC Interrupt Fla	ag bit						
	1 = RTCC in	nterrupt occured	I (must be clea	red in software)	)				

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CCP10IF <sup>(1)</sup>	CCP9IF <sup>(1)</sup>	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3I
bit 7							k
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
	0 = No TMR <u>Compare Moo</u> 1 = A TMR re	gister compare	e occurred	rred (must be c	n software) cleared in softwa	are)	
bit 0	1 = A TMR re 0 = No TMR Compare Moo 1 = A TMR re 0 = No TMR PWM Mode Not used in P	register capture le egister compare register compa	e occurred e match occur re match occu	rred (must be c		are)	

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

#### 查询PIC18F86K90供应商

#### REGISTER 10-8: PIR5: PERIPHERAL INTERRUPT FLAG REGISTER 5

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR7GIF <sup>(1)</sup>	TMR12IF <sup>(1)</sup>	TMR10IF <sup>(1)</sup>	TMR8IF	TMR7IF <sup>(1)</sup>	TMR6IF	TMR5IF	TMR4IF
bit 7	•						bit 0

Legend:						
R = Readable bit		W = Writable bit	U = Unimplemented bit	, read as '0'		
-n = Value a	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		
bit 7	TMR7G	F: TMR7 Gate Interrupt Flag	bits <sup>(1)</sup>			
		R gate interrupt occurred (mus TMR gate interrupt occurred	st be cleared in software)			
bit 6	<b>TMR12IF:</b> TMR12 to PR12 Match Interrupt Flag bit <sup>(1)</sup> 1 = TMR12 to PR12 match occurred (must be cleared in software) 0 = No TMR12 to PR12 match occurred					
bit 5	1 = TM	F: TMR10 to PR10 Match Inte R10 to PR10 match occurred ( TMR10 to PR10 match occurr	(must be cleared in software	)		
bit 4	1 = TM	: TMR8 to PR8 Match Interrup R8 to PR8 match occurred (mi TMR8 to PR8 match occurred	ust be cleared in software)			
bit 3	1 = TM	<ul> <li>TMR7IF: TMR7 Overflow Interrupt Flag bit<sup>(1)</sup></li> <li>1 = TMR7 register overflowed (must be cleared in software)</li> <li>0 = TMR7 register did not overflow</li> </ul>				
bit 2	1 = TM	<b>IRGIF:</b> TMR6 to PR6 Match Interrupt Flag bit = TMR6 to PR6 match occurred (must be cleared in software) = No TMR6 to PR6 match occurred				
bit 1	1 = TM	<b>TMR5IF:</b> TMR5 Overflow Interrupt Flag bit 1 = TMR5 register overflowed (must be cleared in software) 0 = TMR5 register did not overflow				
bit 0	1 = TM	: TMR4 to PR4 Match Interrup R4 to PR4 match occurred (mi TMR4 to PR4 match occurred	ust be cleared in software)			

**Note 1:** Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

#### 查询PIC18F86K90供应商 REGISTER 10-9: PIR6: PERIPHERAL INTERRUPT FLAG REGISTER 6

U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	EEIF	—	CMP3IF	CMP2IF	CMP1IF
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	Unimplemented: Read as '0'
bit 4	EEIF: Data EEDATA/Flash Write Operation Interrupt Flag bit
	<ul> <li>1 = The write operation is complete (must be cleared in software)</li> <li>0 = The write operation is not complete, or has not been started</li> </ul>
bit 3	Unimplemented: Read as '0'
bit 2	CMP3IF: CMP3 Interrupt Flag bit
	<ul><li>1 = CMP3 interrupt occurred (must be cleared in software)</li><li>0 = No CMP3 interrupt occurred</li></ul>
bit 1	CMP2IF: CMP2 Interrupt Flag bit
	<ul> <li>1 = CMP2 interrupt occurred (must be cleared in software)</li> <li>0 = No CMP2 interrupt occurred</li> </ul>
bit 0	CMP1IF: CM1 Interrupt Flag bit
	<ul><li>1 = CMP1 interrupt occurred (must be cleared in software)</li><li>0 = No CMP1 interrupt occurred</li></ul>

#### 查询PIC18F86K90供应商 10.3 PIE Registers

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are six Peripheral Interrupt Enable registers (PIE1 through PIE6). When IPEN (RCON<7>) = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

#### REGISTER 10-10: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE				
bit 7					•		bit 0				
Legend:											
R = Reada	ble bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'					
-n = Value	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown				
bit 7	Unimplemen	ted: Read as '	)'								
bit 6	ADIE: A/D Co	onverter Interru	pt Enable bit								
	1 = Enables t	= Enables the A/D interrupt									
	0 = Disables	the A/D interrup	ot								
bit 5	RC1IE: EUSA	ART Receive In	terrupt Enable	bit							
		he EUSART re									
		the EUSART re									
bit 4		RT Transmit Ir	•								
		1 = Enables the EUSART transmit interrupt									
bit 3	0 = Disables the EUSART transmit interrupt										
		SSP1IE: Master Synchronous Serial Port Interrupt Enable bit L = Enables the MSSP interrupt									
		0 = Disables the MSSP interrupt									
bit 2	TMR1GIE: T	MR1 Gate Inter	rupt Enable bi	t							
	1 = Enables t	he gate									
	0 = Disables	the gate									
bit 1	TMR2IE: TM	R2 to PR2 Mate	h Interrupt En	able bit							

	0 = Disables the gate
bit 1	TMR2IE: TMR2 to PR2 Match Interrupt Enable bit
	<ul><li>1 = Enables the TMR2 to PR2 match interrupt</li><li>0 = Disables the TMR2 to PR2 match interrupt</li></ul>
bit 0	TMR1IE: TMR1 Overflow Interrupt Enable bit
	1 = Enables the TMR1 overflow interrupt

0 = Disables the TMR1 overflow interrupt

#### 查询PIC18F86K90供应商 REGISTER 10-11: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2 R/W-0 U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 OSCFIE SSP2IE BCL2IE BCL1IE **HLVDIE** TMR3IE TMR3GIE bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '0' = Bit is cleared '1' = Bit is set x = Bit is unknown bit 7 **OSCFIE:** Oscillator Fail Interrupt Enable bit 1 = Enabled 0 = Disabled bit 6 Unimplemented: Read as '0' bit 5 SSP2IE: Master Synchronous Serial Port 2 Interrupt Enable bit 1 = Enables the MSSP interrupt 0 = Disables the MSSP interrupt bit 4 BCL2IE: Bus Collision Interrupt Enable bit 1 = Enables the bus collision interrupt 0 = Disables the bus collision interrupt bit 3 BCL1IE: Bus Collision Interrupt Enable bit 1 = Enabled 0 = Disabled bit 2 HLVDIE: High/Low-Voltage Detect Interrupt Enable bit 1 = Enabled 0 = Disabled TMR3IE: TMR3 Overflow Interrupt Enable bit bit 1 1 = Enabled 0 = Disabled bit 0 TMR3GIE: Timer3 Gate Interrupt Enable bit 1 = Enabled 0 = Disabled

#### 查询PIC18F86K90供应商

REGISTER 10-12: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0				
TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE				
bit 7							bit (				
Legend:											
R = Readable	e bit	W = Writable		•	nented bit, read	d as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown				
		50111									
bit 7		ner5 Gate Inter	rupt Enable bi	t							
	1 = Enabled 0 = Disabled										
bit 6		nterrupt Enable	e bit <sup>(1)</sup>								
	1 = Enabled										
	0 = Disabled										
bit 5	RC2IE: AUSART Receive Interrupt Enable bit										
	1 = Enabled										
	0 = Disabled										
bit 4		RT Transmit Ir	iterrupt Enable	e bit							
	1 = Enabled 0 = Disabled										
bit 3		MUL Interrupt Er	able hit								
	CTMUIE: CTMU Interrupt Enable bit 1 = Enabled										
	0 = Disabled										
bit 2	CCP2IE: ECC	CP2 Interrupt E	nable bit								
	1 = Enabled										
	0 = Disabled										
bit 1	CCP1IE: ECCP1 Interrupt Enable bit										
	1 = Enabled										
	0 = Disabled										
bit 0		CC Interrupt En	able bit								
	1 = Enabled										

Note 1: This bit is valid when the Type-B waveform with Non-Static mode is selected.

#### REGISTER 10-13: PIE4: PERIPHERAL INTERRUPT ENABLE REGISTER 4

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CCP10IE <sup>(1)</sup>	CCP9IE <sup>(1)</sup>	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE
bit 7							bit 0

Legend:						
R = Readable bit	W = Writable bit	U = Unimplemented bit,	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 7-0

CCP10IE:CCP3IE: CCP<10:3> Interrupt Enable bits<sup>(1)</sup>

1 = Enabled

0 = Disabled

Note 1: CCP10IE and CCP9IE are unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-			
TMR7GIE <sup>(1)</sup>	TMR12IE <sup>(1)</sup>	TMR10IE <sup>(1)</sup>	TMR8IE	TMR7IE <sup>(1)</sup>	TMR6IE	TMR5IE	TMR4			
bit 7										
Legend:										
R = Readable	bit	W = Writable b	bit	U = Unimpler	mented bit, read	d as '0'				
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown			
bit 7	TMR7GIE: TM	/IR7 Gate Interr	upt Enable b	it(1)						
	1 = Enabled 0 = Disabled									
bit 6	TMR12IE: TMR12 to PR12 Match Interrupt Enable bit <sup>(1)</sup>									
	1 = Enables the TMR12 to PR12 match interrupt									
	0 = Disables the TMR12 to PR12 match interrupt									
bit 5	TMR10IE: TMR10 to PR10 Match Interrupt Enable bit <sup>(1)</sup>									
	1 = Enables the TMR10 to PR10 match interrupt									
		the TMR10 to		•						
bit 4	TMR8IE: TMR8 to PR8 Match Interrupt Enable bit									
	1 = Enables the TMR8 to PR8 match interrupt									
		the TMR8 to F		•						
bit 3		R7 Overflow Inte	-							
	<ol> <li>Enables the TMR7 overflow interrupt</li> </ol>									
	0 = Disables	s the TMR7 ove	rflow interrup	ot						
bit 2	TMR6IE: TMR6 to PR6 Match Interrupt Enable bit									
	1 = Enables	1 = Enables the TMR6 to PR6 match interrupt								
	0 = Disables	s the TMR6 to F	R6 match in	terrupt						
bit 1	TMR5IE: TMR5 Overflow Interrupt Enable bit									
	1 = Enables the TMR5 overflow interrupt									
		the TMR5 ove								
bit 0		R4 to PR4 Matc								
		the TMR4 to P	•							
	0 = Disables									

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

### 查询PIC18F86K90供应商 REGISTER 10-15: PIE6: PERIPHERAL INTERRUPT ENABLE REGISTER 6

U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	EEIE	_	CMP3IE	CMP2IE	CMP1IE
bit 7							bit 0

Legend:						
R = Readable bit	W = Writable bit	U = Unimplemented bit,	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 7-5	Unimplemented: Read as '0'
bit 4	EEIE: Data EEDATA/Flash Write Operation Enable bit
	<ul><li>1 = Interrupt is enabled</li><li>0 = interrupt is disabled</li></ul>
bit 3	Unimplemented: Read as '0'
bit 2	CMP3IE: CMP3 Enable bit
	<ul><li>1 = Interrupt is enabled</li><li>0 = interrupt is disabled</li></ul>
bit 1	CMP2E: CMP2 Enable bit
	<ul><li>1 = Interrupt is enabled</li><li>0 = interrupt is disabled</li></ul>
bit 0	CMP1IE: CMP1 Enable bit
	<ul><li>1 = Interrupt is enabled</li><li>0 = interrupt is disabled</li></ul>

#### 查询PIC18F86K90供应商 10.4 IPR Registers

The IPR registers contain the individual priority bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are six Peripheral Interrupt Priority registers (IPR1 through IPR6). Using the priority bits requires that the Interrupt Priority Enable (IPEN) bit (RCON<7>) be set.

#### REGISTER 10-16: IPR1: PERIPHERAL INTERRUPT PRIORITY REGISTER 1

U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7	Unimplemented: Read as '0'
	-
bit 6	ADIP: A/D Converter Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 5	RC1IP: EUSART Receive Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 4	TX1IP: EUSART Transmit Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 3	SSP1IP: Master Synchronous Serial Port Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 2	TMR1GIP: Timer1 Gate Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 1	TMR2IP: TMR2 to PR2 Match Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 0	TMR1IP: TMR1 Overflow Interrupt Priority bit
	1 = High priority
	0 = Low priority
	· •

### 查询PIC18F86K90供应商 REGISTER 10-17: IPR2: PERIPHERAL INTERRUPT PRIORITY REGISTER 2

R/W-1	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1					
OSCFIP		SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP					
bit 7	÷	·		·			bit 0					
Legend:												
R = Readab	ole bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'						
-n = Value a	nt POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown					
bit 7		cillator Fail Inter	rupt Priority bi	t								
	U 1	1 = High priority 0 = Low priority										
bit 6		-	ı'									
bit 5	Unimplemented: Read as '0' SSP2IP: Master Synchronous Serial Port 2 Interrupt Priority bit											
		1 = High priority										
		0 = Low priority										
bit 4	•	BCL2IP: Bus Collision Interrupt priority bit (MSSP)										
	1 = High pric	ority		. ,								
	0 = Low prio	rity										
bit 3	BCL1IP: Bus Collision Interrupt Priority bit											
	• .	1 = High priority										
	0 = Low prio	0 = Low priority										
bit 2	•	HLVDIP: High/Low-Voltage Detect Interrupt Priority bit										
		1 = High priority										
		0 = Low priority										
bit 1		TMR3IP: TMR3 Overflow Interrupt Priority bit										
	• .	1 = High priority 0 = Low priority										
bit 0	•	MR3 Gate Inter	runt Priority bit	ŀ								
	1 = High priority 0 = Low priority											

R/W-1	R/W-1	R-1	R-1	R/W-1	R/W-1	R/W-1	R/W-*
TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCC
bit 7							
Legend:							
R = Readable	e bit	W = Writable b	bit	U = Unimplen	nented bit, read	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown
bit 7	1 = High prio 0 = Low prior	rity					
bit 6	1 = High prio	•	bit (valid whe	n the Type-B wa	aveform with No	on-Static mode i	IS SEIECTED
bit 5	RC2IP: AUSA	ART Receive Pr	iority Flag bit				
	1 = High prio 0 = Low prio						
bit 4		RT Transmit In	terrupt Priority	/ bit			
	1 — Uiah prio	rit.					
	1 = High prio 0 = Low prio	•					
bit 3	0 = Low prior	•	ority bit				
bit 3	0 = Low prior <b>CTMUIP:</b> CTI 1 = High prior	rity MU Interrupt Pri rity	ority bit				
	0 = Low prior <b>CTMUIP:</b> CTI 1 = High prior 0 = Low prior	rity MU Interrupt Pri rity rity	-				
	0 = Low prior <b>CTMUIP:</b> CTI 1 = High prior 0 = Low prior	rity MU Interrupt Pri rity cP2 Interrupt Pr	-				
	0 = Low prior <b>CTMUIP:</b> CTI 1 = High prior 0 = Low prior <b>CCP2IP:</b> ECC	rity MU Interrupt Pri rity cP2 Interrupt Pr rity	-				
bit 3 bit bit	0 = Low prior CTMUIP: CTI 1 = High prior 0 = Low prior CCP2IP: ECC 1 = High prior 0 = Low prior CCP1IP: ECC	rity MU Interrupt Pri rity CP2 Interrupt Pr rity rity CP1 Interrupt Pr	iority bit				
bit	0 = Low prior CTMUIP: CTI 1 = High prior 0 = Low prior CCP2IP: ECC 1 = High prior 0 = Low prior CCP1IP: ECC 1 = High prior	rity MU Interrupt Pri rity CP2 Interrupt Pr rity rity CP1 Interrupt Pr rity	iority bit				
bit	0 = Low prior CTMUIP: CTI 1 = High prior 0 = Low prior CCP2IP: ECC 1 = High prior 0 = Low prior CCP1IP: ECC 1 = High prior 0 = Low prior	rity MU Interrupt Pri rity CP2 Interrupt Pr rity CP1 Interrupt Pr rity rity	iority bit iority bit				
bit bit	0 = Low prior CTMUIP: CTI 1 = High prior 0 = Low prior CCP2IP: ECC 1 = High prior 0 = Low prior CCP1IP: ECC 1 = High prior 0 = Low prior	rity MU Interrupt Pri rity CP2 Interrupt Pr rity CP1 Interrupt Pr rity cC Interrupt Prio rity	iority bit iority bit				

#### REGISTER 10-19: IPR4: PERIPHERAL INTERRUPT PRIORITY REGISTER 4

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
CCP10IP <sup>(1)</sup>	CCP9IP <sup>(1)</sup>	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP
bit 7						•	bit 0
Legend:							
R = Readable I	oit	W = Writable	bit	U = Unimpler	nented bit, read	as '0'	
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown

CCP10IP:CCP3IP: CCP<10:3> Interrupt Priority bit<sup>(1)</sup>

- 1 = High priority
- 0 = Low priority

Note 1: CCP10IP and CCP9IP are unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

bit 7-0

### 查询PIC18F86K90供应商

### REGISTER 10-20: IPR5: PERIPHERAL INTERRUPT PRIORITY REGISTER 5

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1			
TMR7GIP <sup>(1)</sup>	TMR12IP <sup>(1)</sup>	TMR10IP <sup>(1)</sup>	TMR8IP	TMR7IP <sup>(1)</sup>	TMR6IP	TMR5IP	TMR4IP			
bit 7							bit			
Logondu										
Legend: R = Readable	hit	W = Writable b	;+	U = Unimplem	ontod hit roa	ud oo 'O'				
-n = Value at F		'1' = Bit is set	it.	'0' = Bit is clea		x = Bit is unkr				
					aieu					
bit 7	TMR7GIP: TM	MR7 Gate Interr	upt Priority b	it <sup>(1)</sup>						
	<b>TMR7GIP:</b> TMR7 Gate Interrupt Priority bit <sup>(1)</sup> 1 = High priority									
	0 = Low pric	prity								
bit 6	TMR12IP: TM	IR12 to PR12 M	atch Interru	ot Priority bit <sup>(1)</sup>						
	1 = High price									
	0 = Low priority									
bit 5		1R10 to PR10 M	atch Interru	ot Priority bit <sup>(1)</sup>						
	1 = High prie	•								
bit 4	0 = Low price	-	a Interrupt D	riarity bit						
DIL 4		R8 to PR8 Matcl	r interrupt P	nonty bit						
	1 = High priority 0 = Low priority									
bit 3	•	•	errupt Priority	/ bit <sup>(1)</sup>						
	TMR7IP: TMR7 Overflow Interrupt Priority bit <sup>(1)</sup> 1 = High priority									
	0 = Low priority									
bit 2	TMR6IP: TMF	R6 to PR6 Matcl	n Interrupt P	riority bit						
	1 = High prie	•								
	0 = Low price	ority								
bit 1	TMR5IP: TMF	R5 Overflow Inte	errupt Priority	/ bit						
	1 = High prio	•								
	0 = Low pric	•								
bit 0		R4 to PR4 Match	n Interrupt P	riority bit						
	1 = High prio									
		ity								

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

### 查询PIC18F86K90供应商 REGISTER 10-21: IPR6: PERIPHERAL INTERRUPT PRIORITY REGISTER 6

U-0	U-0	U-0	R/W-1	U-0	R/W-1	R/W-1	R/W-1			
_	_	_	EEIE		CMP3IE	CMP2IE	CMP1IE			
bit 7				·			bit 0			
Legend:										
R = Readat	ble bit	W = Writable	bit	U = Unimpler	mented bit, read	l as '0'				
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown			
bit 7-5	Unimpleme	ented: Read as '	D'							
bit 4	EEIP: EE In	EEIP: EE Interrupt Priority bit								
		= High priority								
	0 = Low pi	riority								
bit 3	SBOREN: F	Read as '0'								
bit 2	CMP3IP: CI	MP3 Interrupt Pri	ority bit							
	1 = High p	•								
	0 = Low pi	riority								
bit 1	CMP2IP: CI	MP2 Interrupt Pri	ority bit							
	1 = High p	•								
	0 = Low pi	•								
bit 0	CMP1IP: CI	MP1 Interrupt Pri	ority bit							
	1 = High p	•								
	0 = Low pi	riority								

#### 查询PIC18F86K90供应商 10.5 RCON Register

The RCON register contains bits used to determine the cause of the last Reset or wake-up from Idle or Sleep modes. RCON also contains the bit that enables interrupt priorities (IPEN).

### REGISTER 10-22: RCON: RESET CONTROL REGISTER

R/W-0	R/W-1	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	SBOREN	CM	RI	TO	PD	POR	BOR
bit 7							bit 0

Legend:					
R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'		
-n = Valu	e at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	
bit 7		errupt Priority Enable bit			

	$\perp$ = Enable priority levels on interrupts
	<ul><li>0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)</li></ul>
bit 6	SBOREN: BOR Software Enable bit
	<u>If BOREN&lt;1:0&gt; = 01:</u>
	1 = BOR is enabled
	0 = BOR is disabled
	<u>If BOREN&lt;1:0&gt; = 00, 10 or 11:</u>
	Bit is disabled and read as '0'.
bit 5	CM: Configuration Mismatch Flag bit
	1 = A Configuration Mismatch Reset has not occurred
	<ul> <li><u>0</u> = A Configuration Mismatch Reset has occurred (must be subsequently set in software)</li> </ul>
bit 4	RI: RESET Instruction Flag bit
	For details of bit operation, see Register 5-1.
bit 3	TO: Watchdog Timer Time-out Flag bit
	For details of bit operation, see Register 5-1.
bit 2	PD: Power-Down Detection Flag bit
	For details of bit operation, see Register 5-1.
bit 1	POR: Power-on Reset Status bit
	For details of bit operation, see Register 5-1.
bit 0	BOR: Brown-out Reset Status bit
	For details of bit operation, see Register 5-1.

#### 查询PIC18F86K90供应商 10.6 INTx Pin Interrupts

External interrupts on the RB0/INT0, RB1/INT1, RB2/INT2 and RB3/INT3 pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge. If that bit is clear, the trigger is on the falling edge.

When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Before re-enabling the interrupt, the flag bit (INTxIF) must be cleared in software in the Interrupt Service Routine.

All external interrupts (INT0, INT1, INT2 and INT3) can wake up the processor from the power-managed modes, if bit, INTxIE, was set prior to going into the power-managed modes. If the Global Interrupt Enable bit (GIE) is set, the processor will branch to the interrupt vector following wake-up.

The interrupt priority for INT1, INT2 and INT3 is determined by the value contained in the Interrupt Priority bits, INT1IP (INTCON3<6>), INT2IP (INTCON3<7>) and INT3IP (INTCON2<1>).

There is no priority bit associated with INT0. It is always a high-priority interrupt source.

### 10.7 TMR0 Interrupt

In 8-bit mode (the default), an overflow in the TMR0 register (FFh  $\rightarrow$  00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh  $\rightarrow$  0000h) will set TMR0IF.

The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). For further details on the Timer0 module, see **Section 12.0 "Timer0 Module"**.

### 10.8 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>).

Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

### 10.9 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the Fast Return Stack.

If a fast return from interrupt is not used (see **Section 6.3 "Data Memory Organization"**), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine (ISR). Depending on the user's application, other registers also may need to be saved.

Example 10-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

MOVWF MOVFF ; ; USER ;	W_TEMP STATUS, STATUS_TEMP BSR, BSR_TEMP ISR CODE	; W_TEMP is in virtual bank ; STATUS_TEMP located anywhere ; BSR_TMEP located anywhere
MOVFF	BSR_TEMP, BSR	; Restore BSR
MOVF	W_TEMP, W	; Restore WREG
MOVFF	STATUS_TEMP, STATUS	; Restore STATUS

### 查询PIC18F86K90供应商

TABLE 10-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	73
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIR2	OSCFIF	—	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIR4	CCP10IF <sup>(1)</sup>	CCP9IF <sup>(1)</sup>	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75
PIR5	TMR7GIF <sup>(1)</sup>	TMR12IF <sup>(1)</sup>	TMR10IF <sup>(1)</sup>	TMR8IF	TMR7IF <sup>(1)</sup>	TMR6IF	TMR5IF	TMR4IF	75
PIR6	—	—	_	EEIF	—	CMP3IF	CMP2IF	CMP1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
PIE2	OSCFIE	—	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
PIE4	CCP10IE <sup>(1)</sup>	CCP9IE <sup>(1)</sup>	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75
PIE5	TMR7GIE <sup>(1)</sup>	TMR12IE <sup>(1)</sup>	TMR10IE <sup>(1)</sup>	TMR8IE	TMR7IE <sup>(1)</sup>	TMR6IE	TMR5IE	TMR4IE	75
PIE6	—	—	_	EEIE	—	CMP3IE	CMP2IE	CMP1IE	78
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
IPR2	OSCFIP	—	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
IPR4	CCP10IP <sup>(1)</sup>	CCP9IP <sup>(1)</sup>	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75
IPR5	TMR7GIP <sup>(1)</sup>	TMR12IP <sup>(1)</sup>	TMR10IP <sup>(1)</sup>	TMR8IP	TMR7IP <sup>(1)</sup>	TMR6IP	TMR5IP	TMR4IP	74
IPR6	—		_	EEIE	_	CMP3IE	CMP2IE	CMP1IE	75
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74

Legend: Shaded cells are not used by the interrupts.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

### 查询PIC18F86K90供应商 11.0 I/O PORTS

Depending on the device selected and features enabled, there are up to nine ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

Each port has three memory mapped registers for its operation:

- TRIS register (Data Direction register)
- PORT register (reads the levels on the pins of the device)
- LAT register (Output Latch register)

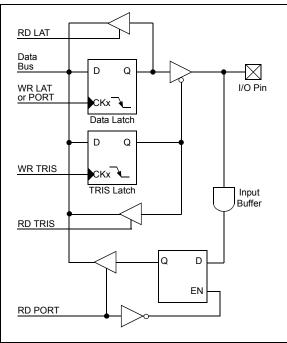
Reading the PORT register reads the current status of the pins, whereas writing to the PORT register writes to the Output Latch (LAT) register.

Setting a TRIS bit (= 1) makes the corresponding port pin an input (putting the corresponding output driver in a High-Impedance mode). Clearing a TRIS bit (= 0) makes the corresponding port pin an output (i.e., put the contents of the corresponding LAT bit on the selected pin).

The Output Latch (LAT register) is useful for read-modify-write operations on the value that the I/O pins are driving. Read-modify-write operations on the LAT register read and write the latched output value for the PORT register.

A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 11-1.

### FIGURE 11-1: GENERIC I/O PORT OPERATION



### 11.1 I/O Port Pin Capabilities

When developing an application, the capabilities of the port pins must be considered. Outputs on some pins have higher output drive strength than others. Similarly, some pins can tolerate higher than VDD input levels.

All of the digital ports are 5.5V input tolerant. The analog ports have the same tolerance, having clamping diodes implemented internally.

### 11.1.1 PIN OUTPUT DRIVE

When used as digital I/O, the output pin drive strengths vary, according to the pins' grouping to meet the needs for a variety of applications. In general, there are two classes of output pins, in terms of drive capability:

- Outputs designed to drive higher current loads such as LEDs:
  - PORTA PORTB
  - PORTC
- Outputs with lower drive levels, but capable of driving normal digital circuit loads with a high input impedance. Able to drive LEDs, but only those with smaller current requirements:
  - PORTD PORTE
  - PORTF PORTG
  - PORTH<sup>(†)</sup> PORTJ<sup>(†)</sup>
  - † These ports are not available on 64-pin devices.

### For more details, see "Absolute Maximum Ratings" in **Section 31.0 "Electrical Characteristics"**.

Regardless of its port, all output pins in LCD Segment or Common-mode have sufficient output to directly drive a display.

### 11.1.2 PULL-UP CONFIGURATION

Four of the I/O ports (PORTB, PORTD, PORTE and PORTJ) implement configurable weak pull-ups on all pins. These are internal pull-ups that allow floating digital input signals to be pulled to a consistent level without the use of external resistors.

The pull-ups are enabled with a single bit for each of the ports: RBPU (INTCON2<7>) for PORTB, and RDPU, REPU and RJPU (PADCFG1<7:5>) for the other ports. By setting RDPU, REPU and RJPU, each of the pull-ups on these ports can be enabled. The pull-ups are disabled on a POR event.

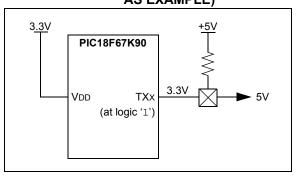
#### 查询PIC18F86K90供应商 11.1.3 OPEN-DRAIN OUTPUTS

The output pins for several peripherals are also equipped with a configurable, open-drain output option. This allows the peripherals to communicate with external digital logic, operating at a higher voltage level, without the use of level translators.

The open-drain option is implemented on port pins specifically associated with the data and clock outputs of the USARTs, the MSSP module (in SPI mode) and the CCP modules. This option is selectively enabled by setting the open-drain control bits in the registers ODCON1, ODCON2 and ODCON3.

When the open-drain option is required, the output pin must also be tied through an external pull-up resistor provided by the user to a higher voltage level, up to 5V (Figure 11-2). When a digital logic high signal is output, it is pulled up to the higher voltage level.

#### FIGURE 11-2: USING THE OPEN-DRAIN OUTPUT (USART SHOWN AS EXAMPLE)



### REGISTER 11-1: ODCON1: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0
SSP10D	CCP2OD	CCP10D	_	—	—	—	SSP2OD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as 'O'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	SSP10D: SPI1 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 = Open-drain capability is disabled
bit 6	CCP2OD: ECCP2 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 = Open-drain capability is disabled
bit 5	CCP10D: ECCP1 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 = Open-drain capability is disabled
bit 4-1	Unimplemented: Read as '0'
bit 0	SSP2OD: SPI2 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 - Open drein eenshility is dischlod

0 = Open-drain capability is disabled

bit 0

#### 查询PIC18F86K90供应商 REGISTER 11-2: ODCON2: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 2 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 CCP100D<sup>(1)</sup> CCP9OD<sup>(1)</sup> CCP8OD CCP7OD CCP6OD CCP5OD CCP4OD CCP3OD bit 7

Legend:									
R = Readable bit		W = Writable bit	U = Unimplemented bit, read as '0'						
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					
bit 7	CCP100	D: CCP10 Open-Drain Out	out Enable bit <sup>(1)</sup>						
		n-drain capability is enabled n-drain capability is disabled							
bit 6	CCP9OE	: CCP9 Open-Drain Output	: Enable bit <sup>(1)</sup>						
	•	n-drain capability is enabled n-drain capability is disabled							
bit 5	CCP8OE	: CCP8 Open-Drain Output	Enable bit						
		n-drain capability is enabled n-drain capability is disabled							
bit 4	CCP7OE	CP7OD: CCP7 Open-Drain Output Enable bit							
		n-drain capability is enabled n-drain capability is disabled							
bit 3	CCP6OE	: CCP6 Open-Drain Output	Enable bit						
		n-drain capability is enabled n-drain capability is disabled							
bit 2	CCP5OE	: CCP5 Open-Drain Output	Enable bit						
bit 1	CCP4OE	: CCP4 Open-Drain Output	Enable bit						
		n-drain capability is enabled n-drain capability is disabled							
bit 0	CCP3OE	: ECCP3 Open-Drain Outp	ut Enable bit						
	•	n-drain capability is enabled n-drain capability is disabled							

Note 1: Unimplemented on PIC18FX5K90 devices.

### 查询PIC18F86K90供应商

REGISTER 11-3: ODCON3: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 3

U-0 R/W-0 CTMUDS bit (					
bit (					
U = Unimplemented bit, read as '0'					
x = Bit is unknown					

- bit 6 **U10D:** EUSART1 Open-Drain Output Enable bit
  - 1 = Open-drain capability is enabled
    - 0 = Open-drain capability is disabled
- bit 5-1 Unimplemented: Read as '0'

bit 0 CTMUDS: CTMU Pulse Delay Enable bit

1 = Pulse delay input for CTMU is enabled on pin, RF1

0 = Pulse delay input for CTMU is disabled on pin, RF1

#### 11.1.4 ANALOG AND DIGITAL PORTS

Many of the ports multiplex analog and digital functionality, providing a lot of flexibility for hardware designers. PIC18F87K90 family devices can make any analog pin analog or digital, depending on an application's needs. The ports' analog/digital functionality is controlled by the registers: ANCON0, ANCON1 and ANCON2. Setting these registers makes the corresponding pins analog and clearing the registers makes the ports digital. For details on these registers, see Section 23.0 "12-Bit Analog-to-Digital Converter (A/D) Module".

### 查询PIC18F86K90供应商 11.2 PORTA, TRISA and

### LATA Registers

PORTA is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISA and LATA.

RA4/T0CKI is a Schmitt Trigger input. All other PORTA pins have TTL input levels and full CMOS output drivers.

The RA4 pin is multiplexed with the Timer0 clock input and one of the LCD segment drives. RA5 and RA<3:0> are multiplexed with analog inputs for the A/D Converter. RA1 is multiplexed with analog as well as the LCD segment drive.

The operation of the analog inputs as A/D Converter inputs is selected by clearing or setting the ANSEL<3:0> control bits in the ANCON1 register. The corresponding TRISA bits control the direction of these pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

Note: RA5 and RA<3:0> are configured as analog inputs on any Reset and are read as '0'. RA4 is configured as a digital input.

OSC2/CLKO/RA6 and OSC1/CLKI/RA7 normally serve as the external circuit connections for the external (primary) oscillator circuit (HS Oscillator modes) or the external clock input and output (EC Oscillator modes). In these cases, RA6 and RA7 are not available as digital I/O and their corresponding TRIS and LAT bits are read as '0'. When the device is configured to use HF-INTOSC, MF-INTOSC or LF-INTOSC as the default oscillator mode, RA6 and RA7 are automatically configured as digital I/O; the oscillator and clock in/clock out functions are disabled.

RA1, RA4 and RA5 are multiplexed with LCD segment drives that are controlled by bits in the LCDSE1 and LCDSE2 registers. I/O port functionality is only available when the LCD segments are disabled.

RA5 has additional functionality for Timer1 and Timer3. It can be configured as the Timer1 clock input or the Timer3 external clock gate input.

#### EXAMPLE 11-1: INITIALIZING PORTA

CLRF	PORTA	; Initialize PORTA by
		; clearing output latches
CLRF	LATA	; Alternate method to
		; clear output data latches
BANKSEL	ANCON1	
MOVLW	00h	; Configure A/D
MOVWF	ANCON1	; for digital inputs
MOVLW	0BFh	; Value used to initialize
		; data direction
MOVWF	TRISA	; Set RA<7, 5:0> as inputs,
		; RA<6> as output
		_

### 查询PIC18F86K90供应商 TABLE 11-1: PORTA FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RA0/AN0/ULPWU	RA0	0	0	DIG	LATA<0> data output; not affected by analog input.
		1	I	TTL	PORTA<0> data input; disabled when analog input enabled.
	AN0	1	I	ANA	A/D Input Channel 0. Default input configuration on POR; does not affect digital output.
	ULPWU	1	I	ANA	Ultra low-power wake-up input.
RA1/AN1/SEG18	RA1	0	0	DIG	LATA<1> data output; not affected by analog input.
		1	Ι	TTL	PORTA<1> data input; disabled when analog input is enabled.
	AN1	1	I	ANA	A/D Input Channel 1. Default input configuration on POR; does not affect digital output.
	SEG18	1	0	ANA	LCD Segment 18 output; disables all other pin functions.
RA2/AN2/VREF-	RA2	0	0	DIG	LATA<2> data output; not affected by analog input.
		1	I	TTL	PORTA<2> data input; disabled when analog functions are enabled.
	AN2	1	I	ANA	A/D Input Channel 2. Default input configuration on POR.
	VREF-	1	Ι	ANA	A/D and comparator low reference voltage input.
RA3/AN3/VREF+	RA3	0	0	DIG	LATA<3> data output; not affected by analog input.
		1	I	TTL	PORTA<3> data input; disabled when analog input is enabled.
	AN3	1	Ι	ANA	A/D Input Channel 3. Default input configuration on POR.
	VREF+	1	Ι	ANA	A/D and comparator high reference voltage input.
RA4/T0CKI/	RA4	0	0	DIG	LATA<4> data output.
SEG14		1	Ι	ST	PORTA<4> data input. Default configuration on POR.
	TOCKI	x	Ι	ST	Timer0 clock input.
	SEG14	1	0	ANA	LCD Segment 14 output; disables all other pin functions.
RA5/AN4/SEG15/	RA5	0	0	DIG	LATA<5> data output; not affected by analog input.
T1CKI/T3G/		1	Ι	TTL	PORTA<5> data input; disabled when analog input is enabled.
HLVDIN	AN4	1	Ι	ANA	A/D Input Channel 4. Default configuration on POR.
	SEG15	1	0	ANA	LCD Segment 15 output; disables all other pin functions.
	T1CKI	x	Ι	ST	Timer1 clock input.
	T3G	x	I	ST	Timer3 external clock gate input.
	HLVDIN	1	I	ANA	High/Low-Voltage Detect external trip point input.
OSC2/CLKO/RA6	OSC2	x	0	ANA	Main oscillator feedback output connection (HS, XT and LP modes).
	CLKO	x	0	DIG	System cycle clock output (Fosc/4, EC and INTOSC modes).
	RA6	0	0	DIG	LATA<6> data output; disabled when OSC2 Configuration bit is set.
		1	I	TTL	PORTA<6> data input; disabled when OSC2 Configuration bit is set.
OSC1/CLKI/RA7	OSC1	x	I	ANA	Main oscillator input connection (HS, XT and LP modes).
	CLKI	x	I	ANA	Main external clock source input (EC modes).
	RA7	0	0	DIG	LATA<7> data output; disabled when OSC2 Configuration bit is set.
		1	Ι	TTL	PORTA<7> data input; disabled when OSC2 Configuration bit is set.

O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, Legend: TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

#### 查询PIC18F86K90供应商 TABLE 11-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTA	RA7 <sup>(1)</sup>	RA6 <sup>(1)</sup>	RA5	RA4	RA3	RA2	RA1	RA0	76
LATA	LATA7 <sup>(1)</sup>	LATA6 <sup>(1)</sup>	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	76
TRISA	TRISA7 <sup>(1)</sup>	TRISA6 <sup>(1)</sup>	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	76
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	81
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

**Note 1:** These bits are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as 'x'.

### 查询PIC18F86K90供应商

#### 11.3 PORTB, TRISB and LATB Registers

PORTB is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISB and LATB. All pins on PORTB are digital only.

#### EXAMPLE 11-2: INITIALIZING PORTB

CLRF	PORTB	; Initialize PORTB by ; clearing output
CURF		; data latches ; Alternate method
CLRF	LATB	, Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISB	; Set RB<3:0> as inputs
		; RB<5:4> as outputs
		; RB<7:6> as inputs

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit, RBPU (INTCON2<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Four of the PORTB pins (RB<7:4>) have an interrupt-on-change feature. Only pins configured as inputs can cause this interrupt to occur; any RB<7:4> pin configured as an output would be excluded from the interrupt-on-change comparison.

Comparisons with the input pins (of RB<7:4>) are made with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are ORed together to generate the RB Port Change Interrupt with Flag bit, RBIF (INTCON<0>).

This interrupt can wake the device from power-managed modes. To clear the interrupt in the Interrupt Service Routine:

- a) Any read or write of PORTB (except with the MOVFF (ANY), PORTB instruction). This will end the mismatch condition.
- b) Wait one instruction cycle (such as executing a NOP instruction).
- c) Clear flag bit, RBIF.

A mismatch condition will continue to set flag bit, RBIF. Reading PORTB will end the mismatch condition and allow flag bit, RBIF, to be cleared after one TCY delay.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

The RB<3:2> pins are multiplexed as CTMU edge inputs. RB5 has an additional function for Timer3 and Timer1. It can be configured for Timer3 clock input or Timer1 external clock gate input.

The RB<5:0> pins also are multiplexed with LCD segment drives that are controlled by bits in the registers, LCDSE1 and LCDSE3. I/O port functionality is only available when the LCD segments are disabled.

#### 查询PIC18F86K90供应商 TABLE 11-3: PORTB FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RB0/INT0/SEG30/	RB0	0	0	DIG	LATB<0> data output.
FLT0		1	I	TTL	PORTB<0> data input; weak pull-up when RBPU bit is cleared.
	INT0	1	I	ST	External Interrupt 0 input.
	SEG30	1	0	ANA	LCD Segment 30 output; disables all other pin functions.
	FLT0	x	I	ST	Enhanced PWM Fault input for ECCPx.
RB1/INT1/SEG8	RB1	0	0	DIG	LATB<1> data output.
		1	I	TTL	PORTB<1> data input; weak pull-up when RBPU bit is cleared.
	INT1	1	Ι	ST	External Interrupt 1 input.
	SEG8	1	0	ANA	LCD Segment 8 output; disables all other pin functions.
RB2/INT2/SEG9/	RB2	0	0	DIG	LATB<2> data output.
CTED1		1	Ι	TTL	PORTB<2> data input; weak pull-up when RBPU bit is cleared.
	INT2	1	I	ST	External Interrupt 2 input.
	SEG9	1	0	LCD Segment 9 output; disables all other pin functions.	
	CTED1	x	Ι	ST	CTMU Edge 1 input.
RB3/INT3/SEG10/	RB3	0	0	DIG	LATB<3> data output.
CTED2/ECCP2/ P2A		1	Ι	TTL	PORTB<3> data input; weak pull-up when RBPU bit is cleared.
PZA	INT3	1	I	ST	External Interrupt 3 input.
	SEG10	1	0	ANA	LCD Segment 10 output; disables all other pin functions.
	CTED2	x	Ι	ST	CTMU Edge 2 input.
-	ECCP2	0	0	DIG	ECCP2 compare output and ECCP2 PWM output. Takes priority over port data.
		1	-	ST	ECCP2 capture input.
	P2A	0	0	DIG	ECCP2 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
RB4/KBI0/SEG11	RB4	0	0	DIG	LATB<4> data output.
		1	I	TTL	PORTB<4> data input; weak pull-up when RBPU bit is cleared.
	KBI0	1	I	TTL	Interrupt-on-pin change.
	SEG11	1	0	ANA	LCD Segment 11 output; disables all other pin functions.
RB5/KBI1/SEG29/	RB5	0	0	DIG	LATB<5> data output.
T3CKI/T1G		1	I	TTL	PORTB<5> data input; weak pull-up when RBPU bit is cleared.
	KBI1	1	Ι	TTL	Interrupt-on-pin change.
	SEG29	1	0	ANA	LCD Segment 29 output; disables all other pin functions.
	T3CKI	x	Ι	ST	Timer3 clock input.
	T1G	x	Ι	ST	Timer1 external clock gate input.
RB6/KBI2/PGC	RB6	0	0	DIG	LATB<6> data output.
		1	Ι	TTL	PORTB<6> data input; weak pull-up when RBPU bit is cleared.
	KBI2	1	Ι	TTL	Interrupt-on-pin change.
	PGC	x	Ι	ST	Serial execution (ICSP) clock input for ICSP and ICD operation.
RB7/KBI3/PGD	RB7	0	0	DIG	LATB<7> data output.
		1	I	TTL	PORTB<7> data input; weak pull-up when RBPU bit is cleared.
	KBI3	1	I	TTL	Interrupt-on-pin change.
	PGD	x	0	DIG	Serial execution data output for ICSP and ICD operation.
		x	I	ST	Serial execution data input for ICSP and ICD operation.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

### 查询PIC18F86K90供应商 TABLE 11-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	76
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	76
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76
INTCON	<b>GIE/GIEH</b>	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	73
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	73
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81

Legend: Shaded cells are not used by PORTB.

#### 查询PIC18F86K90供应商 11.4 PORTC, TRISC and

### LATC Registers

PORTC is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISC and LATC. Only PORTC pins, RC2 through RC7, are digital only pins.

PORTC is multiplexed with ECCP, MSSP and EUSART peripheral functions (Table 11-5). The pins have Schmitt Trigger input buffers. The pins for ECCP, SPI and EUSART are also configurable for open-drain output whenever these functions are active. Open-drain configuration is selected by setting the SSP1OD, CCPxOD and U1OD control bits in the registers, ODCON1 and ODCON3.

RC1 is normally configured as the default peripheral pin for the ECCP2 module. Assignment of ECCP2 is controlled by Configuration bit, CCP2MX (default state, CCP2MX = 1).

When enabling peripheral functions, use care in defining TRIS bits for each PORTC pin. Some peripherals can override the TRIS bit to make a pin an output or input. Consult the corresponding peripheral section for the correct TRIS bit settings.

**Note:** These pins are configured as digital inputs on any device Reset.

The contents of the TRISC register are affected by peripheral overrides. Reading TRISC always returns the current contents, even though a peripheral device may be overriding one or more of the pins.

The RC<7:1> pins are multiplexed with LCD segment drives that are controlled by bits in the registers, LCDSE1, LCDSE2, LCDSE3 and LCDSE4.

RC0 and RC1 pins serve as the input pins for the SOSC oscillator. On a power-up, these pins are defined as SOSC pins. In order to make these ports have digital I/O port functionality, the CONFI1L<4:3> should be set to '10' (Digital SCLKI mode). I/O port functionality is only available when the LCD segments are disabled.

EXAMPLE 11-3:	INITIALIZING PORTC

CLRF	PORTC	; Initialize PORTC by ; clearing output
		; data latches
CLRF	LATC	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISC	; Set RC<3:0> as inputs
		; RC<5:4> as outputs
		; RC<7:6> as inputs

### 查询PIC18F86K90供应商

### TABLE 11-5: PORTC FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RC0/SOSCO/	RC0	0	0	DIG	LATC<0> data output.
SCLKI/		1	Ι	ST	PORTC<0> data input.
	SOSCO	1	Ι	ST	SOSC oscillator output.
	SCLKI	x	0	ANA	Digital clock input; enabled when SOSC oscillator is disabled.
RC1/SOSCI/	RC1	0	0	DIG	LATC<1> data output.
ECCP2/P2A/		1	Ι	ST	PORTC<1> data input.
SEG32	SOSCI	x	I	ANA	SOSC oscillator input.
	ECCP2 <sup>(1)</sup>	0	0	DIG	ECCP2 compare output and ECCP2 PWM output. Takes priority over port data.
		1	Ι	ST	ECCP2 capture input.
	P2A	0	0	DIG	ECCP2 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
	SEG32	1	0	ANA	LCD Segment 32 output; disables all other pin functions.
RC2/ECCP1/	RC2	0	0	DIG	LATC<2> data output.
P1A/SEG13		1	Ι	ST	PORTC<2> data input.
	ECCP1	0	0	DIG	ECCP1 compare output and ECCP1 PWM output. Takes priority over port data.
		1	I	ST	ECCP1 capture input.
	P1A	0	0	DIG	ECCP1 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
	SEG13	1	0	ANA	LCD Segment 13 output; disables all other pin functions.
RC3/SCK1/	RC3	0	0	DIG	LATC<3> data output.
SCL1/SEG17		1	Ι	ST	PORTC<3> data input.
	SCK1	0	0	DIG	SPI clock output (MSSP module); takes priority over port data.
		1	Ι	ST	SPI clock input (MSSP module).
	SCL1	0	0	DIG	I <sup>2</sup> C™ clock output (MSSP module); takes priority over port data.
		1	I	l <sup>2</sup> C	I <sup>2</sup> C clock input (MSSP module); input type depends on module setting.
	SEG17	1	0	ANA	LCD Segment 17 output; disables all other pin functions.
RC4/SDI1/	RC4	0	0	DIG	LATC<4> data output.
SDA1/SEG16		1	I	ST	PORTC<4> data input.
	SDI1		Ι	ST	SPI data input (MSSP module).
	SDA1	1	0	DIG	I <sup>2</sup> C data output (MSSP module); takes priority over port data.
		1	I	l <sup>2</sup> C	I <sup>2</sup> C data input (MSSP module); input type depends on module setting.
	SEG16	1	0	ANA	LCD Segment 16 output; disables all other pin functions.
RC5/SDO1/	RC5	0	0	DIG	LATC<5> data output.
SEG12		1	I	ST	PORTC<5> data input.
	SDO1	0	0	DIG	SPI data output (MSSP module).
	SEG12	1	0	ANA	LCD Segment 12 output; disables all other pin functions.
RC6/TX1/CK1/	RC6	0	0	DIG	LATC<6> data output.
SEG27		1	Ι	ST	PORTC<6> data input.
	TX1	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
	CK1	1	0	DIG	Synchronous serial data input (EUSART module); user must configure as an input
		1	Ι	ST	Synchronous serial clock input (EUSART module).
	SEG27	1	0	ANA	LCD Segment 27 output; disables all other pin functions.

**Legend:** O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input,  $I^2C = I^2C$  Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

#### 查询PIC18F86K90供应商 TABLE 11-5: PORTC FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	I/O Туре	Description
RC7/RX1/DT1/	RC7	0	0	DIG	LATC<7> data output.
SEG28		1	Ι	ST	PORTC<7> data input.
	RX1	1	Ι	ST	Asynchronous serial receive data input (EUSART module).
	DT1	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
		1	-	ST	Synchronous serial data input (EUSART module); user must configure as an input.
	SEG28	1	0	ANA	LCD Segment 28 output; disables all other pin functions.

**Legend:** O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input,  $I^2C = I^2C$  Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

**Note 1:** Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

#### TABLE 11-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	76
LATC	LATC7	LATBC6	LATC5	LATCB4	LATC3	LATC2	LATC1	LATC0	76
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	81
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
LCDSE4	SE39 <sup>(1)</sup>	SE38 <sup>(1)</sup>	SE37 <sup>(1)</sup>	SE36 <sup>(1)</sup>	SE35 <sup>(1)</sup>	SE34 <sup>(1)</sup>	SE33 <sup>(1)</sup>	SE32	81
ODCON1	SSP10D	CCP2OD	CCP10D	_	_	_	_	SSP2OD	79

Legend: Shaded cells are not used by PORTC.

Note 1: Unimplemented on PIC18F6XK90 devices, read as '0'.

### 查询PIC18F86K90供应商

#### 11.5 PORTD, TRISD and LATD Registers

PORTD is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISD and LATD.

All pins on PORTD are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note:	These pins are configured as digital inputs
	on any device Reset.

Each of the PORTD pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit, RDPU (PADCFG1<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on all device Resets.

All of the PORTD pins are multiplexed with LCD segment drives that are controlled by bits in the LCDSE0 register. RD0 is multiplexed with the CTMU pulse generator output.

I/O port functionality is only available when the LCD segments are disabled.

The PORTD also has the  $I^2C$  and SPI functionality on RD4, RD5 and RD6. The pins for SPI are also configurable for open-drain output. Open-drain configuration is selected by setting the SSPxOD control bits in the ODCON1 register.

RD0 has a CTMU functionality. RD1 has the functionality for a Timer5 clock input and also Timer7 has functionality for an external clock gate input.

		INITIALIZING FORTD
CLRF	PORTD	; Initialize PORTD by ; clearing output ; data latches
CLRF	LATD	<pre>; data fatches ; Alternate method ; to clear output</pre>
MOVLW	0CFh	; data latches ; Value used to ; initialize data
MOVWF	TRISD	<pre>; direction ; Set RD&lt;3:0&gt; as inputs ; RD&lt;5:4&gt; as outputs ; RD&lt;7:6&gt; as inputs</pre>

EXAMPLE 11-4: INITIALIZING PORTD

#### 查询PIC18F86K90供应商 TABLE 11-7: PORTD FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RD0/SEG0/	RD0	0	0	DIG	LATD<0> data output.
CTPLS		1	Ι	ST	PORTD<0> data input.
	SEG0	1	0	ANA	LCD Segment 0 output; disables all other pin functions.
	CTPLS	x	0	DIG	CTMU pulse generator output.
RD1/SEG1/	RD1	0	0	DIG	LATD<1> data output.
T5CKI/T7G		1	Ι	ST	PORTD<1> data input.
	SEG1	1	0	ANA	LCD Segment 1 output; disables all other pin functions.
	T5CKI	x	Ι	ST	Timer5 clock input.
	T7G	x	Ι	ST	Timer7 external clock gate input.
RD2/SEG2	RD2	0	0	DIG	LATD<2> data output.
		1	Ι	ST	PORTD<2> data input.
	SEG2	1	0	ANA	LCD Segment 2 output; disables all other pin functions.
RD3/SEG3	RD3	0	0	DIG	LATD<3> data output.
		1	Ι	ST	PORTD<3> data input.
	SEG3	1	0	ANA	LCD Segment 3 output; disables all other pin functions.
RD4/SEG4/	RD4	0	0	DIG	LATD<4> data output.
SDO2		1	Ι	ST	PORTD<4> data input.
	SEG4	1	0	ANA	LCD Segment 4 output; disables all other pin functions.
	SDO2	0	Р	DOG	SPI data output (MSSP module).
RD5/SEG5/	RD5	0	0	DIG	LATD<5> data output.
SDI2/SDA2		1	Ι	ST	PORTD<5> data input.
	SEG5	1	0	ANA	LCD Segment 5 output; disables all other pin functions.
	SDI2	1	Ι	ST	SPI data input (MSSP module).
	SDA2	0	0	l <sup>2</sup> C	I <sup>2</sup> C <sup>™</sup> data input (MSSP module). Input type depends on module setting.
		1	Ι	ANA	LCD Segment 5 output; disables all other pin functions.
RD6/SEG6/	RD6	0	0	DIG	LATD<6> data output.
SCK2/SCL2		1	Ι	ST	PORTD<6> data input.
	SEG6	1	0	ANA	LCD Segment 6 output; disables all other pin functions.
	SCK2	0	0	DIG	SPI clock output (MSSP module). Takes priority over port data.
		1	Ι	ST	SPI clock input (MSSP module).
	SCL2	0	0	DIG	I <sup>2</sup> C clock output (MSSP module). Takes priority over port data.
		1	Ι	l <sup>2</sup> C	I <sup>2</sup> C clock input (MSSP module). Input type depends on module setting.
RD7/SEG7/	RD7	0	0	DIG	LATD<7> data output.
SS2		1	Ι	ST	PORTD<7> data input.
	SEG7	1	Ι	ANA	LCD Segment 7 output; disables all other pin functions.
	SS2	1	Ι	TTL	Slave select input for MSSP module.

**Legend:** O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,  $I^2C = I^2C$  Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

# 查询PIC18F86K90供应商 TABLE 11-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	76
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	76
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	76
LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	81
PADCFG1	RDPU	REPU	RJPU <sup>(1)</sup>	_	—	RTSECSEL1	RTSECSEL0	_	78

Legend: Shaded cells are not used by PORTD.

Note 1: Not available on 64-pin devices.

#### 查询PIC18F86K90供应商 11.6 PORTE, TRISE and LATE Registers

PORTE is a 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISE and LATE.

All pins on PORTE are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output. The RE7 pin is also configurable for open-drain output when ECCP2 is active on this pin. Open-drain configuration is selected by setting the CCP2OD control bit (ODCON1<6>)

Note:	These pins are configured as digital inputs	
	on any device Reset.	

Each of the PORTE pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit, REPU (PADCFG1<6>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

Pins, RE<6:3>, are multiplexed with the LCD common drives. I/O port functions are available only on those PORTE pins according to which commons are active. The configuration is determined by the LMUX<1:0> control bits (LCDCON<1:0>). The availability is summarized in Table 11-9.

# TABLE 11-9:PORTE PINS AVAILABLE IN<br/>DIFFERENT LCD DRIVE<br/>CONFIGURATIONS<sup>(1)</sup>

LCDCON <1:0>	Active LCD Commons	PORTE Pins Available for I/O
00	COM0	RE6, RE5, RE4
01	COM0, COM1	RE6, RE5
10	COM0, COM1 and COM2	RE6
11	All (COM0 through COM3)	None

**Note 1:** If the LCD bias voltages are generated using the internal resistor ladder, the LCDBIASx pins are also available as I/O ports (RE0, RE1 and RE2).

Pins, RE2, RE1 and RE0, are multiplexed with the functions of LCDBIAS3, LCDBIAS2 and LCDBIAS1. When LCD bias generation is required (in any application where the device is connected to an external LCD), these pins cannot be used as digital I/O. These pins can be used as digital I/O, however, when the internal resistor ladder is used for bias generation.

PORTE is also multiplexed with Enhanced PWM outputs, B and C for ECCP1 and ECCP3, and outputs, B, C and D for ECCP2. For all devices, their default assignments are on PORTE<6:0>. On 80-pin devices, the multiplexing for the outputs of ECCP1 and ECCP3 is controlled by the ECCPMX Configuration bit. Clearing this bit reassigns the P1B/P1C and P3B/P3C outputs to PORTH.

RE7 is multiplexed with the LCD segment drive (SEG31) that is controlled by the LCDSE3<7> bit. I/O port function is only available when the segment is disabled. RE7 can also be configured as the alternate peripheral pin for the ECCP2 module. This is done by clearing the CCP2MX Configuration bit.

RE3 can also be configured as the Reference Clock Output (REFO) from the system clock. For further details, refer to **Section 3.7 "Reference Clock Output"**.

CLRF	PORTE	; Initialize PORTE by ; clearing output
		; data latches
CLRF	LATE	; Alternate method
		; to clear output
		; data latches
MOVLW	03h	; Value used to
		; initialize data
		; direction
MOVWF	TRISE	; Set RE<1:0> as inputs
		; RE<7:2> as outputs

### 查询PIC18F86K90供应商

### TABLE 11-10: PORTE FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RE0/LCDBIAS1/	RE0	0	0	DIG	LATE<0> data output.
P2D		1	Ι	ST	PORTE<0> data input.
	LCDBIAS1	—		ANA	LCD module bias voltage input.
	P2D	0	0		ECCP2 PWM Output D. May be configured for tri-state during Enhanced PWM shutdown events.
RE1/LCDBIAS2/	RE1	0	0	DIG	LATE<1> data output.
P2C		1	-	ST	PORTE<1> data input.
	LCDBIAS2	—	-	ANA	LCD module bias voltage input.
	P2C	0	0		ECCP2 PWM Output C. May be configured for tri-state during Enhanced PWM shutdown events
RE2/LCDBIAS3/	RE2	0	0	DIG	LATE<2> data output.
P2B		1		ST	PORTE<2> data input.
	LCDBIAS3	х	-	ANA	LCD module bias voltage input.
	P2B	0	0		ECCP2 PWM Output B. May be configured for tri-state during Enhanced PWM shutdown events.
RE3/COM0/	RE3	0	0	DIG	LATE<3> data output.
P3C/CCP9/		1	Ι	ST	PORTE<3> data input.
REFO	COM0	x	0	ANA	LCD Common 0 output; disables all other outputs.
	P3C	0	0	_	ECCP3 PWM Output C. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP9	0	0	DIG	CCP9 compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP9 capture input.
	REFO	x	0	DIG	Reference output clock.
RE4/COM1/	RE4	0	0	DIG	LATE<4> data output.
P3B/CCP8		1	Ι	ST	PORTE<4> data input.
	COM1	x	0	ANA	LCD Common 1 output; disables all other outputs.
	P3B	0	0		ECCP3 PWM Output B. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP8	0	0	DIG	CCP8 Compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP8 capture input.
RE5/COM2/	RE5	0	0	DIG	LATE<5> data output.
P1C/CCP7		1	Ι	ST	PORTE<5> data input.
	COM2	x	0	ANA	LCD Common 2 output; disables all other outputs.
	P1C	0	0	_	ECCP1 PWM Output C. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP7	0	0	DIG	CCP7 Compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP7 capture input.
RE6/COM3/	RE6	0	0	DIG	LATE<6> data output.
P1B/CCP6		1	Ι	ST	PORTE<6> data input.
	COM3	x	0	ANA	LCD Common 3 output; disables all other outputs.
	P1B	0	0	—	ECCP1 PWM Output B. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP6	0	0	DIG	CCP6 Compare/PWM output. Takes priority over port data.
		1	I	ST	CCP9 capture input.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

**Note 1:** Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

#### 查询PIC18F86K90供应商 TABLE 11-10: PORTE FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description
RE7/ECCP2/	RE7	0	0	DIG	LATE<7> data output.
P2A/SEG31		1	Ι	ST	PORTE<7> data input.
	ECCP2 <sup>(1)</sup>	0	0	DIG	ECCP2 compare/PWM output; takes priority over port data.
		1	-	ST	ECCP2 capture input.
	P2A	0	0		ECCP2 PWM Output A. May be configured for tri-state during Enhanced PWM shutdown event.
	SEG31	1	0	ANA	Segment 31 analog output for LCD; disables digital output.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option). Note 1: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

#### TABLE 11-11: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	76
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	76
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76
LCDCON	LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
ODCON1	SSP10D	CCP2OD	CCP10D	_	_	—	—	SSP2OD	79
ODCON2	CCP10OD	CCP90D	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD	79
PADCFG1	RDPU	REPU	RJPU <sup>(1)</sup>	—	_	RTSECSEL1	RTSECSEL0	-	78

Legend: Shaded cells are not used by PORTE.

**Note 1:** Not available on 64-pin devices.

### 查询PIC18F86K90供应商

### 11.7 PORTF, LATF and TRISF Registers

PORTF is a 7-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISF and LATF. All pins on PORTF are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

PORTF is multiplexed with analog peripheral functions, as well as LCD segments. Pins, RF1 through RF6, may be used as comparator inputs or outputs by setting the appropriate bits in the CMCON register. To use RF<7:1> as digital inputs, it is also necessary to turn off the comparators.

- **Note 1:** On device Resets, pins, RF<7:1>, are configured as analog inputs and are read as '0'.
  - 2: To configure PORTF as a digital I/O, turn off the comparators and clear ANCON1 and ANCON2 to digital.

PORTF is also multiplexed with LCD segment drives controlled by bits in the LCDSE2 and LCDSE3 registers. I/O port functions are only available when the segments are disabled.

EXAMPLE 11-6: INITIALIZING PORTF

	-	
CLRF	PORTF	; Initialize PORTF by
		; clearing output
		; data latches
CLRF	LATF	; Alternate method
		; to clear output
		; data latches
BANKSEL	ANCON1	
MOVLW	01Fh	; Make AN6, AN7 and AN5 digital
MOVWF	ANCON1	;
MOVLW	0F0h	; Make AN8, AN9, AN10 and AN11
		digital
MOVWF	ANCON2	; Set PORTF as digital I/O
MOVLW	0CEh	; Value used to
		; initialize data
		; direction
MOVWF	TRISF	; Set RF3:RF1 as inputs
		; RF5:RF4 as outputs
		; RF7:RF6 as inputs

#### 查询PIC18F86K90供应商 TABLE 11-12: PORTF FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description
RF1/AN6/C2OUT/	RF1	0	0	DIG	LATF<1> data output; not affected by analog input.
SEG19/CTDIN		1	Ι	ST	PORTF<1> data input; disabled when analog input is enabled.
	AN6	1	Ι	ANA	A/D Input Channel 6. Default configuration on POR.
	C2OUT	0	0	DIG	Comparator 2 output; takes priority over port data.
	SEG19	1	0	ANA	LCD Segment 19 output; disables all other pin functions.
	CTDIN	1	Ι	ST	CTMU pulse delay input.
RF2/AN7/C1OUT/	RF2	0	0	DIG	LATF<2> data output; not affected by analog input.
SEG20		1		ST	PORTF<2> data input; disabled when analog input is enabled.
	AN7	1	Ι	ANA	A/D Input Channel 7. Default configuration on POR.
	C10UT	0	0	DIG	Comparator 1 output; takes priority over port data.
	SEG20	1	0	ANA	LCD Segment 20 output; disables all other pin functions.
RF3/AN8/SEG21/	RF3	0	0	DIG	LATF<3> data output; not affected by analog input.
C2INB/CTMUI		1	Ι	ST	PORTF<3> data input; disabled when analog input is enabled.
	AN8	1	I	ANA	A/D Input Channel 8 and Comparator C2+ input. Default input configuration on POR; not affected by analog output.
	SEG21	1	0	ANA	LCD Segment 21 output; disables all other pin functions.
	C2INB	1	Ι	ANA	Comparator 2 Input B.
	CTMUI	x	0	_	CTMU pulse generator charger for the C2INB comparator input.
RF4/AN9/SEG22/	RF4	0	0	DIG	LATF<4> data output; not affected by analog input.
C2INA -		1	Ι	ST	PORTF<4> data input; disabled when analog input is enabled.
	AN9	1	Ι	ANA	A/D Input Channel 9 and Comparator C2- input. Default input configuration on POR; does not affect digital output.
	SEG22	1	0	ANA	LCD Segment 22 output; disables all other pin functions.
	C2INA	1	I	ANA	Comparator 2 Input A.
RF5/AN10/CVREF/ SEG23/C1INB	RF5	0	0	DIG	LATF<5> data output; not affected by analog input. Disabled when CVREF output is enabled.
		1	I	ST	PORTF<5> data input; disabled when analog input is enabled. Disabled when CVREF output is enabled.
	AN10	1	I	ANA	A/D Input Channel 10 and Comparator C1+ input. Default input configuration on POR.
	CVREF	х	0	ANA	Comparator voltage reference output. Enabling this feature disables digital I/O.
	SEG23	1	0	ANA	LCD Segment 23 output; disables all other pin functions.
	C1INB	1	Ι	ANA	Comparator 1 Input B.
RF6/AN11/SEG24/	RF6	0	0	DIG	LATF<6> data output; not affected by analog input.
C1INA		1	I	ST	PORTF<6> data input; disabled when analog input is enabled.
	AN11	1	Ι	ANA	A/D Input Channel 11 and Comparator C1- input. Default input configuration on POR; does not affect digital output.
	SEG24	1	0	ANA	LCD Segment 24 output; disables all other pin functions.
	C1INA	1	Ι	ANA	Comparator 1 Input A.
RF7/AN5/SS1/	RF7	0	0	DIG	LATF<7> data output; not affected by analog input.
SEG25		1	I	ST	PORTF<7> data input; disabled when analog input is enabled.
	AN5	1	I	ANA	A/D Input Channel 5. Default configuration on POR.
	SS1	1	I	TTL	Slave select input for MSSP module.
	SEG25	1	0	ANA	LCD Segment 25 output; disables all other pin functions.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

### 查询PIC18F86K90供应商 TABLE 11-13: SUMMARY OF REGISTERS ASSOCIATED WITH PORTF

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1		76
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1		76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
ANCON0	ANSEL7	ANSEL6	ANSEL5	ANSEL4	ANSEL3	ANSEL2	ANSEL1	ANSEL0	79
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
CMSTAT	CMP3OUT	CMP2OUT	CMP1OUT	_	—	—	_	_	75
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	75
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTF.

#### 查询PIC18F86K90供应商 11.8 PORTG, TRISG and LATG Registers

PORTG is a 5-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISG and LATG.

PORTG is multiplexed with EUSART, LCD and CCP/ECCP/Analog/Comparator/RTCC/Timer input functions (Table 11-14). When operating as I/O, all PORTG pins have Schmitt Trigger input buffers. The open-drain functionality for the CCPx and UART can be configured using ODCONx.

RG4 is multiplexed with LCD segment drives controlled by bits in the LCDSE2 register and as the RG4/SEG26/RTCC/T7XKI/T5G/CCP5/AN16/P1D/C3INC pin. The I/O port function is only available when the segments are disabled.

The RG5 pin is multiplexed with the MCLR pin and is available only as an input port. To configure this port for input only, set the MCLRE pin (CONFIG3H<7>).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTG pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings. The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register without concern due to peripheral overrides.

### EXAMPLE 11-7: INITIALIZING PORTG

a	50556	
CLRF	PORTG	; Initialize PORTG by
		; clearing output
		; data latches
BCF	CM1CON, CON	; disable
		; comparator 1
CLRF	LATG	; Alternate method
		; to clear output
		; data latches
BANKSEL	ANCON2	
MOVLW	0F0h	; make AN16 to AN19
		; digital
MOVWF	ANCON2	
MOVLW	04h	; Value used to
		; initialize data
		; direction
MOVWF	TRISG	; Set RG1:RG0 as
		; outputs
		; RG2 as input
		; RG4:RG3 as inputs

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RG0/ECCP3/	RG0	0	0	DIG	LATG<0> data output.
P3A		1	Ι	ST	PORTG<0> data input.
	ECCP3	0	0	DIG	ECCP3 compare output and ECCP3 PWM output. Takes priority over port data.
		1	Ι	ST	ECCP3 capture input.
	P3A	0	0	—	ECCP3 PWM Output A. May be configured for tri-state during Enhanced PWM shutdown events.
RG1/TX2/CK2/	RG1	0	0	DIG	LATG<1> data output.
AN19/C3OUT		1	Ι	ST	PORTG<1> data input.
	TX2	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
	CK2	1	0	DIG	Synchronous serial data input (EUSART module); user must configure as an input.
		1	I	ST	Synchronous serial clock input (EUSART module).
	AN19	1	I	ANA	A/D Input Channel 19. Default input configuration on POR. Does not affect digital output.
	C3OUT	x	0	DIG	Comparator 3 output.

### TABLE 11-14: PORTG FUNCTIONS

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

 $\mathbf{x}$  = Don't care (TRIS bit does not affect port direction or is overridden for this option).

#### 查询PIC18F86K90供应商 TABLE 11-14: PORTG FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description			
RG2/RX2/DT2/	RG2	0	0	DIG	LATG<2> data output.			
AN18/C3INA		1	Ι	ST	PORTG<2> data input.			
	RX2	1	Ι	ST	Asynchronous serial receive data input (EUSART module).			
	DT2	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.			
	1		I	ST	Synchronous serial data input (EUSART module); user must configure as an input.			
	AN18	1	I	ANA	A/D Input Channel 18. Default input configuration on POR. Does not affect digital output.			
	C3INA	x	Ι	ANA	Comparator 3 Input A.			
RG3/CCP4/AN17/	RG3	0	0	DIG	LATG<3> data output.			
P3D/C3INB		1	-	ST	PORTG<3> data input.			
	CCP4	0	0	DIG	CCP4 compare/PWM output. Takes priority over port data.			
		1	Ι	ST	CCP4 capture input.			
	AN17	1	Ι	ANA	A/D Input Channel 17. Default input configuration on PR. Does not affect digital output.			
	C3INB	x	Ι	ANA	Comparator 3 Input B.			
	P3D	0	0		ECCP3 PWM Output D. May be configured for tri-state during Enhanced PWM.			
RG4/SEG26/	RG4	0	0	DIG	LATG<4> data output.			
RTCC/T7CKI/ T5G/CCP5/		1	I	ST	PORTG<4> data input.			
AN16/P1D/	SEG26	1	0	ANA	LCD Segment 26 output; disables all other pin functions.			
C3INC	RTCC	x	0	DIG	RTCC output.			
	T7CKI	x	-	ST	Timer7 clock input.			
	T5G	х	-	ST	Timer5 external clock gate input.			
	CCP5	0	0	DIG	CCP5 compare/PWM output. Takes priority over port data.			
		1	Ι	ST	CCP5 capture input.			
	AN16	1	Ι	ANA	A/D Input Channel 17. Default input configuration on POR. Does not affect digital output.			
	C3INC	x	Ι	ANA	Comparator 3 Input C.			
	P1D	0	0	_	ECCP1 PWM Output D. May be configured for tri-state during Enhanced PWM.			
RG5			Ι	ST	See the MCLR/RG5 pin.			

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

### TABLE 11-15: SUMMARY OF REGISTERS ASSOCIATED WITH PORTG

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTG	—	—	RG5 <sup>(1)</sup>	RG4	RG3	RG2	RG1	RG0	76
TRISG	—	—	—	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	76
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	79
ODCON1	SSP10D	CCP2OD	CCP10D	—	_		_	SSP2OD	79
ODCON2	CCP10OD	CCP90D	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD	79
1						DODTO			

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTG.

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, the bit is unimplemented.

#### 查询PIC18F86K90供应商 11.9 PORTH, LATH and

### TRISH Registers

Note:	PORTH is	s	available	only	on	the	80-pin
	devices.						

PORTH is an 8-bit wide, bidirectional I/O port. The corresponding Data Direction and Output Latch registers are TRISH and LATH.

All pins on PORTH are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

All PORTH pins are multiplexed with the ADC/CCP/Comparator and LCD segment drives controlled by the LCDSE5 register. I/O port functions are only available when the segments are disabled.

#### EXAMPLE 11-8: INITIALIZING PORTH

CLRF	PORTH	;	Initialize PORTH by
		;	clearing output
		;	data latches
CLRF	LATH	;	Alternate method
		;	to clear output
		;	data latches
BANKSEL	ANCON2		
MOVLW	0Fh	;	Configure PORTH as
MOVWF	ANCON2	;	digital I/O
MOVLW	0Fh	;	Configure PORTH as
MOVWF	ANCON1	;	digital I/O
MOVLW	0CFh	;	Value used to
		;	initialize data
		;	direction
MOVWF	TRISH	;	Set RH3:RH0 as inputs
		;	RH5:RH4 as outputs
		;	RH7:RH6 as inputs
			_

### 查询PIC18F86K90供应商 TABLE 11-16: PORTH FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RH0/SEG47/	RH0	0	0	DIG	LATH<0> data output.
AN23		1	Ι	ST	PORTH<0> data input.
	SEG47	1	0	ANA	LCD Segment 47 output; disables all other pin functions.
	AN23	1	Ι	ANA	A/D Input Channel 23. Default input configuration on POR. Does not affect digital input.
RH1/SEG46/	RH1	0	0	DIG	LATH<1> data output.
AN22		1	I	ST	PORTH<1> data input.
	SEG46	1	0	ANA	LCD Segment 46 output; disables all other pin functions.
	AN22	1	I	ANA	A/D Input Channel 22. Default input configuration on POR. Does not affect digital input.
RH2/SEG45/	RH2	0	0	DIG	LATH<2> data output.
AN21		1	Ι	ST	PORTH<2> data input.
	SEG45	1	0	ANA	LCD Segment 45 output; disables all other pin functions.
	AN21	1	I	ANA	A/D Input Channel 21. Default input configuration on POR. Does not affect digital input.
RH3/SEG44/	RH3	0	0	DIG	LATH<3> data output.
AN20		1	I	ST	PORTH<3> data input.
	SEG44	1	0	ANA	LCD Segment 44 output; disables all other pin functions.
	AN20	1	Ι	ANA	A/D Input Channel 20. Default input configuration on POR. Does not affect digital input.
RH4/SEG40/	RH4	0	0	DIG	LATH<4> data output.
CCP9/P3C/		1	I	ST	PORTH<4> data input.
AN12/C2INC	SEG40	1	0	ANA	LCD Segment 40 output; disables all other pin functions.
	CCP9	0	0	DIG	CCP9 compare/PWM output. Takes priority over port data.
		1	I	ST	CCP9 capture input.
	P3C	0	0	_	ECCP3 PWM Output C. May be configured for tri-state during Enhanced PWM.
	AN12	1	Ι	ANA	A/D Input Channel 12. Default input configuration on POR. Does not affect digital input.
	C2INC	x	I	ANA	Comparator 2 Input C.
RH5/SEG41/	RH5	0	0	DIG	LATH<5> data output.
CCP8/P3B/		1	I	ST	PORTH<5> data input.
AN13/C2IND	SEG41	1	0	ANA	LCD Segment 41 output; disables all other pin functions.
	CCP8	0	0	DIG	CCP8 compare/PWM output. Takes priority over port data.
		1	I	ST	CCP8 capture input.
	P3B	0	0	—	ECCP3 PWM Output B. May be configured for tri-state during Enhanced PWM.
	AN13	1	I	ANA	A/D Input Channel 13. Default input configuration on POR. Does not affect digital input.
	C2IND	x	1	ANA	Comparator 2 Input D.

O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, Legend: x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

#### 查询PIC18F86K90供应商 TABLE 11-16: PORTH FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description	
RH6/SEG42/	RH6	0	0	DIG	LATH<6> data output.	
CCP7/P1C/		1	Ι	ST	PORTH<6> data input.	
AN14/C1INC	SEG42	1	0	ANA	LCD Segment 42 output; disables all other pin functions.	
	CCP7	0	0	DIG	CCP7 compare/PWM output. Takes priority over port data.	
		1	Ι	ST	CCP7 capture input.	
	P1C	0	0	—	ECCP1 PWM Output C. May be configured for tri-state during Enhanced PWM.	
	AN14	1	I	ANA	A/D Input Channel 14. Default input configuration on POR. Does no affect digital input.	
	C1INC	x	Ι	ANA	Comparator 1 Input C.	
RH7/SEG43/	RH7	0	0	DIG	LATH<7> data output.	
CCP6/P1B/		1	I	ST	PORTH<7> data input.	
AN15	SEG43	1	0	ANA	LCD Segment 43 output; disables all other pin functions.	
	CCP6	0	0	DIG	CCP6 compare/PWM output. Takes priority over port data.	
		1	Ι	ST	CCP6 capture input.	
	P1B			—	ECCP1 PWM Output B. May be configured for tri-state during Enhanced PWM.	
	AN15	1	Ι	ANA	A/D Input Channel 15. Default input configuration on POR. Does not affect digital input.	

**Legend:** O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 11-17:	SUMMARY OF REGISTERS ASSOCIATED WITH PORTH
--------------	--

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTH	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	76
LATH	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	76
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76
LCDSE5	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	81
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	79
ODCON2	CCP100D	CCP90D	CCP8OD	CCP7OD	CCP6OD	CCP50D	CCP4OD	CCP3OD	79

### <u>查询PIC18F86K90供应商</u> 11.10 PORTJ, TRISJ and

### LATJ Registers

#### **Note:** PORTJ is available only on 80-pin devices.

PORTJ is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISJ and LATJ.

All pins on PORTJ are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

All PORTJ pins except RJ0 are multiplexed with LCD segment drives controlled by the LCDSE4 register. I/O port functions are only available on these pins when the segments are disabled.

Each of the PORTJ pins has a weak internal pull-up. The pull-ups are provided to keep the inputs at a known state for the external memory interface while powering up. A single control bit can turn off all the pull-ups. This is performed by clearing bit RJPU (PADCFG1<5>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

#### EXAMPLE 11-9: INITIALIZING PORTJ

CLRF	PORTJ	; Initialize PORTJ by
		; clearing output latches
CLRF	LATJ	; Alternate method
		; to clear output latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISJ	; Set RJ3:RJ0 as inputs
		; RJ5:RJ4 as output
		; RJ7:RJ6 as inputs

#### 查询PIC18F86K90供应商 TABLE 11-18: PORTJ FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Туре	Description				
RJ0	RJ0	0	0	DIG	LATJ<0> data output.				
		1	I	ST	PORTJ<0> data input.				
RJ1/SEG33	RJ1	0	0	DIG	LATJ<1> data output.				
		1	I	ST	PORTJ<1> data input.				
	SEG33	1	0	ANA	LCD Segment 33 output; disables all other pin functions.				
RJ2/SEG34	RJ2	0	0	DIG	LATJ<2> data output.				
		1	I	ST	PORTJ<2> data input.				
	SEG34	1	0	ANA	LCD Segment 34 output; disables all other pin functions.				
RJ3/SEG35	RJ3	0	0	DIG	LATJ<3> data output.				
		1	I	ST	PORTJ<3> data input.				
	SEG35	1	0	ANA	LCD Segment 35 output; disables all other pin functions.				
RJ4/SEG39	RJ4	0	0	DIG	LATJ<4> data output.				
		1	I	ST	PORTJ<4> data input.				
	SEG39	1	0	ANA	LCD Segment 39 output; disables all other pin functions.				
RJ5/SEG38	RJ5	0	0	DIG	LATJ<5> data output.				
		1	I	ST	PORTJ<5> data input.				
	SEG38	1	0	ANA	LCD Segment 38 output; disables all other pin functions.				
RJ6/SEG37	RJ6	0	0	DIG	LATJ<6> data output.				
		1	I	ST	PORTJ<6> data input.				
	SEG37	1	0	ANA	LCD Segment 37 output; disables all other pin functions.				
RJ7/SEG36	RJ7	0	0	DIG	LATJ<7> data output.				
		1	I	ST	PORTJ<7> data input.				
	SEG36	1	0	ANA	LCD Segment 36 output; disables all other pin functions.				

**Legend:** O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 11-19:	SUMMARY OF REGISTERS ASSOCIATED WITH PORTJ
--------------	--

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTJ	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	76
LATJ	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	76
TRISJ	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	76
LCDSE4	SE39	SE38	SE37	SE36	SE35	SE34	SE33	SE32	81
PADCFG1	RDPU	REPU	RJPU <sup>(1)</sup>	—	—	RTSECSEL1	RTSECSEL0	_	78

Legend: Shaded cells are not used by PORTJ.

Note 1: Unimplemented on PIC18F6XK90 devices, read as '0'.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商 12.0 TIMER0 MODULE

The Timer0 module incorporates the following features:

- Software-selectable operation as a timer or
- counter in both 8-bit or 16-bit modes
- Readable and writable registers
- Dedicated 8-bit, software programmable
   prescaler
- Selectable clock source (internal or external)
- · Edge select for external clock
- Interrupt-on-overflow

The T0CON register (Register 12-1) controls all aspects of the module's operation, including the prescale selection. It is both readable and writable.

Figure 12-1 provides a simplified block diagram of the Timer0 module in 8-bit mode. Figure 12-2 provides a simplified block diagram of the Timer0 module in 16-bit mode.

#### REGISTER 12-1: T0CON: TIMER0 CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR00N	T08BIT	TOCS	TOSE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

Legend:						
R = Reada	able bit	W = Writable bit	U = Unimplemented bit	, read as '0'		
-n = Value at POR (1' = Bit is set			'0' = Bit is cleared x = Bit is unkno			
bit 7		Timer0 On/Off Control bit				
	1 = Enable					
	0 = Stops	Timer0				
bit 6	TO8BIT: Ti	mer0 8-Bit/16-Bit Control bi	t			
	1 = Timer0	) is configured as an 8-bit ti	mer/counter			
	0 = Timer0	) is configured as a 16-bit ti	mer/counter			
bit 5	TOCS: Tim	er0 Clock Source Select bi	t			
	1 = Transi	tion on T0CKI pin input edg	e			
	0 = Internal clock (Fosc/4)					
bit 4	T0SE: Timer0 Source Edge Select bit					
	1 = Increm	ent on high-to-low transitio	n on the T0CKI pin			
	0 = Increm	ent on low-to-high transitio	n on the T0CKI pin			
bit 3	PSA: Time	er0 Prescaler Assignment b	it			
	1 = Timer0 prescaler is not assigned; Timer0 clock input bypasses the prescaler					
	0 = Timer	prescaler is assigned; Tim	er0 clock input comes from the	e prescaler output		
bit 2-0	T0PS<2:0	>: Timer0 Prescaler Select	bits			
	111 <b>= 1:2</b> 5	56 Prescale value				
	110 <b>= 1:1</b> 2	28 Prescale value				
	101 <b>= 1:6</b> 4	Prescale value				
		2 Prescale value				
		6 Prescale value				
		Prescale value				
		Prescale value				
	000 = 1:2	Prescale value				

#### 查询PIC18F86K90供应商 12.1 Timer0 Operation

Timer0 can operate as either a timer or a counter. The mode is selected with the TOCS bit (TOCON<5>). In Timer mode (TOCS = 0), the module increments on every clock by default unless a different prescaler value is selected (see **Section 12.3 "Prescaler"**). If the TMR0 register is written to, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register.

The Counter mode is selected by setting the T0CS bit (= 1). In this mode, Timer0 increments either on every rising edge or falling edge of the T0CKI pin. The incrementing edge is determined by the Timer0 Source Edge Select bit, T0SE (T0CON<4>); clearing this bit selects the rising edge. Restrictions on the external clock input are discussed below.

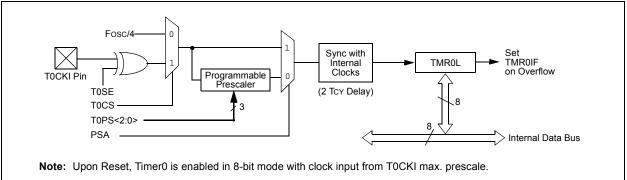
An external clock source can be used to drive Timer0; however, it must meet certain requirements to ensure that the external clock can be synchronized with the internal phase clock (Tosc). There is a delay between synchronization and the onset of incrementing the timer/counter.

### 12.2 Timer0 Reads and Writes in 16-Bit Mode

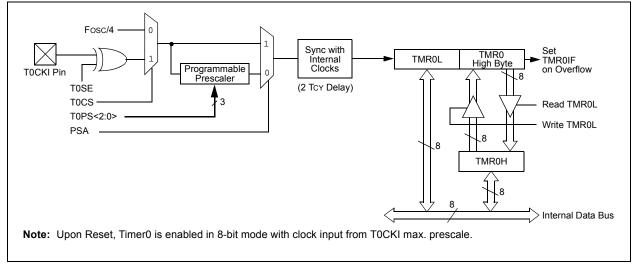
TMR0H is not the actual high byte of Timer0 in 16-bit mode. It is actually a buffered version of the real high byte of Timer0, which is not directly readable nor writable. (See Figure 12-2.) TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16 bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

Similarly, a write to the high byte of Timer0 must also take place through the TMR0H Buffer register. The high byte is updated with the contents of TMR0H when a write occurs to TMR0L. This allows all 16 bits of Timer0 to be updated at once.

#### FIGURE 12-1: TIMER0 BLOCK DIAGRAM (8-BIT MODE)



#### FIGURE 12-2: TIMER0 BLOCK DIAGRAM (16-BIT MODE)



#### 查询PIC18F86K90供应商 12.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not directly readable or writable. Its value is set by the PSA and T0PS<2:0> bits (T0CON<3:0>), which determine the prescaler assignment and prescale ratio.

Clearing the PSA bit assigns the prescaler to the Timer0 module. When it is assigned, prescale values from 1:2 through 1:256 in power-of-two increments are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (for example, CLRF TMR0, MOVWF TMR0, BSF TMR0) clear the prescaler count.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count but will not change the prescaler assignment.

#### 12.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control and can be changed "on-the-fly" during program execution.

#### 12.4 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or from FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF flag bit. The interrupt can be masked by clearing the TMR0IE bit (INTCON<5>). Before reenabling the interrupt, the TMR0IF bit must be cleared in software by the Interrupt Service Routine (ISR).

Since Timer0 is shut down in Sleep mode, the TMR0 interrupt cannot awaken the processor from Sleep.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TMR0L	Timer0 Reg	Timer0 Register Low Byte					74		
TMR0H	Timer0 Reg	Timer0 Register High Byte					74		
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
T0CON	TMR0ON	T08BIT	TOCS	T0SE	PSA	T0PS2	T0PS1	T0PS0	74

 TABLE 12-1:
 REGISTERS ASSOCIATED WITH TIMER0

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by Timer0.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商

#### 13.0 TIMER1 MODULE

The Timer1 timer/counter module incorporates these features:

- Software-selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR1H and TMR1L)
- Selectable clock source (internal or external) with device clock or SOSC oscillator internal options
- Interrupt-on-overflow
- Reset on ECCP Special Event Trigger
- Timer with gated control

Figure 13-1 displays a simplified block diagram of the Timer1 module.

The SOSC oscillator can also be used as a low-power clock source for the microcontroller in power-managed operation. Timer1 can also work on the SOSC oscillator.

Timer1 is controlled through the T1CON Control register (Register 13-1). It also contains the SOSC Oscillator Enable bit (SOSCEN). Timer1 can be enabled or disabled by setting or clearing control bit, TMR1ON (T1CON<0>).

The FOSC clock source should not be used with the ECCP capture/compare features. If the timer will be used with the capture or compare features, always select one of the other timer clocking options.

#### REGISTER 13-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N
bit 7							bit 0

Legend:				
R = Reada	ble bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR (1' = Bit is set		'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7-6	10 = The <u>SO</u> Ext <u>SO</u> Cry SO 01 = Time	<u>SCEN = 0:</u> ernal clock is from the T1CKI <u>SCEN = 1:</u>	er a pin or an oscillator depend I pin (on the rising edge). SCI/SOSCO pins or an extended on clock (Fosc) <sup>(1)</sup>	ding on the SOSCEN bit. ded clock on SCKLI (depends or
bit 5-4	11 = 1:8 F 10 = 1:4 F 01 = 1:2 F	<b>:1:0&gt;:</b> Timer1 Input Clock Pro Prescale value Prescale value Prescale value Prescale value Prescale value	escale Select bits	
bit 3	1 = SOSC 0 = SOSC	: SOSC Oscillator Enable bit C is enabled for Timer1 (base C is disabled for Timer1 ator inverter and feedback re		ate power drain.
bit 2	<b>T1SYNC:</b> Timer1 External Clock Input Synchronization Select bit <u>TMR1CS&lt;1:0&gt; = 10:</u> 1 = Do not synchronize the external clock input 0 = Synchronize the external clock input <u>TMR1CS&lt;1:0&gt; = 0x:</u> This bit is ignored. Timer1 uses the internal clock when TMR1CS<1:0> = 1x.		: <b>0&gt; =</b> 1x.	
bit 1	<b>RD16:</b> 16 1 = Enab	-Bit Read/Write Mode Enable les register read/write of Tim les register read/write of Tim	e bit er1 in one 16-bit operation	
bit 0	-	: Timer1 On bit les Timer1 s Timer1		

Note 1: The Fosc clock source should not be selected if the timer will be used with the ECCP capture/compare features.

#### 查询PIC18F86K90供应商

#### 13.1 Timer1 Gate Control Register

The Timer1 Gate Control register (T1GCON), displayed in Register 13-2, is used to control the Timer1 gate.

#### **REGISTER 13-2:** T1GCON: TIMER1 GATE CONTROL REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-x	R/W-0	R/W-0
TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/T1DONE	T1GVAL	T1GSS1	T1GSS0
bit 7				•			bit 0
Legend:							
R = Reada		W = Writable		U = Unimplemented	d bit, read as		
-n = Value	at POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unkn	own
bit 7	TMR1GE: Ti	mer1 Gate Ena	able bit				
	If TMR1ON =	<u>= 0</u> :					
	This bit is igr	nored.					
	If TMR10N						
				Timer1 gate function er1 gate function			
bit 6		mer1 Gate Pola		si i gato fanotion			
	1 = Timer1 gate is active-high (Timer1 counts when gate is high)						
	0 = Timer1 gate is active-low (Timer1 counts when gate is low)						
bit 5	T1GTM: Tim	er1 Gate Togg	e Mode bit				
		Gate Toggle m					
		Gate Toggle mo flip-flop toggles		d and toggle flip-flop	is cleared		
bit 4	•	mer1 Gate Sin	-				
			-	nabled and is controll	ling Timer1 ga	ate	
		ate Single Pul			0 0		
bit 3	T1GGO/T1D	ONE: Timer1 (	Gate Single P	ulse Acquisition State	us bit		
				is ready, waiting for a			
				has completed or ha GSPM is cleared.	is not been st	arted	
bit 2		ner1 Gate Cur		GSFINIIS Cleared.			
				gate that could be r	provided to TI		unaffected by
	Indicates the current state of the Timer1 gate that could be provided to TMR1H:TMR1L; unaffecte the Timer1 Gate Enable (TMR1GE) bit.						unancolou by
bit 1-0	T1GSS<1:0>: Timer1 Gate Source Select bits						
	11 = Comparator 2 output						
		rator 1 output					
	01 = TMR2 1 00 = Timer1	o match PR2 c	output				
		yal <del>o</del> pili					

#### **Note 1:** Programming the T1GCON prior to T1CON is recommended.

### 查询PIC18F86K90供应商

#### 13.2 Timer1 Operation

The Timer1 module is an 8 or 16-bit incrementing counter that is accessed through the TMR1H:TMR1L register pair.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter. It increments on every selected edge of the external source.

Timer1 is enabled by configuring the TMR1ON and TMR1GE bits in the T1CON and T1GCON registers, respectively.

When SOSC is selected as a Crystal mode (by SOSCEL), the RC1/SOSCI/ECCP2/P2A/SEG32 and RC0/SOSCO/SCLKI pins become inputs. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

#### 13.3 Clock Source Selection

The TMR1CS<1:0> and SOSCEN bits of the T1CON register are used to select the clock source for Timer1. Register 13-1 displays the clock source selections.

#### 13.3.1 INTERNAL CLOCK SOURCE

When the internal clock source is selected, the TMR1H:TMR1L register pair will increment on multiples of Fosc as determined by the Timer1 prescaler.

#### 13.3.2 EXTERNAL CLOCK SOURCE

When the external clock source is selected, the Timer1 module may work as a timer or a counter.

When enabled to count, Timer1 is incremented on the rising edge of the external clock input, T1CKI. Either of these external clock sources can be synchronized to the microcontroller system clock or they can run asynchronously.

When used as a timer with a clock oscillator, an external, 32.768 kHz crystal can be used in conjunction with the dedicated internal oscillator circuit.

Note:	In Counter mode, a falling edge must be registered by the counter prior to the first
	incrementing rising edge after any one or more of the following conditions:

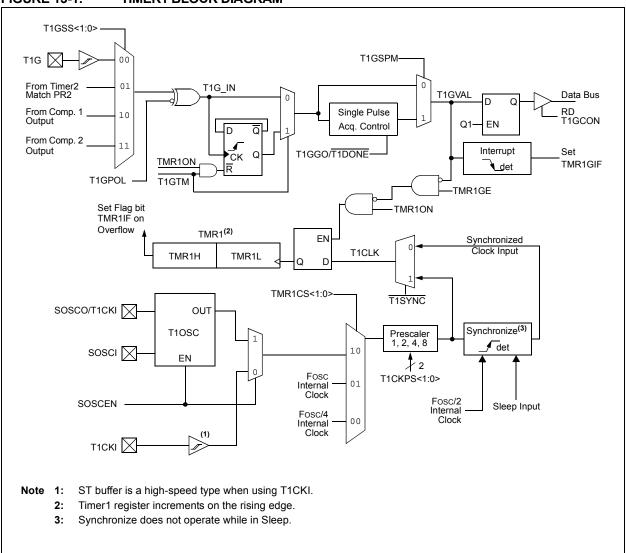
• Timer1 is enabled after a POR Reset

- Write to TMR1H or TMR1L
- Timer1 is disabled
- Timer1 is disabled (TMR1ON = 0)

When T1CKI is high, Timer1 is enabled (TMR1ON = 1) when T1CKI is low.

TMR1CS1	TMR1CS0	SOSCEN	Clock Source
0	1	х	Clock Source (Fosc)
0	0	х	Instruction Clock (Fosc/4)
1	0	0	External Clock on T1CKI Pin
1	0	1	Oscillator Circuit on SOSCI/SOSCO Pins

#### 查询PIC18F86K90供应商 FIGURE 13-1: TIMER1 BLOCK DIAGRAM



#### 查询PIC18F86K90供应商 13.4 Timer1 16-Bit Read/Write Mode

Timer1 can be configured for 16-bit reads and writes. When the RD16 control bit (T1CON<1>) is set, the address for TMR1H is mapped to a buffer register for the high byte of Timer1. A read from TMR1L loads the contents of the high byte of Timer1 into the Timer1 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer1 must also take place through the TMR1H Buffer register. The Timer1 high byte is updated with the contents of TMR1H when a write occurs to TMR1L. This allows a user to write all 16 bits at once to both the high and low bytes of Timer1.

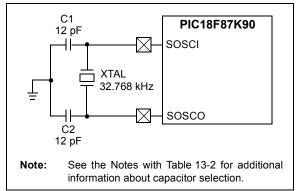
The high byte of Timer1 is not directly readable or writable in this mode. All reads and writes must take place through the Timer1 High Byte Buffer register. Writes to TMR1H do not clear the Timer1 prescaler. The prescaler is only cleared on writes to TMR1L.

#### 13.5 SOSC Oscillator

An on-chip crystal oscillator circuit is incorporated between pins, SOSCI (input) and SOSCO (amplifier output). It is enabled by setting one of five bits: any of the four SOSCEN bits in the TxCON registers (TxCON<3>) or the SOSCGO bit in the OSCCON2 register (OSCCON2<3>). The oscillator is a low-power circuit rated for 32 kHz crystals. It will continue to run during all power-managed modes. The circuit for a typical LP oscillator is depicted in Figure 13-2. Table 13-2 provides the capacitor selection for the SOSC oscillator.

The user must provide a software time delay to ensure proper start-up of the SOSC oscillator.

#### FIGURE 13-2: EXTERNAL COMPONENTS FOR THE SOSC OSCILLATOR



# TABLE 13-2: CAPACITOR SELECTION FOR THE TIMER OSCILLATOR<sup>(2,3,4,5)</sup>

Oscillator Type	Freq.	C1	C2	
LP	32 kHz	12 pF <sup>(1)</sup>	12 pF <sup>(1)</sup>	

- Note 1: Microchip suggests these values as a starting point in validating the oscillator circuit.
  - 2: Higher capacitance increases the stability of the oscillator, but also increases the start-up time.
  - 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
  - 4: Capacitor values are for design guidance only. Values listed would be typical of a CL = 10 pF rated crystal, when SOSCSEL = 11.
  - Incorrect capacitance value may result in a frequency not meeting the crystal manufacturer's tolerance specification.

The SOSC crystal oscillator drive level is determined based on the SOSCSEL (CONFIG1L<4:3>) Configuration bits. The High Drive Level mode, SOSCSEL<1:0> = 11, is intended to drive a wide variety of 32.768 kHz crystals with a variety of load capacitance (CL) ratings.

The Low Drive Level mode is highly optimized for extremely low-power consumption. It is not intended to drive all types of 32.768 kHz crystals. In the Low Drive Level mode, the crystal oscillator circuit may not work correctly if excessively large discrete capacitors are placed on the SOSCO and SOSCI pins. This mode is designed to work only with discrete capacitances of approximately 3 pF-10 pF on each pin.

Crystal manufacturers usually specify a CL (load capacitance) rating for their crystals. This value is related to, but not necessarily the same as, the values that should be used for C1 and C2 in Figure 13-2.

For more details on selecting the optimum C1 and C2 for a given crystal, see the crystal manufacture's applications information. The optimum value depends in part on the amount of parasitic capacitance in the circuit, which is often unknown. For that reason, it is highly recommended that thorough testing and validation of the oscillator be performed after values have been selected.

#### 查询PIC18F86K90供应商 13.5.1 USING SOSC AS A CLOCK SOURCE

The SOSC oscillator is also available as a clock source in power-managed modes. By setting the clock select bits, SCS<1:0> (OSCCON<1:0>), to '01', the device switches to SEC\_RUN mode and both the CPU and peripherals are clocked from the SOSC oscillator. If the IDLEN bit (OSCCON<7>) are cleared and a SLEEP instruction is executed, the device enters SEC\_IDLE mode. Additional details are available in **Section 4.0 "Power-Managed Modes"**.

Whenever the SOSC oscillator is providing the clock source, the SOSC System Clock Status Flag, SOSCRUN (OSCCON2<6>), is set. This can be used to determine the controller's current clocking mode. It can also indicate the clock source currently being used by the Fail-Safe Clock Monitor.

If the Clock Monitor is enabled and the SOSC oscillator fails while providing the clock, polling the SOCSRUN bit will indicate whether the clock is being provided by the SOSC oscillator or another source.

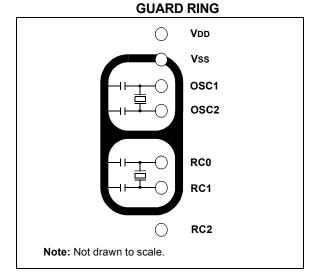
### 13.5.2 SOSC OSCILLATOR LAYOUT CONSIDERATIONS

The SOSC oscillator circuit draws very little power during operation. Due to the low-power nature of the oscillator, it may also be sensitive to rapidly changing signals in close proximity. This is especially true when the oscillator is configured for extremely low-power mode (CONFIG1L<4:3> (SOSCSEL) = 01).

The oscillator circuit, displayed in Figure 13-2, should be located as close as possible to the microcontroller. There should be no circuits passing within the oscillator circuit boundaries other than VSS or VDD.

If a high-speed circuit must be located near the oscillator, it may help to have a grounded guard ring around the oscillator circuit. The guard, as displayed in Figure 13-3, could be used on a single-sided PCB or in addition to a ground plane. (Examples of a high-speed circuit include the ECCP1 pin, in Output Compare or PWM mode, or the primary oscillator, using the OSC2 pin.)

#### FIGURE 13-3: OSCILLATOR CIRCUIT WITH GROUNDED



In the Low Drive Level mode, SOSCSEL<1:0> = 01, it is critical that RC2 I/O pin signals be kept away from the oscillator circuit. Configuring RC2 as a digital output, and toggling it, can potentially disturb the oscillator circuit, even with a relatively good PCB layout. If possible, either leave RC2 unused or use it as an input pin with a slew rate limited signal source. If RC2 must be used as a digital output, it may be necessary to use the High Drive Level Oscillator mode (SOSCSEL<1:0> = 11) with many PCB layouts.

Even in the High Drive Level mode, careful layout procedures should still be followed when designing the oscillator circuit.

In addition to dV/dt induced noise considerations, it is important to ensure that the circuit board is clean. Even a very small amount of conductive soldering flux residue can cause PCB leakage currents that can overwhelm the oscillator circuit.

#### 13.6 Timer1 Interrupt

The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit, TMR1IF (PIR1<0>). This interrupt can be enabled or disabled by setting or clearing the Timer1 Interrupt Enable bit, TMR1IE (PIE1<0>).

#### 查询PIC18F86K90供应商

#### 13.7 Resetting Timer1 Using the ECCP Special Event Trigger

If ECCP modules are configured to use Timer1 and to generate a Special Event Trigger in Compare mode (CCPxM<3:0> = 1011), this signal will reset Timer1. The trigger from ECCP2 will also start an A/D conversion, if the A/D module is enabled. (For more information, see **Section 19.3.4 "Special Event Trigger"**.)

To take advantage of this feature, the module must be configured as either a timer or a synchronous counter. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a period register for Timer1.

If Timer1 is running in Asynchronous Counter mode, this Reset operation may not work.

In the event that a write to Timer1 coincides with a Special Event Trigger, the write operation will take precedence.

Note:	The Special Event Trigger from the
	ECCPx module will only clear the TMR1
	register's content, but not set the TMR1IF
	interrupt flag bit (PIR1<0>).

#### 13.8 Timer1 Gate

Timer1 can be configured to count freely or the count can be enabled and disabled using the Timer1 gate circuitry. This is also referred to as Timer1 gate count enable.

Timer1 gate can also be driven by multiple selectable sources.

#### 13.8.1 TIMER1 GATE COUNT ENABLE

The Timer1 Gate Enable mode is enabled by setting the TMR1GE bit of the T1GCON register. The polarity of the Timer1 Gate Enable mode is configured using the T1GPOL bit (T1GCON<6>).

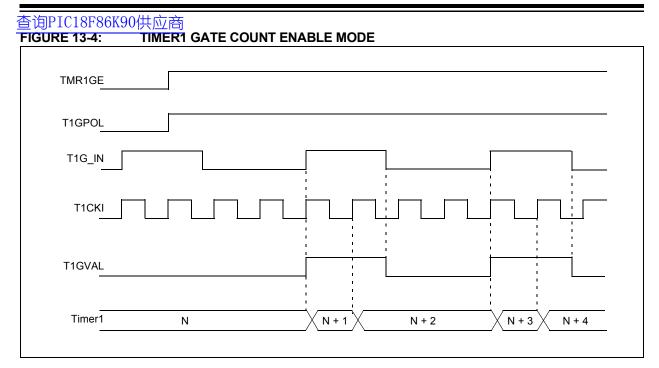
When Timer1 Gate Enable mode is enabled, Timer1 will increment on the rising edge of the Timer1 clock source. When Timer1 Gate Enable mode is disabled, no incrementing will occur and Timer1 will hold the current count. See Figure 13-4 for timing details.

TABLE 13-3:	TIMER1 GATE ENABLE
	SELECTIONS

T1CLK <sup>(†)</sup>	T1GPOL (T1GCON<6>)	T1G Pin	Timer1 Operation
$\uparrow$	0	0	Counts
$\uparrow$	0	1	Holds Count
$\uparrow$	1	0	Holds Count
$\uparrow$	1	1	Counts

† The clock on which TMR1 is running. For more information, see Figure 13-1.

Note: The CCP and ECCP modules use Timers, 1 through 8, for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.



#### 13.8.2 TIMER1 GATE SOURCE SELECTION

The Timer1 gate source can be selected from one of four sources. Source selection is controlled by the T1GSSx bits, T1GCON<1:0> (see Table 13-4).

TABLE 13-4:TIMER1 GATE SOURCES
--------------------------------

T1GSS<1:0>	Timer1 Gate Source
00	Timer1 Gate Pin
01	TMR2 to Match PR2 (TMR2 increments to match PR2)
10	Comparator 1 Output (Comparator logic high output)
11	Comparator 2 Output (Comparator logic high output)

The polarity for each available source is also selectable, controlled by the T1GPOL bit (T1GCON<6>).

#### 13.8.2.1 T1G Pin Gate Operation

The T1G pin is one source for Timer1 gate control. It can be used to supply an external source to the Timer1 gate circuitry.

#### 13.8.2.2 Timer2 Match Gate Operation

The TMR2 register will increment until it matches the value in the PR2 register. On the very next increment cycle, TMR2 will be reset to 00h. When this Reset occurs, a low-to-high pulse will automatically be generated and internally supplied to the Timer1 gate circuitry. The pulse will remain high for one instruction cycle and will return back to a low state until the next match.

Depending on T1GPOL, Timer1 increments differently when TMR2 matches PR2. When T1GPOL = 1, Timer1 increments for a single instruction cycle following a TMR2 match with PR2. When T1GPOL = 0, Timer1 increments continuously, except for the cycle following the match, when the gate signal goes from low-to-high.

#### 13.8.2.3 Comparator 1 Output Gate Operation

The output of Comparator 1 can be internally supplied to the Timer1 gate circuitry. After setting up Comparator 1 with the CM1CON register, Timer1 will increment depending on the transition of the CMP1OUT (CMSTAT<5>) bit.

#### 13.8.2.4 Comparator 2 Output Gate Operation

The output of Comparator 2 can be internally supplied to the Timer1 gate circuitry. After setting up Comparator 2 with the CM2CON register, Timer1 will increment depending on the transition of the CMP2OUT (CMSTAT<6>) bit.

### 查询PIC18F86K90供应商

#### 13.8.3 TIMERI GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full cycle length of a Timer1 gate signal, as opposed to the duration of a single level pulse.

The Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. (For timing details, see Figure 13-5.)

The T1GVAL bit (T1GCON<2>) indicates when the Toggled mode is active and the timer is counting.

The Timer1 Gate Toggle mode is enabled by setting the T1GTM bit (T1GCON<5>). When T1GTM is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

00KE 10-0.		
TMR1GE		
T1GPOL		
T1GTM		
T1G_IN	[	
Т1СКІ		
T1GVAL		
Timer1	N	$\sqrt{N+1}$ $\sqrt{N+2}$ $\sqrt{N+3}$ $N+4$ $\sqrt{N+5}$ $\sqrt{N+6}$ $\sqrt{N+7}$ $N+8$

#### FIGURE 13-5: TIMER1 GATE TOGGLE MODE

#### 查询PIC18F86K90供应商

#### 13.8.4 TIMER1 GATE SINGLE PULSE MODE

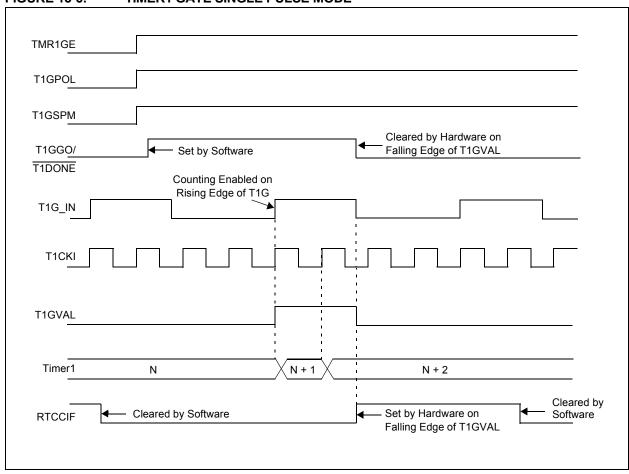
When Timer1 Gate Single Pulse mode is enabled, it is possible to capture a single pulse gate event. Timer1 Gate Single Pulse mode is enabled by setting the T1GSPM bit (T1GCON<4>) and the T1GGO/T1DONE bit (T1GCON<3>). The Timer1 will be fully enabled on the next incrementing edge.

On the next trailing edge of the pulse, the T1GGO/ T1DONE bit will automatically be cleared. No other gate events will be allowed to increment Timer1 until the T1GGO/T1DONE bit is once again set in software. Clearing the T1GSPM <u>bit of the</u> T1GCON register will also clear the T1GGO/T1DONE bit. (For timing details, see Figure 13-6.)

Simultaneously enabling the Toggle and Single Pulse modes will permit both sections to work together. This allows the cycle times on the Timer1 gate source to be measured. (For timing details, see Figure 13-7.)

#### 13.8.5 TIMER1 GATE VALUE STATUS

When the Timer1 gate value status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the T1GVAL bit (T1GCON<2>). This bit is valid even when the Timer1 gate is not enabled (TMR1GE bit is cleared).



#### FIGURE 13-6: TIMER1 GATE SINGLE PULSE MODE

查询PIC18F86K90供[	立商
FIGURE 13-7:	TIMER1 GATE SINGLE PULSE AND TOGGLE COMBINED MODE
TMR1GE	
T1GPOL	
T1GSPM	
T1GTM	
T1GG <u>O/</u> T1DONE T1G_IN	Cleared by Hardware on Falling Edge of T1GVAL
T1CKI	
T1GVAL	
Timer1	N X N + 1 X N + 2 X N + 3 X N + 4
RTCCIF	Set by Hardware on Cleared by Falling Edge of T1GVAL

#### TABLE 13-5: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
TMR1L	Timer1 Register Low Byte								
TMR1H	Timer1 Reg	jister High B	yte						74
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	74
T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ T1DONE	T1GVAL	T1GSS1	T1GSS0	75
OSCCON2	_	SOSCRUN	—	_	SOSCGO	—	MFIOFS	MFIOSEL	77
CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	79
CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2	_	_		C10TSEL0		C9TSEL0	C8TSEL1	C8TSEL0	79

**Legend:** Shaded cells are not used by the Timer1 module.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商 14.0 TIMER2 MODULE

The Timer2 module incorporates the following features:

- 8-bit Timer and Period registers (TMR2 and PR2, respectively)
- · Both registers readable and writable
- Software programmable prescaler (1:1, 1:4 and 1:16)
- Software programmable postscaler (1:1 through 1:16)
- Interrupt on TMR2 to PR2 match
- Optional use as the shift clock for the MSSP modules

The module is controlled through the T2CON register (Register 14-1) that enables or disables the timer, and configures the prescaler and postscaler. Timer2 can be shut off by clearing control bit, TMR2ON (T2CON<2>), to minimize power consumption.

A simplified block diagram of the module is shown in Figure 14-1.

#### 14.1 Timer2 Operation

In normal operation, TMR2 is incremented from 00h on each clock (Fosc/4). A 4-bit counter/prescaler on the clock input gives the prescale options of direct input, divide-by-4 or divide-by-16. These are selected by the prescaler control bits, T2CKPS<1:0> (T2CON<1:0>).

The value of TMR2 is compared to that of the Period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/ postscaler. (See **Section 14.2 "Timer2 Interrupt"**.)

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, while the PR2 register initializes at FFh. Both the prescaler and postscaler counters are cleared on the following events:

- A write to the TMR2 register
- · A write to the T2CON register
- Any device Reset (Power-on Reset (POR), MCLR Reset, Watchdog Timer Reset (WDTR) or Brown-out Reset [BOR])

TMR2 is not cleared when T2CON is written.

Note: The CCP and ECCP modules use Timers 1 through 8 for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

#### REGISTER 14-1: T2CON: TIMER2 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

#### bit 7 Unimplemented: Read as '0'

bit 6-3	T2OUTPS<3:0>: Timer2 Output Postscale Select bits
	0000 = 1:1 Postscale
	0001 = 1:2 Postscale
	•
	•
	•
	1111 = 1:16 Postscale
bit 2	TMR2ON: Timer2 On bit
	1 = Timer2 is on
	0 = Timer2 is off
bit 1-0	T2CKPS<1:0>: Timer2 Clock Prescale Select bits
	00 = Prescaler is 1
	01 = Prescaler is 4
	1x = Prescaler is 16

#### 查询PIC18F86K90供应商 14.2 Timer2 Interrupt

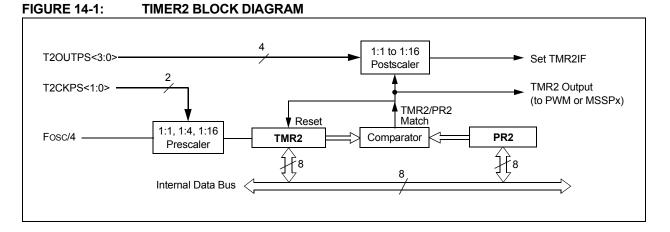
Timer2 can also generate an optional device interrupt. The Timer2 output signal (TMR2 to PR2 match) provides the input for the 4-bit output counter/postscaler. This counter generates the TMR2 match interrupt flag, which is latched in TMR2IF (PIR1<1>). The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE (PIE1<1>).

A range of 16 postscaler options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS<3:0> (T2CON<6:3>).

#### 14.3 Timer2 Output

The unscaled output of TMR2 is available primarily to the ECCP modules, where it is used as a time base for operations in PWM mode.

Timer2 can optionally be used as the shift clock source for the MSSP modules operating in SPI mode. Additional information is provided in Section 21.0 "Master Synchronous Serial Port (MSSP) Module".



#### TABLE 14-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	<b>INTOIE</b>	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
TMR2	Timer2 Reg	gister							74
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	74
PR2	Timer2 Per	riod Register							74

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

#### 查询PIC18F86K90供应商 15.0 TIMER3/5/7 MODULES

The Timer3/5/7 timer/counter modules incorporate these features:

- Software-selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMRxH and TMRxL)
- Selectable clock source (internal or external) with device clock or SOSC oscillator internal options
- Interrupt-on-overflow
- · Module Reset on ECCP Special Event Trigger

Timer7 is unimplemented for devices with program memory of 32 Kbytes (PIC18FX5K90).

**Note:** Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the Timer3, Timer5 or Timer7 module. For example, the control register is named TxCON and refers to T3CON, T5CON and T7CON.

A simplified block diagram of the Timer3/5/7 module is shown in Figure 15-1.

The Timer3/5/7 module is controlled through the TxCON register (Register 15-1). It also selects the clock source options for the ECCP modules. (For more information, see Section 19.1.1 "ECCP Module and Timer Resources".)

The Fosc clock source should not be used with the ECCP capture/compare features. If the timer will be used with the capture or compare features, always select one of the other timer clocking options.

### 查询PIC18F86K90供应商 REGISTER 15-1: TXCON: TIMERx CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
TMRxCS1	TMRxCS0	TxCKPS1	TxCKPS0	SOSCEN	TxSYNC	RD16	TMRxON			
bit 7							bit			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown			
bit 7-6	TMRxCS<1:0	>: Timerx Cloc	k Source Sele	ct bits						
	SOSCE Externa <u>SOSCE</u> Crystal 01 = Timerx	EN = 0: al clock is from EN = 1: oscillator is on clock source is	the T1CKI pin the SOSCI/SC		dge).	on the SOSCE	N bit.			
bit 5-4	TxCKPS<1:0>: Timerx Input Clock Prescale Select bits									
	11 = 1:8 Pres 10 = 1:4 Pres 01 = 1:2 Pres 00 = 1:1 Pres	cale value cale value cale value								
bit 3	SOSCEN: SC	SC Oscillator I	Enable bit							
		enabled for Tim disabled for Tin		SOSCSEL fuse	es)					
bit 2	<b>TxSYNC:</b> Timerx External Clock Input Synchronization Control bit (Not usable if the device clock comes from Timer1/Timer3.)									
	When TMRxCS<1:0> = 10: 1 = Do not synchronize external clock input 0 = Synchronize external clock input									
	<u>When TMRxCS&lt;1:0&gt; = <math>0x</math>:</u> This bit is ignored; Timer3 uses the internal clock.									
bit 1	RD16: 16-Bit Read/Write Mode Enable bit									
				one 16-bit ope two 8-bit opera						
bit 0	TMRxON: Tin	merx On bit								
	1 = Enables T 0 = Stops Tim									

Note 1: The Fosc clock source should not be selected if the timer will be used with the ECCP capture/compare features.

#### 查询PIC18F86K90供应商

#### 15.1 Timer3/5/7 Gate Control Register

The Timer3/5/7 Gate Control register (TxGCON), provided in Register 14-2, is used to control the Timerx gate.

#### REGISTER 15-2: TxGCON: TIMERx GATE CONTROL REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-x	R/W-0	R/W-0				
TMRxGE	TxGPOL	TxGTM	TxGSPM	TxGGO/TxDONE	TxGVAL	TxGSS1	TxGSS0				
bit 7							bit 0				
Legend:			L 1			2					
R = Reada		1' = Bit is se	V = Writable bit U = Unimplemented bit, read as '0'								
-n = Value	alPOR		L	'0' = Bit is cleared		x = Bit is unkn	OWIT				
bit 7	TMRxGE: Ti	merx Gate En	able bit								
	If TMRxON =	<u>= 0:</u>									
	This bit is igr	nored.									
	If TMRxON =			<b>T</b>							
				Timerx gate function erx gate function							
bit 6		merx Gate Pol		ern gate ianetien							
			5	ounts when gate is hi	gh)						
				unts when gate is lov							
bit 5	TxGTM: Tim	GTM: Timerx Gate Toggle Mode bit									
		Gate Toggle m									
		Gate Toggle m flip-flop toggle		ed and toggle flip-flop	is cleared						
bit 4	•	merx Gate Sir	-								
DIL 4			•	abled and is controlling the Timerx gate							
		Bate Single Pu				x guie					
bit 3	TxGGO/TxD	ONE: Timerx	Gate Single F	Pulse Acquisition Stat	us bit						
		1 = Timerx gate single pulse acquisition is ready, waiting for an edge									
				has completed or ha	as not been st	arted					
<b>h</b> :1 0		•		GSPM is cleared.							
bit 2		nerx Gate Cu		acts that sould be pro	wided to TMP		offootod by the				
		Enable (TMR		gate that could be pro			anected by the				
bit 1-0		>: Timerx Gate	,	ect bits							
	11 = Compa	rator 2 output									
		rator 1 output		(2)							
	01 = IMR(x 00 = Timer1	+ 1) to match	PR(x + 1) out	put <sup>(2)</sup>							
			is turned on i	f TMRxGE = 1, regar	dless of the st	tate of TMRxON	۱.				
Note 1:	C C										
NOLE T:	lote 1: Programming the TxGCON prior to TxCON is recommended.										

- **Note 1:** Programming the TxGCON prior to TxCON is recommended.
  - **2:** Timer(x+1) will be Timer4/6/8 or Timerx Timer3/5/7, respectively.

### 查询PIC18F86K90供应商 REGISTER 15-3: OSCCON2: OSCILLATOR CONTROL REGISTER 2

U-0	R-0	U-0	U-0	R/W-0	U-0	R-x	R/W-0	
_	SOSCRUN	—	_	SOSCGO		MFIOFS	MFIOSEL	
bit 7							bit 0	
Legend:								
R = Reada	ble bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'		
-n = Value	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown	
bit 7	Unimplement	ted: Read as '	)'					
bit 6	SOSCRUN: S	SOSC Run Stat	us bit					
		lock comes fro						
	0 = System c	lock comes fro	m an oscillator	other than SO	SC			
bit 5-4	Unimplement	Unimplemented: Read as '0'						
bit 3	SOSCGO: Os	cillator Start Co	ontrol bit					
		is running, eve						
					g it (When the \$ is bit has no ef		ed to run from	
bit 2	Unimplement	Unimplemented: Read as '0'						
bit 1	MFIOFS: MF-	INTOSC Frequ	ency Stable bi	t				
	1 = MF-INTOSC is stable							
	0 = MF-INTO	SC is not stabl	e					
bit 0	MFIOSEL: MI	F-INTOSC Sele	ect bit					
	<ul> <li>1 = MF-INTOSC is used in place of HF-INTOSC frequencies of 500 kHz, 250 kHz and 31.25 kHz</li> <li>0 = MF-INTOSC is not used</li> </ul>							

The operating mode is determined by the clock select

bits, TMRxCSx (TxCON<7:6>). When the TMRxCSx bits

are cleared (= 00), Timer3/5/7 increments on every inter-

nal instruction cycle (Fosc/4). When TMRxCSx = 01, the

Timer3/5/7 clock source is the system clock (Fosc), and when it is '10', Timer3/5/7 works as a counter from the

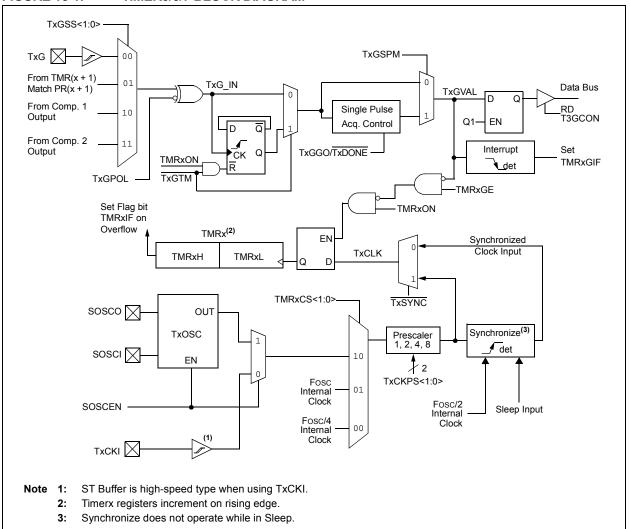
external clock from the TxCKI pin (on the rising edge after

the first falling edge) or the SOSC oscillator.

#### 查询PIC18F86K90供应商 15.2 Timer3/5/7 Operation

Timer3, Timer5 and Timer7 can operate in these modes:

- Timer
- Synchronous Counter
- Asynchronous Counter
- · Timer with Gated Control



#### FIGURE 15-1: TIMER3/5/7 BLOCK DIAGRAM

© 2010 Microchip Technology Inc.

DS39957B-page 203

#### 查询PIC18F86K90供应商

#### 15.3 Timer3/5/7 16-Bit Read/Write Mode

Timer3/5/7 can be configured for 16-bit reads and writes (see Figure 15.3). When the RD16 control bit (TxCON<1>) is set, the address for TMRxH is mapped to a buffer register for the high byte of Timer3/5/7. A read from TMRxL will load the contents of the high byte of Timer3/5/7 into the Timerx High Byte Buffer register. This provides users with the ability to accurately read all 16 bits of Timer3/5/7 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer3/5/7 must also take place through the TMRxH Buffer register. The Timer3/5/7 high byte is updated with the contents of TMRxH when a write occurs to TMRxL. This allows users to write all 16 bits to both the high and low bytes of Timer3/5/7 at once.

The high byte of Timer3/5/7 is not directly readable or writable in this mode. All reads and writes must take place through the Timerx High Byte Buffer register.

Writes to TMRxH do not clear the Timer3/5/7 prescaler. The prescaler is only cleared on writes to TMRxL.

#### 15.4 Using the SOSC Oscillator as the Timer3/5/7 Clock Source

The SOSC internal oscillator may be used as the clock source for Timer3/5/7. The SOSC oscillator is enabled by setting one of five bits: any of the four SOSCEN bits in the TxCON registers (TxCON<3>) or the SOSCGO bit in the OSCCON2 register (OSCCON2<3>). To use it as the Timer3/5/7 clock source, the TMRxCS bit must also be set. As previously noted, this also configures Timer3/5/7 to increment on every rising edge of the oscillator source.

The SOSC oscillator is described in **Section 13.0** "Timer1 Module".

#### 15.5 Timer3/5/7 Gates

Timer3/5/7 can be configured to count freely or the count can be enabled and disabled using the Timer3/5/7 gate circuitry. This is also referred to as the Timer3/5/7 gate count enable.

The Timer3/5/7 gate can also be driven by multiple selectable sources.

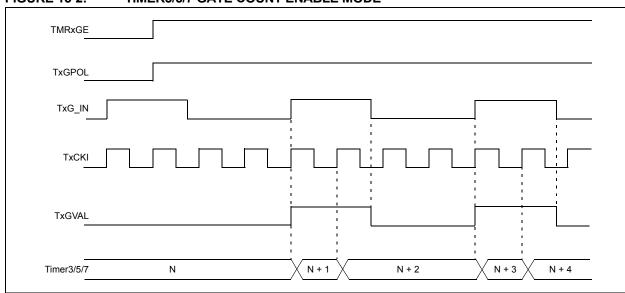
#### 15.5.1 TIMER3/5/7 GATE COUNT ENABLE

The Timerx Gate Enable mode is enabled by setting the TMRxGE bit (TxGCON<7>). The polarity of the Timerx Gate Enable mode is configured using the TxGPOL bit (TxGCON<6>).

When Timerx Gate Enable mode is enabled, Timer3/5/ 7 will increment on the rising edge of the Timer3/5/7 clock source. When Timerx Gate Enable mode is disabled, no incrementing will occur and Timer3/5/7 will hold the current count. See Figure 15-2 for timing details.

TABLE 15-1:	TIMER3/5/7 GATE ENABLE
	SELECTIONS

TxCLK <sup>(†)</sup>	TxGPOL (TxGCON<6>)	TxG Pin	Timerx Operation
$\uparrow$	0	0	Counts
$\uparrow$	0	1	Holds Count



#### FIGURE 15-2: TIMER3/5/7 GATE COUNT ENABLE MODE

#### 查询PIC18F86K90供应商 15.5.2 TIMER3/5/7 GATE SOURCE SELECTION

The Timer3/5/7 gate source can be selected from one of four different sources. Source selection is controlled by the TxGSS<1:0> bits (TxGCON<1:0>). The polarity for each available source is also selectable and is controlled by the TxGPOL bit (TxGCON <6>).

TABLE 15-2:	TIMER3/5/7 GA	TE SOURCES
IADLL IJ-2.		

TxGSS<1:0>	Timerx Gate Source
00	Timerx Gate Pin
01	TMR( $x$ + 1) to Match PR( $x$ + 1) (TMR( $x$ + 1) increments to match PR( $x$ + 1)
10	Comparator 1 Output (Comparator logic high output)
11	Comparator 2 Output (Comparator logic high output)

#### 15.5.2.1 TxG Pin Gate Operation

The TxG pin is one source for Timer3/5/7 gate control. It can be used to supply an external source to the Timerx gate circuitry.

#### 15.5.2.2 Timer4/6/8 Match Gate Operation

The Timer4/6/8 register will increment until it matches the value in the PRx register. On the very next increment cycle, TMRx will be reset to 00h. When this Reset occurs, a low-to-high pulse will automatically be generated and internally supplied to the Timerx gate circuitry. The pulse will remain high for one instruction cycle and will return back to a low state until the next match. Depending on TxGPOL, Timerx increments differently when TMR(x + 1) matches PR(x + 1). When TxGPOL = 1, Timerx increments for a single instruction cycle following a TMR(x + 1) match with PR(x + 1). When TxGPOL = 0, Timerx increments continuously except for the cycle following the match when the gate signal goes from low-to-high.

#### 15.5.2.3 Comparator 1 Output Gate Operation

The output of Comparator 1 can be internally supplied to the Timerx gate circuitry. After setting up Comparator 1 with the CM1CON register, Timerx will increment depending on the transitions of the CMP1OUT (CMSTAT<5>) bit.

#### 15.5.2.4 Comparator 2 Output Gate Operation

The output of Comparator 2 can be internally supplied to the Timerx gate circuitry. After setting up Comparator 2 with the CM2CON register, Timerx will increment depending on the transitions of the CMP2OUT (CMSTAT<6>) bit.

#### 15.5.3 TIMER3/5/7 GATE TOGGLE MODE

When Timer3/5/7 Gate Toggle mode is enabled, it is possible to measure the full cycle length of a Timer3/5/7 gate signal, as opposed to the duration of a single level pulse.

The Timerx gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. (For timing details, see Figure 15-3.)

The TxGVAL bit will indicate when the Toggled mode is active and the timer is counting.

Timer3/5/7 Gate Toggle mode is enabled by setting the TxGTM bit (TxGCON<5>). When the TxGTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

FIGURE 15-3: TIMER3/5/7 GATE TOGGLE MODE

#### 查询PIC18F86K90供应商

#### 15.5.4 TIMER3/5/7 GATE SINGLE PULSE MODE

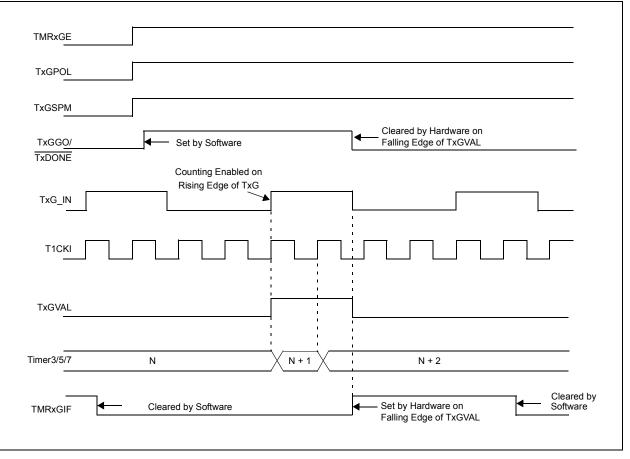
When Timer3/5/7 Gate Single Pulse mode is enabled, it is possible to capture a single pulse gate event. Timer3/5/7 Gate Single Pulse mode is first enabled by setting the TxGSPM bit (TxGCON<4>). Next, the TxGGO/TxDONE bit (TxGCON<3>) must be set.

The Timer3/5/7 will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the TxGGO/TxDONE bit will automatically be cleared. No other gate events will <u>be allowed</u> to increment Timer3/5/7 until the TxGGO/TxDONE bit is once again set in software.

Clearing the TxGSPM bit also will clear the TxGGO/ TxDONE bit. (For timing details, see Figure 15-4.)

Simultaneously enabling the Toggle mode and the Single Pulse mode will permit both sections to work together. This allows the cycle times on the Timer3/5/7 gate source to be measured. (For timing details, see Figure 15-5.)

#### FIGURE 15-4: TIMER3/5/7 GATE SINGLE PULSE MODE



#### 查询PIC18F86K90供应商 FIGURE 15-5: TIMER3/5/7 GATE SINGLE PULSE AND TOGGLE COMBINED MODE TMRxGE TxGPOL TxGSPM TxGTM Cleared by Hardware on TxGGO/ Set by Software Falling Edge of TxGVAL TxDONE Counting Enabled on Rising Edge of TxG TxG\_IN TxCKI TxGVAL Timer3/5/7 N + 1 Ν N + 2 N + 3 N + 4 Set by Hardware on Cleared by Cleared by Software Falling Edge of TxGVAL Software TMRxGIF

#### 15.5.5 TIMER3/5/7 GATE VALUE STATUS

When Timer3/5/7 gate value status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the TxGVAL bit (TxGCON<2>). The TxGVAL bit is valid even when the Timer3/5/7 gate is not enabled (TMRxGE bit is cleared).

#### 15.5.6 TIMER3/5/7 GATE EVENT INTERRUPT

When the Timer3/5/7 gate event interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of TxGVAL occurs, the TMRxGIF flag bit in the PIRx register will be set. If the TMRxGIE bit in the PIEx register is set, then an interrupt will be recognized.

The TMRxGIF flag bit operates even when the Timer3/ 5/7 gate is not enabled (TMRxGE bit is cleared).

### 查询PIC18F86K90供应商

#### 15.6 Timer3/5/7 Interrupt

The TMRx register pair (TMRxH:TMRxL) increments from 0000h to FFFFh and overflows to 0000h. The Timerx interrupt, if enabled, is generated on overflow and is latched in the interrupt flag bit, TMRxIF. Table 15-3 gives each module's flag bit.

#### TABLE 15-3: TIMER3/5/7 INTERRUPT FLAG BITS

Timer Module	Flag Bit
3	PIR2<1>
5	PIR5<1>
7	PIR5<3>

This interrupt can be enabled or disabled by setting or clearing the TMRxIE bit, respectively. Table 15-4 gives each module's enable bit.

#### TABLE 15-4: TIMER3/5/7 INTERRUPT ENABLE BITS

Timer Module	Flag Bit
3	PIE2<1>
5	PIE5<1>
7	PIE5<3>

#### 15.7 Resetting Timer3/5/7 Using the ECCP Special Event Trigger

If the ECCP modules are configured to use Timerx and to generate a Special Event Trigger in Compare mode (CCPxM<3:0> = 1011), this signal will reset Timerx. The trigger from ECCP2 will also start an A/D conversion if the A/D module is enabled (For more information, see **Section 19.3.4 "Special Event Trigger"**.)

The module must be configured as either a timer or synchronous counter to take advantage of this feature. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a Period register for Timerx.

If Timerx is running in Asynchronous Counter mode, the Reset operation may not work.

In the event that a write to Timerx coincides with a Special Event Trigger from an ECCP module, the write will take precedence.

Note:	The Special Event Triggers from the
	ECCPx module will only clear the TMR3
	register's content, but not set the TMR3IF
	interrupt flag bit (PIR1<0>).

Note: The CCP and ECCP modules use Timers, 1 through 8, for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

#### 查询PIC18F86K90供应商 TABLE 15-5: REGISTERS ASSOCIATED WITH TIMER3/5/7 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR5	TMR7GIF <sup>(1)</sup>	TMR12IF <sup>(1)</sup>	TMR10IF <sup>(1)</sup>	TMR8IF	TMR7IF <sup>(1)</sup>	TMR6IF	TMR5IF	TMR4IF	75
PIE5	TMR7GIE <sup>(1)</sup>	TMR12IE <sup>(1)</sup>	TMR10IE <sup>(1)</sup>	TMR8IE	TMR7IE <sup>(1)</sup>	TMR6IE	TMR5IE	TMR4IE	75
PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE	—	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
PIR3	TMR5GIF <sup>(1)</sup>	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE <sup>(1)</sup>	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
TMR3H	Timer3 Regi	ster High Byt	e						75
TMR3L	Timer3 Regi	ster Low Byte	Э						75
T3GCON	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/ T3DONE	T3GVAL	T3GSS1	T3GSS0	75
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	75
TMR5H	Timer5 Register High Byte					80			
TMR5L	Timer5 Regi	ster Low Byte	Э						80
T5GCON	TMR5GE	T5GPOL	T5GTM	T5GSPM	T5GGO/ T5DONE	T5GVAL	T5GSS1	T5GSS0	80
T5CON	TMR5CS1	TMR5CS0	T5CKPS1	T5CKPS0	SOSCEN	T5SYNC	RD16	TMR5ON	80
TMR7H	Timer7 Register High Byte				79				
TMR7L	Timer7 Regi	ster Low Byte	e						79
T7GCON	TMR7GE	T7GPOL	T7GTM	T7GSPM	T7GGO/ T7DONE	T7GVAL	T7GSS1	T7GSS0	79
T7CON	TMR7CS1	TMR7CS0	T7CKPS1	T7CKPS0	SOSCEN	T7SYNC	RD16	TMR7ON	79
OSCCON2	—	SOSCRUN	—	—	SOSCGO	—	MFIOFS	MFIOSEL	77
CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	79
CCPTMRS1	C7TSEL1	C7TSEL0	—	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS1	—	—	—	C10TSEL0	—	C9TSEL0	C8TSEL1	C8TSEL0	79

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by the Timer3/5/7 module.

**Note 1:** Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商 16.0 TIMER4/6/8/10/12 MODULES

The Timer4/6/8/10/12 timer modules have the following features:

- 8-Bit Timer register (TMRx)
- 8-Bit Period register (PRx)
- Readable and writable (all registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on TMRx match of PRx

Timer10 and Timer12 are unimplemented for devices with program memory of 32 Kbytes (PIC18FX5K90).

Note:	Throughout this section, generic references are used for register and bit names that are the
	same, except for an 'x' variable that indicates
	the item's association with the Timer4, Timer6,
	Timer8, Timer10 or Timer12 module. For
	example, the control register is named TxCON
	and refers to T4CON, T6CON, T8CON,
	T10CON and T12CON.

The Timer4/6/8/10/12 modules have a control register shown in Register 16-1. Timer4/6/8/10/12 can be shut off by clearing control bit, TMRxON (TxCON<2>), to minimize power consumption. The prescaler and post-scaler selection of Timer4/6/8/10/12 also are controlled by this register. Figure 16-1 is a simplified block diagram of the Timer4/6/8/10/12 modules.

#### 16.1 Timer4/6/8/10/12 Operation

Timer4/6/8/10/12 can be used as the PWM time base for the PWM mode of the ECCP modules. The TMRx registers are readable and writable, and are cleared on any device Reset. The input clock (Fosc/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits, TxCKPS<1:0> (TxCON<1:0>). The match output of TMRx goes through a 4-bit postscaler (that gives a 1:1 to 1:16 inclusive scaling) to generate a TMRx interrupt, latched in the flag bit, TMRxIF. Table 16-1 gives each module's flag bit.

Timer Module	Flag Bit PIR5 <x></x>	Timer Module	Flag Bit PIR5 <x></x>		
4	0	10	5		
6	2	12	6		
8	4				

TABLE 16-1: TIMER4/6/8/10/12 FLAG BITS

The interrupt can be enabled or disabled by setting or clearing the Timerx Interrupt Enable bit (TMRxIE), shown in Table 16-2.

TABLE 16-2:	TIMER4/6/8/10/12 INTERRUPT
	ENABLE BITS

Timer Module	Flag Bit PIE5 <x></x>		
4	0	10	5
6	2	12	6
8	4		

The prescaler and postscaler counters are cleared when any of the following occurs:

- A write to the TMRx register
- A write to the TxCON register
- Any device Reset (Power-on Reset (POR), MCLR Reset, Watchdog Timer Reset (WDTR) or Brown-out Reset (BOR))

A TMRx is not cleared when a TxCON is written.

Note: The CCP and ECCP modules use Timers, 1 through 8, for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

#### 查询PIC18F86K90供应商

#### REGISTER 16-1: TXCON: TIMER4/6/8/10/12 CONTROL REGISTER

U-0	R/W-0 R/W-0		R/W-0	-0 R/W-0 R/W-0		R/W-0	R/W-0	
—	TxOUTPS3	TxOUTPS2	TxOUTPS1	TxOUTPS0	TMRxON	TxCKPS1	TxCKPS0	
bit 7							bit 0	

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

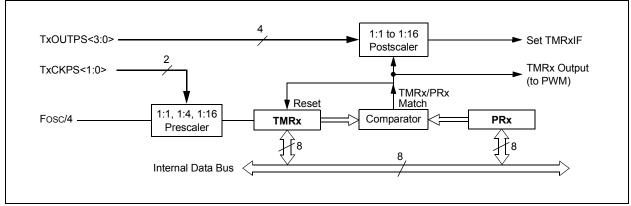
bit 7	Unimplemented: Read as '0'				
bit 6-3	TxOUTPS<3:0>: Timerx Output Postscale Select bits				
	0000 = 1:1 Postscale				
	0001 = 1:2 Postscale				
	•				
	•				
	•				
	1111 = 1:16 Postscale				
bit 2	TMRxON: Timerx On bit				
	1 = Timerx is on				
	0 = Timerx is off				
bit 1-0	TxCKPS<1:0>: Timerx Clock Prescale Select bits				
	00 = Prescaler is 1				
	01 = Prescaler is 4				
	1x = Prescaler is 16				

#### 16.2 Timer4/6/8/10/12 Interrupt

The Timer4/6/8/10/12 modules have 8-bit period registers, PRx, that are both readable and writable. Timer4/6/8/10/12 increment from 00h until they match PR4/6/8/10/12 and then reset to 00h on the next increment cycle. The PRx registers are initialized to FFh upon Reset.

#### 16.3 Output of TMRx

The outputs of TMRx (before the postscaler) are used only as a PWM time base for the ECCP modules. They are not used as baud rate clocks for the MSSP modules as is the Timer2 output.



#### FIGURE 16-1: TIMER4/6/8/10/12 BLOCK DIAGRAM

#### 查询PIC18F86K90供应商 TABLE 16-3: REGISTERS ASSOCIATED WITH TIMER4/6/8/10/12 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
IPR5	TMR7GIP <sup>(1)</sup>	TMR12IP <sup>(1)</sup>	TMR10IP <sup>(1)</sup>	TMR8IP	TMR7IP <sup>(1)</sup>	TMR6IP	TMR5IP	TMR4IP	74
PIR5	TMR7GIF <sup>(1)</sup>	TMR12IF <sup>(1)</sup>	TMR10IF <sup>(1)</sup>	TMR8IF	TMR7IF <sup>(1)</sup>	TMR6IF	TMR5IF	TMR4IF	75
PIE5	TMR7GIE <sup>(1)</sup>	TMR12IE <sup>(1)</sup>	TMR10IE <sup>(1)</sup>	TMR8IE	TMR7IE <sup>(1)</sup>	TMR6IE	TMR5IE	TMR4IE	75
TMR4	Timer4 Regis	ter							80
T4CON	_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	80
PR4	Timer4 Period Register							80	
TMR6	Timer6 Register							79	
T6CON	_	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	79
PR6	Timer6 Period Register							79	
TMR8	Timer8 Register							79	
T8CON	_	T8OUTPS3	T8OUTPS2	T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	79
PR8	Timer8 Period Register							79	
TMR10	Timer10 Register							79	
T10CON	_	T10OUTPS3	T10OUTPS2	T10OUTPS1	T10OUTPS0	TMR100N	T10CKPS1	T10CKPS0	79
PR10	Timer10 Period Register							79	
TMR12	Timer12 Register							79	
T12CON	_	T12OUTPS3	T12OUTPS2	T12OUTPS1	T12OUTPS0	TMR12ON	T12CKPS1	T12CKPS0	79
PR12	Timer12 Period Register							79	
CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	79
CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2	_	_	_	C10TSEL0 <sup>(1)</sup>	_	C9TSEL0 <sup>(1)</sup>	C8TSEL1	C8TSEL0	79

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer4/6/8/10/12 module.

Note 1: Unimplemented on devices with a program memory of 32k bytes (PIC18FX5K22).

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商

#### 17.0 REAL-TIME CLOCK AND CALENDAR (RTCC)

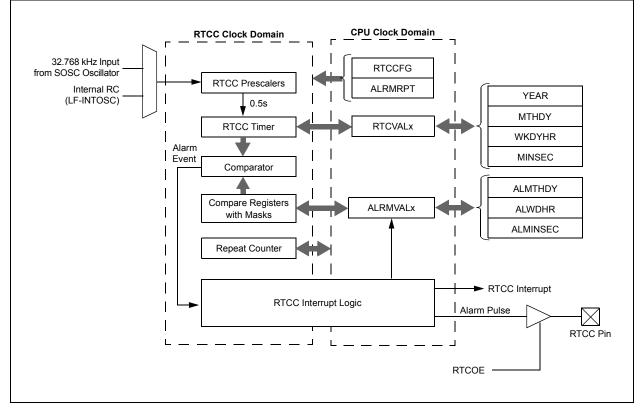
The key features of the Real-Time Clock and Calendar (RTCC) module are:

- Time: hours, minutes and seconds
- Twenty-four hour format (military time)
- Calendar: weekday, date, month and year
- Alarm configurable
- Year range: 2000 to 2099
- Leap year correction
- BCD format for compact firmware
- Optimized for low-power operation
- User calibration with auto-adjust
- Calibration range: ±2.64 seconds error per month
- Requirements: external 32.768 kHz clock crystal
- Alarm pulse or seconds clock output on RTCC pin

The RTCC module is intended for applications where accurate time must be maintained for an extended period with minimum to no intervention from the CPU. The module is optimized for low-power usage in order to provide extended battery life while keeping track of time.

The module is a 100-year clock and calendar with automatic leap year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099.

Hours are measured in 24-hour (military time) format. The clock provides a granularity of one second with half-second visibility to the user.



#### FIGURE 17-1: RTCC BLOCK DIAGRAM

 $\ensuremath{\textcircled{}^{\odot}}$  2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商 17.1 RTCC MODULE REGISTERS

The RTCC module registers are divided into the following categories:

#### **RTCC Control Registers**

- RTCCFG
- RTCCAL
- PADCFG1
- ALRMCFG
- ALRMRPT

#### **RTCC Value Registers**

- RTCVALH
- RTCVALL

Both registers access the following registers:

- YEAR
- MONTH
- DAY
- WEEKDAY
- HOUR
- MINUTE
- SECOND

#### **Alarm Value Registers**

- ALRMVALH
- ALRMVALL
   Both registers access the following registers:
  - ALRMMNTH
  - ALRMDAY
  - ALRMWD
  - ALRMHR
  - ALRMMIN
  - ALRMSEC
- Note: The RTCVALH and RTCVALL registers can be accessed through RTCRPT<1:0> (RTCCFG<1:0>). ALRMVALH and ALRMVALL can be accessed through ALRMPTR<1:0> (ALRMCFG<1:0>).

#### 查询PIC18F86K90供应商 17.1.1 RICC CONTROL R

17.1.1 RICC CONTROL REGISTERS

## **REGISTER 17-1:** RTCCFG: RTCC CONFIGURATION REGISTER<sup>(1)</sup>

R/W-0	U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	
RTCEN <sup>(2)</sup>	_	RTCWREN <sup>(4)</sup>	RTCSYNC	HALFSEC <sup>(3)</sup>	RTCOE	RTCPTR1	RTCPTR0	
bit 7						-	bit (	
Legend:								
R = Readable	bit	W = Writable b	it	U = Unimplen	nented bit, rea	d as '0'		
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown	
		(2)						
bit 7		CC Enable bit <sup>(2)</sup>						
		module is enableo module is disableo						
bit 6		ented: Read as '0						
bit 5	-	: RTCC Value Reg		Enable bit(4)				
bit 5		LH and RTCVALL			by the user			
		LH and RTCVALL				n to by the user		
bit 4		RTCC Value Reg	-		-			
	1 = RTCVA	LH, RTCVALL and	d ALRMRPT I	registers can ch	ange while rea	ading if a rollove	r ripple result	
		valid data read. If	the register i	s read twice ar	nd results in th	e same data, th	ie data can be	
		ed to be valid.		ragiatora aon k	o rood with out	t aan aarn avar a	rollovor ripple	
L:1 0		LH, RTCVALL and		registers can t	be read without	concern over a		
bit 3	HALFSEC: Half-Second Status bit <sup>(3)</sup> 1 = Second half period of a second							
		If period of a seco						
bit 2		CC Output Enabl						
		clock output is ena						
		clock output is dis						
bit 1-0	RTCPTR<1	:0>: RTCC Value	Register Win	dow Pointer bit	S			
		corresponding R						
		R<1:0> value dec	rements on ev	very read or wri	te of RTCVALF	1<15:8> until it r	eaches '00'.	
	RTCVALH: 00 = Minute							
	00 = Windle	-						
	10 = Month	•						
	11 = Reserv	ved						
	RTCVALL:							
	00 = Secon	ds						
	01 = Hours							
	10 <b>= Day</b>							
	11 <b>= Year</b>							
Note 1: The	e RTCCFG re	egister is only affe	cted by a PO	R.				
		CEN bit is only a	-					

- **2:** A write to the RTCEN bit is only allowed when RTCWREN = 1.
- **3:** This bit is read-only; it is cleared to '0' on a write to the lower half of the MINSEC register.
- 4: The RTCWREN bit can only be written with the unlock sequence (see **Example 17-1**).

## 查询PIC18F86K90供应商

.

### REGISTER 17-2: RTCCAL: RTCC CALIBRATION REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CAL7  | CAL6  | CAL5  | CAL4  | CAL3  | CAL2  | CAL1  | CAL0  |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

### bit 7-0 CAL<7:0>: RTC Drift Calibration bits

01111111 = Maximum positive adjustment. Adds 508 RTC clock pulses every minute.

00000001 = Minimum positive adjustment. Adds four RTC clock pulses every minute. 00000000 = No adjustment 11111111 = Minimum negative adjustment. Subtracts four RTC clock pulses every minute.
•

10000000 = Maximum negative adjustment. Subtracts 512 RTC clock pulses every minute.

### REGISTER 17-3: PADCFG1: PAD CONFIGURATION REGISTER

R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0
RDPU	REPU	RJPU <sup>(2)</sup>	_	_	RTSECSEL1 <sup>(1)</sup>	RTSECSEL0 <sup>(1)</sup>	—
bit 7							bit 0

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	RDPU: PORTD Pull-up Enable bit
	<ul> <li>1 = PORTD pull-up resistors are enabled by individual port latch values</li> <li>0 = All PORTD pull-up resistors are disabled</li> </ul>
bit 6	REPU: PORTE Pull-up Enable bit
	<ul> <li>1 = PORTE pull-up resistors are enabled by individual port latch values</li> <li>0 = All PORTE pull-up resistors are disabled</li> </ul>
bit 5	RJPU: PORTJ Pull-up Enable bit <sup>(2)</sup>
	<ul> <li>1 = PORTJ pull-up resistors are enabled by individual port latch values</li> <li>0 = All PORTJ pull-up resistors are disabled</li> </ul>
bit 4-3	Unimplemented: Read as '0'
bit 2-1	RTSECSEL<1:0>: RTCC Seconds Clock Output Select bit <sup>(1)</sup>
	<ul> <li>11 = Reserved; do not use</li> <li>10 = RTCC source clock is selected for the RTCC pin (pin can be LF-INTOSC or SOSC, depending on the RTCOSC (CONFIG3L&lt;1&gt;) bit setting)</li> <li>01 = RTCC seconds clock is selected for the RTCC pin</li> <li>00 = RTCC alarm pulse is selected for the RTCC pin</li> </ul>
bit 0	Unimplemented: Read as '0'

#### **Note 1:** To enable the actual RTCC output, the RTCOE (RTCCFG<2>) bit must be set.

**2:** Available only in 80-pin parts.

Γ.

#### 查询PIC18F86K90供应商 REGISTER 17-4: **ALRMCFG: ALARM CONFIGURATION REGISTER** R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 ALRMEN CHIME AMASK3 AMASK2 AMASK1 AMASK0 ALRMPTR1 ALRMPTR0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 ALRMEN: Alarm Enable bit 1 = Alarm is enabled (cleared automatically after an alarm event whenever ALRMPTR<1:0> = 00 and CHIME = 0) 0 = Alarm is disabled bit 6 CHIME: Chime Enable bit 1 = Chime is enabled; ALRMPTR<1:0> bits are allowed to roll over from 00h to FFh 0 = Chime is disabled; ALRMPTR<1:0> bits stop once they reach 00h bit 5-2 AMASK<3:0>: Alarm Mask Configuration bits 0000 = Every half second 0001 = Every second 0010 = Every 10 seconds 0011 = Every minute 0100 = Every 10 minutes 0101 = Every hour 0110 = Once a day 0111 = Once a week 1000 = Once a month 1001 = Once a year (except when configured for February 29<sup>th</sup>, once every four years) 101x = Reserved – Do not use 11xx = Reserved – Do not use bit 1-0 ALRMPTR<1:0>: Alarm Value Register Window Pointer bits Points to the corresponding Alarm Value registers when reading the ALRMVALH and ALRMVALL registers. The ALRMPTR<1:0> value decrements on every read or write of ALRMVALH until it reaches '00'. ALRMVALH: 00 = ALRMMIN 01 = ALRMWD 10 = ALRMMNTH 11 = Unimplemented ALRMVALL: 00 = ALRMSEC 01 = ALRMHR 10 = ALRMDAY 11 = Unimplemented

## 查询PIC18F86K90供应商

## REGISTER 17-5: ALRMRPT: ALARM REPEAT REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| ARPT7 | ARPT6 | ARPT5 | ARPT4 | ARPT3 | ARPT2 | ARPT1 | ARPT0 |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit W = Writable bit		U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ARPT<7:0>: Alarm Repeat Counter Value bits 1111111 = Alarm will repeat 255 more times .

> . 00000000 = Alarm will not repeat The counter decrements on any alarm event. The counter is prevented from rolling over from 00h to FFh unless CHIME = 1.

### 17.1.2 RTCVALH AND RTCVALL REGISTER MAPPINGS

## REGISTER 17-6: RESERVED REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 Unimplemented: Read as '0'

## 查询PIC18F86K90供应商

## REGISTER 17-7: YEAR: YEAR VALUE REGISTER<sup>(1)</sup>

| R/W-x  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 7  |        |        |        |        |        |        | bit 0  |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4	YRTEN<3:0>: Binary Coded Decimal Value of Year's Tens Digit bits
	Contains a value from 0 to 9.

bit 3-0 **YRONE<3:0>:** Binary Coded Decimal Value of Year's Ones Digit bits Contains a value from 0 to 9.

**Note 1:** A write to the YEAR register is only allowed when RTCWREN = 1.

## **REGISTER 17-8:** MONTH: MONTH VALUE REGISTER<sup>(1)</sup>

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-5	Unimplemented: Read as '0'

bit 4 **MTHTEN0:** Binary Coded Decimal Value of Month's Tens Digit bits Contains a value of '0' or '1'.

bit 3-0 **MTHONE<3:0>:** Binary Coded Decimal Value of Month's Ones Digit bits Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

© 2010 Microchip Technology Inc.

## 查询PIC18F86K90供应商

Γ.

## REGISTER 17-9: DAY: DAY VALUE REGISTER<sup>(1)</sup>

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	<b>DAYTEN&lt;1:0&gt;:</b> Binary Coded Decimal value of Day's Tens Digit bits Contains a value from 0 to 3.
bit 3-0	<b>DAYONE&lt;3:0&gt;:</b> Binary Coded Decimal Value of Day's Ones Digit bits Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

## REGISTER 17-10: WEEKDAY: WEEKDAY VALUE REGISTER<sup>(1)</sup>

U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
—	—	—	—	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

### bit 7-3 Unimplemented: Read as '0'

bit 2-0 **WDAY<2:0>:** Binary Coded Decimal Value of Weekday Digit bits Contains a value from 0 to 6.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

#### 查询PIC18F86K90供应商 REGISTER 17-11: HOUR: HOUR VALUE REGISTER<sup>(1)</sup>

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	<b>HRTEN&lt;1:0&gt;:</b> Binary Coded Decimal Value of Hour's Tens Digit bits Contains a value from 0 to 2.
bit 3-0	<b>HRONE&lt;3:0&gt;:</b> Binary Coded Decimal Value of Hour's Ones Digit bits Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

### REGISTER 17-12: MINUTE: MINUTE VALUE REGISTER

U-0	R/W-x						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN<2:0>: Binary Coded Decimal Value of Minute's Tens Digit bits Contains a value from 0 to 5.
bit 3-0	<b>MINONE&lt;3:0&gt;:</b> Binary Coded Decimal Value of Minute's Ones Digit bits Contains a value from 0 to 9.

## REGISTER 17-13: SECOND: SECOND VALUE REGISTER

U-0	R/W-x						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	<b>SECTEN&lt;2:0&gt;:</b> Binary Coded Decimal Value of Second's Tens Digit bits Contains a value from 0 to 5.
bit 3-0	<b>SECONE&lt;3:0&gt;:</b> Binary Coded Decimal Value of Second's Ones Digit bits Contains a value from 0 to 9.

© 2010 Microchip Technology Inc.

## 查询PIC18F86K90供应商

17.1.3 ALRMVALH AND ALRMVALL

REGISTER MAPPINGS

## **REGISTER 17-14:** ALRMMNTH: ALARM MONTH VALUE REGISTER<sup>(1)</sup>

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	Unimplemented: Read as '0'
bit 4	<b>MTHTEN0:</b> Binary Coded Decimal Value of Month's Tens Digit bits Contains a value of '0' or '1'.
bit 3-0	<b>MTHONE&lt;3:0&gt;:</b> Binary Coded Decimal Value of Month's Ones Digit bits Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

## REGISTER 17-15: ALRMDAY: ALARM DAY VALUE REGISTER<sup>(1)</sup>

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	DAYTEN<1:0>: Binary Coded Decimal Value of Day's Tens Digit bits
	Contains a value from 0 to 3.
bit 3-0	DAYONE<3:0>: Binary Coded Decimal Value of Day's Ones Digit bits
	Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

## 查询PIC18F86K90供应商

REGISTER 17-16: ALRMWD: ALARM WEEKDAY VALUE REGISTER<sup>(1)</sup>

U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
—	_	—	_	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 2-0 **WDAY<2:0>:** Binary Coded Decimal Value of Weekday Digit bits Contains a value from 0 to 6.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

## REGISTER 17-17: ALRMHR: ALARM HOURS VALUE REGISTER<sup>(1)</sup>

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	HRTEN<1:0>: Binary Coded Decimal Value of Hour's Tens Digit bits
	Contains a value from 0 to 2.
bit 3-0	HRONE<3:0>: Binary Coded Decimal Value of Hour's Ones Digit bits
	Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

© 2010 Microchip Technology Inc.

## 查询PIC18F86K90供应商

## REGISTER 17-18: ALRMMIN: ALARM MINUTES VALUE REGISTER

U-0	R/W-x						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN<2:0>: Binary Coded Decimal Value of Minute's Tens Digit bits
	Contains a value from 0 to 5.
bit 3-0	<b>MINONE&lt;3:0&gt;:</b> Binary Coded Decimal Value of Minute's Ones Digit bits Contains a value from 0 to 9.

### REGISTER 17-19: ALRMSEC: ALARM SECONDS VALUE REGISTER

U-0	R/W-x						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6-4 SECTEN<2:0>: Binary Coded Decimal Value of Second's Tens Digit bits Contains a value from 0 to 5.

bit 3-0 SECONE<3:0>: Binary Coded Decimal Value of Second's Ones Digit bits Contains a value from 0 to 9.

#### 查询PIC18F86K90供应商 17.1.4 RICEN BIT WRITE

RTCWREN (RTCCFG<5>) must be set before a write to RTCEN can take place. Any write to the RTCEN bit, while RTCWREN = 0, will be ignored.

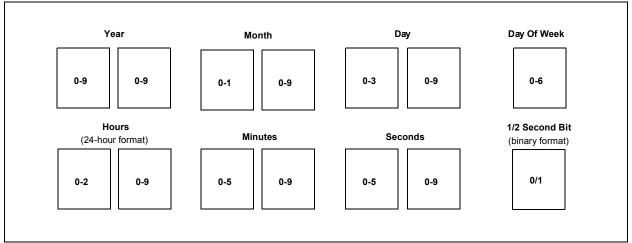
Like the RTCEN bit, the RTCVALH and RTCVALL registers can only be written to when RTCWREN = 1. A write to these registers, while RTCWREN = 0, will be ignored.

FIGURE 17-2: TIMER DIGIT FORMAT

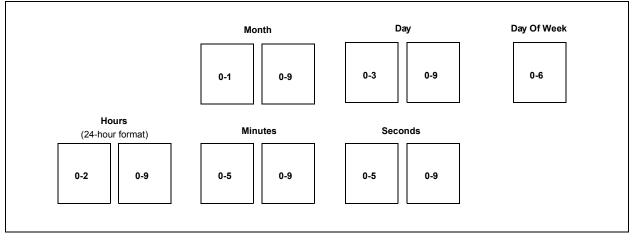
## 17.2 Operation

## 17.2.1 REGISTER INTERFACE

The register interface for the RTCC and alarm values is implemented using the Binary Coded Decimal (BCD) format. This simplifies the firmware when using the module as each of the digits is contained within its own 4-bit value (see Figure 17-2 and Figure 17-3).



## FIGURE 17-3: ALARM DIGIT FORMAT

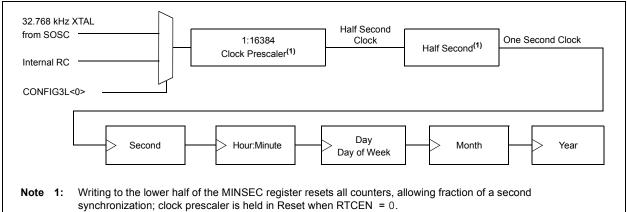


© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商 17.2.2 CLOCK SOURCE

As mentioned earlier, the RTCC module is intended to be clocked by an external Real-Time Clock (RTCC) crystal oscillating at 32.768 kHz, but an internal oscillator can be used. The RTCC clock selection is decided by the RTCOSC bit (CONFIG3L<0>). Calibration of the crystal can be done through this module to yield an error of 3 seconds or less per month. (For further details, see **Section 17.2.9 "Calibration"**.)

## FIGURE 17-4: CLOCK SOURCE MULTIPLEXING



### 17.2.2.1 Real-Time Clock Enable

The RTCC module can be clocked by an external 32.768 kHz crystal (SOSC oscillator), or the LF-INTOSC oscillator, which can be selected in CONFIG3L<0>.

If the external clock is used, the SOSC oscillator should be enabled. If LF-INTOSC is providing the clock, the INTOSC clock can be brought out to the RTCC pin by the RTSECSEL<1:0> bits (PADCFG<2:1>).

## 17.2.3 DIGIT CARRY RULES

This section explains which timer values are affected when there is a rollover:

- Time of Day: From 23:59:59 to 00:00:00 with a carry to the Day field
- Month: From 12/31 to 01/01 with a carry to the Year field
- Day of Week: From 6 to 0 with no carry (see Table 17-1)
- Year Carry: From 99 to 00; this also surpasses the use of the RTCC

For the day-to-month rollover schedule, see Table 17-2.

Because the following values are in BCD format, the carry to the upper BCD digit occurs at the count of 10, not 16 (SECONDS, MINUTES, HOURS, WEEKDAY, DAYS and MONTHS).

## TABLE 17-1: DAY OF WEEK SCHEDULE

Day of Week						
Sunday	0					
Monday	1					
Tuesday	2					
Wednesday	3					
Thursday	4					
Friday	5					
Saturday	6					

## TABLE 17-2:DAY-TO-MONTH ROLLOVER<br/>SCHEDULE

Month	Maximum Day Field
01 (January)	31
02 (February)	28 or 29 <sup>(1)</sup>
03 (March)	31
04 (April)	30
05 (May)	31
06 (June)	30
07 (July)	31
08 (August)	31
09 (September)	30
10 (October)	31
11 (November)	30
12 (December)	31

Note 1: See Section 17.2.4 "Leap Year".

#### 查询PIC18F86K90供应商 17.2.4 LEAP YEAR

Since the year range on the RTCC module is 2000 to 2099, the leap year calculation is determined by any year divisible by four in the above range. Only February is affected in a leap year.

February will have 29 days in a leap year and 28 days in any other year.

## 17.2.5 GENERAL FUNCTIONALITY

All Timer registers containing a time value of seconds or greater are writable. The user configures the time by writing the required year, month, day, hour, minutes and seconds to the Timer registers, via Register Pointers. (See Section 17.2.8 "Register Mapping".)

The timer uses the newly written values and proceeds with the count from the required starting point.

The RTCC is enabled by setting the RTCEN bit (RTCCFG<7>). If enabled while adjusting these registers, the timer still continues to increment. However, any time the MINSEC register is written to, both of the timer prescalers are reset to '0'. This allows fraction of a second synchronization.

The Timer registers are updated in the same cycle as the write instruction's execution by the CPU. The user must ensure that when RTCEN = 1, the updated registers will not be incremented at the same time. This can be accomplished in several ways:

- By checking the RTCSYNC bit (RTCCFG<4>)
- By checking the preceding digits from which a carry can occur
- By updating the registers immediately following the seconds pulse (or an alarm interrupt)

The user has visibility to the half-second field of the counter. This value is read-only and can be reset only by writing to the lower half of the SECONDS register.

### 17.2.6 SAFETY WINDOW FOR REGISTER READS AND WRITES

The RTCSYNC bit indicates a time window during which the RTCC clock domain registers can be safely read and written without concern about a rollover. When RTCSYNC = 0, the registers can be safely accessed by the CPU.

Whether RTCSYNC = 1 or 0, the user should employ a firmware solution to ensure that the data read did not fall on a rollover boundary, resulting in an invalid or partial read. This firmware solution would consist of reading each register twice and then comparing the two values. If the two values matched, then a rollover did not occur.

## 17.2.7 WRITE LOCK

In order to perform a write to any of the RTCC Timer registers, the RTCWREN bit (RTCCFG<5>) must be set.

To avoid accidental writes to the RTCC Timer register, it is recommended that the RTCWREN bit (RTCCFG<5>) be kept clear when not writing to the register. For the RTCWREN bit to be set, there is only one instruction cycle time window allowed between the 55h/AA sequence and the setting of RTCWREN. For that reason, it is recommended that users follow the code example in Example 17-1.

## EXAMPLE 17-1: SETTING THE RTCWREN BIT

movlw	0x55
movwf	EECON2
movlw	AAx0
movwf	EECON2
bsf	RTCCFG, RTCWREN

## 17.2.8 REGISTER MAPPING

To limit the register interface, the RTCC Timer and Alarm Timer registers are accessed through corresponding Register Pointers. The RTCC Value register window (RTCVALH and RTCVALL) uses the RTCPTRx bits (RTCCFG<1:0>) to select the required Timer register pair.

By reading or writing to the RTCVALH register, the RTCC Pointer value (RTCPTR<1:0>) decrements by '1' until it reaches '00'. When '00' is reached, the MINUTES and SECONDS value is accessible through RTCVALH and RTCVALL until the pointer value is manually changed.

TABLE 17-3:	<b>RTCVALH AND RTCVALL</b>
	REGISTER MAPPING

RTCPTR<1:0>	RTCC Value Register Window				
	RTCVALH	RTCVALL			
00	MINUTES	SECONDS			
01	WEEKDAY	HOURS			
10	MONTH	DAY			
11	—	YEAR			

The Alarm Value register windows (ALRMVALH and ALRMVALL) use the ALRMPTR bits (ALRMCFG<1:0>) to select the desired alarm register pair.

By reading or writing to the ALRMVALH register, the Alarm Pointer value, ALRMPTR<1:0>, decrements by '1' until it reaches '00'. When it reaches '00', the ALRMMIN and ALRMSEC value is accessible through ALRMVALH and ALRMVALL until the pointer value is manually changed.

## 查询PIC18F86K90供应商 TABLE 17-4: ALRMVAL REGISTER

MAFFING							
ALRMPTR<1:0>	Alarm Value Register Window						
ALRIVIPTR 1.02	ALRMVALH	ALRMVALL					
00	ALRMMIN	ALRMSEC					
01	ALRMWD	ALRMHR					
10	ALRMMNTH	ALRMDAY					
11	_	_					

## 17.2.9 CALIBRATION

The real-time crystal input can be calibrated using the periodic auto-adjust feature. When properly calibrated, the RTCC can provide an error of less than three seconds per month.

To perform this calibration, find the number of error clock pulses and store the value into the lower half of the RTCCAL register. The 8-bit, signed value, loaded into RTCCAL, is multiplied by four and will be either added or subtracted from the RTCC timer, once every minute.

To calibrate the RTCC module:

- 1. Use another timer resource on the device to find the error of the 32.768 kHz crystal.
- 2. Convert the number of error clock pulses per minute (see Equation 17-1).

## EQUATION 17-1: CONVERTING ERROR CLOCK PULSES

(Ideal Frequency (32,758) – Measured Frequency) \* 60 = Error Clocks per Minute

- If the oscillator is *faster* than ideal (negative result from step 2), the RCFGCALL register value needs to be negative. This causes the specified number of clock pulses to be subtracted from the timer counter once every minute.
- If the oscillator is *slower* than ideal (positive result from step 2), the RCFGCALL register value needs to be positive. This causes the specified number of clock pulses to be added to the timer counter once every minute.
- 3. Load the RTCCAL register with the correct value.

Writes to the RTCCAL register should occur only when the timer is turned off or immediately after the rising edge of the seconds pulse.

Note:	In determining the crystal's error value, it is the user's responsibility to include the
	crystal's initial error from drift due to temperature or crystal aging.

## 17.3 Alarm

The Alarm features and characteristics are:

- · Configurable from half a second to one year
- Enabled using the ALRMEN bit (ALRMCFG<7>, Register 17-4)
- Offers one-time and repeat alarm options

### 17.3.1 CONFIGURING THE ALARM

The alarm feature is enabled using the ALRMEN bit.

This bit is cleared when an alarm is issued. The bit will not be cleared if the CHIME bit =  $1 \text{ or if } ALRMRPT \neq 0$ .

The interval selection of the alarm is configured through the ALRMCFG bits (AMASK<3:0>) (see Figure 17-5). These bits determine which and how many digits of the alarm must match the clock value for the alarm to occur.

The alarm can also be configured to repeat based on a preconfigured interval. The number of times this occurs, after the alarm is enabled, is stored in the ALRMRPT register.

Note:	While the alarm is enabled (ALRMEN = 1), changing any of the registers, other than the RTCCAL, ALRMCFG and ALRMRPT registers and the CHIME bit, can result in a false alarm event leading to a false alarm interrupt. To avoid this, only change the timer and alarm values while the alarm is disabled (ALRMEN = 0). It is recommended that the ALRMCFG and ALRMRPT registers and CHIME bit be
	changed when RTCSYNC = 0.

## 查询PIC18F86K90供应商

Alarm Mask Setting AMASK<3:0>	Day of the Week	e Month Day	Hours	Minutes Seconds
0000 – Every half second 0001 – Every second				:
0010 – Every 10 seconds				: S
0011 – Every minute				s s s
0100 – Every 10 minutes				m s s
0101 – Every hour				mm;ss
0110 – Every day			h h	mm:ss
0111 – Every week	d		h h	mm:ss
1000 – Every month			h h	m m : s s
1001 – Every year <sup>(1)</sup>		m m / d d	h h	; m m ; s s
Note 1: Annually, except when co	onfigured for	February 29.		

When ALRMCFG = 00 and the CHIME bit = 0 (ALRMCFG<6>), the repeat function is disabled and only a single alarm will occur. The alarm can be repeated up to 255 times by loading the ALRMRPT register with FFh.

After each alarm is issued, the ALRMRPT register is decremented by one. Once the register has reached '00', the alarm will be issued one last time.

After the alarm is issued a last time, the ALRMEN bit is cleared automatically and the alarm turned off. Indefinite repetition of the alarm can occur if the CHIME bit = 1.

When CHIME = 1, the alarm is not disabled when the ALRMRPT register reaches '00', but it rolls over to FF and continues counting indefinitely.

## 17.3.2 ALARM INTERRUPT

At every alarm event, an interrupt is generated. Additionally, an alarm pulse output is provided that operates at half the frequency of the alarm.

The alarm pulse output is completely synchronous with the RTCC clock and can be used as a trigger clock to other peripherals. This output is available on the RTCC pin. The output pulse is a clock with a 50% duty cycle and a frequency half that of the alarm event (see Figure 17-6).

The RTCC pin also can output the seconds clock. The user can select between the alarm pulse, generated by the RTCC module, or the seconds clock output.

The RTSECSEL<1:0> bits (PADCFG1<2:1>) select between these two outputs:

- Alarm pulse RTSECSEL<1:0> = 00
- Seconds clock RTSECSEL<1:0> = 01

1	查询PIC18F86K90	共应商
	FIGURE 17-6:	TIMER PULSE GENERATION
	RTCEN bit	
	ALRMEN bit	
	RTCC Alarm Event	
	RTCC Pin	

## 17.4 Sleep Mode

The timer and alarm continue to operate while in Sleep mode. The operation of the alarm is not affected by Sleep, as an alarm event can always wake up the CPU.

The Idle mode does not affect the operation of the timer or alarm.

## 17.5 Reset

### 17.5.1 DEVICE RESET

When a device Reset occurs, the ALRMRPT register is forced to its Reset state causing the alarm to be disabled (if enabled prior to the Reset). If the RTCC was enabled, it will continue to operate when a basic device Reset occurs.

#### 17.5.2 POWER-ON RESET (POR)

The RTCCFG and ALRMRPT registers are reset only on a POR. Once the device exits the POR state, the clock registers should be reloaded with the desired values.

The timer prescaler values can be reset only by writing to the SECONDS register. No device Reset can affect the prescalers.

## 查询PIC18F86K90供应商

17.6 Register Maps

Table 17-5, Table 17-6 and Table 17-7 summarize the registers associated with the RTCC module.

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page:
RTCCFG	RTCEN	_	RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	78
RTCCAL	CAL7	CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	78
PADCFG1	RDPU	REPU	RJPU <sup>(1)</sup>	_	_	RTSECSEL1	RTSECSEL0	—	78
ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	78
ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	78

### TABLE 17-5: RTCC CONTROL REGISTERS

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

**Note 1:** Not available on 64-pin devices.

### TABLE 17-6: RTCC VALUE REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page:
RTCVALH	RTCC Value High Register Window Based on RTCPTR<1:0>								78
RTCVALL	RTCC Value Low Register Window Based on RTCPTR<1:0>								

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

## TABLE 17-7: ALARM VALUE REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page:
ALRMVALH	LH Alarm Value High Register Window Based on ALRMPTR<1:0>								78
ALRMVALL	ALL Alarm Value Low Register Window Based on ALRMPTR<1:0>								78

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

查询PIC18F86K90供应商 NOTES:

## 查询PIC18F86K90供应商

## 18.0 CAPTURE/COMPARE/PWM (CCP) MODULES

PIC18F87K90 family devices have seven CCP (Capture/Compare/PWM) modules, designated CCP4 through CCP10. All the modules implement standard Capture, Compare and Pulse-Width Modulation (PWM) modes.

**Note:** Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the specific CCP module. For example, the control register is named CCPxCON and refers to CCP4CON through CCP10CON.

Each CCP module contains a 16-bit register that can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle register. For the sake of clarity, all CCP module operation in the following sections is described with respect to CCP4, but is equally applicable to CCP5 through CCP10.

Note: The CCP9 and CCP10 modules are disabled on the devices with 32 Kbytes of program memory (PIC18FX5K90).

## REGISTER 18-1: CCPxCON: CCPx CONTROL REGISTER (CCP4-CCP10 MODULES)<sup>(1)</sup>

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
_	_	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0				
bit 7							bit 0				
Legend:											
R = Reada	able bit	W = Writable	bit	U = Unimplen	nented bit, rea	d as '0'					
-n = Value	at POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unki	nown				
bit 7-6	Unimpleme	n <b>ted:</b> Read as '	n'								
bit 5-4	-	<b>DCxB&lt;1:0&gt;:</b> PWM Duty Cycle for CCPx Module bits (bit 1, bit 0)									
	<u>Capture moc</u> Unused. <u>Compare mc</u> Unused.	<u>le:</u> ode:		, , , , , , , , , , , , , , , , , , ,							
		re the two Least		ts (bit 1 and bit ( uty cycle are for			le. The eight				
bit 3-0	0000 = Cap 0001 = Res 0010 = Cor 0011 = Res	erved npare mode: tog	PWM disabled	(resets CCPx n match (CCPxIF							
	0110 = Cap 0111 = Cap 1000 = Cor is se	et)	ry 4th rising e ry 16th rising e tialize CCPx p	edge in low; on comp		-					
	is s	et)		in high; on comp re interrupt on c							
					1		-,				

- reflects I/O state) 1011 = Compare mode: Special Event Trigger; reset timer on CCPx match (CCPxIF bit is set)<sup>(2)</sup>
- 11xx = PWM mode
- **Note 1:** The CCP9 and CCP10 modules are not available on devices with 32 Kbytes of program memory (PIC18FX5K90).
  - 2: CCPxM<3:0> = 1011 will only reset the timer and not start A/D conversion on CCPx match.

## 查询PIC18F86K90供应商

REGISTER 18-2: CCPTMRS1: CCPx TIMER SELECT REGISTER 1

R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
C7TSEL1	C7TSEL0	—	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0
bit 7							bit 0

Legend:									
R = Readal	ble bit	W = Writable bit	U = Unimplemented bit,	read as '0'					
-n = Value a	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					
bit 7-6	C7TSEL	<1:0>: CCP7 Timer Selection	n bits						
	01 = CC 10 = CC	CP7 is based off of TMR1/TM CP7 is based off of TMR5/TM CP7 is based off of TMR5/TM CP7 is based off of TMR5/TM	IR4 IR6						
bit 5	Unimple	mented: Read as '0'							
bit 4	C6TSEL	C6TSEL0: CCP6 Timer Selection bit							
		P6 is based off of TMR1/TMR P6 is based off of TMR5/TMR							
bit 3	Unimple	mented: Read as '0'							
bit 2	C5TSEL	0: CCP5 Timer Selection bit							
		P5 is based off of TMR1/TMR P5 is based off of TMR5/TMR							
bit 1-0	C4TSEL	C4TSEL<1:0>: CCP4 Timer Selection bits							
	01 = CO 10 = CO	CP4 is based off of TMR1/TM CP4 is based off of TMR3/TM CP4 is based off of TMR3/TM eserved; do not use	1R4						

### 查询PIC18F86K90供应商 REGISTER 18-3: CCPTMRS2: CCPx TIMER SELECT REGISTER 2

U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	—	_	C10TSEL0 <sup>(1)</sup>	_	C9TSEL0 <sup>(1)</sup>	C8TSEL1	C8TSEL0
bit 7							bit 0

Legend:									
R = Reada	able bit	W = Writable bit	U = Unimplemented bit,	read as '0'					
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					
bit 7-5	Unimple	emented: Read as '0'							
bit 4	C10TSE	L0: CCP10 Timer Selection b	it <sup>(1)</sup>						
	0 = CCF	P10 is based off of TMR1/TMF	R2						
	1 = CCF	P10 is based off of TMR7/TMF	R2						
bit 3	Unimple	emented: Read as '0'							
bit 2	C9TSEL0: CCP9 Timer Selection bit								
	0 = CCF	P9 is based off of TMR1/TMR2	2						
	1 = CCF	P9 is based off of TMR7/TMR4	4						
bit 1-0	C8TSEL	<1:0>: CCP8 Timer Selection	bits						
	<u>On non 3</u>	32-Kbyte device variants:							
		CP8 is based off of TMR1/TMI							
		CP8 is based off of TMR7/TMI							
		CP8 is based off of TMR7/TMI	R6						
	11 = Reserved; do not use								
		On 32-Kbyte device variants (PIC18F85K90/65K90:							
		CP8 is based off of TMR1/TMI CP8 is based off of TMR1/TMI							
		CP8 is based off of TMR1/TM							
		eserved; do not use							
	TT - 100								

Note 1: This bit is unimplemented and reads as '0' on devices with 32 Kbytes of program memory (PIC18FX5K90).

## 查询PIC18F86K90供应商

## REGISTER 18-4: CCPRxL: CCPx PERIOD LOW BYTE REGISTER

| R/W-x   |
|---------|---------|---------|---------|---------|---------|---------|---------|
| CCPRxL7 | CCPRxL6 | CCPRxL5 | CCPRxL4 | CCPRxL3 | CCPRxL2 | CCPRxL1 | CCPRxL0 |
| bit 7   |         |         |         |         |         |         | bit 0   |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 CCPRxL<7:0>: CCPx Period Register Low Byte bits Capture Mode: Capture register low byte. Compare Mode: Compare register low byte. <u>PWM Mode:</u> Duty Cycle register low byte.

## REGISTER 18-5: CCPRxH: CCPx PERIOD HIGH BYTE REGISTER

| R/W-x   |
|---------|---------|---------|---------|---------|---------|---------|---------|
| CCPRxH7 | CCPRxH6 | CCPRxH5 | CCPRxH4 | CCPRxH3 | CCPRxH2 | CCPRxH1 | CCPRxH0 |
| bit 7   |         |         |         |         |         |         | bit 0   |

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7-0 CCPRxH<7:0>: CCPx Period Register High Byte bits <u>Capture Mode:</u> Capture register high byte. <u>Compare Mode:</u> Compare register high byte. <u>PWM Mode:</u> Duty Cycle Buffer register high byte.

#### 查询PIC18F86K90供应商 18.1 CCP Module Configuration

Each Capture/Compare/PWM module is associated with a control register (generically, CCPxCON) and a data register (CCPRx). The data register, in turn, is comprised of two 8-bit registers: CCPRxL (low byte) and CCPRxH (high byte). All registers are both readable and writable.

#### 18.1.1 CCP MODULES AND TIMER RESOURCES

The CCP modules utilize Timers, 1 through 8, varying with the selected mode. Various timers are available to the CCP modules in Capture, Compare or PWM modes, as shown in Table 18-1.

### TABLE 18-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timor1 Timor2 Timor 5 or Timor7
Compare	Timer1, Timer3, Timer 5 or Timer7
PWM	Timer2, Timer4, Timer 6 or Timer8

The assignment of a particular timer to a module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. (See Register 18-2 and Register 18-3.) All of the modules may be active at once and may share the same timer resource if they are configured to operate in the same mode (Capture/Compare or PWM) at the same time.

The CCPTMRS1 register selects the timers for CCP modules, 7, 6, 5 and 4, and the CCPTMRS2 register selects the timers for CCP modules, 10, 9 and 8. The possible configurations are shown in Table 18-2 and Table 18-3.

## TABLE 18-2: TIMER ASSIGNMENTS FOR CCP MODULES 4, 5, 6 AND 7

	CCPTMRS1 Register										
CCP4 CCP5			CCP6				CCP7				
C4TSEL <1:0>	Capture/ Compare Mode	PWM Mode	C5TSEL0	Capture/ Compare Mode	PWM Mode	C6TSEL0	Capture/ Compare Mode	PWM Mode	C7TSEL <1:0>	Capture/ Compare Mode	PWM Mode
0 0	TMR1	TMR2	0	TMR1	TMR2	0	TMR1	TMR2	0 0	TMR1	TMR2
0 1	TMR3	TMR4	1	TMR5	TMR4	1	TMR5	TMR2	0 1	TMR5	TMR4
1 0	TMR3	TMR6							1 0	TMR5	TMR6
1 1 Reserved <sup>(1)</sup>									1 1	TMR5	TMR8

Note 1: Do not use the reserved bits.

## TABLE 18-3: TIMER ASSIGNMENTS FOR CCP MODULES 8, 9 AND 10

	CCPTMRS2 Register												
CCP8 CCP8 CCP8 Devices with 32 Kb				oytes <sup>(1)</sup>	CCP9 <sup>(1)</sup>			CCP10 <sup>(1)</sup>					
C8TSEL <1:0>	Capture/ Compare Mode	PWM Mode	C8TSEL <1:0>	Capture/ Compare Mode	PWM Mode	C9TSEL0 Capture/ Compare Mode PWM		C10TSEL0	Capture/ Compare Mode	PWM Mode			
0 0	TMR1	TMR2	0 0	TMR1	TMR2	0	TMR1	TMR2	0	TMR1	TMR2		
0 1	TMR7	TMR4	0 1	TMR1	TMR4	1	TMR7	TMR4	1	TMR7	TMR2		
1 0	TMR7	TMR6	1 0	TMR1	TMR6								
1 1	Reserve	ed <sup>(2)</sup>	11	Reserve	ed <sup>(2)</sup>								

**Note 1:** Module not available for devices with 32 Kbytes of program memory.

2: Do not use the reserved bits.

## 查询PIC18F86K90供应商

## 18.1.2 OPEN-DRAIN OUTPUT OPTION

When operating in Output mode (the Compare or PWM modes), the drivers for the CCPx pins can be optionally configured as open-drain outputs. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor and allows the output to communicate with external circuits without the need for additional level shifters.

The open-drain output option is controlled by the CCPxOD bits (ODCON2<7:2>). Setting the appropriate bit configures the pin for the corresponding module for open-drain operation.

### 18.1.3 PIN ASSIGNMENT FOR CCP6, CCP7, CCP8 AND CCP9

The pin assignment for CCP6/7/8/9 (Capture input, Compare and PWM output) can change, based on the device configuration.

The ECCPMX Configuration bit (CONFIG3H<1>) determines the pin to which CCP6/7/8/9 is multiplexed. The pin assignments for these CCP modules are given in Table 18-4.

TABLE 18-4: CCP PIN ASSIGNMENT

ЕССРМХ	Pin Mapped To							
Value	CCP6	CCP7	CCP8	CC9				
1 (Default)	RE6	RE5	RE4	RE3				
0	RH7	RH6	RH5	RH4				

## 18.2 Capture Mode

In Capture mode, the CCPR4H:CCPR4L register pair captures the 16-bit value of the TMR1 or TMR3 register when an event occurs on the CCP4 pins. An event is defined as one of the following:

- · Every falling edge
- Every rising edge
- · Every 4th rising edge
- · Every 16th rising edge

The event is selected by the mode select bits, CCP4M<3:0> (CCP4CON<3:0>). When a capture is made, the interrupt request flag bit, CCP4IF (PIR4<1>), is set. (It must be cleared in software.) If another capture occurs before the value in CCPR4 is read, the old captured value is overwritten by the new captured value.

Figure 18-1 shows the Capture mode block diagram.

## 18.2.1 CCP PIN CONFIGURATION

In Capture mode, the appropriate CCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note:	If RC1 or RE7 is configured as a CCP4
	output, a write to the port causes a capture
	condition.

### 18.2.2 TIMER1/3/5/7 MODE SELECTION

For the available timers (1/3/5/7) to be used for the capture feature, the used timers must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work.

The timer to be used with each CCP module is selected in the CCPTMRSx registers. (See Section 18.1.1 "CCP Modules and Timer Resources".)

Details of the timer assignments for the CCP modules are given in Table 18-2 and Table 18-3.

## 查询PIC18F86K90供应商

FIGURE 18-1: CAPTURE MODE OPERATION BLOCK DIAGRAM TMR5L TMR5H Set CCP5IF TMR5 C5TSEL0 Enable CCP5 Pin Prescaler and CCPR5H CCPR5L ÷ 1, 4, 16 Edge Detect TMR1 C5TSEL0 Enable TMR1H TMR1L CCP5CON<3:0> Set CCP4IF Q1:Q4 -4 CCP4CON<3:0> TMR3H TMR3L C4TSEL1-C4TSEL0 TMR3 Enable CCP4 Pin Prescaler and 🕴 CCPR4H CCPR4L ÷ 1, 4, 16 Edge Detect TMR1 Enable C4TSEL0-TMR1H TMR1L C4TSEL1 This block diagram uses CCP4 and CCP5, and their appropriate timers, as an example. For details on all Note: of the CCP modules and their timer assignments, see Table 18-2 and Table 18-3.

#### 18.2.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCP4IE bit (PIE4<1>) clear to avoid false interrupts and should clear the flag bit, CCP4IF, following any such change in operating mode.

#### 18.2.4 CCP PRESCALER

There are four prescaler settings in Capture mode. They are specified as part of the operating mode selected by the mode select bits (CCP4M<3:0>). Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Doing that also will not clear the prescaler counter - meaning the first capture may be from a non-zero prescaler.

Example 18-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

#### **EXAMPLE 18-1: CHANGING BETWEEN CAPTURE PRESCALERS**

CLRF	CCP4CON	;	Turn CCP module off
MOVLW	NEW_CAPT_PS	;	Load WREG with the
		;	new prescaler mode
		;	value and CCP ON
MOVWF	CCP4CON	;	Load CCP4CON with
		;	this value

### 查询PIC18F86K90供应商 18.3 Compare Mode

In Compare mode, the 16-bit CCPR4 register value is constantly compared against either the TMR1 or TMR3 register pair value. When a match occurs, the CCP4 pin can be:

- Driven high
- Driven low
- Toggled (high-to-low or low-to-high)
- Unchanged (that is, reflecting the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCP4M<3:0>). At the same time, the interrupt flag bit, CCP4IF, is set.

Figure 18-2 shows the Compare mode block diagram

#### 18.3.1 CCP PIN CONFIGURATION

The user must configure the CCPx pin as an output by clearing the appropriate TRIS bit.

Note: Clearing the CCP4CON register will force the RC1 or RE7 compare output latch (depending on device configuration) to the default low level. This is not the PORTC or PORTE I/O data latch.

### 18.3.2 TIMER1/3/5/7 MODE SELECTION

If the CCP module is using the compare feature in conjunction with any of the Timer1/3/5/7 timers, the timers must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the compare operation may not work.

Note:	Details of the timer assignments for the
	CCP modules are given in Table 18-2 and
	Table 18-3.

## 18.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCP4M<3:0> = 1010), the CCP4 pin is not affected. Only a CCP interrupt is generated, if enabled, and the CCP4IE bit is set.

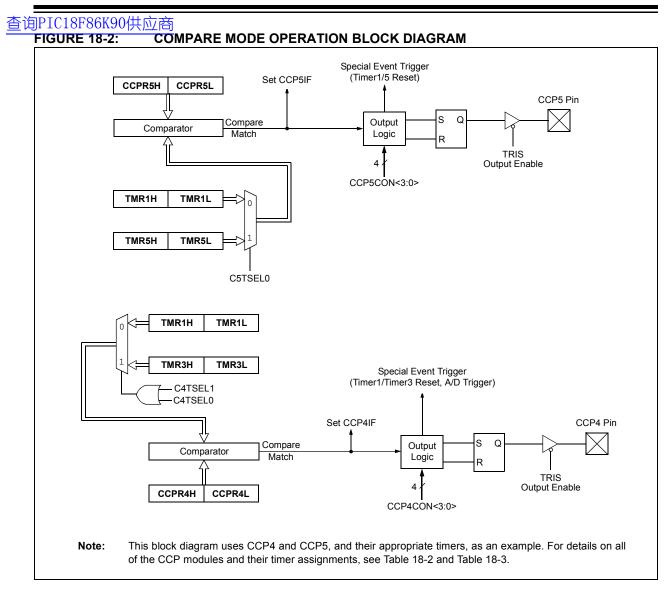
#### 18.3.4 SPECIAL EVENT TRIGGER

Both CCP modules are equipped with a Special Event Trigger. This is an internal hardware signal generated in Compare mode to trigger actions by other modules. The Special Event Trigger is enabled by selecting the Compare Special Event Trigger mode (CCP4M<3:0> = 1011).

For either CCP module, the Special Event Trigger resets the timer register pair for whichever timer resource is currently assigned as the module's time base. This allows the CCPRx registers to serve as a programmable period register for either timer.

The Special Event Trigger for CCP4 cannot start an A/D conversion.

Note: The Special Event Trigger of ECCP1 can start an A/D conversion, but the A/D Converter needs to be enabled. For more information, see Section 19.0 "Enhanced Capture/Compare/PWM (ECCP) Module".



## 查询PIC18F86K90供应商

TABLE 18-5: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1/3/5/7

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
PIR4	CCP10IF <sup>(1)</sup>	CCP9IF <sup>(1)</sup>	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75
PIE4	CCP10IE <sup>(1)</sup>	CCP9IE <sup>(1)</sup>	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75
IPR4	CCP10IP <sup>(1)</sup>	CCP9IP <sup>(1)</sup>	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76
TRISH <sup>(1)</sup>	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76
TMR1L	Timer1 Reg	ister Low By	/te						74
TMR1H	Timer1 Reg	ister High B	yte						74
TMR3L	Timer3 Reg	ister Low By	/te						75
TMR3H	Timer3 Reg	ister High B	yte						75
TMR5L	Timer5 Reg	imer5 Register Low Byte							80
TMR5H	Timer5 Reg	imer5 Register High Byte							80
TMR7L	Timer7 Reg	ïmer7 Register Low Byte							
TMR7H	Timer7 Reg	ister High B	yte						79
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	74
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	75
T5CON	TMR5CS1	TMR5CS0	T5CKPS1	T5CKPS0	SOSCEN	T5SYNC	RD16	TMR5ON	80
T7CON	TMR7CS1	TMR7CS0	T7CKPS1	T7CKPS0	SOSCEN	T7SYNC	RD16	TMR7ON	79
CCPR4L	Capture/Co	mpare/PWM	1 Register	4 Low Byte					80
CCPR4H	Capture/Co	mpare/PWM	1 Register	4 High Byte					80
CCPR5L	Capture/Co	mpare/PWM	1 Register	5 Low Byte					80
CCPR5H	Capture/Co	mpare/PWM	1 Register	5 High Byte					80
CCPR6L	Capture/Co	mpare/PWM	1 Register	6 Low Byte					80
CCPR6H	Capture/Co	mpare/PWM	1 Register	6 High Byte					80
CCPR7L	Capture/Co	mpare/PWM	1 Register	7 Low Byte					80
CCPR7H	Capture/Co	mpare/PWM	1 Register	7 High Byte					80
CCPR8L	Capture/Co	mpare/PWM	1 Register	8 Low Byte					78
CCPR8H	Capture/Co	mpare/PWM	1 Register	8 High Byte					78
CCPR9L <sup>(1)</sup>	Capture/Co	mpare/PWM	1 Register	9 Low Byte					78
CCPR9H <sup>(1)</sup>	Capture/Co	mpare/PWM	1 Register	9 High Byte					78
CCPR10L <sup>(1)</sup>	Capture/Co	mpare/PWM	1 Register	10 Low Byte	;				79
CCPR10H <sup>(1)</sup>	Capture/Co	mpare/PWM	1 Register	10 High Byte	Э				78
CCP4CON			DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	80
CCP5CON		—	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	80

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare or Timer1/3/5/7.

**Note 1:** Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

#### 查询PIC18F86K90供应商 TABLE 18-5: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1/3/5/7 (CONTINUED)

						, <b></b>		(	
Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CCP6CON			DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	80
CCP7CON	_	_	DC7B1	DC7B0	CCP7M3	CCP7M2	CCP7M1	CCP7M0	80
CCP8CON	_	_	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	78
CCP9CON <sup>(1)</sup>	_	_	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	78
CCP10CON <sup>(1)</sup>	_	_	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	79
CCPTMRS1	C7TSEL1	C7TSEL0	—	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2		_	_	C10TSEL0	—	C9TSEL0	C8TSEL1	C8TSEL0	79

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare or Timer1/3/5/7.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

## 18.4 PWM Mode

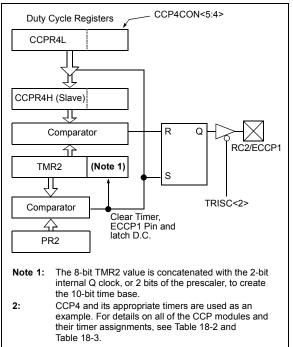
In Pulse-Width Modulation (PWM) mode, the CCP4 pin produces up to a 10-bit resolution PWM output. Since the CCP4 pin is multiplexed with a PORTC or PORTE data latch, the appropriate TRIS bit must be cleared to make the CCP4 pin an output.

Note:	Clearing the CCP4CON register will force the RC1 or RE7 output latch (depending
	on device configuration) to the default low
	level. This is not the PORTC or PORTE
	I/O data latch.

Figure 18-3 shows a simplified block diagram of the ECCP1 module in PWM mode.

For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 18.4.3** "Setup for PWM Operation".

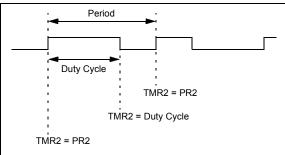




## 查询PIC18F86K90供应商

A PWM output (Figure 18-4) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

### FIGURE 18-4: PWM OUTPUT



## 18.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

## EQUATION 18-1:

 $PWM Period = [(PR2) + 1] \cdot 4 \cdot TOSC \cdot (TMR2 Prescale Value)$ 

PWM frequency is defined as 1/[PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP4 pin is set
  - (An exception: If PWM duty cycle = 0%, the CCP4 pin will not be set)
- The PWM duty cycle is latched from CCPR4L into CCPR4H
- Note: The Timer2 postscalers (see Section 14.0 "Timer2 Module") are not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

## 18.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR4L register (using CCP4 as an example) and to the CCP4CON<5:4> bits. Up to 10-bit resolution is available. The CCPR4L contains the eight MSbs and the CCP4CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR4L:CCP4CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

## EQUATION 18-2:

```
PWM Duty Cycle = (CCPR4L:CCP4CON<5:4>) •
Tosc • (TMR2 Prescale Value)
```

CCPR4L and CCP4CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR4H until after a match between PR2 and TMR2 occurs (that is, the period is complete). In PWM mode, CCPR4H is a read-only register.

The CCPR4H register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation.

When the CCPR4H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or two bits of the TMR2 prescaler, the CCP4 pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the equation:

## **EQUATION 18-3:**

PWM Resolution (max) = 
$$\frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP4 pin will not be cleared.

## TABLE 18-6: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	14	12	10	8	7	6.58

#### 查询PIC18F86K90供应商 18.4.3 SETUP FOR PWM OPERATION

To configure the CCP module for PWM operation (with CCP4 as an example):

- 1. Set the PWM period by writing to the PR2 register.
- 2. Set the PWM duty cycle by writing to the CCPR4L register and CCP4CON<5:4> bits.
- 3. Make the CCP4 pin an output by clearing the appropriate TRIS bit.
- 4. Set the TMR2 prescale value, then enable Timer2 by writing to T2CON.
- 5. Configure the CCP4 module for PWM operation.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73	
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74	
PIR4	CCP10IF <sup>(1)</sup>	CCP9IF <sup>(1)</sup>	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75	
PIE4	CCP10IE <sup>(1)</sup>	CCP9IE <sup>(1)</sup>	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75	
IPR4	CCP10IP <sup>(1)</sup>	CCP9IP <sup>(1)</sup>	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75	
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76	
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76	
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76	
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76	
TMR2	Timer2 Regis	ter					•		74	
TMR4	Timer4 Regis	ter							80	
TMR6	Timer6 Regis	ter							79	
TMR8	Timer8 Regis	Timer8 Register								
PR2	Timer2 Period	Timer2 Period Register								
PR4	Timer4 Period	l Register							80	
PR6	Timer6 Period	l Register							79	
PR8	Timer8 Period	l Register							79	
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	74	
T4CON	—	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	80	
T6CON	_	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	79	
T8CON	—	T8OUTPS3	T8OUTPS2	T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	79	
CCPR4L	Capture/Com	pare/PWM R	egister 4 Low	v Byte					80	
CCPR4H	Capture/Com	pare/PWM R	egister 4 Hig	h Byte					80	
CCPR5L	Capture/Com	pare/PWM R	egister 5 Lov	v Byte					80	
CCPR5H	Capture/Com	pare/PWM R	egister 5 Hig	h Byte					80	
CCPR6L	Capture/Com	pare/PWM R	egister 6 Lov	v Byte					80	
CCPR6H	Capture/Com	pare/PWM R	egister 6 Hig	h Byte					80	
CCPR7L	Capture/Com	pare/PWM R	egister 7 Lov	v Byte					80	
CCPR7H	Capture/Com	pare/PWM R	egister 7 Hig	h Byte					80	
CCPR8L	Capture/Compare/PWM Register 8 Low Byte								78	
CCPR8H	Capture/Com	pare/PWM R	egister 8 Hig	h Byte					78	
CCPR9L <sup>(1)</sup>	Capture/Com	pare/PWM R	egister 9 Lov	v Byte					78	
CCPR9H <sup>(1)</sup>	Capture/Com	pare/PWM R	egister 9 Hig	h Byte					78	
CCPR10L <sup>(1)</sup>	Capture/Com	pare/PWM R	egister 10 Lo	w Byte					79	

## TABLE 18-7: REGISTERS ASSOCIATED WITH PWM AND TIMERS

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by PWM or Timer2/4/6/8.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

## 查询PIC18F86K90供应商

## TABLE 18-7: REGISTERS ASSOCIATED WITH PWM AND TIMERS (CONTINUED)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CCPR10H <sup>(1)</sup>	CPR10H <sup>(1)</sup> Capture/Compare/PWM Register 10 High Byte								
CCP4CON	_	—	DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	80
CCP5CON	—	—	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	80
CCP6CON	_	—	DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	80
CCP7CON	—	—	DC7B1	DC7B0	CCP7M3	CCP7M2	CCP7M1	CCP7M0	80
CCP8CON	—	_	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	78
CCP9CON <sup>(1)</sup>	—	—	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	78
CCP10CON <sup>(1)</sup>	—	_	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	79
CCPTMRS1	C7TSEL1	C7TSEL0	—	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2	_	_	_	C10TSEL0	_	C9TSEL0	C8TSEL1	C8TSEL0	79

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PWM or Timer2/4/6/8.

**Note 1:** Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

### 查询PIC18F86K90供应商 **19.0 ENHANCED**

## CAPTURE/COMPARE/PWM (ECCP) MODULE

PIC18F87K90 family devices have three Enhanced Capture/Compare/PWM (ECCP) modules: ECCP1, ECCP2 and ECCP3. These modules contain a 16-bit register, which can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle register. These ECCP modules are upward compatible with CCP

**Note:** Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the ECCP1, ECCP2 or ECCP3 module. For example, the control register is named CCPxCON and refers to CCP1CON, CCP2CON and CCP3CON.

ECCP1, ECCP2 and ECCP3 are implemented as standard CCP modules with Enhanced PWM capabilities. These include:

- Provision for two or four output channels
- · Output Steering modes
- · Programmable polarity
- Programmable dead-band control
- · Automatic shutdown and restart

The enhanced features are discussed in detail in Section 19.4 "PWM (Enhanced Mode)".

The ECCP1, ECCP2 and ECCP3 modules use the control registers, CCP1CON, CCP2CON and CCP3CON. The control registers, CCP4CON through CCP10CON, are for the CCP4 through CCP10 modules.

## 查询PIC18F86K90供应商

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
PxM1	PxM0	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0				
bit 7							bit				
Lonordi											
<b>Legend:</b> R = Readab	le hit	W = Writable	hit	LI = Unimpler	nented bit, read	l as '0'					
-n = Value a		'1' = Bit is set		'0' = Bit is cle		x = Bit is unkr					
					aleu		IOWII				
bit 7-6	<u>lf CCPxM&lt;3:</u> xx = PxA is <u>lf CCPxM&lt;3:</u>	<u>2&gt; = 11:</u>	<u>):</u> apture/compa	are input/output;		· ·					
	<ul> <li>00 = Single output: PxA, PxB, PxC and PxD are controlled by steering (see Section 19.4.7 "Pulse Steering Mode")</li> <li>01 = Full-bridge output forward: PxD is modulated; PxA is active; PxB, PxC are inactive</li> <li>10 = Half-bridge output: PxA, PxB are modulated with dead-band control; PxC and PxD are assigned as port pins</li> <li>11 = Full-bridge output reverse: PxB is modulated; PxC is active; PxA and PxD are inactive</li> </ul>										
bit 5-4	<b>DCxB&lt;1:0</b> >: PWM Duty Cycle bit 1 and bit 0										
	<u>Capture mode:</u> Unused.										
	Compare mo Unused. <u>PWM mode:</u> These bits ar in CCPRxL.		of the 10-bit F	PWM duty cycle	. The eight MSt	os of the duty c	ycle are found				
bit 3-0		>: ECCPx Mode	e Select bits								
	0001 = Res 0010 = Cor 0011 = Cap 0100 = Cap 0101 = Cap	erved npare mode: to oture mode oture mode: eve oture mode: eve	ggle output or ry falling edge ry rising edge	9	ule)						
	0111 = Cap 1000 = Cor	•	ery 16 <sup>th</sup> rising tialize the ECC	edge CPx pin low; set	the output on a		•				

- 1001 = Compare mode: initialize the ECCPx pin high; clear the output on a compare match (set CCPxIF)
- 1010 = Compare mode: generate a software interrupt only, ECCPx pin reverts to an I/O state
- 1011 = Compare mode: trigger special event (ECCPx resets TMR1 or TMR3, starts A/D conversion, sets CCxIF bit)
- 1100 = PWM mode: PxA and PxC are active-high; PxB and PxD are active-high
- 1101 = PWM mode: PxA and PxC are active-high; PxB and PxD are active-low
- 1110 = PWM mode: PxA and PxC are active-low; PxB and PxD are active-high
- 1111 = PWM mode: PxA and PxC are active-low; PxB and PxD are active-low

## 查询PIC18F86K90供应商 REGISTER 19-2: CCPTMRS0: CCP TIMER SELECT 0 REGISTER

| R/W-0   |
|---------|---------|---------|---------|---------|---------|---------|---------|
| C3TSEL1 | C3TSEL0 | C2TSEL2 | C2TSEL1 | C2TSEL0 | C1TSEL2 | C1TSEL1 | C1TSEL0 |
| bit 7   |         |         |         |         |         |         | bit 0   |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	C3TSEL<1:0>: ECCP3 Timer Selection bit 00 = ECCP3 is based off of TMR1/TMR2 01 = ECCP3 is based off of TMR3/TMR4 10 = ECCP3 is based off of TMR3/TMR6 11 = ECCP3 is based off of TMR3/TMR8
bit 5-3	C2TSEL<2:0>: ECCP2 Timer Selection bit 000 = ECCP2 is based off of TMR1/TMR2 001 = ECCP2 is based off of TMR3/TMR4 010 = ECCP2 is based off of TMR3/TMR6 011 = ECCP2 is based off of TMR3/TMR8 100 = ECCP2 is based off of TMR3/TMR10; option is reserved on the 32-Kbyte device variant; do not use 101 = Reserved; do not use 110 = Reserved; do not use 111 = Reserved; do not use
bit 2-0	C1TSEL<2:0>: ECCP1 Timer Selection bit 000 = ECCP1 is based off of TMR1/TMR2 001 = ECCP1 is based off of TMR3/TMR4 010 = ECCP1 is based off of TMR3/TMR6 011 = ECCP1 is based off of TMR3/TMR8 100 = ECCP1 is based off of TMR3/TMR10; option is reserved on the 32-Kbyte device variant; do not use 101 = ECCP1 is based off of TMR3/TMR12; option is reserved on the 32-Kbyte device variant; do not use 110 = Reserved; do not use 111 = Reserved; do not use

## 查询PIC18F86K90供应商

In addition to the expanded range of modes available through the CCPxCON and ECCPxAS registers, the ECCP modules have two additional registers associated with Enhanced PWM operation and auto-shutdown features. They are:

- ECCPxDEL Enhanced PWM Control
- PSTRxCON Pulse Steering Control

## **19.1 ECCP Outputs and Configuration**

The Enhanced CCP module may have up to four PWM outputs, depending on the selected operating mode. The CCPxCON register is modified to allow control over four PWM outputs: ECCPx/PxA, PxB, PxC and PxD. Applications can use one, two or four of these outputs.

The outputs that are active depend on the ECCP operating mode selected. The pin assignments are summarized in Table 19-3.

To configure the I/O pins as PWM outputs, the proper PWM mode must be selected by setting the PxM<1:0> and CCPxM<3:0> bits. The appropriate TRIS direction bits for the port pins must also be set as outputs.

#### 19.1.1 ECCP MODULE AND TIMER RESOURCES

The ECCP modules use Timers, 1, 2, 3, 4, 6, 8, 10 or 12, depending on the mode selected. These timers are available to CCP modules in Capture, Compare or PWM modes, as shown in Table 19-1.

## TABLE 19-1:ECCP MODE – TIMERRESOURCE

ECCP Mode	Timer Resource		
Capture	Timer1 or Timer3		
Compare	Timer1 or Timer3		
PWM	Timer2, Timer4, Timer6, Timer8,		
	Timer10 or Timer12		

The assignment of a particular timer to a module is determined by the Timer to ECCP enable bits in the CCPTMRSx register (Register 19-2). The interactions between the two modules are depicted in Figure 19-1. Capture operations are designed to be used when the timer is configured for Synchronous Counter mode. Capture operations may not work as expected if the associated timer is configured for Asynchronous Counter mode.

## 19.1.2 ECCP PIN ASSIGNMENT

The pin assignment for ECCPx (capture input, compare and PWM output) can change, based on device configuration. The ECCPMX (CONFIG3H<1>) Configuration bit determines to which pin, ECCP1 and ECCP3, are multiplexed to.

- Default/ECCPMX = 1:
  - ECCP1 (P1B/P1C) multiplexed onto RE6 and RE5
  - ECCP3 (P3B/P3C) multiplexed onto RE4 and RE3
- ECCPMX = 0:
  - ECCP1 (P1B/P1C) multiplexed onto RH7 and RH6
  - ECCP3 (P3B/P3C) multiplexed onto RH5 and RH4.

The pin assignment for ECCP2 (capture input, compare and PWM output) can change, based on device configuration.

The CCP2MX Configuration bit (CONFIG3H<0>) determines to which pin, ECCP2, is multiplexed.

- If CCP2MX = 1 (default) ECCP2 is multiplexed to RC1
- If CCP2MX = 0 ECCP2 is multiplexed to:
- RE7 is the ECCP2 pin with CCP2MX = 0

#### 查询PIC18F86K90供应商 19.2 Capture Mode

In Capture mode, the CCPRxH:CCPRxL register pair captures the 16-bit value of the TMR1 or TMR3 registers when an event occurs on the corresponding ECCPx pin. An event is defined as one of the following:

- · Every falling edge
- · Every rising edge
- Every fourth rising edge
- Every 16<sup>th</sup> rising edge

The event is selected by the mode select bits, CCPxM<3:0> (CCPxCON register<3:0>). When a capture is made, the interrupt request flag bit, CCPxIF, is set (see Table 19-2). The flag must be cleared by software. If another capture occurs before the value in the CCPRxH/L register is read, the old captured value is overwritten by the new captured value.

#### TABLE 19-2: ECCP1/2/3 INTERRUPT FLAG BITS

ECCP Module	Flag Bit
1	PIR3<1>
2	PIR3<2>
3	PIR4<0>

#### 19.2.1 ECCP PIN CONFIGURATION

In Capture mode, the appropriate ECCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note:	If the ECCPx pin is configured as an out-
	put, a write to the port can cause a capture
	condition.

#### 19.2.2 TIMER1/TIMER3 MODE SELECTION

The timers that are to be used with the capture feature (Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work. The timer to be used with each ECCP module is selected in the CCPTMRS0 register (Register 19-2).

#### 19.2.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCPxIE interrupt enable bit clear to avoid false interrupts. The interrupt flag bit, CCPxIF, should also be cleared following any such change in operating mode.

#### 19.2.4 ECCP PRESCALER

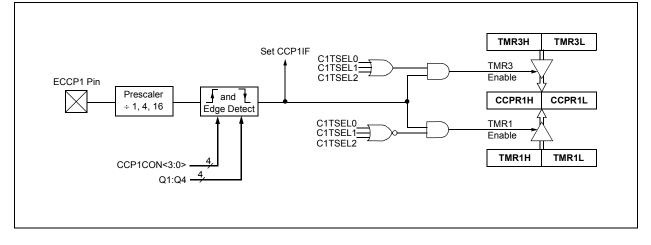
There are four prescaler settings in Capture mode; they are specified as part of the operating mode selected by the mode select bits (CCPxM<3:0>). Whenever the ECCP module is turned off, or Capture mode is disabled, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 19-1 provides the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

#### EXAMPLE 19-1: CHANGING BETWEEN CAPTURE PRESCALERS

			Turn ECCP module off
MOVLW	NEW_CAPT_PS	;	Load WREG with the
		;	new prescaler mode
		;	value and ECCP ON
MOVWF	CCP1CON	;	Load CCP1CON with
		;	this value

#### FIGURE 19-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



#### 查询PIC18F86K90供应商 19.3 Compare Mode

In Compare mode, the 16-bit CCPRx register value is constantly compared against either the TMR1 or TMR3 register pair value. When a match occurs, the ECCPx pin can be:

- Driven high
- Driven low
- Toggled (high-to-low or low-to-high)
- Unchanged (that is, reflecting the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCPxM<3:0>). At the same time, the interrupt flag bit, CCPxIF, is set.

#### 19.3.1 ECCP PIN CONFIGURATION

Users must configure the ECCPx pin as an output by clearing the appropriate TRIS bit.

Note:	Clearing the CCPxCON register will force
	the ECCPx compare output latch (depend-
	ing on device configuration) to the default
	low level. This is not the PORTx I/O data
	latch.

#### 19.3.2 TIMER1/TIMER3 MODE SELECTION

Timer1 and/or Timer3 must be running in Timer mode or Synchronized Counter mode if the ECCP module is using the compare feature. In Asynchronous Counter mode, the compare operation will not work reliably.

#### 19.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCPxM<3:0> = 1010), the ECCPx pin is not affected; only the CCPxIF interrupt flag is affected.

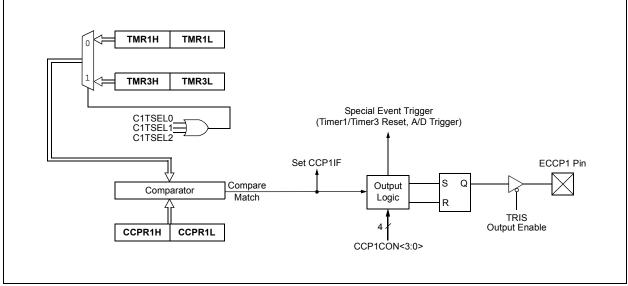
#### 19.3.4 SPECIAL EVENT TRIGGER

The ECCP module is equipped with a Special Event Trigger. This is an internal hardware signal generated in Compare mode to trigger actions by other modules. The Special Event Trigger is enabled by selecting the Compare Special Event Trigger mode (CCPxM<3:0> = 1011).

The Special Event Trigger resets the Timer register pair for whichever timer resource is currently assigned as the module's time base. This allows the CCPRx registers to serve as a programmable period register for either timer.

The Special Event Trigger can also start an A/D conversion. In order to do this, the A/D Converter must already be enabled.





### 查询PIC18F86K90供应商

#### 19.4 PWM (Enhanced Mode)

The Enhanced PWM mode can generate a PWM signal on up to four different output pins with up to 10 bits of resolution. It can do this through four different PWM Output modes:

- Single PWM
- Half-Bridge PWM
- Full-Bridge PWM, Forward mode
- · Full-Bridge PWM, Reverse mode

To select an Enhanced PWM mode, the PxM bits of the CCPxCON register must be set appropriately.

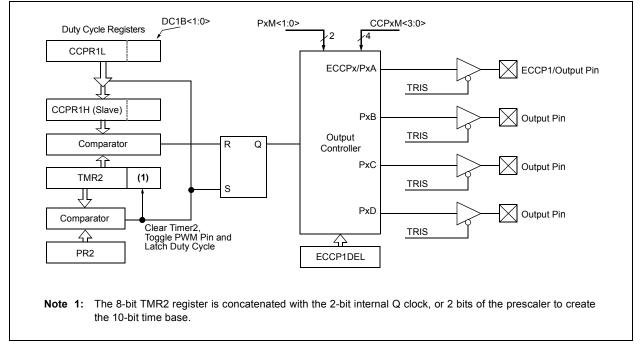
The PWM outputs are multiplexed with I/O pins and are designated: PxA, PxB, PxC and PxD. The polarity of the PWM pins is configurable and is selected by setting the CCPxM bits in the CCPxCON register appropriately.

Table 19-1 provides the pin assignments for each Enhanced PWM mode.

Figure 19-3 provides an example of a simplified block diagram of the Enhanced PWM module.

**Note:** To prevent the generation of an incomplete waveform when the PWM is first enabled, the ECCP module waits until the start of a new PWM period before generating a PWM signal.

#### FIGURE 19-3: EXAMPLE SIMPLIFIED BLOCK DIAGRAM OF THE ENHANCED PWM MODE



Note:The TRIS register value for each PWM output must be configured appropriately.Any pin not used by an Enhanced PWM mode is available for alternate pin functions.

#### 查询PIC18F86K90供应商

#### TABLE 19-3: EXAMPLE PIN ASSIGNMENTS FOR VARIOUS PWM ENHANCED MODES

ECCP Mode	PxM<1:0>	PxA	PxB	PxC	PxD
Single	00	Yes <sup>(1)</sup>	Yes <sup>(1)</sup>	Yes <sup>(1)</sup>	Yes <sup>(1)</sup>
Half-Bridge	10	Yes	Yes	No	No
Full-Bridge, Forward	01	Yes	Yes	Yes	Yes
Full-Bridge, Reverse	11	Yes	Yes	Yes	Yes

**Note 1:** Outputs are enabled by pulse steering in Single mode (see Register 19-5).

### FIGURE 19-4: EXAMPLE PWM (ENHANCED MODE) OUTPUT RELATIONSHIPS (ACTIVE-HIGH STATE)

			<b> </b> ◀	Period	<b>──</b> ►
00	(Single Output)	PxA Modulated	Delay <sup>(1)</sup>	Delay <sup>(1)</sup>	
		PxA Modulated			
10	(Half-Bridge)	PxB Modulated		i	
		PxA Active			
01	(Full-Bridge, Forward)	PxB Inactive	_	   	
01		PxC Inactive	_ ; _ <u>_ ;</u>		
		PxD Modulated	=i	 	1 
		PxA Inactive		   	
11	(Full-Bridge, Reverse)	PxB Modulated			
		PxC Active		  I	
		PxD Inactive —		1 1 1	1 1 1
	tionships:				,

Note 1: Dead-band delay is programmed using the ECCPxDEL register (Section 19.4.6 "Programmable Dead-Band Delay Mode").

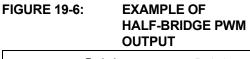
#### 查询PIC18F86K90供应商 FIGURE 19-5: EXAMPLE ENHANCED PWM OUTPUT RELATIONSHIPS (ACTIVE-LOW STATE)

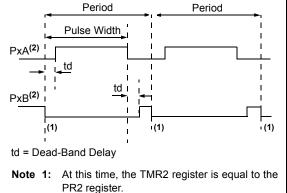
				Period ——	
00	(Single Output)	PxA Modulated			
		PxA Modulated	Delay <sup>(1)</sup>	Delay <sup>(1)</sup>	
10	(Half-Bridge)	PxB Modulated			
		PxA Active	- ;		
01	(Full-Bridge,	PxB Inactive			<i>i</i> I I
01	Forward)	PxC Inactive	- <u> </u>	I	  
		PxD Modulated	'		
		PxA Inactive	- I 	1 1 1	
11	(Full-Bridge,	PxB Modulated	- — <u> </u>		1 I I
	Reverse)	PxC Active			
		PxD Inactive	- <u>-</u> ;	I	 ! !
		* (PR2 + 1) * (TMR2 Preso sc * (CCPRxL<7:0>:CCPx( * (ECCPxDEL<6:0>)		cale Value)	

#### 查询PIC18F86K90供应商 19.4.1 HALF-BRIDGE MODE

In Half-Bridge mode, two pins are used as outputs to drive push-pull loads. The PWM output signal is output on the PxA pin, while the complementary PWM output signal is output on the PxB pin (see Figure 19-6). This mode can be used for half-bridge applications, as shown in Figure 19-7, or for full-bridge applications, where four power switches are being modulated with two PWM signals.

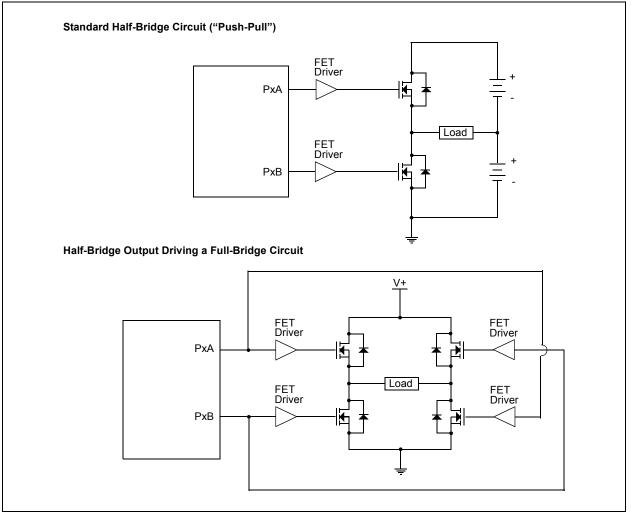
In Half-Bridge mode, the programmable dead-band delay can be used to prevent shoot-through current in half-bridge power devices. The value of the PxDC<6:0> bits of the ECCPxDEL register sets the number of instruction cycles before the output is driven active. If the value is greater than the duty cycle, the corresponding output remains inactive during the entire cycle. For more details on the dead-band delay operations, see **Section 19.4.6 "Programmable Dead-Band Delay Mode"**. Since the PxA and PxB outputs are multiplexed with the port data latches, the associated TRIS bits must be cleared to configure PxA and PxB as outputs.





**2:** Output signals are shown as active-high.

#### FIGURE 19-7: EXAMPLE OF HALF-BRIDGE APPLICATIONS



#### 查询PIC18F86K90供应商 19.4.2 FULL-BRIDGE MODE

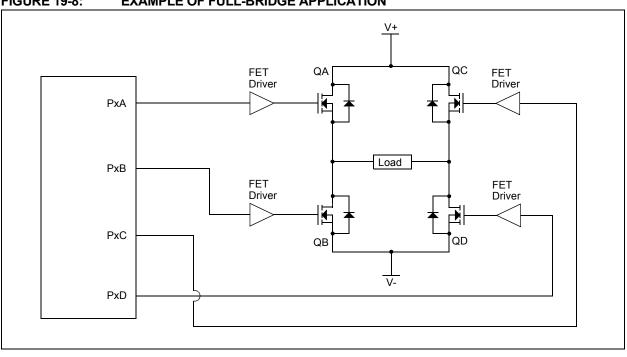
In Full-Bridge mode, all four pins are used as outputs. An example of a full-bridge application is provided in Figure 19-8.

In the Forward mode, the PxA pin is driven to its active state and the PxD pin is modulated, while the PxB and PxC pins are driven to their inactive state, as provided in Figure 19-9.

FIGURE 19-8: EXAMPLE OF FULL-BRIDGE APPLICATION

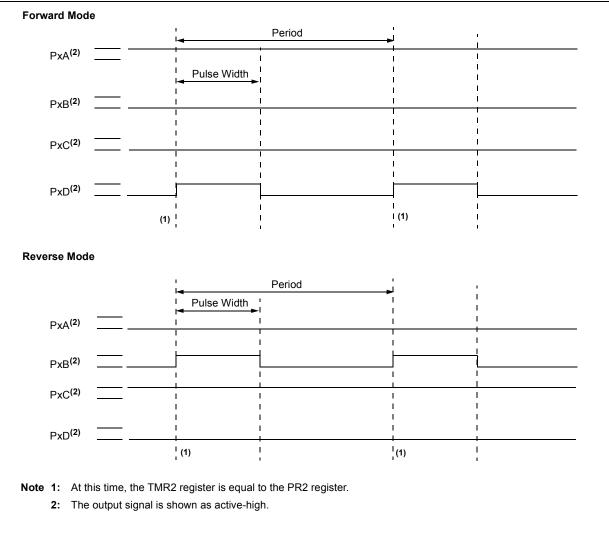
In the Reverse mode, the PxC pin is driven to its active state and the PxB pin is modulated, while the PxA and PxD pins are driven to their inactive state, as provided Figure 19-9.

The PxA, PxB, PxC and PxD outputs are multiplexed with the port data latches. The associated TRIS bits must be cleared to configure the PxA, PxB, PxC and PxD pins as outputs.



#### 查询PIC18F86K90供应商

#### FIGURE 19-9: EXAMPLE OF FULL-BRIDGE PWM OUTPUT



#### 查询PIC18F86K90供应商

19.4.2.1 Direction Change in Full-Bridge Mode

In the Full-Bridge mode, the PxM1 bit in the CCPxCON register allows users to control the forward/reverse direction. When the application firmware changes this direction control bit, the module will change to the new direction on the next PWM cycle.

A direction change is initiated in software by changing the PxM1 bit of the CCPxCON register. The following sequence occurs prior to the end of the current PWM period:

- The modulated outputs (PxB and PxD) are placed in their inactive state.
- The associated unmodulated outputs (PxA and PxC) are switched to drive in the opposite direction.
- PWM modulation resumes at the beginning of the next period.

For an illustration of this sequence, see Figure 19-10.

The Full-Bridge mode does not provide a dead-band delay. As one output is modulated at a time, a dead-band delay is generally not required. There is a situation where a dead-band delay is required. This situation occurs when both of the following conditions are true:

- The direction of the PWM output changes when the duty cycle of the output is at or near 100%.
- The turn-off time of the power switch, including the power device and driver circuit, is greater than the turn-on time.

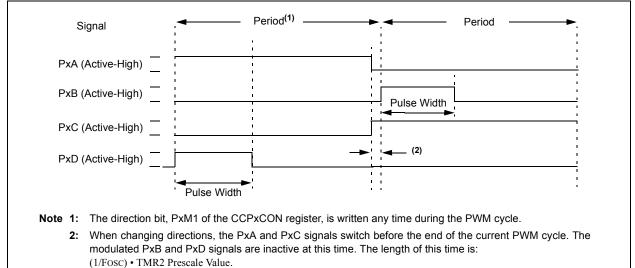
Figure 19-11 shows an example of the PWM direction changing from forward to reverse, at a near 100% duty cycle. In this example, at time, t1, the PxA and PxD outputs become inactive, while the PxC output becomes active. Since the turn-off time of the power devices is longer than the turn-on time, a shoot-through current will flow through power devices, QC and QD (see Figure 19-8), for the duration of 't'. The same phenomenon will occur to power devices, QA and QB, for PWM direction change from reverse to forward.

If changing PWM direction at high duty cycle is required for an application, two possible solutions for eliminating the shoot-through current are:

- Reduce PWM duty cycle for one PWM period before changing directions.
- Use switch drivers that can drive the switches off faster than they can drive them on.

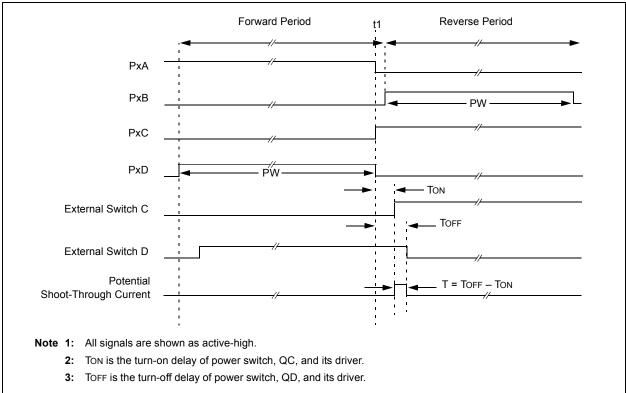
Other options to prevent shoot-through current may exist.

#### FIGURE 19-10: EXAMPLE OF PWM DIRECTION CHANGE



#### 查询PIC18F86K90供应商

#### FIGURE 19-11: EXAMPLE OF PWM DIRECTION CHANGE AT NEAR 100% DUTY CYCLE



#### 19.4.3 START-UP CONSIDERATIONS

When any PWM mode is used, the application hardware must use the proper external pull-up and/or pull-down resistors on the PWM output pins.

Note:	When the microcontroller is released from Reset, all of the I/O pins are in the High-Impedance state. The external circuits must keep the power switch devices in the OFF state until the micro- controller drives the I/O pins with the proper signal levels or activates the PWM
	output(s).

The CCPxM<1:0> bits of the CCPxCON register allow the user to choose whether the PWM output signals are active-high or active-low for each pair of PWM output pins (PxA/PxC and PxB/PxD). The PWM output polarities must be selected before the PWM pin output drivers are enabled. Changing the polarity configuration while the PWM pin output drivers are enabled is not recommended since it may result in damage to the application circuits.

The PxA, PxB, PxC and PxD output latches may not be in the proper states when the PWM module is initialized. Enabling the PWM pin output drivers at the same time as the Enhanced PWM modes may cause damage to the application circuit. The Enhanced PWM modes must be enabled in the proper Output mode and complete a full PWM cycle before enabling the PWM pin output drivers. The completion of a full PWM cycle is indicated by the TMR2IF or TMR4IF bit of the PIR1 or PIR5 register being set as the second PWM period begins.

#### 19.4.4 ENHANCED PWM AUTO-SHUTDOWN MODE

The PWM mode supports an Auto-Shutdown mode that will disable the PWM outputs when an external shutdown event occurs. Auto-Shutdown mode places the PWM output pins into a predetermined state. This mode is used to help prevent the PWM from damaging the application.

The auto-shutdown sources are selected using the ECCPxAS<2:0> bits (ECCPxAS<6:4>). A shutdown event may be generated by:

- A logic '0' on the pin that is assigned the FLT0 input function
- Comparator C1
- Comparator C2
- · Setting the ECCPxASE bit in firmware

A shutdown condition is indicated by the ECCPxASE (Auto-Shutdown Event Status) bit (ECCPxAS<7>). If the bit is a '0', the PWM pins are operating normally. If the bit is a '1', the PWM outputs are in the shutdown state.

#### 查询PIC18F86K90供应商

When a shutdown event occurs, two things happen:

- The ECCPxASE bit is set to '1'. The ECCPxASE will remain set until cleared in firmware or an auto-restart occurs. (See Section 19.4.5 "Auto-Restart Mode".)
- The enabled PWM pins are asynchronously placed in their shutdown states. The PWM output pins are grouped into pairs: PxA/PxC and PxB/PxD. The state of each pin pair is determined by the PSSxAC and PSSxBD bits (ECCPxAS<3:2> and <1:0>, respectively).

Each pin pair may be placed into one of three states:

- Drive logic '1'
- Drive logic '0'
- Tri-state (high-impedance)

#### REGISTER 19-3: ECCPxAS: ECCPx AUTO-SHUTDOWN CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ECCPxASE	ECCPxAS2	ECCPxAS1	ECCPxAS0	PSSxAC1	PSSxAC0	PSSxBD1	PSSxBD0	
bit 7 bit 0								

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	ECCPxASE: ECCP Auto-Shutdown Event Status bit 1 = A shutdown event has occurred; ECCP outputs are in a shutdown state 0 = ECCP outputs are operating
bit 6-4	ECCPxAS<2:0>: ECCP Auto-Shutdown Source Select bits 000 = Auto-shutdown is disabled 001 = Comparator C1OUT output is high 010 = Comparator C2OUT output is high 011 = Either Comparator C1OUT or C2OUT is high 100 = ViL on FLT0 pin 101 = ViL on FLT0 pin or Comparator C1OUT output is high 110 = ViL on FLT0 pin or Comparator C2OUT output is high 111 = ViL on FLT0 pin, Comparator C1OUT or Comparator C2OUT is high
bit 3-2	PSSxAC<1:0>: Pins PxA and PxC Shutdown State Control bits 00 = Drive the PxA and PxC pins to '0' 01 = Drive the PxA and PxC pins to '1' 1x = PxA and PxC pins tri-state
bit 1-0	PSSxBD<1:0>: Pins PxB and PxD Shutdown State Control bits 00 = Drive the PxB and PxD pins to '0' 01 = Drive the PxB and PxD pins to '1' 1x = PxB and PxD pins tri-state
Note:	The auto-shutdown condition is a level-based signal, not an edge-based signal. As long as the level i present, the auto-shutdown will persist.

Writing to the ECCPxASE bit is disabled while an auto-shutdown condition persists. Once the auto-shutdown condition has been removed and the PWM restarted (either through firmware or auto-restart), the PWM signal will always restart at the beginning of the next PWM period.

is

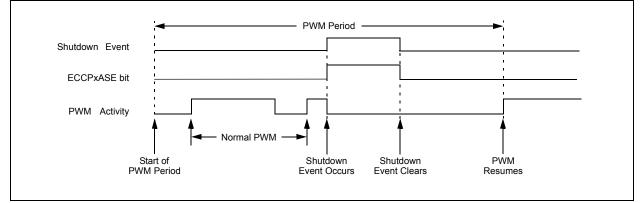
#### 查询PIC18F86K90供应商 **FIGURE 19-12:** PWM AUTO-SHUTDOWN WITH FIRMWARE RESTART (PxRSEN = 0) PWM Period Shutdown Event ECCPxASE bit PWM Activity Normal PWM ECCPXASE Cleared by Firmware PWM Start of Shutdown Shutdown Event Occurs Event Clears PWM Period Resumes

#### 19.4.5 AUTO-RESTART MODE

The Enhanced PWM can be configured to automatically restart the PWM signal once the auto-shutdown condition has been removed. Auto-restart is enabled by setting the PxRSEN bit (ECCPxDEL<7>).

If auto-restart is enabled, the ECCPxASE bit will remain set as long as the auto-shutdown condition is active. When the auto-shutdown condition is removed, the ECCPxASE bit will be cleared via hardware and normal operation will resume. The module will wait until the next PWM period begins, however, before re-enabling the output pin. This behavior allows the auto-shutdown with auto-restart features to be used in applications based on current mode of PWM control.

#### FIGURE 19-13: PWM AUTO-SHUTDOWN WITH AUTO-RESTART ENABLED (PxRSEN = 1)



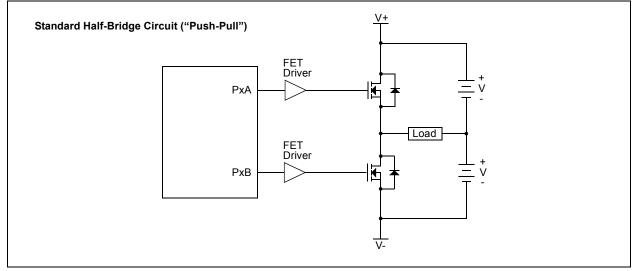
#### 查询PIC18F86K90供应商 19.4.6 PROGRAMMABLE DEAD-BAND DELAY MODE

In half-bridge applications, where all power switches are modulated at the PWM frequency, the power switches normally require more time to turn off than to turn on. If both the upper and lower power switches are switched at the same time (one turned on and the other turned off), both switches may be on for a short period until one switch completely turns off. During this brief interval, a very high current (shoot-through current) will flow through both power switches, shorting the bridge supply. To avoid this potentially destructive shoot-through current from flowing during switching, turning on either of the power switches is normally delayed to allow the other switch to completely turn off.

In Half-Bridge mode, a digitally programmable dead-band delay is available to avoid shoot-through current from destroying the bridge power switches. The delay occurs at the signal transition from the non-active state to the active state. For an illustration, see Figure 19-14. The lower seven bits of the associated ECCPxDEL register (Register 19-4) set the delay period in terms of microcontroller instruction cycles (TcY or 4 Tosc).

#### FIGURE 19-14: EXAMPLE OF HALF-BRIDGE PWM OUTPUT Period Period Pulse Width PxA<sup>(2)</sup> td I PxB<sup>(2)</sup> (1) (1) (1) td = Dead-Band Delay Note 1: At this time, the TMR2 register is equal to the PR2 register. 2: Output signals are shown as active-high.

#### FIGURE 19-15: EXAMPLE OF HALF-BRIDGE APPLICATIONS



#### 查询PIC18F86K90供应商

#### REGISTER 19-4: ECCPxDEL: ENHANCED PWM CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PxRSEN	PxDC6	PxDC5	PxDC4	PxDC3	PxDC2	PxDC1	PxDC0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 PxRSEN: PWM Restart Enable bit

1 = Upon auto-shutdown, the ECCPxASE bit clears automatically once the shutdown event goes away; the PWM restarts automatically

0 = Upon auto-shutdown, ECCPxASE must be cleared by software to restart the PWM

bit 6-0 PxDC<6:0>: PWM Delay Count bits

PxDCn = Number of Fosc/4 (4 \* Tosc) cycles between the scheduled time when a PWM signal **should** transition active and the **actual** time it does transition active.

#### 19.4.7 PULSE STEERING MODE

In Single Output mode, pulse steering allows any of the PWM pins to be the modulated signal. Additionally, the same PWM signal can simultaneously be available on multiple pins.

Once the Single Output mode is selected (CCPxM<3:2> = 11 and PxM<1:0> = 00 of the CCPxCON register), the user firmware can bring out the same PWM signal to one, two, three or four output pins by setting the appropriate STR<D:A> bits (PSTRxCON<3:0>), as provided in Table 19-3.

Note: The associated TRIS bits must be set to output ('0') to enable the pin output driver in order to see the PWM signal on the pin.

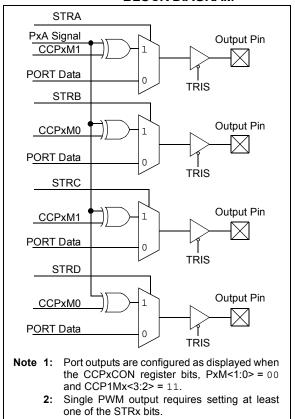
While the PWM Steering mode is active, the CCPxM<1:0> bits (CCPxCON<1:0>) select the PWM output polarity for the Px<D:A> pins.

The PWM auto-shutdown operation also applies to the PWM Steering mode, as described in **Section 19.4.4 "Enhanced PWM Auto-shutdown mode"**. An auto-shutdown event will only affect pins that have PWM outputs enabled.

#### 查询PIC18F86K90供应商 REGISTER 19-5: PSTRxCON: PULSE STEERING CONTROL<sup>(1)</sup> R/W-0 R/W-0 U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-1 CMPL1 CMPL0 STRSYNC STRD STRC STRB STRA bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7-6 CMPL<1:0>: Complementary Mode Output Assignment Steering Sync bits 00 = See STRD:STRA 01 = PA and PB are selected as the complementary output pair 10 = PA and PC are selected as the complementary output pair 11 = PA and PD are selected as the complementary output pair bit 5 Unimplemented: Read as '0' bit 4 STRSYNC: Steering Sync bit 1 = Output steering update occurs on the next PWM period 0 = Output steering update occurs at the beginning of the instruction cycle boundary STRD: Steering Enable bit D bit 3 1 = PxD pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxD pin is assigned to a port pin bit 2 STRC: Steering Enable bit C 1 = PxC pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxC pin is assigned to a port pinbit 1 STRB: Steering Enable bit B 1 = PxB pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxB pin is assigned to a port pin STRA: Steering Enable bit A bit 0 1 = PxA pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxA pin is assigned to a port pin

Note 1: The PWM Steering mode is available only when the CCPxCON register bits, CCPxM<3:2> = 11 and PxM<1:0> = 00.

#### 查询PIC18F86K90供应商 FIGURE 19-16: SIMPLIFIED STEERING BLOCK DIAGRAM



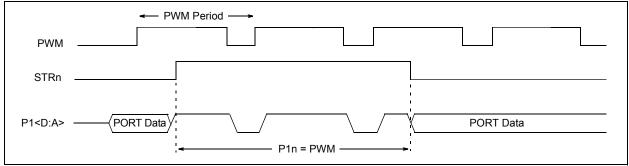
#### 19.4.7.1 Steering Synchronization

The STRSYNC bit of the PSTRxCON register gives the user two choices for when the steering event will happen. When the STRSYNC bit is '0', the steering event will happen at the end of the instruction that writes to the PSTRxCON register. In this case, the output signal at the Px<D:A> pins may be an incomplete PWM waveform. This operation is useful when the user firmware needs to immediately remove a PWM signal from the pin.

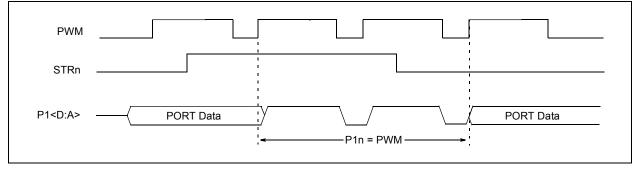
When the STRSYNC bit is '1', the effective steering update will happen at the beginning of the next PWM period. In this case, steering on/off the PWM output will always produce a complete PWM waveform.

Figures 19-17 and 19-18 illustrate the timing diagrams of the PWM steering depending on the STRSYNC setting.

#### FIGURE 19-17: EXAMPLE OF STEERING EVENT AT END OF INSTRUCTION (STRSYNC = 0)



#### FIGURE 19-18: EXAMPLE OF STEERING EVENT AT BEGINNING OF INSTRUCTION (STRSYNC = 1)



#### 查询PIC18F86K90供应商

#### 19.4.8 OPERATION IN POWER-MANAGED MODES

In Sleep mode, all clock sources are disabled. Timer2/4/6/8 will not increment and the state of the module will not change. If the ECCPx pin is driving a value, it will continue to drive that value. When the device wakes up, it will continue from this state. If Two-Speed Start-ups are enabled, the initial start-up frequency from HF-INTOSC and the postscaler may not be stable immediately.

In PRI\_IDLE mode, the primary clock will continue to clock the ECCPx module without change.

#### 19.4.8.1 Operation with Fail-Safe Clock Monitor (FSCM)

If the Fail-Safe Clock Monitor (FSCM) is enabled, a clock failure will force the device into the power-managed RC\_RUN mode and the OSCFIF bit of the PIR2/4/6/8 register will be set. The ECCPx will then be clocked from the internal oscillator clock source, which may have a different clock frequency than the primary clock.

#### 19.4.9 EFFECTS OF A RESET

Both Power-on Reset and subsequent Resets will force all ports to Input mode and the ECCP registers to their Reset states.

This forces the ECCP module to reset to a state compatible with previous, non-enhanced CCP modules used on other PIC18 and PIC16 devices.

### 查询PIC18F86K90供应商 TABLE 19-4: REGISTERS ASSOCIATED WITH ECCP1/2/3 MODULE AND TIMER1/2/3/4/6/8/10/12

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:		
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73		
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74		
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75		
PIR4	CCP10IF <sup>(1)</sup>	CCP9IF <sup>(1)</sup>	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75		
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75		
PIE4	CCP10IE <sup>(1)</sup>										
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75 75		
IPR4	CCP10IP <sup>(1)</sup>	CCP9IP <sup>(1)</sup>	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75		
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76		
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76		
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76		
TRISH <sup>(2)</sup>	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76		
TMR1H	Timer1 Regist								74		
TMR1L	Timer1 Regist								74		
TMR2	Timer2 Regist								74		
TMR3H	Timer3 Regist								75		
TMR3L	Timer3 Regist								75		
TMR4	Timer4 Register								80		
TMR6	Timer6 Register								79		
TMR8	Timer8 Register								79		
TMR10	TMR10 Register								79		
TMR12	TMR10 Register								79		
PR2	Timer2 Period								74		
PR4	Timer4 Period	-							80		
PR6	Timer6 Period	-							79		
PR8	Timer8 Period	-							79		
PR10	Timer10 Perio	-							79		
PR12	Timer12 Perio								79		
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	74		
T2CON	_		T2OUTPS2		T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	74		
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	75		
T4CON		T4OUTPS3		T4OUTPS1	T4OUTPS0			T4CKPS0	80		
T6CON		T6OUTPS3		T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	79		
T8CON		T8OUTPS3		T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	79		
T10CON			T100UTPS2		T10OUTPS0	TMR10ON	T10CKPS1	T10CKPS0	79		
T12CON			T120UTPS2		T12OUTPS0	TMR120N	T12CKPS1	T12CKPS0	79		
	Capture/Com				1120011 00	1101112011	1120101	112014-00	75		
CCPR1L									75		
CCPR2H									78		
	Capture/Com								78		
CCPR3H	Capture/Com								78		
CCPR3H CCPR3L	Capture/Comp		8 8	,					78		
CCPRSL CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	78		
CCP2CON	P2M1	P1M0 P2M0	DC1B1 DC2B1	DC1B0 DC2B0	CCP1M3 CCP2M3	CCP1M2 CCP2M2	CCP1M1 CCP2M1	CCP1M0 CCP2M0	75		
CCP2CON CCP3CON	P2M1 P3M1	P21010 P3M0	DC2B1 DC3B1	DC2B0 DC3B0	CCP2M3 CCP3M3	CCP2M2 CCP3M2	CCP2M1 CCP3M1	CCP2M0 CCP3M0	78		
					of 32 Kbytes (			OUF JIVIU	10		

2: Unimplemented on PIC18F6XK90 devices.

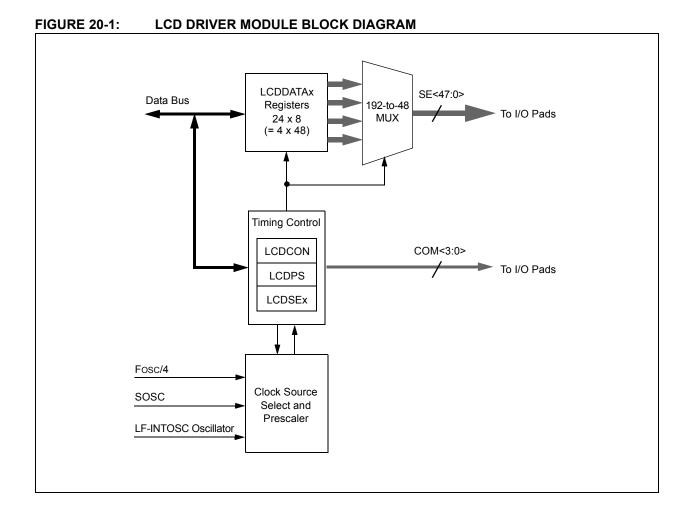
#### 查询PIC18F86K90供应商 20.0 LIQUID CRYSTAL DISPLAY (LCD) DRIVER MODULE

The Liquid Crystal Display (LCD) driver module generates the timing control to drive a static or multiplexed LCD panel. In the 80-pin devices (PIC18F8XK90), the module drives the panels of up to four commons and up to 48 segments and in the 64-pin devices (PIC18F6XK90), the module drives the panels of up to four commons and up to 33 segments. It also provides control of the LCD pixel data.

The LCD driver module supports:

- Direct driving of LCD panel
- · Three LCD clock sources with selectable prescaler
- Up to four commons:
  - Static (One common)
  - 1/2 multiplex (two commons)
  - 1/3 multiplex (three commons)
  - 1/4 multiplex (four commons)
- Up to 48 (in 80-pin devices), 32 (in 64-pin devices) segments
- Static, 1/2 or 1/3 LCD bias
- Internal resistors for bias voltage generation
- Software contrast control for LCD using the internal biasing

A simplified block diagram of the module is shown in Figure 20-1.



© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商 20.1 LCD Registers

The LCD driver module has 32 registers:

- LCD Control Register (LCDCON)
- LCD Phase Register (LCDPS)
- LCD Reference Ladder Register (LCDRL)
- LCD Reference Voltage Control Register (LCDREF)
- Six LCD Segment Enable Registers (LCDSE5:LCDSE0)
- 24 LCD Data Registers (LCDDATA23:LCDDATA0)

The LCDCON register, shown in Register 20-1, controls the overall operation of the module. Once the module is configured, the LCDEN (LCDCON<7>) bit is used to enable or disable the LCD module. The LCD panel can also operate during Sleep by clearing the SLPEN (LCDCON<6>) bit.

The LCDPS register, shown in Register 20-2, configures the LCD clock source prescaler and the type of waveform, Type-A or Type-B. For details on these features, see Section 20.2 "LCD Clock Source Selection", Section 20.3 "LCD Bias Types" and Section 20.8 "LCD Waveform Generation".

#### REGISTER 20-1: LCDCON: LCD CONTROL REGISTER

R/W-0	R/W-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0
bit 7							bit 0

Legend:	C = Clearable bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7	LCDEN: LCD Driver Enable bit 1 = LCD driver module is enabled 0 = LCD driver module is disabled
bit 6	<b>SLPEN:</b> LCD Driver Enable in Sleep mode bit 1 = LCD driver module is disabled in Sleep mode 0 = LCD driver module is enabled in Sleep mode
bit 5	WERR: LCD Write Failed Error bit 1 = LCDDATAx register is written while WA (LCDPS<4>) = 0 (must be cleared in software) 0 = No LCD write error
bit 4	Unimplemented: Read as '0'
bit 3-2	<b>CS&lt;1:0&gt;:</b> Clock Source Select bits 00 = (Fosc/4)/8192 01 = SOSC oscillator/32 1x = INTRC (31.25 kHz)/32
bit 1-0	LMUX<1:0>: Commons Select bits

LMUX<1:0>	Multiplex	Maximum Number of Pixels (PIC18F6X90)	Maximum Number of Pixels (PIC18F8X90)	Bias
00	Static (COM0)	33	48	Static
01	1/2 (COM<1:0>)	66	96	1/2 or 1/3
10	1/3 (COM<2:0>)	99	144	1/2 or 1/3
11	1/4 (COM<3:0>)	132	192	1/3

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0			
WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0			
bit 7						ł	k			
Legend:										
R = Readab	ole bit	W = Writable	bit	U = Unimpler	nented bit, rea	ad as '0'				
-n = Value a	It POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkn	iown			
bit 7		orm Type Selec								
		aveform (phase aveform (phase								
bit 6	BIASMD: Bia	as Mode Select	bit							
	When LMUX									
		s mode (do not	set this bit to '	1')						
	When LMUX									
	1 = 1/2 Bias I									
	0 = 1/3  Bias mode									
	<u>When LMUX&lt;1:0&gt; = 10:</u> 1 = 1/2 Bias mode									
	0 = 1/3 Bias mode									
	When LMUX 0 = 1/3 Bias	<u>&lt;1:0&gt; = 11:</u> node (do not se	et this bit to '1')	)						
bit 5	LCDA: LCD	Active Status bi	t							
	1 = LCD drive	er module is ac	tive							
	0 = LCD drive	er module is ina	ictive							
bit 4	WA: LCD Wr	ite Allow Status	bit							
		the LCDDATA the LCDDATA								
bit 3-0	LP<3:0>: LC	D Prescaler Se	lect bits							
	1111 <b>= 1:16</b>									
	1110 = 1:15									
	1101 = 1:14 1100 = 1:13									
	1100 = 1:13 1011 = 1:12									
	1010 = 1:11									
	1001 = 1:10									
	1000 = 1:9									
	0111 = 1:8 0110 = 1:7									
	0101 = 1.6									
	0100 = 1:5									
	0011 = 1:4									
	0010 = 1:3 0001 = 1:2									
	0001 = 1.2									

查询PIC18F86K90供应商 REGISTER 20-3: LCDREF: LCD REFERENCE VOLTAGE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
LCDIRE	LCDIRS	LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE			
bit 7							bit (			
Legend:										
R = Readabl	e bit	W = Writable	bit	U = Unimplen	nented bit, rea	d as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unki	nown			
bit 7	LCDIRE: LC	D Internal Refe	ence Enable	bit						
		LCD reference LCD reference		d connected to	the internal co	ntrast control c	ircuit			
bit 6	<u>If LCDIRE =</u> 1 = Internal L	D Internal Refe <u>1:</u> .CD contrast co .CD contrast co	ntrol is power	ed by VDDCORE	e (3.3V) voltage	e				
	If LCDIRE =			·	gap buffer is d	isabled.				
bit 5-3	LCDCST<2:0>: LCD Contrast Control bits									
	111 = Resis 110 = Resis 101 = Resis 100 = Resis 011 = Resis 010 = Resis 001 = Resis	esistance of the tor ladder is at tor ladder is at	maximum resi 6/7th of maxin 5/7th of maxin 4/7th of maxin 3/7th of maxin 2/7th of maxin 1/7th of maxin	istance (minimu num resistance num resistance num resistance num resistance num resistance num resistance	ım contrast)	ted				
bit 2	1 = Bias 3 le	Bias 3 Pin Enab vel is connecteo vel is internal (ii	to the extern		S3					
bit 1	1 = Bias 2 le	Bias 2 Pin Enab vel is connecteo vel is internal (ii	to the extern		S2					
bit 0	<ul> <li>0 = Bias 2 level is internal (internal resistor ladder)</li> <li>VLCD1PE: Bias 1 Pin Enable bit</li> <li>1 = Bias 1 level is connected to the external pin, LCDBIAS1</li> <li>0 = Bias 1 level is internal (internal resistor ladder)</li> </ul>									

#### 查询PIC18F86K90供应商 REGISTER 20-4: LCDRL: LCD REFERENCE LADDER CONTROL REGISTER R/W-0 R/W-0 R/W-0 R/W-0 U-0 R/W-0 R/W-0 R/W-0 (1) LRLAP1 LRLAP0 LRLBP1 LRLBP0 LRLAT2 LRLAT1 LRLAT0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7-6 LRLAP<1:0>: LCD Reference Ladder A Time Power Control bits During Time Interval A: 11 = Internal LCD reference ladder is powered in High-Power mode 10 = Internal LCD reference ladder is powered in Medium Power mode 01 = Internal LCD reference ladder is powered in Low-Power mode 00 = Internal LCD reference ladder is powered down and unconnected bit 5-4 LRLBP<1:0>: LCD Reference Ladder B Time Power Control bits During Time Interval B: 11 = Internal LCD reference ladder is powered in High-Power mode 10 = Internal LCD reference ladder is powered in Medium Power mode 01 = Internal LCD reference ladder is powered in Low-Power mode 00 = Internal LCD reference ladder is powered down and unconnected Unimplemented: Read as '0'(1) bit 3 bit 2-0 LRLAT<2:0>: LCD Reference Ladder A Time Interval Control bits Sets the number of 32 clock counts when the A Time Interval Power mode is active. For Type-A Waveforms (WFT = 0): 000 = Internal LCD reference ladder is always in B Power mode 001 = Internal LCD reference ladder is in A Power mode for 1 clock and B Power mode for 15 clocks 010 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 14 clocks 011 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 13 clocks 100 = Internal LCD reference ladder is in A Power mode for 4 clocks and B Power mode for 12 clocks 101 = Internal LCD reference ladder is in A Power mode for 5 clocks and B Power mode for 11 clocks 110 = Internal LCD reference ladder is in A Power mode for 6 clocks and B Power mode for 10 clocks 111 = Internal LCD reference ladder is in A Power mode for 7 clocks and B Power mode for 9 clocks For Type-B Waveforms (WFT = 1): 000 = Internal LCD reference ladder is always in B Power mode 001 = Internal LCD reference ladder is in A Power mode for 1 clock and B Power mode for 31 clocks 010 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 30 clocks 011 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 29 clocks 100 = Internal LCD reference ladder is in A Power mode for 4 clocks and B Power mode for 28 clocks 101 = Internal LCD reference ladder is in A Power mode for 5 clocks and B Power mode for 27 clocks 110 = Internal LCD reference ladder is in A Power mode for 6 clocks and B Power mode for 26 clocks 111 = Internal LCD reference ladder is in A Power mode for 7 clocks and B Power mode for 25 clocks

#### **Note 1:** LCDRL<3> should be maintained as '0'.

#### 查询PIC18F86K90供应商

The LCDSE5:LCDSE0 registers configure the functions of the port pins. Setting the segment enable bit for a particular segment configures that pin as an LCD driver. There are six LCD Segment Enable registers, as shown in Table 20-1. The prototype LCDSEx register is shown in Register 20-5.

#### TABLE 20-1: LCDSE REGISTERS AND ASSOCIATED SEGMENTS

Register	Segments
LCDSE0	7:0 (RD<7:0>)
LCDSE1	15:8 (RA<5:4>, RC2, RC5, RB<4:1>)
LCDSE2	23:16 (RF<5:1>, RA1, RC<4:3>)
LCDSE3	31:24 (RE7, RB0, RB5, RC<7:6>, RG4, RF<7:6>)
LCDSE4	39:32 (RJ<4:7>, RJ<3:1>, RC1)
LCDSE5	47:40 (RH<0:3>, RH<7:4>)

Note:	The LCDSE5:LCDSE4 registers are not
	implemented in PIC18F6XK90 devices.

Once the module is initialized for the LCD panel, the individual bits of the LCDDATA23:LCDDATA0 registers are cleared or set to represent a clear or dark pixel, respectively.

Specific sets of LCDDATA registers are used with specific segments and common signals. Each bit represents a unique combination of a specific segment connected to a specific common.

Individual LCDDATA bits are named by the convention, "SxxCy", with "xx" as the segment number and "y" as the common number. The relationship is summarized in Table 20-2. The prototype LCDDATAx register is shown in Register 20-6.

Note:	In PIC18F6XK90 devices, writing into the						
	registers, LCDDATA4, LCDDATA5,						
	LCDDATA10, LCDDATA11, LCDDATA16,						
	LCDDATA17, LCDDATA22 and						
	LCDDATA23, will not affect the status of						
	any pixel. These registers can be used as						
	general purpose registers.						

#### REGISTER 20-5: LCDSEx: LCD SEGMENTx ENABLE REGISTER

R/W-0	R/W-0						
SE(n + 7)	SE(n + 6)	SE(n + 5)	SE(n + 4)	SE(n + 3)	SE(n + 2)	SE(n + 1)	SE(n)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 SE(n + 7):SE(n): Segment Enable bits For LCDSE0: n = 0 For LCDSE1: n = 8 For LCDSE2: n = 16 For LCDSE3: n = 24 For LCDSE4: n = 32 For LCDSE5: n = 40 1 = Segment function of the pin is enabled, digital I/O is disabled 0 = I/O function of the pin is enabled

#### 查询PIC18F86K90供应商 TABLE 20-2: LCDDATA REGISTERS AND BITS FOR SEGMENT AND COM COMBINATIONS

Segments	COM Lines				
	0	1	2	3	
	LCDDATA0	LCDDATA6	LCDDATA12	LCDDATA18	
0 through 7	S00C0:S07C0	S00C1:S07C1	S00C2:S07C2	S00C3:S07C3	
9 through 15	LCDDATA1	LCDDATA7	LCDDATA13	LCDDATA19	
8 through 15	S08C0:S15C0	S08C1:S15C1	S08C2:S15C2	S08C0:S15C3	
16 through 22	LCDDATA2	LCDDATA8	LCDDATA14	LCDDATA20	
16 through 23	S16C0:S23C0	S16C1:S23C1	S16C2:S23C2	S16C3:S23C3	
24 through 31	LCDDATA3	LCDDATA9	LCDDATA15	LCDDATA21	
	S24C0:S31C0	S24C1:S31C1	S24C2:S31C2	S24C3:S31C3	
32 through 39	LCDDATA4 <sup>(1)</sup>	LCDDATA10 <sup>(1)</sup>	LCDDATA16 <sup>(1)</sup>	LCDDATA22 <sup>(1)</sup>	
	S32C0:S39C0	S32C1:S39C1	S32C2:S39C2	S32C3:S39C3	
40 through 47	LCDDATA5 <sup>(2)</sup>	LCDDATA11 <sup>(2)</sup>	LCDDATA17 <sup>(2)</sup>	LCDDATA23 <sup>(2)</sup>	
	S40C0:S47C0	S40C1:S47C1	S40C2:S47C2	S40C3:S47C3	

**Note 1:** Bits<7:1> of these registers are not implemented in PIC18F6XK90 devices. Bit 0 of these registers (SEG32Cy) is always implemented.

2: These registers are not implemented in PIC18F6XK90 devices.

#### REGISTER 20-6: LCDDATAX: LCD DATAX REGISTER

R/W-0	R/W-0						
S(n + 7)Cy	S(n + 6)Cy	S(n + 5)Cy	S(n + 4)Cy	S(n + 3)Cy	S(n + 2)Cy	S(n + 1)Cy	S(n)Cy
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0	S(n + 7)Cy:S(n)Cy: Pixel On bits
	For registers, LCDDATA0 through LCDDATA5: n = (8x), y = 0
	<u>For registers, LCDDATA6 through LCDDATA11: n = (8(x – 6)), y = 1</u>
	<u>For registers, LCDDATA12 through LCDDATA17: n = (8(x – 12)), y = 2</u>
	For registers, LCDDATA18 through LCDDATA23: n = (8(x – 18)), y = 3
	1 = Pixel on (dark) 0 = Pixel off (clear)

#### <u>查询PIC18F86K90供应商</u> 20.2 LCD Clock Source Selection

The LCD driver module has three possible clock sources:

- (Fosc/4)/8192
- SOSC Clock/32
- INTRC/32

The first clock source is the system clock divided by 8,192 ((Fosc/4)/8192). This divider ratio is chosen to provide about 1 kHz output when the system clock is 8 MHz. The divider is not programmable. Instead, the LCD prescaler bits, LCDPS<3:0>, are used to set the LCD frame clock rate.

The second clock source is the SOSC oscillator/32. This also outputs about 1 kHz when a 32.768 kHz crystal is used with the SOSC oscillator. To use the SOSC oscillator as a clock source, set the SOSCEN (T1CON<3>) bit.

The third clock source is a 31.25 kHz internal RC oscillator/32 that provides approximately 1 kHz output.

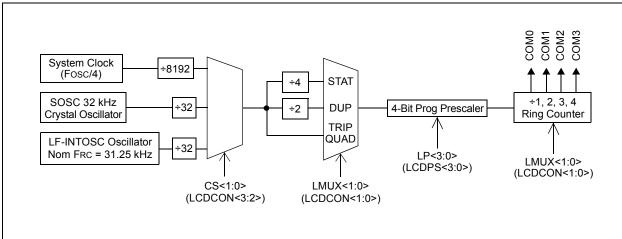
The second and third clock sources may be used to continue running the LCD while the processor is in Sleep.

These clock sources are selected through the bits CS<1:0> (LCDCON<3:2>).

#### 20.2.1 LCD PRESCALER

A 16-bit counter is available as a prescaler for the LCD clock. The prescaler is not directly readable or writable. Its value is set by the LP<3:0> bits (LCDPS<3:0>) that determines the prescaler assignment and prescale ratio.

Selectable prescale values are from 1:1 through 1:32,768, in power-of-2 increments.



#### FIGURE 20-2: LCD CLOCK GENERATION

#### 查询PIC18F86K90供应商 20.3 LCD Bias Types

The LCD module can be configured in one of three bias types:

- Static bias (two voltage levels: Vss and VDD)
- 1/2 bias (three voltage levels: Vss, 1/2 VDD and VDD)
- 1/3 bias (four voltage levels: Vss, 1/3 VDD, 2/3 VDD and VDD)

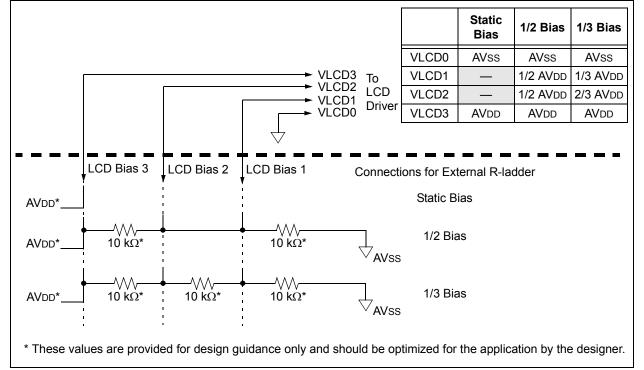
LCD bias voltages can be generated with an internal or external resistor ladder. The internal resistor ladder eliminates the external solution's use of up to three pins. If the internal reference ladder is used to generate bias voltages, it also can provide software contrast control (using LCDCST<2:0>). An external resistor ladder can not do this.

#### 20.3.1 EXTERNAL RESISTOR BIASING

The external resistor ladder should be connected to the VLCD1 pin (Bias 1), VLCD2 pin (Bias 2), VLCD3 pin (Bias 3) and Vss. The VLCD3 pin is used to set the highest voltage to the LCD glass and can be connected to VDD or a lower voltage.

Figure 20-3 shows the proper way to connect the resistor ladder to the Bias pins.





#### 查询PIC18F86K90供应商 20.3.2 INTERNAL RESISTOR BIASING

This mode does not use external resistors, but rather internal resistor ladders that are configured to generate the bias voltage.

The internal reference ladder actually consists of three separate ladders. Disabling the internal reference ladder disconnects all of the ladders, allowing external voltages to be supplied.

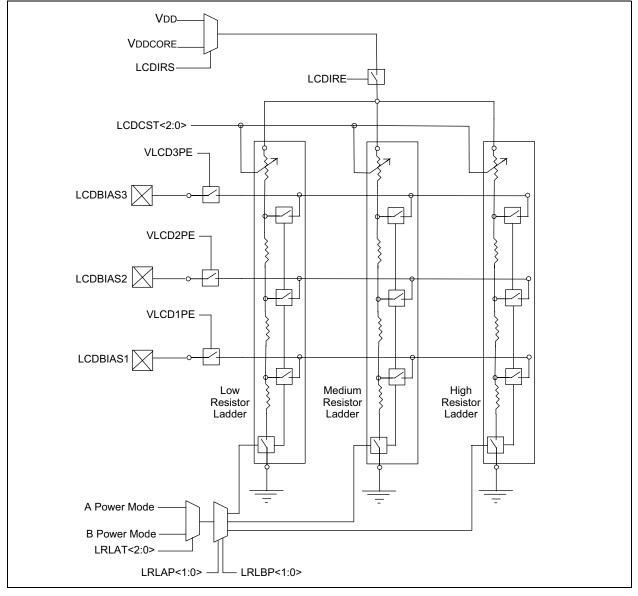
Depending on the total resistance of the resistor ladders, the biasing can be classified as low, medium or high power.

Table 20-3 shows the total resistance of each of the ladders. Figure 20-4 shows the internal resister ladder connections. When the internal resistor ladder is selected, the bias voltage can either be from VDD or from VDDCORE, depending on the LCDIRS setting.

#### TABLE 20-3: INTERNAL RESISTANCE LADDER POWER MODES

Power Mode	Nominal Resistance of Entire Ladder	IDD
Low	<b>3</b> ΜΩ	1 μA
Medium	300 kΩ	10 μA
High	30 kΩ	100 μA

#### FIGURE 20-4: LCD BIAS INTERNAL RESISTOR LADDER CONNECTION DIAGRAM



#### 查询PIC18F86K90供应商

There are two power modes designated as "Mode A" and "Mode B". Mode A is set by the bits, LRLAP<1:0> and Mode B by LRLB<1:0>. The resistor ladder to use for Modes A and B are selected by the bits, LRLAP<1:0> and LRLBP<1:0>, respectively

Each ladder has a matching contrast control ladder, tuned to the nominal resistance of the reference ladder. This contrast control resistor can be controlled by LCDREF<5:3> (LCDCST<2:0>). Disabling the internal reference ladder results in all of the ladders being disconnected, allowing external voltages to be supplied.

To get additional current in High-Power mode, when LCDRL<7:6> (LRLAP<1:0>) = 11, both the medium and high-power resistor ladders are activated.

Whenever the LCD module is inactive (LCDA (LCDPS < 5>) = 0), the reference ladder will be turned off.

#### 20.3.2.1 Automatic Power Mode Switching

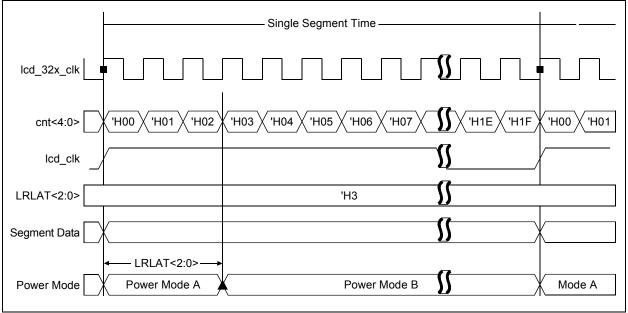
As an LCD segment is electrically only a capacitor, current is drawn only during the interval when the voltage is switching. To minimize total device current, the LCD reference ladder can be operated in a different power mode for the transition portion of the duration. This is controlled by the LCDRL register.

Mode A Power mode is active for a programmable time, beginning at the time when the LCD segment waveform is transitioning. The LCDRL<2:1> (LRLAT<2:0>) bits select how long, or if the Mode A is active. Mode B Power mode is active for the remaining time before the segments or commons change again.

As shown in Figure 20-5, there are 32 counts in a single segment time. Type-A can be chosen during the time when the wave form is in transition. Type-B can be used when the clock is stable or not in transition.

By using this feature of automatic power switching, using Type-A/Type-B, the power consumption can be optimized for a given contrast.

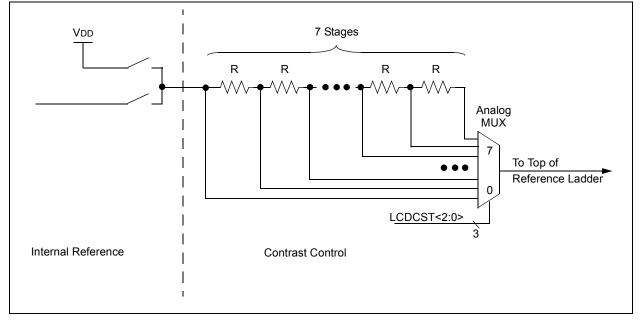




#### 查询PIC18F86K90供应商 20.3.2.2 Contrast Control

The LCD contrast control circuit consists of a 7-tap resistor ladder, controlled by the LCDCST bits (see Figure 20-6.).





### 查询PIC18F86K90供应商

#### 20.3.2.3 Internal Reference

Under firmware control, an internal reference for the LCD bias voltages can be enabled. When enabled, the source of this voltage can be VDD.

When no internal reference is selected, the LCD contrast control circuit is disabled and LCD bias must be provided externally. Whenever the LCD module is inactive (LCDA = 0), the internal reference will be turned off.

#### 20.3.2.4 VLCDx Pins

The VLCD3, VLCD2 and VLCD1 pins provide the ability for an external LCD bias network to be used instead of the internal ladder. Use of the VLCDx pins does not prevent use of the internal ladder.

Each VLCD pin has an independent control in the LCDREF register, allowing access to any or all of the LCD bias signals.

This architecture allows for maximum flexibility in different applications. The VLCDx pins could be used to add capacitors to the internal reference ladder for increasing the drive capacity. For applications where the internal contrast control is insufficient, the firmware can choose to enable only the VLCD3 pin, allowing an external contrast control circuit to use the internal reference divider.

#### 20.4 LCD Multiplex Types

The LCD driver module can be configured into four multiplex types:

- Static (only COM0 used)
- 1/2 multiplex (COM0 and COM1 are used)
- 1/3 multiplex (COM0, COM1 and COM2 are used)
- 1/4 multiplex (COM0, COM1, COM2 and COM3 are used)

The LMUX<1:0> setting (LCDCON<1:0>) decides the function of the PORTE<6:4> bits. (For details, see Table 20-4.)

If the pin is a digital I/O, the corresponding TRIS bit controls the data direction. If the pin is a COM drive, the TRIS setting of that pin is overridden.

Note:	On a Power-on Reset, the LMUX<1:0>
	bits are '00'.

#### TABLE 20-4: PORTE<6:4> FUNCTION

LMUX<1:0>	PORTE<6>	PORTE<5>	PORTE<4>
00	Digital I/O	Digital I/O	Digital I/O
01	Digital I/O	Digital I/O	COM1 Driver
10	Digital I/O	COM2 Driver	COM1 Driver
11	COM3 Driver	COM2 Driver	COM1 Driver

#### 20.5 Segment Enables

The LCDSEx registers are used to select the pin function for each segment pin. The selection allows each pin to operate as either an LCD segment driver or a digital only pin. To configure the pin as a segment pin, the corresponding bits in the LCDSEx registers must be set to '1'.

If the pin is a digital I/O, the corresponding TRIS bit controls the data direction. Any bit set in the LCDSEx registers overrides any bit settings in the corresponding TRIS register.

Note: On a Power-on Reset, these pins are configured as digital I/O.

#### 20.6 Pixel Control

The LCDDATAx registers contain bits that define the state of each pixel. Each bit defines one unique pixel.

Table 20-2 shows the correlation of each bit in the LCDDATAx registers to the respective common and segment signals.

Any LCD pixel location not being used for display can be used as general purpose RAM.

#### 查询PIC18F86K90供应商 20.7 LCD Frame Frequency

The rate at which the COM and SEG outputs change is called the LCD frame frequency.

#### TABLE 20-5: FRAME FREQUENCY FORMULAS

Multiplex	Frame Frequency =	
Static	Clock Source/(4 x 1 x (LP<3:0> + 1))	
1/2	Clock Source/(2 x 2 x (LP<3:0> + 1))	
1/3	Clock Source/(1 x 3 x (LP<3:0> + 1))	
1/4	Clock Source/(1 x 4 x (LP<3:0> + 1))	

Note: Clock source is (Fosc/4)/8192, Timer1 Osc/32 or INTRC/32.

# TABLE 20-6:APPROXIMATE FRAME<br/>FREQUENCY (IN Hz) USING<br/>Fosc AT 32 MHz, TIMER1 AT<br/>32.768 kHz OR INTRC OSC

LP<3:0>	Static	1/2	1/3	1/4
1	125	125	167	125
2	83	83	111	83
3	62	62	83	62
4	50	50	67	50
5	42	42	56	42
6	36	36	48	36
7	31	31	42	31

#### 20.8 LCD Waveform Generation

LCD waveform generation is based on the philosophy that the net AC voltage across the dark pixel should be maximized and the net AC voltage across the clear pixel should be minimized. The net DC voltage across any pixel should be zero.

The COM signal represents the time slice for each common, while the SEG contains the pixel data.

The pixel signal (COM-SEG) will have no DC component and can take only one of the two rms values. The higher rms value will create a dark pixel and a lower rms value will create a clear pixel.

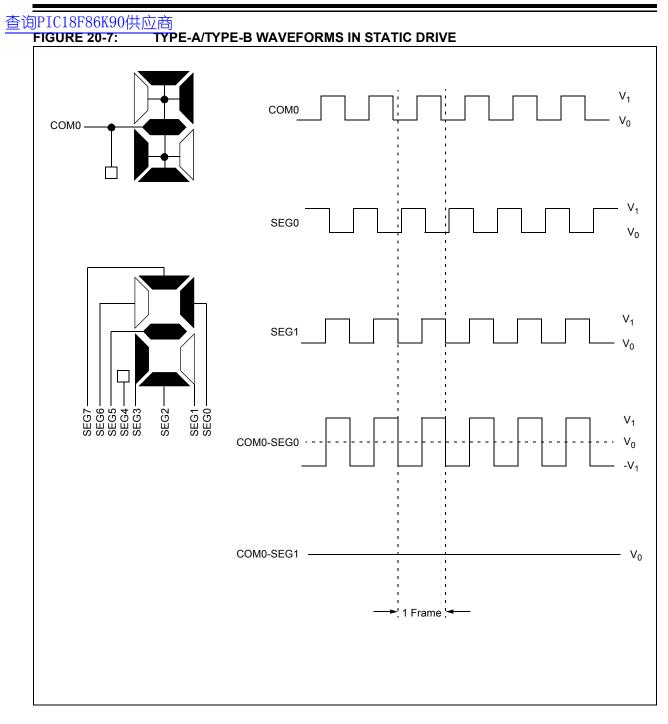
As the number of commons increases, the delta between the two rms values decreases. The delta represents the maximum contrast that the display can have.

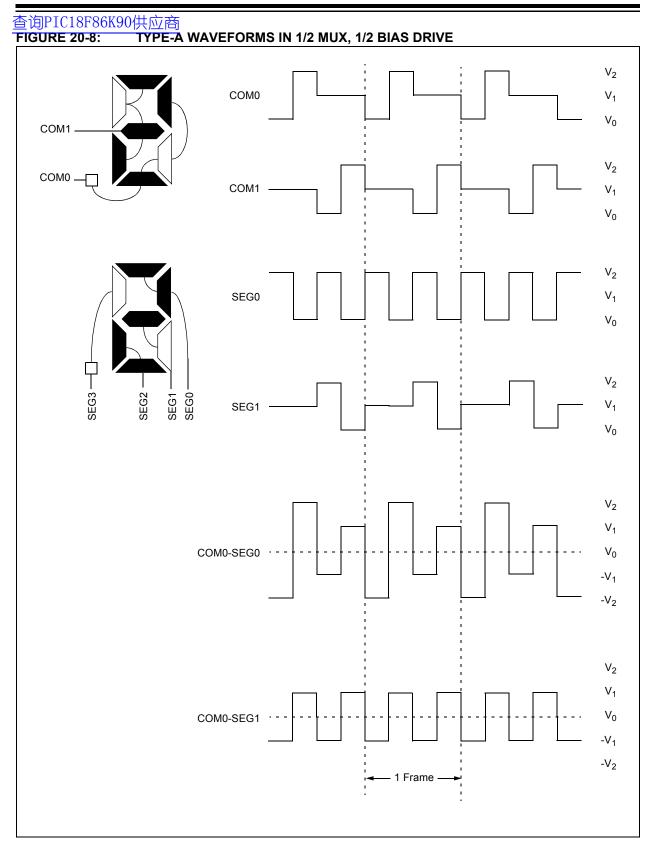
The LCDs can be driven by two types of waveforms: Type-A and Type-B. In a Type-A waveform, the phase changes within each common type, whereas a Type-B waveform's phase changes on each frame boundary. Thus, Type-A waveforms maintain 0 VDc over a single frame, whereas Type-B waveforms take two frames.

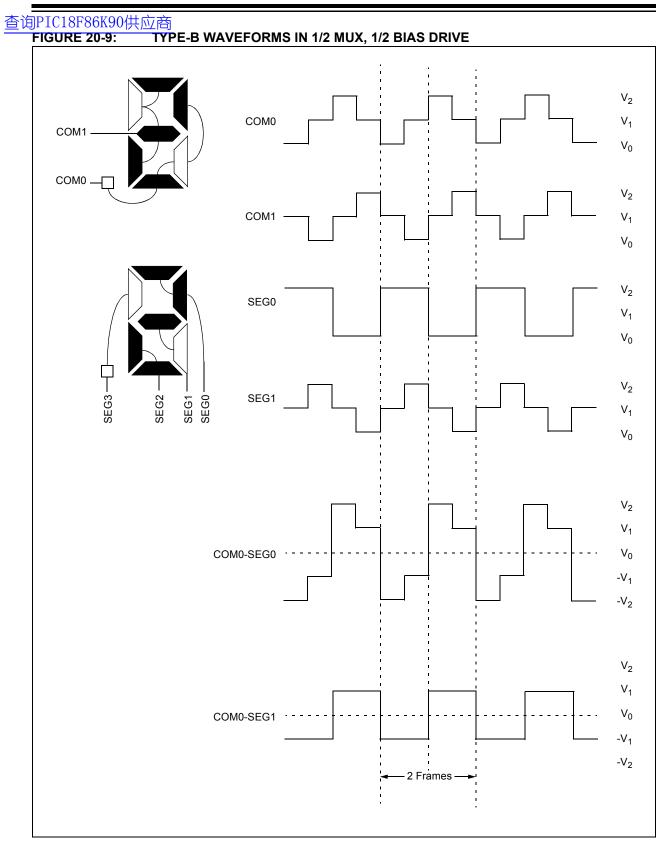
Note 1:	If Sleep has to be executed with LCD Sleep		
	enabled (SLPEN (LCDCON<6>) = 1),		
	care must be taken to execute Sleep only		
	when VDC on all the pixels is '0'.		

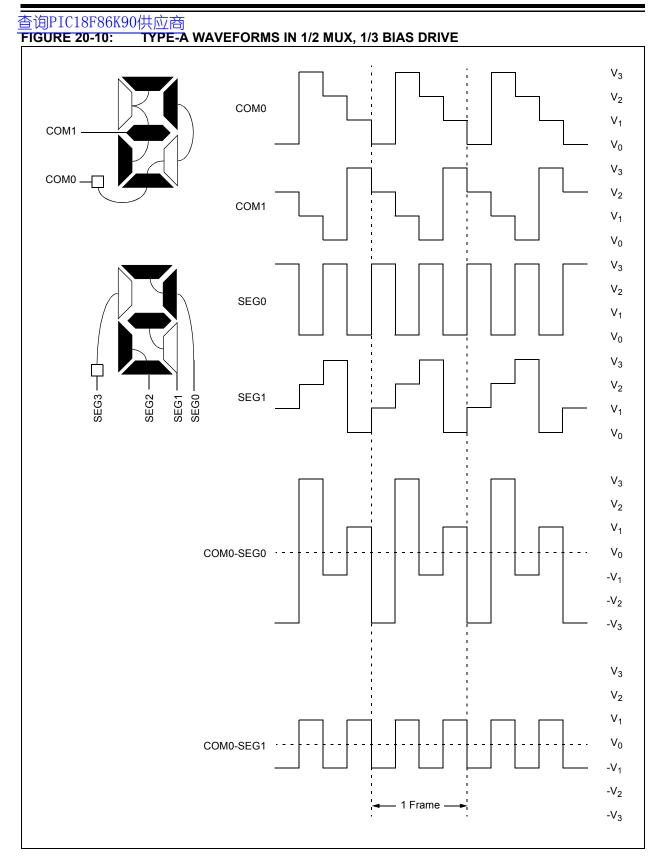
2: When the LCD clock source is (Fosc/4)/ 8192, if Sleep is executed irrespective of the LCDCON<SLPEN> setting, the LCD goes into Sleep. Thus, take care to see that VDc on all pixels is '0' when Sleep is executed.

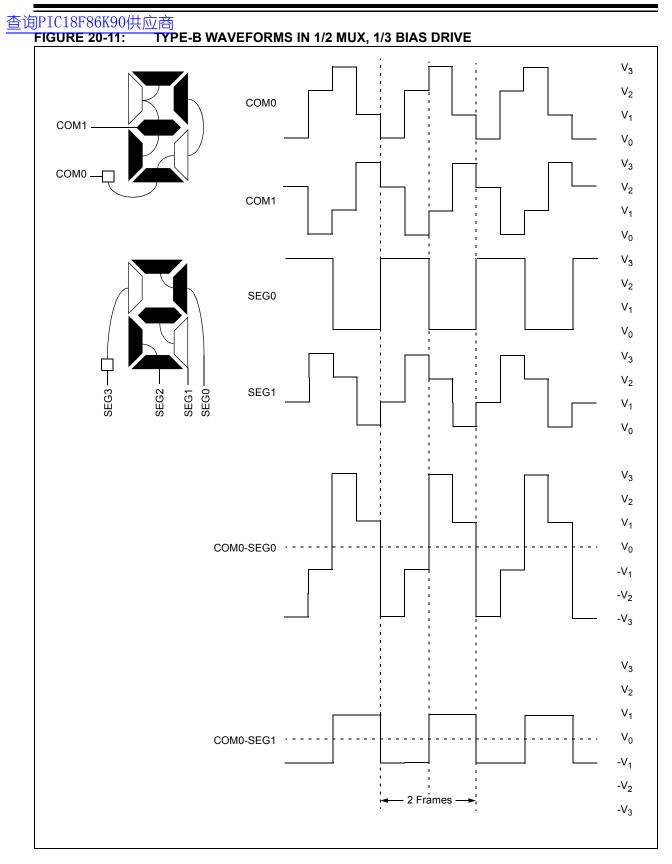
Figure 20-7 through Figure 20-17 provide waveforms for static, half-multiplex, one-third multiplex and quarter multiplex drives for Type-A and Type-B waveforms.





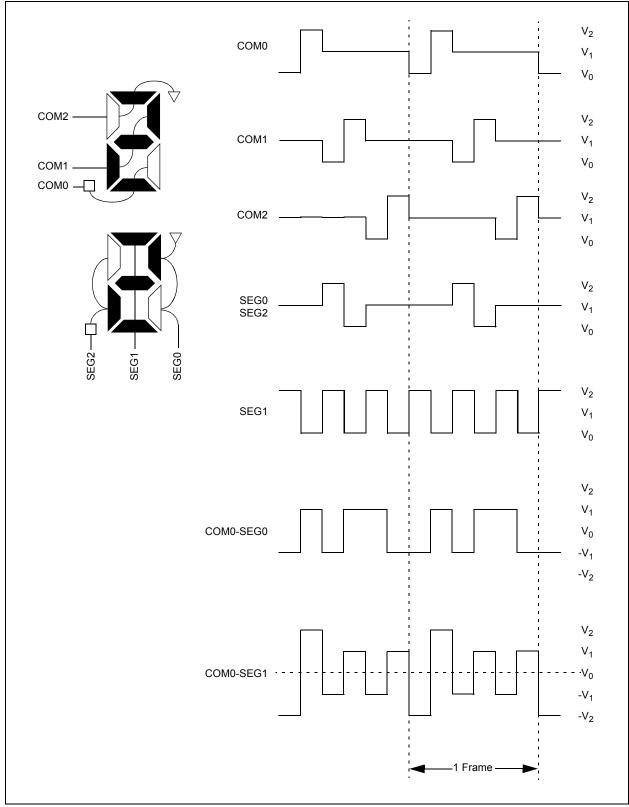


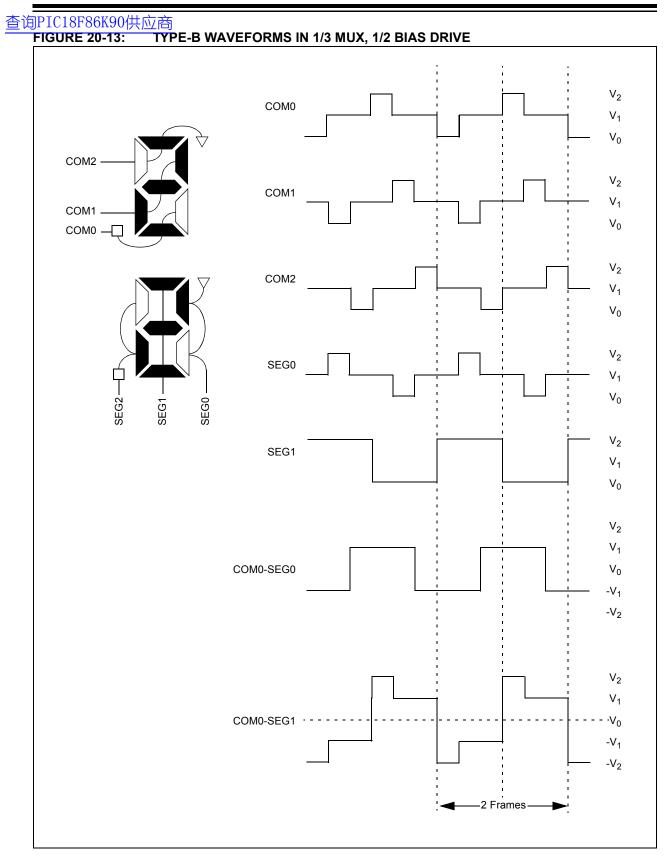




#### 查询PIC18F86K90供应商

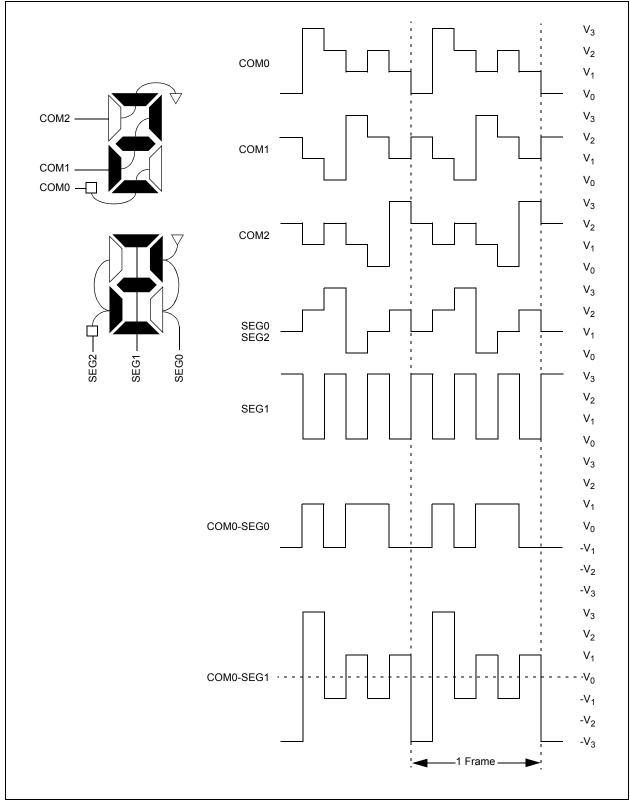
FIGURE 20-12: TYPE-A WAVEFORMS IN 1/3 MUX, 1/2 BIAS DRIVE

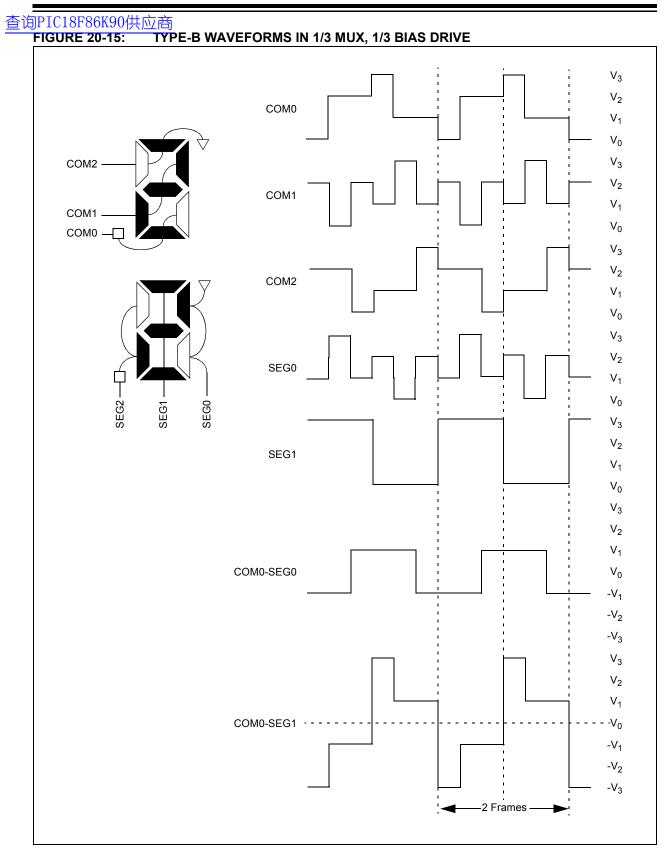




#### 查询PIC18F86K90供应商

FIGURE 20-14: TYPE-A WAVEFORMS IN 1/3 MUX, 1/3 BIAS DRIVE

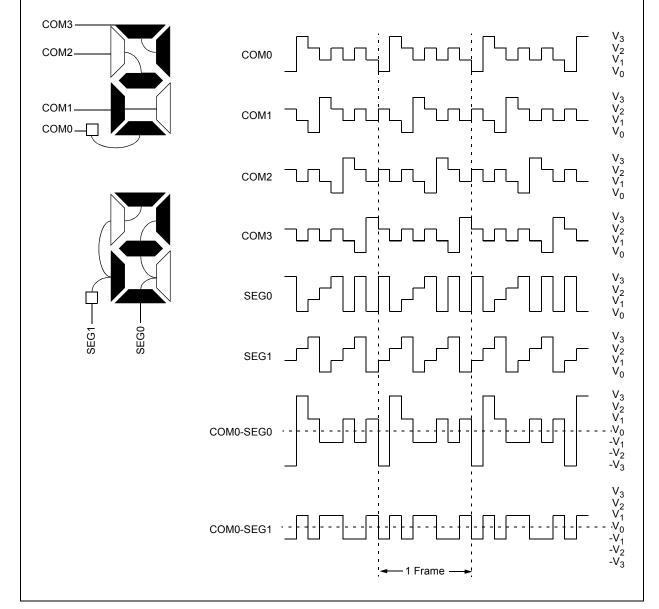


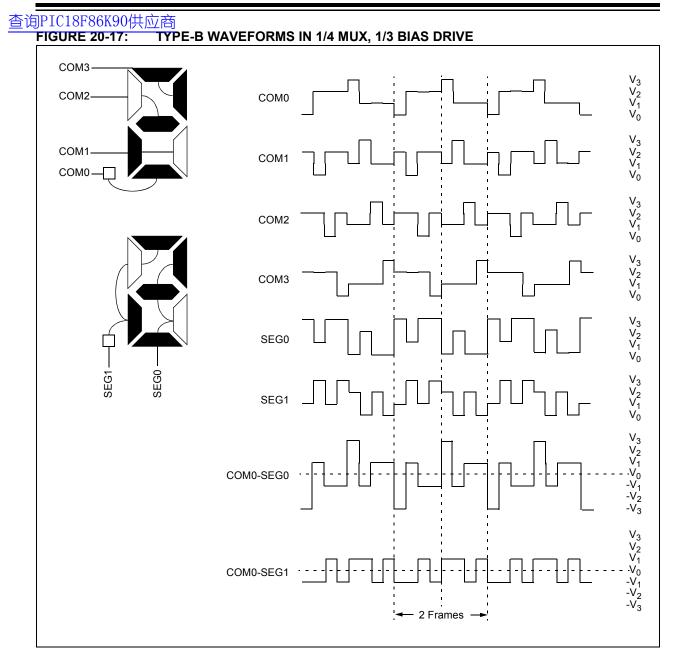


© 2010 Microchip Technology Inc.

### 查询PIC18F86K90供应商







#### 查询PIC18F86K90供应商 20.9 LCD Interrupts

The LCD timing generation provides an interrupt that defines the LCD frame timing. This interrupt can be used to coordinate the writing of the pixel data with the start of a new frame, which produces a visually crisp transition of the image.

This interrupt can also be used to synchronize external events to the LCD. For example, the interface to an external segment driver can be synchronized for segment data updates to the LCD frame.

A new frame is defined as beginning at the leading edge of the COM0 common signal. The interrupt will be set immediately after the LCD controller completes accessing all pixel data required for a frame. This will occur at a fixed interval before the frame boundary (TFINT), as shown in Figure 20-18.

The LCD controller will begin to access data for the next frame within the interval from the interrupt to when the controller begins accessing data after the interrupt (TFWR). New data must be written within TFWR, as this is when the LCD controller will begin to access the data for the next frame.

When the LCD driver is running with Type-B waveforms and the LMUX<1:0> bits are not equal to '00', there are some additional issues.

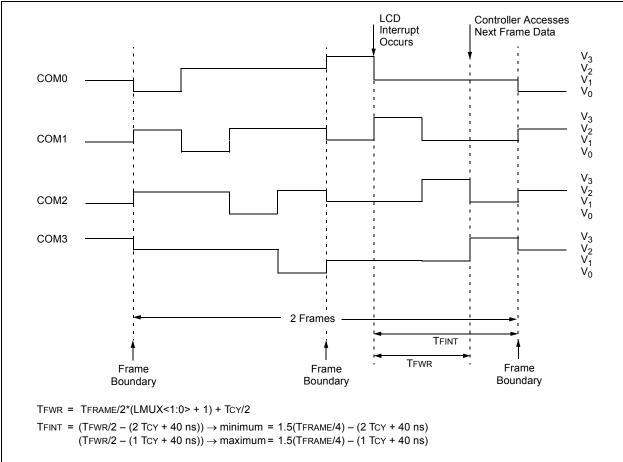
Since the DC voltage on the pixel takes two frames to maintain 0V, the pixel data must not change between subsequent frames. If the pixel data were allowed to change, the waveform for the odd frames would not necessarily be the complement of the waveform generated in the even frames and a DC component would be introduced into the panel.

Because of this, using Type-B waveforms requires synchronizing the LCD pixel updates to occur within a subframe after the frame interrupt.

To correctly sequence writing in Type-B, the interrupt only occurs on complete phase intervals. If the user attempts to write when the write is disabled, the WERR bit (LCDCON<5>) is set.

Note:	The inte	errupt	is no	t generate	d when	the
	Type-A v	vavefo	orm is	selected a	nd when	the
	Type-B	with	no	multiplex	(static)	is
	selected					





#### 查询PIC18F86K90供应商 20.10 Operation During Sleep

**FIGURE 20-19:** 

The LCD module can operate during Sleep. Setting the SLPEN bit (LCDCON<6>) allows the LCD module to go to Sleep. Clearing this bit allows the module to continue operating during Sleep.

If a SLEEP instruction is executed and SLPEN = 1, the LCD module will cease all functions and go into a very low-current consumption mode. The module will stop operation immediately and drive the minimum LCD voltage on both segment and common lines. Figure 20-19 shows this operation.

The LCD module current consumption will not decrease in this mode, but the overall consumption of the device will be lower due to shut down of the core and other peripheral functions.

To ensure that no DC component is introduced on the panel, the SLEEP instruction should be executed immediately after an LCD frame boundary. The LCD

interrupt can be used to determine the frame boundary. For the formulas to calculate the delay, see Section 20.9 "LCD Interrupts".

If a SLEEP instruction is executed and SLPEN = 0, the module will continue to display the current contents of the LCDDATA registers. The LCD data cannot be changed.

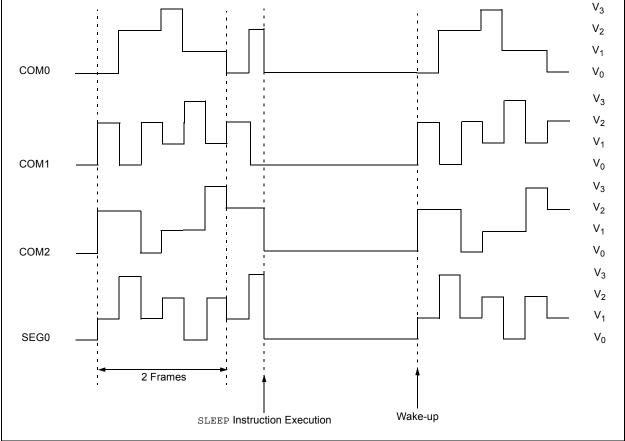
To allow the module to continue operation while in Sleep, the clock source must be either the internal RC oscillator or Timer1 external oscillator.

If the system clock is selected and the module is programmed to not Sleep, the module will ignore the SLPEN bit and stop operation immediately. The minimum LCD voltage then will be driven onto the segments and commons.

The internal RC oscillator or external Note: SOSC oscillator must be used to operate the LCD module during Sleep.



SLEEP ENTRY/EXIT WHEN SLPEN = 1 OR CS<1:0> = 00



### 查询PIC18F86K90供应商

#### 20.11 Configuring the LCD Module

To configure the LCD module.

- 1. Select the frame clock prescale, using bits, LP<3:0> (LCDPS<3:0>).
- 2. Configure the appropriate pins to function as segment drivers using the LCDSEx registers.
- If using the internal reference resistors for biasing, enable the internal reference ladder and:
  - Define the Mode A and Mode B interval by using the LRLAT<2:0> bits (LCDRL<2:0>)
  - Define the low, medium or high ladder for Mode A and Mode B by using the LRLAP<1:0> bits (LCDRL<7:6>) and the LRLBP<1:0> bits (LCDRL<5:4>), respectively
  - Set the VLCDxPE bits and enable the LCDIRE bit (LCDREF<7>)

- 4. Configure the following LCD module functions using the LCDCON register:
  - Multiplex and Bias mode LMUX<1:0> bits
  - Timing Source CS<1:0> bits
  - Sleep mode SLPEN bit
- 5. Write initial values to the pixel data registers, LCDDATA0 through LCDDATA23.
- 6. Clear the LCD Interrupt Flag, LCDIF (PIR3<6>), and if desired, enable the interrupt by setting bit, LCDIE (PIE3<6>).
- Enable the LCD module by setting bit, LCDEN (LCDCON<7>).

#### 查询PIC18F86K90供应商 TABLE 20-7: REGISTERS ASSOCIATED WITH LCD OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
LCDDATA23 <sup>(1)</sup>	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	77
LCDDATA22(1)	S39C3	S38C3	S37C3	S36C3	S35C3	S34C3	S33C3	S32C3	77
LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	77
LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	77
LCDDATA19	S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	77
LCDDATA18	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	77
LCDDATA17 <sup>(1)</sup>	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	77
LCDDATA16(1)	S39C2	S38C2	S37C2	S36C2	S35C2	S34C2	S33C2	S32C2	77
LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	77
LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	77
LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	77
LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	77
LCDDATA11 <sup>(1)</sup>	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	77
LCDDATA10 <sup>(1)</sup>	S39C1	S38C1	S37C1	S36C1	S35C1	S34C1	S33C1	S32C1	77
LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	77
LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	77
LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	77
LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	77
LCDDATA5 <sup>(1)</sup>	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	77
LCDDATA4 <sup>(1)</sup>	S39C0	S38C0	S37C0	S36C0	S35C0	S34C0	S33C0	S32C0	77
LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	77
LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	77
LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	77
LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	77
LCDSE5 <sup>(2)</sup>	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	81
LCDSE4 <sup>(2)</sup>	SE39	SE38	SE37	SE36	SE35	SE34	SE33	SE32	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE9	SE8	81
LCDSE0	SE7	SE6	SE5	SE4	SE3	SE2	SE1	SE0	81
LCDCON	LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0	81
LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	81
LCDREF	LCDIRE	LCDIRS	LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE	81
LCDRL	LRLAP1	LRLAP0	LRLBP1	LRLBP0	—	LRLAT2	LRLAT1	LRLAT0	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used for LCD operations.

**Note 1:** These registers are implemented, but unused on 64-pin devices and may be used as general purpose data RAM.

2: These registers are unimplemented on 64-pin devices.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商

#### 21.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

#### 21.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I<sup>2</sup>C<sup>™</sup>)
  - Full Master mode
  - Slave mode (with general address call)

The I<sup>2</sup>C interface supports the following modes in hardware:

- Master mode
- Multi-Master mode
- Slave mode with 5-bit and 7-bit address masking (with address masking for both 10-bit and 7-bit addressing)

All members of the PIC18F87K90 family have two MSSP modules, designated as MSSP1 and MSSP2. Each module operates independently of the other.

Note: Throughout this section, generic references to an MSSP module in any of its operating modes may be interpreted as being equally applicable to MSSP1 or MSSP2. Register names and module I/O signals use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module when required. Control bit names are not individuated.

#### 21.2 Control Registers

Each MSSP module has three associated control registers. These include a status register (SSPxSTAT) and two control registers (SSPxCON1 and SSPxCON2). The use of these registers and their individual configuration bits differ significantly depending on whether the MSSP module is operated in SPI or  $I^2C$  mode.

Additional details are provided under the individual sections.

Note:	In devices with more than one MSSP module, it is very important to pay close attention to SSPxCON register names. SSP1CON1 and SSP1CON2 control
	different operational aspects of the same module, while SSP1CON1 and SSP2CON1 control the same features for two different modules.

#### 21.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDOx) RC5/SDO1/SEG12 or RD4/SEG4/SDO2
- Serial Data In (SDIx) RC4/SDI1/SDA1/SEG16 or RD5/SEG5/SDI2/SDA2
- Serial Clock (SCKx) RC3/SCK1/SCL1/SEG17 or RD6/SEG6/SCK2/SCL2

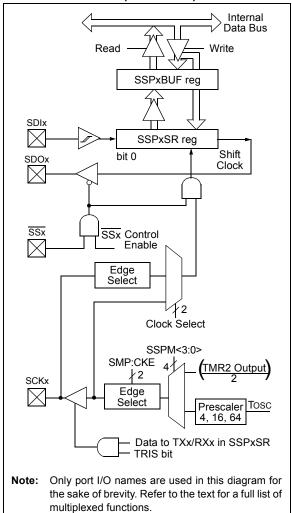
Additionally, a fourth pin may be used when in a Slave mode of operation:

 Slave Select (SSx) – RF7/AN5/SS1/SEG25 or RD7/SEG7/SS2

Figure 21-1 shows the block diagram of the MSSP module when operating in SPI mode.



MSSPx BLOCK DIAGRAM (SPI MODE)



#### 查询PIC18F86K90供应商 21.3.1 REGISTERS

Each MSSP module has four registers for SPI mode operation. These are:

- MSSPx Control Register 1 (SSPxCON1)
- MSSPx Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSPx Shift Register (SSPxSR) Not directly accessible

SSPxCON1 and SSPxSTAT are the control and status registers in SPI mode operation. The SSPxCON1 register is readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from. In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

Note: The SSPxBUF register cannot be used with read-modify-write instructions, such as BCF, COMF, etc. To avoid lost data in Master mode, a read of the SSPxBUF must be performed to clear the Buffer Full (BF) detect bit (SSPxSTAT<0>) between each transmission.

#### REGISTER 21-1: SSPxSTAT: MSSPx STATUS REGISTER (SPI MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE <sup>(1)</sup>	D/A	Р	S	R/W	UA	BF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	SMP: Sample bit
	SPI Master mode:
	1 = Input data sampled at the end of data output time
	0 = Input data sampled at the middle of data output time
	SPI Slave mode:
	SMP must be cleared when SPI is used in Slave mode.
bit 6	CKE: SPI Clock Select bit <sup>(1)</sup>
	1 = Transmit occurs on transition from active to Idle clock state
	0 = Transmit occurs on transition from Idle to active clock state
bit 5	D/A: Data/Address bit
	Used in I <sup>2</sup> C™ mode only.
bit 4	P: Stop bit
	Used in I <sup>2</sup> C mode only. This bit is cleared when the MSSPx module is disabled; SSPEN is cleared.
bit 3	Start bit
	Used in I <sup>2</sup> C mode only.
bit 2	R/W: Read/Write Information bit
	Used in I <sup>2</sup> C mode only.
bit 1	UA: Update Address bit
	Used in I <sup>2</sup> C mode only.
bit 0	BF: Buffer Full Status bit (Receive mode only)
	1 = Receive complete, SSPxBUF is full
	0 = Receive not complete, SSPxBUF is empty
Note 1	Delevity of the electric state is get by the CKD bit (CCD) $(CON(1/4))$

Note 1: Polarity of the clock state is set by the CKP bit (SSPxCON1<4>).

#### 查询PIC18F86K90供应商 REGISTER 21-2: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV <sup>(1)</sup>	SSPEN <sup>(2)</sup>	CKP	SSPM3 <sup>(3)</sup>	SSPM2 <sup>(3)</sup>	SSPM1 <sup>(3)</sup>	SSPM0 <sup>(3)</sup>
bit 7				•			bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	WCOL: Write Collision Detect bit
	1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in
	software)
	0 = No collision
bit 6	SSPOV: Receive Overflow Indicator bit <sup>(1)</sup>
	<ul> <li>SPI Slave mode:</li> <li>1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).</li> <li>0 = No overflow</li> </ul>
bit 5	SSPEN: Master Synchronous Serial Port Enable bit <sup>(2)</sup>
DIUS	
	<ul> <li>1 = Enables serial port and configures SCKx, SDOx, SDIx and SSx as serial port pins</li> <li>0 = Disables serial port and configures these pins as I/O port pins</li> </ul>
h:+ 4	
bit 4	CKP: Clock Polarity Select bit
	1 = Idle state for clock is a high level
	0 = Idle state for clock is a low level
bit 3-0	SSPM<3:0>: Master Synchronous Serial Port Mode Select bits <sup>(3)</sup>
	1010 = SPI Master mode: Clock = Fosc/8
	0101 = SPI Slave mode: Clock = SCKx pin; <u>SSx</u> pin control disabled; SSx can be used as I/O pin
	0100 = SPI Slave mode: Clock = SCKx pin; SSx pin control enabled
	0011 = SPI Master mode: Clock = TMR2 Output/2
	0010 = SPI Master mode: Clock = Fosc/64
	0001 = SPI Master mode: Clock = Fosc/16 0000 = SPI Master mode: Clock = Fosc/4
	0000 - SFT Master mode. Clock - POSC/4
Note 1:	In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.

- 2: When enabled, these pins must be properly configured as inputs or outputs.
- **3:** Bit combinations not specifically listed here are either reserved or implemented in  $I^2C^{TM}$  mode only.

#### 查询PIC18F86K90供应商 21.3.2 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPxCON1<5:0> and SSPxSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCKx is the clock output)
- Slave mode (SCKx is the clock input)
- Clock Polarity (Idle state of SCKx)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCKx)
- Clock Rate (Master mode only)
- · Slave Select mode (Slave mode only)

Each MSSP module consists of a transmit/receive shift register (SSPxSR) and a buffer register (SSPxBUF). The SSPxSR shifts the data in and out of the device, MSb first. The SSPxBUF holds the data that was written to the SSPxSR until the received data is ready. Once the 8 bits of data have been received, that byte is moved to the SSPxBUF register. Then, the Buffer Full detect bit, BF (SSPxSTAT<0>), and the interrupt flag bit, SSPxIF, are set. This double-buffering of the received data (SSPxBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPxBUF register during transmission/reception of data will be ignored and the Write Collision Detect bit, WCOL (SSPxCON1<7>), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPxBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPxBUF should be read before the next byte of data to transfer is written to the SSPxBUF. The Buffer Full bit, BF (SSPxSTAT<0>), indicates when SSPxBUF has been loaded with the received data (transmission is complete). When the SSPxBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 21-1 shows the loading of the SSPxBUF (SSPxSR) for data transmission.

The SSPxSR is not directly readable or writable and can only be accessed by addressing the SSPxBUF register. Additionally, the SSPxSTAT register indicates the various status conditions.

#### 21.3.3 OPEN-DRAIN OUTPUT OPTION

The drivers for the SDOx output and SCKx clock pins can be optionally configured as open-drain outputs. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor, and allows the output to communicate with external circuits without the need for additional level shifters. For more information, see **Section 11.1.3 "Open-Drain Outputs"**.

The open-drain output option is controlled by the SSP2OD (ODCON1<0>) and SSP1OD bits (ODCON1<7>). Setting an SSPxOD bit configures the SDOx and SCKx pins for the corresponding module for open-drain operation.

Note: To avoid lost data in Master mode, a read of the SSPxBUF must be performed to clear the Buffer Full (BF) detect bit (SSPxSTAT<0>) between each transmission.

#### EXAMPLE 21-1: LOADING THE SSP1BUF (SSP1SR) REGISTER

LOOP	BTFSS BRA MOVF	LOOP	;Has data been received (transmit complete)? ;No ;WREG reg = contents of SSP1BUF
	MOVWF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF MOVWF	TXDATA, W SSP1BUF	;W reg = contents of TXDATA ;New data to xmit

#### 查询PIC18F86K90供应商 21.3.4 ENABLING SPI I/O

To enable the serial port, MSSP Enable bit, SSPEN (SSPxCON1<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, reinitialize the SSPxCON registers and then set the SSPEN bit. This configures the SDIx, SDOx, SCKx and SSx pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed as follows:

- SDIx is automatically controlled by the SPI module
- SDOx must have the TRISC<5> or TRISD<4> bit cleared
- SCKx (Master mode) must have the TRISC<3> or TRISD<6>bit cleared
- SCKx (Slave mode) must have the TRISC<3> or TRISD<6> bit set
- SSx must have the TRISF<7> or TRISD<7> bit set

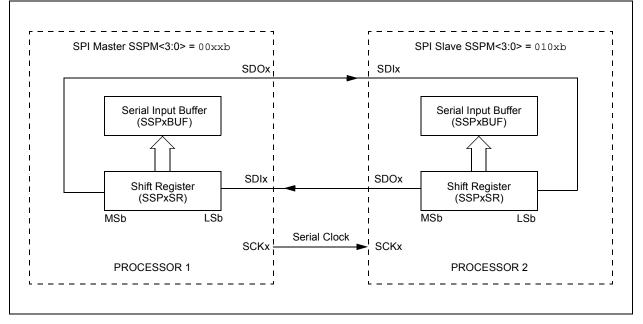
Any serial port function that is not desired may be overridden by programming the corresponding Data Direction (TRIS) register to the opposite value.

#### 21.3.5 TYPICAL CONNECTION

Figure 21-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCKx signal. Data is shifted out of both shift registers on their programmed clock edge and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- · Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

#### FIGURE 21-2: SPI MASTER/SLAVE CONNECTION



#### 查询PIC18F86K90供应商 21.3.6 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCKx. The master determines when the slave (Processor 1, Figure 21-2) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPxBUF register is written to. If the SPI is only going to receive, the SDOx output could be disabled (programmed as an input). The SSPxSR register will continue to shift in the signal present on the SDIx pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPxBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "Line Activity Monitor" mode.

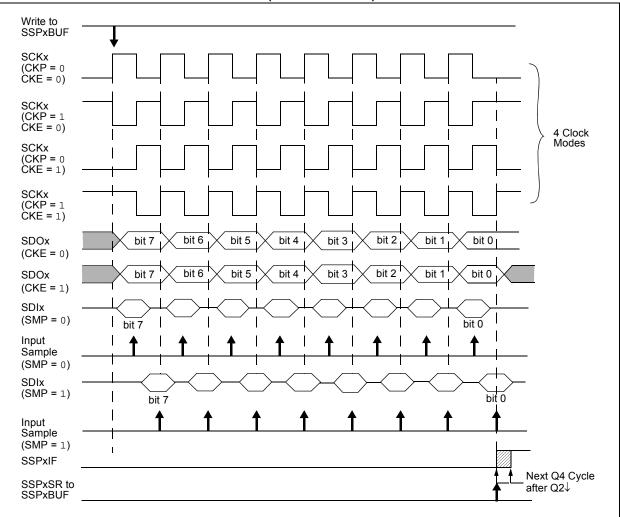
The clock polarity is selected by appropriately programming the CKP bit (SSPxCON1<4>). This, then, would give waveforms for SPI communication as

shown in Figure 21-3, Figure 21-5 and Figure 21-6, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user-programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 40 MHz) of 10.00 Mbps.

Figure 21-3 shows the waveforms for Master mode. When the CKE bit is set, the SDOx data is valid before there is a clock edge on SCKx. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPxBUF is loaded with the received data is shown.



#### FIGURE 21-3: SPI MODE WAVEFORM (MASTER MODE)

#### 查询PIC18F86K90供应商 21.3.7 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCKx. When the last bit is latched, the SSPxIF interrupt flag bit is set.

While in Slave mode, the external clock is supplied by the external clock source on the SCKx pin. This external clock must meet the minimum high and low times as specified in the electrical specifications.

While in Sleep mode, the slave can transmit/receive data. When a byte is received, the device can be configured to wake-up from Sleep.

#### 21.3.8 SLAVE SELECT SYNCHRONIZATION

The  $\overline{SSx}$  pin allows a Synchronous Slave mode. The SPI must be in Slave mode with the  $\overline{SSx}$  pin control enabled (SSPxCON1<3:0> = 04h). When the  $\overline{SSx}$  pin is low, transmission and reception are enabled and the SDOx pin is driven. When the  $\overline{SSx}$  pin goes high, the SDOx pin is no longer driven, even if in the middle of a

transmitted byte and becomes a floating output. External pull-up/pull-down resistors may be desirable depending on the application.

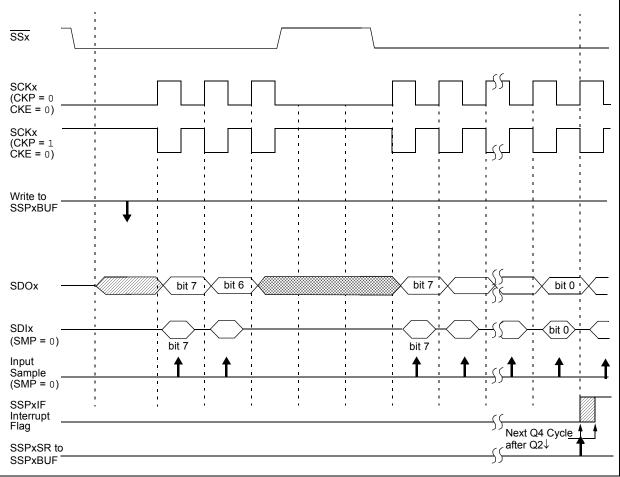
Note 1:	When	the	SPI	is	in	Slave	mode
	with	SSx	pin	C	contr	ol e	nabled
	(SSPx	CON1	<3:0>	= 0	100	), the	SPI
	module	will re	set if th	ne S	SSx p	in is set	to VDD.

2: If the SPI is used in Slave mode with CKE set, then the SSx pin control must be enabled.

When the SPI module resets, the bit counter is forced to '0'. This can be done by either forcing the SSx pin to a high level or clearing the SSPEN bit.

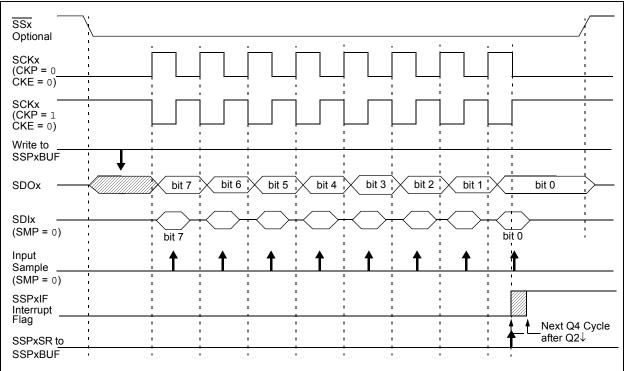
To emulate two-wire communication, the SDOx pin can be connected to the SDIx pin. When the SPI needs to operate as a receiver, the SDOx pin can be configured as an input. This disables transmissions from the SDOx. The SDIx can always be left as an input (SDIx function) since it cannot create a bus conflict.



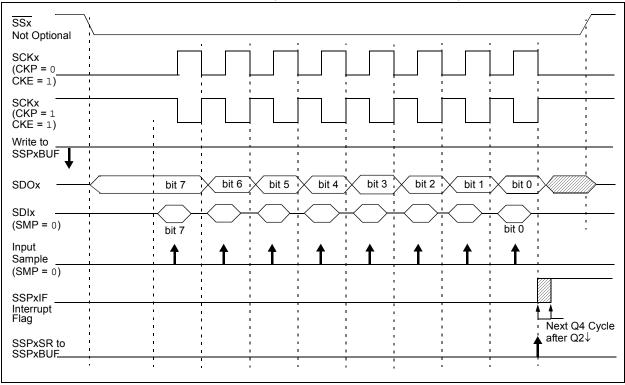


#### 查询PIC18F86K90供应商

FIGURE 21-5: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)



#### FIGURE 21-6: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)



#### 查询PIC18F86K90供应商

#### 21.3.9 OPERATION IN POWER-MANAGED MODES

In SPI Master mode, module clocks may be operating at a different speed than when in full-power mode; in the case of the Sleep mode, all clocks are halted.

In Idle modes, a clock is provided to the peripherals. That clock can be from the primary clock source, the secondary clock (SOSC oscillator) or the INTOSC source. See **Section 3.3** "**Clock Sources and Oscillator Switching**" for additional information.

In most cases, the speed that the master clocks SPI data is not important; however, this should be evaluated for each system.

If MSSP interrupts are enabled, they can wake the controller from Sleep mode, or one of the Idle modes, when the master completes sending data. If an exit from Sleep or Idle mode is not desired, MSSP interrupts should be disabled.

If the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the device wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in any power-managed mode and data to be shifted into the SPI Transmit/Receive Shift register. When all 8 bits have been received, the MSSP interrupt flag bit will be set, and if enabled, will wake the device.

#### 21.3.10 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

#### 21.3.11 BUS MODE COMPATIBILITY

Table 21-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKE control bits.

Standard SPI Mode	Control Bits State				
Terminology	СКР	CKE			
0, 0	0	1			
0, 1	0	0			
1, 0	1	1			
1, 1	1	0			

There is also an SMP bit which controls when the data is sampled.

### 21.3.12 SPI CLOCK SPEED AND MODULE INTERACTIONS

Because MSSP1 and MSSP2 are independent modules, they can operate simultaneously at different data rates. Setting the SSPM<3:0> bits of the SSPxCON1 register determines the rate for the corresponding module.

An exception is when both modules use Timer2 as a time base in Master mode. In this instance, any changes to the Timer2 module's operation will affect both MSSP modules equally. If different bit rates are required for each module, the user should select one of the other three time base options for one of the modules.

### 查询PIC18F86K90供应商 TABLE 21-2: REGISTERS ASSOCIATED WITH SPI OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR2	OSCFIF	—	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE		SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
IPR2	OSCFIP	_	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
SSP1BUF	MSSP1 Rec	eive Buffer/Tra	ansmit Regi	ster					80
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	74
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	74
SSP1STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	74
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	80
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	81
SSP2STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	80
SSP2BUF	MSSP2 Rec	eive Buffer/Tra	ansmit Regi	ster					80
ODCON3	U2OD	U10D	_	—		—	—	CTMUDS	79

Legend: Shaded cells are not used by the MSSP module in SPI mode.

#### 查询PIC18F86K90供应商 **21.4 I<sup>2</sup>C™ Mode**

FIGURE 21-7

The MSSP module in I<sup>2</sup>C mode fully implements all master and slave functions (including general call support), and provides interrupts on Start and Stop bits in hardware to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications, as well as 7-bit and 10-bit addressing.

Two pins are used for data transfer:

- Serial Clock (SCLx) RC3/SCK1/SCL1/SEG17 or RD6/SEG6/SCK2/SCL2
- Serial Data (SDAx) RC4/SDI1/SDA1/SEG16 or RD5/SEG5/SDI2/SDA2

The user must configure these pins as inputs by setting the associated TRIS bits.

MSSPX BLOCK DIAGRAM

FIGURE	(I <sup>2</sup> C <sup>™</sup> MODE)
SCLX SDAX	Read Write SSPxBUF reg Shift Clock SSPxSR reg MSb LSb Match Detect Addr Match Address Mask SSPxADD reg
	Start and Stop bit Detect S, P bits (SSPxSTAT reg)
t	Only port I/O names are used in this diagram for he sake of brevity. Refer to the text for a full list of nultiplexed functions.

#### 21.4.1 REGISTERS

The MSSP module has seven registers for  ${\rm I}^2{\rm C}$  operation. These are:

- MSSPx Control Register 1 (SSPxCON1)
- MSSPx Control Register 2 (SSPxCON2)
- MSSPx Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSPx Shift Register (SSPxSR) Not directly accessible
- MSSPx Address Register (SSPxADD)
- I<sup>2</sup>C Slave Address Mask Register (SSPxMSK)

SSPxCON1, SSPxCON2 and SSPxSTAT are the control and status registers in  $l^2$ C mode operation. The SSPxCON1 and SSPxCON2 registers are readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

SSPxADD contains the slave device address when the MSSP is configured in  $I^2C$  Slave mode. When the MSSP is configured in Master mode, the lower seven bits of SSPxADD act as the Baud Rate Generator reload value.

SSPxMSK holds the slave address mask value when the module is configured for 7-Bit Address Masking mode. While it is a separate register, it shares the same SFR address as SSPxADD. It is only accessible when the SSPM<3:0> bits are specifically set to permit access. Additional details are provided in Section 21.4.3.4 "7-Bit Address Masking Mode".

In receive operations, SSPxSR and SSPxBUF together, create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

### 查询PIC18F86K90供应商 <del>REGISTER 21-3: SSPxS</del>TAT: MSSPx STATUS REGISTER (I<sup>2</sup>C™ MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0				
SMP	CKE	D/Ā	P <sup>(1)</sup>	S <sup>(1)</sup>	R/W <sup>(2,3)</sup>	UA	BF				
bit 7	I						bit				
Legend:											
R = Readat	ole bit	W = Writable	e bit	-	mented bit, read	d as '0'					
-n = Value a	at POR	'1' = Bit is se	t	'0' = Bit is cl	eared	x = Bit is unkr	nown				
bit 7	SMP: Slew Rate Control bit In Master or Slave mode:										
			bled for Stand	ard Speed mov	de (100 kHz and	1 MH⁊)					
			bled for High-S			1 1011 12)					
bit 6	CKE: SMBu		0	· · · ·	,						
	In Master or	Slave mode:									
	1 = Enable S	SMBus-specific									
	_	SMBus-specific	c inputs								
bit 5	D/A: Data/A	ddress bit									
	In Master mode:										
	Reserved.										
	In Slave mode: 1 = Indicates that the last byte received or transmitted was data										
			yte received or								
bit 4	P: Stop bit <sup>(1)</sup>										
Sit 1	1 = Indicates that a Stop bit has been detected last										
		was not detected									
bit 3	<b>S</b> : Start bit <sup>(1)</sup>										
	1 = Indicates that a Start bit has been detected last										
	0 = Start bit	was not detecte	ed last								
bit 2	R/W: Read/	Write Informatio	on bit <sup>(2,3)</sup>								
	In Slave mode:										
	1 = Read										
	0 = Write										
	In Master me	ode: t is in progress									
		t is not in progr	ess								
bit 1				e onlv)							
	<ul> <li>Update Address bit (10-Bit Slave mode only)</li> <li>1 = Indicates that the user needs to update the address in the SSPxADD register</li> </ul>										
		does not need									
bit 0	BF: Buffer Full Status bit										
	In Transmit mode:										
	1 = SSPxBL										
	0 = SSPxBU										
	In Receive n		a at in aluda tha		hite)						
			not include the es not include t								
	This bit is cleare										
			nation following		ess match. This l	bit is only valid	from the				

- address match to the next Start bit, Stop bit or not  $\overline{ACK}$  bit.
- 3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Active mode.

#### 查询PIC18F86K90供应商 REGISTER 21-4: SSPxCON1: MSSPx CONTROL REGISTER 1 (I<sup>2</sup>C™ MODE) R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 WCOL SSPOV SSPEN<sup>(1)</sup> CKP SSPM3<sup>(2)</sup> SSPM2<sup>(2)</sup> SSPM1<sup>(2)</sup> SSPM0<sup>(2)</sup> bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 WCOL: Write Collision Detect bit In Master Transmit mode: 1 = A write to the SSPxBUF register was attempted while the I<sup>2</sup>C conditions were not valid for a transmission to be started (must be cleared in software) 0 = No collisionIn Slave Transmit mode: 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software) 0 = No collisionIn Receive mode (Master or Slave modes): This is a "don't care" bit. bit 6 SSPOV: Receive Overflow Indicator bit In Receive mode: 1 = A byte is received while the SSPxBUF register is still holding the previous byte (must be cleared in software) 0 = No overflow In Transmit mode: This is a "don't care" bit in Transmit mode. bit 5 SSPEN: Master Synchronous Serial Port Enable bit<sup>(1)</sup> 1 = Enables the serial port and configures the SDAx and SCLx pins as the serial port pins 0 = Disables the serial port and configures these pins as I/O port pins bit 4 CKP: SCKx Release Control bit In Slave mode: 1 = Releases clock 0 = Holds clock low (clock stretch), used to ensure data setup time In Master mode: Unused in this mode. SSPM<3:0>: Master Synchronous Serial Port Mode Select bits<sup>(2)</sup> bit 3-0 1111 = $I^2C$ Slave mode: 10-bit address with Start and Stop bit interrupts enabled $1110 = I^2C$ Slave mode: 7-bit address with Start and Stop bit interrupts enabled $1011 = I^2C$ Firmware Controlled Master mode (slave Idle) 1001 = Load the SSPMSK register at the SSPxADD SFR address<sup>(3,4)</sup> $1000 = I^2C$ Master mode: Clock = Fosc/(4 \* (SSPxADD + 1)) 0111 = $I^2C$ Slave mode: 10-bit address $0110 = I^2C$ Slave mode: 7-bit address Note 1: When enabled, the SDAx and SCLx pins must be configured as inputs. 2: Bit combinations not specifically listed here are either reserved or implemented in SPI mode only. 3: When SSPM<3:0> = 1001, any reads or writes to the SSPxADD SFR address actually access the SSPxMSK register.

4: This mode is only available when 7-Bit Address Masking mode is selected (MSSPMSK Configuration bit is '1').

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT <sup>(1)</sup>	ACKEN <sup>(2)</sup>	RCEN <sup>(2)</sup>	PEN <sup>(2)</sup>	RSEN <sup>(2)</sup>	SEN <sup>(2)</sup>
bit 7							bit
Legend:							
R = Readabl	e bit	W = Writable	bit	U = Unimplen	nented bit, read	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own
bit 7	GCEN: Gener	ral Call Enable	bit				
	Unused in Ma	ister mode.					
bit 6	ACKSTAT: Ac	cknowledge Sta	itus bit (Master	r Transmit mod	e only)		
		dge was not re		ave			
		dge was receiv			. (1)		
bit 5		-	bit (Master Re	ceive mode onl	y)(1)		
	1 = Not Ackno 0 = Acknowle	0					
bit 4		•	anaa Frahla k	.:(2)			
DIL 4		nowledge Sequ			Clyping and	transmits AC	(DT data bi
		cally cleared by		SDAx and St	SEX piris and	transmits ACr	
		edge sequence					
bit 3	RCEN: Receiv	ve Enable bit (I	Master Receive	e mode only) <sup>(2)</sup>			
	1 = Enables R	Receive mode f	or I <sup>2</sup> C				
	0 = Receive is	s Idle					
bit 2	PEN: Stop Co	ondition Enable	bit <sup>(2)</sup>				
	1 = Initiates S 0 = Stop cond		n SDAx and S	CLx pins; autor	natically cleare	d by hardware	
bit 1	RSEN: Repea	ated Start Cond	lition Enable bi	t <sup>(2)</sup>			
		Repeated Start d Start condition		DAx and SCLx	pins; automati	cally cleared by	/ hardware
bit 0	SEN: Start Co	ondition Enable	bit <sup>(2)</sup>				
	1 = Initiates S	tart condition o	n SDAx and S	CLx pins; autor	natically cleare	d by hardware	

2: If the I<sup>2</sup>C module is active, these bits may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

]PIC18F86 REGISTER	K90供应商 <b>21-6: SSP</b> x	CON2: MSSF	Y CONTROI	REGISTER	2 (I <sup>2</sup> C™ SLA	VE MODE)	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ADMSK5	ADMSK4	ADMSK3	ADMSK2	ADMSK1	SEN <sup>(1)</sup>
bit 7	·	•		•		•	bit
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own
bit 6	0 = General c ACKSTAT: Ac	all address is c cknowledge Sta	lisabled	ddress (0000h)			
bit 5-2	Unused in Sla	ave mode.		hite (5 Rit Add	ress Masking r	node)	
Sit O Z	it 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled						
bit 1	ADMSK1: Sla	ave Address Le	ast Significant	bit(s) Mask Se	lect bit		
	In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled						
In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled							
bit 0				ve transmit and	I slave receive	(stretch enable	d)

If the I<sup>2</sup>C module is active, this bit may not be set (no spooling) and the SSPxBUF may not be written (or Note 1: writes to the SSPxBUF are disabled).

REGISTER 2	1-7: SSPX	WSK: FC I S	LAVEADDR	ESS MASK R	EGISTER (7-	BIIMASKIN	G MODE)
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0 <sup>(2)</sup>

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 MSK<7:0>: Slave Address Mask Select bit

bit 7

1 = Masking of the corresponding bit of SSPxADD is enabled

0 = Masking of the corresponding bit of SSPxADD is disabled

Note 1: This register shares the same SFR address as SSPxADD and is only addressable in select MSSPx operating modes. See Section 21.4.3.4 "7-Bit Address Masking Mode" for more details.

2: MSK0 is not used as a mask bit in 7-bit addressing.

bit 0

#### 查询PIC18F86K90供应商 21.4.2 OPERATION

The MSSP module functions are enabled by setting the MSSP Enable bit, SSPEN (SSPxCON1<5>).

The SSPxCON1 register allows control of the  $I^2C$  operation. Four mode selection bits (SSPxCON1<3:0>) allow one of the following  $I^2C$  modes to be selected:

- I<sup>2</sup>C Master mode, clock
- I<sup>2</sup>C Slave mode (7-bit address)
- I<sup>2</sup>C Slave mode (10-bit address)
- I<sup>2</sup>C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I<sup>2</sup>C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I<sup>2</sup>C Firmware Controlled Master mode, slave is Idle

Selection of any I<sup>2</sup>C mode with the SSPEN bit set forces the SCLx and SDAx pins to be open-drain, provided these pins are programmed as inputs by setting the appropriate TRISC or TRISD bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCLx and SDAx pins.

#### 21.4.3 SLAVE MODE

In Slave mode, the SCLx and SDAx pins must be configured as inputs (TRISC<4:3> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The  $I^2C$  Slave mode hardware will always generate an interrupt on an address match. Address masking will allow the hardware to generate an interrupt for more than one address (up to 31 in 7-bit addressing and up to 63 in 10-bit addressing). Through the mode select bits, the user can also choose to interrupt on Start and Stop bits.

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (ACK) pulse and load the SSPxBUF register with the received value currently in the SSPxSR register.

Any combination of the following conditions will cause the MSSP module not to give this ACK pulse:

- The Buffer Full bit, BF (SSPxSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPxCON1<6>), was set before the transfer was received.

In this case, the SSPxSR register value is not loaded into the SSPxBUF, but bit, SSPxIF, is set. The BF bit is cleared by reading the SSPxBUF register, while bit, SSPOV, is cleared through software.

The SCLx clock input must have a minimum high and low for proper operation. The high and low times of the  $I^2C$  specification, as well as the requirement of the MSSP module, are shown in timing parameter 100 and parameter 101.

#### 21.4.3.1 Addressing

Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPxSR register. All incoming bits are sampled with the rising edge of the clock (SCLx) line. The value of register, SSPxSR<7:1>, is compared to the value of the SSPxADD register. The address is compared on the falling edge of the eighth clock (SCLx) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

- 1. The SSPxSR register value is loaded into the SSPxBUF register.
- 2. The Buffer Full bit, BF, is set.
- 3. An ACK pulse is generated.
- 4. The MSSP Interrupt Flag bit, SSPxIF, is set (and interrupt is generated, if enabled) on the falling edge of the ninth SCLx pulse.

In 10-Bit Addressing mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. The  $R/\overline{W}$  bit (SSPxSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '11110 A9 A8 0', where 'A9' and 'A8' are the two MSbs of the address. The sequence of events for 10-bit addressing is as follows, with steps, 7 through 9, for the slave-transmitter:

- 1. Receive first (high) byte of address (bits, SSPxIF, BF and UA, are set on address match).
- 2. Update the SSPxADD register with second (low) byte of address (clears bit, UA, and releases the SCLx line).
- 3. Read the SSPxBUF register (clears bit, BF) and clear flag bit, SSPxIF.
- 4. Receive second (low) byte of address (bits, SSPxIF, BF and UA, are set).
- 5. Update the SSPxADD register with the first (high) byte of address. If match releases the SCLx line, this will clear bit, UA.
- 6. Read the SSPxBUF register (clears bit, BF) and clear flag bit, SSPxIF.
- 7. Receive Repeated Start condition.
- 8. Receive first (high) byte of address (bits, SSPxIF and BF, are set).
- 9. Read the SSPxBUF register (clears bit, BF) and clear flag bit, SSPxIF.

### 查询PIC18F86K90供应商

21.4.3.2 Address Masking Modes

Masking an address bit causes that bit to become a "don't care". When one address bit is masked, two addresses will be Acknowledged and cause an interrupt. It is possible to mask more than one address bit at a time, which greatly expands the number of addresses Acknowledged.

The  $l^2C$  slave behaves the same way whether address masking is used or not. However, when address masking is used, the  $l^2C$  slave can Acknowledge multiple addresses and cause interrupts. When this occurs, it is necessary to determine which address caused the interrupt by checking the SSPxBUF.

The PIC18F87K90 family of devices is capable of using two different Address Masking modes in  $I^2C$  slave operation: 5-Bit Address Masking and 7-Bit Address Masking. The Masking mode is selected at device configuration using the MSSPMSK Configuration bit. The default device configuration is 7-Bit Address Masking.

Both Masking modes, in turn, support address masking of 7-bit and 10-bit addresses. The combination of Masking modes and addresses provide different ranges of Acknowledgable addresses for each combination.

While both Masking modes function in roughly the same manner, the way they use address masks are different.

#### 21.4.3.3 5-Bit Address Masking Mode

As the name implies, 5-Bit Address Masking mode uses an address mask of up to 5 bits to create a range of addresses to be Acknowledged, using bits, 5 through 1, of the incoming address. This allows the module to Acknowledge up to 31 addresses when using 7-bit addressing, or 63 addresses with 10-bit addressing (see Example 21-2). This Masking mode is selected when the MSSPMSK Configuration bit is programmed ('0').

The address mask in this mode is stored in the SSPxCON2 register, which stops functioning as a control register in  $l^2C$  Slave mode (Register 21-6). In 7-Bit Address Masking mode, address mask bits, ADMSK<5:1> (SSPxCON2<5:1>), mask the corresponding address bits in the SSPxADD register. For any ADMSK bits that are set (ADMSK<n> = 1), the corresponding address bit is ignored (SSPxADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

In 10-Bit Address Masking mode, bits, ADMSK<5:2>, mask the corresponding address bits in the SSPxADD register. In addition, ADMSK1 simultaneously masks the two LSbs of the address (SSPxADD<1:0>). For any ADMSK bits that are active (ADMSK<n> = 1), the corresponding address bit is ignored (SPxADD<n> = x). Also note, that although in 10-Bit Address Masking mode, the upper address bits reuse part of the SSPxADD register bits. The address mask bits do not interact with those bits; they only affect the lower address bits.

Note 1: ADMSK1 masks the two Least Significant bits of the address.

 The two Most Significant bits of the address are not affected by address masking.

#### EXAMPLE 21-2: ADDRESS MASKING EXAMPLES IN 5-BIT MASKING MODE

#### 7-Bit Addressing:

SSPxADD<7:1>= A0h (1010000) (SSPxADD<0> is assumed to be '0')

```
ADMSK<5:1> = 00111
```

Addresses Acknowledged: A0h, A2h, A4h, A6h, A8h, AAh, ACh, AEh

#### 10-Bit Addressing:

SSPxADD<7:0> = A0h (10100000) (The two MSb of the address are ignored in this example, since they are not affected by masking)

ADMSK<5:1> = 00111

Addresses Acknowledged: A0h, A1h, A2h, A3h, A4h, A5h, A6h, A7h, A8h, A9h, AAh, ABh, ACh, ADh, AEh, AFh

### 查询PIC18F86K90供应商

#### 21.4.3.4 7-Bit Address Masking Mode

Unlike 5-bit masking, 7-Bit Address Masking mode uses a mask of up to 8 bits (in 10-bit addressing) to define a range of addresses that can be Acknowledged, using the lowest bits of the incoming address. This allows the module to Acknowledge up to 127 different addresses with 7-bit addressing, or 255 with 10-bit addressing (see Example 21-3). This mode is the default configuration of the module and is selected when MSSPMSK is unprogrammed ('1').

The address mask for 7-Bit Address Masking mode is stored in the SSPxMSK register, instead of the SSPxCON2 register. SSPxMSK is a separate hardware register within the module, but it is not directly addressable. Instead, it shares an address in the SFR space with the SSPxADD register. To access the SSPxMSK register, it is necessary to select MSSP mode, '1001' (SSPxCON1<3:0> = 1001) and then read or write to the location of SSPxADD.

To use 7-Bit Address Masking mode, it is necessary to initialize SSPxMSK with a value before selecting the  $I^2C$  Slave Addressing mode. Thus, the required sequence of events is:

- 1. Select SSPxMSK Access mode (SSPxCON2<3:0> = 1001).
- Write the mask value to the appropriate SSPxADD register address (FC8h for MSSP1, F6Eh for MSSP2).
- 3. Set the appropriate I<sup>2</sup>C Slave mode (SSPxCON2<3:0> = 0111 for 10-bit addressing, 0110 for 7-bit addressing).

Setting or clearing mask bits in SSPxMSK behaves in the opposite manner of the ADMSK bits in 5-Bit Address Masking mode. That is, clearing a bit in SSPxMSK causes the corresponding address bit to be masked; setting the bit requires a match in that position. SSPxMSK resets to all '1's upon any Reset condition and, therefore, has no effect on the standard MSSP operation until written with a mask value.

With 7-bit addressing, SSPxMSK<7:1> bits mask the corresponding address bits in the SSPxADD register. For any SSPxMSK bits that are active (SSPxMSK<n> = 0), the corresponding SSPxADD address bit is ignored (SSPxADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

With 10-bit addressing, SSPxMSK<7:0> bits mask the corresponding address bits in the SSPxADD register. For any SSPxMSK bits that are active (= 0), the corresponding SSPxADD address bit is ignored (SSPxADD

Note: The two Most Significant bits of the address are not affected by address masking.

#### EXAMPLE 21-3: ADDRESS MASKING EXAMPLES IN 7-BIT MASKING MODE

#### 7-Bit Addressing:

SSPxADD<7:1> = 1010 000

SSPxMSK<7:1> = 1111 001

Addresses Acknowledged = ACh, A8h, A4h, A0h

10-Bit Addressing:

SSPxADD<7:0> = 1010 0000

SSPxMSK<7:0> = 1111 0011

Addresses Acknowledged = ACh, A8h, A4h, A0h

#### 查询PIC18F86K90供应商 21.4.3.5 Reception

When the  $R/\overline{W}$  bit of the address byte is clear and an address match occurs, the  $R/\overline{W}$  bit of the SSPxSTAT register is cleared. The received address is loaded into the SSPxBUF register and the SDAx line is held low (ACK).

When the address byte overflow condition exists, then the no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit, BF (SSPxSTAT<0>), is set or bit, SSPOV (SSPxCON1<6>), is set.

An MSSP interrupt is generated for each data transfer byte. The interrupt flag bit, SSPxIF, must be cleared in software. The SSPxSTAT register is used to determine the status of the byte.

If SEN is enabled (SSPxCON2<0> = 1), SCLx will be held low (clock stretch) following each data transfer. The clock must be released by setting bit, CKP (SSPxCON1<4>). See **Section 21.4.4** "**Clock Stretching**" for more details.

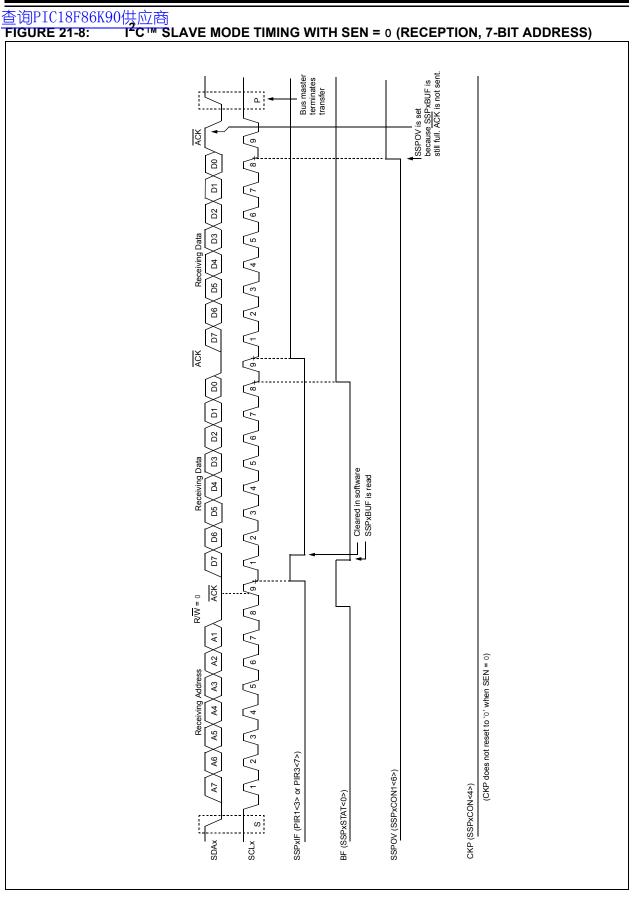
#### 21.4.3.6 Transmission

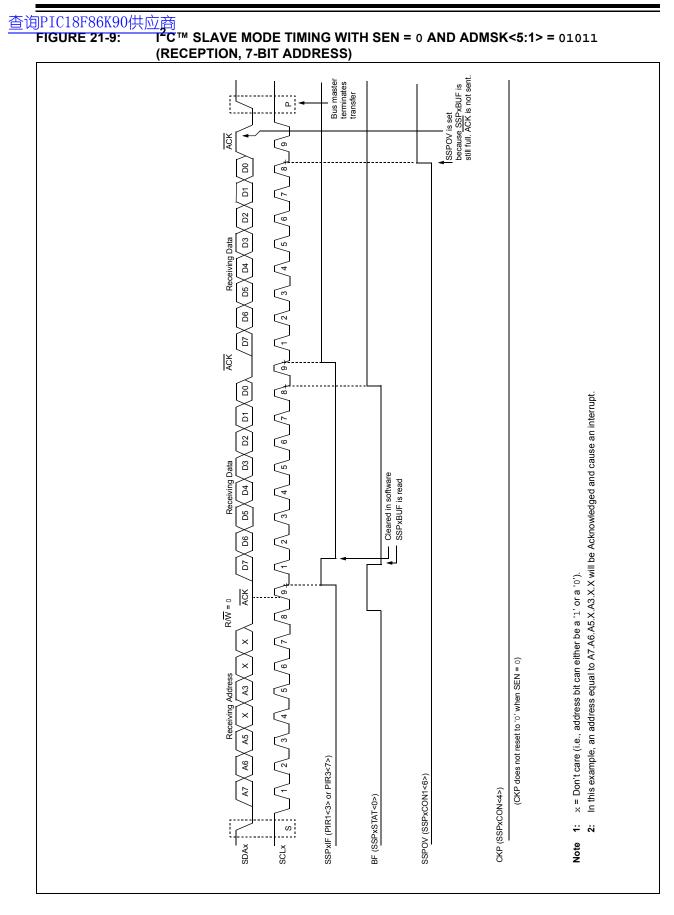
When the R/W bit of the incoming address byte is set and an address match occurs, the  $R/\overline{W}$  bit of the SSPxSTAT register is set. The received address is loaded into the SSPxBUF register. The ACK pulse will be sent on the ninth bit and pin, SCLx, is held low regardless of SEN (see Section 21.4.4 "Clock Stretching" for more details). By stretching the clock, the master will be unable to assert another clock pulse until the slave is done preparing the transmit data. The transmit data must be loaded into the SSPxBUF register which also loads the SSPxSR register. Then, pin, SCLx, should be enabled by setting bit, CKP (SSPxCON1<4>). The eight data bits are shifted out on the falling edge of the SCLx input. This ensures that the SDAx signal is valid during the SCLx high time (Figure 21-10).

The  $\overline{ACK}$  pulse from the master-receiver is latched on the rising edge of the ninth SCLx input pulse. If the SDAx line is high (not  $\overline{ACK}$ ), then the data transfer is complete. In this case, when the  $\overline{ACK}$  is latched by the slave, the slave logic is reset and the slave monitors for another occurrence of the Start bit. If the SDAx line was low ( $\overline{ACK}$ ), the next transmit data must be loaded into the SSPxBUF register. Again, pin, SCLx, must be enabled by setting bit, CKP.

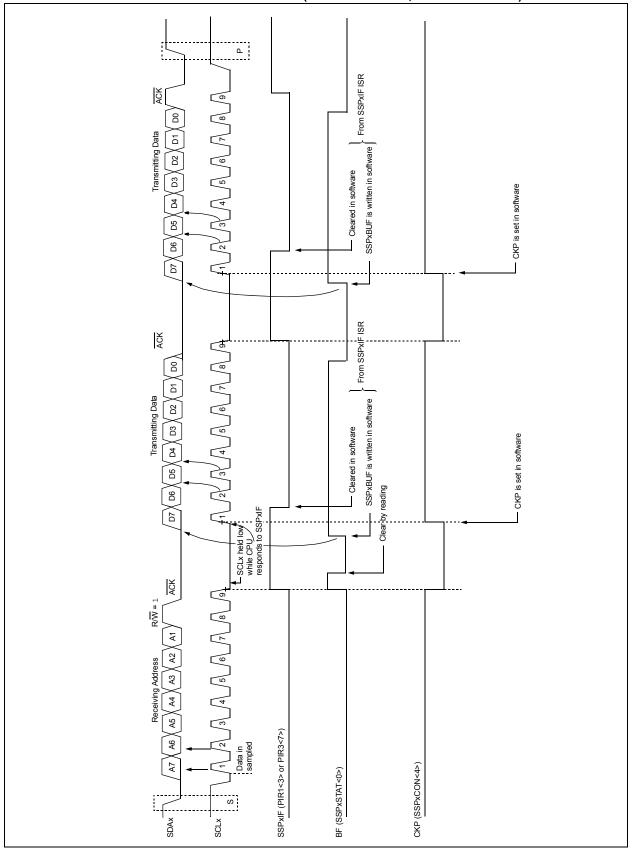
An MSSP interrupt is generated for each data transfer byte. The SSPxIF bit must be cleared in software and the SSPxSTAT register is used to determine the status of the byte. The SSPxIF bit is set on the falling edge of the ninth clock pulse.

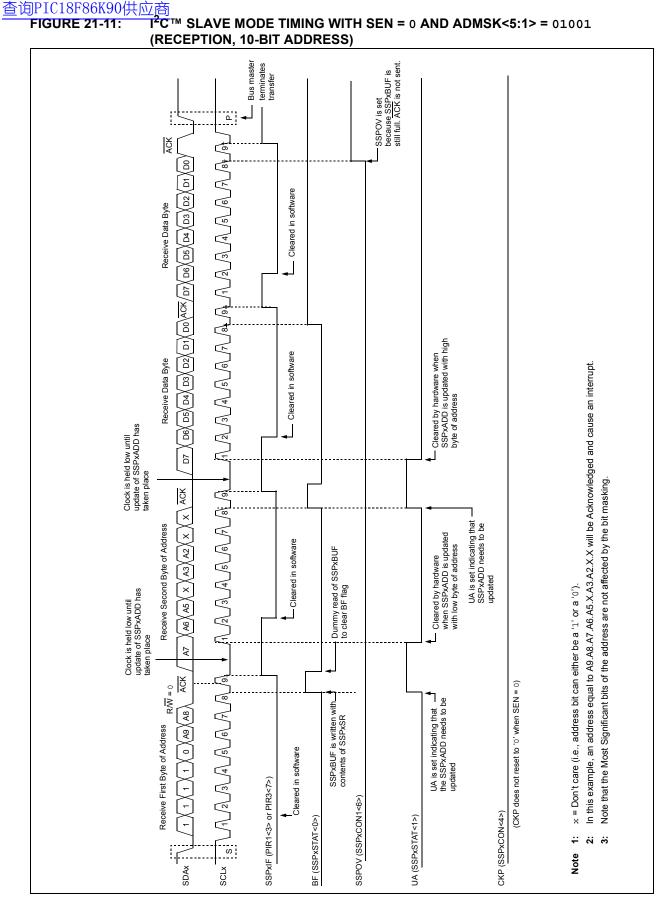


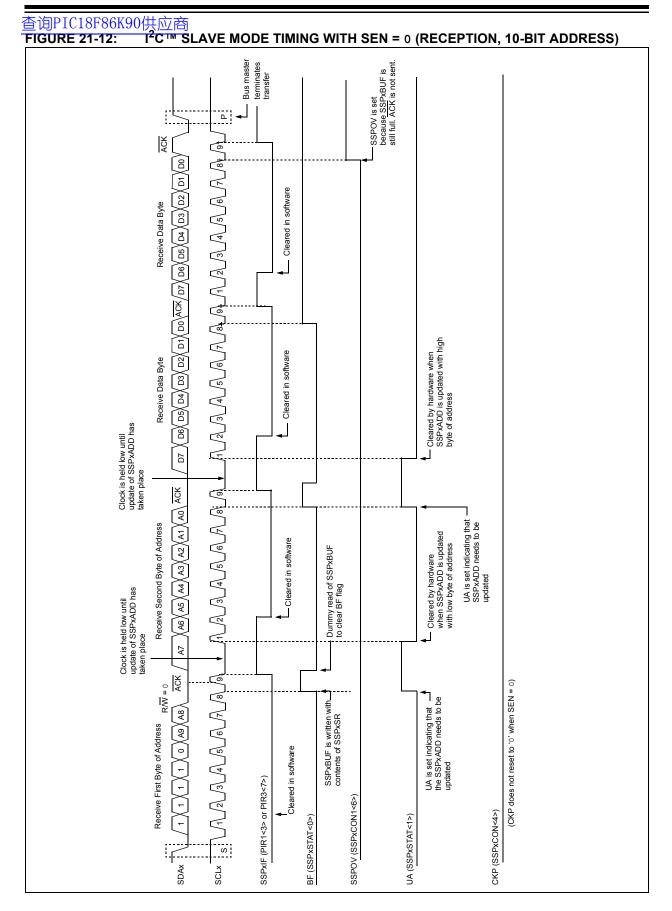


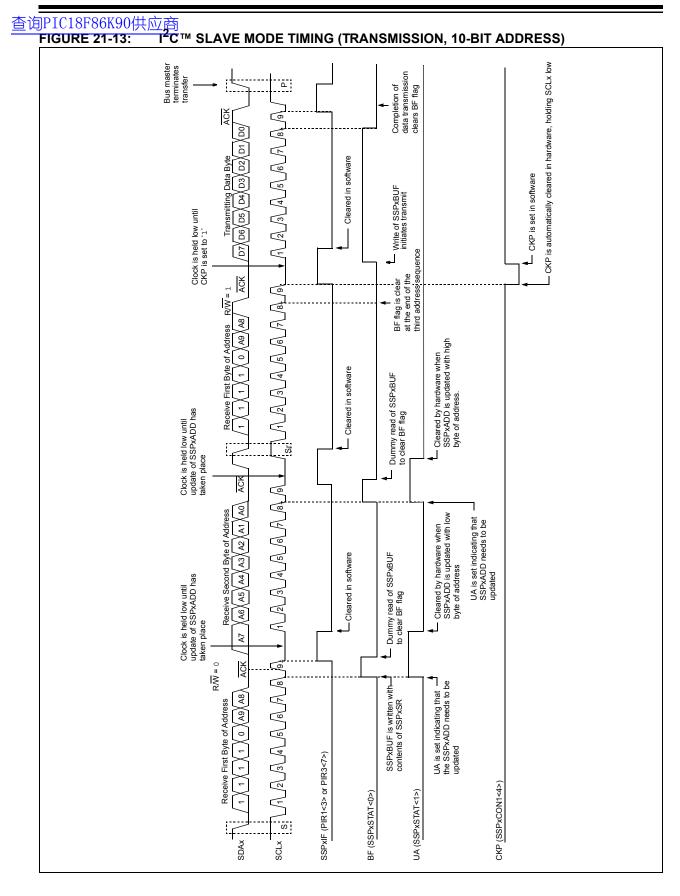


查询PIC18F86K90供应商 FIGURE 21-10: I<sup>2</sup>C™ SLAVE MODE TIMING (TRANSMISSION, 7-BIT ADDRESS)









#### 查询PIC18F86K90供应商 21.4.4 CLOCK STRETCHING

Both 7-Bit and 10-Bit Slave modes implement automatic clock stretching during a transmit sequence.

The SEN bit (SSPxCON2<0>) allows clock stretching to be enabled during receives. Setting SEN will cause the SCLx pin to be held low at the end of each data receive sequence.

#### 21.4.4.1 Clock Stretching for 7-Bit Slave Receive Mode (SEN = 1)

In 7-Bit Slave Receive mode, on the falling edge of the ninth clock at the end of the ACK sequence, if the BF bit is set, the CKP bit in the SSPxCON1 register is automatically cleared, forcing the SCLx output to be held low. The CKP bit being cleared to '0' will assert the SCLx line low. The CKP bit must be set in the user's ISR before reception is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and read the contents of the SSPxBUF before the master device can initiate another receive sequence. This will prevent buffer overruns from occurring (see Figure 21-15).

- Note 1: If the user reads the contents of the SSPxBUF before the falling edge of the ninth clock, thus clearing the BF bit, the CKP bit will not be cleared and clock stretching will not occur.
  - 2: The CKP bit can be set in software regardless of the state of the BF bit. The user should be careful to clear the BF bit in the ISR before the next receive sequence in order to prevent an overflow condition.

#### 21.4.4.2 Clock Stretching for 10-Bit Slave Receive Mode (SEN = 1)

In 10-Bit Slave Receive mode, during the address sequence, clock stretching automatically takes place but CKP is not cleared. During this time, if the UA bit is set after the ninth clock, clock stretching is initiated. The UA bit is set after receiving the upper byte of the 10-bit address and following the receive of the second byte of the 10-bit address with the R/W bit cleared to '0'. The release of the clock line occurs upon updating SSPxADD. Clock stretching will occur on each data receive sequence as described in 7-bit mode.

Note: If the user polls the UA bit and clears it by updating the SSPxADD register before the falling edge of the ninth clock occurs, and if the user hasn't cleared the BF bit by reading the SSPxBUF register before that time, then the CKP bit will still NOT be asserted low. Clock stretching on the basis of the state of the BF bit only occurs during a data sequence, not an address sequence.

#### 21.4.4.3 Clock Stretching for 7-Bit Slave Transmit Mode

The 7-Bit Slave Transmit mode implements clock stretching by clearing the CKP bit after the falling edge of the ninth clock if the BF bit is clear. This occurs regardless of the state of the SEN bit.

The user's ISR must set the CKP bit before transmission is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and load the contents of the SSPxBUF before the master device can initiate another transmit sequence (see Figure 21-10).

- Note 1: If the user loads the contents of SSPxBUF, setting the BF bit before the falling edge of the ninth clock, the CKP bit will not be cleared and clock stretching will not occur.
  - 2: The CKP bit can be set in software regardless of the state of the BF bit.

#### 21.4.4.4 Clock Stretching for 10-Bit Slave Transmit Mode

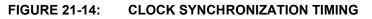
In 10-Bit Slave Transmit mode, clock stretching is controlled during the first two address sequences by the state of the UA bit, just as it is in 10-Bit Slave Receive mode. The first two addresses are followed by a third address sequence, which contains the high-order bits of the 10-bit address and the R/W bit set to '1'. After the third address sequence is performed, the UA bit is not set, the module is now configured in Transmit mode and clock stretching is controlled by the BF flag as in 7-Bit Slave Transmit mode (see Figure 21-13).

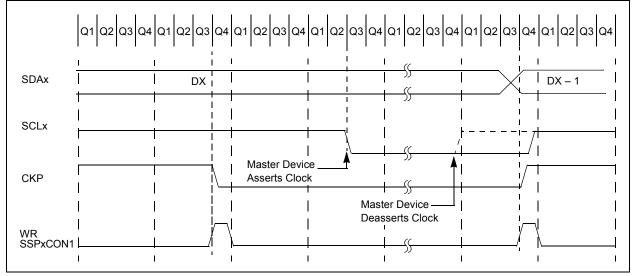
#### 查询PIC18F86K90供应商

### 21.4.4.5 Clock Synchronization and the CKP bit

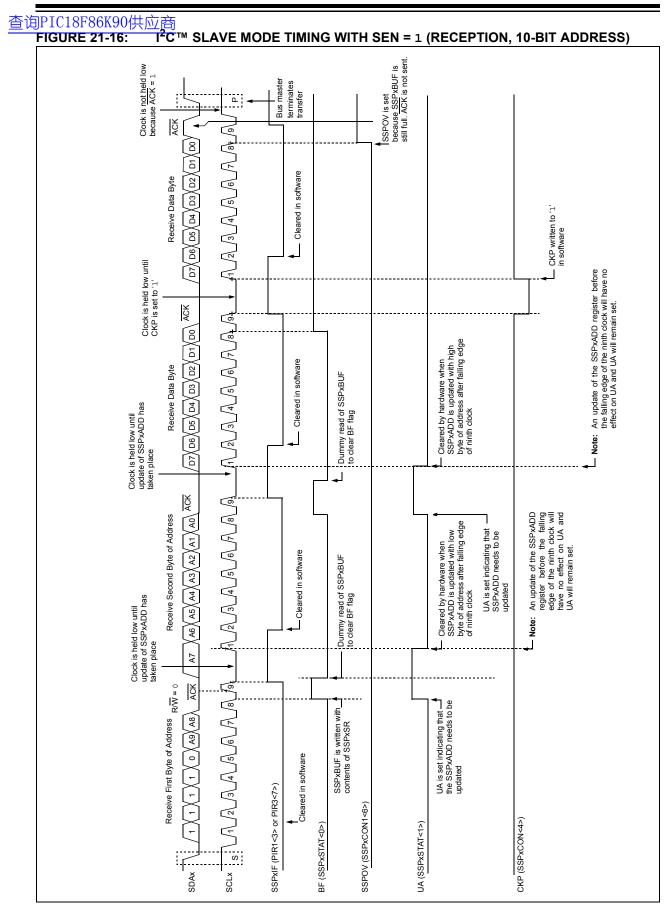
When the CKP bit is cleared, the SCLx output is forced to '0'. However, clearing the CKP bit will not assert the SCLx output low until the SCLx output is already sampled low. Therefore, the CKP bit will not assert the SCLx line until an external  $\rm I^2C$  master device has

already asserted the SCLx line. The SCLx output will remain low until the CKP bit is set and all other devices on the  $I^2$ C bus have deasserted SCLx. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCLx (see Figure 21-14).





#### 查询PIC18F86K90供应商 FIGURE 21-15: I<sup>2</sup>CI™ SLAVE MODE TIMING WITH SEN = 1 (RECEPTION, 7-BIT ADDRESS) Clock is not held low because ACK = 1SSPOV is set because <u>SSP</u>xBUF is still full. ACK is not sent. Bus master terminates transfer ٩ ACK 8 5 D2 Receiving Data D5 -CKP written to '1' in software Clock is held low until CKP is set to '1' × 8 BF is set after falling edge of the 9th clock, CKP is reset to '0' and clock stretching occurs 6 ACK 8 5 D2 Receiving Data Cleared in software D5 X D4 X Clock is not held low because buffer full bit is clear prior to falling edge of 9th clock If BF is cleared prior to the falling cdge of the 9th clock, CKP will not be reset to '0' and no clock stretching will occur SSPxBUF is read 8 F 20 ACK R/<u>W</u> = 0 Ł A2 Receiving Address a5 X a4 X a3 ) SSPxIF (PIR1<3> or PIR3<7>) A6 SSPOV (SSPxCON1<6>) A7 CKP (SSPxCON<4>) BF (SSPxSTAT<0>) s ļ SCLX SDAx



#### 查询PIC18F86K90供应商

#### 21.4.5 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I<sup>2</sup>C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the  $I^2C$  protocol. It consists of all '0's with R/W = 0.

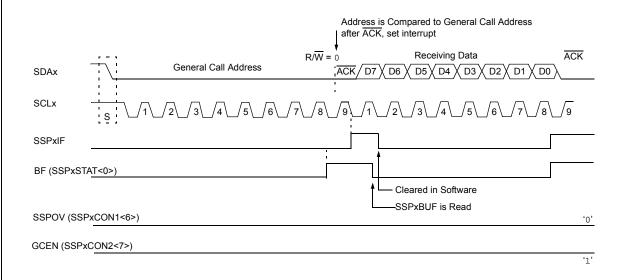
The general call address is recognized when the General Call Enable bit, GCEN, is enabled (SSPxCON2<7> set). Following a Start bit detect, 8 bits are shifted into the SSPxSR and the address is compared against the SSPxADD. It is also compared to the general call address and fixed in hardware.

If the general call address matches, the SSPxSR is transferred to the SSPxBUF, the BF flag bit is set (eighth bit), and on the falling edge of the ninth bit (ACK bit), the SSPxIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPxBUF. The value can be used to determine if the address was device-specific or a general call address.

In 10-Bit Addressing mode, the SSPxADD is required to be updated for the second half of the address to match and the UA bit is set (SSPxSTAT<1>). If the general call address is sampled when the GCEN bit is set, while the slave is configured in 10-Bit Addressing mode, then the second half of the address is not necessary, the UA bit will not be set and the slave will begin receiving data after the Acknowledge (Figure 21-17).





#### 查询PIC18F86K90供应商 21.4.6 MASTER MODE

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPxCON1 and by setting the SSPEN bit. In Master mode, the SCLx and SDAx lines are manipulated by the MSSP hardware if the TRIS bits are set.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the  $I^2C$  bus may be taken when the P bit is set, or the bus is Idle, with both the S and P bits clear.

In Firmware Controlled Master mode, user code conducts all  $I^2C$  bus operations based on Start and Stop bit conditions.

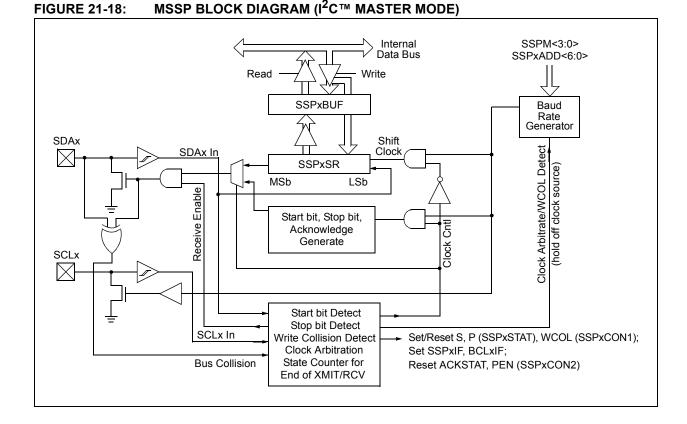
Once Master mode is enabled, the user has six options.

- 1. Assert a Start condition on SDAx and SCLx.
- 2. Assert a Repeated Start condition on SDAx and SCLx.
- 3. Write to the SSPxBUF register initiating transmission of data/address.
- 4. Configure the I<sup>2</sup>C port to receive data.
- 5. Generate an Acknowledge condition at the end of a received byte of data.
- 6. Generate a Stop condition on SDAx and SCLx.

Note: The MSSPx module, when configured in I<sup>2</sup>C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPxBUF register to initiate transmission before the Start condition is complete. In this case, the SSPxBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPxBUF did not occur.

The following events will cause the MSSPx Interrupt Flag bit, SSPxIF, to be set (and MSSP interrupt, if enabled):

- · Start condition
- · Stop condition
- Data transfer byte transmitted/received
- Acknowledge transmitted
- Repeated Start



### 查询PIC18F86K90供应商

21.4.6.1 I<sup>2</sup>C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I<sup>2</sup>C bus will not be released.

In Master Transmitter mode, serial data is output through SDAx while SCLx outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address, followed by a '1' to indicate the receive bit. Serial data is received via SDAx, while SCLx outputs the serial clock. Serial data is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

The Baud Rate Generator, used for the SPI mode operation, is used to set the SCLx clock frequency for either 100 kHz, 400 kHz or 1 MHz I<sup>2</sup>C operation. See **Section 21.4.7 "Baud Rate"** for more details.

A typical transmit sequence would go as follows:

- 1. The user generates a Start condition by setting the Start Enable bit, SEN (SSPxCON2<0>).
- SSPxIF is set. The MSSPx module will wait the required start time before any other operation takes place.
- 3. The user loads the SSPxBUF with the slave address to transmit.
- 4. Address is shifted out the SDAx pin until all 8 bits are transmitted.
- The MSSPx module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- The MSSPx module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- 7. The user loads the SSPxBUF with eight bits of data.
- 8. Data is shifted out the SDAx pin until all 8 bits are transmitted.
- The MSSPx module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- 10. The MSSPx module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- 11. The user generates a Stop condition by setting the Stop Enable bit, PEN (SSPxCON2<2>).
- 12. Interrupt is generated once the Stop condition is complete.

#### 查询PIC18F86K90供应商 21.4.7 BAUD RATE

In I<sup>2</sup>C Master mode, the Baud Rate Generator (BRG) reload value is placed in the lower 7 bits of the SSPxADD register (Figure 21-19). When a write occurs to SSPxBUF, the Baud Rate Generator will automatically begin counting. The BRG counts down to 0 and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TcY) on the Q2 and Q4 clocks. In I<sup>2</sup>C Master mode, the BRG is reloaded automatically.

Once the given operation is complete (i.e., transmission of the last data bit is followed by ACK), the internal clock will automatically stop counting and the SCLx pin will remain in its last state.

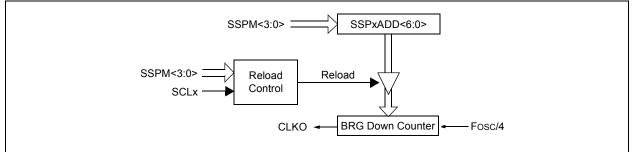
Table 21-3 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPxADD. The SSPxADD BRG value of  $0 \ge 00$  is not supported.

#### 21.4.7.1 Baud Rate and Module Interdependence

Because MSSP1 and MSSP2 are independent, they can operate simultaneously in I<sup>2</sup>C Master mode at different baud rates. This is done by using different BRG reload values for each module.

Because this mode derives its basic clock source from the system clock, any changes to the clock will affect both modules in the same proportion. It may be possible to change one or both baud rates back to a previous value by changing the BRG reload value.

#### FIGURE 21-19: BAUD RATE GENERATOR BLOCK DIAGRAM



#### TABLE 21-3: I<sup>2</sup>C<sup>™</sup> CLOCK RATE w/BRG

Fosc	Fcy	Fcy * 2	BRG Value	FscL (2 Rollovers of BRG)
40 MHz	10 MHz	20 MHz	18h	400 kHz <sup>(1)</sup>
40 MHz	10 MHz	20 MHz	1Fh	312.5 kHz
40 MHz	10 MHz	20 MHz	63h	100 kHz
16 MHz	4 MHz	8 MHz	09h	400 kHz <sup>(1)</sup>
16 MHz	4 MHz	8 MHz	0Ch	308 kHz
16 MHz	4 MHz	8 MHz	27h	100 kHz
4 MHz	1 MHz	2 MHz	02h	333 kHz <sup>(1)</sup>
4 MHz	1 MHz	2 MHz	09h	100 kHz
16 MHz <sup>(2)</sup>	4 MHz	8 MHz	03h	1 MHz <sup>(1)</sup>

**Note 1:** The I<sup>2</sup>C<sup>™</sup> interface does not conform to the 400 kHz I<sup>2</sup>C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

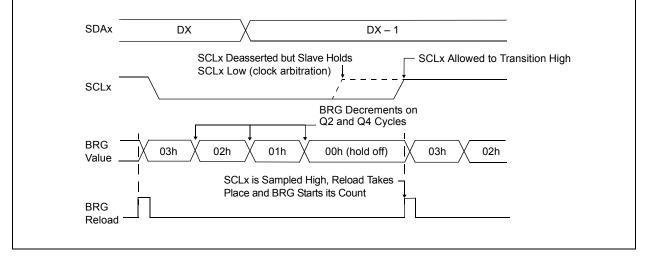
**2:** A minimum of 16 MHz Fosc is required to get the 1 MHz  $I^2C$ .

#### 查询PIC18F86K90供应商 21.4.7.2 Clock Arbitration

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, deasserts the SCLx pin (SCLx allowed to float high). When the SCLx pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCLx pin is actually sampled high. When the

SCLx pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. This ensures that the SCLx high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 21-20).





#### 查询PIC18F86K90供应商 21.4.8 ℃™ MASTER MODE START CONDITION TIMING

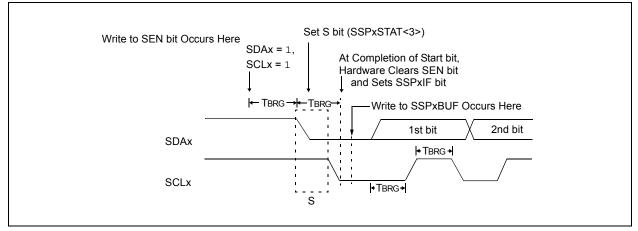
To initiate a Start condition, the user sets the Start Enable bit, SEN (SSPxCON2<0>). If the SDAx and SCLx pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and starts its count. If SCLx and SDAx are both sampled high when the Baud Rate Generator times out (TBRG), the SDAx pin is driven low. The action of the SDAx being driven low while SCLx is high is the Start condition and causes the S bit (SSPxSTAT<3>) to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit (SSPxCON2<0>) will be automatically cleared by hardware. The Baud Rate Generator is suspended, leaving the SDAx line held low and the Start condition is complete.

Note: If, at the beginning of the Start condition, the SDAx and SCLx pins are already sampled low or if during the Start condition, the SCLx line is sampled low before the SDAx line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCLxIF, is set, the Start condition is aborted and the I<sup>2</sup>C module is reset into its Idle state.

#### 21.4.8.1 WCOL Status Flag

If the user writes the SSPxBUF when a Start sequence is in progress, the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPxCON2 is disabled until the Start condition is complete.



#### FIGURE 21-21: FIRST START BIT TIMING

#### 查询PIC18F86K90供应商

#### 21.4.9 I<sup>2</sup>C<sup>™</sup> MASTER MODE REPEATED START CONDITION TIMING

A Repeated Start condition occurs when the RSEN bit (SSPxCON2<1>) is programmed high and the I<sup>2</sup>C logic module is in the Idle state. When the RSEN bit is set, the SCLx pin is asserted low. When the SCLx pin is sampled low, the Baud Rate Generator is loaded with the contents of SSPxADD<5:0> and begins counting. The SDAx pin is released (brought high) for one Baud Rate Generator count (TBRG). When the Baud Rate Generator times out, and if SDAx is sampled high, the SCLx pin will be deasserted (brought high). When SCLx is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. SDAx and SCLx must be sampled high for one TBRG. This action is then followed by assertion of the SDAx pin (SDAx = 0) for one TBRG while SCLx is high. Following this, the RSEN bit (SSPxCON2<1>) will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDAx pin held low. As soon as a Start condition is detected on the SDAx and SCLx pins, the S bit (SSPxSTAT<3>) will be set. The SSPxIF bit will not be set until the Baud Rate Generator has timed out.

- Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.
  - **2:** A bus collision during the Repeated Start condition occurs if:
    - SDAx is sampled low when SCLx goes from low-to-high.
    - SCLx goes low before SDAx is asserted low. This may indicate that another master is attempting to transmit a data '1'.

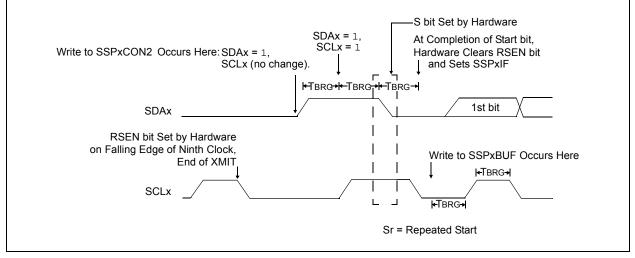
Immediately following the SSPxIF bit getting set, the user may write the SSPxBUF with the 7-bit address in 7-bit mode or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

#### 21.4.9.1 WCOL Status Flag

If the user writes the SSPxBUF when a Repeated Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPxCON2 is disabled until the Repeated Start condition is complete.

#### FIGURE 21-22: REPEATED START CONDITION WAVEFORM



#### 查询PIC18F86K90供应商 21.4.10 I<sup>2</sup>C™ MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address or the other half of a 10-bit address, is accomplished by simply writing a value to the SSPxBUF register. This action will set the Buffer Full flag bit, BF, and allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDAx pin after the falling edge of SCLx is asserted (see data hold time specification parameter 106). SCLx is held low for one Baud Rate Generator rollover count (TBRG). Data should be valid before SCLx is released high (see data setup time specification parameter 107). When the SCLx pin is released high, it is held that way for TBRG. The data on the SDAx pin must remain stable for that duration and some hold time after the next falling edge of SCLx. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDAx. This allows the slave device being addressed to respond with an ACK bit during the ninth bit time if an address match occurred, or if data was received properly. The status of ACK is written into the ACKDT bit on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge Status bit, ACKSTAT, is cleared; if not, the bit is set. After the ninth clock, the SSPxIF bit is set and the master clock (Baud Rate Generator) is suspended until the next data byte is loaded into the SSPxBUF, leaving SCLx low and SDAx unchanged (Figure 21-23).

After the write to the SSPxBUF, each bit of the address will be shifted out on the falling edge of SCLx until all seven address bits and the R/W bit are completed. On the falling edge of the eighth clock, the master will deassert the SDAx pin, allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDAx pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPxCON2<6>). Following the falling edge of the ninth clock transmission of the address, the SSPxIF flag is set, the BF flag is cleared and the Baud Rate Generator is turned off until another write to the SSPxBUF takes place, holding SCLx low and allowing SDAx to float.

#### 21.4.10.1 BF Status Flag

In Transmit mode, the BF bit (SSPxSTAT<0>) is set when the CPU writes to SSPxBUF and is cleared when all 8 bits are shifted out.

#### 21.4.10.2 WCOL Status Flag

If the user writes the SSPxBUF when a transmit is already in progress (i.e., SSPxSR is still shifting out a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur) after 2 TCY after the SSPxBUF write. If SSPxBUF is rewritten within 2 TCY, the WCOL bit is set and SSPxBUF is updated. This may result in a corrupted transfer.

The user should verify that the WCOL bit is clear after each write to SSPxBUF to ensure the transfer is correct. In all cases, WCOL must be cleared in software.

#### 21.4.10.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPxCON2<6>) is cleared when the slave has sent an Acknowledge  $(\overline{ACK} = 0)$  and is set when the slave does not Acknowledge  $(\overline{ACK} = 1)$ . A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

#### 21.4.11 I<sup>2</sup>C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPxCON2<3>).

Note: The MSSP module must be in an inactive state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting, and on each rollover, the state of the SCLx pin changes (high-to-low/low-to-high) and data is shifted into the SSPxSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPxSR are loaded into the SSPxBUF, the BF flag bit is set, the SSPxIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCLx low. The MSSP is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable bit, ACKEN (SSPxCON2<4>).

#### 21.4.11.1 BF Status Flag

In receive operation, the BF bit is set when an address or data byte is loaded into SSPxBUF from SSPxSR. It is cleared when the SSPxBUF register is read.

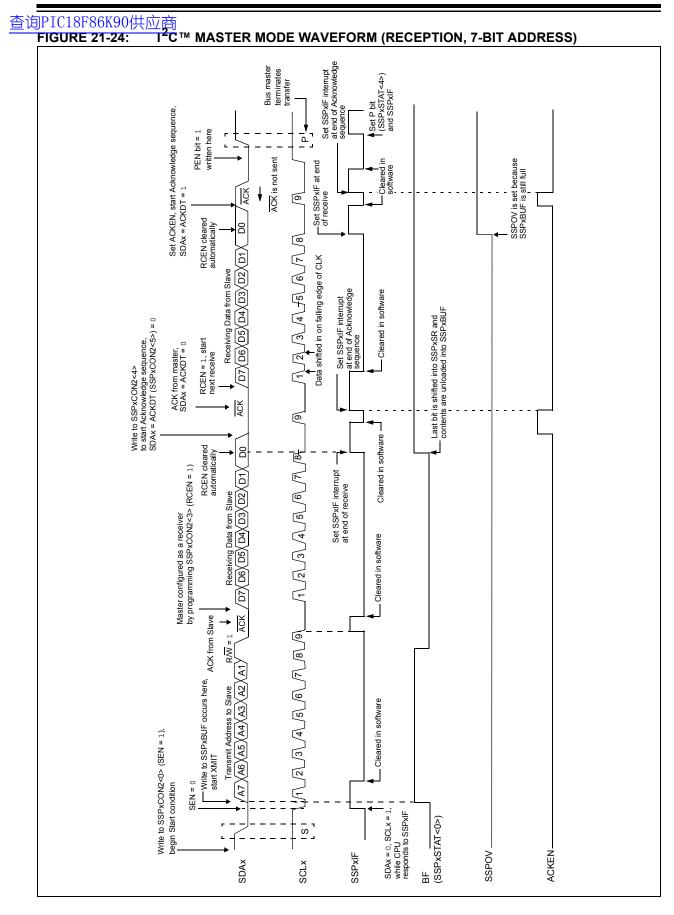
#### 21.4.11.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when 8 bits are received into the SSPxSR and the BF flag bit is already set from a previous reception.

#### 21.4.11.3 WCOL Status Flag

If the user writes the SSPxBUF when a receive is already in progress (i.e., SSPxSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

#### 查询PIC18F86K90供应商 FIGURE 21-23: 1<sup>2</sup>C™ MASTER MODE WAVEFORM (TRANSMISSION, 7 OR 10-BIT ADDRESS) SSPxCON2 = 1 software ACKSTAT in ٩ Cleared 6 ACK From slave, clear ACKSTAT bit (SSPxCON2<6>) $\sqrt{3}$ $\sqrt{4}$ 5 6 7 8DO Cleared in software service routine from MSSP interrupt Б SSPxBUF is written in software Transmitting Data or Second Half $D3 \times$ D4 ess D5X of 10-bit De 2 1 SCLx held low while CPU \ responds to SSPxIF 17 (~ ACK = 06 R/W = 0 After Start condition, SEN cleared by hardware $\mathsf{SSPxBUF}$ written with 7-bit address and $\mathsf{R}\overline{\mathsf{W}},$ start transmit 8 5 F /5/ /6 A6 🗙 A5 🗙 A4 🗙 A3 🗙 A2 👌 Transmit Address to Slave Cleared in software Write SSPxCON2<0> (SEN = 1), 4 SSPxBUF written 2 3 Start condition begins SEN = 0Ā $\overline{}$ BF (SSPxSTAT<0>) S . SSPxIF SDAX SCLX SEN PEN R/V



#### 查询PIC18F86K90供应商

#### 21.4.12 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence Enable bit. ACKEN (SSPxCON2<4>). When this bit is set, the SCLx pin is pulled low and the contents of the Acknowledge data bit are presented on the SDAx pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (TBRG) and the SCLx pin is deasserted (pulled high). When the SCLx pin is sampled high (clock arbitration), the Baud Rate Generator counts for TBRG; the SCLx pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into an inactive state (Figure 21-25).

#### 21.4.12.1 WCOL Status Flag

If the user writes the SSPxBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

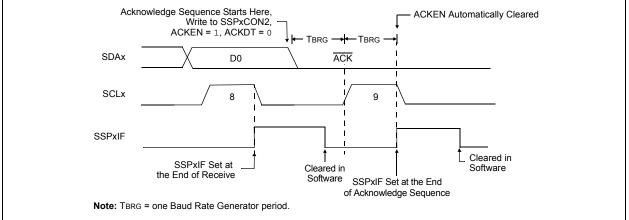
#### 21.4.13 STOP CONDITION TIMING

A Stop bit is asserted on the SDAx pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPxCON2<2>). At the end of a receive/transmit, the SCLx line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDAx line low. When the SDAx line is sampled low, the Baud Rate Generator is reloaded and counts down to 0. When the Baud Rate Generator times out, the SCLx pin will be brought high and one TBRG (Baud Rate Generator rollover count) later, the SDAx pin will be deasserted. When the SDAx pin is sampled high while SCLx is high, the P bit (SSPxSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPxIF bit is set (Figure 21-26).

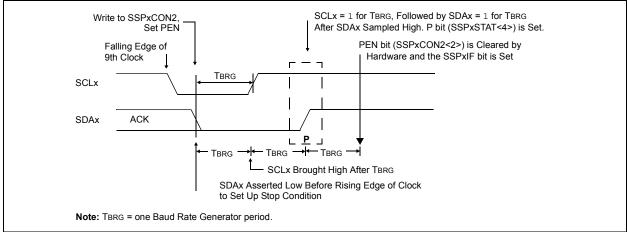
#### 21.4.13.1 WCOL Status Flag

If the user writes the SSPxBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

#### FIGURE 21-25: ACKNOWLEDGE SEQUENCE WAVEFORM



#### FIGURE 21-26: STOP CONDITION RECEIVE OR TRANSMIT MODE



#### 查询PIC18F86K90供应商 21.4.14 SLEEP OPERATION

While in Sleep mode, the I<sup>2</sup>C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

#### 21.4.15 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

#### 21.4.16 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the  $I^2C$  bus may be taken when the P bit (SSPxSTAT<4>) is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the MSSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDAx line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware with the result placed in the BCLxIF bit.

The states where arbitration can be lost are:

- · Address Transfer
- Data Transfer
- A Start Condition
- A Repeated Start Condition
- An Acknowledge Condition

#### 21.4.17 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDAx pin, arbitration takes place when the master outputs a '1' on SDAx, by letting SDAx float high, and another master asserts a '0'. When the SCLx pin floats high, data should be stable. If the expected data on SDAx is a '1' and the data sampled on the SDAx pin = 0, then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLxIF, and reset the  $l^2C$  port to its Idle state (Figure 21-27).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDAx and SCLx lines are deasserted and the SSPxBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the  $I^2C$  bus is free, the user can resume communication by asserting a Start condition.

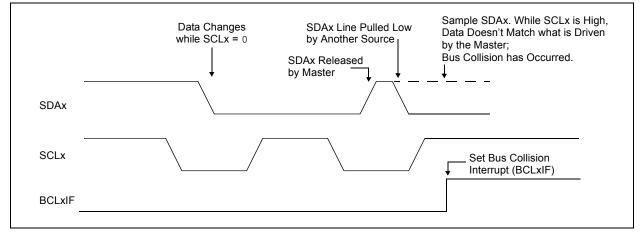
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDAx and SCLx lines are deasserted and the respective control bits in the SSPxCON2 register are cleared. When the user services the bus collision Interrupt Service Routine, and if the I<sup>2</sup>C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDAx and SCLx pins. If a Stop condition occurs, the SSPxIF bit will be set.

A write to the SSPxBUF will start the transmission of data at the first data bit regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I<sup>2</sup>C bus can be taken when the P bit is set in the SSPxSTAT register, or the bus is Idle and the S and P bits are cleared.

#### FIGURE 21-27: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE



#### 查询PIC18F86K90供应商

#### 21.4.17.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

- a) SDAx or SCLx is sampled low at the beginning of the Start condition (Figure 21-28).
- b) SCLx is sampled low before SDAx is asserted low (Figure 21-29).

During a Start condition, both the SDAx and the SCLx pins are monitored.

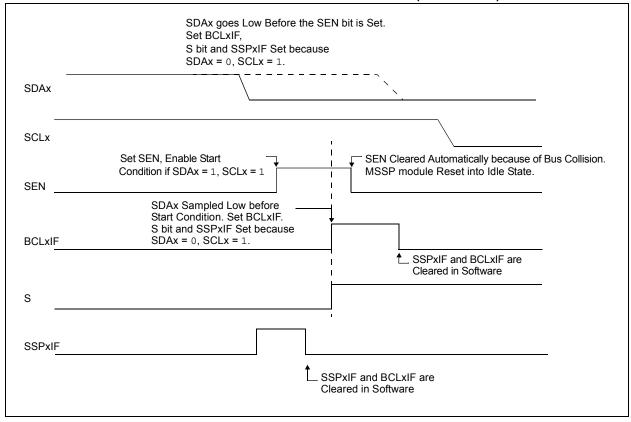
If the SDAx pin is already low, or the SCLx pin is already low, then all of the following occur:

- · the Start condition is aborted,
- the BCLxIF flag is set and
- the MSSP module is reset to its inactive state (Figure 21-28)

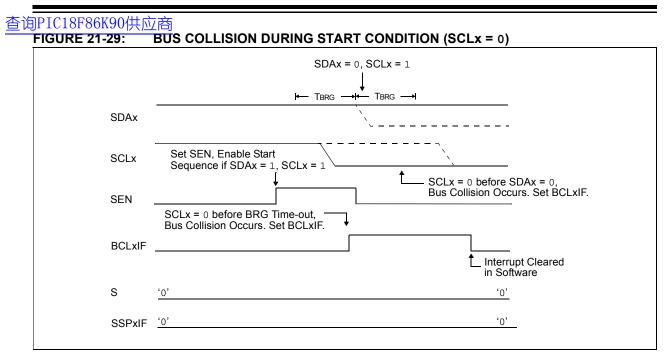
The Start condition begins with the SDAx and SCLx pins deasserted. When the SDAx pin is sampled high, the Baud Rate Generator is loaded from SSPxADD<6:0> and counts down to 0. If the SCLx pin is sampled low while SDAx is high, a bus collision occurs because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDAx pin is sampled low during this count, the BRG is reset and the SDAx line is asserted early (Figure 21-30). If, however, a '1' is sampled on the SDAx pin, the SDAx pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to 0. If the SCLx pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCLx pin is asserted low.

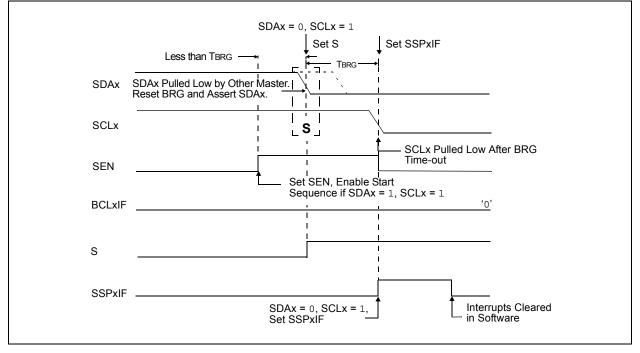
Note: The reason that bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDAx before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.



#### FIGURE 21-28: BUS COLLISION DURING START CONDITION (SDAx ONLY)



#### FIGURE 21-30: BRG RESET DUE TO SDAX ARBITRATION DURING START CONDITION



© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

21.4.17.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

- a) A low level is sampled on SDAx when SCLx goes from a low level to a high level.
- b) SCLx goes low before SDAx is asserted low, indicating that another master is attempting to transmit a data '1'.

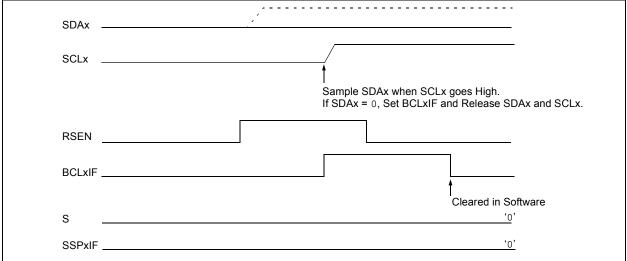
When the user deasserts SDAx and the pin is allowed to float high, the BRG is loaded with SSPxADD<6:0> and counts down to 0. The SCLx pin is then deasserted and when sampled high, the SDAx pin is sampled.

If SDAx is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', Figure 21-31). If SDAx is sampled high, the BRG is reloaded and begins counting. If SDAx goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDAx at exactly the same time.

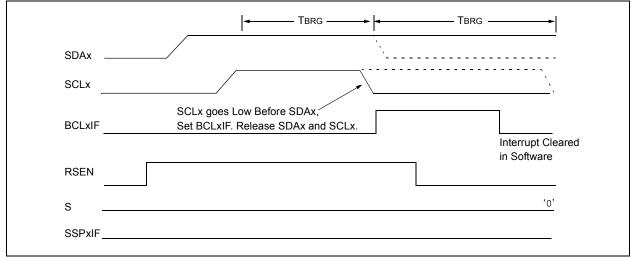
If SCLx goes from high-to-low before the BRG times out and SDAx has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (see Figure 21-32).

If, at the end of the BRG time-out, both SCLx and SDAx are still high, the SDAx pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCLx pin, the SCLx pin is driven low and the Repeated Start condition is complete.

#### FIGURE 21-31: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)



#### FIGURE 21-32: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



#### 查询PIC18F86K90供应商

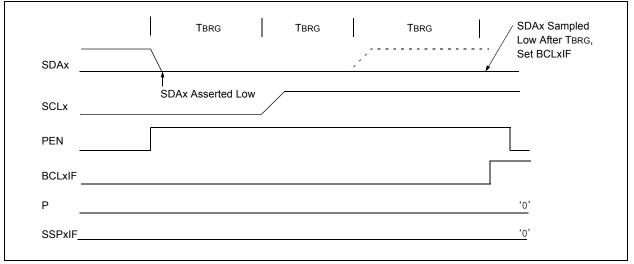
21.4.17.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

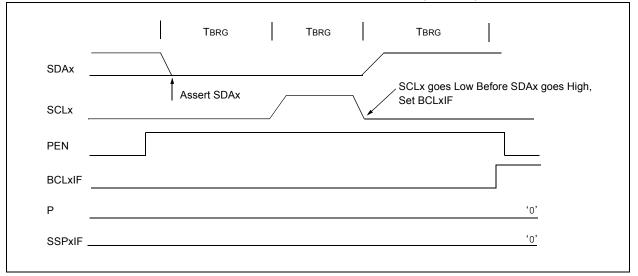
- After the SDAx pin has been deasserted and allowed to float high, SDAx is sampled low after the BRG has timed out.
- b) After the SCLx pin is deasserted, SCLx is sampled low before SDAx goes high.

The Stop condition begins with SDAx asserted low. When SDAx is sampled low, the SCLx pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPxADD<6:0> and counts down to 0. After the BRG times out, SDAx is sampled. If SDAx is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 21-33). If the SCLx pin is sampled low before SDAx is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 21-34).

#### FIGURE 21-33: BUS COLLISION DURING A STOP CONDITION (CASE 1)



#### FIGURE 21-34: BUS COLLISION DURING A STOP CONDITION (CASE 2)



### 查询PIC18F86K90供应商 TABLE 21-4: REGISTERS ASSOCIATED WITH I<sup>2</sup>C™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR2	OSCFIF	_	SSP2IF	BLC2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE		SSP2IE	BLC2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
IPR2	OSCFIP		SSP2IP	BLC2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	76
SSP1BUF	MSSP1 R	eceive Buffe	r/Transmit R	egister					74
		ddress Regis aud Rate Re							74
SSP1MSK <sup>(1)</sup>	MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0	—
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	74
000400000	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	74
SSP1CON2	GCEN	ACKSTAT	ADMSK5(2)	ADMSK4 <sup>(2)</sup>	ADMSK3(2)	ADMSK2(2)	ADMSK1(2)	SEN	74
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	74
SSP2BUF	MSSP2 R	eceive Buffe	r/Transmit R	egister		I			80
		ddress Regis aud Rate Re			er mode)				80
SSP2MSK <sup>(1)</sup>	MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0	—
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	80
	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0.1
SSP2CON2	GCEN	ACKSTAT	ADMSK5 <sup>(2)</sup>	ADMSK4(2)	ADMSK3(2)	ADMSK2(2)	ADMSK1(2)	SEN	81
SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	80

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by the MSSP module in  $I^2C^{TM}$  mode.

Note 1: SSPxMSK shares the same address in SFR space as SSPxADD, but is only accessible in certain  $I^2C^{M}$ Slave operating modes in 7-Bit Masking mode. See Section 21.4.3.4 "7-Bit Address Masking Mode" for more details.

2: Alternate bit definitions for use in I<sup>2</sup>C Slave mode operations only.

#### 查询PIC18F86K90供应商 22.0 ENHANCED UNIVERSAL

### SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (EUSART)

The Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) module is one of two serial I/O modules. (Generically, the EUSART is also known as a Serial Communications Interface or SCI.) The EUSART can be configured as a full-duplex, asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers. It can also be configured as a half-duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

The Enhanced USART module implements additional features, including automatic baud rate detection and calibration, automatic wake-up on Sync Break reception and 12-bit Break character transmit. These make it ideally suited for use in Local Interconnect Network bus (LIN/J2602 bus) systems.

All members of the PIC18F87K90 family are equipped with two independent EUSART modules, referred to as EUSART1 and EUSART2. They can be configured in the following modes:

- Asynchronous (full duplex) with:
  - Auto-wake-up on character reception
  - Auto-baud calibration
  - 12-bit Break character transmission
- Synchronous Master (half duplex) with selectable clock polarity
- Synchronous Slave (half duplex) with selectable clock polarity

The pins of EUSART1 and EUSART2 are multiplexed with the functions of PORTC (RC6/TX1/CK1/ SEG27 and RC7/RX1/DT1/SEG28) and PORTG (RG1/TX2/CK2/AN19/C3OUT and RG2/RX2/DT2/ AN18/C3INA), respectively. In order to configure these pins as an EUSART:

- For EUSART1:
  - SPEN (RCSTA1<7>) bit must be set (= 1)
  - TRISC<7> bit must be set (= 1)
  - TRISC<6> bit must be cleared (= 0) for Asynchronous and Synchronous Master modes
  - TRISC<6> bit must be set (= 1) for Synchronous Slave mode
- For EUSART2:
  - SPEN (RCSTA2<7>) bit must be set (= 1)
  - TRISG<2> bit must be set (= 1)
  - TRISG<1> bit must be cleared (= 0) for Asynchronous and Synchronous Master modes
  - TRISC<6> bit must be set (= 1) for Synchronous Slave mode

Note:	The EUSART control will automatically
	reconfigure the pin from input to output as
	needed.

The operation of each Enhanced USART module is controlled through three registers:

- Transmit Status and Control (TXSTAx)
- Receive Status and Control (RCSTAx)
- Baud Rate Control (BAUDCONx)

These are detailed in Register 22-1, Register 22-2 and Register 22-3, respectively, on the following pages.

Note: Throughout this section, references to register and bit names that may be associated with a specific EUSART module are referred to generically by the use of 'x' in place of the specific module number. Thus, "RCSTAx" might refer to the Receive Status register for either EUSART1 or EUSART2.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN <sup>(1)</sup>	SYNC	SENDB	BRGH	TRMT	TX9D
bit 7		•	l		1		bit C
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimpler	nented bit, rea	id as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7	CSRC: Cloc	k Source Select	bit				
	Asynchrono	us mode:					
	Don't care.						
	Synchronou						
		node (clock gene ode (clock from					
bit 6		ransmit Enable b		,			
	1 = Selects	9-bit transmissio	n				
	0 = Selects	8-bit transmissio	n				
bit 5		smit Enable bit <sup>(1</sup>	)				
		it is enabled					
hit 1		it isndisabled ART Mode Sele	at bit				
bit 4	1 = Synchro						
		onous mode					
bit 3	SENDB: Se	nd Break Charad	cter bit				
	<u>Asynchrono</u>						
		nc Break on nex			irdware upon o	completion)	
	0 = Sync Br Synchronou	eak transmissior	i nas complete	ea			
	Don't care.	<u>s mode.</u>					
bit 2	BRGH: High	n Baud Rate Sele	ect bit				
	<u>Asynchrono</u>						
	1 = High spe 0 = Low spe						
	<u>Synchronou</u>						
	Unused in th						
bit 1	TRMT: Tran	smit Shift Regist	er Status bit				
	1 = TSR is e						
	0 = TSR is f						
bit 0	TX9D: 9th b	it of Transmit Da	ita				
		ddress/data bit o					

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9
bit 7							
Logondi							
Legend: R = Readab	le bit	W = Writable	oit	U = Unimplen	nented bit, rea	d as '0'	
-n = Value a		'1' = Bit is set		'0' = Bit is cle		x = Bit is unkn	own
bit 7	SPEN: Seria	I Port Enable bit	:				
		ort is enabled					
	0 = Serial is	port disabled (h	eld in Reset)				
bit 6		eceive Enable b	it				
		9-bit reception					
bit 5		8-bit reception e Receive Enab	la hit				
DIL D	Asynchronou						
	Don't care.	<u>io modo</u> .					
		s mode – Master	<u>:</u>				
		single receive					
		s single receive ared after recep	tion is compl	ete			
		s mode – Slave:					
	Don't care.						
bit 4	CREN: Cont	inuous Receive	Enable bit				
	Asynchronou						
	1 = Enables 0 = Disables	the receiver the receiver					
	Synchronous						
			eive until enal	ole bit, CREN, is	cleared (CRE	N overrides SR	EN)
	0 = Disables	s continuous rec	eive				
bit 3		dress Detect En					
		<u>is mode 9-Bit (R</u>		- 4			
						buffer when RS be used as pari	
		is mode 9-Bit (R	-				cy on
	Don't care.	······································	<u> </u>				
bit 2	FERR: Fram	ing Error bit					
	-	•	eared by read	ding the RCREG	Sx register and	receiving the ne	ext valid l
	0 = No fram	•					
bit 1	OERR: Over						
	1 = Overrun 0 = No over	error (can be cl	eared by clea	iring bit, CREN)			
bit 0		it of Received D	ata				

R/W-0	R-1	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN
bit 7		I	1				bit (
Legend:							
R = Readabl	le bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'	
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
				o			
bit 7		Auto-Baud Acquis			Detectmede		
		rollover has occur e cleared in soft	•	uto-Baud Rate	Detect mode		
	•	G rollover has oc	,				
bit 6	RCIDL: Rec	eive Operation I	dle Status bit				
	1 = Receive	operation is Idle	•				
		operation is acti					
bit 5		ta/Receive Polar	ity Select bit				
	Asynchrono		uartad (active				
		data (RXx) is in data (RXx) is no	· ·	,			
	Synchronou		(				
	•	Tx) is inverted (a					
		Tx) is not inverte					
bit 4	-	nchronous Clock	Polarity Selec	ct bit			
	Asynchrono	<u>us mode:</u> e for transmit (T)	(x) is a low lev	رما			
		e for transmit (T)	,				
	<u>Synchronou</u>						
		e for clock (CKx)	-	l			
h:4 0		e for clock (CKx)		L :1			
bit 3		Bit Baud Rate R aud Rate Genera	-				
		ud Rate Generat				RGHx value is	ianored
bit 2		nted: Read as '		, ( p	,, -		0
bit 1	-	-up Enable bit					
	Asynchrono	-					
		T will continue to			pt generated c	on the falling ed	ge; bit cleare
		ware on the follow					
	<u>Synchronou</u>		a or the fishing	euge delected			
	Unused in th						
bit 0	ABDEN: Au	ito-Baud Detect I	Enable bit				
	<u>Asynchrono</u>						
		baud rate meas		e next characte	er. Requires re	ception of a Sy	nc field (55h
		in hardware upo ate measuremen		completed			
	Synchronou			- sinplotou			
	Unused in th						

#### 查询PIC18F86K90供应商 22.1 Baud Rate Generator (BRG)

The BRG is a dedicated, 8-bit or 16-bit generator that supports both the Asynchronous and Synchronous modes of the EUSART. By default, the BRG operates in 8-bit mode; setting the BRG16 bit (BAUDCONx<3>) selects 16-bit mode.

The SPBRGHx:SPBRGx register pair controls the period of a free-running timer. In Asynchronous mode, bits, BRGH (TXSTAx<2>) and BRG16 (BAUDCONx<3>), also control the baud rate. In Synchronous mode, BRGH is ignored. Table 22-1 shows the formula for computation of the baud rate for different EUSART modes which only apply in Master mode (internally generated clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRGHx:SPBRGx registers can be calculated using the formulas in Table 22-1. From this, the error in baud rate can be determined. An example calculation is shown in Example 22-1. Typical baud rates and error values for the various Asynchronous modes are shown in Table 22-2. It may be advantageous to use the high baud rate (BRGH = 1) or the 16-bit BRG to reduce the baud rate error, or achieve a slow baud rate for a fast oscillator frequency.

Writing a new value to the SPBRGHx:SPBRGx registers causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate. When operated in Synchronous mode, SPBRGH:SPBRG values of 0000h and 0001h are not supported. In the Asynchronous mode, all BRG values may be used.

#### 22.1.1 OPERATION IN POWER-MANAGED MODES

The device clock is used to generate the desired baud rate. When one of the power-managed modes is entered, the new clock source may be operating at a different frequency. This may require an adjustment to the value in the SPBRGx register pair.

#### 22.1.2 SAMPLING

The data on the RXx pin (either RC7/RX1/DT1/SEG28 or RG2/RX2/DT2/AN18/C3INA) is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RXx pin.

C	onfiguration B	its		David Data Commula
SYNC	BRG16	BRGH	BRG/EUSART Mode	Baud Rate Formula
0	0	0	8-Bit/Asynchronous	Fosc/[64 (n + 1)]
0	0	1	8-Bit/Asynchronous	$\Gamma_{000}/[16(n+1)]$
0	1	0	16-Bit/Asynchronous	Fosc/[16 (n + 1)]
0	1	1	16-Bit/Asynchronous	
1	0	x	8-Bit/Synchronous	Fosc/[4 (n + 1)]
1	1	х	16-Bit/Synchronous	

#### TABLE 22-1: BAUD RATE FORMULAS

**Legend:** x = Don't care, n = value of SPBRGHx:SPBRGx register pair

# 查询PIC18F86K90供应商 EXAMPLE 22-1: CALCULATING BAUD RATE ERROR

For a device with FOSC of 10	6 MH	Iz, desired baud rate of 9600, Asynchronous mode, and 8-bit BRG:
Desired Baud Rate	=	FOSC/(64 ([SPBRGHx:SPBRGx] + 1))
Solving for SPBRGHx:	SPB	RGx:
Х	=	((FOSC/Desired Baud Rate)/64) – 1
	=	((16000000/9600)/64) – 1
	=	[25.042] = 25
Calculated Baud Rate	=	1600000/(64 (25 + 1))
	=	9615
Error	=	(Calculated Baud Rate - Desired Baud Rate)/Desired Baud Rate
	=	(9615 - 9600)/9600 = 0.16%

#### **TABLE 22-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:			
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75			
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75			
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	77			
SPBRGH1	EUSART1	SART1 Baud Rate Generator Register High Byte										
SPBRG1	EUSART1	Baud Rate	Generator I	Register Lo	w Byte				75			
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79			
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79			
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	79			
SPBRGH2	EUSART2	ART2 Baud Rate Generator Register High Byte										
SPBRG2	EUSART2	Baud Rate	Generator I	Register Lo	w Byte				80			

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the BRG.

#### 查询PIC18F86K90供应商 TABLE 22-3: BAUD RATES FOR ASYNCHRONOUS MODES

IADLL	22-5. BAOD NATESTON ASTNCHNONOUS MODES															
		SYNC = 0, BRGH = 0, BRG16 = 0														
BAUD	Fosc	Fosc = 40.000 MHz			= 20.000	) MHz	Foso	: = 10.000	MHz	Fos	c = 8.000	MHz				
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)				
0.3	_			_		_	_	_	_	_	_	_				
1.2	—	_	—	1.221	1.73	255	1.202	0.16	129	1.201	-0.16	103				
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2.403	-0.16	51				
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9.615	-0.16	12				
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	_	_	_				
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	—	_	_				
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	—	_	_				

			S	YNC = 0, E	BRGH = (	, <b>BRG16 =</b>	0		
BAUD	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fos	c = 1.000	MHz
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	0.300	0.16	207	0.300	-0.16	103	0.300	-0.16	51
1.2	1.202	0.16	51	1.201	-0.16	25	1.201	-0.16	12
2.4	2.404	0.16	25	2.403	-0.16	12	_	_	—
9.6	8.929	-6.99	6	—	_	_	_	_	_
19.2	20.833	8.51	2	—	_	_	_	_	_
57.6	62.500	8.51	0	—	_	_	—	_	_
115.2	62.500	-45.75	0	_		_	_	—	

					SYNC	= 0, BRGH	<b>i =</b> 1, BRG	<b>16 =</b> 0					
BAUD	Fosc	= 40.000	) MHz	Fosc = 20.000 MHz			Fosc	Fosc = 10.000 MHz			Fosc = 8.000 MHz		
RATE (K)	Actual % SPBRG Rate % value (K) (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	_	_	_	_	_	_	_	_	_	_	_	_	
1.2	_	_	_	—	_	_	_	_	_	—	_	_	
2.4	—	_	_	—	_	_	2.441	1.73	255	2.403	-0.16	207	
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51	
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25	
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8	
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	_	_	

		SYNC = 0, BRGH = 1, BRG16 = 0										
BAUD	Foso	= 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz					
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	_	_	_		_	_	0.300	-0.16	207			
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51			
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25			
9.6	9.615	0.16	25	9.615	-0.16	12	—	—	—			
19.2	19.231	0.16	12	_	_	_	_	_	_			
57.6	62.500	8.51	3	—	_	—	—	_	—			
115.2	125.000	8.51	1	_	_	—	_	_	—			

© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

#### TABLE 22-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

		SYNC = 0, BRGH = 0, BRG16 = 1												
BAUD RATE	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz				
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)		
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	0.300	-0.04	1665		
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1.201	-0.16	415		
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2.403	-0.16	207		
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51		
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25		
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8		
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	—	_	_		

		SYNC = 0, BRGH = 0, BRG16 = 1											
BAUD RATE	Foso	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz						
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)				
0.3	0.300	0.04	832	0.300	-0.16	415	0.300	-0.16	207				
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51				
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25				
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_				
19.2	19.231	0.16	12	—	_	_	_	_	_				
57.6	62.500	8.51	3	—	_	_	—	_	_				
115.2	125.000	8.51	1	_		—	_		—				

		SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1													
BAUD	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz					
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	0.300	-0.01	6665			
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1.200	-0.04	1665			
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2.400	-0.04	832			
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9.615	-0.16	207			
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19.230	-0.16	103			
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57.142	0.79	34			
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117.647	-2.12	16			

		SYN	IC = 0, BR(	GH = 1, BF	or SYNC =	= 1, BRG1	6 = 1			
BAUD RATE	Foso	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	0.300	0.01	3332	0.300	-0.04	1665	0.300	-0.04	832	
1.2	1.200	0.04	832	1.201	-0.16	415	1.201	-0.16	207	
2.4	2.404	0.16	415	2.403	-0.16	207	2.403	-0.16	103	
9.6	9.615	0.16	103	9.615	-0.16	51	9.615	-0.16	25	
19.2	19.231	0.16	51	19.230	-0.16	25	19.230	-0.16	12	
57.6	58.824	2.12	16	55.555	3.55	8	—	—	—	
115.2	111.111	-3.55	8	_	_	_	—	_	—	

#### 查询PIC18F86K90供应商 22.1.3 AUTO-BAUD RATE DETECT

The Enhanced USART module supports the automatic detection and calibration of baud rate. This feature is active only in Asynchronous mode and while the WUE bit is clear.

The automatic baud rate measurement sequence (Figure 22-1) begins whenever a Start bit is received and the ABDEN bit is set. The calculation is self-averaging.

In the Auto-Baud Rate Detect (ABD) mode, the clock to the BRG is reversed. Rather than the BRG clocking the incoming RXx signal, the RXx signal is timing the BRG. In ABD mode, the internal Baud Rate Generator is used as a counter to time the bit period of the incoming serial byte stream.

Once the ABDEN bit is set, the state machine will clear the BRG and look for a Start bit. The Auto-Baud Rate Detect must receive a byte with the value, 55h (ASCII "U", which is also the LIN/J2602 bus Sync character), in order to calculate the proper bit rate. The measurement is taken over both a low and a high bit time in order to minimize any effects caused by asymmetry of the incoming signal. After a Start bit, the SPBRGx begins counting up, using the preselected clock source on the first rising edge of RXx. After eight bits on the RXx pin or the fifth rising edge, an accumulated value totalling the proper BRG period is left in the SPBRGHx:SPBRGx register pair. Once the 5th edge is seen (this should correspond to the Stop bit), the ABDEN bit is automatically cleared.

If a rollover of the BRG occurs (an overflow from FFFFh to 0000h), the event is trapped by the ABDOVF status bit (BAUDCONx<7>). It is set in hardware by BRG rollovers and can be set or cleared by the user in software. ABD mode remains active after rollover events and the ABDEN bit remains set (Figure 22-2).

While calibrating the baud rate period, the BRG registers are clocked at 1/8th the preconfigured clock rate. Note that the BRG clock can be configured by the BRG16 and BRGH bits. The BRG16 bit must be set to use both SPBRG1 and SPBRGH1 as a 16-bit counter. This allows the user to verify that no carry occurred for 8-bit modes by checking for 00h in the SPBRGHx register. Refer to Table 22-4 for counter clock rates to the BRG.

While the ABD sequence takes place, the EUSART state machine is held in Idle. The RCxIF interrupt is set once the fifth rising edge on RXx is detected. The value in the RCREGx needs to be read to clear the RCxIF interrupt. The contents of RCREGx should be discarded.

Note 1:	If the WUE bit is set with the ABDEN bit,
	Auto-Baud Rate Detection will occur on
	the byte following the Break character.

- 2: It is up to the user to determine that the incoming character baud rate is within the range of the selected BRG clock source. Some combinations of oscillator frequency and EUSART baud rates are not possible due to bit error rates. Overall system timing and communication baud rates must be taken into consideration when using the Auto-Baud Rate Detection feature.
- **3:** To maximize baud rate range, it is recommended to set the BRG16 (BAUDCONx<3>) bit if the auto-baud feature is used.

### TABLE 22-4:BRG COUNTERCLOCK RATES

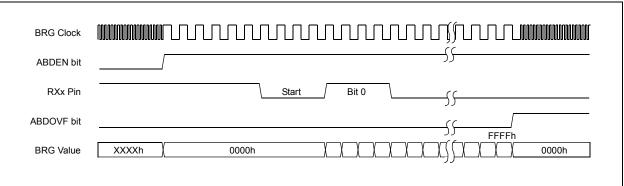
BRG16	BRGH	BRG Counter Clock
0	0	Fosc/512
0	1	Fosc/128
1	0	Fosc/128
1	1	Fosc/32

#### 22.1.3.1 ABD and EUSART Transmission

Since the BRG clock is reversed during ABD acquisition, the EUSART transmitter cannot be used during ABD. This means that whenever the ABDEN bit is set, TXREGx cannot be written to. Users should also ensure that ABDEN does not become set during a transmit sequence. Failing to do this may result in unpredictable EUSART operation.

BRG Value	XXXXh X	0000h		) ( 001Ch
RXx Pin		Start	Edge #1 Edge #2 Edge #3 Edge # Bit 0 Bit 1 Bit 2 Bit 3 Bit 4 Bit 5 Bit 6	4 Edge #5 Bit 7 Stop Bit
BRG Clock	רדרר <mark>ל</mark> נומננות המתחת המנה המשחת המ	www.		
ABDEN bit	Set by User			Auto-Cleared
RCxIF bit (Interrupt)				
Read				
RCREGx	i i		1	
SPBRGx			XXXXh	X 1Ch
SPBRGHx			XXXXh	00h

#### FIGURE 22-2: BRG OVERFLOW SEQUENCE



#### 查询PIC18F86K90供应商 22.2 EUSART Asynchronous Mode

The Asynchronous mode of operation is selected by clearing the SYNC bit (TXSTAx<4>). In this mode, the EUSART uses standard Non-Return-to-Zero (NRZ) format (one Start bit, eight or nine data bits and one Stop bit). The most common data format is 8 bits. An on-chip, dedicated 8-bit/16-bit Baud Rate Generator can be used to derive standard baud rate frequencies from the oscillator.

The EUSART transmits and receives the LSb first. The EUSART's transmitter and receiver are functionally independent but use the same data format and baud rate. The Baud Rate Generator produces a clock, either x16 or x64 of the bit shift rate, depending on the BRGH and BRG16 bits (TXSTAx<2> and BAUDCONx<3>). Parity is not supported by the hardware but can be implemented in software and stored as the 9th data bit.

When operating in Asynchronous mode, the EUSART module consists of the following important elements:

- Baud Rate Generator
- · Sampling Circuit
- Asynchronous Transmitter
- Asynchronous Receiver
- Auto-Wake-up on Sync Break Character
- 12-Bit Break Character Transmit
- Auto-Baud Rate Detection

#### 22.2.1 EUSART ASYNCHRONOUS TRANSMITTER

The EUSART transmitter block diagram is shown in Figure 22-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREGx. The TXREGx register is loaded with data in software. The TSR register is not loaded until the Stop bit has been transmitted from the previous load. As soon as the Stop bit is transmitted, the TSR is loaded with new data from the TXREGx register (if available). Once the TXREGx register transfers the data to the TSR register (occurs in one TCY), the TXREGx register is empty and the TXxIF flag bit is set. This interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TXxIE. TXxIF will be set regardless of the state of TXxIE; it cannot be cleared in software. TXxIF is also not cleared immediately upon loading TXREGx, but becomes valid in the second instruction cycle following the load instruction. Polling TXxIF immediately following a load of TXREGx will return invalid results.

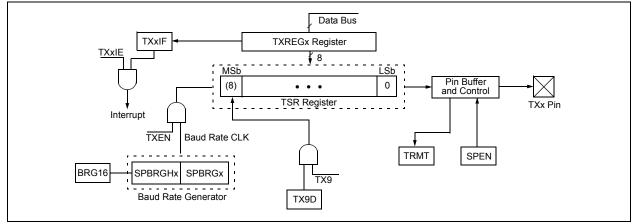
While TXxIF indicates the status of the TXREGx register; another bit, TRMT (TXSTAx<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty.

Note 1: The TSR register is not mapped in data memory, so it is not available to the user.
2: Flag bit, TXxIF, is set when enable bit, TXEN, is set.

To set up an Asynchronous Transmission:

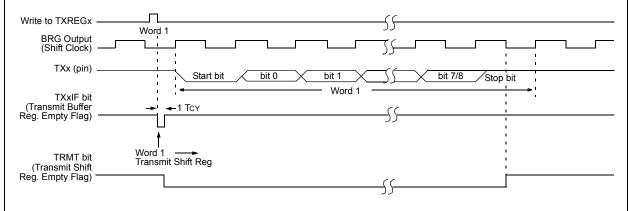
- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, TXxIE.
- 4. If 9-bit transmission is desired, set transmit bit, TX9. Can be used as address/data bit.
- 5. Enable the transmission by setting bit, TXEN, which will also set bit, TXxIF.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Load data to the TXREGx register (starts transmission).
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

#### FIGURE 22-3: EUSART TRANSMIT BLOCK DIAGRAM

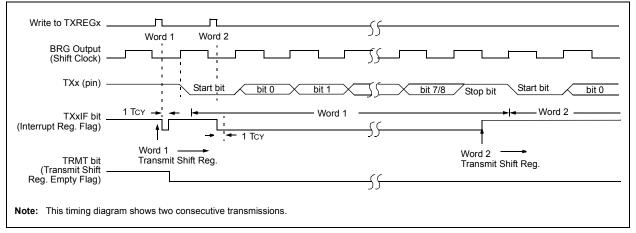


© 2010 Microchip Technology Inc.

### 查询PIC18F86K90供应商 FIGURE 22-4: ASYNCHRONOUS TRANSMISSION



#### FIGURE 22-5: ASYNCHRONOUS TRANSMISSION (BACK-TO-BACK)



#### 查询PIC18F86K90供应商 TABLE 22-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
TXREG1	EUSART1	Transmit Re	gister						75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate (	Generator R	legister Higl	n Byte				74
SPBRG1	EUSART1	Baud Rate 0	Generator R	egister Low	v Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
TXREG2	EUSART2	Transmit Re	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate (	Generator R	egister High	n Byte			•	80
SPBRG2	EUSART2	Baud Rate (	Generator R	egister Low	v Byte				80

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

#### 查询PIC18F86K90供应商

#### 22.2.2 EUSART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 22-6. The data is received on the RXx pin and drives the data recovery block. The data recovery block is actually a high-speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

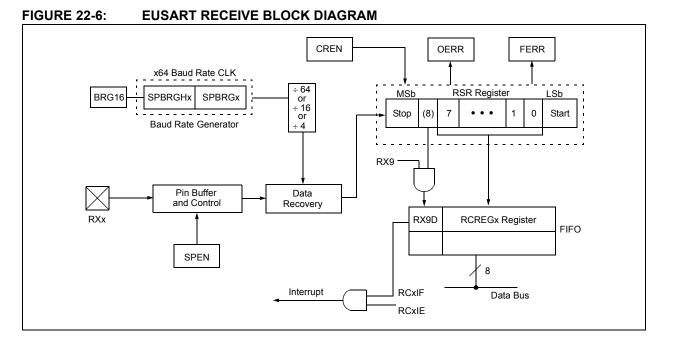
To set up an Asynchronous Reception:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, RCxIE.
- 4. If 9-bit reception is desired, set bit, RX9.
- 5. Enable the reception by setting bit, CREN.
- Flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if enable bit, RCxIE, was set.
- 7. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading the RCREGx register.
- 9. If any error occurred, clear the error by clearing enable bit, CREN.
- 10. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

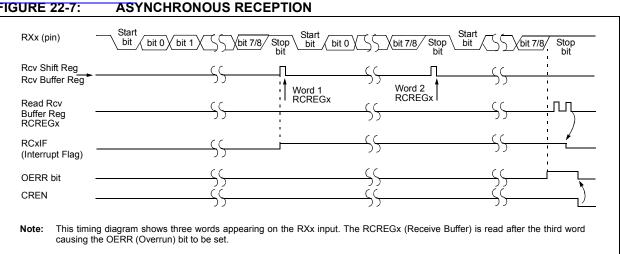
### 22.2.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- 3. If interrupts are required, set the RCEN bit and select the desired priority level with the RCxIP bit.
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- 6. Enable reception by setting the CREN bit.
- The RCxIF bit will be set when reception is complete. The interrupt will be Acknowledged if the RCxIE and GIE bits are set.
- 8. Read the RCSTAx register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- 9. Read RCREGx to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.



#### 查询PIC18F86K90供应商 FIGURE 22-7: ASYNCHRO



#### TABLE 22-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
RCREG1	EUSART1 Receive Register								
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16		WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate G	Senerator R	egister High	n Byte				74
SPBRG1	EUSART1	Baud Rate G	Generator R	egister Low	Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
RCREG2	EUSART2	Receive Reg	jister			•			80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16		WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate G	Senerator R	egister High	Byte		-		80
SPBRG2	EUSART2	Baud Rate G	Generator Ro	egister Low	Byte				80

**Legend:** — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

#### 查询PIC18F86K90供应商

#### 22.2.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Because of this, the Baud Rate Generator is inactive and a proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up due to activity on the RXx/DTx line while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCONx<1>). Once set, the typical receive sequence on RXx/DTx is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on the RXx/DTx line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN/J2602 protocol.)

Following a wake-up event, the module generates an RCxIF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 22-8) and asynchronously if the device is in Sleep mode (Figure 22-9). The interrupt condition is cleared by reading the RCREGx register.

The WUE bit is automatically cleared once a low-to-high transition is observed on the RXx line following the wake-up event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

#### 22.2.4.1 Special Considerations Using Auto-Wake-up

Since auto-wake-up functions by sensing rising edge transitions on RXx/DTx, information with any state changes before the Stop bit may signal a false End-of-Character (EOC) and cause data or framing errors. To work properly, therefore, the initial character in the transmission must be all '0's. This can be 00h (8 bits) for standard RS-232 devices or 000h (12 bits) for LIN/J2602 bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., HS or HSPLL mode). The Sync Break (or Wake-up Signal) character must be of sufficient length and be followed by a sufficient interval to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

#### 查询PIC18F86K90供应商

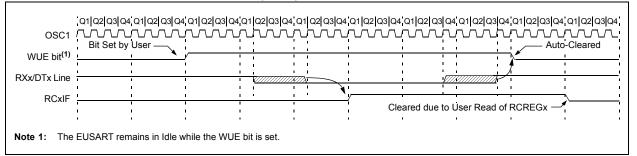
### 22.2.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RCxIF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RCxIF bit. The WUE bit is cleared after this when a rising edge is seen on RXx/DTx. The interrupt condition is then cleared by reading the RCREGx register. Ordinarily, the data in RCREGx will be dummy data and should be discarded.

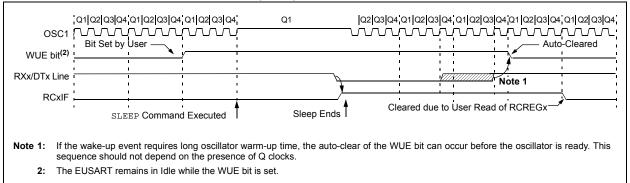
The fact that the WUE bit has been cleared (or is still set) and the RCxIF flag is set should not be used as an indicator of the integrity of the data in RCREGx. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCIDL bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

#### FIGURE 22-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION



#### FIGURE 22-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



### 查询PIC18F86K90供应商

#### 22.2.5 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN/J2602 bus standard. The Break character transmit consists of a Start bit, followed by twelve '0' bits and a Stop bit. The Frame Break character is sent whenever the SENDB and TXEN bits (TXSTAx<3> and TXSTAx<5>, respectively) are set while the Transmit Shift Register is loaded with data. Note that the value of data written to TXREGx will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN/J2602 specification).

Note that the data value written to the TXREGx for the Break character is ignored. The write simply serves the purpose of initiating the proper sequence.

The TRMT bit indicates when the transmit operation is active or Idle, just as it does during normal transmission. See Figure 22-10 for the timing of the Break character sequence.

#### 22.2.5.1 Break and Sync Transmit Sequence

The following sequence will send a message frame header made up of a Break, followed by an Auto-Baud Sync byte. This sequence is typical of a LIN/J2602 bus master.

- 1. Configure the EUSART for the desired mode.
- 2. Set the TXEN and SENDB bits to set up the Break character.
- 3. Load the TXREGx with a dummy character to initiate transmission (the value is ignored).
- 4. Write '55h' to TXREGx to load the Sync character into the transmit FIFO buffer.
- 5. After the Break has been sent, the SENDB bit is reset by hardware. The Sync character now transmits in the preconfigured mode.

When the TXREGx becomes empty, as indicated by the TXxIF, the next data byte can be written to TXREGx.

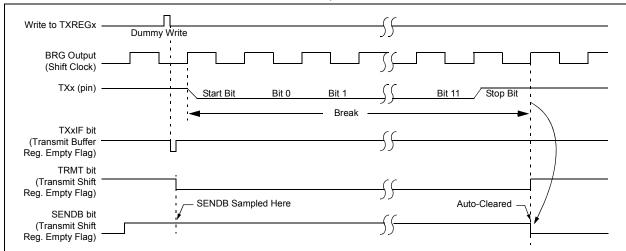
#### 22.2.6 RECEIVING A BREAK CHARACTER

The Enhanced USART module can receive a Break character in two ways.

The first method forces configuration of the baud rate at a frequency of 9/13 the typical speed. This allows for the Stop bit transition to be at the correct sampling location (13 bits for Break versus Start bit and 8 data bits for typical data).

The second method uses the auto-wake-up feature described in **Section 22.2.4 "Auto-Wake-up on Sync Break Character"**. By enabling this feature, the EUSART will sample the next two transitions on RXx/DTx, cause an RCxIF interrupt and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Rate Detect feature. For both methods, the user can set the ABDEN bit once the TXxIF interrupt is observed.



#### FIGURE 22-10: SEND BREAK CHARACTER SEQUENCE

#### 查询PIC18F86K90供应商 22.3 EUSART Synchronous Master Mode

The Synchronous Master mode is entered by setting the CSRC bit (TXSTAx<7>). In this mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit, SYNC (TXSTAx<4>). In addition, enable bit, SPEN (RCSTAx<7>), is set in order to configure the TXx and RXx pins to CKx (clock) and DTx (data) lines, respectively.

The Master mode indicates that the processor transmits the master clock on the CKx line. Clock polarity is selected with the TXCKP bit (BAUDCONx<4>). Setting TXCKP sets the Idle state on CKx as high, while clearing the bit sets the Idle state as low. This option is provided to support Microwire devices with this module.

#### 22.3.1 EUSART SYNCHRONOUS MASTER TRANSMISSION

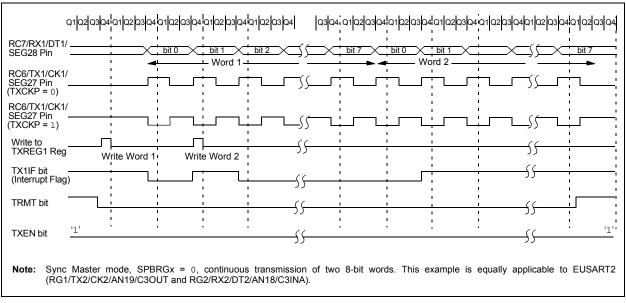
The EUSART transmitter block diagram is shown in Figure 22-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The TSR register obtains its data from the Read/Write Transmit Buffer register, TXREGx. The TXREGx register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREGx (if available).

Once the TXREGx register transfers the data to the TSR register (occurs in one TcY), the TXREGx is empty and the TXxIF flag bit is set. The interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TXxIE. TXxIF is set regardless of the state of enable bit, TXxIE; it cannot be cleared in software. It will reset only when new data is loaded into the TXREGx register.

While flag bit, TXxIF, indicates the status of the TXREGx register, another bit, TRMT (TXSTAx<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user must poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

To set up a Synchronous Master Transmission:

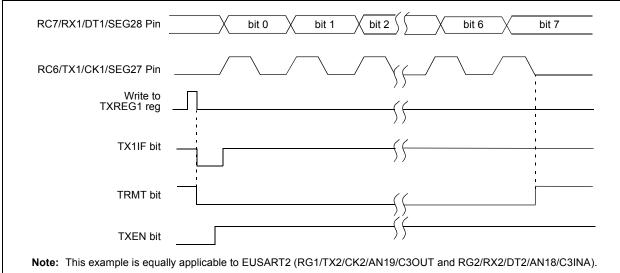
- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit, TXxIE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- 5. Enable the transmission by setting bit, TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREGx register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.



#### FIGURE 22-11: SYNCHRONOUS TRANSMISSION

#### 查询PIC18F86K90供应商

FIGURE 22-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)



<b>TABLE 22-7</b> :	REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
TXREG1	EUSART1	Transmit Re	gister						75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16		WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate C	Generator R	egister Higl	n Byte				74
SPBRG1	EUSART1	Baud Rate C	Generator R	egister Low	v Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
TXREG2	EUSART2	Transmit Re	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate C	Generator R	egister Higl	n Byte			-	80
SPBRG2	EUSART2	Baud Rate C	Generator R	egister Low	v Byte				80

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

#### 查询PIC18F86K90供应商 22.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTAx<5>) or the Continuous Receive Enable bit, CREN (RCSTAx<4>). Data is sampled on the RXx pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.

- 3. Ensure bits, CREN and SREN, are clear.
- 4. If interrupts are desired, set enable bit, RCxIE.
- 5. If 9-bit reception is desired, set bit, RX9.
- 6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
- 7. Interrupt flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCxIE, was set.
- 8. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 9. Read the 8-bit received data by reading the RCREGx register.
- 10. If any error occurred, clear the error by clearing bit CREN.
- 11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 22-13:	SYNCHRONOUS RECEPTION (MASTER MODE, SREN)
---------------	---

02/03/04/01/02/03/04 RC7/RX1/DT1/ bit 0 bit 1 bit 2 bit 3 bit 4 bit 5 bit 6 bit 7 SEG28 Pin RC6/TX1/CK1/ SEG27 Pin (TXCKP = 0) RC6/TX1/CK1/ SEG27 Pin (TXCKP = 1) Write to bit. SREN SREN bit CREN bit '0' '0' RC1IF bit (Interrupt) Read RCREG1 Note: Timing diagram demonstrates Sync Master mode with bit, SREN = 1, and bit, BRGH = 0. This example is equally applicable to EUSART2 (RG1/TX2/CK2/AN19/C3OUT and RG2/RX2/DT2/AN18/C3INA).

#### 查询PIC18F86K90供应商

#### TABLE 22-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
RCREG1	EUSART1 Receive Register								
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate (	Generator	Register ⊢	ligh Byte				74
SPBRG1	EUSART1	Baud Rate (	Generator	Register L	ow Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
RCREG2	EUSART2	Receive Re	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate (	Generator	Register H	ligh Byte				80
SPBRG2	EUSART2	Baud Rate (	Generator	Register L	ow Byte				80

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

#### 查询PIC18F86K90供应商

#### 22.4 EUSART Synchronous Slave Mode

Synchronous Slave mode is entered by clearing bit, CSRC (TXSTAx<7>). This mode differs from the Synchronous Master mode in that the shift clock is supplied externally at the CKx pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in any low-power mode.

#### 22.4.1 EUSART SYNCHRONOUS SLAVE TRANSMISSION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep mode.

If two words are written to the TXREGx and then the SLEEP instruction is executed, the following will occur:

- a) The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in the TXREGx register.
- c) Flag bit, TXxIF, will not be set.
- d) When the first word has been shifted out of TSR, the TXREGx register will transfer the second word to the TSR and flag bit, TXxIF, will now be set.

e) If enable bit, TXxIE, is set, the interrupt will wake the chip from Sleep. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Transmission:

- 1. Enable the synchronous slave serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. Clear bits, CREN and SREN.
- 3. If interrupts are desired, set enable bit, TXxIE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- 5. Enable the transmission by setting enable bit, TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREGx register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
TXREG1	EUSART1	Transmit Reg	gister						75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate G	Senerator R	egister Higl	n Byte				74
SPBRG1	EUSART1	Baud Rate G	enerator R	egister Low	<sup>,</sup> Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
TXREG2	EUSART2	Transmit Reg	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate G	Generator R	egister Higl	n Byte				80
SPBRG2	EUSART2	Baud Rate G	Generator R	egister Low	' Byte				80

#### TABLE 22-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave transmission.

#### 查询PIC18F86K90供应商

#### 22.4.2 EUSART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep, or any Idle mode and bit, SREN, which is a "don't care" in Slave mode.

If receive is enabled by setting the CREN bit prior to entering Sleep or any Idle mode, then a word may be received while in this low-power mode. Once the word is received, the RSR register will transfer the data to the RCREGx register. If the RCxIE enable bit is set, the interrupt generated will wake the chip from the low-power mode. If the global interrupt is enabled, the program will branch to the interrupt vector. To set up a Synchronous Slave Reception:

- 1. Enable the synchronous master serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. If interrupts are desired, set enable bit, RCxIE.
- 3. If 9-bit reception is desired, set bit, RX9.
- 4. To enable reception, set enable bit, CREN.
- 5. Flag bit, RCxIF, will be set when reception is complete. An interrupt will be generated if enable bit, RCxIE, was set.
- 6. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 7. Read the 8-bit received data by reading the RCREGx register.
- 8. If any error occurred, clear the error by clearing bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
RCREG1	EUSART1	Receive Reo	gister						75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate C	Generator R	egister High	n Byte				74
SPBRG1	EUSART1	Baud Rate C	Generator R	egister Low	' Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
RCREG2	EUSART2	Receive Reo	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate (	Generator R	egister High	n Byte				80
SPBRG2	EUSART2	Baud Rate (	Generator R	egister Low	<sup>,</sup> Byte				80

#### TABLE 22-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave reception.

#### 查询PIC18F86K90供应商

#### 23.0 12-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module in the PIC18F87K90 family of devices has 16 inputs for the 64-pin devices and 24 inputs for the 80-pin devices. This module allows conversion of an analog input signal to a corresponding signed 12-bit digital number.

The module has these registers:

- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)
- A/D Port Configuration Register 0 (ANCON0)
- A/D Port Configuration Register 1 (ANCON1)
- A/D Port Configuration Register 2 (ANCON2)
- ADRESH (the upper A/D Results register)
- ADRESL (the lower A/D Results register)

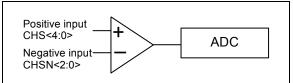
The ADCON0 register, shown in Register 23-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 23-2, configures the voltage reference and special trigger selection. The ADCON2 register, shown in Register 23-3, configures the A/D clock source and programmed acquisition time and justification.

#### 23.1 Differential A/D Converter

The converter in PIC18F87K90 family devices is implemented as a differential A/D where the differential voltage between two channels is measured and converted to digital values (see Figure 23-1).

The converter also can be configured to measure a voltage from a single input by clearing the CHSN bits (ADCON1<2:0>). With this configuration, the negative channel input is connected internally to AVss (see Figure 23-2).

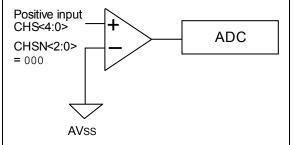
### FIGURE 23-1: DIFFERENTIAL CHANNEL MEASUREMENT



Differential conversion feeds the two input channels to a unity gain differential amplifier. The positive channel input is selected using the CHS bits (ADCON0<6:2>) and the negative channel input is selected using the CHSN bits (ADCON1<2:0>).

The output from the amplifier is fed to the A/D convert, as shown in Figure 23-1. The 12-bit result is available on the ADRESH and ADRESL registers. There is also a sign bit, along with the 12-bit result, indicating if the result is a positive or negative value.





In the Single Channel Measurement mode, the negative input is connected to Avss by clearing the CHSN bits (ADCON1<2:0>).

### 查询PIC18F86K90供应商

23.2 A/D Registers

#### 23.2.1 A/D CONTROL REGISTERS

#### REGISTER 23-1: ADCON0: A/D CONTROL REGISTER 0

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	CHS4	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

#### bit 7 Unimplemented: Read as '0'

bit 6-2	CHS<4:0>: Analog Channel Select bits	
	00000 = Channel 00 (AN0)	10000 = Channel 16 (AN16)
	00001 = Channel 01 (AN1)	10001 = Channel 17 (AN17)
	00010 = Channel 02 (AN2)	10010 = Channel 18 (AN18)
	00011 = Channel 03 (AN3)	10011 = Channel 19 (AN19)
	00100 = Channel 04 (AN4)	10100 = Channel 20 (AN20) <sup>(1,2)</sup>
	00101 = Channel 05 (AN5)	10101 = Channel 21 (AN21) <sup>(1,2)</sup>
	00110 = Channel 06 (AN6)	10110 = Channel 22 (AN22) <sup>(1,2)</sup>
	00111 = Channel 07 (AN7)	10111 = Channel 23 (AN23) <sup>(1,2)</sup>
	01000 = Channel 08 (AN8)	11000 = (Reserved) <sup>(2)</sup>
	01001 = Channel 09 (AN9)	11001 = (Reserved) <sup>(2)</sup>
	01010 = Channel 10 (AN10)	11010 = (Reserved) <sup>(2)</sup>
	01011 = Channel 11 (AN11)	11011 = (Reserved) <sup>(2)</sup>
	01100 = Channel 12 (AN12) <sup>(1,2)</sup>	11100 = Channel 28 (Reserved CTMU)
	01101 = Channel 13 (AN13) <sup>(1,2)</sup>	11101 = Channel 29 (Internal temperature diode)
	01110 = Channel 14 (AN14) <sup>(1,2)</sup>	11110 = Channel 30 (VDDCORE)
	01111 = Channel 15 (AN15) <sup>(1,2)</sup>	11111 = Channel 31 (1.024V band gap)
bit 1	GO/DONE: A/D Conversion Status bit	
	cleared automatically by hardware w	ess. Setting this bit starts an A/D conversion cycle. The bit is when the A/D conversion is completed.
	0 = A/D conversion is completed or not i	in progress
bit 0	ADON: A/D On bit	
	1 = A/D Converter is operating	
	0 = A/D Converter module is shut off and	d consuming no operating current
	The second second second second second second	

Note 1: These channels are not implemented on 64-pin devices.

2: Performing a conversion on unimplemented channels will return random values.

#### 查询PIC18F86K90供应商 REGISTER 23-2: ADCON1: A/D CONTROL REGISTER 1 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 TRIGSEL1 **TRIGSEL0** VCFG1 VCFG0 VNCFG CHSN2 CHSN1 CHSN0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7-6 TRIGSEL<1:0>: Special Trigger Select bits 11 = Selects the special trigger from the RTCC 10 = Selects the special trigger from the Timer1 01 = Selects the special trigger from the CTMU 00 = Selects the special trigger from the ECCP2 bit 5-4 VCFG<1:0>: A/D VREF+ Configuration bits 11 = Internal VREF+ (4.096V) 10 = Internal VREF+ (2.048V) 01 = External VREF+ 00 = AVDD bit 3 VNCFG: A/D VREF- Configuration bit 1 = External VREF 0 = AVss bit 2-0 CHSN<2:0>: Analog Negative Channel Select bits 111 = Channel 07 (AN6) 110 = Channel 06 (AN5) 101 = Channel 05 (AN4) 100 = Channel 04 (AN3) 011 = Channel 03 (AN2) 010 = Channel 02 (AN1) 001 = Channel 01 (AN0) 000 = Selecting '000' chooses AVss/external VREF- as a negative channel based on VNCFG

**Note 1:** If the A/D FRC clock source is selected, a delay of one TCY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

### 查询PIC18F86K90供应商 REGISTER 23-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
ADFM		ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0					
bit 7							bit C					
Legend:												
R = Readal	ble bit	W = Writable	oit	U = Unimpler	nented bit. read	d as '0'						
-n = Value a		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	nown					
bit 7	<b>ADFM:</b> A/D F 1 = Right just 0 = Left justifi		elect bit									
bit 6	•	Unimplemented: Read as '0'										
bit 5-3	-	A/D Acquisition		oits								
	111 = 20 TAD 110 = 16 TAD 101 = 12 TAD 100 = 8 TAD 011 = 6 TAD 010 = 4 TAD 001 = 2 TAD 000 = 0 TAD <sup>(1</sup>											
bit 2-0	111 = FRC (cl 110 = Fosc/d 101 = Fosc/1 100 = Fosc/4	16 4 lock derived fro 32 3	m A/D RC osc	illator) <sup>(1)</sup>								

Note 1: If the A/D FRC clock source is selected, a delay of one TcY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

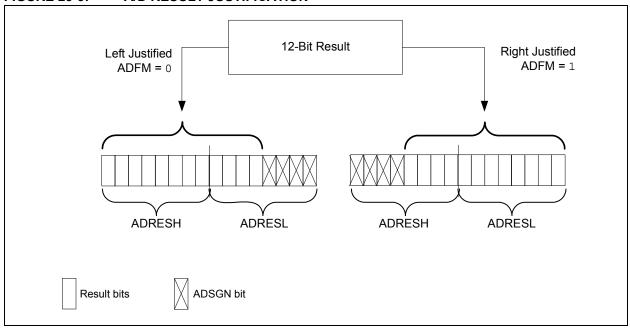
#### 查询PIC18F86K90供应商 23.2.2 A/D RESULT REGISTERS

The ADRESH:ADRESL register pair is where the 12-bit A/D result and extended sign bits (ADSGN) are loaded at the completion of a conversion. This register pair is 16 bits wide. The A/D module gives the flexibility of left or right justifying the 12-bit result in the 16-bit result register. The A/D Format Select bit (ADFM) controls this justification.

FIGURE 23-3: A/D RESULT JUSTIFICATION

Figure 23-3 shows the operation of the A/D result justification and location of the sign bit (ADSGN). The extended sign bits allow for easier 16-bit math to be performed on the result.

When the A/D Converter is disabled, these 8-bit registers can be used as two, general purpose registers.



#### REGISTER 23-4: ADRESH: A/D RESULT HIGH BYTE REGISTER, LEFT JUSTIFIED (ADFM = 0)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
ADRES11	ADRES10	ADRES9	ADRES8	ADRES7	ADRES6	ADRES5	ADRES4
bit 7							

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7-0 ADRES<11:4>: A/D Result High Byte bits

查询PIC18F86K90供应商 REGISTER 23-5: ADRESL: A/D RESULT LOW BYTE REGISTER, LEFT JUSTIFIED (ADFM = 0)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
ADRES3	ADRES2	ADRES1	ADRES0	ADSGN	ADSGN	ADSGN	ADSGN
bit 7							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

#### bit 7-4 ADRES<3:0>: A/D Result Low Byte bits

ADSGN: A/D Result Sign bits bit 3-0

#### REGISTER 23-6: ADRESH: A/D RESULT HIGH BYTE REGISTER, RIGHT JUSTIFIED (ADFM = 1)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
ADSGN	ADSGN	ADSGN	ADSGN	ADRES11	ADRES10	ADRES9	ADRES8
bit 7	•						

Legend:				
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

#### bit 7-4 ADSGN: A/D Result Sign bits

bit 3-0 ADRES<11:8>: A/D Result High Byte bits

#### REGISTER 23-7: ADRESL: A/D RESULT LOW BYTE REGISTER, RIGHT JUSTIFIED (ADFM = 1)

| R/W-x  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| ADRES7 | ADRES6 | ADRES5 | ADRES4 | ADRES3 | ADRES2 | ADRES1 | ADRES0 |
| bit 7  |        |        |        |        |        |        |        |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ADRES<7:0>: A/D Result Low Byte bits

#### 查询PIC18F86K90供应商

The ANCONx registers are used to configure the operation of the I/O pin associated with each analog channel. Clearing a ANSELx bit configures the corresponding pin (ANx) to operate as a digital only I/O. Setting a bit configures the pin to operate as an analog input for either the A/D Converter or the comparator module, with all digital peripherals disabled and digital inputs read as '0'.

As a rule, I/O pins that are multiplexed with analog inputs default to analog operation on any device Reset.

#### REGISTER 23-8: ANCON0: A/D PORT CONFIGURATION REGISTER 0

| R/W-1  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| ANSEL7 | ANSEL6 | ANSEL5 | ANSEL4 | ANSEL3 | ANSEL2 | ANSEL1 | ANSEL0 |
| bit 7  |        |        |        |        |        |        | bit 0  |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0

ANSEL<7:0>: Analog Port Configuration bits (AN7 and AN0)

0 = Pin configured as a digital port

1 = Pin configured as an analog channel – digital input disabled and any inputs read as '0'

#### REGISTER 23-9: ANCON1: A/D PORT CONFIGURATION REGISTER 1

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANSEL15 <sup>(1)</sup>	ANSEL14 <sup>(1)</sup>	ANSEL13 <sup>(1)</sup>	ANSEL12 <sup>(1)</sup>	ANSEL11	ANSEL10	ANSEL9	ANSEL8
bit 7							bit 0

Legend:						
R = Readable bit	W = Writable bit	U = Unimplemented bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 7-0 ANSEL<15:8>: Analog Port Configuration bits (AN15 through AN8)

0 = Pin is configured as a digital port

1 = Pin is configured as an analog channel – digital input is disabled and any inputs read as '0'

**Note 1:** AN12 through AN15, and AN20 to AN23, are implemented only on 80-pin devices. For 64-pin devices, the corresponding ANSELx bits are still implemented for these channels, but have no effect.

© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

#### REGISTER 23-10: ANCON2: A/D PORT CONFIGURATION REGISTER 2

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANSEL23 <sup>(1)</sup>	ANSEL22 <sup>(1)</sup>	ANSEL21 <sup>(1)</sup>	ANSEL20 <sup>(1)</sup>	ANSEL19	ANSEL18	ANSEL17	ANSEL16
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

#### bit 7-0 **ANSEL<23:16>:** Analog Port Configuration bits (AN23 through AN16)

- 1 = Pin configured as an analog channel digital input disabled and any inputs read as '0'
- **Note 1:** AN12 through AN15, and AN20 to AN23, are implemented only on 80-pin devices. For 64-pin devices, the corresponding ANSELx bits are still implemented for these channels, but have no effect.

The analog reference voltage is software-selectable to either the device's positive and negative supply voltage (AVDD and AVSS) or the voltage level on the RA3/AN3/VREF+ and RA2/AN2/VREF- pins. VREF+ has two additional internal voltage reference selections: 2.048V and 4.096V.

The A/D Converter can uniquely operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

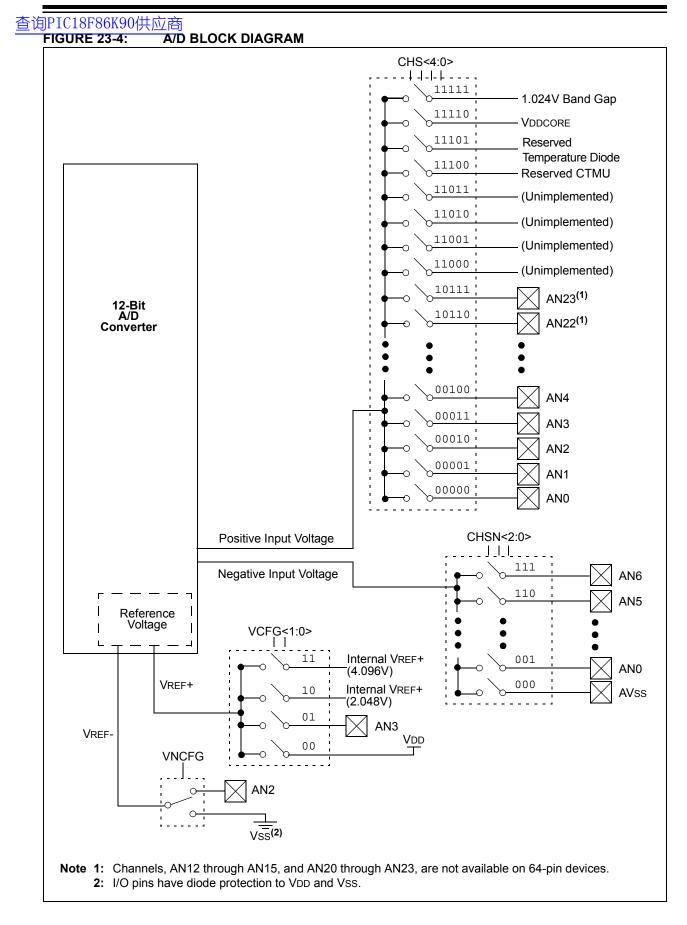
The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

Each port pin associated with the A/D Converter can be configured as an analog input or a digital I/O. The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/DONE bit (ADCON0<1>) is cleared and the A/D Interrupt Flag bit, ADIF (PIR1<6>), is set.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted. The value in the ADRESH:ADRESL register pair is not modified for a Power-on Reset. These registers will contain unknown data after a Power-on Reset.

The block diagram of the A/D module is shown in Figure 23-4.

<sup>0 =</sup> Pin configured as a digital port



#### 查询PIC18F86K90供应商

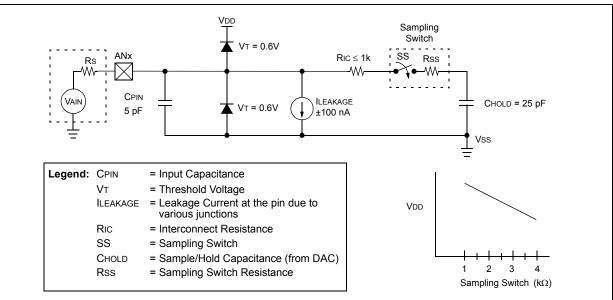
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion can start. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 23.3 "A/D Acquisition Requirements"**. After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

To do an A/D conversion, follow these steps:

- 1. Configure the A/D module:
  - Configure the required ADC pins as analog pins (ANCON0, ANCON1 and ANCON2)
  - Set the voltage reference (ADCON1)
  - Select the A/D positive and negative input channels (ADCON0 and ADCON1)
  - Select the A/D acquisition time (ADCON2)
  - Select the A/D conversion clock (ADCON2)
  - Turn on the A/D module (ADCON0)
- FIGURE 23-5: ANALOG INPUT MODEL

- 2. Configure the A/D interrupt (if desired):
  - Clear the ADIF bit (PIR1<6>)
  - Set the ADIE bit (PIE1<6>)
  - Set the GIE bit (INTCON<7>)
- 3. Wait the required acquisition time (if required).
- 4. Start the conversion:
  - Set the GO/DONE bit (ADCON0<1>)
- 5. Wait for A/D conversion to complete, by either:
  Polling for the GO/DONE bit to be cleared OR
  - Waiting for the A/D interrupt
- 6. Read A/D Result registers (ADRESH:ADRESL), and if required, clear bit, ADIF.
- 7. For the next conversion, begin with step 1 or 2, as required.

The A/D conversion time per bit is defined as TAD. Before the next acquisition starts, a minimum wait of 2 TAD is required.



#### 查询PIC18F86K90供应商 23.3 A/D Acquisition Requirements

For the A/D Converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 23-5. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD).

The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is 2.5 k $\Omega$ . After the analog input channel is selected or changed, the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note:	When	the	conversion	is	started,	the	
	holding capacitor is disconnected from the						
	input p	in.					

To calculate the minimum acquisition time, Equation 23-1 can be used. This equation assumes that 1/2 LSb error is used (1,024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Equation 23-3 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

CHOLD	=	25 pF
• Rs	=	2.5 kΩ
Conversion Error	$\leq$	1/2 LSb
• Vdd	=	$3V \rightarrow Rss = 2 \ k\Omega$
Temperature	=	85°C (system max.)

#### EQUATION 23-1: ACQUISITION TIME

TACQ =	Amplifier Settling Time + Holding Capacitor Charging Time + Temperature Coefficient	
=	TAMP + TC + TCOFF	

#### EQUATION 23-2: A/D MINIMUM CHARGING TIME

VHOLD	=	$(\text{VREF} - (\text{VREF}/2048)) \bullet (1 - e^{(-\text{TC/CHOLD}(\text{RIC} + \text{RSS} + \text{RS}))})$
or		
TC	=	-(CHOLD)(RIC + RSS + RS) ln(1/2048)

#### EQUATION 23-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

TACQ	=	TAMP + TC + TCOFF
Тамр	=	0.2 μs
TCOFF	=	(Temp – 25°C)(0.02 μs/°C) (85°C – 25°C)(0.02 μs/°C) 1.2 μs
Tempera	ture c	oefficient is only required for temperatures $> 25^{\circ}$ C. Below 25°C, TCOFF = 0 ms.
Тс	=	-(Chold)(Ric + Rss + Rs) $\ln(1/2048)$ µs -(25 pF) (1 k $\Omega$ + 2 k $\Omega$ + 2.5 k $\Omega$ ) ln(0.0004883) µs 1.05 µs
TACQ	=	0.2 μs + 1.05 μs + 1.2 μs 2.45 μs

© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

#### 23.4 Selecting and Configuring Automatic Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the  $GO/\overline{DONE}$  bit is set.

When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit.

This occurs when the ACQT<2:0> bits (ADCON2<5:3>) remain in their Reset state ('000'), which is compatible with devices that do not offer programmable acquisition times.

If desired, the ACQTx bits can be set to select a programmable acquisition time for the A/D module. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

#### 23.5 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 14 TAD per 12-bit conversion. The source of the A/D conversion clock is software-selectable.

The possible options for TAD are:

- 2 Tosc
- 4 Tosc
- 8 Tosc
- 16 Tosc
- 32 Tosc
- 64 Tosc
- Using the internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible but greater than the minimum TAD. (For more information, see parameter 130 in Table 31-26.)

Table 23-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

### TABLE 23-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock S	Maximum	
Operation	ADCS<2:0>	Device Frequency
2 Tosc	000	2.86 MHz
4 Tosc	100	5.71 MHz
8 Tosc	001	11.43 MHz
16 Tosc	101	22.86 MHz
32 Tosc	010	40.00 MHz
64 Tosc	110	40.00 MHz
RC <sup>(2)</sup>	x11	1.00 MHz <sup>(1)</sup>

Note 1: The RC source has a typical TAD time of 4  $\mu s.$ 

2: For device frequencies above 1 MHz, the device must be in Sleep mode for the entire conversion or the A/D accuracy may be out of specification.

### 23.6 Configuring Analog Port Pins

The ANCON0, ANCON1, ANCON2, TRISA, TRISF, TRISG and TRISH registers control the operation of the A/D port pins. The port pins needed as analog inputs must have their corresponding TRISx bits set (input). If the TRISx bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS<3:0> bits and the TRISx bits.

- Note 1: When reading the PORT register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will be accurately converted.
  - 2: Analog levels on any pin defined as a digital input may cause the digital input buffer to consume current out of the device's specification limits.

#### 查询PIC18F86K90供应商 23.7 A/D Conversions

Figure 23-6 shows the operation of the A/D Converter after the GO/DONE bit has been set and the ACQT<2:0> bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

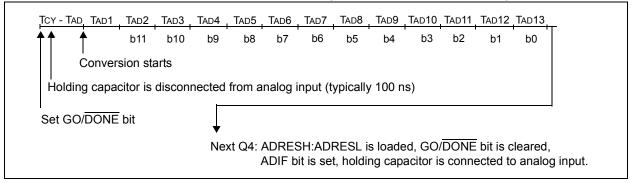
Figure 23-7 shows the operation of the A/D Converter after the GO/DONE bit has been set, the ACQT<2:0> bits set to '010' and a 4 TAD acquisition time selected.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

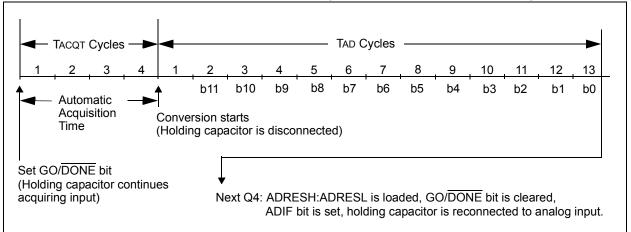
After the A/D conversion is completed or aborted, a 2 TAD wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

Note:	The GO/DONE bit should NOT be set in
	the same instruction that turns on the A/D.

#### FIGURE 23-6: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)



#### FIGURE 23-7: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)



#### 查询PIC18F86K90供应商

#### 23.8 Use of the Special Event Triggers

A/D conversion can be started by the Special Event Trigger of any of these modules:

- ECCP2 Requires CCP2M<3:0> bits (CCP2CON<3:0>) set at '1011'
- CTMU Requires the setting of the CTTRIG bit (CTMUCONH<0>)
- Timer1
- RTCC
- To start an A/D conversion:
- The A/D module must be enabled (ADON = 1)
- The appropriate analog input channel selected
- The minimum acquisition period set one of these ways:
  - Timing provided by the user
  - Selection made of an appropriate TACQ time

With these conditions met, the trigger sets the GO/DONE bit and the A/D acquisition starts.

If the A/D module is not enabled (ADON = 0), the module ignores the Special Event Trigger.

Note: With an ECCP2 trigger, Timer1 or Timer3 is cleared. The timers reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH:ADRESL to the desired location). If the A/D module is not enabled, the Special Event Trigger is ignored by the module, but the timer's counter resets.

#### 23.9 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT<2:0> and ADCS<2:0> bits in ADCON2 should be updated in accordance with the power-managed mode clock that will be used.

After the power-managed mode is entered (either of the power-managed Run modes), an A/D acquisition or conversion may be started. Once an acquisition or conversion is started, the device should continue to be clocked by the same power-managed mode clock source until the conversion has been completed. If desired, the device may be placed into the corresponding power-managed Idle mode during the conversion.

If the power-managed mode clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in Sleep mode requires that the A/D RC clock be selected. If bits, ACQT<2:0>, are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry into Sleep mode. The IDLEN and SCS<1:0> bits in the OSCCON register must have already been cleared prior to starting the conversion.

#### 查询PIC18F86K90供应商 TABLE 23-2: SUMMARY OF A/D REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values
									on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
ADRESH	A/D Result	t Register H	igh Byte						74
ADRESL	A/D Result	t Register Lo	ow Byte						74
ADCON0	_	CHS4	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	74
ADCON1	TRIGSEL1	TRIGSEL0	VCFG1	VCFG0	VNCFG	CHSN2	CHSN1	CHSN0	74
ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	74
ANCON0	ANSEL7	ANSEL6	ANSEL5	ANSEL4	ANSEL3	ANSEL2	ANSEL1	ANSEL0	79
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	79
CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	78
PORTA	RA7 <sup>(2)</sup>	RA6 <sup>(2)</sup>	RA5	RA4	RA3	RA2	RA1	RA0	76
TRISA	TRISA7 <sup>(2)</sup>	TRISA6 <sup>(2)</sup>	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	76
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
PORTG	—	—	RG5/ LATG5 <sup>(3)</sup>	RG4	RG3	RG2	RG1	RG0	76
TRISG	_	_	_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	76
PORTH <sup>(1)</sup>	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	76
TRISH <sup>(1)</sup>	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: This register is not implemented on 64-pin devices.

**2:** These bits are available only in certain oscillator modes, when the OSC2 Configuration bit = 0. If that Configuration bit is cleared, this signal is not implemented.

3: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商 24.0 COMPARATOR MODULE

The analog comparator module contains three comparators that can be independently configured in a variety of ways. The inputs can be selected from the analog inputs and two internal voltage references. The digital outputs are available at the pin level and can also be read through the control register. Multiple output and interrupt event generation are also available. A generic single comparator from the module is shown in Figure 24-1.

Key features of the module includes:

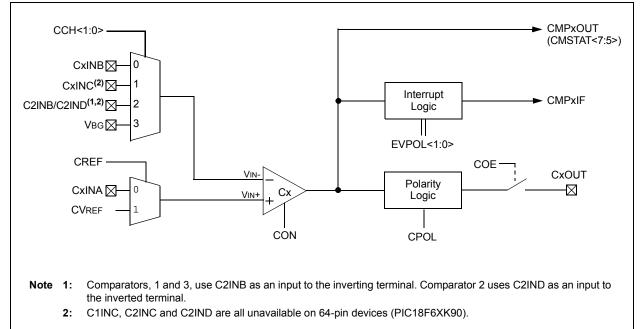
- · Independent comparator control
- · Programmable input configuration
- · Output to both pin and register levels
- · Programmable output polarity
- Independent interrupt generation for each comparator with configurable interrupt-on-change

#### 24.1 Registers

The CMxCON registers (CM1CON, CM2CON and CM3CON) select the input and output configuration for each comparator, as well as the settings for interrupt generation (see Register 24-1).

The CMSTAT register (Register 24-2) provides the output results of the comparators. The bits in this register are read-only.





#### 查询PIC18F86K90供应商

#### REGISTER 24-1: CMxCON: COMPARATOR CONTROL x REGISTER

R/W-0	R/W-0	R/W-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0
oit 7							bit
lagandi							
Legend: R = Read	abla bit	W = Writable	h:+		opted bit read		
n = Value		'1' = Bit is set		0 = Onimpien 0' = Bit is clea	nented bit, read		0.11/2
-n = value	ealPOR	I = BILIS SEL		0 = Bit is clea	ared	x = Bit is unkr	IOWN
bit 7	CON: Compa	arator Enable bi	t				
	•	tor is enabled					
		tor is disabled					
bit 6	COE: Compa	arator Output Er	nable bit				
	1 = Comparator output is present on the CxOUT pin						
		ator output is inte	-				
bit 5	CPOL: Comparator Output Polarity Select bit						
		ator output is inv ator output is no					
bit 4-3		Interrupt Pola					
		t generation on	•				
	10 = Interrup	ot generation on	ly on high-to-lo	ow transition of t			
				gh transition of t	he output		
	•	ot generation is o			0		
bit 2	•		•	non-inverting inp	,		
		rting input conn		ernal CVREF voli INA nin	lage		
bit 1-0		Comparator Cha		•			
		g input of comp					
				s to the C2INB	or C2IND pin <sup>(2</sup>	,3)	
		• • •		s to the CxINC	•		
	00 = Invertin	g input of comp	arator connect	s to the CxINB	pin		
Note 1:	The CMPxIF bit i after the initial cc	-	set any time th	is mode is sele	cted and must l	be cleared by t	he application

**3:** C1INC, C2INC and C2IND are all unavailable for 64-pin devices (PIC18F6XK90).

### 查询PIC18F86K90供应商

#### REGISTER 24-2: CMSTAT: COMPARATOR STATUS REGISTER

R-1	R-1	R-1	U-0	U-0	U-0	U-0	U-0
CMP3OUT	CMP2OUT	CMP1OUT	—	_	—	—	—
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

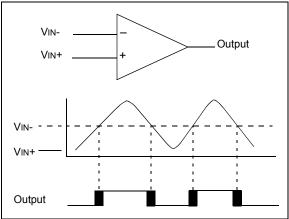
bit 7-5	CMPxOUT<3:1>: Comparator x Status bits
	If CPOL (CMxCON<5>)= 0 (non-inverted polarity):
	1 = Comparator x's VIN+ > VIN-
	0 = Comparator x's VIN+ < VIN-
	If CPOL = 1 (inverted polarity):
	1 = Comparator x's VIN+ < VIN-
	0 = Comparator x's VIN+ > VIN-

bit 4-0 Unimplemented: Read as '0'

#### 查询PIC18F86K90供应商 24.2 Comparator Operation

A single comparator is shown in Figure 24-2, along with the relationship between the analog input levels and the digital output. When the analog input at VIN+ is less than the analog input, VIN-, the output of the comparator is a digital low level. When the analog input at VIN+ is greater than the analog input, VIN-, the output of the comparator is a digital high level. The shaded areas of the output of the comparator in Figure 24-2 represent the uncertainty due to input offsets and response time.

#### FIGURE 24-2: SINGLE COMPARATOR



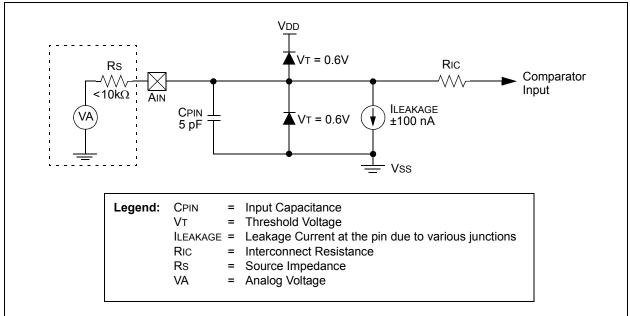
#### 24.3 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output has a valid level. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response to a comparator input change. Otherwise, the maximum delay of the comparators should be used (see **Section 31.0 "Electrical Characteristics"**).

#### 24.4 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 24-3. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and VSs. The analog input, therefore, must be between VSs and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up condition may occur.

A maximum source impedance of  $10 \text{ k}\Omega$  is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.



#### FIGURE 24-3: COMPARATOR ANALOG INPUT MODEL

#### 查询PIC18F86K90供应商

#### 24.5 Comparator Control and Configuration

Each comparator has up to eight possible combinations of inputs: up to four external analog inputs and one of two internal voltage references.

All of the comparators allow a selection of the signal from pin, CxINA, or the voltage from the Comparator Voltage Reference (CVREF) on the non-inverting channel. This is compared to either CxINB, CxINC, C2INB/C2IND or the microcontroller's fixed internal reference voltage (VBG, 1.024V nominal) on the inverting channel. The comparator inputs and outputs are tied to fixed I/O pins, defined in Table 24-1. The available comparator configurations and their corresponding bit settings are shown in Figure 24-4.

TABLE 24-1:	COMPARATOR INPUTS AND
	OUTPUTS

0011010				
Comparator	Input or Output	I/O Pin		
	C1INA (VIN+)	RF6		
	C1INB (VIN-)	RF5		
1	C1INC <sup>(1)</sup> (VIN-)	RH6		
	C2INB (VIN-)	RF3		
	C1OUT	RF2		
	C2INA (VIN+)	RF4		
	C2INB (VIN-)	RF3		
2	C2INC <sup>(1)</sup> (VIN-)	RH4		
	C2IND <sup>(1)</sup> (VIN-)	RH5		
	C2OUT	RF1		
	C3INA (VIN+)	RG2		
	C3INB (VIN-)	RG3		
3	C3INC (VIN-)	RG4		
	C2INB (VIN-)	RF3		
	C3OUT	RG1		
Nata A: C1				

Note 1: C1INC, C2INC and C2IND are all unavailable for 64-pin devices (PIC18F6XK90).

### 24.5.1 COMPARATOR ENABLE AND INPUT SELECTION

Setting the CON bit of the CMxCON register (CMxCON<7>) enables the comparator for operation. Clearing the CON bit disables the comparator, resulting in minimum current consumption.

The CCH<1:0> bits in the CMxCON register (CMxCON<1:0>) direct either one of three analog input pins, or the Internal Reference Voltage (VBG), to the comparator, VIN-. Depending on the comparator

operating mode, either an external or internal voltage reference may be used. For external analog pins that are unavailable in 64-pin devices (C1INC, C2INC and C2IND), the corresponding configurations that use them as inputs are unavailable.

The analog signal present at VIN- is compared to the signal at VIN+ and the digital output of the comparator is adjusted accordingly.

The external reference is used when CREF = 0 (CMxCON<2>) and VIN+ is connected to the CxINA pin. When external voltage references are used, the comparator module can be configured to have the reference sources externally. The reference signal must be between VSS and VDD and can be applied to either pin of the comparator.

The comparator module also allows the selection of an internally generated voltage reference from the Comparator Voltage Reference (CVREF) module. This module is described in more detail in **Section 25.0 "Comparator Voltage Reference Module**". The reference from the comparator voltage reference module is only available when CREF = 1. In this mode, the internal voltage reference is applied to the comparator's VIN+ pin.

Note:	The comparator input pin selected by
	CCH<1:0> must be configured as an input
	by setting both the corresponding TRISF,
	TRISG or TRISH bit and the corresponding
	ANSELx bit in the ANCONx register.

### 24.5.2 COMPARATOR ENABLE AND OUTPUT SELECTION

The comparator outputs are read through the CMSTAT register. The CMSTAT<5> bit reads the Comparator 1 output, CMSTAT<6> reads Comparator 2 output and CMSTAT<7> reads Comparator 3 output. These bits are read-only.

The comparator outputs may also be directly output to the RF2, RF1 and RG1 I/O pins by setting the COE bit (CMxCON<6>). When enabled, multiplexers in the output path of the pins switch to the output of the comparator. While in this mode, the TRISF<2:1> and TRISG<1> bits still function as the digital output enable bits for the RF2, RF1 and RG1 pins.

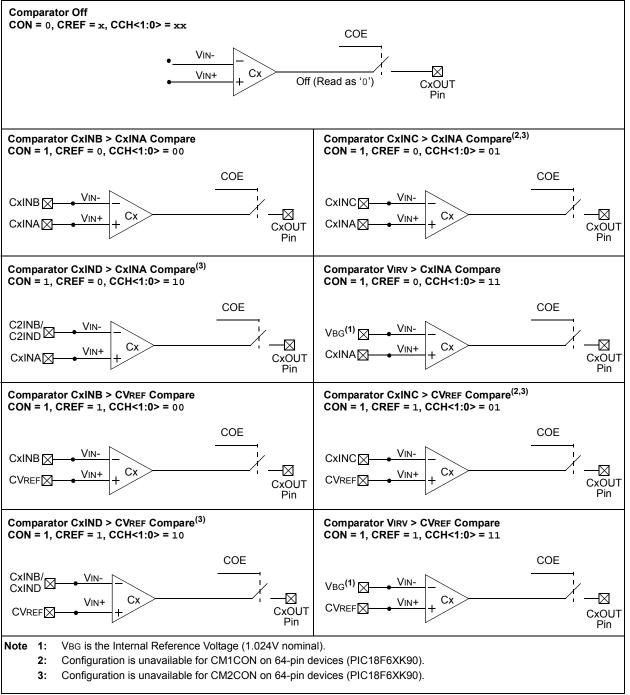
By default, the comparator's output is at logic high whenever the voltage on VIN+ is greater than on VIN-. The polarity of the comparator outputs can be inverted using the CPOL bit (CMxCON<5>).

The uncertainty of each of the comparators is related to the input offset voltage and the response time given in the specifications, as discussed in **Section 24.2 "Comparator Operation"**.

#### 查询PIC18F86K90供应商

FIGURE 24-4: COMPARATOR CONFIGURATIONS





### 查询PIC18F86K90供应商

#### 24.6 Comparator Interrupts

The comparator interrupt flag is set whenever any of the following occurs:

- · Low-to-high transition of the comparator output
- High-to-low transition of the comparator output
- Any change in the comparator output

The comparator interrupt selection is done by the EVPOL<1:0> bits in the CMxCON register (CMxCON<4:3>).

In order to provide maximum flexibility, the output of the comparator may be inverted using the CPOL bit in the CMxCON register (CMxCON<5>). This is functionally identical to reversing the inverting and non-inverting inputs of the comparator for a particular mode.

An interrupt is generated on the low-to-high or high-tolow transition of the comparator output. This mode of interrupt generation is dependent on EVPOL<1:0> in the CMxCON register. When EVPOL<1:0> = 01 or 10, the interrupt is generated on a low-to-high or high-tolow transition of the comparator output. Once the interrupt is generated, it is required to clear the interrupt flag by software. When EVPOL<1:0> = 11, the comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMSTAT<7:5>, to determine the actual change that occurred.

The CMPxIF bits (PIR6<2:0>) are the Comparator Interrupt Flags. The CMPxIF bits must be reset by clearing them. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated. Table 24-2 shows the interrupt generation with respect to comparator input voltages and EVPOL bit settings.

Both the CMPxIE bits (PIE6<2:0>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit (INTCON<7>) must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMPxIF bits will still be set if an interrupt condition occurs.

A simplified diagram of the interrupt section is shown in Figure 24-3.

**Note:** CMPxIF will not be set when EVPOL<1:0> = 00.

CPOL	EVPOL<1:0>	Comparator Input Change	CxOUT Transition	Interrupt Generated
	0.0	VIN+ > VIN-	Low-to-High	No
	00	VIN+ < VIN-	High-to-Low	No
	01	VIN+ > VIN-	Low-to-High	Yes
0	01	VIN+ < VIN-	High-to-Low	No
0	1.0	VIN+ > VIN-	Low-to-High	No
	10	VIN+ < VIN-	High-to-Low	Yes
	11	VIN+ > VIN-	Low-to-High	Yes
		VIN+ < VIN-	High-to-Low	Yes
	00	VIN+ > VIN-	High-to-Low	No
		VIN+ < VIN-	Low-to-High	No
		VIN+ > VIN-	High-to-Low	No
1		VIN+ < VIN-	Low-to-High	Yes
1	10 -	VIN+ > VIN-	High-to-Low	Yes
		VIN+ < VIN-	Low-to-High	No
	11	VIN+ > VIN-	High-to-Low	Yes
	11	Vin+ < Vin-	Low-to-High	Yes

#### TABLE 24-2: COMPARATOR INTERRUPT GENERATION

#### 查询PIC18F86K90供应商

#### 24.7 Comparator Operation During Sleep

When a comparator is active and the device is placed in Sleep mode, the comparator remains active and the interrupt is functional, if enabled. This interrupt will wake-up the device from Sleep mode, when enabled. Each operational comparator will consume additional current. To minimize power consumption while in Sleep mode, turn off the comparators (CON = 0) before entering Sleep. If the device wakes up from Sleep, the contents of the CMxCON register are not affected.

#### 24.8 Effects of a Reset

A device Reset forces the CMxCON registers to their Reset state. This forces both comparators and the voltage reference to the OFF state.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	<b>INT0IF</b>	RBIF	73
PIR6	_	_	_	EEIF	_	CMP3IF	CMP2IF	CMP1IF	75
PIE6	_	_		EEIE	_	CMP3IE	CMP2IE	CMP1IE	78
IPR6	_	_	_	EEIP	_	CMP3IP	CMP2IP	CMP1IP	75
CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	78
CM2CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
CM3CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
CVRCON	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	75
CMSTAT	CMP3OUT	CMP2OUT	CMP1OUT		—	_	_	_	75
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	76
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
PORTG	—	_	RG5	RG4	RG3	RG2	RG1	RG0	76
LATG	—	_	—	LATG4	LATG3	LATG2	LATG1	LATG0	76
TRISG	_	_		TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	76
PORTH	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	76
LATH	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	76
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76

#### TABLE 24-3: REGISTERS ASSOCIATED WITH COMPARATOR MODULE

**Legend:** — = unimplemented, read as '0'.

#### 查询PIC18F86K90供应商

#### 25.0 COMPARATOR VOLTAGE REFERENCE MODULE

The comparator voltage reference is a 32-tap resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it may also be used independently of them.

A block diagram of the module is shown in Figure 25-1. The resistor ladder is segmented to provide a range of CVREF values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference.

#### 25.1 Configuring the Comparator Voltage Reference

The comparator voltage reference module is controlled through the CVRCON register (Register 25-1). The comparator voltage reference provides a range of output voltage with 32 levels.

The CVR<4:0> selection bits (CVRCON<4:0>) offer a range of output voltages. Equation 25-1 shows how the comparator voltage reference is computed.

#### EQUATION 25-1:

If CVRSS = 1:

 $CVREF = (VREF-) + (CVR < 4:0 > /32) \cdot (VREF+ - VREF-)$ 

If CVRSS = 0:

 $C_{VREF} = (AVSS) + (CVR < 4:0 > /32) \bullet (AVDD - AVSS)$ 

The comparator reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF- that are multiplexed with RA3 and RA2. The voltage source is selected by the CVRSS bit (CVRCON<5>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output (see Table 31-2 in **Section 31.0 "Electrical Characteristics"**).

#### REGISTER 25-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

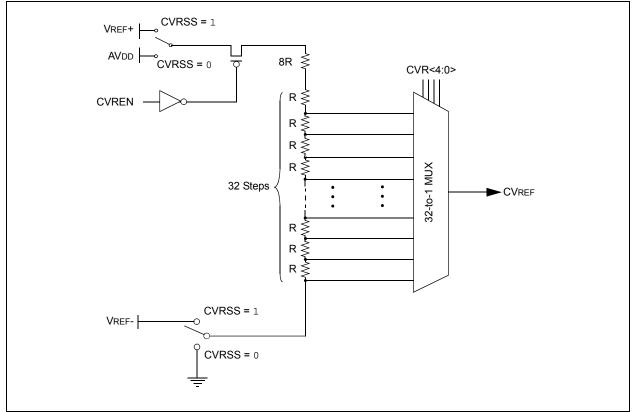
| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CVREN | CVROE | CVRSS | CVR4  | CVR3  | CVR2  | CVR1  | CVR0  |
| bit 7 | •     |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

CVREN: Comparator Voltage Reference Enable bit 1 = CVREF circuit is powered on 0 = CVREF circuit is powered down
CVROE: Comparator VREF Output Enable bit
<ul> <li>1 = CVREF voltage level is output on the CVREF pin</li> <li>0 = CVREF voltage level is disconnected from the CVREF pin</li> </ul>
CVRSS: Comparator VREF Source Selection bit
<ul> <li>1 = Comparator reference source, CVRSRC = VREF+ – VREF-</li> <li>0 = Comparator reference source, CVRSRC = AVDD – AVSS</li> </ul>
<b>CVR&lt;4:0&gt;:</b> Comparator VREF Value Selection ( $0 \le CVR<4:0> \le 31$ ) bits
When CVRSS = 1:
CVREF = (VREF-) + (CVR<4:0>/32) • (VREF+ – VREF-)
$\frac{\text{When CVRSS} = 0}{\text{CVR}}$
$CVREF = (AVSS) + (CVR<4:0>/32) \bullet (AVDD - AVSS)$

#### 查询PIC18F86K90供应商

FIGURE 25-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM



#### 25.2 Voltage Reference Accuracy/Error

The full range of voltage reference cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 25-1) keep CVREF from approaching the reference source rails. The voltage reference is derived from the reference source; therefore, the CVREF output changes with fluctuations in that source. The tested absolute accuracy of the voltage reference can be found in **Section 31.0 "Electrical Characteristics"**.

#### 25.3 Operation During Sleep

When the device wakes up from Sleep through an interrupt or a Watchdog Timer time-out, the contents of the CVRCON register are not affected. To minimize current consumption in Sleep mode, the voltage reference should be disabled.

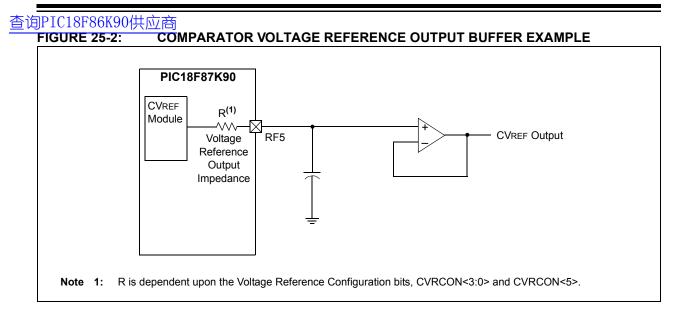
#### 25.4 Effects of a Reset

A device Reset disables the voltage reference by clearing bit, CVREN (CVRCON<7>). This Reset also disconnects the reference from the RF5 pin by clearing bit, CVROE (CVRCON<6>).

#### 25.5 Connection Considerations

The voltage reference module operates independently of the comparator module. The output of the reference generator may be connected to the RF5 pin if the CVROE bit is set. Enabling the voltage reference output onto RF5 when it is configured as a digital input will increase current consumption. Connecting RF5 as a digital output with CVRSS enabled will also increase current consumption.

The RF5 pin can be used as a simple D/A output with limited drive capability. Due to the limited current drive capability, a buffer must be used on the voltage reference output for external connections to VREF. Figure 25-2 shows an example buffering technique.



Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CVRCON	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	75
CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	78
CM2CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
CM3CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used with the comparator voltage reference.

查询PIC18F86K90供应商 NOTES:

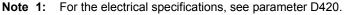
#### 查询PIC18F86K90供应商 **26.0 HIGH/LOW-VOLTAGE DETECT** (HLVD)

The PIC18F87K90 family of devices has a High/Low-Voltage Detect module (HLVD). This is a programmable circuit that sets both a device voltage trip point and the direction of change from that point. If the device experiences an excursion past the trip point in that direction, an interrupt flag is set. If the interrupt is enabled, the program execution branches to the interrupt vector address and the software responds to the interrupt. The High/Low-Voltage Detect Control register (Register 26-1) completely controls the operation of the HLVD module. This allows the circuitry to be "turned off" by the user under software control, which minimizes the current consumption for the device.

The module's block diagram is shown in Figure 26-1.

#### REGISTER 26-1: HLVDCON: HIGH/LOW-VOLTAGE DETECT CONTROL REGISTER

R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-0
VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3 <sup>(1)</sup>	HLVDL2 <sup>(1)</sup>	HLVDL1 <sup>(1)</sup>	HLVDL0 <sup>(1)</sup>
bit 7	-						bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'	
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7		oltage Directio	n Magnitude (	Select hit			
		•	•		oint (HLVDL<3:0	)>)	
					point (HLVDL<		
bit 6	BGVST: Ban	d Gap Referen	ce Voltages S	table Status Fla	ag bit		
		and gap voltag					
	0 = Internal b	and gap voltag	e references	are not stable			
bit 5	IRVST: Intern	al Reference \	oltage Stable	Flag bit			
			Ų	0	e interrupt flag		0 0
				not be enabled	ate the interrup	t hag at the spe	ecilied voltage
bit 4	•	gh/Low-Voltage	•				
	1 = HLVD is	enabled					
	0 = HLVD is						
bit 3-0	HLVDL<3:0>	: Voltage Dete	ction Limit bits	;(1)			
		• •	ut is used (inp	ut comes from	the HLVDIN pir	1)	
	1110 <b>= Maxi</b> r	num setting					
	•						
	•						
	0000 <b>= Minin</b>	num setting					
Note 1: For	the electrical s	necifications	ee narameter	· D420			



#### 查询PIC18F86K90供应商

The module is enabled by setting the HLVDEN bit (HLVDCON<4>). Each time the HLVD module is enabled, the circuitry requires some time to stabilize. The IRVST bit (HLVDCON<5>) is a read-only bit used to indicate when the circuit is stable. The module can only generate an interrupt after the circuit is stable and IRVST is set.

The VDIRMAG bit (HLVDCON<7>) determines the overall operation of the module. When VDIRMAG is cleared, the module monitors for drops in VDD below a predetermined set point. When the bit is set, the module monitors for rises in VDD above the set point.

#### 26.1 Operation

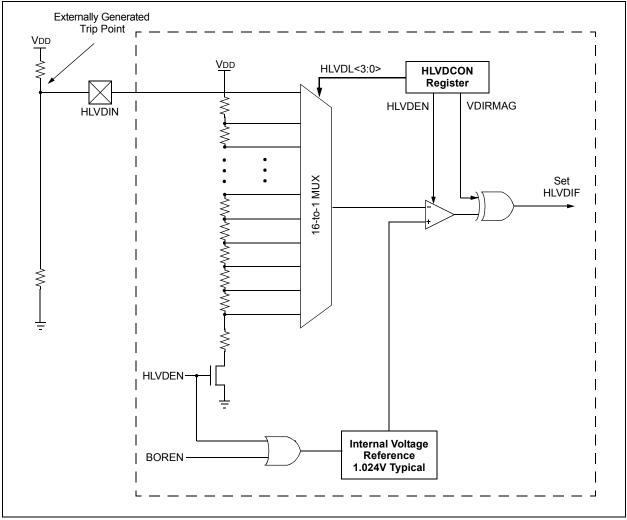
When the HLVD module is enabled, a comparator uses an internally generated reference voltage as the set point. The set point is compared with the trip point, where each node in the resistor divider represents a trip point voltage. The "trip point" voltage is the voltage level at which the device detects a high or low-voltage event, depending on the configuration of the module.

When the supply voltage is equal to the trip point, the voltage tapped off of the resistor array is equal to the internal reference voltage generated by the voltage reference module. The comparator then generates an interrupt signal by setting the HLVDIF bit.

The trip point voltage is software programmable to any of 16 values. The trip point is selected by programming the HLVDL<3:0> bits (HLVDCON<3:0>).

The HLVD module has an additional feature that allows the user to supply the trip voltage to the module from an external source. This mode is enabled when bits, HLVDL<3:0>, are set to '1111'. In this state, the comparator input is multiplexed from the external input pin, HLVDIN. This gives users the flexibility of configuring the High/Low-Voltage Detect interrupt to occur at any voltage in the valid operating range.





#### 查询PIC18F86K90供应商 26.2 HLVD Setup

To set up the HLVD module:

- 1. Select the desired HLVD trip point by writing the value to the HLVDL<3:0> bits.
- 2. Set the VDIRMAG bit to detect high voltage (VDIRMAG = 1) or low voltage (VDIRMAG = 0).
- 3. Enable the HLVD module by setting the HLVDEN bit.
- 4. Clear the HLVD interrupt flag (PIR2<2>), which may have been set from a previous interrupt.
- If interrupts are desired, enable the HLVD interrupt by setting the HLVDIE and GIE bits (PIE2<2> and INTCON<7>, respectively).

An interrupt will not be generated until the IRVST bit is set.

**Note:** Before changing any module settings (VDIRMAG, HLVDL<3:0>), first disable the module (HLVDEN = 0), make the changes and re-enable the module. This prevents the generation of false HLVD events.

#### 26.3 Current Consumption

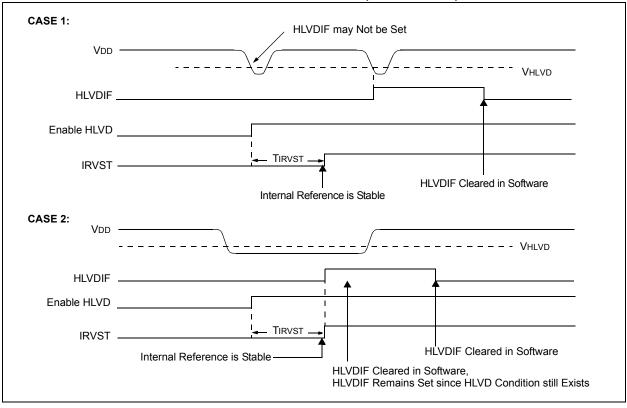
When the module is enabled, the HLVD comparator and voltage divider are enabled and consume static current. The total current consumption, when enabled, is specified in electrical specification parameter D022B (Table 31-10). Depending on the application, the HLVD module does not need to operate constantly. To reduce current requirements, the HLVD circuitry may only need to be enabled for short periods where the voltage is checked. After such a check, the module could be disabled.

#### 26.4 HLVD Start-up Time

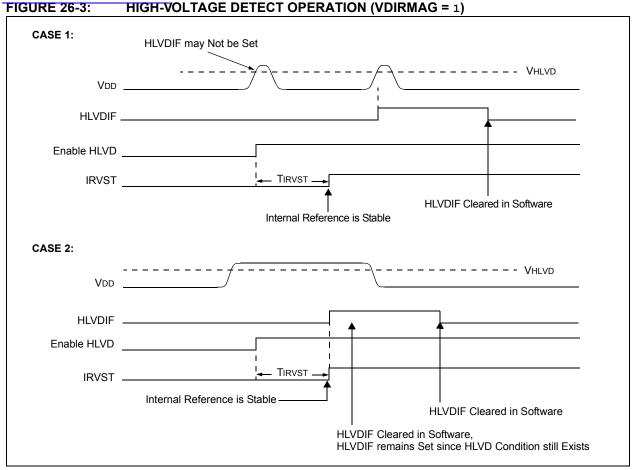
The internal reference voltage of the HLVD module, specified in electrical specification parameter 37 (Section 31.0 "Electrical Characteristics"), may be used by other internal circuitry, such as the programmable Brown-out Reset. If the HLVD or other circuits using the voltage reference are disabled to lower the device's current consumption, the reference voltage circuit will require time to become stable before a low or high-voltage condition can be reliably detected. This start-up time, TIRVST, is an interval that is independent of device clock speed. It is specified in electrical specification parameter 36 (Table 31-10).

The HLVD interrupt flag is not enabled until TIRVST has expired and a stable reference voltage is reached. For this reason, brief excursions beyond the set point may not be detected during this interval (see Figure 26-2 or Figure 26-3).

#### FIGURE 26-2: LOW-VOLTAGE DETECT OPERATION (VDIRMAG = 0)



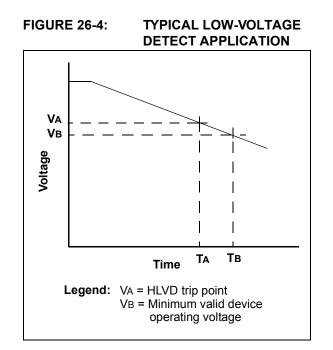
#### 查询PIC18F86K90供应商



#### 26.5 Applications

In many applications, it is desirable to detect a drop below, or rise above, a particular voltage threshold. For example, the HLVD module could be periodically enabled to detect Universal Serial Bus (USB) attach or detach. This assumes the device is powered by a lower voltage source than the USB when detached. An attach would indicate a high-voltage detect from, for example, 3.3V to 5V (the voltage on USB) and vice versa for a detach. This feature could save a design a few extra components and an attach signal (input pin).

For general battery applications, Figure 26-4 shows a possible voltage curve. Over time, the device voltage decreases. When the device voltage reaches voltage, VA, the HLVD logic generates an interrupt at time, TA. The interrupt could cause the execution of an ISR, which would allow the application to perform "house-keeping tasks" and a controlled shutdown before the device voltage exits the valid operating range at TB. This would give the application a time window, represented by the difference between TA and TB, to safely exit.



### 查询PIC18F86K90供应商

26.6 Operation During Sleep

When enabled, the HLVD circuitry continues to operate during Sleep. If the device voltage crosses the trip point, the HLVDIF bit will be set and the device will wake-up from Sleep. Device execution will continue from the interrupt vector address if interrupts have been globally enabled.

#### 26.7 Effects of a Reset

A device Reset forces all registers to their Reset state. This forces the HLVD module to be turned off.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
HLVDCON	VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3	HLVDL2	HLVDL1	HLVDL0	75
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR2	OSCFIF	—	SSP2IF	BLC2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE	—	SSP2IE	BLC2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
IPR2	OSCFIP	_	SSP2IP	BLC2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
TRISA	TRISA7 <sup>(1)</sup>	TRISA6 <sup>(1)</sup>	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	76

#### TABLE 26-1: REGISTERS ASSOCIATED WITH HIGH/LOW-VOLTAGE DETECT MODULE

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the HLVD module.

**Note 1:** PORTA<7:6> and their direction bits are individually configured as port pins based on various primary oscillator modes. When disabled, these bits read as '0'.

查询PIC18F86K90供应商 NOTES:

### 查询PIC18F86K90供应商

#### 27.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

The Charge Time Measurement Unit (CTMU) is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation. By working with other on-chip analog modules, the CTMU can precisely measure time, capacitance and relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors.

The module includes these key features:

- Up to 24 channels available for capacitive or time measurement input
- · On-chip precision current source
- Four-edge input trigger sources
- Polarity control for each edge source
- Control of edge sequence

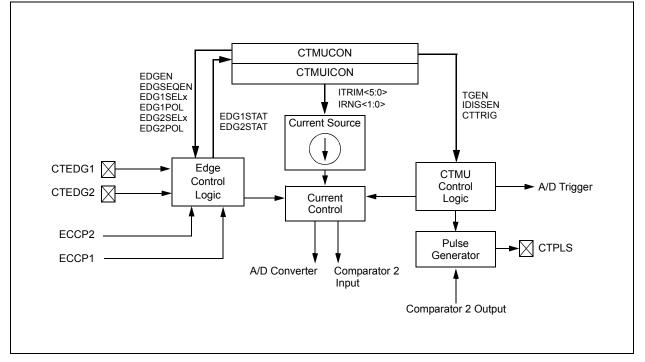
#### FIGURE 27-1: CTMU BLOCK DIAGRAM

- Control of response to edges
- · Time measurement resolution of 1 nanosecond
- · High-precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- Accurate current source suitable for capacitive measurement

The CTMU works in conjunction with the A/D Converter to provide up to 24 channels for time or charge measurement, depending on the specific device and the number of A/D channels available. When configured for time delay, the CTMU is connected to one of the analog comparators. The level-sensitive input edge sources can be selected from four sources: two external inputs or the ECCP1/ECCP2 Special Event Triggers.

The CTMU special event can trigger the Analog-to-Digital Converter module.

Figure 27-1 provides a block diagram of the CTMU.



#### 查询PIC18F86K90供应商 27.1 CTMU Registers

The control registers for the CTMU are:

- CTMUCONH
- CTMUCONL
- CTMUICON

The CTMUCONH and CTMUCONL registers (Register 27-1 and Register 27-2) contain control bits for configuring the CTMU module edge source selection, edge source polarity selection, edge sequencing, A/D trigger, analog circuit capacitor discharge and enables. The CTMUICON register (Register 27-3) has bits for selecting the current source range and current source trim.

#### REGISTER 27-1: CTMUCONH: CTMU CONTROL HIGH REGISTER

CTMUEN — CTMUSIDL TGEN EDGEN EDGSEQEN IDISSEN CTTRIG bit 7 bit 0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
bit 7 bit 0	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG
	bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	CTMUEN: CTMU Enable bit
	<ul><li>1 = Module is enabled</li><li>0 = Module is disabled</li></ul>
bit 6	Unimplemented: Read as '0'
bit 5	CTMUSIDL: Stop in Idle Mode bit
	<ul><li>1 = Discontinue module operation when device enters Idle mode</li><li>0 = Continue module operation in Idle mode</li></ul>
bit 4	TGEN: Time Generation Enable bit
	<ul><li>1 = Enables edge delay generation</li><li>0 = Disables edge delay generation</li></ul>
bit 3	EDGEN: Edge Enable bit
	<ul><li>1 = Edges are not blocked</li><li>0 = Edges are blocked</li></ul>
bit 2	EDGSEQEN: Edge Sequence Enable bit
	<ul> <li>1 = Edge 1 event must occur before Edge 2 event can occur</li> <li>0 = No edge sequence is needed</li> </ul>
bit 1	IDISSEN: Analog Current Source Control bit
	<ul><li>1 = Analog current source output is grounded</li><li>0 = Analog current source output is not grounded</li></ul>
bit 0	<b>CTTRIG:</b> Trigger Control bit 1 = Trigger output is enabled 0 = Trigger output is disabled

#### 查询PIC18F86K90供应商 REGISTER 27-2: CTMUCONL: CTMU CONTROL LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT
bit 7							bit 0

Legend:				
R = Reada	ble bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	EDG2PO	L: Edge 2 Polarity Select bit	t	
		e 2 is programmed for a posi e 2 is programmed for a nega		
bit 6-5	11 = CTE 10 = CTE 01 = ECC		ect bits	
bit 4	1 = Edge	L: Edge 1 Polarity Select bit a 1 is programmed for a posi a 1 is programmed for a nega	tive edge response	
bit 3-2	11 = CTE 10 = CTE 01 = ECC	1	ect bits	
bit 1	1 = Edge	AT: Edge 2 Status bit 2 2 event has occurred 2 2 event has not occurred		
bit 0	1 = Edge	AT: Edge 1 Status bit e 1 event has occurred e 1 event has not occurred		

### 查询PIC18F86K90供应商 REGISTER 27-3: CTMUICON: CTMU CURRENT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0		
bit 7	•			•			bit C		
Legend:									
R = Readab	le bit	W = Writable	bit	U = Unimplem	ented bit, read	l as '0'			
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unki	nown		
	<ul> <li>011110</li> <li>.</li> &lt;</ul>								
	100010 100001 = Ma	ximum negativ	e change from	nominal currer	t				
bit 1-0	IRNG<1:0>: Current Source Range Select bits 11 = 100 x Base Current 10 = 10 x Base Current								

- 01 = Base current level (0.55 μA nominal)
- 00 = Current source disabled

### 查询PIC18F86K90供应商

#### 27.2 CTMU Operation

The CTMU works by using a fixed current source to charge a circuit. The type of circuit depends on the type of measurement being made.

In the case of charge measurement, the current is fixed and the amount of time the current is applied to the circuit is fixed. The amount of voltage read by the A/D becomes a measurement of the circuit's capacitance.

In the case of time measurement, the current, as well as the capacitance of the circuit, is fixed. In this case, the voltage read by the A/D is representative of the amount of time elapsed from the time the current source starts and stops charging the circuit.

If the CTMU is being used as a time delay, both capacitance and current source are fixed, as well as the voltage supplied to the comparator circuit. The delay of a signal is determined by the amount of time it takes the voltage to charge to the comparator threshold voltage.

#### 27.2.1 THEORY OF OPERATION

The operation of the CTMU is based on the equation for charge:

 $C = I \bullet \frac{dV}{dT}$ 

More simply, the amount of charge measured in coulombs in a circuit is defined as current in amperes (I) multiplied by the amount of time in seconds that the current flows (t). Charge is also defined as the capacitance in farads (C) multiplied by the voltage of the circuit (V). It follows that:

 $I \bullet t = C \bullet V$ 

The CTMU module provides a constant, known current source. The A/D Converter is used to measure (V) in the equation, leaving two unknowns: capacitance (C) and time (t). The above equation can be used to calculate capacitance or time, by either the relationship using the known fixed capacitance of the circuit:

 $t = (C \bullet V)/I$ 

or by:

$C = (I \bullet t)/V$
-----------------------

using a fixed time that the current source is applied to the circuit.

#### 27.2.2 CURRENT SOURCE

At the heart of the CTMU is a precision current source, designed to provide a constant reference for measurements. The level of current is user-selectable across three ranges or a total of two orders of magnitude, with the ability to trim the output in  $\pm 2\%$  increments (nominal). The current range is selected by the IRNG<1:0> bits (CTMUICON<1:0>), with a value of '00' representing the lowest range.

Current trim is provided by the ITRIM<5:0> bits (CTMUICON<7:2>). These six bits allow trimming of the current source in steps of approximately 2% per step. Half of the range adjusts the current source positively and the other half reduces the current source. A value of '000000' is the neutral position (no change). A value of '100000' is the maximum negative adjustment (approximately -62%) and '011111' is the maximum positive adjustment (approximately +62%).

#### 27.2.3 EDGE SELECTION AND CONTROL

CTMU measurements are controlled by edge events occurring on the module's two input channels. Each channel, referred to as Edge 1 and Edge 2, can be configured to receive input pulses from one of the edge input pins (CTEDG1 and CTEDG2) or CCPx Special Event Triggers. The input channels are level-sensitive, responding to the instantaneous level on the channel rather than a transition between levels. The inputs are selected using the EDG1SEL and EDG2SEL bit pairs (CTMUCONL<3:2, 6:5>).

In addition to source, each channel can be configured for event polarity using the EDGE2POL and EDGE1POL bits (CTMUCONL<7,4>). The input channels can also be filtered for an edge event sequence (Edge 1 occurring before Edge 2) by setting the EDGSEQEN bit (CTMUCONH<2>).

#### 27.2.4 EDGE STATUS

The CTMUCON register also contains two status bits, EDG2STAT and EDG1STAT (CTMUCONL<1:0>). Their primary function is to show if an edge response has occurred on the corresponding channel. The CTMU automatically sets a particular bit when an edge response is detected on its channel. The level-sensitive nature of the input channels also means that the status bits become set immediately if the channel's configuration is changed and matches the channel's current state.

The module uses the edge status bits to control the current source output to external analog modules (such as the A/D Converter). Current is only supplied to external modules when only one (not both) of the status bits is set. Current is shut off when both bits are either set or cleared. This allows the CTMU to measure current only during the interval between edges. After both status bits are set, it is necessary to clear them before another measurement is taken. Both bits should be cleared simultaneously, if possible, to avoid re-enabling the CTMU current source.

In addition to being set by the CTMU hardware, the edge status bits can also be set by software. This permits a user application to manually enable or disable the current source. Setting either (but not both) of the bits enables the current source. Setting or clearing both bits at once disables the source.

#### 查询PIC18F86K90供应商 27.2.5 INTERRUPTS

The CTMU sets its interrupt flag (PIR3<3>) whenever the current source is enabled, then disabled. An interrupt is generated only if the corresponding interrupt enable bit (PIE3<3>) is also set. If edge sequencing is not enabled (i.e., Edge 1 must occur before Edge 2), it is necessary to monitor the edge status bits and determine which edge occurred last and caused the interrupt.

### 27.3 CTMU Module Initialization

The following sequence is a general guideline used to initialize the CTMU module:

- 1. Select the current source range using the IRNGx bits (CTMUICON<1:0>).
- 2. Adjust the current source trim using the ITRIMx bits (CTMUICON<7:2>).
- Configure the edge input sources for Edge 1 and Edge 2 by setting the EDG1SEL and EDG2SEL bits (CTMUCONL<3:2> and <6:5>, respectively).
- Configure the input polarities for the edge inputs using the EDG1POL and EDG2POL bits (CTMUCONL<4,7>).

The default configuration is for negative edge polarity (high-to-low transitions).

5. Enable edge sequencing using the EDGSEQEN bit (CTMUCONH<2>).

By default, edge sequencing is disabled.

6. Select the operating mode (Measurement or Time Delay) with the TGEN bit.

The default mode is Time/Capacitance Measurement.

 Configure the module to automatically trigger an A/D conversion when the second edge event has occurred using the CTTRIG bit (CTMUCONH<0>).

The conversion trigger is disabled by default.

- 8. Discharge the connected circuit by setting the IDISSEN bit (CTMUCONH<1>).
- 9. After waiting a sufficient time for the circuit to discharge, clear IDISSEN.
- 10. Disable the module by clearing the CTMUEN bit (CTMUCONH<7>).
- 11. Clear the Edge Status bits, EDG2STAT and EDG1STAT (CTMUCONL<1:0>).
- 12. Enable both edge inputs by setting the EDGEN bit (CTMUCONH<3>).
- 13. Enable the module by setting the CTMUEN bit.

Depending on the type of measurement or pulse generation being performed, one or more additional modules may also need to be initialized and configured with the CTMU module:

- Edge Source Generation: In addition to the external edge input pins, CCPx Special Event Triggers can be used as edge sources for the CTMU.
- Capacitance or Time Measurement: The CTMU module uses the A/D Converter to measure the voltage across a capacitor that is connected to one of the analog input channels.
- Pulse Generation: When generating system clock independent, output pulses, the CTMU module uses Comparator 2 and the associated comparator voltage reference.

### 27.4 Calibrating the CTMU Module

The CTMU requires calibration for precise measurements of capacitance and time, as well as for accurate time delay. If the application only requires measurement of a relative change in capacitance or time, calibration is usually not necessary. An example of a lesser precision application is a capacitive touch switch, in which the touch circuit has a baseline capacitance and the added capacitance of the human body changes the overall capacitance of a circuit.

If actual capacitance or time measurement is required, two hardware calibrations must take place:

- The current source needs calibration to set it to a precise current.
- The circuit being measured needs calibration to measure or nullify any capacitance other than that to be measured.

#### 27.4.1 CURRENT SOURCE CALIBRATION

The current source on board the CTMU module has a range of  $\pm 60\%$  nominal for each of three current ranges. For precise measurements, it is possible to measure and adjust this current source by placing a high-precision resistor, RCAL, onto an unused analog channel. An example circuit is shown in Figure 27-2.

To measure the current source:

- 1. Initialize the A/D Converter.
- 2. Initialize the CTMU.
- Enable the current source by setting EDG1STAT (CTMUCONL<0>).
- 4. Issue the settling time delay.
- 5. Perform the A/D conversion.
- 6. Calculate the current source current using I = V/RCAL, where RCAL is a high-precision resistance and V is measured by performing an A/D conversion.

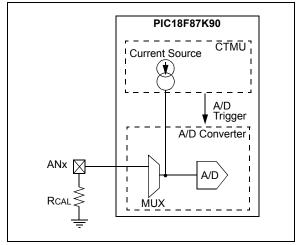
#### 查询PIC18F86K90供应商

The CTMU current source may be trimmed with the trim bits in CTMUICON using an iterative process to get the exact current desired. Alternatively, the nominal value without adjustment may be used. That value may be stored by software, for use in all subsequent capacitive or time measurements.

To calculate the value for  $\ensuremath{\mathrm{RCAL}}$  , the nominal current must be chosen. Then, the resistance can be calculated.

For example, if the A/D Converter reference voltage is 3.3V, use 70% of full scale (or 2.31V) as the desired approximate voltage to be read by the A/D Converter. If the range of the CTMU current source is selected to be 0.55  $\mu$ A, the resistor value needed is calculated as, RCAL = 2.31V/0.55  $\mu$ A, for a value of 4.2 MΩ. Similarly, if the current source is chosen to be 5.5  $\mu$ A, RCAL would be 420,000Ω, and 42,000Ω if the current source is set to 55  $\mu$ A.

#### FIGURE 27-2: CTMU CURRENT SOURCE CALIBRATION CIRCUIT



A value of 70% of full-scale voltage is chosen to make sure that the A/D Converter was in a range that is well above the noise floor. If an exact current is chosen to incorporate the trimming bits from CTMUICON, the resistor value of RCAL may need to be adjusted accordingly. RCAL also may be adjusted to allow for available resistor values. RCAL should be of the highest precision available, in light of the precision needed for the circuit that the CTMU will be measuring. A recommended minimum would be 0.1% tolerance.

The following examples show a typical method for performing a CTMU current calibration.

• Example 27-1 demonstrates how to initialize the A/D Converter and the CTMU.

This routine is typical for applications using both modules.

• Example 27-2 demonstrates one method for the actual calibration routine.

This method manually triggers the A/D Converter to demonstrate the entire step-wise process. It is also possible to automatically trigger the conversion by setting the CTMU's CTTRIG bit (CTMUCONH<0>).

```
查询PIC18F86K90供应商
             SETUP FOR CTMU CALIBRATION ROUTINES
EXAMPLE 27-1:
#include "p18cxxx.h"
 void setup(void)
 { //CTMUCON - CTMU Control register
   CTMUCONH = 0 \times 00;
                          //make sure CTMU is disabled
   CTMUCONL = 0X90;
   //CTMU continues to run when emulator is stopped,CTMU continues
   //to run in idle mode, Time Generation mode disabled, Edges are blocked
   //No edge sequence order, Analog current source not grounded, trigger
   //output disabled, Edge2 polarity = positive level, Edge2 source =
   //source 0, Edgel polarity = positive level, Edgel source = source 0,
   // Set Edge status bits to zero
    //CTMUICON - CTMU Current Control Register
   CTMUICON = 0 \times 01;
                          //0.55uA, Nominal - No Adjustment
 //Setup AD converter;
 TRISA=0x04;
                          //set channel 2 as an input
   // Configured AN2 as an analog channel
   // ANCONO
   ANCON0 = 0 \times 04;
   // ANCON1
   ANCON1 = 0 XE0;
   // ADCON1
   ADCON2bits.ADFM=1;
                      //Resulst format 1= Right justified
                          //Acquition time 7 = 20TAD 2 = 4TAD 1=2TAD
   ADCON2bits.ACQT=1;
   ADCON2bits.ADCS=2;
                          //Clock conversion bits 6= FOSC/64 2=FOSC/32
   // ADCON0
                        //Vref+ = AVdd
   ADCON1bits.VCFG0 =0;
   ADCON1bits.VCFG1 =0;
                          //Vref+ = AVdd
   ADCON1bits.VNCFG =0;
                         //Vref- = AVss
   ADCON0bits.CHS=2;
                          //Select ADC channel
   ADCON0bits.ADON=1;
                          //Turn on ADC
}
```

#### 查询PIC18F86K90供应商 EXAMPLE 27-2: CURRENT CALIBRATION ROUTINE

```
#include "pl8cxxx.h"
#define COUNT 500
                                          //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define RCAL .027
                                          //R value is 4200000 (4.2M)
                                          //scaled so that result is in
                                          //1/100th of uA
#define ADSCALE 1023
                                         //for unsigned conversion 10 sig bits
#define ADREF 3.3
                                          //Vdd connected to A/D Vr+
int main(void)
{
    int i;
    int j = 0; //index for loop
    unsigned int Vread = 0;
    double VTot = 0;
    float Vavg=0, Vcal=0, CTMUISrc = 0; //float values stored for calcs
//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();
CTMUCONHbits.CTMUEN = 1;
                                          //Enable the CTMU
    for(j=0;j<10;j++)</pre>
    {
        CTMUCONHbits.IDISSEN = 1;
                                          //drain charge on the circuit
        DELAY;
                                          //wait 125us
        CTMUCONHbits.IDISSEN = 0;
                                          //end drain of circuit
        CTMUCONLbits.EDG1STAT = 1;
                                          //Begin charging the circuit
                                          //using CTMU current source
        DELAY;
                                          //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;
                                          //Stop charging circuit
        PIR1bits.ADIF = 0;
                                          //make sure A/D Int not set
        ADCON0bits.GO=1;
                                          //and begin A/D conv.
        while(!PIR1bits.ADIF);
                                          //Wait for A/D convert complete
        Vread = ADRES;
                                          //Get the value from the A/D
        PIR1bits.ADIF = 0;
                                          //Clear A/D Interrupt Flag
        VTot += Vread;
                                          //Add the reading to the total
    }
    Vavg = (float)(VTot/10.000);
                                          //Average of 10 readings
    Vcal = (float)(Vavg/ADSCALE*ADREF);
    CTMUISrc = Vcal/RCAL;
                                          //CTMUISrc is in 1/100ths of uA
}
```

#### 查询PIC18F86K90供应商 27.4.2 CAPACITANCE CALIBRATION

There is a small amount of capacitance from the internal A/D Converter sample capacitor as well as stray capacitance from the circuit board traces and pads that affect the precision of capacitance measurements. A measurement of the stray capacitance can be taken by making sure the desired capacitance to be measured has been removed.

After removing the capacitance to be measured:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT (= 1).
- 3. Wait for a fixed delay of time, *t*.
- 4. Clear EDG1STAT.
- 5. Perform an A/D conversion.
- 6. Calculate the stray and A/D sample capacitances:

```
COFFSET = CSTRAY + CAD = (I \cdot t)/V
```

Where:

- I is known from the current source measurement step
- t is a fixed delay
- V is measured by performing an A/D conversion

This measured value is then stored and used for calculations of time measurement or subtracted for capacitance measurement. For calibration, it is expected that the capacitance of CSTRAY + CAD is approximately known; CAD is approximately 4 pF.

An iterative process may be required to adjust the time, *t*, that the circuit is charged to obtain a reasonable voltage reading from the A/D Converter. The value of *t* may be determined by setting *C*OFFSET to a theoretical value and solving for *t*. For example, if *C*STRAY is theoretically calculated to be 11 pF, and V is expected to be 70% of VDD or 2.31V, t would be:

or 63 µs.

See Example 27-3 for a typical routine for CTMU capacitance calibration.

#### 查询PIC18F86K90供应商 EXAMPLE 27-3: CAPACITANCE CALIBRATION ROUTINE

```
#include "pl8cxxx.h"
#define COUNT 25
                                          //@ 8MHz INTFRC = 62.5 us.
#define ETIME COUNT*2.5
                                          //time in uS
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define ADSCALE 1023
                                         //for unsigned conversion 10 sig bits
#define ADREF 3.3
                                         //Vdd connected to A/D Vr+
#define RCAL .027
                                          //R value is 4200000 (4.2M)
                                          //scaled so that result is in
                                          //1/100th of uA
int main(void)
{
    int i;
   int j = 0;
                                          //index for loop
   unsigned int Vread = 0;
   float CTMUISrc, CTMUCap, Vavg, VTot, Vcal;
//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();
CTMUCONHbits.CTMUEN = 1;
                                          //Enable the CTMU
    for(j=0;j<10;j++)</pre>
    {
        CTMUCONHbits.IDISSEN = 1;
                                          //drain charge on the circuit
        DELAY;
                                          //wait 125us
        CTMUCONHbits.IDISSEN = 0;
                                          //end drain of circuit
        CTMUCONLbits.EDG1STAT = 1;
                                          //Begin charging the circuit
                                          //using CTMU current source
        DELAY;
                                          //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;
                                          //Stop charging circuit
        PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
        ADCON0bits.GO=1;
                                         //and begin A/D conv.
        while(!PIR1bits.ADIF);
                                          //Wait for A/D convert complete
        Vread = ADRES;
                                          //Get the value from the A/D
        PIR1bits.ADIF = 0;
                                          //Clear A/D Interrupt Flag
        VTot += Vread;
                                          //Add the reading to the total
    }
   Vavg = (float)(VTot/10.000);
                                          //Average of 10 readings
   Vcal = (float)(Vavg/ADSCALE*ADREF);
                                          //CTMUISrc is in 1/100ths of uA
    CTMUISrc = Vcal/RCAL;
    CTMUCap = (CTMUISrc*ETIME/Vcal)/100;
}
```

© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

### 27.5 Measuring Capacitance with the CTMU

There are two ways to measure capacitance with the CTMU. The absolute method measures the actual capacitance value. The relative method only measures for any change in the capacitance.

#### 27.5.1 ABSOLUTE CAPACITANCE MEASUREMENT

For absolute capacitance measurements, both the current and capacitance calibration steps found in **Section 27.4 "Calibrating the CTMU Module"** should be followed.

To perform these measurements:

- 1. Initialize the A/D Converter.
- 2. Initialize the CTMU.
- 3. Set EDG1STAT.
- 4. Wait for a fixed delay, T.
- 5. Clear EDG1STAT.
- 6. Perform an A/D conversion.
- 7. Calculate the total capacitance, CTOTAL = (I \* T)/V, where:
  - I is known from the current source measurement step (Section 27.4.1 "Current Source Calibration")
  - T is a fixed delay
  - V is measured by performing an A/D conversion
- 8. Subtract the stray and A/D capacitance (COFFSET from Section 27.4.2 "Capacitance Calibration") from CTOTAL to determine the measured capacitance.

#### 27.5.2 RELATIVE CHARGE MEASUREMENT

Not all applications require precise capacitance measurements. When detecting a valid press of a capacitance-based switch, only a relative change of capacitance needs to be detected.

In such an application, when the switch is open (or not touched), the total capacitance is the capacitance of the combination of the board traces, the A/D Converter and other elements. A larger voltage will be measured by the A/D Converter. When the switch is closed (or touched), the total capacitance is larger due to the addition of the capacitance of the human body to the above listed capacitances and a smaller voltage will be measured by the A/D Converter.

To detect capacitance changes simply:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT.
- 3. Wait for a fixed delay.
- 4. Clear EDG1STAT.
- 5. Perform an A/D conversion.

The voltage measured by performing the A/D conversion is an indication of the relative capacitance. In this case, no calibration of the current source or circuit capacitance measurement is needed. (For a sample software routine for a capacitive touch switch, see Example 27-4.)

#### 查询PIC18F86K90供应商 EXAMPLE 27-4: ROUTINE FOR CAPACITIVE TOUCH SWITCH

```
#include "p18cxxx.h"
#define COUNT 500
                                          //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define OPENSW 1000
                                          //Un-pressed switch value
#define TRIP 300
                                          //Difference between pressed
                                         //and un-pressed switch
#define HYST 65
                                         //amount to change
                                          //from pressed to un-pressed
#define PRESSED 1
#define UNPRESSED 0
int main(void)
{
    unsigned int Vread;
                                         //storage for reading
    unsigned int switchState;
    int i;
    //assume CTMU and A/D have been setup correctly
    //see Example 27-1 for CTMU & A/D setup
    setup();
    CTMUCONHbits.CTMUEN = 1;
                                         //Enable the CTMU
    CTMUCONHbits.IDISSEN = 1;
                                         //drain charge on the circuit
                                         //wait 125us
   DELAY;
    CTMUCONHbits.IDISSEN = 0;
                                         //end drain of circuit
    CTMUCONLbits.EDG1STAT = 1;
                                         //Begin charging the circuit
                                         //using CTMU current source
                                         //wait for 125us
   DELAY;
    CTMUCONLbits.EDG1STAT = 0;
                                         //Stop charging circuit
    PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
    ADCON0bits.GO=1;
                                         //and begin A/D conv.
    while(!PIR1bits.ADIF);
                                         //Wait for A/D convert complete
    Vread = ADRES;
                                         //Get the value from the A/D
    if(Vread < OPENSW - TRIP)
    {
        switchState = PRESSED;
    else if(Vread > OPENSW - TRIP + HYST)
        switchState = UNPRESSED;
    }
}
```

#### 查询PIC18F86K90供应商

### 27.6 Measuring Time with the CTMU Module

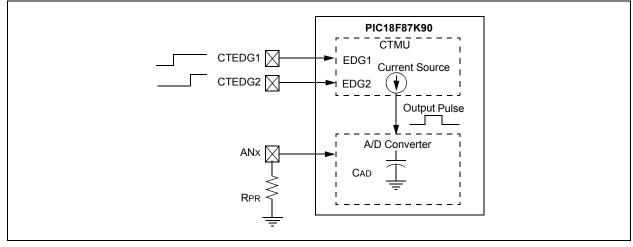
Time can be precisely measured after the ratio  $({\rm C/I})$  is measured from the current and capacitance calibration step. To do that:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT.
- 3. Set EDG2STAT.
- 4. Perform an A/D conversion.
- 5. Calculate the time between edges as  $T = (C/I) \cdot V$ , where:
  - I is calculated in the current calibration step (Section 27.4.1 "Current Source Calibration")
  - C is calculated in the capacitance calibration step (Section 27.4.2 "Capacitance Calibration")
  - V is measured by performing the A/D conversion

It is assumed that the time measured is small enough that the capacitance, *C*OFFSET, provides a valid voltage to the A/D Converter. For the smallest time measurement, always set the A/D Channel Select register (AD1CHS) to an unused A/D channel, the corresponding pin for which is not connected to any circuit board trace. This minimizes added stray capacitance, keeping the total circuit capacitance close to that of the A/D Converter itself (25 pF).

To measure longer time intervals, an external capacitor may be connected to an A/D channel and that channel selected whenever making a time measurement.

### FIGURE 27-3: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR TIME MEASUREMENT



#### 查询PIC18F86K90供应商

#### 27.7 Creating a Delay with the CTMU Module

A unique feature on board the CTMU module is its ability to generate system clock independent output pulses based on either an internal voltage or an external capacitor value. When using an external voltage, this is accomplished using the CTDIN input pin as a trigger for the pulse delay. When using an internal capacitor value, this is accomplished using the internal comparator voltage reference module and Comparator 2 input pin. The pulse is output onto the CTPLS pin. To enable this mode, set the TGEN bit.

See Figure 27-4 for an example circuit. When CTMUDS (ODCON3<0>) is cleared, the pulse delay is determined by the output of Comparator 2, and when it is set, the pulse delay is determined by the input of CTDIN. CDELAY is chosen by the user to determine the output pulse width on CTPLS. The pulse width is calculated by T = (CDELAY/I) \* V, where I is known from the current source measurement step (Section 27.4.1 "Current Source Calibration") and V is the internal reference voltage (CVREF).

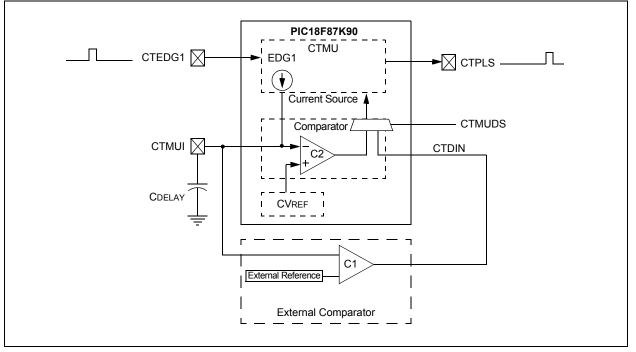
An example use of the external capacitor feature is interfacing with variable capacitive-based sensors, such as a humidity sensor. As the humidity varies, the pulse-width output on CTPLS will vary. An example use of the CTDIN feature is interfacing with a digital sensor. The CTPLS output pin can be connected to an input capture pin and the varying pulse width measured to determine the humidity in the application.

To use this feature:

- 1. If CTMUDS is cleared, initialize Comparator 2.
- 2. If CTMUDS is cleared, initialize the comparator voltage reference.
- 3. Initialize the CTMU and enable time delay generation by setting the TGEN bit.
- 4. Set EDG1STAT.

When CTMUDS is cleared, as soon as CDELAY charges to the value of the voltage reference trip point, an output pulse is generated on CTPLS. When CTMUDS is set, as soon as CTDIN is set, an output pulse is generated on CTPLS.

### FIGURE 27-4: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR PULSE DELAY GENERATION



#### 查询PIC18F86K90供应商

#### 27.8 Measuring Temperature Using the CTMU Module

The CTMU, along with an internal diode, can be used to measure the temperature. The ADC can be connected to the internal diode and the CTMU module can

source the current to the diode. The ADC reading will reflect the temperature. With the increase, the ADC readings will go low. This can be used for low-cost temperature measurement applications.

#### EXAMPLE 27-5: ROUTINE FOR TEMPERATURE MEASUREMENT USING INTERNAL DIODE

//Initialize CTMU CTMUICON=0x03; CTMUCONHbits.CTMUEN=1;	
CTMUCONLbits.EDG1STAT=1;	
//Initialize ADC ADCON0=0xE5;	//ADCON and connect to Internal diode
ADCON1=0;	
ADCON2=0xBE;	//Right justified
ADCON0bits.GO=1;	
while(ADCON0bits.GO==1);	
Temp=ADRES;	;//read ADC results ( inversely proportional to temperature)

DS39957B-page 420

#### 查询PIC18F86K90供应商 27.9 Operation During Sleep/Idle Modes

#### 27.9.1 SLEEP MODE

When the device enters any Sleep mode, the CTMU module current source is always disabled. If the CTMU is performing an operation that depends on the current source when Sleep mode is invoked, the operation may not terminate correctly. Capacitance and time measurements may return erroneous values.

#### 27.9.2 IDLE MODE

The behavior of the CTMU in Idle mode is determined by the CTMUSIDL bit (CTMUCONH<5>). If CTMUSIDL is cleared, the module will continue to operate in Idle mode. If CTMUSIDL is set, the module's current source is disabled when the device enters Idle mode. If the module is performing an operation when Idle mode is invoked, in this case, the results will be similar to those with Sleep mode.

#### 27.10 Effects of a Reset on CTMU

Upon Reset, all registers of the CTMU are cleared. This disables the CTMU module, turns off its current source and returns all configuration options to their default settings. The module needs to be re-initialized following any Reset.

If the CTMU is in the process of taking a measurement at the time of Reset, the measurement will be lost. A partial charge may exist on the circuit that was being measured, which should be properly discharged before the CTMU makes subsequent attempts to make a measurement. The circuit is discharged by setting and clearing the IDISSEN bit (CTMUCONH<1>) while the A/D Converter is connected to the appropriate channel.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	78
CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	78
CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0	78
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75

#### TABLE 27-1: REGISTERS ASSOCIATED WITH CTMU MODULE

**Legend:** — = unimplemented, read as '0'

查询PIC18F86K90供应商 NOTES:

#### 查询PIC18F86K90供应商

### 28.0 SPECIAL FEATURES OF THE CPU

The PIC18F87K90 family of devices includes several features intended to maximize reliability and minimize cost through elimination of external components. These include:

- Oscillator Selection
- Resets:
  - Power-on Reset (POR)
  - Power-up Timer (PWRT)
  - Oscillator Start-up Timer (OST)
- Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT) and On-Chip Regulator
- Fail-Safe Clock Monitor
- Two-Speed Start-up
- Code Protection
- ID Locations
- In-Circuit Serial Programming<sup>™</sup>

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 3.0 "Oscillator Configurations"**.

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, the PIC18F87K90 family of devices has a Watchdog Timer, which is either permanently enabled via the Configuration bits or software controlled (if configured as disabled).

The inclusion of an internal RC (LF-INTOSC) oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

### 28.1 Configuration Bits

The Configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped starting at program memory location, 300000h.

The user will note that address, 300000h, is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h-3FFFFh), which can only be accessed using table reads and table writes.

Software programming the Configuration registers is done in a manner similar to programming the Flash memory. The WR bit in the EECON1 register starts a self-timed write to the Configuration register. In normal operation mode, a TBLWT instruction with the TBLPTR pointing to the Configuration register sets up the address and the data for the Configuration register write. Setting the WR bit starts a long write to the Configuration register. The Configuration registers are written a byte at a time. To write or erase a configuration cell, a TBLWT instruction can write a '1' or a '0' into the cell. For additional details on Flash programming, refer to **Section 7.5 "Writing to Flash Program Memory"**.

#### 查询PIC18F86K90供应商 TABLE 28-1: CONFIGURATION BITS AND DEVICE IDs

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value
300000h	CONFIG1L	—	XINST	_	SOSCSEL1	SOSCSEL0	INTOSCSEL	_	RETEN	-1-1 11
300001h	CONFIG1H	IESO	FCMEN	_	PLLCFG	FOSC3	FOSC2	FOSC1	FOSC0	0000 1000
300002h	CONFIG2L	_	BORPWR1	BORWPR0	BORV1	BORV0	BOREN1	BOREN0	PWRTEN	-111 1111
300003h	CONFIG2H	_	WDTPS4	WDTPS3	WDTPS2	WDTPS1	WDTPS0	WDTEN1	WDTEN0	-111 1111
300004h	CONFIG3L	_	_	_	_	—	—	_	RTCOSC	1
300005h	CONFIG3H	MCLRE	_			MSSPMSK	—	ECCPMX <sup>(2)</sup>	CCP2MX	1 1-11
300006h	CONFIG4L	DEBUG	_		BBSIZ0	—	_	-	STVREN	111
300008h	CONFIG5L	CP7 <sup>(1)</sup>	CP6 <sup>(1)</sup>	CP5 <sup>(1)</sup>	CP4 <sup>(1)</sup>	CP3	CP2	CP1	CP0	1111 1111
300009h	CONFIG5H	CPD	CPB	_	_	_	_	_		11
30000Ah	CONFIG6L	WRT7 <sup>(1)</sup>	WRT6 <sup>(1)</sup>	WRT5 <sup>(1)</sup>	WRT4 <sup>(1)</sup>	WRT3	WRT2	WRT1	WRT0	1111 1111
30000Bh	CONFIG6H	WRTD	WRTB	WRTC	_	—	—	_	_	111
30000Ch	CONFIG7L	EBTR7 <sup>(1)</sup>	EBTR6 <sup>(1)</sup>	EBTR5 <sup>(1)</sup>	EBTR4 <sup>(1)</sup>	EBTR3	EBTR2	EBTR1	EBTR0	1111 1111
30000Dh	CONFIG7H	_	EBTRB	_	_	—	—	_	_	-1
3FFFFEh	DEVID1 <sup>(3)</sup>	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	XXXX XXXX
3FFFFFh	DEVID2 <sup>(3)</sup>	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	XXXX XXXX

**Legend:** x = unknown, u = unchanged, - = unimplemented, q = value depends on condition. Shaded cells are unimplemented, read as '0'.

**Note 1:** Implemented in the PIC18F67K90 and PIC18F87K90 devices.

2: Implemented in the 80-pin devices (PIC18F8XK90).

3: See Register 28-14 for DEVID1 values. DEVID registers are read-only and cannot be programmed by the user.

#### 查询PIC18F86K90供应商 REGISTER 28-1: CONFIG1L: CONFIGURATION REGISTER 1 LOW (BYTE ADDRESS 300000h)

U-0	R/P-1	U-0	R/P-1	R/P-1	R/P-1	U-0	R/P-1
—	XINST	—	SOSCSEL1	SOSCSEL0	INTOSCSEL0	_	RETEN
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	XINST: Extended Instruction Set Enable bit
	<ul> <li>1 = Instruction set extension and Indexed Addressing mode are enabled</li> <li>0 = Instruction set extension and Indexed Addressing mode are disabled (Legacy mode)</li> </ul>
bit 5	Unimplemented: Read as '0'
bit 4-3	SOSCSEL<1:0>: SOSC Power Selection and Mode Configuration bits
	<ul> <li>11 = High-power SOSC circuit is selected</li> <li>10 = Digital (SCLKI) mode: I/O port functionality of RC0 and RC1 is enabled</li> <li>01 = Low-power SOSC circuit is selected</li> <li>00 = Reserved</li> </ul>
bit 2	INTOSCSEL: LF-INTOSC Low-Power Enable bit
	<ul> <li>1 = LF-INTOSC is in High-Power mode during Sleep</li> <li>0 = LF-INTOSC is in Low-Power mode during Sleep</li> </ul>
bit 1	Unimplemented: Read as '0'
bit 0	RETEN: VREG Sleep Enable bit
	1 = Regulator power is in Sleep mode, controlled by VREGSLP (WDTCON<7>) 0 = Regulator power is in Sleep mode, controlled by SRETEN (WDTCON<4>) Ultra low-pow

= Regulator power is in Sleep mode, controlled by SRETEN (WDTCON<4>). Ultra low-power regulator is enabled.

### 查询PIC18F86K90供应商

R/P-0	R/P-0	U-0	U-0	R/P-1	R/P-0	R/P-0	R/P-0				
IESO	FCMEN	_	PLLCFG <sup>(1)</sup>	FOSC3 <sup>(2)</sup>	FOSC2 <sup>(2)</sup>	FOSC1 <sup>(2)</sup>	FOSC0 <sup>(2)</sup>				
bit 7							bit C				
Legend:		P = Program	mable bit								
R = Readab	le bit	W = Writable	e bit	U = Unimpler	mented bit, read	l as '0'					
-n = Value a	t POR	'1' = Bit is se	t	'0' = Bit is cle	ared	x = Bit is unkr	nown				
L:1 7			- Watan Owitalaa								
bit 7			cillator Switchov	ver bit							
		ed Start-up is ed Start-up is									
bit 6	•		onitor Enable b	it							
		Clock Monitor									
		Clock Monito									
bit 5	Unimplemen	ted: Read as	<b>'</b> 0'								
bit 4	PLLCFG: 4x	PLL Enable b	it(1)								
		is multiplied t									
		is used direct	5								
bit 3-0	FOSC<3:0>:										
	1101 = EC1, EC oscillator (low power, DC-160 kHz)										
	1100 = EC1IO, EC oscillator with CLKOUT function on RA6 (low power, DC-160 kHz)										
	1011 = EC2, EC oscillator (medium power, 160 kHz-4 MHz) 1010 = EC2IO, EC oscillator with CLKOUT function on RA6 (medium power, DC-160 kHz)										
	0101 = EC3, EC oscillator (high power, 4 MHz-64 MHz)										
	0100 = EC3IO, EC oscillator with CLKOUT function on RA6 (high power, 4 MHz-64 MHz)										
		0011 = HS1, HS oscillator (medium power, 4 MHz-16 MHz)									
		0010 = HS2, HS oscillator (high power, 16 MHz-25 MHz) 0001 = XT oscillator									
	0000 = LP o										
	0111 = RC,	External RC o	scillator								
			coscillator with	CKLOUT fund	tion on RA6						
		02, Internal R									
	1001 = INIIC	Ji, internal R	C oscillator with		CUON ON RAG						
Note 1: N	lot valid for the IN	ITIOx PLL mo	de.								

- Not valid for the INTIOx PLL mode. Note 1:
  - 2: INTIO+PLL can only be enabled by the PLLEN bit (OSCTUNE<6>). Other PLL modes can be enabled by either the PLLEN bit or the PLLCFG (CONFIG1H<4>) bit.

#### 查询PIC18F86K90供应商 REGISTER 28-3: CONFIG2L: CONFIGURATION REGISTER 2 LOW (BYTE ADDRESS 300002h)

U-0	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
	BORPWR1 <sup>(1)</sup>	BORPWR0 <sup>(1)</sup>	BORV1 <sup>(1)</sup>	BORV0 <sup>(1)</sup>	BOREN1 <sup>(2)</sup>	BOREN0 <sup>(2)</sup>	PWRTEN <sup>(2)</sup>
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 7 Unimplemented: Read as '0'
- bit 6-5 **BORPWR<1:0>:** BORMV Power Level bits<sup>(1)</sup>
  - 11 = ZPBORVMV instead of BORMV is selected
  - 10 = BORMV is set to high-power level
  - 01 = BORMV is set to medium-power level
  - 00 = BORMV is set to low-power level
- bit 4-3 BORV<1:0>: Brown-out Reset Voltage bits<sup>(1)</sup>
  - 11 = VBORMV is set to 1.8V
  - 10 = VBORMV is set to 2.0V
  - 01 = VBORMV is set to 2.7V
  - 00 = VBORMV is set to 3.0V

#### bit 2-1 BOREN<1:0>: Brown-out Reset Enable bits<sup>(2)</sup>

- 11 = Brown-out Reset is enabled in hardware only (SBOREN is disabled)
- 10 = Brown-out Reset is enabled in hardware only and disabled in Sleep mode (SBOREN is disabled)
- 01 = Brown-out Reset is enabled and controlled by software (SBOREN is enabled)
- 00 = Brown-out Reset is disabled in hardware and software

#### bit 0 **PWRTEN:** Power-up Timer Enable bit<sup>(2)</sup>

- 1 = PWRT is disabled
- 0 = PWRT is enabled
- Note 1: For the specifications, see Section 31.1 "DC Characteristics: Supply Voltage PIC18F87K90 Family (Industrial)".
  - **2:** The Power-up Timer is decoupled from Brown-out Reset, allowing these features to be independently controlled.

### 查询PIC18F86K90供应商

### REGISTER 28-4: CONFIG2H: CONFIGURATION REGISTER 2 HIGH (BYTE ADDRESS 300003h)

U-0	R/P-1						
—	WDTPS4	WDTPS3	WDTPS2	WDTPS1	WDTPS0	WDTEN1	WDTEN0
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'

bit 6-2	WDTPS<4:0>: Watchdog Timer Postscale Select bits
	11111 <b>= 1:1,048,576</b>
	10011 <b>= 1:524,288</b>
	10010 <b>= 1:262,144</b>
	10001 <b>= 1:131,072</b>
	10000 <b>= 1:65,536</b>
	01111 <b>= 1:32,768</b>
	01110 <b>= 1:16,384</b>
	01101 <b>= 1:8,192</b>
	01100 <b>= 1:4,096</b>
	01011 <b>= 1:2,048</b>
	01010 = 1:1,024
	01001 <b>= 1:512</b>
	01000 <b>= 1:256</b>
	00111 <b>= 1:128</b>
	00110 <b>= 1</b> :64
	00101 = 1:32
	00100 = 1:16
	00011 = 1:8
	00010 = 1:4
	00001 <b>= 1</b> :2
	00000 = 1:1
bit 1-0	WDTEN<1:0>: Watchdog Timer Enable bits
	11 = WDT is enabled in hardware; SWDTEN bit is disabled
	10 = WDT is controlled by the SWDTEN bit setting
	01 = WDT is enabled only while device is active and is disabled in Sk

01 = WDT is enabled only while device is active and is disabled in Sleep mode; SWDTEN bit is disabled

00 = WDT is disabled in hardware; SWDTEN bit is disabled

### 查询PIC18F86K90供应商

bit 0

REGISTER 28-5: CONFIG3L: CONFIGURATION REGISTER 3 LOW (BYTE ADDRESS 300004h)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/P-1
—	—	—	—	—	—	—	RTCOSC
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 Unimplemented: Read as '0'

RTCOSC: RTCC Reference Clock Select bit

1 = RTCC uses SOSC as a reference clock

0 = RTCC uses LF-INTOSC as a reference clock

#### REGISTER 28-6: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)

R/P-1	U-0	U-0	U-0	R/P-1	U-0	R/P-1	R/P-1
MCLRE	—	—	_	MSSPMSK	—	ECCPMX <sup>(1)</sup>	CCP2MX
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	MCLRE: MCLR Pin Enable bit
	1 = MCLR pin is enabled; RG5 input pin is disabled
	0 = RG5 input pin is enabled; MCLR is disabled
bit 6-4	Unimplemented: Read as '0'
bit 3	MSSPMSK: MSSP V3 7-Bit Address Masking Mode Enable bit
	1 = 7-Bit Address Masking mode is enabled
	0 = 5-Bit Address Masking mode is enabled
bit 2	Unimplemented: Read as '0'
bit 1	ECCPMX: ECCP MUX bit <sup>(1)</sup>
	1 = Enhanced ECCP1 (P1B/P1C) is multiplexed onto RE6 and RE5, CCP6 onto RE6, and CCP7 onto RE5
	Enhanced ECCP3 (P3B/P3C) is multiplexed onto RE4 and RE3, CCP6 onto RE4, and CCP7 onto RE3
	0 = Enhanced ECCP1 (P1B/P1C) is multiplexed onto RH7 and RH6, CCP8 onto RH7, and CCP9 onto RH6
	Enhanced ECCP3 (P3B/P3C) is multiplexed onto RH5 and RH4, CCP8 onto RH5, and CCP9 onto RH4
bit 0	CCP2MX: ECCP2 MUX bit
	1 = ECCP2 is multiplexed with RC1
	0 = ECCP2 input/output is multiplexed with RE7 <sup>(1)</sup>

#### Note 1: This feature is only available on 80-pin devices.

查询PIC18F86K90供应商 REGISTER 28-7: CONFIG4L: CONFIGURATION REGISTER 4 LOW (BYTE ADDRESS 300006h)

R/P-1	U-0	U-0	R/P-0	U-0	R/P-0	U-0	R/P-1
DEBUG	_	_	BBSIZ0	-	—	_	STVREN
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

DEBUG: Background Debugger Enable bit
<ul> <li>1 = Background debugger is disabled, RB6 and RB7 are configured as general purpose I/O pins</li> <li>0 = Background debugger is enabled, RB6 and RB7 are dedicated to In-Circuit Debug</li> </ul>
Unimplemented: Read as '0'
BBSIZ<0>: Boot Block Size Select bit
1 = 2 kW boot block size
0 = 1 kW boot block size
Unimplemented: Read as '0'
STVREN: Stack Full/Underflow Reset Enable bit
<ol> <li>1 = Stack full/underflow will cause a Reset</li> <li>0 = Stack full/underflow will not cause a Reset</li> </ol>

#### 查询PIC18F86K90供应商 REGISTER 28-8: CONFIG5L: CONFIGURATION REGISTER 5 LOW (BYTE ADDRESS 300008h)<sup>(2)</sup>

R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1
CP7 <sup>(1)</sup>	CP6 <sup>(1)</sup>	CP5 <sup>(1)</sup>	CP4 <sup>(1)</sup>	CP3	CP2	CP1	CP0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	<b>CP7:</b> Code Protection bit <sup>(1)</sup>
	<ul> <li>1 = Block 7 is not code-protected</li> <li>0 = Block 7 is code-protected</li> </ul>
bit 6	CP6: Code Protection bit <sup>(1)</sup>
	<ul><li>1 = Block 6 is not code-protected</li><li>0 = Block 6 is code-protected</li></ul>
bit 5	CP5: Code Protection bit <sup>(1)</sup>
	<ul><li>1 = Block 5 is not code-protected</li><li>0 = Block 5 is code-protected</li></ul>
bit 4	CP4: Code Protection bit <sup>(1)</sup>
	<ul><li>1 = Block 4 is not code-protected</li><li>0 = Block 4 is code-protected</li></ul>
bit 3	CP3: Code Protection bit
	<ul><li>1 = Block 3 is not code-protected</li><li>0 = Block 3 is code-protected</li></ul>
bit 2	CP2: Code Protection bit
	<ul><li>1 = Block 2 is not code-protected</li><li>0 = Block 2 is code-protected</li></ul>
bit 1	CP1: Code Protection bit
	<ul><li>1 = Block 1 is not code-protected</li><li>0 = Block 1 is code-protected</li></ul>
bit 0	CP0: Code Protection bit
	<ul><li>1 = Block 0 is not code-protected</li><li>0 = Block 0 is code-protected</li></ul>
Note 1:	This bit is only available on PIC18F67K90 and PIC18F87K90.

2: For the memory size of the blocks, refer to Figure 28-6.

#### 查询PIC18F86K90供应商

REGISTER 28-9: CONFIG5H: CONFIGURATION REGISTER 5 HIGH (BYTE ADDRESS 300009h)<sup>(1)</sup>

R/C-1	R/C-1	U-0	U-0	U-0	U-0	U-0	U-0	
CPD	CPB	—	_	—	—	_	_	
bit 7		·					bit C	
Legend: C = Clearable bit		bit						
R = Readable bit W		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unknown		
bit 7	CPD: Data E	EPROM Code	Protection bit					
<ul><li>1 = Data EEPROM is not code-protected</li><li>0 = Data EEPROM is code-protected</li></ul>								
bit 6	it 6 <b>CPB:</b> Boot Block Code Protection bit							

1 = Boot block is not code-protected 0 = Boot block is code-protected

bit 5-0 Unimplemented: Read as '0'

**Note 1:** For the memory size of the blocks, refer to Figure 28-6.

#### 查询PIC18F86K90供应商 REGISTER 28-10: CONFIGEL: CONFIGURATION REGISTER 6 LOW (BYTE ADDRESS 30000Ah)<sup>(2)</sup>

R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1
WRT7 <sup>(1)</sup>	WRT6 <sup>(1)</sup>	WRT5 <sup>(1)</sup>	WRT4 <sup>(1)</sup>	WRT3	WRT2	WRT1	WRT0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Reada	ble bit W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value	at POR '1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	WRT7: Write Protection bit <sup>(1)</sup>		
	<ul><li>1 = Block 7 is not write-protected</li><li>0 = Block 7 is write-protected</li></ul>		
bit 6	WRT6: Write Protection bit <sup>(1)</sup> 1 = Block 6 is not write-protected 0 = Block 6 is write-protected		
bit 5	WRT5: Write Protection bit <sup>(1)</sup> 1 = Block 5 is not write-protected 0 = Block 5 is write-protected		
bit 4	WRT4: Write Protection bit <sup>(1)</sup> 1 = Block 4 is not write-protected 0 = Block 4 is write-protected		
bit 3	WRT3: Write Protection bit 1 = Block 3 is not write-protected 0 = Block 3 is write-protected		
bit 2	WRT2: Write Protection bit 1 = Block 2 is not write-protected 0 = Block 2 is write-protected		
bit 1	WRT1: Write Protection bit 1 = Block 1 is not write-protected 0 = Block 1 is write-protected		
bit 0	WRT0: Write Protection bit 1 = Block 0 is not write-protected 0 = Block 0 is write-protected		

**Note 1:** This bit is only available on PIC18F67K90 and PIC18F87K90.

2: For the memory size of the blocks, refer to Figure 28-6.

### 查询PIC18F86K90供应商

REGISTER 28-11: CONFIG6H: CONFIGURATION REGISTER 6 HIGH (BYTE ADDRESS 30000Bh)<sup>(2)</sup>

R/C-1	R/C-1	R-1	U-0	U-0	U-0	U-0	U-0	
WRTD	WRTB	WRTC <sup>(1)</sup>	—	—	—	—	—	
bit 7					•		bit 0	
Legend:		C = Clearable	bit					
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'				
	~ -							

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unkn	nown
---	------

bit 7	WRTD: Data EEPROM Write Protection bit
	<ul><li>1 = Data EEPROM is not write-protected</li><li>0 = Data EEPROM is write-protected</li></ul>
bit 6	WRTB: Boot Block Write Protection bit
	1 = Boot block is not write-protected
	0 = Boot block is write-protected
bit 5	WRTC: Configuration Register Write Protection bit <sup>(1)</sup>
	<ul> <li>1 = Configuration registers are not write-protected</li> <li>0 = Configuration registers are write-protected</li> </ul>
bit 4-0	Unimplemented: Read as '0'

Note 1: This bit is read-only in normal execution mode; it can be written only in Program mode.

2: For the memory size of the blocks, refer to Figure 28-6.

### 查询PIC18F86K90供应商

**REGISTER 28-12:** CONFIG7L: CONFIGURATION REGISTER 7 LOW (BYTE ADDRESS 30000Ch)<sup>(3)</sup>

R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1
EBTR7 <sup>(1)</sup>	EBTR6 <sup>(1)</sup>	EBTR5 <sup>(1)</sup>	EBTR4 <sup>(1)</sup>	EBTR3	EBTR2	EBTR1	EBTR0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	EBTR7: Table Read Protection bit <sup>(1)</sup>
	<ul> <li>1 = Block 7 is not protected from table reads executed in other blocks</li> <li>0 = Block 7 is protected from table reads executed in other blocks</li> </ul>
bit 6	EBTR6: Table Read Protection bit <sup>(1)</sup>
	<ul> <li>1 = Block 6 is not protected from table reads executed in other blocks</li> <li>0 = Block 6 is protected from table reads executed in other blocks</li> </ul>
bit 5	EBTR5: Table Read Protection bit <sup>(1)</sup>
	<ul> <li>1 = Block 5 is not protected from table reads executed in other blocks</li> <li>0 = Block 5 is protected from table reads executed in other blocks</li> </ul>
bit 4	EBTR4: Table Read Protection bit <sup>(1)</sup>
	<ul><li>1 = Block 4 is not protected from table reads executed in other blocks</li><li>0 = Block 4 is protected from table reads executed in other blocks</li></ul>
bit 3	EBTR3: Table Read Protection bit
	<ul> <li>1 = Block 3 is not protected from table reads executed in other blocks</li> <li>0 = Block 3 is protected from table reads executed in other blocks</li> </ul>
bit 2	EBTR2: Table Read Protection bit
	<ul> <li>1 = Block 2 is not protected from table reads executed in other blocks</li> <li>0 = Block 2 is protected from table reads executed in other blocks</li> </ul>
bit 1	EBTR1: Table Read Protection bit
	<ul> <li>1 = Block 1 is not protected from table reads executed in other blocks</li> <li>0 = Block 1 is protected from table reads executed in other blocks</li> </ul>
bit 0	EBTR0: Table Read Protection bit
	<ul> <li>1 = Block 0 is not protected from table reads executed in other blocks</li> <li>0 = Block 0 is protected from table reads executed in other blocks</li> </ul>
Note 1:	This bit is only available on PIC18F67K90 and PIC18F87K90.
2:	This bit is only available on PIC18F66K90, PIC18F67K90, PIC18F86K90 and PIC

- 2: This bit is only available on PIC18F66K90, PIC18F67K90, PIC18F86K90 and PIC18F87K90.
  - 3: For the memory size of the blocks, refer to Figure 28-6.

### 查询PIC18F86K90供应商

REGISTER 28-13: CONFIG7H: CONFIGURATION REGISTER 7 HIGH (BYTE ADDRESS 30000Dh)<sup>(1)</sup>

U-0	R/C-1	U-0	U-0	U-0	U-0	U-0	U-0
—	EBTRB	—	—	—	—	—	—
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6 <b>EBTRB:</b> Boot Block Table Read Protection bit	
--	--

1 = Boot block is not protected from table reads executed in other blocks

0 = Boot block is protected from table reads executed in other blocks

bit 5-0 Unimplemented: Read as '0'

**Note 1:** For the memory size of the blocks, refer to Figure 28-6.

### 查询PIC18F86K90供应商

REGISTER 28-14: DEVID1: DEVICE ID REGISTER 1 FOR THE PIC18F87K90 FAMILY

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	DEV<2:0>: Device ID bits
	Devices with DEV<10:3> of 0101 0010 (see DEVID2):
	010 = PIC18F65K90
	000 = PIC18F66K90
	101 = PIC18F85K90
	011 = PIC18F86K90
	Devices with DEV<10:3> of 0101 0001:
	000 = PIC18F67K90
	010 = PIC18F87K90
bit 4-0	REV<4:0>: Revision ID bits
	These bits are used to indicate the device revision.

'1' = Bit is set

#### REGISTER 28-15: DEVID2: DEVICE ID REGISTER 2 FOR THE PIC18F87K90 FAMILY

R	R	R	R	R	R	R	R	
DEV10 <sup>(1)</sup>	DEV9 <sup>(1)</sup>	DEV8 <sup>(1)</sup>	DEV7 <sup>(1)</sup>	DEV6 <sup>(1)</sup>	DEV5 <sup>(1)</sup>	DEV4 <sup>(1)</sup>	DEV3 <sup>(1)</sup>	
bit 7							bit 0	
Legend:								
R = Readable b	oit	W = Writable	bit	U = Unimplemented bit, read as '0'				

'0' = Bit is cleared

bit 7-0 **DEV<10:3>:** Device ID bits<sup>(1)</sup> These bits are used with the DEV<2:0> bits in the Device ID Register 1 to identify the part number. 0101 0010 = PIC18F65K90, PIC18F66K90, PIC18F85K90 and PIC18F86K90 0101 0001 = PIC18F67K90 and PIC18F87K90

**Note 1:** These values for DEV<10:3> may be shared with other devices. The specific device is always identified by using the entire DEV<10:0> bit sequence.

-n = Value at POR

x = Bit is unknown

#### 查询PIC18F86K90供应商 28.2 Watchdog Timer (WDT)

For the PIC18F87K90 family of devices, the WDT is driven by the LF-INTOSC source. When the WDT is enabled, the clock source is also enabled. The nominal WDT period is 4 ms and has the same stability as the LF-INTOSC oscillator.

The 4 ms period of the WDT is multiplied by a 16-bit postscaler. Any output of the WDT postscaler is selected by a multiplexer, controlled by bits in Configuration Register 2H. Available periods range from 4 ms to 4,194 seconds (about one hour). The WDT and postscaler are cleared when any of the following events occur: a SLEEP or CLRWDT instruction is executed, the IRCF bits (OSCCON<6:4>) are changed or a clock failure has occurred.

The WDT can be operated in one of four modes as determined by CONFIG2H (WDTEN<1:0>) The four modes are:

- WDT Enabled
- WDT Disabled
- WDT under software control (WDTCON<0>, SWDTEN)
- WDT
  - Enabled during normal operation
  - Disabled during Sleep

Note 1: The CLRWDT and SLEEP instructions clear the WDT and postscaler counts when executed.

- Changing the setting of the IRCF bits (OSCCON<6:4>) clears the WDT and postscaler counts.
- **3:** When a CLRWDT instruction is executed, the postscaler count will be cleared.

#### WDT Enabled, SWDTEN Disabled WDT Controlled with SWDTEN bit Setting WDT Enabled only While Device Active, Disabled WDT Disabled in Hardware, SWDTEN Disabled Enable WDT WDTEN1-WDTEN0 WDT Counter Wake-up from ÷128 INTRC Source Power-Managed Modes Change on IRCF<2:0> bits -WDT Programmable Postscaler Reset CLRWDT Reset 1:1 to 1:1,048,576 All Device Resets 4 WDTPS<3:0> Sleep Enable WDT SWDTEN WDTEN<1:0> **INTRC Source**

### FIGURE 28-1: WDT BLOCK DIAGRAM

#### 查询PIC18F86K90供应商 28.2.1 CONTROL REGISTER

Register 28-16 shows the WDTCON register. This is a readable and writable register which contains a control bit that allows software to override the WDT Enable Configuration bit, but only if the Configuration bit has disabled the WDT.

#### REGISTER 28-16: WDTCON: WATCHDOG TIMER CONTROL REGISTER

R/W-0	U-0	R-x	R/W-0	U-0	R/W-0	R/W-0	R/W-0
REGSLP	—	ULPLVL <sup>(3)</sup>	SRETEN <sup>(2)</sup>		ULPEN	ULPSINK <sup>(3)</sup>	SWDTEN <sup>(1)</sup>
bit 7						•	bit 0

Legend:								
R = Readable bit		W = Writable bit	U = Unimplemented bit,	U = Unimplemented bit, read as '0'				
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown				
bit 7	REGSLP	Regulator Voltage Sleep E	Enable bit					
			mode when device's Sleep mo when device's Sleep mode is a					
bit 6	Unimple	mented: Read as '0'						
bit 5	ULPLVL:	Ultra Low-Power Wake-up	Output bit <sup>(3)</sup>					
		ge on RA0 > ~0.5V ge on RA0 < ~0.5V						
bit 4	SRETEN	Regulator Voltage Sleep [	Disable bit <sup>(2)</sup>					
		TEN (CONFIG1L<0>) = 0 a e in Sleep	nd the regulator is enabled, the	e device goes into Ultra Low-Powe				
	0 = The I	•	's Sleep mode is enabled and	the Low-Power mode is controlle				
bit 3	Unimple	mented: Read as '0'						
bit 2	ULPEN:	JItra Low-Power Wake-up I	Module Enable bit					
		low-power wake-up modul low-power wake-up modul	e is enabled; ULPLVL bit indica e is disabled	ates comparator output				
bit 1	ULPSINK	: Ultra Low-Power Wake-u	p Current Sink Enable bit <sup>(3)</sup>					
		low-power wake-up curren low power wake-up curren						
bit 0	SWDTEN	: Software Controlled Wate	hdog Timer Enable bit <sup>(1)</sup>					
	1 = Watcl	ndog Timer is on	-					
	0 = Watcl	ndog Timer is off						

Note 1: This bit has no effect if the Configuration bits, WDTEN<1:0>, are enabled.

**2:** This bit is available only when ENVREG = 1 and  $\overline{\text{RETEN}}$  = 0.

**3:** Not valid unless ULPEN = 1.

TABLE 28-2:	SUMMARY OF WATCHDOG TIMER REGISTERS
-------------	-------------------------------------

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
WDTCON	REGSLP	—	ULPLVL	SRETEN	_	ULPEN	ULPSINK	SWDTEN	74

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Watchdog Timer.

### 查询PIC18F86K90供应商

### 28.3 On-Chip Voltage Regulator

All of the PIC18F87K90 family devices power their core digital logic at a nominal 3.3V. For designs that are required to operate at a higher typical voltage, such as 5V, all family devices incorporate two on-chip regulators that allows the device to run its core logic from VDD. Those regulators are:

- Normal On-Chip Regulator
- Ultra Low-Power, On-Chip Regulator

The hardware configuration of these regulators are the same and are explained in **Section 28.3.1**. The regulators' only differences relate to when the device enters Sleep, as explained in **Section 28.3.2**.

#### 28.3.1 REGULATOR ENABLE/DISABLE BY HARDWARE

The regulator can be enabled or disabled only by hardware. The regulator is controlled by the ENVREG pin and the VDDCORE/VCAP pin.

### 28.3.1.1 Regulator Enable Mode

Tying VDD to the pin enables the regulator, which in turn, provides power to the core from the other VDD pins.

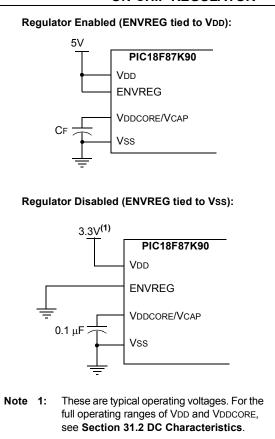
When the regulator is enabled, a low-ESR filter capacitor must be connected to the VDDCORE/VCAP pin (see Figure 28-2). This helps maintain the regulator's stability. The recommended value for the filter capacitor is given in **Section 31.2 DC Characteristics**.

### 28.3.1.2 Regulator Disable Mode

If ENVREG is tied to Vss, the regulator is disabled. In this case, a 0.1  $\mu\text{F}$  capacitor should be connected to the VDDCORE/VCAP pin (see Figure 28-2).

When the regulator is being used, the overall voltage budget is very tight. The regulator should operate the device down to 1.8V. When VDD drops below 3.3V, the regulator no longer regulates, but the output voltage follows the input until VDD reaches 1.8V. Below this voltage, the output of the regulator output may drop to 0V.

## FIGURE 28-2: CONNECTIONS FOR THE ON-CHIP REGULATOR



### 查询PIC18F86K90供应商

#### 28.3.2 OPERATION OF REGULATOR IN SLEEP

The difference in the two regulators' operation arises with Sleep mode. The ultra low-power regulator gives the device the lowest current in the Regulator Enabled mode.

The on-chip regulator can go into a lower power mode when the device goes to Sleep by setting the REGSLP bit (WDTCON<7>). This puts the regulator in a standby mode so that the device consumes much less current.

The on-chip regulator can also go into the Ultra Low-Power mode, which consumes the lowest current possible with the regulator enabled. This mode is controlled by the RETEN bit (CONFIG1L<0>) and SRETEN bit (WDTCON<4>). The various modes of regulator operation are shown in Table 28-3.

When the ultra low-power regulator is in Sleep mode, the internal reference voltages in the chip will be shut off and any interrupts referring to the internal reference will not wake up the device. If the BOR or LVD is enabled, the regulator will keep the internal references on and the lowest possible current will not be achieved.

When using the ultra low-power regulator in Sleep mode, the device will take about 250  $\mu$ s, typical, to start executing the code after it wakes up.

Regulator	Power Mode	VREGSLP WDTCON<7>	SRETEN WDTCON<4>	RETEN CONFIG1L<0>
Enabled	Normal Operation (Sleep)	0	х	1
Enabled	Low-Power mode (Sleep)	1	x	1
Enabled	Normal Operation (Sleep)	0	0	х
Enabled	Low-Power mode (Sleep)	1	0	x
Enabled	Ultra Low-Power mode (Sleep)	x	1	0

### TABLE 28-3: SLEEP MODE REGULATOR SETTINGS<sup>(1)</sup>

**Note 1:** x = Indicates that VIT status is invalid.

#### 查询PIC18F86K90供应商 28.4 Two-Speed Start-up

The Two-Speed Start-up feature helps to minimize the latency period from oscillator start-up to code execution by allowing the microcontroller to use the INTOSC (LF-INTOSC, MF-INTOSC, HF-INTOSC) oscillator as a clock source until the primary clock source is available. It is enabled by setting the IESO Configuration bit.

Two-Speed Start-up should be enabled only if the primary oscillator mode is LP, XT or HS (Crystal-Based modes). Other sources do not require an OST start-up delay; for these, Two-Speed Start-up should be disabled.

When enabled, Resets and wake-ups from Sleep mode cause the device to configure itself to run from the internal oscillator block as the clock source, following the time-out of the Power-up Timer after a Power-on Reset is enabled. This allows almost immediate code execution while the primary oscillator starts and the OST is running. Once the OST times out, the device automatically switches to PRI\_RUN mode.

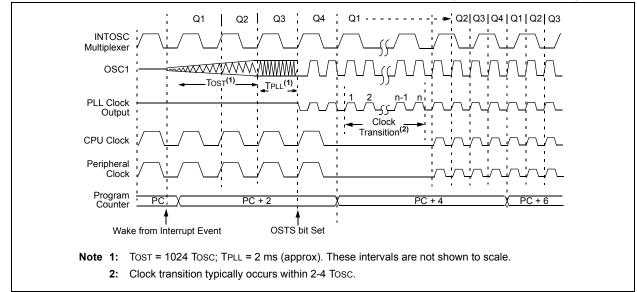
To use a higher clock speed on wake-up, the INTOSC or postscaler clock sources can be selected to provide a higher clock speed by setting bits, IRCF<2:0>, immediately after Reset. For wake-ups from Sleep, the INTOSC or postscaler clock sources can be selected by setting the IRCF2:0> bits prior to entering Sleep mode.

In all other power-managed modes, Two-Speed Startup is not used. The device will be clocked by the currently selected clock source until the primary clock source becomes available. The setting of the IESO bit is ignored.

#### 28.4.1 SPECIAL CONSIDERATIONS FOR USING TWO-SPEED START-UP

While using the INTOSC oscillator in Two-Speed Startup, the device still obeys the normal command sequences for entering power-managed modes, including multiple SLEEP instructions (refer to **Section 4.1.4 "Multiple Sleep Commands"**). In practice, this means that user code can change the SCS<1:0> bit settings or issue SLEEP instructions before the OST times out. This would allow an application to briefly wake-up, perform routine "housekeeping" tasks and return to Sleep before the device starts to operate from the primary oscillator.

User code can also check if the primary clock source is currently providing the device clocking by checking the status of the OSTS bit (OSCCON<3>). If the bit is set, the primary oscillator is providing the clock. Otherwise, the internal oscillator block is providing the clock during wake-up from Reset or Sleep mode.

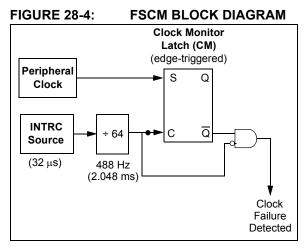


#### FIGURE 28-3: TIMING TRANSITION FOR TWO-SPEED START-UP (INTOSC TO HSPLL)

#### 查询PIC18F86K90供应商 28.5 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator block. The FSCM function is enabled by setting the FCMEN Configuration bit.

When FSCM is enabled, the LF-INTOSC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 28-4) is accomplished by creating a sample clock signal, which is the output from the LF-INTOSC divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor (CM) latch. The CM is set on the falling edge of the device clock source, but cleared on the rising edge of the sample clock.



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 28-5). This causes the following:

- The FSCM generates an oscillator fail interrupt by setting bit, OSCFIF (PIR2<7>)
- The device clock source switches to the internal oscillator block (OSCCON is not updated to show the current clock source – this is the fail-safe condition)
- The WDT is reset

During switchover, the postscaler frequency from the internal oscillator block may not be sufficiently stable for timing-sensitive applications. In these cases, it may be desirable to select another clock configuration and enter an alternate power-managed mode. This can be done to attempt a partial recovery or execute a controlled shutdown. See Section 4.1.4 "Multiple Sleep Commands" and Section 28.4.1 "Special Considerations for Using Two-Speed Start-up" for more details.

To use a higher clock speed on wake-up, the INTOSC or postscaler clock sources can be selected to provide a higher clock speed by setting bits, IRCF<2:0>, immediately after Reset. For wake-ups from Sleep, the INTOSC or postscaler clock sources can be selected by setting the IRCF<2:0> bits prior to entering Sleep mode.

The FSCM will detect only failures of the primary or secondary clock sources. If the internal oscillator block fails, no failure would be detected nor would any action be possible.

### 28.5.1 FSCM AND THE WATCHDOG TIMER

Both the FSCM and the WDT are clocked by the INTOSC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTOSC oscillator when the FSCM is enabled.

As already noted, the clock source is switched to the INTOSC clock when a clock failure is detected. Depending on the frequency selected by the IRCF<2:0> bits, this may mean a substantial change in the speed of code execution. If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, Fail-Safe Clock events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed, and decreasing the likelihood of an erroneous time-out.

### 28.5.2 EXITING FAIL-SAFE OPERATION

The Fail-Safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 1H (with any required start-up delays that are required for the oscillator mode, such as the OST or PLL timer). The INTOSC multiplexer provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTOSC multiplexer. The OSCCON register will remain in its Reset state until a power-managed mode is entered.

#### 查询PIC18F86K90供应商 **FIGURE 28-5: FSCM TIMING DIAGRAM** Sample Clock Oscillator Device Failure Clock Output CM Output $(\overline{Q})$ Failure -Detected OSCFIF CM Test CM Test CM Test The device clock is normally at a much higher frequency than the sample clock. The relative frequencies in this Note: example have been chosen for clarity.

#### 28.5.3 FSCM INTERRUPTS IN POWER-MANAGED MODES

By entering a power-managed mode, the clock multiplexer selects the clock source selected by the OSCCON register. Fail-Safe Monitoring of the powermanaged clock source resumes in the power-managed mode.

If an oscillator failure occurs during power-managed operation, the subsequent events depend on whether or not the oscillator failure interrupt is enabled. If enabled (OSCFIF = 1), code execution will be clocked by the INTOSC multiplexer. An automatic transition back to the failed clock source will not occur.

If the interrupt is disabled, subsequent interrupts while in Idle mode will cause the CPU to begin executing instructions while being clocked by the INTOSC source.

#### 28.5.4 POR OR WAKE FROM SLEEP

The FSCM is designed to detect oscillator failure at any point after the device has exited Power-on Reset (POR) or low-power Sleep mode. When the primary device clock is EC, RC or INTRC modes, monitoring can begin immediately following these events. For oscillator modes involving a crystal or resonator (HS, HSPLL, LP or XT), the situation is somewhat different. Since the oscillator may require a start-up time considerably longer than the FCSM sample clock time, a false clock failure may be detected. To prevent this, the internal oscillator block is automatically configured as the device clock and functions until the primary clock is stable (when the OST and PLL timers have timed out).

This is identical to Two-Speed Start-up mode. Once the primary clock is stable, the INTOSC returns to its role as the FSCM source.

Note: The same logic that prevents false oscillator failure interrupts on POR, or wake from Sleep, also prevents the detection of the oscillator's failure to start at all following these events. This can be avoided by monitoring the OSTS bit and using a timing routine to determine if the oscillator is taking too long to start. Even so, no oscillator failure interrupt will be flagged.

As noted in **Section 28.4.1 "Special Considerations for Using Two-Speed Start-up"**, it is also possible to select another clock configuration and enter an alternate power-managed mode while waiting for the primary clock to become stable. When the new powermanaged mode is selected, the primary clock is disabled.

#### 查询PIC18F86K90供应商

### 28.6 Program Verification and Code Protection

The user program memory is divided into four blocks for the PIC18FX5K90 device and PIC18FX6K90 devices, and eight blocks for PIC18FX7K90 devices. One of these is a boot block of 1 or 2 Kbytes. The remainder of the memory is divided into blocks on binary boundaries. Each of the blocks has three code protection bits associated with them. They are:

- Code-Protect bit (CPn)
- Write-Protect bit (WRTn)
- External Block Table Read bit (EBTRn)

Figure 28-6 shows the program memory organization for 48, 64, 96 and 128-Kbyte devices and the specific code protection bit associated with each block. The actual locations of the bits are summarized in Table 28-4.

### FIGURE 28-6: CODE-PROTECTED PROGRAM MEMORY FOR THE PIC18F87K90 FAMILY

	\		PIC18	=X7K90	PIC18F	PIC18FX6K90		PIC18FX5K90	
		$\land$	BBSIZ = 1	BBSIZ = 0	BBSIZ = 1	BBSIZ = 0	BBSIZ = 1	BBSIZ = 0	Address
	Unimplemented		Boot Block	Boot Block	Boot Block	Boot Block	Boot Block	Boot Block	0000h
	Read as '0'		2 kW Block 0	Block 0 7 kW	2 kW Block 0 6 kW	Block 0 7 kW	2 kW Block 0 2 kW	Block 0 3 kW	0800h 1000h 17FFh
			6 kW	7 KVV			Block 1 4 kW	Block 1 4 kW	1800 3FFF
			Block 1	Block 1	Block 1 8 kW	Block 1 8 kW	Block 2 4 kW		4000h 5FFFh
200000h			8 kW	8 kW			Block 3 4 kW		6000h 7FFF
			Block 2 8 kW	Block 2 8 kW	Block 2 8 kW	Block 2 8 kW			8000h BFFFh
			Block 3 8 kW	Block 3 8 kW	Block 3 8 kW	Block 3 8 kW			C000h FFFFh
	Configuration and ID Space		Block 4 8 kW	Block 4 8 kW					10000h 13FFFh
	Cpull		Block 5 8 kW	Block 5 8 kW					14000h 17FFFh
			Block 6 8 kW	Block 6 8 kW					18000h 1BFFFh
			Block 7 8 kW	Block 7 8 kW					1C000h 1FFFFh
BFFFFFh									

### 查询PIC18F86K90供应商

### TABLE 28-4: SUMMARY OF CODE PROTECTION REGISTERS

			-						_
File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
300008h	CONFIG5L	CP7 <sup>(1)</sup>	CP6 <sup>(1)</sup>	CP5 <sup>(1)</sup>	CP4 <sup>(1)</sup>	CP3	CP2	CP1	CP0
300009h	CONFIG5H	CPD	CPB		—		_		_
30000Ah	CONFIG6L	WRT7 <sup>(1)</sup>	WRT6 <sup>(1)</sup>	WRT5 <sup>(1)</sup>	WRT4 <sup>(1)</sup>	WRT3	WRT2	WRT1	WRT0
30000Bh	CONFIG6H	WRTD	WRTB	WRTC	_				_
30000Ch	CONFIG7L	EBRT7 <sup>(1)</sup>	EBRT6 <sup>(1)</sup>	EBTR5 <sup>(1)</sup>	EBTR4 <sup>(1)</sup>	EBTR3	EBTR2	EBTR1	EBTR0
30000Dh	CONFIG7H	_	EBTRB			_			_

Legend: Shaded cells are unimplemented.

Note 1: This bit is available only on the PIC18F67K90 and PIC18F87K90 devices.

#### 28.6.1 PROGRAM MEMORY CODE PROTECTION

The program memory may be read to, or written from, any location using the table read and table write instructions. The Device ID may be read with table reads. The Configuration registers may be read and written with the table read and table write instructions.

In normal execution mode, the CPn bits have no direct effect. CPn bits inhibit external reads and writes. A block of user memory may be protected from table writes if the WRTn Configuration bit is '0'.

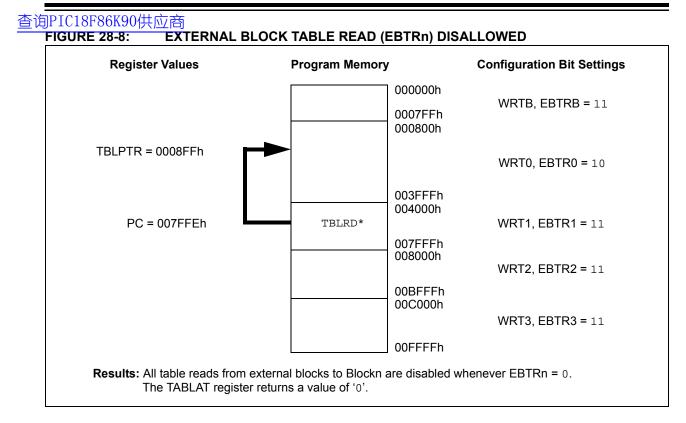
The EBTRn bits control table reads. For a block of user memory with the EBTRn bit set to '0', a table read instruction that executes from within that block is allowed to read. A table read instruction that executes from a

location outside of that block is not allowed to read and will result in reading '0's. Figures 28-7 through 28-9 illustrate table write and table read protection.

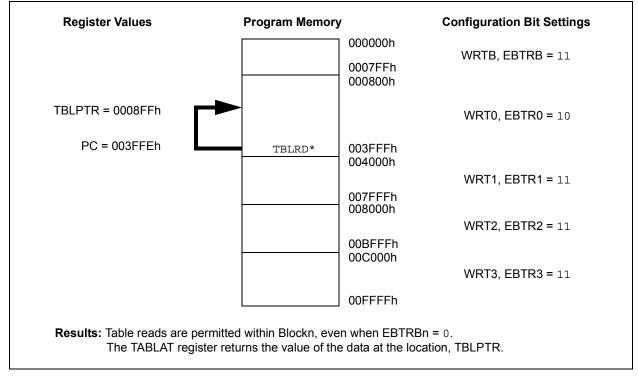
Note: Code protection bits may only be written to a '0' from a '1' state. It is not possible to write a '1' to a bit in the '0' state. Code protection bits are only set to '1' by a full chip erase or block erase function. The full chip erase and block erase functions can only be initiated via ICSP or an external programmer. Refer to the device programming specification for more information.

#### **Register Values Program Memory Configuration Bit Settings** 000000h WRTB. EBTRB = 11 0007FFh 000800h TBLPTR = 0008FFh WRT0. EBTR0 = 01 PC = 003FFEhTBLWT\* 003FFFh 004000h WRT1, EBTR1 = 11 007FFFh 008000h PC = 00BFFEhTBLWT\* WRT2, EBTR2 = 11 00BFFFh 00C000h WRT3, EBTR3 = 11 00FFFFh **Results:** All table writes are disabled to Blockn whenever WRTn = 0.

### FIGURE 28-7: TABLE WRITE (WRTn) DISALLOWED



#### FIGURE 28-9: EXTERNAL BLOCK TABLE READ (EBTRn) ALLOWED



#### 查询PIC18F86K90供应商 28.6.2 DATA EEPROM CODE PROTECTION

The entire data EEPROM is protected from external reads and writes by two bits: CPD and WRTD. CPD inhibits external reads and writes of data EEPROM. WRTD inhibits internal and external writes to data EEPROM. The CPU can always read data EEPROM under normal operation, regardless of the protection bit settings.

#### 28.6.3 CONFIGURATION REGISTER PROTECTION

The Configuration registers can be write-protected. The WRTC bit controls protection of the Configuration registers. In normal execution mode, the WRTC bit is readable only. WRTC can only be written via ICSP or an external programmer.

### 28.7 ID Locations

Eight memory locations (20000h-200007h) are designated as ID locations, where the user can store checksum or other code identification numbers. These locations are both readable and writable during normal execution through the TBLRD and TBLWT instructions or during program/verify. The ID locations can be read when the device is code-protected.

### 28.8 In-Circuit Serial Programming

The PIC18F87K90 family of devices can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed. For the various programming modes, please refer to the device programming specification.

### 28.9 In-Circuit Debugger

When the DEBUG Configuration bit is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB<sup>®</sup> IDE. When the microcontroller has this feature enabled, some resources are not available for general use. Table 28-5 shows which resources are required by the background debugger.

I/O Pins:	RB6, RB7
Stack:	Two Levels
Program Memory:	512 Bytes
Data Memory:	10 Bytes

To use the In-Circuit Debugger function of the microcontroller, the design must implement In-Circuit Serial Programming connections to MCLR/RG5/VPP, VDD, Vss, RB7 and RB6. This will interface to the In-Circuit Debugger module available from Microchip or one of the third party development tool companies.

#### 查询PIC18F86K90供应商 29.0 INSTRUCTION SET SUMMARY

The PIC18F87K90 family of devices incorporates the standard set of 75 PIC18 core instructions, as well as an extended set of 8 new instructions for the optimization of code that is recursive or that utilizes a software stack. The extended set is discussed later in this section.

### 29.1 Standard Instruction Set

The standard PIC18 MCU instruction set adds many enhancements to the previous PIC<sup>®</sup> MCU instruction sets, while maintaining an easy migration from these PIC MCU instruction sets. Most instructions are a single program memory word (16 bits), but there are four instructions that require two program memory locations.

Each single-word instruction is a 16-bit word divided into an opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- Byte-oriented operations
- Bit-oriented operations
- · Literal operations
- Control operations

The PIC18 instruction set summary in Table 29-2 lists **byte-oriented**, **bit-oriented**, **literal** and **control** operations. Table 29-1 shows the opcode field descriptions.

Most byte-oriented instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The destination of the result (specified by 'd')
- 3. The accessed memory (specified by 'a')

The file register designator, 'f', specifies which file register is to be used by the instruction. The destination designator, 'd', specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All **bit-oriented** instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The bit in the file register (specified by 'b')
- 3. The accessed memory (specified by 'a')

The bit field designator, 'b', selects the number of the bit affected by the operation, while the file register designator, 'f', represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (specified by 'k')
- The desired FSR register to load the literal value into (specified by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (specified by 'n')
- The mode of the CALL or RETURN instructions (specified by 's')
- The mode of the table read and table write instructions (specified by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for four double-word instructions. These instructions were made double-word to contain the required information in 32 bits. In the second word, the 4 MSbs are '1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP.

The double-word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1  $\mu$ s. If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2  $\mu$ s. Two-word branch instructions (if true) would take 3  $\mu$ s.

Figure 29-1 shows the general formats that the instructions can have. All examples use the convention 'nnh' to represent a hexadecimal number.

The Instruction Set Summary, shown in Table 29-2, lists the standard instructions recognized by the Microchip MPASM<sup>™</sup> Assembler.

Section 29.1.1 "Standard Instruction Set" provides a description of each instruction.

#### 查询PIC18F86K90供应查 FABLE 29-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM access bit:
	a = 0: RAM location in Access RAM (BSR register is ignored)
	a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
C, DC, Z, OV, N	ALU Status bits: Carry, Digit Carry, Zero, Overflow, Negative.
d	Destination select bit:
	d = 0: store result in WREG
	d = 1: store result in file register f
dest	Destination: either the WREG register or the specified register file location.
f	8-bit register file address (00h to FFh), or 2-bit FSR designator (0h to 3h).
fs	12-bit register file address (000h to FFFh). This is the source address.
fd	12-bit register file address (000h to FFFh). This is the destination address.
GIE	Global Interrupt Enable bit.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
mm	The mode of the TBLPTR register for the table read and table write instructions. Only used with table read and table write instructions:
*	No Change to register (such as TBLPTR with table reads and writes)
*+	Post-Increment register (such as TBLPTR with table reads and writes)
*_	Post-Decrement register (such as TBLPTR with table reads and writes)
+*	Pre-Increment register (such as TBLPTR with table reads and writes)
n	The relative address (2's complement number) for relative branch instructions or the direct address for
	Call/Branch and Return instructions.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
PD	Power-Down bit.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
s	Fast Call/Return mode select bit:
	s = 0: do not update into/from shadow registers
	s = 1: certain registers loaded into/from shadow registers (Fast mode)
TBLPTR	21-bit Table Pointer (points to a Program Memory location).
TABLAT	8-bit Table Latch.
TO	Time-out bit.
TOS	Top-of-Stack.
u	Unused or Unchanged.
WDT	Watchdog Timer.
WREG	Working register (accumulator).
х	Don't care ('0' or '1'). The assembler will generate code with $x = 0$ . It is the recommended form of use for
	compatibility with all Microchip software tools.
Zs	7-bit offset value for Indirect Addressing of register files (source).
zd	7-bit offset value for Indirect Addressing of register files (destination).
{ }	Optional argument.
[text]	Indicates an Indexed Address.
(text)	The contents of text.
[expr] <n></n>	Specifies bit n of the register indicated by the pointer expr.
$\rightarrow$	Assigned to.
< >	Register bit field.
e	In the set of.
italics	User-defined term (font is Courier New).

Byte-oriented file register operations	Example Instruction
<u>15 10 9 8 7 0</u>	
OPCODE d a f (FILE #)	ADDWF MYREG, W, B
d = 0 for result destination to be WREG register	
d = 1 for result destination to be file register (f) a = 0 to force Access Bank	
a = 1 for BSR to select bank f = 8-bit file register address	
Byte to Byte move operations (2-word)	
15 12 11 0	
OPCODE f (Source FILE #)	MOVFF MYREG1, MYREG2
15 12 11 0	
1111 f (Destination FILE #)	
f = 12-bit file register address	
-	
Bit-oriented file register operations	
15 12 11 9 8 7 0 OPCODE b (BIT #) a f (FILE #)	BSF MYREG, bit, B
	BSF MIKEG, DIC, B
b = 3-bit position of bit in file register (f) a = 0 to force Access Bank	
a = 1 for BSR to select bank	
f = 8-bit file register address	
Literal operations	
<u>15 8 7 0</u>	
OPCODE k (literal)	MOVLW 7Fh
k = 8-bit immediate value	
Control operations	
CALL, GOTO and Branch operations 15 8 7 0	
OPCODE n<7:0> (literal)	GOTO Label
15 12 11 0	
1111 n<19:8> (literal)	
n = 20-bit immediate value	
15 8 7 0 OPCODE S n<7:0> (literal)	CALL MYFUNC
	CALL MIFONC
15 12 11 0 1111 n<19:8> (literal)	
1111 n<19:8> (literal) S = Fast bit	
<u>15 11 10 0</u>	
OPCODE n<10:0> (literal)	BRA MYFUNC
15 8 7 0	
OPCODE n<7:0> (literal)	BC MYFUNC

### 查询PIC18F86K90供应商

#### TABLE 29-2: PIC18F87K90 FAMILY INSTRUCTION SET

Mnemo	onic,	Description	Cueles	16-Bit Instruction Word			Vord	Status	Natas
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BYTE-OR	ENTED	OPERATIONS							
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, Skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4
CPFSGT	f, a	Compare f with WREG, Skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4
CPFSLT	f, a	Compare f with WREG, Skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2
DECF	f, d, a	Decrement f	1	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2
INCF	f, d, a	Increment f	1	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1	0001	00da	ffff	ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1
MOVFF	f <sub>s</sub> , f <sub>d</sub>	Move f <sub>s</sub> (source) to 1st word	2	1100	ffff	ffff	ffff	None	
	3, u	f <sub>d</sub> (destination) 2nd word		1111	ffff	ffff	ffff		
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	1, 2
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	1, 2
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	,
RRCF	f, d, a	Rotate Right f through Carry	1	0011	00da	ffff	ffff	Ć, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff		
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	1, 2
SUBFWB	f, d, a	Subtract f from WREG with	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	,
	, - , -	Borrow						-, -, , - ,	
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	1, 2
SUBWFB	f, d, a	Subtract WREG from f with	1	0101	10da	ffff	ffff	C, DC, Z, OV, N	·
	, - ,	Borrow				-	_	, _, , _ , _ ,	
SWAPF	f, d, a	Swap Nibbles in f	1	0011	10da	ffff	ffff	None	4
TSTFSZ	f, a	Test f, Skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2
XORWF		Exclusive OR WREG with f	1		10da	ffff		Z, N	,_
								_,	

**Note 1:** When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

**3:** If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

### 查询PIC18F86K90供应商

### TABLE 29-2: PIC18F87K90 FAMILY INSTRUCTION SET (CONTINUED)

Mnemo	onic,	Description	Quala	16-l	Bit Instr	uction V	Vord	Status	Netse
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BIT-ORIEI	NTED O	PERATIONS							
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, b, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2
CONTRO	OPER	ATIONS							
BC	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	1 (2)	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	2	1101	0nnn	nnnn	nnnn	None	
ΒZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call Subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	—	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust WREG	1	0000	0000	0000	0111	С	
GOTO	n	Go to Address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	—	No Operation	1	0000	0000	0000	0000	None	
NOP	—	No Operation	1	1111	xxxx	xxxx	xxxx	None	4
POP	—	Pop Top of Return Stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	—	Push Top of Return Stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn	None	
RESET		Software Device Reset	1	0000	0000	1111	1111		
RETFIE	S	Return from Interrupt Enable	2	0000	0000	0001	000s	GIE/GIEH, PEIE/GIEL	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk	None	
RETURN	S	Return from Subroutine	2	0000	0000	0001	001s	None	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

**Note 1:** When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

**3:** If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

### 查询PIC18F86K90供应商

TABLE 29-2: PIC18F87K90 FAMILY INSTRUCTION SET (CONTINUED)

IABLE 2	J-Z.	PIC18F8/K90 FAMILT INSTE		SEI	CONT	INUED	)		
Mnemo	onic,	Description	16-Bit Instruction		ruction	Word	Status	Notes	
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
LITERAL	OPERA	TIONS							
ADDLW	k	Add Literal and WREG	1	0000	1111	kkkk	kkkk	C, DC, Z, OV, N	
ANDLW	k	AND Literal with WREG	1	0000	1011	kkkk	kkkk	Z, N	
IORLW	k	Inclusive OR Literal with WREG	1	0000	1001	kkkk	kkkk	Z, N	
LFSR	f, k	Move literal (12-bit) 2nd word	2	1110	1110	00ff	kkkk	None	
		to FSR(f) 1st word		1111	0000	kkkk	kkkk		
MOVLB	k	Move Literal to BSR<3:0>	1	0000	0001	0000	kkkk	None	
MOVLW	k	Move Literal to WREG	1	0000	1110	kkkk	kkkk	None	
MULLW	k	Multiply Literal with WREG	1	0000	1101	kkkk	kkkk	None	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk	None	
SUBLW	k	Subtract WREG from Literal	1	0000	1000	kkkk	kkkk	C, DC, Z, OV, N	
XORLW	k	Exclusive OR Literal with WREG	1	0000	1010	kkkk	kkkk	Z, N	
DATA MEI	MORY	→ PROGRAM MEMORY OPERAT	IONS						
TBLRD*		Table Read	2	0000	0000	0000	1000	None	
TBLRD*+		Table Read with Post-Increment		0000	0000	0000	1001	None	
TBLRD*-		Table Read with Post-Decrement		0000	0000	0000	1010	None	
TBLRD+*		Table Read with Pre-Increment		0000	0000	0000	1011	None	
TBLWT*		Table Write	2	0000	0000	0000	1100	None	
TBLWT*+		Table Write with Post-Increment		0000	0000	0000	1101	None	
TBLWT*-		Table Write with Post-Decrement		0000	0000	0000	1110	None	
TBLWT+*		Table Write with Pre-Increment		0000	0000	0000	1111	None	

**Note 1:** When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

**3:** If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

ADD W to f ADDWF

 $0 \leq f \leq 255$  $d \in [0\,,1]$ a ∈ [0,1]  $(W) + (f) \rightarrow dest$ N, OV, C, DC, Z

0010

GPR bank.

Q2

Read

register 'f

ADDWF

=

=

W

REG

17h

0C2h

0D9h

0C2h

f {,d {,a}}

01da

Add W to register 'f'. If 'd' is '0', the

result is stored in W. If 'd' is '1', the result is stored back in register 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever  $f \le 95$  (5Fh). See Section 29.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Q3

Process

Data

REG, 0, 0

ffff

ffff

Q4

Write to

destination

#### 查询PIC18F86K90供应商 STANDARD INSTRUCTION SET 29.1.1

ADDLW	ADD Litera	l to W		ADDWF	AI
Syntax:	ADDLW	k		Syntax:	A
Operands:	$0 \le k \le 255$			Operands:	0
Operation:	$(W) + k \rightarrow V$	N			d a
Status Affected:	N, OV, C, D	Ю, Z		Operation:	а (W
Encoding:	0000	1111 kk	kk kkkk	Status Affected:	(v) N,
Description:		ts of W are ad k' and the res	lded to the ult is placed in	Encoding: Description:	Ac
Words:	1				re
Cycles:	1				re: If '
Q Cycle Activity:					IT If '
Q1	Q2	Q3	Q4		GI
Decode	Read literal 'k'	Process Data	Write to W		lf ' se
<u>Example:</u> Before Instruc W =		5h			in me Se Bi Li
After Instructio W =				Words:	1
vv =	25h			Cycles:	1
				Q Cycle Activity: Q1	
				Decode	F reg
				Example:	AI
				Before Instruc W REG	=
				After Instruction	11

All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in Note: symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

ADDWFC	ADD W an	d Carry b	oit to f	
Syntax:	ADDWFC	f {,d {,a	a}}	
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$			
Operation:	(W) + (f) +	$(C) \rightarrow de$	st	
Status Affected:	N,OV, C, D	C, Z		
Encoding:	0010	00da	ffff	ffff
Description:	Add W, the location 'f'. placed in V placed in d	lf 'd' is '0 V. lf 'd' is	, the resu 1', the re	ult is sult is
	If 'a' is '0', t If 'a' is '1', t GPR bank.	he BSR is		
	If 'a' is '0' a set is enab in Indexed mode wher Section 29 Bit-Oriente Literal Offs	led, this ir Literal Of never f ≤ 9 0.2.3 "Byt ed Instrue	nstruction fset Addr 95 (5Fh). re-Orient ctions in	operates essing See ed and Indexed
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3		Q4
Decode	Read register 'f'	Proces Data		/rite to stination
Example:	ADDWFC	REG,	0, 1	
Before Instruct Carry bit REG W After Instructio Carry bit REG	= 1 = 02h = 4Dh on = 0 = 02h			
W	= 50h			

	LW	AND Liter	al with W	1		
Synta	IX:	ANDLW	k			
Opera	ands:	$0 \le k \le 255$	5			
Opera	ation:	(W) .AND.	$k \rightarrow W$			
Status	s Affected:	N, Z				
Enco	ding:	0000	1011	kkk	k	kkkk
Desci	ription:	The conter 8-bit literal				
Word	s:	1				
Cycle	s:	1				
QC	cle Activity:					
_	Q1	Q2	Q3	8		Q4
	Decode	Read literal 'k'	Proce Data		V	Vrite to W
<u>Exam</u>	iple:	ANDLW	05Fh			
-	Before Instruc W After Instructic	= A3h				
/	W	= 03h				

### 查询PIC18F86K90供应商

ANDWF	AND W wit	h f	
Syntax:	ANDWF	f {,d {,a}}	
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$		
Operation:	(W) .AND. (	(f) $\rightarrow$ dest	
Status Affected:	N, Z		
Encoding:	0001	01da ff:	ff ffff
Description:	register 'f'. I	; '1', the result	IDed with esult is stored is stored back
			nk is selected. d to select the
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	nd the extende ed, this instruct Literal Offset A lever f ≤ 95 (5) .2.3 "Byte-Or ed Instruction set Mode" for	ction operates Addressing Fh). See iented and s in Indexed
Words:	1		
Cycles:	1		
Q Cycle Activity:			
Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination
Example:	ANDWF	REG, 0, 0	
Before Instruc W REG	= 17h		
After Instructio	= C2h		

вс		Branch if C	Carry					
Synta	ax:	BC n						
Oper	ands:	-128 ≤ n ≤ 1	$-128 \le n \le 127$					
Oper	ation:	if Carry bit i (PC) + 2 + 2						
Statu	is Affected:	None	None					
Enco	oding:	1110	0010 nn	nn nnnn				
Desc	cription:	If the Carry will branch.	bit is '1', then	the program				
		added to the incremented instruction,	d to fetch the r the new addre n. This instruct	e PC will have next ess will be				
Word	ds:	1						
Cycle	es:	1(2)						
Q C If Ju	ycle Activity: imp:							
	Q1	Q2	Q3	Q4				
	Decode	Read literal 'n'	Process Data	Write to PC				
	No operation	No operation	No operation	No operation				
lf No	o Jump:							
	Q1	Q2	Q3	Q4				
	Decode	Read literal	Process	No				
		'n'	Data	operation				
Exan	<u>nple:</u>	HERE	BC 5					
	Before Instruc PC After Instruction	= ad	dress (here	)				
	If Carry PC If Carry	= 1; = ad = 0;	dress (HERE	+ 12)				
	PC		dress (HERE	+ 2)				

## 查询PIC18F86K90供应商

BCF	Bit Clear f			BN
Syntax:	BCF f, b	{,a}		Synta
Operands:	$0 \leq f \leq 255$			Opera
	0 ≤ b ≤ 7 a ∈ [0,1]			Opera
Operation:	$0 \rightarrow f \le b >$			Statu
Status Affected:	None			Enco
Encoding:	1001	bbba ffi	ff ffff	Desc
Description:	Bit 'b' in reg	jister 'f' is clea	red.	
	,	he Access Bar he BSR is use	nk is selected. d to select the	
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	nd the extended ed, this instruct Literal Offset A lever $f \le 95$ (51 .2.3 "Byte-Or ad Instruction set Mode" for	ction operates Addressing Fh). See iented and s in Indexed	Word Cycle Q Cy
Words:	1			lf Ju
Cycles:	1			[
Q Cycle Activity:				
Q1	Q2	Q3	Q4	
Decode	Read register 'f'	Process Data	Write register 'f'	lf No
After Instruction	tion EG = C7h	LAG_REG ,	7, 0	<u>Exam</u>

		Branch if N	legative				
Synta	ax:	BN n					
Oper	ands:	-128 ≤ n ≤ <sup>-</sup>	127				
Oper	ation:	•	if Negative bit is '1', (PC) + 2 + 2n $\rightarrow$ PC				
Statu	s Affected:	None					
Enco	ding:	1110	0110	nnnn	nnnn		
Desc	ription:	If the Nega program wi		-	the		
		The 2's cor added to th incremente instruction, PC + 2 + 2r two-cycle ir	e PC. Sin d to fetch the new n. This in:	ice the P the nex address struction	C will hav t will be		
Word	ls:	1					
Cycle	es:	1(2)					
Q C If Ju	ycle Activity: mp:						
	Q1	Q2	Q3	-	Q4		
	Decode	Read literal	Proce		Write to		
	200040	ʻn'	Data		PC		
	No	'n' No	Data No	1	PC No		
	No	'n'	Data	1	PC		
lf No	No operation o Jump:	'n' No operation	Data No operati	ion o	PC No peration		
lf No	No operation Jump: Q1	'n' No operation Q2	Data No operati Q3	ion o	PC No peration Q4		
lf No	No operation o Jump:	'n' No operation Q2 Read literal	Data No operati Q3 Proce	ion o	PC No peration Q4 No		
lf No	No operation Jump: Q1	'n' No operation Q2	Data No operati Q3	ion o	PC No peration Q4		
<u>Exan</u>	No operation o Jump: Q1 Decode	'n' No operation Q2 Read literal 'n' HERE	Data No operati Q3 Proce Data	ion o	PC No peration Q4 No		
<u>Exan</u>	No operation o Jump: Q1 Decode	'n' No operation Q2 Read literal 'n' HERE tion = ad	Data No operati Q3 Proce Data	ss o Jump	PC No peration Q4 No		

### 查询PIC18F86K90供应商

BNC		Branch if N	lot Carry		BNN
Synta	ax:	BNC n			Syntax:
Oper	ands:	-128 ≤ n ≤ ′	127		Operands
Oper	ation:	if Carry bit i (PC) + 2 + 2			Operation
Statu	is Affected:	None			Status Affe
Enco	oding:	1110	0011 nr	nnn nnnn	Encoding:
Desc	cription:	If the Carry will branch.	bit is '0', the	n the program	Descriptio
		added to the incremente instruction,	d to fetch the the new add n. This instruc	he PC will have next	e
Word	ds:	1			Words:
Cycle	es:	1(2)			Cycles:
Q C If Ju	ycle Activity: imp:				Q Cycle / If Jump:
	Q1	Q2	Q3	Q4	
	Decode	Read literal 'n'	Process Data	Write to PC	De
	No operation	No operation	No operation	No operation	ope
lf No	o Jump:				If No Jur
	Q1	Q2	Q3	Q4	
	Decode	Read literal 'n'	Process Data	No operation	De
<u>Exan</u>	Before Instruct PC After Instruction If Carry PC	= ad on = 0;	BNC Jumj dress (HERF dress (Jump	Ξ)	<u>Example:</u> Befor After
	lf Carry PC	= 1; = ad	dress (HERI	E + 2)	

BNN		Branch if I	Not Negative				
Synta	ax:	BNN n					
Oper	ands:	-128 ≤ n ≤	127				
Oper	ation:	if Negative (PC) + 2 +	,				
Statu	s Affected:	None					
Enco	ding:	1110	0111 nn	nn nnnn			
Desc	ription:	If the Nega program wi	tive bit is '0', t Il branch.	hen the			
		added to th incremente instruction,	d to fetch the the new addr n. This instruc	ne PC will have next ress will be			
Word	ls:	1	1				
Cycle	es:	1(2)	1(2)				
Q C If Ju	•						
	Q1	Q2	Q3	Q4			
	Decode	Read literal 'n'	Process Data	Write to PC			
	No	No	No	No			
IF NIZ	operation	operation	operation	operation			
	o Jump: Q1	Q2	Q3	Q4			
	Decode	Read literal	Process	No			
		'n'	Data	operation			
<u>Exan</u>	nple:	HERE	BNN Jum <u>r</u>				
Before Instructio PC After Instruction		= ad	dress (here	:)			
	If Negativ PC If Negativ	/e = 0; = ad /e = 1;	dress (Jump				
	PC	= ad	dress (HERE	+ 2)			

BNO	v	Branch if N	Branch if Not Overflow				
Synta	ax:	BNOV n					
Oper	ands:	-128 ≤ n ≤ 1	127				
Oper	ation:	if Overflow (PC) + 2 + 2	,				
Statu	is Affected:	None					
Enco	oding:	1110	0101 nni	nn nnnn			
Desc	cription:	If the Overfi program wi	low bit is '0', th Il branch.	nen the			
		added to the incremented instruction,	d to fetch the r the new addre n. This instruct	e PC will have next ess will be			
Word	ls:	1	1				
Cycle	es:	1(2)					
Q C If Ju	ycle Activity: imp:						
	Q1	Q2	Q3	Q4			
	Decode	Read literal 'n'	Process Data	Write to PC			
	No operation	No operation	No operation	No operation			
lf No	o Jump:						
	Q1	Q2	Q3	Q4			
	Decode	Read literal 'n'	Process Data	No operation			
Exan	nple:	HERE	BNOV Jump				
	Before Instruc PC After Instructio	= ad	dress (here	)			
	If Overflo PC If Overflo PC	= ad w = 1;	dress (Jump dress (HERE	,			

BNZ	Branch if N	lot Zero				
Syntax:	BNZ n					
Operands:	-128 ≤ n ≤ 1	127				
Operation:		if Zero bit is '0', (PC) + 2 + 2n $\rightarrow$ PC				
Status Affected:	None					
Encoding:	1110	0001 nnr	nn nnnn			
Description:	If the Zero I will branch.	oit is '0', then t	he program			
	added to the incremented instruction,	nplement num e PC. Since th d to fetch the r the new addre n. This instruct instruction.	e PC will have next ess will be			
Words:	1					
Cycles:	1(2)					
Q Cycle Activity: If Jump:						
Q1	Q2	Q3	Q4			
Decode	Read literal 'n'	Process Data	Write to PC			
No	No	No	No			
operation	operation	operation	operation			
If No Jump:						
Q1	Q2	Q3	Q4			
Decode	Read literal	Process	No			
	'n'	Data	operation			
Example:	HERE	BNZ Jump				

PC After Instruction	=	address (HERE)
If Zero PC If Zero PC	= = =	0; address (Jump) 1; address (HERE + 2)

BRA		Unconditio	Unconditional Branch				
Synta	ax:	BRA n					
Oper	ands:	-1024 ≤ n ≤	1023				
Oper	ation:	(PC) + 2 + 2	$2n \rightarrow PC$				
Statu	s Affected:	None					
Enco	oding:	1101	0nnn nn	nn nnnn			
Desc	ription:	the PC. Sin incremented instruction,	ce the PC will d to fetch the the new addre n. This instruc	next ess will be			
Word	ls:	1					
Cycles:		2					
QC	vcle Activity:						
	Q1	Q2	Q3	Q4			
	Decode	Read literal 'n'	Process Data	Write to PC			
	No operation	No operation	No operation	No operation			
<u>Exar</u>	n <u>ple:</u> Before Instruc PC After Instructio	= ad	BRA Jump dress (HERE				

BSF	Bit Set f					
Syntax:	BSF f, b	{,a}				
Operands:	0 ≤ f ≤ 255 0 ≤ b ≤ 7					
	<b>a</b> ∈ [0,1]					
Operation:	$1 \rightarrow \text{f}$					
Status Affected:	None					
Encoding:	1000	bbba	ffff	ffff		
Description:	Bit 'b' in reg	gister 'f' i	s set.			
	lf 'a' is '0', f If 'a' is '1', f GPR bank.	he BSR i				
	in Indexed mode wher Section 29 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details				
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	3	Q4		
Decode	Read register 'f'	Proce Data		Write gister 'f'		
Example:		FLAG_RE	G, 7, 1			
Before Instruc FLAG_R	EG = 0A	Nh				
After Instruction						

BTFSC	Bit Test File	, Skip if Clea	·	BTFSS	Bit Tes	t File, Skip if Set	
Syntax:	BTFSC f, b	{,a}		Syntax:	BTFSS	f, b {,a}	
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0, 1]$			Operands:	0 ≤ f ≤ 2 0 ≤ b < a ∈ [0 ,	7	
Operation:	skip if (f <b>)</b>	= 0		Operation:	skip if (1	f <b>) = 1</b>	
Status Affected:	None			Status Affect	ted: None		
Encoding:	1011	bbba ff	ff ffff	Encoding:	1010	) bbba ff	ff ffff
Description:	instruction is the next inst current instru and a NOP is	If bit 'b' in register 'f' is '0', then the next instruction is skipped. If bit 'b' is '0', then the next instruction fetched during the current instruction execution is discarded and a NOP is executed instead, making this a two-cycle instruction.			instruct the nex current and a N	in register 'f' is '1', ion is skipped. If bit t instruction fetched instruction executio IOP is executed inst vo-cycle instruction	"b' is '1', then d during the on is discarded read, making
		e Access Ban BSR is used to	k is selected. If o select the			0', the Access Banl , the BSR is used to ank.	
	is enabled, t Indexed Lite whenever f Section 29.3 Bit-Oriented	d the extended his instruction ral Offset Addu ≤ 95 (5Fh). See 2.3 "Byte-Orie d Instructions et Mode" for d	essing mode ented and in Indexed		set is er Indexed whenev Sectior Bit-Orio	0' and the extender nabled, this instruct d Literal Offset Addi ver f ≤ 95 (5Fh). Ser n 29.2.3 "Byte-Orie ented Instructions Offset Mode" for d	ion operates in ressing mode e ented and s in Indexed
Words:	1			Words:	1		
Cycles:		cles if skip and 2-word instrue		Cycles:	1(2) Note:	3 cycles if skip an by a 2-word instru	
Q Cycle Activity:				Q Cycle Ac	tivity.		
Q1	Q2	Q3	Q4	-	Q1 Q2	Q3	Q4
Decode	Read	Process	No		code Read	Process	No
	register 'f'	Data	operation		register	ʻʻf' Data	operation
lf skip:				If skip:			
Q1	Q2	Q3	Q4		Q1 Q2	Q3	Q4
No	No	No	No		lo No	No	No
operation	operation ved by 2-word ins	operation	operation		ation operation operation operation		operation
Q1	Q2	Q3	Q4		Q1 Q2	Q3	Q4
No	No	No	No			No	No
operation	operation	operation	operation		ation operatio		operation
No	No	No	No	Ν	lo No	No	No
operation	operation	operation	operation	oper	ation operation	on operation	operation
Example:	HERE B FALSE : TRUE :	IFSC FLAC	B, 1, 0	Example:	HERE FALSE TRUE	BTFSS FLAG : :	G, 1, 0
Before Instru PC After Instruc If FLAC Pr If FLAC Pr	= add tion G<1> = 0; C = add G<1> = 1;	ress (HERE) ress (TRUE) ress (FALSE	)	P After Ir If	Instruction C = hstruction FLAG<1> = PC = FLAG<1> = PC =	address (HERE) 0; address (FALSE 1; address (TRUE)	)

## 查询PIC18F86K90供应商

BTG	Bit Toggle	f		BOV		Branch if C	Overflow		
Syntax:	BTG f, b {,a	ı}		Syntax:		BOV n			
Operands:	$0 \leq f \leq 255$			Operan	ds:	-128 ≤ n ≤ ′	127		
	0 ≤ b < 7 a ∈ [0,1]			Operati	on:		if Overflow bit is '1', (PC) + 2 + 2n $\rightarrow$ PC		
Operation:	$(\overline{f} > b) \to f <$	b>		Status A	Affected:	None			
Status Affected:	None			Encodir	na:	1110	0100 nn	nn nnnn	
Encoding:	0111	bbba ff	ff ffff	Descrip	-	If the Overf	low bit is '1', t	hen the	
Description:	Bit 'b' in da	Bit 'b' in data memory location, 'f', is				program wi	ll branch.		
	,	he Access Bai he BSR is use				added to the incremente instruction,	d to fetch the the new addr	ne PC will have next ess will be	
	If 'a' is '0' and the extended instruction					PC + 2 + 2n. This instruction is then a two-cycle instruction.			
	set is enabled, this instruction operates in Indexed Literal Offset Addressing		Words:						
	mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and					1			
				Cycles:		1(2)			
		ed Instruction set Mode" for		Q Cycl If Jump	e Activity: D:				
Words:	1				Q1	Q2	Q3	Q4	
Cycles:	1				Decode	Read literal 'n'	Process Data	Write to PC	
Q Cycle Activity:					No	No	No	No	
Q1	Q2	Q3	Q4		operation	operation	operation	operation	
Decode	Read register 'f'	Process Data	Write register 'f'	lf No J	•	~~~	0.0	~ ~ ~	
		Dala	register i		Q1 Decode	Q2 Read literal	Q3 Process	Q4 No	
Example:	BTG P	ORTC, 4, 0	1		Decode	'n'	Data	operation	
Before Instru		01010, 1, 0	,						
PORTC	= 0111 (	0101 <b>[75h]</b>		Exampl	<u>e:</u>	HERE	BOV Jump	)	
After Instructi PORTC		0101 <b>[65h]</b>			fore Instruct PC ter Instructi If Overfic PC If Overfic	= ad on ow = 1; = ad	dress (HERE dress (Jump		

If Overflow = 0; PC = address (HERE + 2)

ΒZ		Branch if Z	Zero					
Synta	ax:	BZ n						
Oper	ands:	-128 ≤ n ≤ ′	127					
Oper	ation:	if Zero bit is (PC) + 2 + 2	,					
Statu	is Affected:	None						
Enco	oding:	1110	0000	nnnn	nnnn			
Desc	cription:	If the Zero I will branch.	bit is '1', th	en the p	rogram			
		added to the incremente instruction, PC + 2 + 2r	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.					
Word	ls:	1						
Cycles:		1(2)	1(2)					
Q C If Ju	ycle Activity: Imp:							
	Q1	Q2	Q3		Q4			
	Decode	Read literal	Process	s V	/rite to			
		ʻn'	Data		PC			
	No operation	No operation	No		No eration			
If NIZ	Jump:	operation	operatio	π ομ	eration			
	Q1	Q2	Q3		Q4			
	Decode	Read literal	Process	5	No			
		'n'	Data	ор	eration			
Exan	nple:	HERE	BZ Ji	ump				
	Before Instruc PC After Instructio	= ad	dress (HE	CRE)				
	If Zero	= 1;						

	Subroutin				
Syntax:	CALL k {,	•			
Operands:	0 ≤ k ≤ 104 s ∈ [0,1]	8575			
Operation:	$\begin{array}{l} (PC) + 4 \rightarrow \\ k \rightarrow PC < 20 \\ \text{if } s = 1, \\ (W) \rightarrow WS \\ (STATUS) \\ (BSR) \rightarrow E \end{array}$	0:1>; , → STATI	JSS,		
Status Affected:	None				
Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)	1110 1111	110s k <sub>19</sub> kkk	k <sub>7</sub> k} kkk		kkkk kkkk
	(PC+ 4) is p If 's' = 1, th registers a respective STATUSS update occ is loaded in two-cycle i	ne W, STA re also pu shadow i and BSR curs. Ther nto PC<2	ATUS a ushed registe S. If 's n, the 2 0:1>. (	and I into rs, V i = 0 20-bi	BSR their VS, , no t value
Words:	2				
Cycles:	2				
Cycles.					
Q Cycle Activity:					
Q Cycle Activity: Q1	Q2	Q	1		Q4
Q Cycle Activity:	Q2 Read literal 'k'<7:0>,	Q3 Push P stac	C to	'k'<	Q4 ad litera <19:8> te to P
Q Cycle Activity: Q1	Read literal	Push P	C to k	'k'<	ad litera
Q Cycle Activity: Q1 Decode	Read literal 'k'<7:0>,	Push P stac	C to k	'k'< Writ	ad litera <19:8> te to P
Q Cycle Activity: Q1 Decode No operation	Read literal 'k'<7:0>, No operation HERE	Push P stac No	C to k	'k'< Writ	ad litera <19:8> te to P No eratior
Q Cycle Activity: Q1 Decode No operation	Read literal 'k'<7:0>, No operation HERE tion = address	Push P stac No operat	C to k ion THEF	'k'< Writ	ad litera <19:8> te to P No eratior

## 查询PIC18F86K90供应商

CLRF	Clear f				
Syntax:	CLRF f {,a	a}			
Operands:	$0 \leq f \leq 255$				
	<b>a</b> ∈ [0,1]				
Operation:	$\begin{array}{l} 000h \rightarrow f, \\ 1 \rightarrow Z \end{array}$				
Status Affected:	Z				
Encoding:	0110	101a	ffff	ffff	
Description:	Clears the cregister.	contents	of the spe	cified	
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proce Data		Write gister 'f'	
Example: CLRF FLAG_REG,1 Before Instruction FLAG_REG = 5Ah After Instruction					

FLAG\_REG = 00h

CLRWDT	Clear Wate	Clear Watchdog Timer				
Syntax:	CLRWDT					
Operands:	None					
Operation:						
Status Affected:	TO, PD					
Encoding:	0000	0000	0000	0100		
Description: CLRWDT instruction resets the Watchdog Timer. It also resets the post scaler of the WDT. Status bits, TO an PD, are set.						
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3		Q4		
Decode	No operation	Proce Data		No operation		
Example:	CLRWDT					
Before Instruct WDT Cou After Instructio WDT Cou <u>WD</u> T Pos <u>TO</u> PD	unter = n unter =	<b>?</b> 00h 1 1				

© 2010 Microchip	Technology Inc.
------------------	-----------------

COMF	Compleme	ent f		CPFSEQ	Compare	with W, Skip	if f = W	
Syntax:	COMF f	{,d {,a}}		Syntax:	CPFSEQ	f {,a}		
Operands:	$0 \le f \le 255$			Operands:	$0 \le f \le 255$			
	$d \in [0, 1]$				<b>a</b> ∈ [0,1]			
	<b>a</b> ∈[0,1]			Operation:	(f) - (W),	(\\)		
Operation:	$\overline{f} \rightarrow dest$				skip if (f) = (unsigned)	(vv) comparison)		
Status Affected:	N, Z			Status Affected:	None	·····		
Encoding:	0001	11da ff	ff ffff	Encoding:	0110	001a ff	ff ffff	
Description:	complement stored in W	nts of register ' nted. If 'd' is '0 /. If 'd' is '1', th k in register 'f'.	', the result is le result is	Description:	location 'f'	Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction.		
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank. If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See				discarded a instead, ma	If 'f' = W, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction.		
					If 'a' is '1', t	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.		
	Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			set is enab in Indexed	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See			
Words:	1					.2.3 "Byte-O	,	
Cycles:	1						ns in Indexed	
Q Cycle Activity:						set Mode" for	details.	
Q1	Q2	Q3	Q4	Words:	1			
Decode	Read register 'f'	Process Data	Write to destination	Cycles:		cles if skip an 2-word instru		
				Q Cycle Activity	-			
Example:	COMF	REG, 0, 0		Q1	Q2	Q3	Q4	
Before Instruc REG	tion = 13h			Decode	Read	Process	No	
After Instructio				lf alvia	register 'f'	Data	operation	
REG	= 13h			lf skip: Q1	Q2	Q3	Q4	
W	= ECh			No	No	No	No	
				operation	operation	operation	operation	
				If skip and follow	ved by 2-word ir	struction:		
				Q1	Q2	Q3	Q4	
				No	No	No	No	
				operation No	operation No	operation No	operation No	
				operation	operation	operation	operation	
				Example:	HERE NEQUAL EQUAL	CPFSEQ REG	G, 0	
				Before Instr				
				PC Ad	dress = HE	RE		

PC Address W REG	= = =	HERE ? ?	
After Instruction			
If REG	=	W;	
PC	=		(EQUAL)
If REG PC	≠ =	W; Address	(NEQUAL)

-		17 (1-1-1-3			
CPFS	GT	Compare f	with W, Skip	if f > W	CPFSI
Synta:	X:	CPFSGT	f {,a}		Syntax
Opera	ands:	$0 \le f \le 255$			Opera
•		<b>a</b> ∈[0,1]			Opera
Opera	ation:	(f) - (W),			Operat
		skip if (f) >	· · ·		Opera
		(unsigned c	omparison)		
Status	Affected:	None			Status
Encoc	ding:	0110	010a ffi	ff ffff	Encod
Descr	iption:	Compares t	he contents of	data memory	
			o the contents		Descri
		performing	an unsigned s	ubtraction.	
			nts of 'f' are gr		
			WREG, then t		
			s discarded ar stead, making		
		two-cycle in	-	uns a	
			he Access Bar	nk is selected	
			ne BSR is use		
		GPR bank.			
		If 'a' is '0' a	nd the extende	ed instruction	
			ed, this instruc		Words
			_iteral Offset A		Cycles
			ever f ≤ 95 (5		
			.2.3 "Byte-Ori		
			et Mode" for		Q Cyc
Words	s.	1			_
Cycles		1(2)			
Oycic.	5.	( )	ycles if skip ar	nd followed	L
			a 2-word instru		lf skip
Q Cy	cle Activity:				Г
	Q1	Q2	Q3	Q4	
	Decode	Read	Process	No	lf skip
Ļ		register 'f'	Data	operation	ii Skip
lf skip		02	03	04	Γ
Г	Q1 No	Q2 No	Q3 No	Q4 No	1
	operation	operation	operation	operation	-
lf skir		d by 2-word in			1
	Q1	Q2	Q3	Q4	
Γ	No	No	No	No	Examp
L	operation	operation	operation	operation	
	No	No	No	No	
L	operation	operation	operation	operation	l B
Exam	nle <sup>.</sup>	HERE	CPFSGT RE	G 0	
	<u>pic.</u>	NGREATER	:	id, 0	А
		GREATER	:		
E	Before Instruc	tion			
	PC		dress (HERE	)	
	W Neter Instructio	= ?			
F	After Instructic				
	PC	= Ad	dress (GREA	TER)	
	If REG PC	≤ W; = Ad	dress (NGRE	ለጥ፹ጋ ነ	
	10	- Au	GIGGG (INGREE	, 111 IV	

FSLI	SLT Compare f with W, Skip if f < W						
ntax:		CPFSLT 1	{,a}				
erand	ds:	$0 \leq f \leq 255$					
		<b>a</b> ∈ [0,1]	<b>a</b> ∈ [0,1]				
eratio	on:	(f) - (W),					
	skip if (f) < (W) (unsigned comparison)						
tuo A	footod		ompanson)				
	Affected:	None					
codin	-		0110 000a ffff ff				
script	tion:	location 'f' t	Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction.				
		contents of instruction i	nts of 'f' are le W, then the f s discarded a	etched and a NOP is			
		two-cycle in	stead, makin istruction.	g this a			
				ank is selected. ed to select the			
rds:		1					
cles:		1(2)					
163.		( )	cles if skip a	nd followed			
		by a	a 2-word instr	uction.			
Cycle	e Activity:						
	Q1	Q2	Q3	Q4			
	Decode	Read	Process	No			
register 'f' Data operation							
skip: Q1		Q2	Q3	Q4			
	No	No	No	No			
C	peration	operation	operation	operation			
skip a	and followed	d by 2-word in	struction:				
	Q1	Q2	Q3	Q4			
_	No	No	No	No			
C	peration No	operation No	operation No	operation No			
c	operation	operation	operation	operation			
L				<u> </u>			
ample	<u>e:</u>	HERE (	CPFSLT REG	, 1			
NLESS : LESS :							
Be	fore Instruc	tion					
PC = Address (HERE)							
Aft	W er Instructio	= ?					
	If REG	< W;					
	PC If REG	= Ad ≥ W;	dress (LESS	3)			
	PC		dress (NLES	SS)			

DAW	Decimal A	djust W Regis	ster	DECF	Decremen	tf			
Syntax:	DAW		Syntax:	DECF f{,	DECF f {,d {,a}}				
Operands:	None		Operands:	$0 \leq f \leq 255$					
Operation:	-	If $[W<3:0> > 9]$ or $[DC = 1]$ , then $(W<3:0>) + 6 \rightarrow W<3:0>$ ;			d ∈ [0,1] a ∈ [0,1]				
	else, $(W<3:0>) \rightarrow W<3:0>;$ If $[W<7:4>>9]$ or $[C = 1]$ , then $(W<7:4>) + 6 \rightarrow W<7:4>;$ C = 1; else, $(W<7:4>) \rightarrow W<7:4>$ C 0000 0000 0000 0111			Operation:	(f) – 1 $\rightarrow$ d	$(f) - 1 \rightarrow dest$			
				Status Affected:	C, DC, N, 0	DV, Z			
				Encoding:	0000	01da ff	ff ffff		
				Description:	result is sto	Decrement register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.			
Status Affected: Encoding:					If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
Description:	DAW adjust resulting fro variables (e and produc result.	es the 8-bit value om the earlier a each in packed es a correct pa	ue in W, addition of two I BCD format)		If 'a' is '0' a set is enab in Indexed mode when <b>Section 29</b>	and the extend led, this instru Literal Offset $J$ never f $\leq$ 95 (5 0.2.3 "Byte-Or	iFh). See		
Words:	1				Literal Off	set Mode" for	details.		
Cycles:	1			Words:	1				
Q Cycle Activity:		~ ~	<b>e</b> (	Cycles:	1				
Q1 Decode	Q2 Read	Q3 Process	Q4 Write	Q Cycle Activity:					
Decode	register W	Data	W	Q1	Q2	Q3	Q4		
Example 1:	DAW		11	Decode	Read register 'f'	Process Data	Write to destination		
Before Instru W	ction = A5h			Example:	DECF	CNT, 1, 0	)		
C DC After Instructi W C DC	= 0 = 0 ion = 05h = 1 = 0			Before Instruc CNT Z After Instructi CNT Z	= 01h = 0				
Example 2: Before Instru C DC After Instructi W C DC	= CEh = 0 = 0			L	Ţ				

DECFSZ	Decrement	t f, Skip if 0		DCF
Syntax:	DECFSZ f	f {,d {,a}}		Synta
Operands:	$0 \le f \le 255$ $d \in [0, 1]$			Oper
Operation:	$a \in [0, 1]$ (f) – 1 → de skip if result			Oper
Status Affected:	None			Statu
Encoding:	0010	11da ffi	ff ffff	Enco
Description:	decremente placed in W	ts of register 'f ed. If 'd' is '0', /. If 'd' is '1', th k in register 'f'	the result is ne result is	Desc
	which is alr and a NOP i	is '0', the nex eady fetched i s executed ins le instruction.		
	-		nk is selected. d to select the	
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	nd the extend ed, this instruct Literal Offset A lever $f \le 95$ (5 .2.3 "Byte-Or ed Instruction set Mode" for	ction operates Addressing Fh). See <b>iented and</b> is in Indexed	
Words:	1			
Cycles:	•	cles if skip an 2-word instru		Word Cycle
Q Cycle Activity:	- <b>j</b> -			
Q1	Q2	Q3	Q4	QC
Decode	Read register 'f'	Process Data	Write to destination	
lf skip:				1
Q1	Q2	Q3	Q4	lf sk
No	No	No	No	
operation If skip and followed	operation	operation	operation	
Q1	Q2	Q3	Q4	lf sk
No	No	No	No	]
operation	operation	operation	operation	
No	No	No	No	
operation	operation	operation	operation	
Example:	HERE CONTINUE	DECFSZ GOTO	CNT, 1, 1 LOOP	Exan
Roforo Instruc				
Before Instruc PC		(HERE)		
After Instruction		,,		
CNT If CNT	= CNT - 1 = 0.	1		
PC	٥,	G (CONTINUE	])	
If CNT PC	<ul><li>≠ 0;</li><li>= Address</li></ul>	6 (HERE + 2	2)	
		, <u> </u>		

F	SNZ	Decrement	f, Skip if Not	0		
nta	ax:	DCFSNZ	f {,d {,a}}			
	ands:	0 ≤ f ≤ 255	() ()- JJ			
.01		d ∈ [0,1] a ∈ [0,1]				
er	ation:	(f) – 1 $\rightarrow$ de skip if result				
atu	s Affected:	None				
со	ding:	0100	11da fff	f ffff		
	ription:	The content decremente placed in W	ts of register 'f ed. If 'd' is '0', t /. If 'd' is '1', th < in register 'f'.	' are he result is		
		instruction v discarded a	is not '0', the i which is alread nd a NOP is ex king it a two-c	ly fetched is recuted		
			ne Access Ban ne BSR is useo			
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
ord	s:	1				
cle	s:	1(2)				
			ycles if skip ar a 2-word instru			
C	ycle Activity:					
1	Q1	Q2	Q3	Q4		
	Decode	Read register 'f'	Process Data	Write to destination		
ski	•	00	00	04		
I	Q1	Q2	Q3	Q4		
	No operation	No operation	No operation	No operation		
ı ski		d by 2-word in:		oporation		
	Q1	Q2	Q3	Q4		
	No	No	No	No		
	operation	operation	operation	operation		
	•		operateri			
	No operation	No operation	No operation	No operation		
an	No	No operation	No operation	No		
	No operation nple: Before Instruc TEMP	No operation HERE I ZERO NZERO tion =	No operation	No operation		
	No operation nple: Before Instruc	No operation HERE I ZERO NZERO tion =	No operation	No operation P, 1, 0		

### 查询PIC18F86K90供应商

GOT	0	Uncondit	Unconditional Branch				
Synta	ax:	GOTO k					
Oper	ands:	$0 \le k \le 10$	48575				
Oper	ation:	$k \rightarrow PC<2$	20:1>				
Statu	s Affected:	None	None				
	oding: vord (k<7:0>) word(k<19:8>)	1110 1111					
Desc	ription:	anywhere range. The PC<20:1>	GOTO allows an unconditional branch anywhere within entire 2-Mbyte memory range. The 20-bit value 'k' is loaded into PC<20:1>. GOTO is always a two-cycle instruction.				
Word	ls:	2					
Cycle	es:	2					
QC	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read literal 'k'<7:0>,		No Read literal operation 'k'<19:8>, Write to PC			
	No operation	No operation	No operat	ion	No operation		
Example: GOTO THERE After Instruction PC = Address (THERE)							

INCF	Increment	f			
Syntax:	INCF f{,	INCF f {,d {,a}}			
Operands:	$0 \leq f \leq 255$				
	d ∈ [0,1] a ∈ [0,1]				
Operation:		ost			
Operation: Status Affected:	(f) + 1 $\rightarrow$ dest C, DC, N, OV, Z				
Encoding:	0010	10da	ffff	ffff	
Description:					
	incremente placed in V	The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'.			
	If 'a' is '0', ' If 'a' is '1', ' GPR bank.	the BSR i			
	If 'a' is '0' a set is enab in Indexed mode when Section 29 Bit-Oriento Literal Off	led, this i Literal Of never f ≤ 9 9.2.3 "Byt ed Instru	nstructio fset Add 95 (5Fh) <b>te-Orien</b> ctions i	n operates ressing . See ted and n Indexed	
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proce Data		Write to estination	
Example:	INCF	CNT,	1, 0		
Before Instruc	tion				
CNT Z	= FFh = 0				
С	- 0 = ? = ?				
DC	•				
After Instructic CNT	on = 00h				
Z	= 0011 = 1				
C DC	= 1 = 1				
	-				

INCFSZ	Increment	f, Skip if 0		INFSNZ
Syntax:	INCFSZ f	{,d {,a}}		Syntax:
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$			Operands
Operation:	(f) + 1 $\rightarrow$ description description (f) + 1 $\rightarrow$ description description (f)			Operation
Status Affected:	None			Status Aff
Encoding:	0011	11da ff	ff ffff	Encoding
Description:	The conten incremente placed in W	ts of register 'f d. If 'd' is '0', t /. If 'd' is '1', th k in register 'f'	f' are he result is ne result is	Descriptic
	which is alm and a NOP i	is '0', the nex eady fetched i is executed ins le instruction.	s discarded	
			nk is selected. d to select the	
	set is enabl in Indexed mode wher Section 29 Bit-Oriente	nd the extend led, this instruc- Literal Offset A never $f \le 95$ (5 .2.3 "Byte-Or ad Instruction set Mode" for	ction operates Addressing Fh). See <b>iented and</b> is in Indexed	
Words:	1			Words:
Cycles:		cycles if skip a a 2-word insti		Cycles:
Q Cycle Activity:	- ,			Q Cycle
Q1	Q2	Q3	Q4	
Decode	Read register 'f'	Process Data	Write to destination	D
If skip:				If skip:
Q1	Q2	Q3	Q4	ı —
No operation	No operation	No operation	No operation	ор
If skip and followe				If skip an
Q1	Q2	Q3	Q4	
No	No	No	No	
operation	operation	operation	operation	ор
No	No	No	No	
operation	operation	operation	operation	ор
Example:	NZERO	INCFSZ CN : :	VT, 1, 0	Example:
Before Instru	ction			Befo
PC		S (HERE)		After
After Instructi CNT	on = CNT + <sup>-</sup>	1		Alter
If CNT	= 0;			
PC If CNT	= Address ≠ 0;	S (ZERO)		
PC		S (NZERO)		

	NZ	Increment f, Skip if Not 0			
nta	ax:	INFSNZ f	{,d {,a}}		
bera	ands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d  \in  [0  , 1] \\ a  \in  [0  , 1] \end{array}$			
bera	ation:	(f) + 1 $\rightarrow$ de skip if result			
atus	s Affected:	None			
ico	ding:	0100	10da fff	f fff	
esci	ription:	incremente placed in W	ts of register 'f d. If 'd' is '0', th ⁄. If 'd' is '1', th < in register 'f'.	ne result is	
		instruction v discarded a	is not '0', the r which is alread nd a NOP is ex king it a two-c	ly fetched is ecuted	
			he Access Bar he BSR is use		
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
ord		1			
/cle			cles if skip and 2-word instru		
Cy	ycle Activity:	00		<u>.</u>	
-	Q1	Q2	Q3	Q4	
	Decode				
	Decoue	Read register 'f'	Process Data	Write to destination	
ski		Read register 'f'	Data	Write to destination	
ski					
ski	ip:	register 'f'	Data	destination	
ski	ip: Q1	register 'f' Q2	Data Q3	destination Q4	
	ip: Q1 No operation	Q2 No	Data Q3 No operation	destination Q4 No	
	ip: Q1 No operation ip and follower Q1	Q2 No operation	Data Q3 No operation	destination Q4 No	
	ip: Q1 No operation ip and followed Q1 No	Q2 No operation d by 2-word ins Q2 No	Data Q3 No operation struction: Q3 No	destination Q4 No operation Q4 No	
	ip: Q1 No operation ip and followed Q1 No operation	Q2 No operation d by 2-word ins Q2 No operation	Data Q3 No operation struction: Q3 No operation	destination Q4 No operation Q4 No operation	
	ip: Q1 No operation ip and follower Q1 No operation No	Q2 No operation d by 2-word ins Q2 No operation No	Data Q3 No operation struction: Q3 No operation No	destinationQ4NoQ4NooperationNooperationNo	
ski	ip: Q1 No operation ip and followed Q1 No operation	Q2 No operation d by 2-word ins Q2 No operation No operation	Data Q3 No operation struction: Q3 No operation No operation	destination Q4 No operation Q4 No operation	
ski [ :am	ip: Q1 No operation ip and followed Q1 No operation No operation	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO	Data Q3 No operation struction: Q3 No operation No operation	destination Q4 No operation Q4 No operation No operation	
ski [ am	ip: Q1 No operation ip and followed Q1 No operation No operation nple: Before Instruct PC After Instruction REG	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO tion = Address on = REG + 1	Data Q3 No operation struction: Q3 No operation No operation	destination Q4 No operation Q4 No operation No operation	
ski [ am	ip: Q1 No operation ip and followed Q1 No operation No operation nple: Before Instruct PC After Instruction REG If REG PC	Q2         No         operation         d by 2-word ins         Q2         No         operation         Ition         =       Address         on	Data Q3 No operation struction: Q3 No operation No operation	destination Q4 No operation Q4 No operation No operation	
ski [ am	ip: Q1 No operation ip and follower Q1 No operation No operation nple: Before Instruction PC After Instruction REG If REG	Register 'f'           Q2           No           operation           d by 2-word ins           Q2           No           operation           No           operation           No           operation           No           operation           HERE           ZERO           NZERO           tion           =           Address           or           =           REG + "           0;	Data Q3 No operation struction: Q3 No operation No operation UNFSNZ REG (HERE) 1 (NZERO)	destination Q4 No operation Q4 No operation No operation	

### 查询PIC18F86K90供应商

IORLW	Inclusive (	OR Litera	l with W	
Syntax:	IORLW k			
Operands:	$0 \le k \le 255$	5		
Operation:	(W) .OR. k	ightarrow W		
Status Affected:	N, Z			
Encoding:	0000	1001	kkkk	kkkk
Description:	The conter 8-bit literal in W.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3		Q4
Decode	Read literal 'k'	Proce Data		/rite to W
Example:	IORLW	35h		

IORWF	Inclusive C	OR W wit	h f		
Syntax:	IORWF f	<sup>-</sup> {,d {,a}}			
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$	d ∈ [0, 1]			
Operation:	(W) .OR. (f	$) \rightarrow dest$			
Status Affected:	N, Z				
Encoding:	0001	00da	ffff	ffff	
Description:	Inclusive O '0', the resu the result is	ult is plac	ed in W. I	f 'd' is '1',	
	If 'a' is '0', t If 'a' is '1', t GPR bank.				
	If 'a' is '0' a set is enabl in Indexed mode wher Section 29 Bit-Oriente Literal Offs	led, this in Literal Of never f ≤ 9 1.2.3 "Byt ed Instru	nstruction fset Addre 95 (5Fh). te-Oriente ctions in	operates essing See ed and Indexed	
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proce Data		Vrite to stination	
Example: Before Instruc		ESULT,	0, 1		

ample:	IC	RWF
Before Instruct	tion	
RESULT	=	13h
W	=	91h
After Instructio	n	
RESULT	=	13h
W	=	93h

Before Instruction W = 9Ah

After Instruction W = BFh

### 查询PIC18F86K90供应商

LFSF	ર	Load FSR	1			
Synta	ax:	LFSR f, k	(			
Oper	ands:	$\begin{array}{l} 0 \leq f \leq 2 \\ 0 \leq k \leq 40 \end{array}$	95			
Oper	ation:	$k\toFSRf$				
Statu	s Affected:	None				
Enco	ding:	1110 1111				
Desc	ription:	The 12-bit literal 'k' is loaded into the file select register pointed to by 'f'.				
Word	ls:	2				
Cycle	es:	2				
QC	ycle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	Read literal 'k' MSB	Proce Data		Write literal 'k' MSB to FSRfH	
	Decode	Read literal 'k' LSB	Proce Data		Vrite literal	
Exan	nple:	LFSR 2,	3ABh			

03h ABh

After Instruction FSR2H FSR2L =

MOVF	Move f				
Syntax:	MOVF f{	d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$	d ∈ [0,1] a ∈ [0,1]			
Operation:	$f \to dest$				
Status Affected:	N, Z				
Encoding:	0101	00da	ffff	ffff	
Description:	The contents of register 'f' are moved to a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'. Location 'f' can be anywhere in the 256-byte bank.				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
	If 'a' is '0' a set is enabl in Indexed mode wher Section 29 Bit-Oriente Literal Offs	ed, this ins Literal Offse ever f ≤ 95 .2.3 "Byte- d Instruct	truction et Addre (5Fh). S Oriente ions in	operate essing See ed and Indexed	
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Process Data		Write W	
Example:		EG, 0, 0			
Before Instruc	tion				

Before Instruction		
REG	=	22h
W	=	FFh
After Instruction		
REG	=	22h
W	=	22h

© 2010 Microchip Technology Inc.

### 查询PIC18F86K90供应商

моу	FF	Move f to f	F				
Synta	ax:	MOVFF f <sub>s</sub>	,f <sub>d</sub>				
Oper	ands:		$\begin{array}{l} 0 \leq f_s \leq 4095 \\ 0 \leq f_d \leq 4095 \end{array}$				
Oper	ation:	$(f_s) \to f_d$					
Statu	s Affected:	None					
	ding: ord (source) vord (destin.)	1100 1111	ffff ffff	ffff ffff	ffff <sub>s</sub> ffff <sub>d</sub>		
Description: The contents of source regis moved to destination register Location of source ' $f_s$ ' can be in the 4096-byte data space FFFh) and location of destin can also be anywhere from FFFh.					"f <sub>d</sub> ". anywhere (000h to ation 'f <sub>d</sub> '		
Either source or destir (a useful special situal					an be W		
		MOVFF is p transferring peripheral i buffer or ar	a data n egister (s	nemory lo such as th	cation to a		
		The MOVFF PCL, TOSU destination	J, TOSH				
Word	ls:	2	2				
Cycle	es:	2					
QC	ycle Activity:						
	Q1	Q2	Q3	5	Q4		
	Decode	Read register 'f' (src)	Proce Data		No peration		
	Decode	No operation No dummy read	No operat		Write egister 'f' (dest)		
Example: MOVFF REG1, REG2 Before Instruction							

Before Instruction		
REG1	=	33h
REG2	=	11h
After Instruction		
REG1	=	33h
REG2	=	33h

MOVLB Move Literal to Low Nibble in					n BSR	
Syntax:	MOVLW I	<b>(</b>				
Operands:	$0 \le k \le 255$	$0 \le k \le 255$				
Operation:	$k \rightarrow BSR$					
Status Affected:	None					
Encoding:	0000	0001	kkk	:k	kkkk	
Description:	The 8-bit literal 'k' is loaded into the Bank Select Register (BSR). The value of BSR<7:4> always remains '0' regardless of the value of $k_7$ : $k_4$ .					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3			Q4	
Decode	Read literal 'k'	Proces Data			te literal to BSR	
Example:	MOVLB	5				
Before Instruct	ion					

02h

05h

BSR Register =

BSR Register =

After Instruction

DS39957B-page 474

### 查询PIC18F86K90供应商

W

=

5Ah

MOVLW	Move Lite	ral to W				
Syntax:	MOVLW	k				
Operands:	$0 \le k \le 255$	5				
Operation:	$k\toW$					
Status Affected:	None					
Encoding:	0000	1110	kkkk kkkk			
Description:	The 8-bit li	The 8-bit literal 'k' is loaded into W.				
Words:	1	1				
Cycles:	1	1				
Q Cycle Activity:						
Q1	Q2	Q3	5	Q4		
Decode	Read literal 'k'	Proce Data		Vrite to W		
Example:	MOVLW	5Ah				
After Instruction						

MOVWF	Move W t	o f			
Syntax:	MOVWF	f {,a}			
Operands:	0 ≤ f ≤ 255 a ∈ [0 , 1]	5			
Operation:	$(W) \to f$				
Status Affected:	None				
Encoding:	0110	111a	ffff	ffff	
Description:	Move data Location 'f 256-byte t	" can be a	0		
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proce Data		Write gister 'f'	
Example:	MOVWF	reg, 0			

uction	
=	4Fh
=	FFh
tion	
=	4Fh
=	4Fh
	= = tion =

© 2010 Microchip Technology Inc.

### 查询PIC18F86K90供应商

MULLW	Multiply Li	iteral with W		MULWF	Multiply W w	rith f	
Syntax:	MULLW	k		Syntax:	MULWF f {	,a}	
Operands:	$0 \le k \le 255$	5		Operands:	$0 \leq f \leq 255$		
Operation:	(W) x k $\rightarrow$ PRODH:PRODL			<b>a</b> ∈ [0,1]			
Status Affected:	None			Operation:	$(W) x (f) \to P$	RODH:PROD	L
Encoding:	0000	1101 kk	kk kkkk	Status Affected:	None		
Description:	out betwee 8-bit literal	'k'. The 16-bit	s of W and the result is	Encoding: Description:	An unsigned between the	contents of W	is carried out and the
	<ul><li>placed in the PRODH:PRODL register</li><li>pair. PRODH contains the high byte.</li><li>W is unchanged.</li><li>None of the Status flags are affected.</li><li>Note that neither Overflow nor Carry is</li><li>possible in this operation. A Zero result</li><li>is possible but not detected.</li></ul>		0		stored in the	PRODH:PRO	•
				<ul> <li>pair. PRODH contains the high byte. Both W and 'f' are unchanged.</li> <li>None of the Status flags are affected.</li> <li>Note that neither Overflow nor Carry is possible in this operation. A Zero result is possible but not detected.</li> </ul>			
Words:	1				If 'a' is '0' the	Access Ban	k is selected. If
Cycles: Q Cycle Activity:	1				'a' is '1', the E GPR bank.		
Q1 Decode	Q2 Read	Q3 Process	Q4 Write		If 'a' is '0' and is enabled, th		l instruction se operates in
	literal 'k'	Data	registers PRODH: PRODL		Indexed Liter whenever f ≤ Section 29.2 Bit-Oriented	95 (5Fh). See <b>.3 "Byte-Orie</b>	ented and
Example:	MULLW	0C4h			Literal Offse	t Mode" for d	etails.
Before Instruc		00111		Words:	1		
W	= E2	2h		Cycles:	1		
PRODH PRODL	= ? = ?			Q Cycle Activity:			
After Instructio	=			Q1	Q2	Q3	Q4
W PRODH PRODL	= E2 = AI = 08	Dh		Decode	Read register 'f'	Process Data	Write registers PRODH: PRODL
				Example:	MULWF	REG, 1	
				Before Instru	uction		

 $\begin{array}{rrrr} \text{Before Instruction} \\ W & = & \text{C4h} \\ \text{REG} & = & \text{B5h} \\ \text{PRODH} & = & ? \\ \text{PRODL} & = & ? \\ \text{After Instruction} \\ W & = & \text{C4h} \\ \text{REG} & = & \text{B5h} \\ \text{PRODH} & = & \text{8Ah} \\ \text{PRODL} & = & 94h \\ \end{array}$ 

### 查询PIC18F86K90供应商

NEGF	Negate f				
Syntax:	NEGF f {,a}				
Operands:	$0 \leq f \leq 255$				
	<b>a</b> ∈ [0,1]				
Operation:	$(f) + 1 \rightarrow f$				
Status Affected:	N, OV, C, DC, Z				
Encoding:	0110 110a ffff ffff				
Description:	Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'.				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

Q1	Q2	Q3	Q4		
Decode	Read	Process	Write		
	register 'f'	Data	register 'f'		

Example:	NEGF	REG,	1
----------	------	------	---

Before Instru	ction			
REG	=	0011	1010	[3Ah]
After Instructi	on			
REG	=	1100	0110	[C6h]

NOP	NOP No Operation						
Synta	ax:	NOP					
Oper	ands:	None					
Oper	ation:	No operati	on				
Status Affected: None							
Encoding:		0000	0000	000	0	0000	
		1111	xxxx	XXX	x	xxxx	
Desc	ription:	No operati	on.				
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q	3		Q4	
	Decode	No	No			No	
		operation	operation operation				

Example:

None.

POP		Рор Тор о	f Return	Stack	Ĩ	
Synta	ax:	POP				
Oper	ands:	None				
Oper	ation:	$(TOS) \rightarrow b$	it bucket			
Statu	is Affected:	None				
Enco	oding:	0000	0000	000	0	0110
Desc	ription:	The TOS v stack and i then becon was pushe This instruc the user to stack to inc	s discard nes the p d onto the ction is pr properly	ed. Th reviou e retur rovideo mana	ne T( is va n sta d to ge th	DS value lue that ack. enable ne return
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	5		Q4
	Decode	No operation	POP T valu		ор	No eration
Exan	nple:	POP GOTO	NEW			
	Before Instruc TOS Stack (1	tion level down)		031A2 014332		
	After Instructio TOS PC	n		)14332 NEW	2h	

PUSH	Push Top o	of Ret	urn Stac	k	
Syntax:	PUSH				
Operands:	None				
Operation:	$(PC + 2) \rightarrow$	TOS			
Status Affected:	None				
Encoding:	0000	0000	000	00	0101
Description:	The PC + 2 the return s value is pus This instruc software sta then pushin	tack. shed d tion a ack by	The prev lown on t llows imp modifyir	ious the s blem ng T(	TOS stack. enting a OS and
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2		Q3		Q4
Decode	PUSH PC + 2 onto return stack		No ration	ор	No eration
Example:	PUSH				
Before Instru TOS PC	ction	= =	345Ah 0124h		
After Instructi PC TOS	on	=	0126h		

### 查询PIC18F86K90供应商

RCA	LL	Relative C	all		
Synta	ax:	RCALL r	I		
Oper	ands:	-1024 ≤ n :	≤ 1023		
Oper	ation:	(PC) + 2 (PC) + 2 +	,	;	
Statu	s Affected:	None			
Enco	ding:	1101	1nnn	nnr	in nnnn
2000	ription:	address (F stack. The	urrent loc. PC + 2) is n, add the n' to the P mented to the new n. This in	ation. pushe e 2's c C. Sin o fetch addre	First, return ed onto the omplement ce the PC will the next ss will be
Word	ls:	1			
Cycle	es:	2			
QC	ycle Activity:				
	Q1	Q2	Q3	3	Q4
	Decode	Read literal 'n' PUSH PC	Proce Data		Write to PC

RESET		Reset			
Syntax:		RESET			
Operand	ds:	None			
Operatio	on:	Reset all re affected by	·		
Status A	ffected:	All			
Encodin	g:	0000	0000	111	1 1111
Descript	ion:	This instruction provides a way to execute a MCLR Reset in software.			
Words:		1			
Cycles:		1			
Q Cycle	e Activity:				
	Q1	Q2	Q3	}	Q4
I	Decode	Start reset	No operat		No operation

Example:

-	Instruction	

After Instruction	
Registers =	Reset Value
Flags* =	Reset Value

RESET

Example: HERE RCALL Jump

to stack

No

operation

No

operation

No

operation

Before Instruction

No

operation

PC = Address (HERE) After Instruction PC = TOS= Address (Jump) Address (HERE + 2)

RET	FIE	Return from	m Interrupt		
Synta	ax:	RETFIE {s	;}		
Opera	ands:	$s \in [0,1]$			
Opera	ation:	if s = 1, (WS) $\rightarrow$ W, (STATUSS) (BSRS) $\rightarrow$	$\stackrel{\text{IEH or PEIE}}{\to} \text{STATUS}$	),	nged
Statu	s Affected:	GIE/GIEH,	PEIE/GIEL.		
Enco	ding:	0000	0000 0	001	000s
Desc	ription:	and Top-of- the PC. Inte setting eithe global intern contents of STATUSS a their corres STATUS an	n interrupt. S Stack (TOS errupts are e er the high c rupt enable the shadow and BSRS a ponding reg ad BSR. If 's gisters occur	is loa nablec r low-p bit. If 's registe re load isters \ = 0, n	ded into I by priority s' = 1, the ers WS, led into <i>N</i> ,
Word	s.	1	,		
Cycle		2			
	vcle Activity:	-			
u o	Q1	Q2	Q3		Q4
	Decode	No operation	No operation	fro Set	OP PC m stack GIEH or GIEL
	No operation	No operation	No operation	ор	No peration
<u>Exam</u>	After Interrupt PC W BSR STATUS	RETFIE	= TOS = WS = BSR		

RETLW	Return Lite	eral to W		
Syntax:	RETLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow W$ , (TOS) $\rightarrow P0$	C,		
	PCLATU, P	CLATH a	re uncha	nged
Status Affected:	None			
Encoding:	0000	1100	kkkk	kkkk
Description:	W is loaded program co of the stack high addres unchanged.	unter is lo (the retui s latch (P	aded fro m addres	m the to ss). The
Words:	1			
Cycles:	2			
Q Cycle Activity:				
Q1	Q2	Q3		Q4
Decode	Read literal 'k'	Proces Data	fro	OP PC m stack, ite to W
No	No	No		No
operation	operation	operatio	on op	peration
Example:				
CALL TABLE	; W contai ; offset v ; W now ha ; table va	value As	le	
: TABLE				
ADDWF PCL	; W = offs	set		
RETLW k0	; Begin ta	able		
RETLW k1 : :	;			

iction	
=	07h
tion	
=	value of kn
	= tion

### 查询PIC18F86K90供应商

RETUR	RN	Return from	m Subro	utine	
Syntax		RETURN	{s}		
Opera	nds:	$s \in [0,1]$			
Operat	ion:	$(TOS) \rightarrow Prif s = 1,$ $(WS) \rightarrow W,$ (STATUSS) $(BSRS) \rightarrow PCLATU, Prif Prif (STATU, Prif (STATU, Prif (STATU, Prif (STATU))))$	$\rightarrow$ STAT	·	hanged
Status	Affected:	None			
Encodi	ing:	0000	0000	0001	001s
		popped and is loaded in 's'= 1, the c registers W loaded into registers W 's' = 0, no c occurs.	to the pre- contents S, STATI their cor , STATU	ogram of of the sl USS an respond S and E	counter. If hadow d BSRS are ding BSR. If
Words	:	1			
Cycles	:	2			
Q Cyc	le Activity:				
	Q1	Q2	Q3	3	Q4
	Decode	No	Proce	ess	POP PC
		operation	Data	a	from stack
	No operation	No operation	No operat		No operation

RETURN

After Instruction: PC = TOS

RLCF	Rotate Left	T throug		
Syntax:	RLCF f {	,d {,a}}		
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d  \in  \left[ 0 \; , 1 \right] \end{array}$			
	<b>a</b> ∈ [0,1]			
Operation:	$(f < n >) \rightarrow de$ $(f < 7 >) \rightarrow C,$ $(C) \rightarrow dest <$		₹,	
Status Affected:	C, N, Z			
Encoding:	0011	01da	ffff	ffff
Description:	The content one bit to th If 'd' is '0', th is '1', the res 'f'.	e left thro ne result i	ugh the s place	e Carry flag ed in W. If 'd
	lf 'a' is '0', th If 'a' is '1', th GPR bank.			
	If 'a' is '0' ar set is enable			
	in Indexed L mode when Section 29. Bit-Oriente Literal Offs	₋iteral Off ever f ≤ 9 2.3 "Byte d Instruc	set Add 5 (5Fh) e-Orier tions i	dressing ). See nted and n Indexed
	mode when Section 29. Bit-Oriente	Literal Off ever f ≤ 9 2.3 "Byte d Instruc et Mode'	set Add 5 (5Fh) e-Orier tions i	dressing ). See nted and in Indexed tails.
Words:	mode when Section 29. Bit-Oriente Literal Offs	Literal Off ever f ≤ 9 2.3 "Byte d Instruc et Mode'	set Add 5 (5Fh) <b>-Orier</b> tions i ' for de	dressing ). See nted and in Indexed tails.
	mode when Section 29. Bit-Oriente Literal Offs	Literal Off ever f ≤ 9 2.3 "Byte d Instruc et Mode'	set Add 5 (5Fh) <b>-Orier</b> tions i ' for de	dressing ). See nted and in Indexed tails.
Cycles:	mode when Section 29. Bit-Oriente Literal Offs	Literal Off ever f ≤ 9 2.3 "Byte d Instruc et Mode'	set Add 5 (5Fh) <b>-Orier</b> tions i ' for de	dressing ). See nted and in Indexed tails.
	mode when Section 29. Bit-Oriente Literal Offs	Literal Off ever f ≤ 9 2.3 "Byte d Instruc et Mode'	set Add 5 (5Fh e-Orier tions i ' for de	dressing ). See nted and in Indexed tails.
Cycles: Q Cycle Activity:	mode when Section 29. Bit-Oriente Literal Offs 1 1 2 Q2 Read	Literal Off: ever f ≤ 9 2.3 "Byte d Instruc et Mode'      Q3 Proce	set Add 5 (5Fh) <b>-Orier</b> <b>tions i</b> ' for de egister t	dressing ). See <b>hted and</b> <b>in Indexed</b> trails. f Q4 Write to
Cycles: Q Cycle Activity: Q1	mode when Section 29. Bit-Oriente Literal Offs 1 1 2 2	Literal Off: ever f ≤ 9 2.3 "Byte d Instruc et Mode'  Re Q3	set Add 5 (5Fh) <b>-Orier</b> <b>tions i</b> ' for de egister t	dressing ). See nted and in Indexed tails. f Q4
Cycles: Q Cycle Activity: Q1	mode when Section 29. Bit-Oriente Literal Offs 1 1 2 Q2 Read	Literal Offi ever f ≤ 9 2.3 "Byte d Instruc et Mode' - re Q3 Proce Data	set Add 5 (5Fh) <b>-Orier</b> <b>tions i</b> ' for de egister t	Aressing ). See hted and in Indexed datails. f Q4 Write to destination
Cycles: Q Cycle Activity: Q1 Decode	mode when Section 29. Bit-Oriente Literal Offs C 1 1 1 2 Q2 Read register 'f' RLCF tion = 1110 = 0	Literal Off: ever f ≤ 9 2.3 "Byte d Instruc et Mode'	set Add 5 (5Fh <b>e-Orier</b> tions i ' for de egister f	Aressing ). See hted and in Indexed datails. f Q4 Write to destination

RLN	CF	Rotate Left f (No Carry)					
Synta	ax:	RLNCF	f {,d {,a}}				
Oper	ands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$					
Oper	ation:		$(f < n >) \rightarrow dest < n + 1 >,$ $(f < 7 >) \rightarrow dest < 0 >$				
Statu	s Affected:	N, Z	N, Z				
Enco	ding:	0100	01da ff:	ff ffff			
Desc	ription:	one bit to t is placed ir	The contents of register 'f' are rotated one bit to the left. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.				
			he Access Bai he BSR is use				
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
		-	register f				
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3	Q4			
	Decode	Read register 'f'	Process Data	Write to destination			
Exan	nple:	RLNCF	REG, 1,	0			
	Before Instruc REG After Instructic	= 1010 1	.011				
	REG	= 0101 C	0111				

Syntax:			tate Rig		<u> </u>	<u></u>	
Onoran		RR	CF f{	,d {,a}}			
Operan	ids:	$0 \leq f \leq 255$					
			[0,1]				
<b>•</b>			[0,1]				
Operati	on:	(f<	$(n>) \rightarrow 0$ $(0>) \rightarrow 0$ $(a) \rightarrow des$		L>,		
Statua	Affected	. ,	N, Z				
	Affected:	_		0.0.1		6	
Encodii Descrip	0		0011	00da	fff		fff
		flao If 'o	g. lf 'd' is	he right t s '0', the r the resul	esult is	s plac	ced in
		lf 'a		the Acce the BSR			
		Bit	-Orient eral Off	9.2.3 "By ed Instru set Mod	e" for c	<b>in I</b> detai	ndexe
			► C	-	egister		
					0	t	<b></b> >
Words:		1		<u> </u>	0	t	]->
Words: Cycles:		1 1				t	<u>]</u> →
Cycles:	le Activity:					<u>†</u>	]-•
Cycles:		1	Q2	Q		†	<b>→</b> Q4
Cycles:	le Activity:	1 R	Q2 ead ster 'f'	Q: Proce Dat	3 ess	W	rite to
Cycles:	le Activity: Q1	1 R	ead	Proce	3 ess	W	
Cycles: Q Cycl	le Activity: Q1 Decode le:	1 R regi	ead ster 'f'	Proce Dat	3 ess	W des	rite to
Cycles: Q Cycl	le Activity: Q1 Decode le: efore Instruc	1 R regi <sub>RR</sub>	ead ster 'f' CF	Proce Dat	3 ess a	W des	rite to
Cycles: Q Cycl	le Activity: Q1 Decode le:	1 R regi	ead ster 'f'	Proce Dat	3 ess a	W des	rite to
Cycles: Q Cycl Exampl Be	le Activity: Q1 Decode le: efore Instruc REG	1 R regi RR tion = =	ead ster 'f' CF 1110	Proce Dat REG, 0110	3 ess a	W des	rite to

RRNCF	Rotate Riç	ght f (No Carry	()			
Syntax:	RRNCF	f {,d {,a}}				
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d  \in  [0  ,  1] \\ a  \in  [0  ,  1] \end{array}$					
Operation:	$(f < n >) \rightarrow dest < n - 1 >,$ $(f < 0 >) \rightarrow dest < 7 >$					
Status Affected:	N, Z					
Encoding:	0100	0100 00da ffff ffff				
Description:	The contents of register 'f' are rotate one bit to the right. If 'd' is '0', the res is placed in W. If 'd' is '1', the result i placed back in register 'f'.					
	If 'a' is 'o', the Access Bank will be selected, overriding the BSR value. If is '1', then the bank will be selected a per the BSR value.					
	If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
		<ul> <li>register</li> </ul>	r f 🗕 🏲			
Words:		<ul> <li>register</li> </ul>	r f 📕 🍝			
Words: Cycles:	1 1	► registe	r f			
Cycles:		► register	r f			
		Q3	rf Q4			
Cycles: Q Cycle Activity:	1					
Cycles: Q Cycle Activity: Q1	1 Q2 Read	Q3 Process	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instruct REG	1 Q2 Read register 'f' RRNCF tion = 1101	Q3 Process Data	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instruct	1 Q2 Read register 'f' RRNCF etion = 1101 on	Q3 Process Data REG, 1, 0 0111	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instruct REG After Instruction	1 Q2 Read register 'f' RRNCF tion = 1101 on = 1110	Q3 Process Data REG, 1, 0 0111	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instruct REG After Instruction REG	1 Q2 Read register 'f' RRNCF tion = 1101 RRNCF tion = ? = 1101	Q3 Process Data REG, 1, 0 0111 1011 REG, 0, 0	Q4 Write to			

SETF	Set f		
Syntax:	SETF f {,a	a}	
Operands:	0 ≤ f ≤ 255	•	
	<b>a</b> ∈ [0,1]		
Operation:	$FFh\tof$		
Status Affected:	None		
Encoding:	0110	100a ff:	ff ffff
Description:	The content are set to F	ts of the speci Fh.	fied register
	,	he Access Bai he BSR is use	nk is selected. d to select the
If 'a' is '0' and the extended instru set is enabled, this instruction ope in Indexed Literal Offset Addressi mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented a Bit-Oriented Instructions in Inde Literal Offset Mode" for details			
Words:	1		
Cycles:	1		
Q Cycle Activity:			
Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'
Example:	SETF	REG,1	
Before Instruct REG	= 5A	h	
After Instructic REG	n = FF	h	

### 查询PIC18F86K90供应商

SLE	EP	Enter Sle	ep Mode				
Synt	ax:	SLEEP					
Oper	ands:	None					
Oper	ation:						
Statu	is Affected:	TO, PD					
Enco	oding:	0000	0000	000	0	0011	
Desc	Description: The Power-Down status bit (PD) cleared. The Time-out status bit ( is set. The Watchdog Timer and i postscaler are cleared.				bit (TO)		
		•	The processor is put into Sleep mode with the oscillator stopped.				
Word	ds:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3			Q4	
	Decode	No operation	Proce: Data			Go to Sleep	
$\begin{array}{ c c c c c c }\hline & operation & Data & Sleep \\ \hline \hline Example: & SLEEP \\ Before Instruction \\ \hline \hline TO & = & ? \\ \hline PD & = & ? \\ \hline After Instruction \\ \hline \hline TO & = & 1 \uparrow \\ \hline PD & = & 0 \\ \hline \end{array}$							
† If	WDT causes v	wake-up, this I	oit is clea	red.			

a ∈ [0,1] Operation:  $(W) - (f) - (\overline{C}) \rightarrow dest$ N, OV, C, DC, Z Status Affected: Encoding: 0101 01da ffff ffff Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored in register 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank. If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever  $f \le 95$  (5Fh). See Section 29.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q3 Q4 Q1 Q2 Decode Read Process Write to register 'f' Data destination Example 1: SUBFWB REG, 1, 0 **Before Instruction** REG = 3 W 2 1 = = After Instruction REG = FF 2 0 W = C Z N = = 0 = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 **Before Instruction** REG = 2 5 1 Ŵ = С = After Instruction REG 2 3 W = C Z = 1 0 = N ; result is positive = 0 SUBFWB Example 3: REG, 1, 0 Before Instruction REG = 1 2 0 W = С = After Instruction REG W C Z N 0 2 = = 1 = = ; result is zero 1 =

Subtract f from W with Borrow

SUBFWB f {,d {,a}}

 $0 \leq f \leq 255$ 

 $d \in [0, 1]$ 

SUBFWB

Operands:

Syntax:

DS39957B-page 484

SUBLW		iteral.			
$0 \le k \le 2$					
	$Operands: \qquad 0 \le k \le 255$				
Operation: $k - (W) \rightarrow W$					
N, OV, C	, DC, Z				
0000	1000	kkk	k	kkkk	
1					
1					
Q2	Q3			Q4	
Read literal 'k'			W	/rite to W	
SUBLW	02h				
on					
= 01h					
= 01h	01h 1 ; result is positive				
SUBLW	02h				
on = 02h = ?					
= 00h	; result is z	zero			
SUBLW	02h				
on = 03h = ? • = FFh = 0	; (2's comj ; result is r	oleme	nt)		
	W is sub literal 'k'. 1 Read literal 'k' SUBLW on = 01h = 0 SUBLW on = 02h = 02h = 1 = 1 = 0 SUBLW on = 02h = 1 = 0 SUBLW on = 03h = ?	W is subtracted from literal 'k'. The result 1 1 1 2 2 2 3 8 2 3 8 2 3 3 8 2 3 3 3 3 3 3 3	W is subtracted from the literal 'k'. The result is pla 1 1 1 <u>Q2</u> <u>Q3</u> <u>Read</u> <u>Process</u> <u>literal 'k'</u> <u>Data</u> <u>SUBLW</u> 02h 0 = 01h = 01h = 1; result is positive 0 SUBLW 02h 0 = 02h = 02h = 02h = 1; result is zero = 1 = 0 SUBLW 02h 0 = 2 SUBLW 02h	W is subtracted from the 8-bi literal 'k'. The result is placed 1 1 1 <u>Q2 Q3</u> <u>Read Process W</u> <u>literal 'k' Data</u> <u>SUBLW 02h</u> on = 01h = 1 ; result is positive = 0 <u>SUBLW 02h</u> on = 02h = ? = 00h = 1 ; result is zero = 1 = 0 <u>SUBLW 02h</u> on = 02h = ?	

SUB	WF	Subtract	w	from f		
Synta	ax:	SUBWF	f {	.d {.a}}		
Opera		0 ≤ f ≤ 25		, (,))		
opon		d ∈ [0,1] a ∈ [0,1]				
Opera	ation:	(f) – (W)	$\rightarrow$ C	lest		
Statu	s Affected:	N, OV, C, DC, Z				
Enco	ding:	0101 11da ffff ffff				
Desc	ription:	Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.				
			', th	e Access Bank e BSR is used		
		set is ena in Indexe mode wh Section Bit-Orien	able ed Li iene 29.2 ntec	d the extended d, this instructi iteral Offset Ad ever f ≤ 95 (5Fh 2.3 "Byte-Orie d Instructions et Mode" for de	on operates dressing i). See nted and in Indexed	
Word	s:	1				
Cycle	s:	1				
QC	cle Activity:					
_	Q1	Q2		Q3	Q4	
	Decode	Read register	'f'	Process Data	Write to destination	
Exam	nple 1:	SUBWE	ŗ	REG, 1, 0		
	Before Instruc	tion				
	REG W	= 3 = 2 = ?				
	C	= 2				
	After Instructio					
	REG W	= 1 = 2				
	С	= 1	; r	result is positive	е	
	Z N	= 0 = 0				
Exam	<u>nple 2:</u>	SUBWE	7	REG, 0, 0		
	Before Instruc	tion				
	REG W	= 2 = 2 = ?				
	C	= 2				
4	After Instructio					
	REG W	= 2 = 0				
	С	= 1	; r	result is zero		
	Z N	= 1 = 0				
Exam	nple 3:	SUBWE	7	REG, 1, 0		
	Before Instruc	tion				
	REG W	= 1 = 2				
	C	= 2				
	After Instructio			<b>o</b> l (		
	REG W	= FFh = 2	;(	2's complemer	it)	
	С	= 0	; r	esult is negativ	/e	
	Z N	= 0 = 1				

SUBWFB	Subtract V	/ from f with Borrow	SWA				
Syntax:	SUBWFB	SUBWFB f {,d {,a}}					
Operands:	$0 \leq f \leq 255$	$0 \leq f \leq 255$					
	d ∈ [0,1] a ∈ [0,1]						
Operation:	a ∈ [0, ⊥] (f) – (W) – (	$\overline{(C)}$ dest					
Status Affected:	., . ,	Opera					
Encoding:	0101	OV, C, DC, Z 0101 10da ffff fff					
Description:		and the Carry flag (be					
Description.		er 'f' (2's complement					
	method). If	'd' is '0', the result is a					
		s '1', the result is store	d back				
	in register '						
		he Access Bank is se he BSR is used to sel					
	GPR bank.						
	<b>lf 'a' is '</b> 0' a	nd the extended instru	uction				
		ed, this instruction op					
		Literal Offset Address	0				
		ever f ≤ 95 (5Fh). See .2.3 "Byte-Oriented a					
		ed Instructions in Inc					
	Literal Off	set Mode" for details.					
Words:	1		\A/ord				
Cycles:	1		Word				
Q Cycle Activity:			Cycle				
Q1	Q2		Q4 QCy				
Decode	Read register 'f'		te to nation				
Example 1:	SUBWFB	REG, 1, 0					
Before Instruc		1120 / 2 / 0	-				
REG	= 19h	(0001 1001)	Exam				
W C	= 0Dh = 1	(0000 1101)	I				
After Instruction							
REG W							
С	= 0Ch = 0Dh	(0000 1011)	,				
Z	= 0Dh = 1	(0000 1011) (0000 1101)	,				
N	= 0Dh = 1 = 0	(0000 1101)	,				
N	= 0Dh = 1 = 0 = 0		,				
	<pre>= 0Dh = 1 = 0 = 0 SUBWFB</pre>	(0000 1101); result is positive	,				
N Example 2: Before Instruc REG	= 0Dh = 1 = 0 = 0 SUBWFB stion = 1Bh	(0000 1101) ; result is positive REG, 0, 0 (0001 1011)	,				
N Example 2: Before Instruc	= 0Dh = 1 = 0 = 0 SUBWFB	(0000 1101) ; result is positive REG, 0, 0	,				
N Example 2: Before Instruct REG W C After Instructed	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010)	,				
N <u>Example 2:</u> Before Instruct REG W C After Instruction REG	= 0Dh = 1 = 0 = 0 SUBWFB tion = 1Bh = 1Ah = 0 on = 1Bh	(0000 1101) ; result is positive REG, 0, 0 (0001 1011)	,				
N Example 2: Before Instruct W C After Instruction REG W C	= 0Dh = 1 = 0 SUBWFB stion = 1Bh = 1Ah = 0 on = 1Bh = 00h = 1	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011)	,				
N <u>Example 2:</u> Before Instruct REG W C After Instructio REG W	= 0Dh = 1 = 0 = 0 SUBWFB ettion = 1Bh = 1Ah = 0 con = 1Bh = 00h	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010)	,				
N Example 2: Before Instruct W C After Instruction REG W C Z	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 00h = 1 = 1	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011)	,				
N Example 2: Before Instruct W C After Instruction REG W C Z N	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 0 00h = 1 = 1 = 0 SUBWFB	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011) ; result is zero					
N Example 2: Before Instruct W C After Instruction REG W C Z N Example 3: Before Instruct REG	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 0 00h = 1 = 1 = 0 SUBWFB etion = 03h	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1011) ; result is zero REG, 1, 0 (0000 0011)					
N Example 2: Before Instruct REG W C After Instruction REG W C Z N Example 3: Before Instruct	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 1 = 0 SUBWFB etion	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011) ; result is zero REG, 1, 0					
N Example 2: Before Instruct REG W C After Instruction REG W Example 3: Before Instruct REG W C After Instruction REG W C After Instruction REG M C After Instruction REG M C After Instruction REG M C After Instruction REG M C After Instruction REG M C After Instruction REG M C After Instruction C Z N Example 3: REG M C After Instruction REG M C After Instruction After Instruction C After Instruction After Instruction C After Instruction C After Instruction After Instruction Af	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 1 = 0 SUBWFB etion = 03h = 0Eh = 1 on	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011) ; result is zero REG, 1, 0 (0000 0011) (0000 1101)					
N Example 2: Before Instruct REG W C After Instruction REG W Example 3: Before Instruct REG W C C Z N	= 0Dh = 1 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 00h = 1 = 1 = 0 SUBWFB etion = 03h = 03h = 1	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011) ; result is zero REG, 1, 0 (0000 0011) (0000 1101) (1111 0100)					
N Example 2: Before Instruct REG W C After Instruction REG W Example 3: Before Instruction REG W C After Instruction REG W C M C M C M M C M M M M M M M M M M M M M	= 0Dh = 1 = 0 = 0 SUBWFB etion = 1Bh = 1Ah = 0 on = 1Bh = 0 = 1 = 0 SUBWFB etion = 0Sh = 1 = 0 SUBWFB etion = 0Sh = 1 = 0 = 0 = 0 = 0 = 0 = 0 = 0 = 0 = 0 = 0	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011) ; result is zero REG, 1, 0 (0000 0011) (0000 1101)					
N Example 2: Before Instruct REG W C After Instruction REG W Example 3: Before Instruct REG W C After Instruction REG W C After Instruction REG	= 0Dh = 1 = 0 SUBWFB ettion = 1Bh = 1Ah = 0 on = 1Bh = 0 SUBWFB ettion = 0 SUBWFB ettion = 0 SUBWFB = 1 = 0 SUBWFB = 1 = 0 = 0 = 0 = 1Bh = 0 = 0 = 0 = 0 = 1Bh = 0 = 0 = 0 = 0 = 0 = 1Bh = 0 = 0 = 0 = 0 = 0 = 1Bh = 0 = 0 = 0 = 0 = 0 = 0 = 1Bh = 0 = 0 = 0 = 0 = 0 = 0 = 0 = 0	(0000 1101) ; result is positive REG, 0, 0 (0001 1011) (0001 1010) (0001 1011) ; result is zero REG, 1, 0 (0000 0011) (0000 1101) (1111 0100) ; [2's comp]					

SWAPF	Swap f				
Syntax:	SWAPF f	{,d {,a}}			
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d  \in  [0,1] \\ a  \in  [0,1] \end{array}$	d ∈ [0,1]			
Operation:	$(f<3:0>) \rightarrow$ $(f<7:4>) \rightarrow$				
Status Affected:	None				
Encoding:	0011	10da	ffff	ffff	
Description:	'f' are excha is placed in	The upper and lower nibbles of register 'f' are exchanged. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed in register 'f'.			
	,			is selected. to select the	
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proce Data		Write to destination	
Example: SWAPF REG, 1, 0 Before Instruction REG = 53h After Instruction REG = 35h					

Table Read (Continued)

TBLRD

#### 查询PIC18F86K90供应商

TBLRD	)	Table Read					
Syntax	:	TBLRD ( *; *+; *-; +*)					
Operar	nds:	None					
Operat		None if TBLRD *, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT, TBLPTR – No Change; if TBLRD *+, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT, (TBLPTR) + 1 $\rightarrow$ TBLPTR; if TBLRD *-, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT, (TBLPTR) – 1 $\rightarrow$ TBLPTR;					
		if TBLRD +*					
		(TBLPTR) +	·1 –	> TBL	PTR,		<b>-</b>
<u>.</u>		(Prog Mem	(IBL	PIR)	$) \rightarrow 1$	ABLA	.1
	Affected:	None			1		r
Encodi	ng:	0000	00	000	000	00	10nn nn=0 * =1 *- =2 *- =3 + <sup>3</sup>
Descrip	otion:	This instruction is used to read the con of Program Memory (P.M.). To address program memory, a pointer called Table Pointer (TBLPTR) is used.					dress the
		The TBLPT each byte in has a 2-Mby	the	progr	am me	emory	
		TBLPTR<0> = 0:Least Significant Byte of Program Memory Word					
		TBLPTR<0> = 1:Most Significant Byte of Program Memory Word					
		The TBLRD instruction can modify the value of TBLPTR as follows:					
		<ul> <li>no chang</li> </ul>	е				
		<ul> <li>post-incre</li> </ul>	emer	nt			
		post-decrement					
		pre-increment					
Words:		1					
Cycles	:	2					
Q Cyc	le Activity	:					
-	Q1	Q2		G	23		Q4
	Decode	No operation		N opera		ор	No eration

Example 1:	TBLRD	*+	;	
Before Instruction	on			
TABLAT TBLPTR			=	55h 00A356h
MEMORY	• •	)	=	34h
After Instruction	l			
TABLAT			=	34h
TBLPTR			=	00A357h
Example 2:	TBLRD	+*	;	
Before Instruction	on			
TABLAT			=	AAh
TBLPTR			=	01A357h
MEMORY	(01A357h)	)	=	1211
MEMORY	•	)	=	34h
After Instruction				
TABLAT			=	34h
TBLPTR			=	01A358h

No operation (Read Program

Memory)

No

operation

No operation (Write TABLAT)

No

operation

### 查询PIC18F86K90供应商

TBLWT	Table Wri	te						
Syntax:	TBLWT ( *; *+; *-; +*)							
Operands:	None							
Operation:	if TBLWT*, (TABLAT) $\rightarrow$ Holding Register, TBLPTR – No Change; if TBLWT*+, (TABLAT) $\rightarrow$ Holding Register, (TBLPTR) + 1 $\rightarrow$ TBLPTR; if TBLWT*-, (TABLAT) $\rightarrow$ Holding Register, (TBLPTR) – 1 $\rightarrow$ TBLPTR; if TBLWT+*, (TBLPTR) + 1 $\rightarrow$ TBLPTR, (TABLAT) $\rightarrow$ Holding Register							
Statua Affaatad	. ,		y iteyistei					
Status Affected: Encoding:	0000	0000	0000	11nn nn=0 * =1 *+ =2 *- =3 +*				
Description:	This instruction uses the 3 LSBs of TBLPTR to determine which of the 8 holding registers the TABLAT is written to. The holding registers are used to program the contents of Program Memory (P.M.). (Refer to Section 6.0 "Memory Organization" for additional details on programming Flash memory.) The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR has a 2-Mbyte address range. The LSb of the TBLPTR selects which byte of the program memory location to access.							
	TBLPT			nificant Byte n Memory				
	TBLPT			ificant Byte n Memory				
	<ul> <li>Word</li> <li>The TBLWT instruction can modify the value of TBLPTR as follows:</li> <li>no change</li> <li>post-increment</li> </ul>							
		crement						
	<ul> <li>pre-incr</li> </ul>	rement						
Words:	1							
Cycles:	2							
Q Cycle Activity:	_							
	Q1	Q2	Q3	Q4				
	Decode	No operation	No operation	No operation				
	No	No	No	No				
		operation		operation				

(Read

TÀBLAT)

Example 1:	TBLWT	•

Example 1:	TBLWT *+;		
Before Instru	ction		
TABLAT TBLPTF HOLDIN		= =	55h 00A356h
(00A356		=	FFh
After Instruct	ions (table write	comp	letion)
		= =	55h 00A357h
(00A350		=	55h
Example 2:	TBLWT +*;		
Before Instru	ction		
TABLAT	-	=	34h
TBLPT		=	01389Ah
(01389/	NG REGISTER Ah) NG REGISTER	=	FFh
(013896		=	FFh
After Instruct	ion (table write c	omple	etion)
TABLAT		=	34h
	R NG REGISTER	=	01389Bh
(01389/		=	FFh
(013898		=	34h

(Write to Holding

Register)

TSTFSZ		Test f, Skip	o if O			
Syntax:		TSTFSZ f {	,a}			
Operands	S:	0 ≤ f ≤ 255 a ∈ [0 , 1]				
Operation	1:	skip if f = 0				
Status Aff	ected:	None				
Encoding	:	0110	011a fff	f ffff		
Descriptic	on:	If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction.				
		If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:		1				
Cycles:			rcles if skip and a 2-word instru			
Q Cycle	Activity:					
	Q1	Q2	Q3	Q4		
D	ecode	Read	Process	No		
lf a laine i		register 'f'	Data	operation		
lf skip:	Q1	Q2	Q3	Q4		
	No	No	No	No No		
ор	eration	operation	operation	operation		
If skip an	d followe	d by 2-word in				
<b></b>	Q1	Q2	Q3	Q4		
	No	No	No	No		
ор	eration	operation	operation	operation		
ор	NO eration	No operation	No operation	No operation		
Example:	Example: HERE TSTFSZ CNT, 1 NZERO : ZERO :					
Befo	ore Instruc	tion				
	PC		dress (HERE	)		
After	Instructic If CNT		h			
	IF CN I PC If CNT PC	= Ad ≠ 00	dress (ZERO	,		
		/10		- ,		

XORLW	Exclusive	Exclusive OR Literal with W				
Syntax:	XORLW	k				
Operands:	$0 \le k \le 25$	$0 \leq k \leq 255$				
Operation:	(W) .XOR	(W) .XOR. $k \rightarrow W$				
Status Affected:	N, Z	N, Z				
Encoding:	0000	0000 1010 kkkk kkkk				
Description:		The contents of W are XORed with the 8-bit literal 'k'. The result is placed in W.				
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3		Q4		
Decode	Read literal 'k'	Proces Data	s V	Vrite to W		
Example:	XORLW	0AFh				
Before Instruction W = B5h After Instruction W = 1Ah						

XORWF	Exclusive	OR W with f	
Syntax:	XORWF	f {,d {,a}}	
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$		
Operation:	(W) .XOR. (	(f) $\rightarrow$ dest	
Status Affected:	N, Z		
Encoding:	0001	10da ff:	ff ffff
Description:	register 'f'. I	i'1', the result	s of W with esult is stored is stored back
	, -	he Access Bai he BSR is use	nk is selected. d to select the
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	nd the extende ed, this instruc Literal Offset A ever f ≤ 95 (5) .2.3 "Byte-Or d Instruction set Mode" for	ction operates Addressing Fh). See <b>iented and</b> <b>s in Indexed</b>
Words:	1		
Cycles:	1		
Q Cycle Activity:			
Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination
Example:		REG, 1, 0	
Before Instruct REG W	tion = AFh = B5h		
After Instructio REG W	n = 1Ah = B5h		

#### 查询PIC18F86K90供应商 29.2 Extended Instruction Set

In addition to the standard 75 instructions of the PIC18 instruction set, the PIC18F87K90 family of devices also provides an optional extension to the core CPU functionality. The added features include eight additional instructions that augment Indirect and Indexed Addressing operations and the implementation of Indexed Literal Offset Addressing for many of the standard PIC18 instructions.

The additional features of the extended instruction set are enabled by default on unprogrammed devices. Users must properly set or clear the XINST Configuration bit during programming to enable or disable these features.

The instructions in the extended set can all be classified as literal operations, which either manipulate the File Select Registers, or use them for Indexed Addressing. Two of the instructions, ADDFSR and SUBFSR, each have an additional special instantiation for using FSR2. These versions (ADDULNK and SUBULNK) allow for automatic return after execution.

The extended instructions are specifically implemented to optimize re-entrant program code (that is, code that is recursive or that uses a software stack) written in high-level languages, particularly C. Among other things, they allow users working in high-level languages to perform certain operations on data structures more efficiently. These include:

- Dynamic allocation and deallocation of software stack space when entering and leaving subroutines
- Function Pointer invocation
- Software Stack Pointer manipulation
- Manipulation of variables located in a software stack

A summary of the instructions in the extended instruction set is provided in Table 29-3. Detailed descriptions are provided in **Section 29.2.2 "Extended Instruction Set"**. The opcode field descriptions in Table 29-1 (page 450) apply to both the standard and extended PIC18 instruction sets.

Note: The instruction set extension and the Indexed Literal Offset Addressing mode were designed for optimizing applications written in C; the user may likely never use these instructions directly in assembler. The syntax for these commands is provided as a reference for users who may be reviewing code that has been generated by a compiler.

#### 29.2.1 EXTENDED INSTRUCTION SYNTAX

Most of the extended instructions use indexed arguments, using one of the File Select Registers and some offset to specify a source or destination register. When an argument for an instruction serves as part of Indexed Addressing, it is enclosed in square brackets ("[]"). This is done to indicate that the argument is used as an index or offset. The MPASM<sup>™</sup> Assembler will flag an error if it determines that an index or offset value is not bracketed.

When the extended instruction set is enabled, brackets are also used to indicate index arguments in byte-oriented and bit-oriented instructions. This is in addition to other changes in their syntax. For more details, see Section 29.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands".

Note: In the past, square brackets have been used to denote optional arguments in the PIC18 and earlier instruction sets. In this text and going forward, optional arguments are denoted by braces ("{ }").

Mnemonic,		Description Cycles 16-Bit Instruction Word		Cycles 16-Bit Instruction Word S		Status		
Opera	nds	Description	Cycles	MSb LSb A		MSb L		Affected
ADDFSR	f, k	Add Literal to FSR	1	1110	1000	ffkk	kkkk	None
ADDULNK	k	Add Literal to FSR2 and Return	2	1110	1000	11kk	kkkk	None
CALLW		Call Subroutine using WREG	2	0000	0000	0001	0100	None
MOVSF	z <sub>s</sub> , f <sub>d</sub>	Move z <sub>s</sub> (source) to 1st word	2	1110	1011	0zzz	ZZZZ	None
		f <sub>d</sub> (destination) 2nd word		1111	ffff	ffff	ffff	
MOVSS	z <sub>s</sub> , z <sub>d</sub>	Move z <sub>s</sub> (source) to 1st word	2	1110	1011	lzzz	ZZZZ	None
		z <sub>d</sub> (destination) 2nd word		1111	xxxx	XZZZ	ZZZZ	
PUSHL	k	Store Literal at FSR2,	1	1110	1010	kkkk	kkkk	None
		Decrement FSR2						
SUBFSR	f, k	Subtract Literal from FSR	1	1110	1001	ffkk	kkkk	None
SUBULNK	k	Subtract Literal from FSR2 and Return	2	1110	1001	11kk	kkkk	None

#### TABLE 29-3: EXTENSIONS TO THE PIC18 INSTRUCTION SET

#### 查询PIC18F86K90供应商 29.2.2 EXTENDED INSTRUCTION SET

ADD	FSR	Add Liter	Add Literal to FSR			
Synta	ax:	ADDFSR	ADDFSR f, k			
Oper	ands:	$0 \le k \le 63$				
		f ∈ [ 0, 1,	2]			
Oper	ation:	FSR(f) + I	$  \rightarrow FSR($	f)		
Statu	s Affected:	None				
Enco	ding:	1110 1000 ffkk kkkk				
Desc	ription:	The 6-bit	literal 'k' is	s added	to the	
		contents of	of the FSF	R specifi	ed by 'f'.	
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	Read	Proces	ss	Write to	
		literal 'k'	Data		FSR	

Example: ADDFSR 2, 23h

Before Instruction FSR2 = 03FFh After Instruction FSR2 = 0422h

ADD	ULNK	Add Liter	Add Literal to FSR2 and Return			
Synta	ax:	ADDULN	K k			
Oper	ands:	$0 \le k \le 63$				
Oper	ation:	FSR2 + k	$\rightarrow$ FSR2,			
		$(TOS) \rightarrow F$	$(TOS) \rightarrow PC$			
Statu	s Affected:	None	None			
Enco	oding:	1110	1000	11kk	kkkk	
Desc	ription:	contents o	The 6-bit literal 'k' is added to the contents of FSR2. A RETURN is then executed by loading the PC with the TOS.			
		The instruction takes two cycles to execute; a NOP is performed during the second cycle.				
		This may be thought of as a special case of the ADDFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.				
Word	ls:	1				
Cycle	es:	2				
Q C	ycle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	Read	Proces	s	Write to	
		literal 'k'	Data		FSR	
	No	No	No		No	
	Operation	Operation	Operatio	on	Operation	
<u>Exan</u>	nple:	ADDULNK 2	23h			

ample:	Al	DDULNK	2
Before Instruc	ction		
FSR2	=	03FFh	
PC	=	0100h	
After Instructi	on		
FSR2	=	0422h	
PC	=	(TOS)	

**Note:** All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

CAL	LW	Subroutine	Subroutine Call Using WREG				
Synta	ax:	CALLW					
Oper	ands:	None					
Oper	ation:	$(PC + 2) \rightarrow$ $(W) \rightarrow PCL$ $(PCLATH) \rightarrow$ $(PCLATU) \rightarrow$	., → PCH,				
Statu	s Affected:	None	None				
Enco	ding:	0000	0000 000	01 0100			
Desc	ription	pushed ont contents of existing val contents of latched into respectively executed a new next in Unlike CAL	First, the return address (PC + 2) is pushed onto the return stack. Next, the contents of W are written to PCL; the existing value is discarded. Then, the contents of PCLATH and PCLATU are latched into PCH and PCU, respectively. The second cycle is executed as a NOP instruction while the new next instruction is fetched. Unlike CALL, there is no option to				
10/0 00	I	update W, STATUS or BSR.					
Word		1					
Cycle		2					
QC	ycle Activity: Q1	Q2	Q3	Q4			
	Decode	Read WREG	Push PC to stack	No operation			
	No operation	No operation	No operation	No operation			
	nple: PC PCLATH PCLATH PCLATU W After Instruction PC TOS PCLATH PCLATU W	= address = 10h = 00h = 06h m = 001006 = address = 10h		)			

MOVS	F	Move Inde	exed to f			
Syntax	<b>(</b> :	MOVSF [	z <sub>s</sub> ], f <sub>d</sub>			
Opera		0 ≤ z <sub>s</sub> ≤ 12 0 ≤ f <sub>d</sub> ≤ 409	7			
Opera	tion:	((FSR2) +	$z_s) \rightarrow f_d$			
Status	Affected:	None				
	ing: rd (source) ord (destin.)	1110 1011 0zzz zzzz <sub>s</sub> 1111 ffff ffff ffff <sub>d</sub>				
Descri	ption:	The contents of the source register are moved to destination register 'f <sub>d</sub> '. The actual address of the source register is determined by adding the 7-bit literal offset 'z <sub>s</sub> ', in the first word, to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f <sub>d</sub> ' in the second word. Both addresses can be anywhere in the 4096-byte data space (000h to FFFh).				
		The MOVSF instruction cannot use the PCL, TOSU, TOSH or TOSL as the destination register.				
		If the resultant source address points to an Indirect Addressing register, the value returned will be 00h.				
Words	:	2				
Cycles	3:	2				
Q Cy	cle Activity:					
_	Q1	Q2	Q3		Q4	
	Decode	Determine source addr	Determ source a		Read source reg	
	Decode	No operation No dummy read	No operat	ion	Write register 'f' (dest)	
<u>Examp</u>	<u>ole:</u>	MOVSF	[05h],	REG2		
	efore Instruct FSR2 Contents of 85h REG2 fter Instruction FSR2 Contents of 85h REG2	= 80 = 33 = 11 on = 80	8h h 0h 8h			

MOVSS	Move Indexed to Indexed		
Syntax:	MOVSS [z <sub>s</sub> ], [z <sub>d</sub> ]		
Operands:	$\begin{array}{l} 0 \leq z_s \leq 127 \\ 0 \leq z_d \leq 127 \end{array}$		
Operation:	$((FSR2) + z_s) \rightarrow ((FSR2))$	2) + z <sub>d</sub> )	
Status Affected:	None		
Encoding: 1st word (source) 2nd word (dest.)		.zzz zzzz <sub>s</sub> zzz zzzz <sub>d</sub>	
Description	The contents of the sour moved to the destinatio addresses of the source registers are determine 7-bit literal offsets, 'z <sub>s</sub> ' c respectively, to the valu registers can be located the 4096-byte data mer (000h to FFFh). The MOVSS instruction of PCL, TOSU, TOSH or T destination register.	In register. The e and destination d by adding the or ' $z_d$ ', le of FSR2. Both d anywhere in mory space cannot use the	
	If the resultant source a an Indirect Addressing value returned will be 0 resultant destination ad an Indirect Addressing instruction will execute	register, the 0h. If the Idress points to register, the	
Words:	2		
Cycles:	2		
Q Cycle Activity:			

vcles:	2	
Q Cycle Activity:	-	
	~~	02

,			
Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	Determine dest addr	Determine dest addr	Write to dest reg
		uest addi	to dest reg

Example:	MOVSS	[05h],	[06h]

Before Instruction		
FSR2	=	80h
Contents of 85h Contents	=	33h
of 86h	=	11h
After Instruction		
FSR2	=	80h
Contents of 85h Contents	=	33h
of 86h	=	33h

PUSHL	Store Litera	al at FSR	2, Decr	ement FSR2
Syntax:	PUSHL k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow (FSR2)$ FSR2 – 1 –	.,		
Status Affected:	None			
Encoding:	1111	1010	kkk}	c kkkk
	memory address specified by FSR2. FSR2 is decremented by 1 after the operation. This instruction allows users to push values onto a software stack.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	C	23	Q4
Decode	Read 'k'	Proc da		Write to destination
Example:	PUSHL 0	da		

Before Instruction FSR2H:FSR2L Memory (01ECh)	= =	01ECh 00h
After Instruction FSR2H:FSR2L Memory (01ECh)	= =	01EBh 08h

### 查询PIC18F86K90供应商

SUB	FSR	Subtract Literal from FSR			
Synta	ax:	SUBFSR	f, k		
Oper	ands:	$0 \le k \le 63$	$0 \le k \le 63$		
		f ∈ [ 0, 1,	2]		
Oper	ation:	FSRf – k	$\rightarrow$ FSRf		
Statu	s Affected:	None			
Enco	ding:	1110	1001	ffkk	kkkk
Desc	ription:	The 6-bit literal 'k' is subtracted from the contents of the FSR specified by 'f'.			
Word	ls:	1			
Cycle	es:	1			
QC	ycle Activity:				
	Q1	Q2	Q3		Q4
	Decode	Read	Proce	ss	Write to
		register 'f'	Data	a de	estination
Exan	nple:	SUBFSR	2, 23h		

Example:	SUBFSR 2, 23h
Before Instruction	n
FSR2 =	03FFh
After Instruction	
FSR2 =	03DCh

SUBULNK	Subtract Literal from FSR2 and Return			
Syntax:	SUBULNK I	(		
Operands:	$0 \leq k \leq 63$			
Operation:	$\begin{array}{l} FSR2-k \rightarrow \\ (TOS) \rightarrow PC \end{array}$	FSR2,		
Status Affected:	None			
Encoding:	1110 1	001	11kk	kkkk
Description:	The 6-bit literal 'k' is subtracted from the contents of the FSR2. A RETURN is then executed by loading the PC with the TOS.			
	The instruction takes two cycles to execute; a NOP is performed during the second cycle.			
	This may be thought of as a special case of the SUBFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.			
Words:	1			
Cycles:	2			
Q Cycle Activity:				
Q1	Q2	(	23	Q4
Decode	Read register 'f'		cess ata	Write to destination
No	No	Ν	lo	No
Operation	Operation	Oper	ration	Operation

Example: SUBULNK 23h

ion	
=	03FFh
=	0100h
n	
=	03DCh
=	(TOS)
	= = n =

#### 查询PIC18F86K90供应商

#### 29.2.3 BYTE-ORIENTED AND BIT-ORIENTED INSTRUCTIONS IN INDEXED LITERAL OFFSET MODE

Note:	Enabling the PIC18 instruction set exten-
	sion may cause legacy applications to
	behave erratically or fail entirely.

In addition to eight new commands in the extended set, enabling the extended instruction set also enables Indexed Literal Offset Addressing (Section 6.6.1 "Indexed Addressing with Literal Offset"). This has a significant impact on the way that many commands of the standard PIC18 instruction set are interpreted.

When the extended set is disabled, addresses embedded in opcodes are treated as literal memory locations: either as a location in the Access Bank (a = 0) or in a GPR bank designated by the BSR (a = 1). When the extended instruction set is enabled and a = 0, however, a file register argument of 5Fh or less is interpreted as an offset from the pointer value in FSR2 and not as a literal address. For practical purposes, this means that all instructions that use the Access RAM bit as an argument – that is, all byte-oriented and bit-oriented instructions, or almost half of the core PIC18 instructions – may behave differently when the extended instruction set is enabled.

When the content of FSR2 is 00h, the boundaries of the Access RAM are essentially remapped to their original values. This may be useful in creating backward compatible code. If this technique is used, it may be necessary to save the value of FSR2 and restore it when moving back and forth between C and assembly routines in order to preserve the Stack Pointer. Users must also keep in mind the syntax requirements of the extended instruction set (see Section 29.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands").

Although the Indexed Literal Offset mode can be very useful for dynamic stack and pointer manipulation, it can also be very annoying if a simple arithmetic operation is carried out on the wrong register. Users who are accustomed to the PIC18 programming must keep in mind, that when the extended instruction set is enabled, register addresses of 5Fh or less are used for Indexed Literal Offset Addressing.

Representative examples of typical byte-oriented and bit-oriented instructions in the Indexed Literal Offset mode are provided on the following page to show how execution is affected. The operand conditions shown in the examples are applicable to all instructions of these types.

### 29.2.3.1 Extended Instruction Syntax with Standard PIC18 Commands

When the extended instruction set is enabled, the file register argument, 'f', in the standard byte-oriented and bit-oriented commands is replaced with the literal offset value, 'k'. As already noted, this occurs only when 'f' is less than or equal to 5Fh. When an offset value is used, it must be indicated by square brackets ("[]"). As with the extended instructions, the use of brackets indicates to the compiler that the value is to be interpreted as an index or an offset. Omitting the brackets, or using a value greater than 5Fh within the brackets, will generate an error in the MPASM<sup>™</sup> Assembler.

If the index argument is properly bracketed for Indexed Literal Offset Addressing, the Access RAM argument is never specified; it will automatically be assumed to be '0'. This is in contrast to standard operation (extended instruction set disabled), when 'a' is set on the basis of the target address. Declaring the Access RAM bit in this mode will also generate an error in the MPASM Assembler.

The destination argument, 'd', functions as before.

In the latest versions of the MPASM Assembler, language support for the extended instruction set must be explicitly invoked. This is done with either the command line option,  $/_{Y}$ , or the PE directive in the source listing.

#### 29.2.4 CONSIDERATIONS WHEN ENABLING THE EXTENDED INSTRUCTION SET

It is important to note that the extensions to the instruction set may not be beneficial to all users. In particular, users who are not writing code that uses a software stack may not benefit from using the extensions to the instruction set.

Additionally, the Indexed Literal Offset Addressing mode may create issues with legacy applications written to the PIC18 assembler. This is because instructions in the legacy code may attempt to address registers in the Access Bank below 5Fh. Since these addresses are interpreted as literal offsets to FSR2 when the instruction set extension is enabled, the application may read or write to the wrong data addresses.

When porting an application to the PIC18F87K90 family, it is very important to consider the type of code. A large, re-entrant application that is written in C and would benefit from efficient compilation will do well when using the instruction set extensions. Legacy applications that heavily use the Access Bank will most likely not benefit from using the extended instruction set.

#### 查询PIC18F86K90供应商

ADDWF	ADD W to (Indexed L		fset n	nod	e)	
Syntax:	ADDWF	[k] {,d}				
Operands:	$\begin{array}{l} 0 \leq k \leq 95 \\ d \; \in \; [0\;,\; 1] \end{array}$					
Operation:	(W) + ((FSR2) + k) $\rightarrow$ dest					
Status Affected:	N, OV, C, DC, Z					
Encoding:	0010	01d0 kkkk		ĸk	kkkk	
Description:	The contents of W are added to the contents of the register indicated by FSR2, offset by the value 'k'.					
	If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3			Q4	
Decode	Read 'k'	Proce Data		-	Vrite to stination	
Example:	ADDWF	[OFST]	,0			
Before Instructi W OFST FSR2 Contents of 0A2Ch After Instruction W Contents of 0A2Ch	= = = =	17h 2Ch 0A00r 20h 37h 20h	1			

BSF		Bit Set Ind (Indexed L	exed iteral Offset	mode)			
Synt	ax:	BSF [k], b					
Ope	rands:	$\begin{array}{l} 0 \leq f \leq 95 \\ 0 \leq b \leq 7 \end{array}$					
Ope	ration:	$1 \rightarrow ((FSR2) + k) < b >$					
Statu	us Affected:	None					
Enco	oding:	1000 bbb0 kkkk kkkk					
Desc	cription:	Bit 'b' of the offset by the	Bit 'b' of the register indicated by FSR2, offset by the value 'k', is set.				
Word	ds:	1					
Cycl	es:	1					
QC	Cycle Activity:						
	Q1	Q2	Q3	Q4			
	Decode	Read register 'f'	Process Data	Write to destination			
<u>Exar</u>	Example: BSF [FLAG_OFST], 7						
	Before Instruc FLAG_O FSR2		0Ah 0A00h				
	Contents of 0A0Ah	-	55h				
	After Instructio						
	Contents of 0A0Ah		D5h				
SETF Set Indexed (Indexed Literal Offset mode)							
SET	F			mode)			
SET Synt				mode)			
Synt		(Indexed L		mode)			
Synt Oper	ax:	(Indexed L SETF [k]	iteral Offset	mode)			
Synt Oper Oper	ax: rands:	(Indexed L SETF [k] 0 ≤ k ≤ 95	iteral Offset	mode)			
Synt Oper Oper Statu	ax: rands: ration:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS	iteral Offset SR2) + k)	mode)			
Synt Oper Oper Statu Enco	ax: rands: ration: us Affected:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten	BR2) + k)	kkk kkkk ter indicated by			
Synt Oper Oper Statu Enco	ax: rands: ration: us Affected: oding: cription:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten	1000 k3	kkk kkkk ter indicated by			
Synt Oper Statu Enco Deso	ax: rands: ration: us Affected: oding: cription: ds:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The contem FSR2, offset	BR2) + k)	kkk kkkk ter indicated by			
Synt Oper Statu Enco Deso Word Cycle	ax: rands: ration: us Affected: oding: cription: ds: es:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1	BR2) + k)	kkk kkkk ter indicated by			
Synt Oper Statu Enco Deso Word Cycle	ax: rands: ration: us Affected: oding: cription: ds:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1	BR2) + k)	kkk kkkk ter indicated by			
Synt Oper Statu Enco Deso Word Cycle	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1 1	R2) + k) 1000 ki ts of the regise t by 'k', are s Q3 Process	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Statu Enco Deso Word Cycle	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1 1 Q2	R2) + k) 1000 ki ts of the regis t by 'k', are s	kkk kkkk ter indicated by set to FFh.			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1 1 Q2 Read 'k'	R2) + k) 1000 ki ts of the regise t by 'k', are s Q3 Process	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1 Decode	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1 1 2 Read 'k' SETF	R2) + k) 1000 ki ts of the regis to by 'k', are s Q3 Process Data	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: Cycle Activity: Q1 Decode <u>nple:</u> Before Instruc OFST	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1 1 2 Read 'k' SETF [ tion = 20	R2) + k) 1000 ki ts of the regis to of the regis to y 'k', are s Q3 Process Data OFST] h	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1 Decode Decode <u>nple:</u> Before Instruc OFST FSR2 Contents	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offset 1 1 Q2 Read 'k' SETF [ tion = 2C = 0A	R2) + k) 1000 ki ts of the regis ts of the regis t by 'k', are s Q3 Process Data OFST] h 00h	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1 Decode Mple: Before Instruc OFST FSR2 Contents of 0A2Ct	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offset 1 1 Q2 Read 'k' SETF [ SETF [ tion = 2C = 0A	R2) + k) 1000 ki ts of the regis ts of the regis t by 'k', are s Q3 Process Data OFST] h 00h	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1 Decode Decode <u>nple:</u> Before Instruc OFST FSR2 Contents	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offset 1 1 Q2 Read 'k' SETF [ Conten FSR2 (Conten FSR2) (FS SETF [ Conten FSR2) (Conten FSR2) (C	R2) + k) 1000 ki ts of the regis ts of the regis t by 'k', are s Q3 Process Data OFST] h 00h	kkk kkkk ter indicated by set to FFh. Q4 Write			
Synt Oper Oper Statu Encc Desc Word Cycle Q C	ax: rands: ration: us Affected: oding: cription: ds: es: cycle Activity: Q1 Decode <u>nple:</u> Before Instruct OFST FSR2 Contents of 0A2Ch	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The conten FSR2, offse 1 1 1 Q2 Read 'k' SETF [ tion = 2C = 0A n = 00 on	R2) + k) 1000 k] ts of the regise t by 'k', are s Q3 Process Data OFST] h 00h h	kkk kkkk ter indicated by set to FFh. Q4 Write			

#### 查询PIC18F86K90供应商

#### 29.2.5 SPECIAL CONSIDERATIONS WITH MICROCHIP MPLAB<sup>®</sup> IDE TOOLS

The latest versions of Microchip's software tools have been designed to fully support the extended instruction set for the PIC18F87K90 family family. This includes the MPLAB C18 C Compiler, MPASM assembly language and MPLAB Integrated Development Environment (IDE).

When selecting a target device for software development, MPLAB IDE will automatically set default Configuration bits for that device. The default setting for the XINST Configuration bit is '0', disabling the extended instruction set and Indexed Literal Offset Addressing. For proper execution of applications developed to take advantage of the extended instruction set, XINST must be set during programming.

To develop software for the extended instruction set, the user must enable support for the instructions and the Indexed Addressing mode in their language tool(s). Depending on the environment being used, this may be done in several ways:

- A menu option or dialog box within the environment that allows the user to configure the language tool and its settings for the project
- A command line option
- A directive in the source code

These options vary between different compilers, assemblers and development environments. Users are encouraged to review the documentation accompanying their development systems for the appropriate information.

#### 查询PIC18F86K90供应商 30.0 DEVELOPMENT SUPPORT

The PIC<sup>®</sup> microcontrollers and dsPIC<sup>®</sup> digital signal controllers are supported with a full range of software and hardware development tools:

- Integrated Development Environment
- MPLAB<sup>®</sup> IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB C Compiler for Various Device Families
  - HI-TECH C for Various Device Families
  - MPASM<sup>™</sup> Assembler
  - MPLINK<sup>™</sup> Object Linker/ MPLIB<sup>™</sup> Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- · Simulators
  - MPLAB SIM Software Simulator
- Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers
  - MPLAB ICD 3
  - PICkit™ 3 Debug Express
- Device Programmers
  - PICkit<sup>™</sup> 2 Programmer
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits, and Starter Kits

#### 30.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16/32-bit microcontroller market. The MPLAB IDE is a Windows<sup>®</sup> operating system-based application that contains:

- A single graphical interface to all debugging tools
  - Simulator
  - Programmer (sold separately)
  - In-Circuit Emulator (sold separately)
  - In-Circuit Debugger (sold separately)
- A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- · Mouse over variable inspection
- Drag and drop variables from source to watch windows
- · Extensive on-line help
- Integration of select third party tools, such as IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either C or assembly)
- One-touch compile or assemble, and download to emulator and simulator tools (automatically updates all project information)
- · Debug using:
  - Source files (C or assembly)
  - Mixed C and assembly
  - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

#### 查询PIC18F86K90供应商

#### 30.2 MPLAB C Compilers for Various Device Families

The MPLAB C Compiler code development systems are complete ANSI C compilers for Microchip's PIC18, PIC24 and PIC32 families of microcontrollers and the dsPIC30 and dsPIC33 families of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

#### 30.3 HI-TECH C for Various Device Families

The HI-TECH C Compiler code development systems are complete ANSI C compilers for Microchip's PIC family of microcontrollers and the dsPIC family of digital signal controllers. These compilers provide powerful integration capabilities, omniscient code generation and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

The compilers include a macro assembler, linker, preprocessor, and one-step driver, and can run on multiple platforms.

#### 30.4 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel<sup>®</sup> standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- · Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

#### 30.5 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

#### 30.6 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC devices. MPLAB C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- Command line interface
- · Rich directive set
- Flexible macro language
- MPLAB IDE compatibility

#### 查询PIC18F86K90供应商 **30.7 MPLAB SIM Software Simulator**

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC<sup>®</sup> DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

#### 30.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC<sup>®</sup> Flash MCUs and dsPIC<sup>®</sup> Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with incircuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

#### 30.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC<sup>®</sup> Flash microcontrollers and dsPIC<sup>®</sup> DSCs with the powerful, yet easyto-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

#### 30.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC<sup>®</sup> and dsPIC<sup>®</sup> Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming<sup>™</sup>.

The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

#### 查询PIC18F86K90供应商

#### 30.11 PICkit 2 Development Programmer/Debugger and PICkit 2 Debug Express

The PICkit<sup>™</sup> 2 Development Programmer/Debugger is a low-cost development tool with an easy to use interface for programming and debugging Microchip's Flash families of microcontrollers. The full featured Windows<sup>®</sup> programming interface supports baseline (PIC10F, PIC12F5xx, PIC16F5xx), midrange (PIC12F6xx, PIC16F), PIC18F, PIC24, dsPIC30, dsPIC33, and PIC32 families of 8-bit, 16-bit, and 32-bit microcontrollers, and many Microchip Serial EEPROM products. With Microchip's powerful MPLAB Integrated Development Environment (IDE) the PICkit<sup>™</sup> 2 enables in-circuit debugging on most PIC<sup>®</sup> microcontrollers. In-Circuit-Debugging runs, halts and single steps the program while the PIC microcontroller is embedded in the application. When halted at a breakpoint, the file registers can be examined and modified.

The PICkit 2 Debug Express include the PICkit 2, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

#### 30.12 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an MMC card for file storage and data applications.

#### 30.13 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM<sup>™</sup> and dsPICDEM<sup>™</sup> demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ<sup>®</sup> security ICs, CAN, IrDA<sup>®</sup>, PowerSmart battery management, SEEVAL<sup>®</sup> evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

### 查询PIC18F86K90供应商

### 31.0 ELECTRICAL CHARACTERISTICS

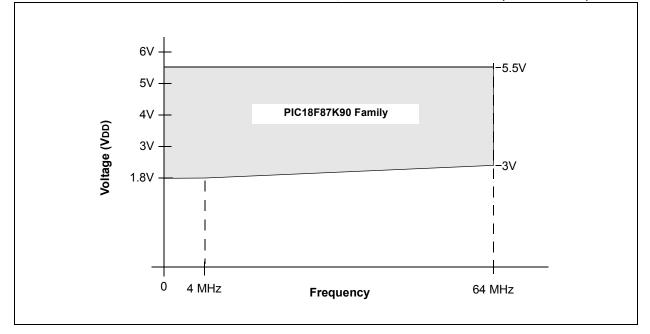
### Absolute Maximum Ratings<sup>(†)</sup>

Ambient temperature under bias40°C to +125°C
Storage temperature65°C to +150°C
Voltage on any digital only I/O pin or MCLR with respect to Vss (except VDD)
Voltage on any combined digital and analog pin with respect to Vss (except VDD and MCLR)0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss (regulator enabled)
Voltage on VDD with respect to Vss (regulator disabled)
Total power dissipation (Note 1)
Maximum current out of Vss pin
Maximum current into VDD pin
Maximum output current sunk by PORTA<7:6> and any PORTB and PORTC I/O pins
Maximum output current sunk by any PORTD, PORTE and PORTJ I/O pins
Maximum output current sunk by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins
Maximum output current sourced by PORTA<7:6> and any PORTB and PORTC I/O pins
Maximum output current sourced by any PORTD, PORTE and PORTJ I/O pins
Maximum output current sourced by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins
Maximum current sunk by all ports combined
<b>Note 1:</b> Power dissipation is calculated as follows: Pdis = VDD x {IDD $-\sum$ IOH} + $\sum$ {(VDD $-$ VOH) x IOH} + $\sum$ (VOL x IOL)

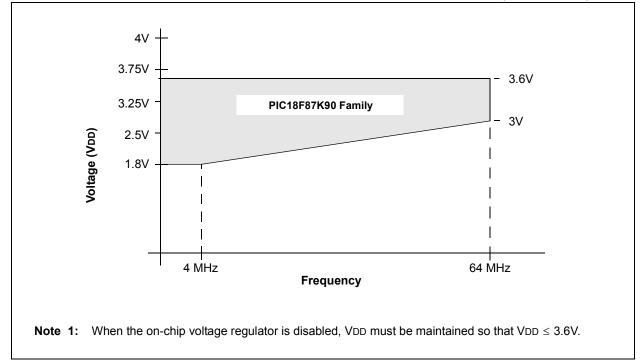
**† NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

#### 查询PIC18F86K90供应商

FIGURE 31-1: VOLTAGE-FREQUENCY GRAPH, REGULATOR ENABLED (INDUSTRIAL)<sup>(1)</sup>



#### FIGURE 31-2: VOLTAGE-FREQUENCY GRAPH, REGULATOR DISABLED (INDUSTRIAL)<sup>(1,2)</sup>



#### 查询PIC18F86K90供应商 31.1 DC Characteristics:

### Supply Voltage PIC18F87K90 Family (Industrial)

	87K90 Fan ustrial)	nily	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial						
Param No.	Symbol	Characteristic	Min	Тур	Мах	Units	Conditions		
D001	Vdd	Supply Voltage	1.8 1.8		3.6 5.5	V V	ENVREG tied to Vss ENVREG tied to VDD		
D001C	AVdd	Analog Supply Voltage	Vdd - 0.3	_	VDD + 0.3	V			
D001D	AVss	Analog Ground Potential	Vss – 0.3	_	Vss + 0.3	V			
D002	Vdr	RAM Data Retention Voltage <sup>(1)</sup>	1.5	—	—	V			
D003	Vpor	VDD Start Voltage to Ensure Internal Power-on Reset Signal	—	_	0.7	V	See Section 5.3 "Power-on Reset (POR)" for details		
D004	Svdd	<b>VDD Rise Rate</b> to Ensure Internal Power-on Reset Signal	0.05	_	-	V/ms	See Section 5.3 "Power-on Reset (POR)" for details		
D005	Bvdd	Brown-out Reset Voltage (High/Medium/Low-Power mode) BORV<1:0> = 11 BORV<1:0> = 10 BORV<1:0> = 01 BORV<1:0> = 00	1.69 1.88 2.53 2.82	1.8 2.0 2.7 3.0	1.91 2.12 2.86 3.18				

Note 1: This is the limit to which VDD can be lowered in Sleep mode, or during a device Reset, without losing RAM data.

### 查询PIC18F86K90供应商

#### 31.2 DC Characteristics:

#### Power-Down and Supply Current PIC18F87K90 Family (Industrial)

PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial								
Param No.	Device	Тур	Max	Units	Cond	litions				
	Power-Down Current (IPD)	(1)								
	All devices	10	500	nA	-40°C					
		20	500	nA	+25°C	$V_{DD} = 1.8V^{(4)}$				
		120	600	nA	+60°C	(Sleep mode) Regulator Disabled				
		630	1800	nA	+85°C					
	All devices	50	700	nA	-40°C					
		60	700	nA	+25°C	$V_{DD} = 3.3V^{(4)}$				
		170	800	nA	+60°C	(Sleep mode) Regulator Disabled				
		700	2700	nA	+85°C					
	All devices	350	1300	nA	-40°C					
		400	1400	nA	+25°C	$V_{DD} = 5V^{(5)}$				
		550	1500	nA	+60°C	(Sleep mode) Regulator Enabled				
		1350	4000	nA	+85°C					

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- MCLR = VDD; WDT enabled/disabled as specified.
- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).

- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F86K90供应商 **31.2 DC Characteristics**:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	<b>7K90 Family</b> strial)	<b>Standard</b> Operating	-	-		otherwise stated) +85°C for industrial		
Param No.	Device	Тур	Max	Units		Conditions		
	Supply Current (IDD) <sup>(2,3)</sup>							
	All devices	5.3	10	μΑ	-40°C	VDD = 1.8V <sup>(4)</sup>		
		5.5	10	μΑ	+25°C	Regulator Disabled		
		5.5	10	μA	+85°C	regulator Disabled		
	All devices	10	15	μA	-40°C	$V_{DD} = 3.3 V^{(4)}$	Fosc = 31 kHz	
		10	16	μA	+25°C	Regulator Disabled	(RC_RUN mode,	
		11	17	μA	+85°C	r togulator Bioabioa	LF-INTOSC)	
	All devices	70	180	μA	-40°C	VDD = 5V <sup>(5)</sup>		
		80	185	μA	+25°C	Regulator Enabled		
		90	190	μA	+85°C			
	All devices	410	850	μA	-40°C	VDD = 1.8V <sup>(4)</sup>	Fosc = 1 MHz	
		410	800	μA	+25°C	Regulator Disabled		
		410	830	μA	+85°C	regulator Disabled		
	All devices	680	990	μA	-40°C	) (= = = 0, 0) ( <b>(4</b> )		
		680	960	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(RC_RUN mode,	
		670	950	μA	+85°C	regulator Disabled	HF-INTOSC)	
	All devices	760	1400	μA	-40°C	VDD = 5V <sup>(5)</sup>		
		780	1400	μA	+25°C	Regulator Enabled		
		800	1500	μA	+85°C			
	All devices	760	1300	μΑ	-40°C			
		760	1400	μΑ	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled		
		770	1500	μΑ	+85°C			
	All devices	1.4	2.5	mA	-40°C	$\lambda = 0.0 \lambda (4)$	Fosc = 4 MHz	
		1.4	2.5	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	( <b>RC_RUN</b> mode, HF-INTOSC)	
		1.4	2.5	mA	+85°C			
	All devices	1.5	2.7	mA	-40°C	) (c. c. c. (5)		
		1.5	2.7	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled		
		1.5	2.7	mA	+85°C			

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

**3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).

**6:** LCD glass is not connected; resistor current is not included.

#### 查询PIC18F86K90供应商 31.2 DC Characteristics:

#### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	7K90 Family strial)	<b>Standard</b> Operating				otherwise stated) ⊊+85°C for industrial		
Param No.	Device	Тур	Max	Units		Condition	S	
	Supply Current (IDD) Cont	(2,3)						
	All devices	2.1	5.5	μA	-40°C	) ( ) ( <b>(4</b> )		
		2.1	5.7	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled		
		2.2	6.0	μA	+85°C	Regulator Disabled		
	All devices	3.7	7.5	μA	-40°C	VDD = 3.3V <sup>(4)</sup>	Fosc = 31 kHz	
		3.9	7.8	μA	+25°C	Regulator Disabled	(RC_IDLE mode,	
		3.9	8.5	μA	+85°C	Regulator Disabled	LF-INTOSC)	
	All devices	70	180	μA	-40°C	V <sub>DD</sub> = 5V <sup>(5)</sup>		
		80	190	μA	+25°C	VDD = 5V <sup>(6)</sup> Regulator Enabled		
		80	200	μA	+85°C	regulator Enabled		
	All devices	330	650	μA	-40°C	) (= = ( 0) ((4)	Fosc = 1 MHz ( <b>RC_IDLE</b> mode,	
		330	640	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled		
		330	630	μA	+85°C			
	All devices	520	850	μA	-40°C	) (= = = 0, 0) ( <b>(4</b> )		
		520	900	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled		
		520	850	μA	+85°C	Regulator Disabled	HF-INTOSC)	
	All devices	590	940	μA	-40°C	VDD = 5V <sup>(5)</sup>		
		600	960	μA	+25°C	Regulator Enabled		
		620	990	μA	+85°C	regulator Enabled		
	All devices	470	770	μΑ	-40°C	VDD = 1.8V <sup>(4)</sup>		
		470	770	μΑ	+25°C	Regulator Disabled		
		460	760	μΑ	+85°C	. togulator Bioabiou		
	All devices	800	1400	μΑ	-40°C	$V_{DD} = 3.3 V^{(4)}$	Fosc = 4 MHz	
		800	1350	μA	+25°C	Regulator Disabled	( <b>RC_IDLE</b> mode, internal HF-INTOSC)	
		790	1300	μΑ	+85°C	. togulator Bioabiou		
	All devices	880	1600	μΑ	-40°C	V <sub>DD</sub> = 5V <sup>(5)</sup>		
		890	1700	μΑ	+25°C	VDD = 5V <sup>(6)</sup> Regulator Enabled		
		910	1800	μA	+85°C			

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F86K90供应商 **31.2 DC Characteristics**:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	<b>7K90 Family</b> strial)	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Device	Тур	Max	Units		Conditions					
	Supply Current (IDD) Cont.	(2,3)									
	All devices	130	390	μA	-40°C	) ( ( _ ) (4)					
		130	390	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		130	390	μA	+85°C	regulator Disabled					
	All devices	270	790	μA	-40°C		Fosc = 1 MHz				
		270	790	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_RUN mode,				
		270	790	μA	+85°C	regulator Disabled	EC oscillator)				
	All devices	430	990	μA	-40°C						
		450	980	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		460	980	μA	+85°C						
	All devices	430	860	μA	-40°C	) ( ( _ ) (4)					
		530	900	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		490	880	μA	+85°C	regulator Disabled					
	All devices	850	1750	μA	-40°C		Fosc = 4 MHz				
		850	1700	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_RUN mode,				
		850	1800	μA	+85°C	regulator Disabled	EC oscillator)				
	All devices	1.1	2.7	mA	-40°C	) (= = = = = ; (5)					
		1.1	2.6	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		1.1	2.6	mA	+85°C						
	All devices	12	19	mA	-40°C	) (== 0.0) ((4)					
		12	19	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	_				
		12	19	mA	+85°C	- legulator Bioabioa	Fosc = 64 MHz ( <b>PRI_RUN</b> mode,				
	All devices	13	20	mA	-40°C	) (= = = = = ) (5)	EC oscillator)				
		13	20	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled	····)				
		12	20	mA	+85°C						

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- **6:** LCD glass is not connected; resistor current is not included.

### 查询PIC18F86K90供应商

#### 31.2 DC Characteristics:

#### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial								
Param No.	Device	Тур	Max	Units	Conditions						
	Supply Current (IDD) Cont	(2,3)									
	All devices	3.3	5.6	mA	-40°C	$\lambda = 0.01$					
		3.3	5.5	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	Fosc = 16 MHz, ( <b>PRI_RUN</b> mode, 4 MHz EC oscillator with PLL)				
		3.3	5.5	mA	+85°C						
	All devices	3.5	5.9	mA	-40°C						
		3.5	5.8	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		3.5	5.8	mA	+85°C	riogulator Enabloa					
	All devices	12	18	mA	-40°C	) (= = = 0, 0) ( <b>(4</b> )					
		12	18	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled					
		12	18	mA	+85°C		Fosc = 64 MHz,				
	All devices	13	20	mA	-40°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled	<ul> <li>(PRI_RUN mode, 16 MHz EC oscillator with PLL)</li> </ul>				
		12	20	mA	+25°C						
		12	20	mA	+85°C						

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- MCLR = VDD; WDT enabled/disabled as specified.
- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).

- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F86K90供应商 **31.2 DC Characteristics**:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Device	Тур	Max	Units		Conditions						
	Supply Current (IDD) Cont	(2,3)										
	All devices	42	73	μA	-40°C							
		42	73	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled						
		43	74	μA	+85°C							
	All devices	110	190	μA	-40°C		Fosc = 1 MHz					
		110	195	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_IDLE mode,					
		110	195	μA	+85°C		EC oscillator)					
	All devices	280	450	μA	-40°C							
		290	440	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled						
		300	460	μA	+85°C							
	All devices	160	360	μA	-40°C							
		160	360	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled						
		170	370	μA	+85°C							
	All devices	330	650	μA	-40°C		Fosc = 4 MHz					
		340	660	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_IDLE mode,					
		340	660	μA	+85°C		EC oscillator)					
	All devices	510	900	μΑ	-40°C	) (= = = = = ; (5)						
		520	950	μΑ	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled						
		540	990	μA	+85°C							
	All devices	4.7	9	mA	-40°C	) (== 0.0) ((4)						
		4.8	9	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled						
		4.8	9	mA	+85°C	. legalator Bioabiou	Fosc = 64 MHz					
	All devices	5.1	11	mA	-40°C	) (= = = = = ) (5)	( <b>PRI_IDLE</b> mode, EC oscillator)					
		5.1	11	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled						
		5.2	12	mA	+85°C							

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- **6:** LCD glass is not connected; resistor current is not included.

### 查询PIC18F86K90供应商

#### 31.2 DC Characteristics:

#### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial										
Param No.	Device	Тур	Мах	Units	Conditions							
	Supply Current (IDD) Cont.	Supply Current (IDD) Cont. <sup>(2,3)</sup>										
	All devices	3.7	8.5	μA	-40°C	( + -) (4)						
		5.4	10	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled	Fosc = 32 kHz <sup>(3)</sup> ( <b>SEC_RUN</b> mode,					
		6.60	13	μA	+85°C	r togalator Bioabioa						
	All devices	8.7	18	μA	-40°C	(0.0)						
		10	20	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled						
		12	23	μA	+85°C	r togalator Disablea	SOSCSEL = 01)					
	All devices	60	150	μA	-40°C	) (						
		90	190	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled						
		100	240	μA	+85°C	rtogulator Enabled						
	All devices	1.2	4	μA	-40°C	) (= = = ( )) ( <b>(</b> 4)						
		1.7	5	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled						
		2.6	6	μA	+85°C	r togalator Bioabioa						
	All devices	1.6	7	μA	-40°C	(0.0)	Fosc = 32 kHz <sup>(3)</sup>					
		2.8	9	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(SEC_IDLE mode,					
		4.1	10	μA	+85°C	- Regulator Biodbiod	SOSCSEL = 01)					
	All devices	60	160	μA	-40°C	) (======; (5)						
		80	180	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled						
		100	240	μA	+85°C							

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F86K90供应商 **31.2 DC Characteristics**:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

PIC18F8 (Indus	7K90 Family strial)	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Device	Тур	Max	Units		Conditions					
	Module Differential Curren	nts (∆IwDT, ⊿	Albor, $\Delta$	Ihlvd, ∆I	OSCB, ∆IAD)						
D022	Watchdog Timer										
(∆IWDT)	PIC18FXXK90	0.3	1	μA	-40°C	VDD = 1.8V <sup>(4)</sup>					
		0.3	1	μA	+25°C	Regulator Disabled					
		0.3	1	μA	+85°C	Regulator Disabled					
	PIC18FXXK90	0.6	1.9	μA	-40°C	VDD = 3.3V <sup>(4)</sup>					
		0.6	1.8	μA	+25°C	Regulator Disabled					
		0.6	1.8	μA	+85°C	Regulator Disabled					
	PIC18FXXK90	0.6	1.8	μA	-40°C	VDD = 5V <sup>(5)</sup>					
		0.6	1.8	μA	+25°C	Regulator Enabled					
		0.6	1.8	μA	+85°C						
D022A	Brown-out Reset										
( $\Delta$ IBOR)	PIC18FXXK90	4.6	19	μA	-40°C	VDD = 3.3V <sup>(4)</sup>					
		4.5	20	μA	+25°C	Regulator Disabled	High-Power BOR				
		4.7	20	μA	+85°C	Regulator Disabled					
	PIC18FXXK90	4.2	20	μA	-40°C	VDD = 5V <sup>(5)</sup>					
		4.3	20	μA	+25°C	Regulator Enabled	High-Power BOR				
		4.4	20	μA	+85°C	regulator Enabled					
D022B	High/Low-Voltage Detect										
(∆Ihlvd)	PIC18FXXK90	3.8	9	μA	-40°C	VDD = 1.8V <sup>(4)</sup>					
		4.2	9	μA	+25°C	Regulator Disabled					
		4.3	10	μA	+85°C	r togulator Bioabioa					
	PIC18FXXK90	4.5	11	μA	-40°C	VDD = 3.3V <sup>(4)</sup>					
		4.8	12	μA	+25°C	Regulator Disabled					
		4.8	12	μA	+85°C						
	PIC18FXXK90	4.9	13	μA	-40°C	VDD = 5V <sup>(5)</sup>					
		4.9	13	μA	+25°C	Regulator Enabled					
		4.9	13	μA	+85°C						

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

### 查询PIC18F86K90供应商

#### 31.2 DC Characteristics:

#### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

PIC18F87K90 Family (Industrial)		$\begin{tabular}{lllllllllllllllllllllllllllllllllll$									
Param No.	Device	Тур	Max	Units		Condition	S				
D025 (∆IRTCC)	Real-Time Clock/ Calendar with SOSC										
	PIC18FXXK90	0.7	2.7	μA	-40°C						
		0.7	2.7	μA	+25°C	VDD = 1.8V <sup>(4)</sup>					
		1.1	2.8	μA	+60°C	Regulator Disabled					
		1.1	2.9	μA	+85°C						
	PIC18FXXK90	1.20	2.9	μA	-40°C		-				
		1.10	2.8	μA	+25°C	VDD = 3.3V <sup>(4)</sup>	32.768 kHz, SOSCGO = 1				
		2	4.6	μA	+60°C	Regulator Disabled					
		2	4.8	μA	+85°C						
	PIC18FXXK90	1.5	4.4	μA	-40°C						
		1.5	4.4	μA	+25°C	VDD = 5V <sup>(5)</sup>					
		1.7	4.7	μA	+60°C	Regulator Enabled					
		1.7	4.7	μA	+85°C						
D025B	LCD Internal Biasing		1			1	1				
(∆ILCD)	PIC18FXXK90	0.6	2.8	μA	-40°C	VDD = 1.8V <sup>(4)</sup>	Internal biasing <sup>(6)</sup> 1/4 Multiplex mode				
		0.6	2.8	μA	+25°C	Regulator Disabled					
		0.7	3.4	μA	+85°C	-					
	PIC18FXXK90	1.1	3.9	μA	-40°C	$V_{DD} = 3.3V^{(4)}$					
		1.0	3.9	μA	+25°C	Regulator Disabled	Type-A wave form				
		1.1	4.5	μA	+85°C		LCD clock is internal RC				
	PIC18FXXK90	1.3	5.8	μA	-40°C	VDD = 5V					
		1.2	5.8	μA	+25°C	Regulator Enabled					
		1.6	6.5	μA	+85°C	ů					
D025B	LCD External Biasing										
(ΔILCD)	PIC18FXXK90	0.3	1.4	μA	-40°C	VDD = 1.8V <sup>(4)</sup>					
		0.3	1.4	μA	+25°C	Regulator Disabled					
		0.7	1.7	μA	+85°C						
	PIC18FXXK90	0.7	2.9	μA	-40°C	VDD = 3.3V <sup>(4)</sup>	External biasing <sup>(6)</sup>				
		0.7	3.5	μA	+25°C	Regulator Disabled	1/4 Multiplex mode Type-A wave form LCD clock is internal RC				
		1.1	3.9	μA	+85°C						
	PIC18FXXK90	0.8	3.3	μA	-40°C	VDD = 5V					
		1.1	4.1	μA	+25°C	Regulator Enabled					
		1.1	4.2	μA	+85°C						

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

**3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).

5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).

**6:** LCD glass is not connected; resistor current is not included.

# 查询PIC18F86K90供应商 31.3 DC Characteristics: PIC18F87K90 Family (Industrial)

DC CHA	ARACTE	RISTICS				unless otherwise stated) ≤ +85°C for industrial
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
	VIL	Input Low Voltage				
		All I/O Ports:				
D030		with TTL Buffer	Vss	0.15 Vdd	V	VDD < 4.5V
D031		with Schmitt Trigger Buffer	—	0.8	V	$4.5 \leq V\text{DD} \leq 5.5 V$
		RC3, RC4	Vss	0.3 Vdd	V	VDD < 4.5
		RD5, RD6	Vss	1.5	V	$4.5 \le V \text{DD} \le 5.5 \text{V}$
D032		MCLR	Vss	0.2 VDD	V	
D033		OSC1	Vss	0.3 VDD	V	LP, XT, HS, HSPLL modes
D033A		OSC1	Vss	0.2 VDD	V	EC, ECPLL modes
D034		SOSCI	Vss	0.3 Vdd	V	
	Viн	Input High Voltage I/O Ports:				
D040		with TTL Buffer	0.25 VDD	Vdd	V	VDD < 4.5V
			2.0	Vdd		$4.5 \leq V \text{DD} \leq 5.5 \text{V}$
D041		with Schmitt Trigger Buffer	0.8 Vdd	Vdd	V	
		RC3, RC4	0.7 Vdd	Vdd	V	VDD < 4.5
		RD5, RD6	3V	5.5	V	$4.5 \leq V \text{DD} \leq 5.5 \text{V}$
D042		MCLR	0.8 Vdd	Vdd	V	
D043		OSC1	0.7 Vdd	Vdd	V	LP, XT, HS, HSPLL modes
D043A		OSC1	0.8 Vdd	Vdd	V	EC, ECPLL modes
D044		SOSCI	0.7 Vdd	Vdd	V	
	lı∟	Input Leakage Current <sup>(1)</sup>				
D060		I/O Ports	±50	±200	nA	$Vss \le VPIN \le VDD,$ Pin at High-Impedance
D061		MCLR	_	±5	μA	$Vss \leq V PIN \leq V DD$
D063		OSC1	—	±5	μA	$Vss \leq V PIN \leq V DD$
	IPU	Weak Pull-up Current				
D070	IPURB	PORTB Weak Pull-up Current	50	400	μA	VDD = 3.3V, VPIN = VSS

### 查询PIC18F86K90供应商

31.3 DC Characteristics: PIC18F87K90 Family (Industrial) (Continued)

DC CHA	ARACTE	RISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial					
Param No.	Symbol	Characteristic	Min	Мах	Units	Conditions		
	Vol	Output Low Voltage						
D080		I/O Ports:						
		PORTA, PORTF, PORTG, PORTH	_	0.6	V	Io∟ = 2 mA, VDD = 4.5V, -40°C to +85°C		
		PORTB, PORTC, PORTD, PORTE, PORTJ	_	0.6	V	Io∟ = 3.4 mA, VDD = 4.5V, -40°C to +85°C		
D083		OSC2/CLKO (EC, ECPLL modes)	_	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C		
	Vон	Output High Voltage <sup>(1)</sup>						
D090		I/O Ports:			V			
		PORTA, PORTF, PORTG, PORTH	Vdd - 0.7	—	V	IOH = -2 mA, VDD = 3.3V, -40°C to +85°C		
		PORTB, PORTC,PORTD, PORTE, PORTJ	Vdd - 0.7	—	V	IOH = -2 mA, VDD = 3.3V, -40°C to +85°C		
D092		OSC2/CLKO (INTOSC, EC, ECPLL modes)	Vdd - 0.7	—	V	IOH = -1 mA, VDD = 3.3V, -40°C to +85°C		
		Capacitive Loading Specs on Output Pins						
D100 <sup>(4)</sup>	COSC2	OSC2 Pin	_	20	pF	In HS mode when external clock is used to drive OSC1		
D101	Сю	All I/O Pins and OSC2	_	50	pF	To meet the AC Timing Specifications		
D102	Св	SCLx, SDAx	—	400	pF	I <sup>2</sup> C™ Specification		

**Note 1:** Negative current is defined as current sourced by the pin.

### 31.4 DC Characteristics: CTMU Current Source Specifications

DC CH	DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Param No.	Sym	Characteristic	Min	Typ <sup>(1)</sup>	Мах	Units	Conditions		
	IOUT1	CTMU Current Source, Base Range	—	550		nA	CTMUICON<1:0> = 01		
	IOUT2	CTMU Current Source, 10x Range	_	5.5	_	μA	CTMUICON<1:0> = 10		
	IOUT3	CTMU Current Source, 100x Range	_	55	_	μA	CTMUICON<1:0> = 11		

**Note 1:** Nominal value at center point of current trim range (CTMUICON<7:2> = 000000).

### 查询PIC18F86K90供应商

#### TABLE 31-1: MEMORY PROGRAMMING REQUIREMENTS

DC CH	ARACTE	ERISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C $\leq$ TA $\leq$ +85°C for industrial				
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
		Internal Program Memory Programming Specifications <sup>(1)</sup>					
D110	VPP	Voltage on MCLR/VPP/RE5 pin	VDD + 4.5	—	9	V	(Note 3)
D113	IDDP	Supply Current during Programming	_	_	10	mA	
		Data EEPROM Memory					(Note 2)
D120	ED	Byte Endurance	100K	1000K	_	E/W	-40°C to +85°C
D121	Vdrw	VDD for Read/Write	1.8	—	3.6	V	Using EECON to read/write
D122	TDEW	Erase/Write Cycle Time	—	4	—	ms	
D123	TRETD	Characteristic Retention	40	—	—	Year	Provided no other specifications are violated
D124	Tref	Number of Total Erase/Write Cycles before Refresh <sup>(2)</sup>	1M	10M	—	E/W	-40°C to +85°C
		Program Flash Memory					
D130	Eр	Cell Endurance	10K	_	_	E/W	-40°C to +85°C
D131	Vpr	VDD for Read	1.8	_	5.5	V	ENVREG tied to VDD
			1.8	—	3.3	V	ENVREG tied to Vss
D132B	VPEW	Voltage for Self-Timed Erase or Write Operations					
		VDD	1.8	—	5.5	V	ENVREG tied to VDD
D133A	Tiw	Self-Timed Write Cycle Time	—	2	—	ms	
D134	TRETD	Characteristic Retention	40	—	—	Year	Provided no other specifications are violated
D135	IDDP	Supply Current during Programming	—	—	10	mA	
D140	TWE	Writes per Erase Cycle	—	—	1		For each physical address

† Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** These specifications are for programming the on-chip program memory through the use of table write instructions.

2: Refer to Section 8.8 "Using the Data EEPROM" for a more detailed discussion on data EEPROM endurance.

**3:** The MPLAB<sup>®</sup> ICD 2 does not support variable VPP output. Circuitry to limit the ICD 2 VPP voltage must be placed between the ICD 2 and target system when programming or debugging with the ICD 2.

### 查询PIC18F86K90供应商

### TABLE 31-2: COMPARATOR SPECIFICATIONS

Operating	<b>Dperating Conditions:</b> $1.8V \le VDD \le 5V$ , $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Мах	Units	Comments
D300	VIOFF	Input Offset Voltage	—	±5.0	40	mV	
D301	VICM	Input Common-Mode Voltage	_	—	AVDD - 1.5	V	
D302	CMRR	Common-Mode Rejection Ratio	55	—	—	dB	
D303	TRESP	Response Time <sup>(1)</sup>	_	150	400	ns	
D304	Тмс2о∨	Comparator Mode Change to Output Valid*	—	—	10	μS	

**Note 1:** Response time measured with one comparator input at (AVDD – 1.5)/2, while the other input transitions from Vss to VDD.

### TABLE 31-3: VOLTAGE REFERENCE SPECIFICATIONS

Operating	<b>Operating Conditions:</b> $1.8V \le V_{DD} \le 5V$ , $-40^{\circ}C \le T_A \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments
D310	VRES	Resolution	VDD/24	_	VDD/32	LSb	
D311	VRAA	Absolute Accuracy	—	_	1/2	LSb	
D312	VRur	Unit Resistor Value (R)	—	2k	—	Ω	
D313	TSET	Settling Time <sup>(1)</sup>	—		10	μS	

**Note 1:** Settling time measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'.

#### TABLE 31-4: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Operatir	<b>Operating Conditions:</b> -40°C $\leq$ TA $\leq$ +85°C (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments
	Vrgout	Regulator Output Voltage		3.3		V	
	Cefc	External Filter Capacitor Value	4.7	10		μF	Capacitor must be low-ESR, a low series resistance (< 5Ω)

### 查询PIC18F86K90供应商

### 31.5 AC (Timing) Characteristics

#### 31.5.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2pp	S	3. Tcc:st	(I <sup>2</sup> C specifications only)
2. TppS		4. Ts	(I <sup>2</sup> C specifications only)
Т			
F	Frequency	Т	Time
Lowercase	letters (pp) and their meanings:		
рр			
сс	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Uppercase	letters and their meanings:	·	
S			
F	Fall	Р	Period
н	High	R	Rise
I	Invalid (High-Impedance)	V	Valid
L	Low	Z	High-Impedance
I <sup>2</sup> C only			
AA	output access	High	High
BUF	Bus free	Low	Low
TCC:ST (I <sup>2</sup> C	specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

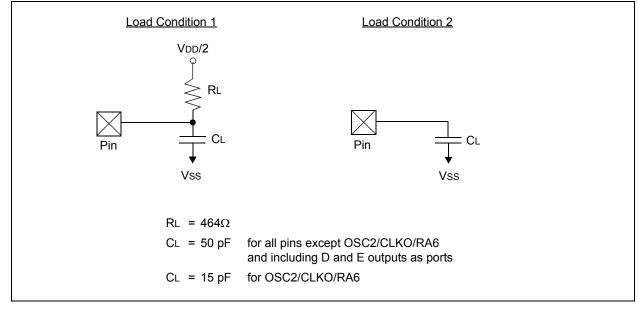
#### 查询PIC18F86K90供应商 31.5.2 IIMING CONDITIONS

The temperature and voltages specified in Table 31-5 apply to all timing specifications unless otherwise noted. Figure 31-3 specifies the load conditions for the timing specifications.

#### TABLE 31-5: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC

	Standard Operating Conditions (unless otherwise stated)
AC CHARACTERISTICS	Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial
	Operating voltage VDD range as described in <b>Section 31.1</b> and <b>Section 31.3</b> .

#### FIGURE 31-3: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



#### 查询PIC18F86K90供应商 31.5.3 TIMING DIAGRAMS AND SPECIFICATIONS FIGURE 31-4: EXTERNAL CLOCK TIMING 0SC1 04 01 02 03 04 01 1 0SC1 04 01 02 04 01 0 0SC1 04 01 02 04 01 0 0SC1 04 01 0 0SC1 04 01 0 0SC1 04 01 0 0SC1 04 0 0SC1 04

#### TABLE 31-6: EXTERNAL CLOCK TIMING REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	Fosc	External CLKIN Frequency <sup>(1)</sup>	DC	64	MHz	EC, ECIO Oscillator mode
		Oscillator Frequency <sup>(1)</sup>	DC	4	MHz	RC Oscillator mode
			0.1	4	MHz	XT Oscillator mode
			4	16	MHz	HS Oscillator mode
			4	16	MHz	HS + PLL Oscillator mode
			5	33	kHz	LP Oscillator mode
1	Tosc	External CLKIN Period <sup>(1)</sup>	15.6	_	ns	EC, ECIO Oscillator mode
		Oscillator Period <sup>(1)</sup>	250	_	ns	RC Oscillator mode
			250	10,000	ns	XT Oscillator mode
			40 62.5	250 250	ns ns	HS Oscillator mode HS + PLL Oscillator mode
			5	200	μS	LP Oscillator mode
2	Тсү	Instruction Cycle Time <sup>(1)</sup>	62.5	_	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1)	30		ns	XT Oscillator mode
	TosH	High or Low Time	2.5	_	μs	LP Oscillator mode
			10		ns	HS Oscillator mode
4	TosR,	External Clock in (OSC1)		20	ns	XT Oscillator mode
	TosF	Rise or Fall Time	—	50	ns	LP Oscillator mode
			—	7.5	ns	HS Oscillator mode

**Note 1:** Instruction cycle period (TCY) equals four times the input oscillator time base period for all configurations except PLL. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

### 查询PIC18F86K90供应商

#### TABLE 31-7: PLL CLOCK TIMING SPECIFICATIONS (VDD = 1.8V TO 5.5V)

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
F10	Fosc	Oscillator Frequency Range	4	_	5	MHz	VDD = 1.8-5.5V
			4		16	MHz	VDD = 3.0-5.5V, -40°C to +85°C
F11	Fsys	On-Chip VCO System Frequency	16	_	20	MHz	VDD = 1.8-5.5V
			16		64	MHz	VDD = 3.0-5.5V, -40°C to +85°C
F12	t <sub>rc</sub>	PLL Start-up Time (Lock Time)	_	_	2	ms	
F13	$\Delta \text{CLK}$	CLKOUT Stability (Jitter)	-2	_	+2	%	

† Data in "Typ" column is at 3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

#### TABLE 31-8: INTERNAL RC ACCURACY (INTOSC)

		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$						
Param No.	Min Typ Max Units Conditions				ditions			
OA1	HF-INTOSC Accuracy @ Freq	= 16 MHz, 8 MHz, 4 MHz, 2 MHz, 1 MHz, 500 kHz, 250 kHz <sup>(1)</sup>						
		-2	_	2	%	+25°C	VDD = 3.0-5.0V	
		-5		5	%	-40°C to +85°C	VDD = 3.0-5.0V	
		-5	_	5	%	-40°C to +85°C	VDD = 1.8-5.0V	
OA2	LF-INTOSC Accuracy @ Freq	= 31 kHz					•	
		-15		15	%	-40°C to +85°C	VDD = 1.8-5.0V	

Note 1: Frequency calibrated at 25°C. OSCTUNE register can be used to compensate for temperature drift.

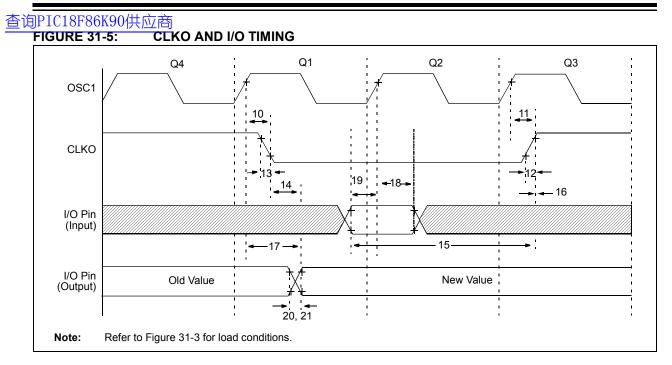


TABLE 31-9:	CLKO AND I/O TIMING REQUIREMENTS
-------------	----------------------------------

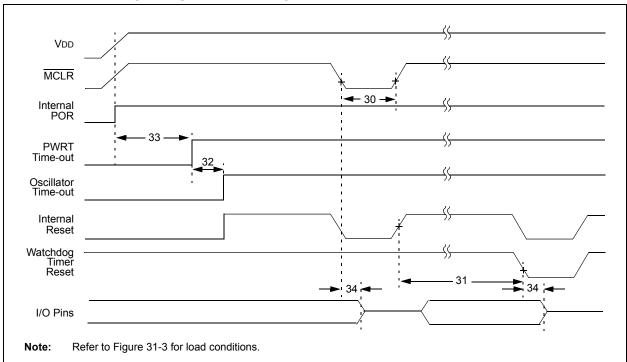
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
10	TosH2cĸL	OSC1 ↑ to CLKO ↓	—	75	200	ns	(Note 1)
11	TosH2ckH	OSC1 ↑ to CLKO ↑	—	75	200	ns	(Note 1)
12	TCKR	CLKO Rise Time	—	15	30	ns	(Note 1)
13	ТскF	CLKO Fall Time	—	15	30	ns	(Note 1)
14	TckL2IoV	CLKO $\downarrow$ to Port Out Valid	—		0.5 Tcy + 20	ns	
15	TioV2скH	Port In Valid before CLKO ↑	0.25 Tcy + 25		_	ns	
16	TckH2iol	Port In Hold after CLKO ↑	0			ns	
17	TosH2IoV	OSC1 ↑ (Q1 cycle) to Port Out Valid	—	50	150	ns	
18	TosH2ıol	OSC1 ↑ (Q2 cycle) to Port Input Invalid (I/O in hold time)	100	_	—	ns	
19	TioV2osH	Port Input Valid to OSC1 ↑ (I/O in setup time)	0	_	—	ns	
20	TIOR	Port Output Rise Time	—	10	25	ns	
21	TIOF	Port Output Fall Time		10	25	ns	
22†	Tinp	INTx pin High or Low Time	20	_	—	ns	
23†	Trbp	RB<7:4> Change INTx High or Low Time	Тсү		—	ns	

† These parameters are asynchronous events not related to any internal clock edges.

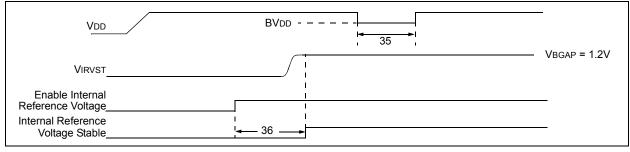
**Note 1:** Measurements are taken in EC mode, where CLKO output is 4 x Tosc.

### 查询PIC18F86K90供应商

FIGURE 31-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



#### FIGURE 31-7: BROWN-OUT RESET TIMING



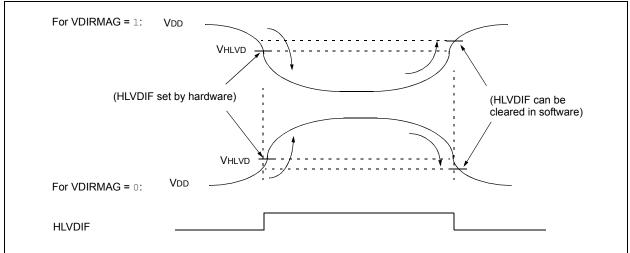
### 查询PIC18F86K90供应商

#### TABLE 31-10: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Тур	Мах	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2		—	μS	VDD = 3.3-5.0V, -40°C to +85°C
			5	_	_	μS	VDD = 3.3-5.0V
31	Twdt	Watchdog Timer Time-out Period (no postscaler)	—	4.00	—	ms	
32	Tost	Oscillation Start-up Timer Period	1024 Tosc	_	1024 Tosc	_	Tosc = OSC1 period
33	TPWRT	Power-up Timer Period	—	65.5	140	ms	
34	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	—	2	—	μS	
35	TBOR	Brown-out Reset Pulse Width	200	_	—	μS	$VDD \le BVDD$ (see D005)
36	TIRVST	Time for Internal Reference Voltage to become Stable	_	25	—	μS	
37	Thlvd	High/Low-Voltage Detect Pulse Width	200	_	—	μS	$V D D \leq V H L V D$
38	TCSD	CPU Start-up Time	5	_	10	μS	
39	TIOBST	Time for INTOSC to Stabilize		1	_	ms	

### 查询PIC18F86K90供应商

FIGURE 31-8: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS



#### TABLE 31-11: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

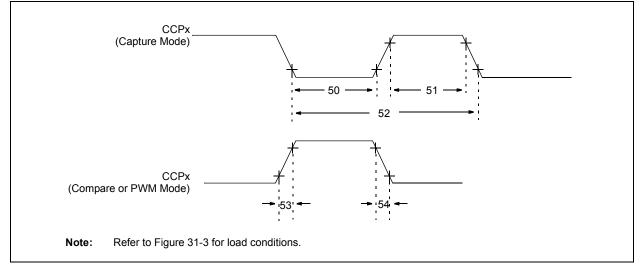
Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Sym	Charact	eristic	Min	Тур	Max	Units	Conditions	
D420		HLVD Voltage on VDD	HLVDL<3:0> = 0000	1.80	1.86	1.90	V		
		Transition High-to-Low	HLVDL<3:0> = 0001	2.03	2.12	2.13	V		
			HLVDL<3:0> = 0010	2.24	2.33	2.35	V		
			HLVDL<3:0> = 0011	2.40	2.49	2.53	V		
			HLVDL<3:0> = 0100	2.50	2.59	2.62	V		
			HLVDL<3:0> = 0101	2.70	2.75	2.84	V		
			HLVDL<3:0> = 0110	2.82	2.93	2.97	V		
			HLVDL<3:0> = 0111	2.95	3.07	3.10	V		
			HLVDL<3:0> = 1000	3.24	3.30	3.41	V		
			HLVDL<3:0> = 1001	3.42	3.48	3.59	V		
			HLVDL<3:0> = 1010	3.61	3.67	3.79	V		
			HLVDL<3:0> = 1011	3.82	3.87	4.01	V		
			HLVDL<3:0> = 1100	4.06	4.21	4.26	V		
			HLVDL<3:0> = 1101	4.33	4.42	4.55	V		
			HLVDL<3:0> = 1110	4.64	4.77	4.87	V		

查询PICI8F86K90供应商 FIGURE 31-9: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

Param No.	Symbol		Characteristic		Min	Мах	Units	Conditions
40	T⊤0H	T0CKI High F	ulse Width	No prescaler	0.5 Tcy + 20	—	ns	
				With prescaler	10	—	ns	
41	T⊤0L	T0CKI Low P	ulse Width	No prescaler	0.5 Tcy + 20	—	ns	
				With prescaler	10	—	ns	
42	T⊤0P	T0CKI Period	TOCKI Period		Tcy + 10	—	ns	
				With prescaler	Greater of: 20 ns or (TcY + 40)/N	_	ns	N = prescale value (1, 2, 4,, 256)
45	T⊤1H	TH T1CKI High Time	Synchronous,	no prescaler	0.5 TCY + 20	—	ns	
			Synchronous,	with prescaler	10	—	ns	
			Asynchronous		30	—	ns	
46	T⊤1L	T1CKI Low	Synchronous,	no prescaler	0.5 TCY + 5	—	ns	
		Time	Synchronous,	with prescaler	10	—	ns	
			Asynchronous		30	—	ns	
47	TT1P T1CKI Input Synchronous Period			Greater of: 20 ns or (Tcy + 40)/N	—	ns	N = prescale value (1, 2, 4, 8)	
			Asynchronous		60	—	ns	
	F⊤1	T1CKI Oscilla	ator Input Frequ	tor Input Frequency Range		50	kHz	
48	TCKE2TMRI	Delay from E	xternal T1CKI C ent	lock Edge to	2 Tosc	7 Tosc	—	

#### 查询PIC18F86K90供应商

FIGURE 31-10: CAPTURE/COMPARE/PWM TIMINGS (ECCP1, ECCP2 MODULES)



### TABLE 31-13: CAPTURE/COMPARE/PWM REQUIREMENTS (ECCP1, ECCP2 MODULES)

Param No.	Symbol	с	haracteristic	Min	Max	Units	Conditions
50	TccL	CCPx Input Low	No prescaler	0.5 Tcy + 20		ns	
		Time	With prescaler	10	—	ns	
51	TccH	CCPx Input	No prescaler	0.5 Tcy + 20		ns	
	Hig	High Time	With prescaler	10		ns	
52	TCCP	CCPx Input Perio	CCPx Input Period		_	ns	N = prescale value (1, 4 or 16)
53	TccR	CCPx Output Fal	ll Time	—	25	ns	
54	TCCF	CCPx Output Fal	ll Time	—	25	ns	

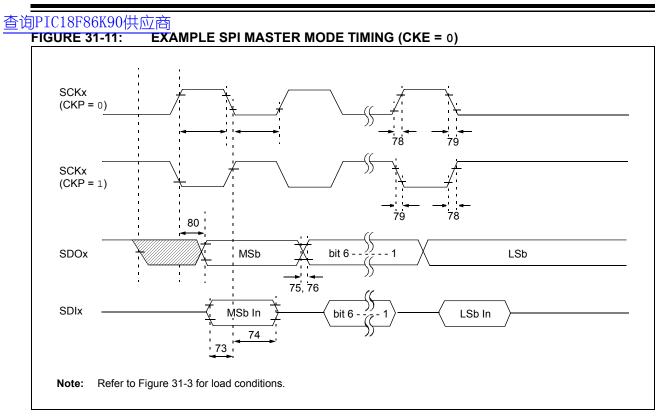


TABLE 31-14:	EXAMPLE SPI MODE REQUIREMENTS	(MASTER MODE, CKE = 0)
--------------	-------------------------------	------------------------

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	20		ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2	1.5 Tcy + 40	—	ns	
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge	40	—	ns	
75	TDOR	SDOx Data Output Rise Time	—	25	ns	
76	TDOF	SDOx Data Output Fall Time	—	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)	—	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)	—	25	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	_	50	ns	

#### 查询PIC18F86K90供应商 FIGURE 31-12: EXAMPLE SPI MASTER MODE TIMING (CKE = 1) SCKx (CKP = 0) 79 73 SCKx (CKP = 1) 80 78 SDOx MSb bit 6 -LSb - - 1

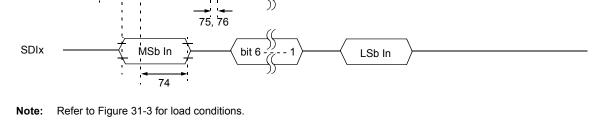


TABLE 31-15:	EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)	
--------------	--	--

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2	1.5 Tcy + 40	—	ns	
74	TscH2dlL, TscL2dlL	Hold Time of SDIx Data Input to SCKx Edge	40	_	ns	
75	TDOR	SDOx Data Output Rise Time	—	25	ns	
76	TDOF	SDOx Data Output Fall Time	—	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)	—	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)	—	25	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	50	ns	
81	TDOV2scH, TDOV2scL	SDOx Data Output Setup to SCKx Edge	Тсү	_	ns	

#### 查询PIC18F86K90供应商 FIGURE 31-13: EXAMPLE SPI SLAVE MODE TIMING (CKE = 0) SSx \$ 70 SCKx (CKP = 0) 83-72 79 78 SCKx (CKP = 1) 79 78 80 LSb MSb bit 6 SDOx - 1 → → 75, 76 77 MSb In SDIx bit 6 LSb In 74 73 Refer to Figure 31-3 for load conditions. Note:

#### TABLE 31-16: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

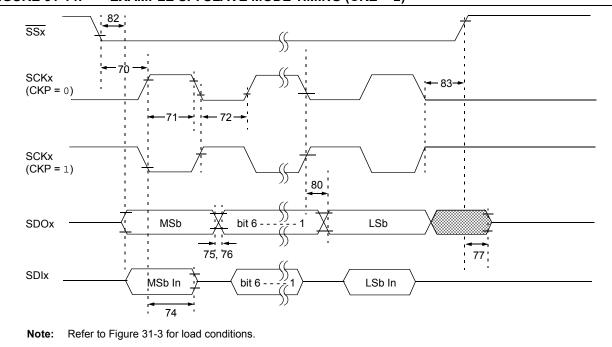
Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{\operatorname{SSx}}\downarrow$ to SCKx $\downarrow$ or SCKx $\uparrow$ Input		3 Тсү	_	ns	
70A	TssL2WB	SSx to write to SSPxBUF		3 TCY	—	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	—	ns	
71A		(Slave mode)	Single Byte	40	—	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	—	ns	
72A		(Slave mode)	Single Byte	40	—	ns	(Note 1)
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge		20	—	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clock Edge of Byte 2		1.5 Tcy + 40	—	ns	(Note 2)
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx	Edge	40	—	ns	
75	TDOR	SDOx Data Output Rise Time		—	25	ns	
76	TDOF	SDOx Data Output Fall Time		—	25	ns	
77	TssH2doZ	SSx ↑ to SDOx Output High-impedance	e	10	50	ns	
78	TscR	SCKx Output Rise Time (Master mode)		—	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)		—	25	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge		—	50	ns	
83	TscH2ssH, TscL2ssH	SSx		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

**2:** Only if Parameter #71A and #72A are used.

### 查询PIC18F86K90供应商

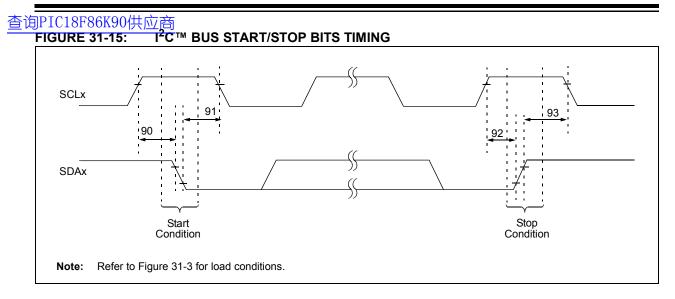
FIGURE 31-14: EXAMPLE SPI SLAVE MODE TIMING (CKE = 1)



Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{\text{SSx}} \downarrow$ to SCKx $\downarrow$ or SCKx $\uparrow$ Input		3 Тсү		ns	
70A	TssL2WB	SSx to write to SSPxBUF		3 TCY	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73A	Тв2в	Last Clock Edge of Byte 1 to the First	1.5 Tcy + 40	_	ns	(Note 2)	
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SC	Kx Edge	40		ns	
75	TDOR	SDOx Data Output Rise Time		—	25	ns	
76	TDOF	SDOx Data Output Fall Time		—	25	ns	
77	TssH2doZ	SSx ↑ to SDOx Output High-Impeda	ance	10	50	ns	
78	TscR	SCKx Output Rise Time (Master mo	de)		25	ns	
79	TscF	SCKx Output Fall Time (Master mod	le)		25	ns	
80	TSCH2DOV, TSCL2DOV	SDOx Data Output Valid after SCKx	—	50	ns		
82	TssL2doV	SDOx Data Output Valid after $\overline{\text{SSx}} \downarrow \text{Edge}$		_	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	

**Note 1:** Requires the use of Parameter #73A.

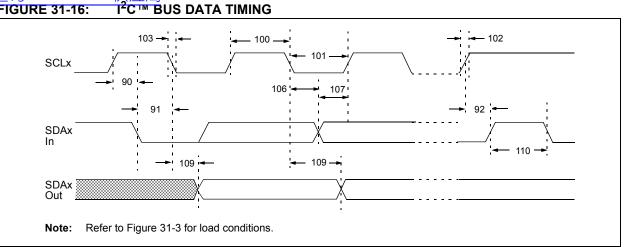
**2:** Only if Parameter #71A and #72A are used.



### TABLE 31-18: I<sup>2</sup>C<sup>™</sup> BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	TSU:STA	Start Condition	100 kHz mode	4700	_	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	600	—		Start condition
91	THD:STA	Start Condition	100 kHz mode	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	4700	_	ns	
		Setup Time	400 kHz mode	600	_		
93	THD:STO	Stop Condition	100 kHz mode	4000	_	ns	
		Hold Time	400 kHz mode	600	_		

#### 查询PIC18F86K90供应商 FIGURE 31-16: I<sup>2</sup>C™BUS DAT/

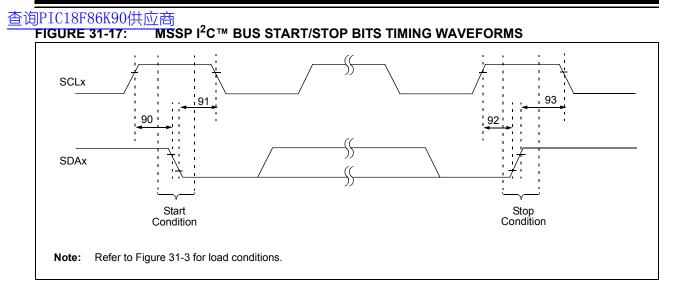


Param. No.	Symbol	Characteris	tic	Min	Мах	Units	Conditions
100	Тнідн	Clock High Time	100 kHz mode	4.0	—	μS	
			400 kHz mode	0.6		μS	
			MSSP module	1.5 TCY	—		
101	TLOW	Clock Low Time	100 kHz mode	4.7	_	μS	
			400 kHz mode	1.3	—	μS	
			MSSP module	1.5 TCY	_		
102	TR	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF
103	TF	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	
			400 kHz mode	20 + 0.1 Св	300	ns	CB is specified to be from 10 to 400 pF
90	TSU:STA	Start Condition Setup Time	100 kHz mode	4.7		μS	Only relevant for Repeated
			400 kHz mode	0.6		μS	Start condition
91	THD:STA	Start Condition Hold Time	100 kHz mode	4.0	_	μS	After this period, the first clock
			400 kHz mode	0.6	_	μS	pulse is generated
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250		ns	(Note 2)
			400 kHz mode	100		ns	
92	Tsu:sto	Stop Condition Setup Time	100 kHz mode	4.7		μS	
			400 kHz mode	0.6		μS	
109	ΤΑΑ	Output Valid from Clock	100 kHz mode	—	3500	ns	(Note 1)
			400 kHz mode		—	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	-	μS	Time the bus must be free before
			400 kHz mode	1.3	—	μS	a new transmission can start
D102	Св	Bus Capacitive Loading		_	400	pF	

### TABLE 31-19: I<sup>2</sup>C<sup>™</sup> BUS DATA REQUIREMENTS (SLAVE MODE)

**Note 1:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCLx to avoid unintended generation of Start or Stop conditions.

2: A Fast mode I<sup>2</sup>C<sup>™</sup> bus device can be used in a Standard mode I<sup>2</sup>C bus system, but the requirement, TSU:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, TR max. + TSU:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I<sup>2</sup>C bus specification), before the SCLx line is released.



### TABLE 31-20: MSSP I<sup>2</sup>C<sup>™</sup> BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	TSU:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)		ns	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Repeated Start
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	_		condition
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	After this period, the
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		first clock pulse is
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	_		generated
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	_		
93	THD:STO	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_	1	
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	_	]	

**Note 1:** Maximum pin capacitance = 10 pF for all  $I^2C^{TM}$  pins.

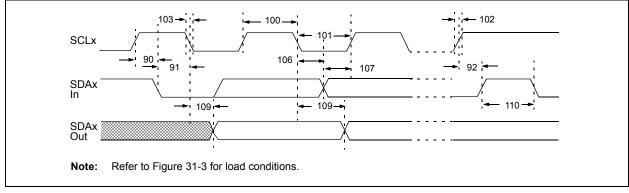


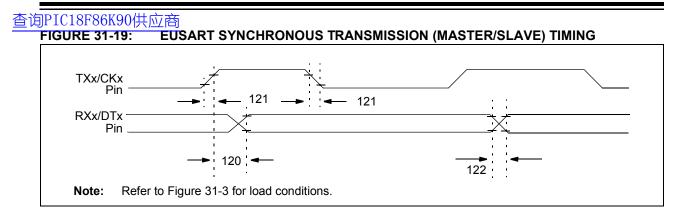
FIGURE 31-18: MSSP I<sup>2</sup>C<sup>™</sup> BUS DATA TIMING

### 查询PIC18F86K90供应商 TABLE 31-21: MSSPI<sup>2</sup>C™ BUS DATA REQUIREMENTS

Param. No.	Symbol	Charac	teristic	Min	Max	Units	Conditions
100	Тнідн	Clock High Time	100 kHz mode	2(Tosc)(BRG + 1)		_	
			400 kHz mode	2(Tosc)(BRG + 1)		_	
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	_	_	
101	TLOW	Clock Low Time	100 kHz mode	2(Tosc)(BRG + 1)	—		
			400 kHz mode	2(Tosc)(BRG + 1)	_	_	
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	—	_	
102	TR	SDAx and SCLx	100 kHz mode	—	1000	ns	CB is specified to be from
		Rise Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF
			1 MHz mode <sup>(1)</sup>	—	300	ns	
103	TF	SDAx and SCLx	100 kHz mode	—	300	ns	CB is specified to be from
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF
			1 MHz mode <sup>(1)</sup>	_	100	ns	
90	TSU:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)		_	Only relevant for Repeated
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)		_	Start condition
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)		_	
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	—	After this period, the first
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	—	_	clock pulse is generated
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)	—	_	
106	THD:DAT	Data Input	100 kHz mode	0	_	ns	
		Hold Time	400 kHz mode	0	0.9	μs	
			1 MHz mode <sup>(1)</sup>	_	—	ns	
107	TSU:DAT	Data Input	100 kHz mode	250	_	ns	(Note 2)
		Setup Time	400 kHz mode	100	_	ns	
			1 MHz mode <sup>(1)</sup>	_	_	ns	
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	—	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)		_	
			1 MHz mode <sup>(1)</sup>	2(Tosc)(BRG + 1)		_	
109	ΤΑΑ	Output Valid	100 kHz mode	_	3500	ns	
		from Clock	400 kHz mode	_	1000	ns	
			1 MHz mode <sup>(1)</sup>	—	—	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	—	μS	Time the bus must be free
			400 kHz mode	1.3	—	μs	before a new transmission
			1 MHz mode <sup>(1)</sup>	_	—	μS	can start
D102	Св	Bus Capacitive L	oading	—	400	pF	

**Note 1:** Maximum pin capacitance = 10 pF for all  $I^2C^{TM}$  pins.

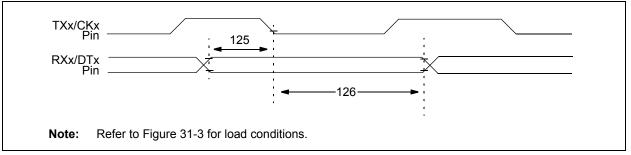
**2:** A Fast mode I<sup>2</sup>C bus device can be used in a Standard mode I<sup>2</sup>C bus system, but parameter #107  $\ge$  250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.



#### TABLE 31-22: EUSART/AUSART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic		Мах	Units	Conditions
120	TCKH2DTV	SYNC XMIT (MASTER and SLAVE) Clock High to Data Out Valid	_	40	ns	
121	TCKRF	Clock Out Rise Time and Fall Time (Master mode)	—	20	ns	
122	TDTRF	Data Out Rise Time and Fall Time	—	20	ns	

#### FIGURE 31-20: EUSART/AUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING



#### TABLE 31-23: EUSART/AUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TDTV2CKL	SYNC RCV (MASTER and SLAVE) Data Hold before $CKx \downarrow (DTx hold time)$	10		ns	
126	TCKL2DTL	Data Hold after CKx $\downarrow$ (DTx hold time)	15		ns	

### TABLE 31-24: ULTRA LOW-POWER WAKE-UP SPECIFICATIONS

	Standard Operating Conditions: 3.0V < VDD < 3.6V Operating temperature -40°C $\leq$ TA $\leq$ +85°C (unless otherwise stated)							
Param. No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments	
Dxxx	IULP	Ultra Low-Power Wake-up Sink Current	_	60			Net of I/O leakage and current sink at 1.6V on pin, VDD = 3.3V	

© 2010 Microchip Technology Inc.

#### 查询PIC18F86K90供应商

### TABLE 31-25: A/D CONVERTER CHARACTERISTICS: PIC18F87K90 FAMILY (INDUSTRIAL)

Param No.	Sym	Characteristic	Min	Тур	Мах	Units	Conditions
A01	NR	Resolution	—	_	12	bit	$\Delta V \text{REF} \ge 3.0 V$
A03	EIL	Integral Linearity Error	—	<±1	±2.0	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			—	—	±2.0	LSB	VDD = 5.0V
A04	Edl	Differential Linearity Error	—	<±1	+1.5/-1.0	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			_	—	+1.5/-1.0	LSB	VDD = 5.0V
A06	EOFF	Offset Error	—	<±1	±5	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			—	—	±3	LSB	VDD = 5.0V
A07	Egn	Gain Error	—	<±1	±1.25	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			—	—	±2.00	LSB	VDD = 5.0V
A10	_	Monotonicity	(	Guaranteed <sup>(</sup>	1)	_	$Vss \leq Vain \leq Vref$
A20	$\Delta VREF$	Reference Voltage Range (VREFH – VREFL)	3	—	Vdd - Vss	V	For 12-bit resolution
A21	Vrefh	Reference Voltage High	Vss + 3.0V	—	Vss + 3.0V	V	For 12-bit resolution
A22	Vrefl	Reference Voltage Low	Vss – 0.3V	—	Vss - 3.0V	V	For 12-bit resolution
A25	VAIN	Analog Input Voltage	VREFL	_	VREFH	V	
A30	Zain	Recommended Impedance of Analog Voltage Source	_	_	2.5	kΩ	
A50	IREF	VREF Input Current <sup>(2)</sup>	_	—	5	μA	During VAIN acquisition.
			—	—	150	μA	During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

2: VREFH current is from the RA3/AN3/VREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from the RA2/AN2/VREF-/CVREF pin or VSs, whichever is selected as the VREFL source.

#### 查询PIC18F86K90供应商 FIGURE 31-21: A/D CONVERSION TIMING BSF ADCON0, GO (Note 2) 131 Q4 130 132 A/D CLK A/D DATA 9 8 . . . 0 NEW\_DATA OLD DATA ADRES TCY (Note 1) ADIF GO DONE SAMPLING STOPPED SAMPLE If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to Note 1: be executed. 2: This is a minimal RC delay (typically 100 ns), which also disconnects the holding capacitor from the analog input.

### TABLE 31-26: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Мах	Units	Conditions
130	Tad	A/D Clock Period	0.8	12.5 <sup>(1)</sup>	μS	Tosc based, VREF $\geq$ 3.0V
			1.4	25 <sup>(1)</sup>	μS	VDD = 3.0V; TOSC based, VREF full range
			_	1	μS	A/D RC mode
			_	3	μS	VDD = 3.0V; A/D RC mode
131	TCNV	Conversion Time (not including acquisition time) <sup>(2)</sup>	14	15	Tad	
132	TACQ	Acquisition Time <sup>(3)</sup>	1.4		μS	-40°C to +85°C
135	Tswc	Switching Time from Convert $\rightarrow$ Sample	—	(Note 4)		
137	TDIS	Discharge Time	0.2	—	μS	

**Note 1:** The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES registers may be read on the following TCY cycle.

**3:** The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to Vss or Vss to VDD). The source impedance (Rs) on the input channels is 50 $\Omega$ .

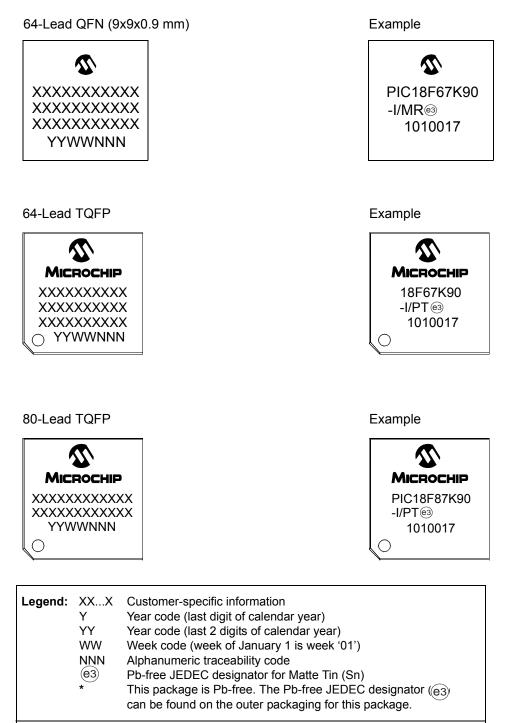
4: On the following cycle of the device clock.

查询PIC18F86K90供应商 NOTES:

### 查询PIC18F86K90供应商

### 32.0 PACKAGING INFORMATION

### 32.1 Package Marking Information



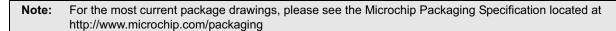
**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

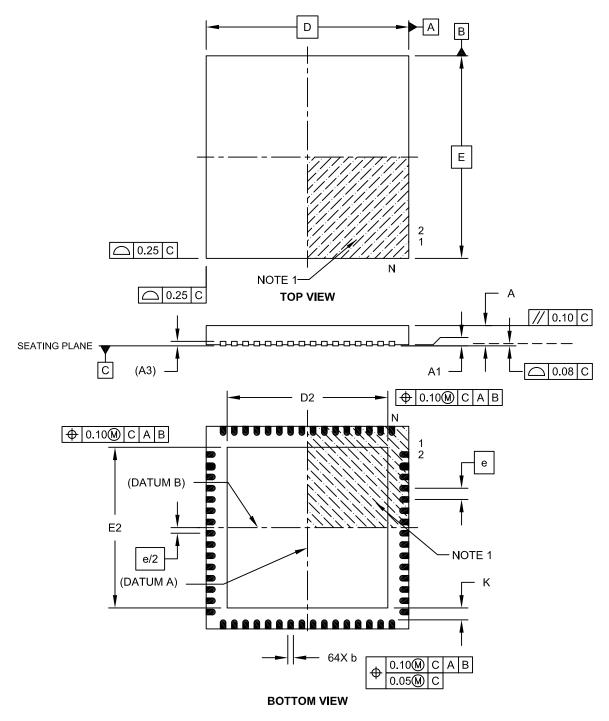
© 2010 Microchip Technology Inc.



The following sections give the technical details of the packages.

### 64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN]



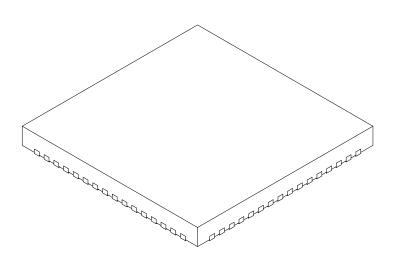


Microchip Technology Drawing C04-149B Sheet 1 of 2

### 查询PIC18F86K90供应商

### 64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN]

For the most current package drawings, please see the Microchip Packaging Specification located at Note: http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	64		
Pitch	е	0.50 BSC		
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.20 REF		
Overall Width	E	9.00 BSC		
Exposed Pad Width	E2	7.05 7.15 7.50		7.50
Overall Length	D	9.00 BSC		
Exposed Pad Length	D2	7.05 7.15 7.		7.50
Contact Width	b	0.18 0.25 0.3		0.30
Contact Length	L	0.30 0.40 0.5		0.50
Contact-to-Exposed Pad	K	0.20		-

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

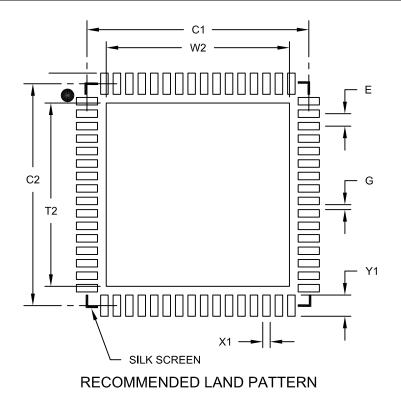
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-149B Sheet 2 of 2

### 查询PIC18F86K90供应商

64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN] With 0.40 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	E 0.50 BSC		
Optional Center Pad Width	W2			7.35
Optional Center Pad Length	T2			7.35
Contact Pad Spacing	C1		8.90	
Contact Pad Spacing	C2		8.90	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			0.85
Distance Between Pads	G	0.20		

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

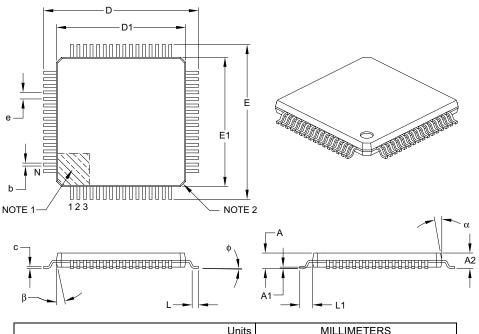
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2149A

### 查询PIC18F86K90供应商

#### 64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX	
Number of Leads	N	64			
Lead Pitch	е	0.50 BSC			
Overall Height	А	1.2			
Molded Package Thickness	A2	0.95	1.00	1.05	
Standoff	A1	0.05	-	0.15	
Foot Length	L	0.45	0.60	0.75	
Footprint	L1	1.00 REF			
Foot Angle	ф	0° 3.5° 7°		7°	
Overall Width	E	12.00 BSC			
Overall Length	D		12.00 BSC		
Molded Package Width	E1		10.00 BSC		
Molded Package Length	D1		10.00 BSC		
Lead Thickness	С	0.09 – 0.20		0.20	
Lead Width	b	0.17 0.22 0.27		0.27	
Mold Draft Angle Top	α	11° 12° 13°			
Mold Draft Angle Bottom	β	11° 12° 13°			

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

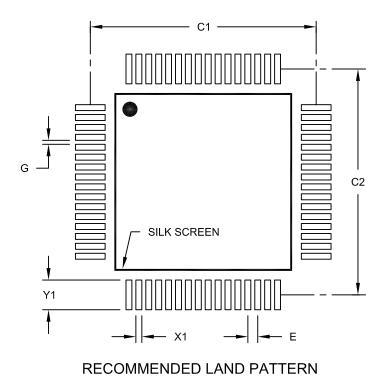
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085B

### 查询PIC18F86K90供应商

### 64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIM		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

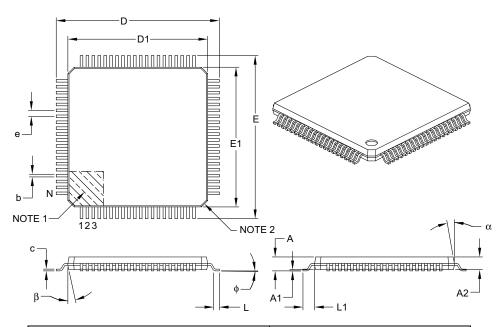
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2085A

### 查询PIC18F86K90供应商

#### 80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		5
	<b>Dimension Limits</b>	MIN	NOM	MAX
Number of Leads	N	80		
Lead Pitch	е	0.50 BSC		
Overall Height	А	-	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	—	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1	1.00 REF		
Foot Angle	φ	0° 3.5° 7°		7°
Overall Width	E		14.00 BSC	
Overall Length	D		14.00 BSC	
Molded Package Width	E1		12.00 BSC	
Molded Package Length	D1	12.00 BSC		
Lead Thickness	С	0.09	—	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11° 12° 13°		
Mold Draft Angle Bottom	β	11° 12° 13°		

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

- 4. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

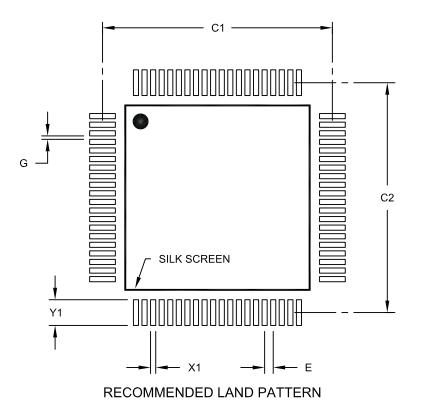
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-092B

### 查询PIC18F86K90供应商

### 80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		13.40	
Contact Pad Spacing	C2		13.40	
Contact Pad Width (X80)	X1			0.30
Contact Pad Length (X80)	Y1			1.50
Distance Between Pads	G	0.20		

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2092A

#### 查询PIC18F86K90供应商 APPENDIX A: REVISION HISTORY

### **Revision A (September 2009)**

Original data sheet for PIC18F87K90 family devices.

### **Revision B (April 2010)**

Changes to Section 32.0 "Packaging Information", including new packaging diagrams. Changes to some of the values in Section 31.0 "Electrical Characteristics". The new Section 2.0 "Guidelines for Getting Started with PIC18F Microcontrollers" has been added. Minor text edits throughout the document.

### APPENDIX B: MIGRATION FROM PIC18F85J90 AND PIC18F87J90 TO PIC18F87K90

Devices in the PIC18F87K90, PIC18F85J90 and PIC18F87J90 families are almost similar in their functions and features. Code can be migrated from the 18F85J90 to the PIC18F87K90 without many changes. The differences between the two device families are listed in Table B-1.

### 查询PIC18F86K90供应商

### TABLE B-1: NOTABLE DIFFERENCES BETWEEN PIC18F87K90, PIC18F87J90 AND PIC18F85J90 FAMILIES FAMILIES

FAIVIILIES			
Characteristic	PIC18F87K90 Family	PIC18F87J90 Family	PIC18F85J90 Family
Max Operating Frequency	64 MHz	48 MHz	40 MHz
Max Program Memory	128 Kbytes	128 Kbytes	32 Kbytes
Data Memory	4 Kbytes	4 Kbytes	2 Kbytes
Program Memory Endurance	10,000 Write/Erase (minimum)	10,000 Write/Erase (minimum)	1,000 Write/Erase (minimum)
Single-Word Write for Flash	Yes	Yes	No
Oscillator Options	PLL can be used with INTOSC	Yes	PLL cannot be used with INTOSC
CTMU	Yes	Yes	No
RTCC	Yes	Yes	No
SOSC Oscillator Options	Low-power oscillator option for SOSC	Low-power oscillator option for SOSC	No
TICKI Clock	T1CKI can be used as a clock without enabling the SOSC oscillator	No	No
INTOSC	Up to 16 MHz	8 MHz	8 MHz
SPI/I <sup>2</sup> C™	2	1	1
Timers	11	4	4
ECCP	3	No	No
ССР	7	2	2
Data EEPROM	Yes	No	No
Programmable BOR	Multiple level of BOR	No	No
WDT Prescale Options	22	16	16
5V Operation	Yes	No	No
nanoWatt XLP	Yes	No	No
Regulator	Yes	Yes	Yes
Low-Power BOR	Yes	No	No
ADC	24-Channel Differential (12-bit)	12-Channel Not differential (10-bit)	12-Channel Not Differential (10-bit)
Internal Temp Sensor	Yes	No	No
Programmable HLVD	Yes	No	No
EUSART	2 EUSARTs	1 EUSART, 1 AUSART	1 EUSART, 1 AUSART
Comparators	3	2	2
Oscillator Options	14 options by OSC<3:0>	8 options by OSC<3:0>	8 options by OSC<3:0>
Ultra Low-Power Wake-up (ULPW)	Yes	No	No
Power-up Timer	Yes	No	No
MCLR Pin as Input Port	Yes	No	No
LCD Charge Pump	No	Yes	Yes
Internal Resistor Ladder for Biasing	Yes	No	No

#### 查询PIC18F86K90供应商 INDEX

### Α

	<b>~</b> - 4
A/D	
A/D Converter Interrupt, Configuring	
Acquisition Requirements	
ADRESH Register	
Analog Port Pins, Configuring	
Associated Registers	
Automatic Acquisition Time	
Configuring the Module	380
Conversion Clock (TAD)	382
Conversion Requirements	
Conversion Status (GO/DONE Bit)	378
Conversions	
Converter Characteristics	538
Differential	371
Operation in Power-Managed Modes	
Use of the Special Event Triggers	
Absolute Maximum Ratings	
AC (Timing) Characteristics	
Load Conditions for Device Timing	
Specifications	520
Parameter Symbology	
Temperature and Voltage Specifications	
Timing Conditions	
ACKSTAT	
ACKSTAT Status Flag	331
ADCON0 Register GO/DONE Bit	070
ADDFSR	
ADDLW	
ADDULNK	
ADDWF	
ADDWFC	
ADRESL Register	
Analog and Digital Ports	154
Analog-to-Digital Converter. See A/D.	
ANDLW	456
ANDWF	.457
Assembler	
MPASM Assembler	500
D	
В	
Baud Rate Generator	333
BC	
BCF	458
BF	337
BF Status Flag	337
Block Diagrams	
A/D	.379
A/D Differential Channel Measurement	371
Analog Input Model	
Baud Rate Generator	
Capture Mode Operation	
Comparator Analog Input Model	
Comparator Configurations	
Comparator Output	
Comparator Voltage Reference	306
	550

CTMU Typical Connections and Internal Configuration for Pulse Delay Generation 419
CTMU Typical Connections and Internal
Configuration for Time Measurement
Device Clock
Enhanced PWM Mode
EUSART Receive
EUSART Transmit
External Clock Input, EC
External Clock Input, HS
External Power-on Reset Circuit
(Slow VDD Power-up)
Fail-Safe Clock Monitor (FSCM)
Full-Bridge Application
Generic I/O Port Operation 151
Half-Bridge Applications 258, 265
High/Low-Voltage Detect with External Input 400
Internal Reference and Contrast Control
Interrupt Logic 128
INTIO1 Oscillator Mode 47
INTIO2 Oscillator Mode 47
LCD Bias Internal Resistor Ladder Connection 280
LCD Clock Generation 278
LCD Driver Module 271
MSSPx (I <sup>2</sup> C Master Mode) 331
MSSPx (I <sup>2</sup> C Mode)
MSSPx (SPI Mode) 301
On-Chip Reset Circuit
Open-Drain Output 152
PIC18F6XK90
PIC18F8XK9013
PLL
PWM Operation (Simplified) 245
RC Oscillator Mode 46
RCIO Oscillator Mode 46
Reads from Flash Program Memory 113
RTCC
Simplified Steering
Single Comparator
SOSC External Components 189
SPI Master/Slave Connection
Table Read Operation 109
Table Write Operation 110
Table Writes to Flash Program Memory 115
Timer0 in 16-Bit Mode 182
Timer0 in 8-Bit Mode 182
Timer1
Timer2
Timer3/5/7
Timer4/6/8/10/12
Watchdog Timer
BN
BNC
BNN
BNOV
BNOV
BOR. See Brown-out Reset.
BOV. See Brown-out Reset. BOV
BOV
BRG. See Baud Rate Generator. 401
Brown-out Reset (BOR)
Detecting
Deteoding

Comparator Voltage Reference

Output Buffer Example ...... 397

### 查询PIC18F86K90供应商

BSF	101
BTFSC	
BTFSS	
BTG	
BZ	
С	
-	
C Compilers	
MPLAB C18	500
CALL	
CALLW	
Capture (CCP Module)	240
Associated Registers	244
CCP Pin Configuration	
CCPR4H:CCPR4L Registers	
5	
Prescaler	
Software Interrupt	
Timer1/3/5/7 Mode Selection	
Capture (ECCP Module)	253
CCPRxH:CCPRxL Registers	
ECCP Pin Configuration	
Prescaler	
Software Interrupt	
Timer1/Timer3 Mode Selection	
Capture/Compare/PWM (CCP)	
Capture Mode. See Capture.	
CCP Mode and Timer Resources	220
CCP6/7/8/9 Pin Assignment	240
CCPRxH Register	
-	
CCPRxL Register	
Compare Mode. See Compare.	
Configuration	
Open-Drain Output Option	
Charge Time Measurement Unit (CTMU)	
Associated Registers	421
Calibrating the Module	
Creating a Delay	419
Effects of a Reset	421
Measuring Capacitance with the CTMU	
Measuring Temperature with Use	
Measuring Time	110
	410
Madula Initialization	
Module Initialization	410
Module Initialization Operation	410
Operation	410 409
Operation During Sleep and Idle Modes	410 409 421
Operation During Sleep and Idle Modes Clock Sources	410 409 421 43
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset	410 409 421 43 44
Operation During Sleep and Idle Modes Clock Sources	410 409 421 43 44
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register	410 409 421 43 44 44
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF.	410 409 421 43 43 44 44 465
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register	410 409 421 43 43 44 44 465
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT	410 409 421 43 43 44 44 465
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples	410 409 421 43 44 44 44 465 465
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	410 409 421 43 44 44 44 465 465 465 126
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples	410 409 421 43 44 44 44 465 465 465 126
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine	
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine	
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine 8 x 8 Unsigned Multiply Routine	
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine	
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine	
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers	
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value	410 409 421 43 44 44 465 465 126 126 125 125 125 415 241, 253 87
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers	410 409 421 43 44 44 465 465 126 126 125 125 125 415 241, 253 87
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value	410 409 421 43 44 44 465 465 126 126 125 125 125 415 241, 253 87 413
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine Data EEPROM Read	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 6 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine Data EEPROM Read Data EEPROM Refresh Routine	410 409 421 43 44 44 465 465 126 126 125 125 125 415 241, 253 87 413 121
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine Data EEPROM Read Data EEPROM Refresh Routine Data EEPROM Write Data EEPROM Write Erasing a Flash Program Memory Row	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121 114
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121 114
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine Data EEPROM Read Data EEPROM Refresh Routine Data EEPROM Write Erasing a Flash Program Memory Row Fast Register Stack How to Clear RAM (Bank 1) Using Indirect	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121 121 87
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine Data EEPROM Read Data EEPROM Refresh Routine Data EEPROM Write Erasing a Flash Program Memory Row Fast Register Stack How to Clear RAM (Bank 1) Using Indirect	410 409 421 43 44 44 445 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121 121 87
Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	410 409 421 43 44 44 445 465 126 126 125 125 125 125 241, 253 87 413 121 122 121 114 87 

	158
Initializing PORTC	161
Initializing PORTD	164
Initializing PORTE	167
Initializing PORTF	170
Initializing PORTG	173
Initializing PORTH	
Initializing PORTJ	
Loading the SSP1BUF (SSP1SR) Register	
Reading a Flash Program Memory Word	
Routine for Capacitive Touch Switch	
Routine for Temperature Measurement	
Using Internal Diode	420
Saving STATUS, WREG and BSR	
Registers in RAM	1/0
Setting the RTCWREN Bit	
Setup for CTMU Calibration Routines	
Writing to Flash Program Memory	
Code Protection	
Associated Registers	
Data EEPROM	
Program Memory	
COMF	
Comparator	
Analog Input Connection Considerations	
Associated Registers	394
Control and Configuration	
Effects of a Reset	
Enable and Input Selection	391
Enable and Output Selection	391
Interrupts	393
Operation	390
Operation During Sleep	394
Response Time	
Comparator Specifications	
Comparator Voltage Reference	
Accuracy and Error	
Accuracy and Error Associated Registers	396
Associated Registers	396 397
Associated Registers Configuring	396 397 395
Associated Registers Configuring Connection Considerations	396 397 395 396
Associated Registers Configuring Connection Considerations Effects of a Reset	396 397 395 396 396
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep	396 397 395 396 396 396
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module)	396 397 395 396 396 396 242
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers	396 397 395 396 396 396 242 244
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module)	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module). CCPRx Register	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module). CCPRx Register Pin Configuration	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection.	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection. Computed GOTO.	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection. Computed GOTO. Configuration Bits	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Jimer3 Mode Selection. Computed GOTO. Configuration Bits Configuration Mismatch (CM) Reset. Configuration Register Protection.	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Corfiguration Register Protection Core Features Easy Migration	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Corfiguration Register Protection Core Features Easy Migration	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features Easy Migration Extended Instruction Set	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features Easy Migration Extended Instruction Set Memory Options	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24

#### 查询PIC18F86K90供应商 CPFSEQ

CPFSEQ	<u> </u>	
CPFSGT		
CPFSLT		
Crystal Oscil	lator/Ceramic Resonator	
Customer Ch	ange Notification Service	
Customer No	tification Service	
Customer Su	innort	562

### D

Data Addressing Modes	102
	102
Comparing Addressing Modes with the	100
Extended Instruction Set Enabled	
Direct	102
Indexed Literal Offset	
BSR	
Instructions Affected	105
Mapping Access Bank	
Indirect	102
Inherent and Literal	102
Data EEPROM Memory	
Associated Registers	123
EEADR and EEADRH Registers	
EECON1 and EECON2 Registers	119
Operation During Code-Protect	
Overview	
Protection, Spurious Writes	122
Reading	
Usage	
Write Verify	121
Writing	
Data Memory	
Access Bank	
Bank Select Register (BSR)	
Extended Instruction Set	
General Purpose Registers	
Memory Maps	
PIC18FX5K90/X7K90 Devices	
Special Function Registers	
Special Function Registers	
DAW	468
DC Characteristics	
CTMU Current Source	
PIC18F87K90 Family, Industrial	
Power-Down and Supply Current	
Supply Voltage	
DCFSNZ	469
DECF	468
DECFSZ	469
Default System Clock	
Details on Individual Family Members	10
Development Support	
Device Overview	
Features (64-Pin Devices)	
Features (80-Pin Devices)	
Direct Addressing	
E	
Effect on Standard PIC18 Instructions	106
Effects of Power-Managed Modes on Various	

Effects of Power-Managed Modes of Various	
Clock Sources	
Electrical Characteristics	503

Enhanced Capture/Compare/PWM (ECCP)	. 249
Capture Mode. See Capture.	
Compare Mode. See Compare.	
ECCP Mode and Timer Resources	. 252
Enhanced PWM Mode	. 255
Auto-Restart	. 264
Auto-Shutdown	. 262
Direction Change in Full-Bridge	
Output Mode	. 261
Full-Bridge Application	. 259
Full-Bridge Mode	
Half-Bridge Application	
Half-Bridge Application Examples	
Half-Bridge Mode	
Output Relationships (Active-High and	
Active-Low)	. 256
Output Relationships Diagram	. 257
Programmable Dead-Band Delay	265
Shoot-Through Current	. 265
Start-up Considerations	
Outputs and Configuration	
Enhanced Capture/Compare/PWM (ECCP1/2/3)	. 202
Associated Registers	270
Enhanced Universal Synchronous Asynchronous	. 270
Receiver Transmitter (EUSART). See EUSART.	
Equations	
16 x 16 Signed Multiplication Algorithm	126
16 x 16 Unsigned Multiplication Algorithm	
A/D Acquisition Time	
A/D Minimum Charging Time	
Calculating the Minimum Required	. 301
	004
Acquisition Time	
Errata	
Errata EUSART	8
Errata EUSART Asynchronous Mode	8
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and	8 . 357
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence	8 . 357 . 364
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive	8 . 357 . 364 . 361
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit	8 . 357 . 364 . 361 . 359
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break	8 . 357 . 364 . 361 . 359 . 362
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver	8 . 357 . 364 . 361 . 359 . 362
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with	8 . 357 . 364 . 361 . 359 . 362 . 360
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357 . 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG)	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 351 . 352
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 351 . 352 . 355
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357 . 351 . 351 . 352 . 355 . 352
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 351 . 355 . 352 . 355 . 352 . 353
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit)	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 351 . 355 . 355 . 352 . 353 . 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling	8 . 357 . 364 . 361 . 359 . 362 . 360 . 351 . 351 . 351 . 355 . 352 . 353 . 351 . 351 . 351 . 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 355 . 355 . 352 . 353 . 351 . 351 . 351 . 351 . 351 . 355 . 366 . 367 . 366 . 366 . 366 . 366 . 366 . 367 . 366 . 357 . 366 . 357 . 366 . 357 . 357 . 355 . 355
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 356 . 356
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Transmit	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 356 . 356 . 356 . 356 . 356 . 368 . 368 . 368
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Receive Associated Registers, Transmit Reception	8 . 357 . 364 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 352 . 353 . 351 . 355 . 352 . 353 . 351 . 355 . 352 . 353 . 355 . 355 . 352 . 353 . 355 . 356 . 356 . 356 . 368 . 368 . 368 . 368 . 368 . 367 . 368 . 367 . 3
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Receive Associated Registers, Transmit Reception Transmission	8 . 357 . 364 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 352 . 353 . 351 . 355 . 352 . 353 . 351 . 355 . 352 . 353 . 355 . 355 . 352 . 355 . 356 . 356 . 356 . 356 . 356 . 356 . 356 . 356 . 358 . 368 . 368 . 367 . 368 . 367 . 368 . 368 . 367 . 367 . 368 . 368 . 367 . 367 . 368 . 367 . 367
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Error, Calculating Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Transmit. Reception Transmission Synchronous Slave Mode	8 . 357 . 364 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 356 . 355 . 355 . 355 . 355 . 355 . 355 . 356 . 355 . 355 . 355 . 356 . 368 . 366 . 367 . 367 . 368 . 367 . 367
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Transmit. Reception Transmission Synchronous Slave Mode Associated Registers, Receive	8 . 357 . 364 . 359 . 362 . 360 . 360 . 360 . 351 . 351 . 352 . 355 . 356 . 357 . 357
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Transmit. Reception Transmission Synchronous Slave Mode Associated Registers, Receive Associated Registers, Transmit	8 . 357 . 364 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 355 . 356 . 357 . 357
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Transmit. Reception Transmission Synchronous Slave Mode Associated Registers, Receive	8 . 357 . 364 . 359 . 362 . 360 . 360 . 360 . 357 . 351 . 351 . 355 . 352 . 355 . 356 . 356 . 357 . 357 . 357 . 355 . 355 . 356 . 356 . 366 . 357 . 357 . 357 . 355 . 356 . 366 . 366 . 367 . 365 . 368 . 366 . 367 . 365 . 368 . 366 . 367 . 365 . 368 . 367 . 365 . 368 . 367 . 365 . 369 . 370 . 370

查询PICI8F86K90供应商	
Extended Instruction Set	
ADDFSR	
ADDULNK	
CALLW	
MOVSF	
MOVSS	
PUSHL	
SUBFSR	
SUBULNK	
External Oscillator Modes	
Clock Input (EC, ECPLL Modes)	
HS, HSPLL	44
F	
•	
Fail-Safe Clock Monitor	423, 443
Exiting Operation	
Interrupts in Power-Managed Modes	
POR or Wake from Sleep	
WDT During Oscillator Failure	
Fast Register Stack	87
Firmware Instructions	
Flash Program Memory	
Associated Registers	
Control Registers	
EECON1 and EECON2	110
TABLAT (Table Latch) Register	112
TBLPTR (Table Pointer) Register	112
Erase Sequence	114
Erasing	114
Operation During Code-Protect	117
Protection Against Spurious Writes	
Reading	

Boundaries Based on Operation......112 Table Reads and Table Writes ......109 Write Sequence ......115 Write Verify ......117 Writing To......115

#### н

G

Table Pointer

FSCM. See Fail-Safe Clock Monitor.

Hardware Multiplier	125
8 x 8 Multiplication Algorithms	125
Operation	125
Performance Comparison (table)	125
High/Low-Voltage Detect	399
Applications	402
Associated Registers	403
Current Consumption	401
Effects of a Reset	403
Operation	400
During Sleep	403
Setup	401
Start-up Time	401
Typical Low-Voltage Detect Application	402
HLVD. See High/Low-Voltage Detect.	

#### I

I/O Ports
Open-Drain Outputs
Output Pin Drive
Pin Capabilities
Pull-up Configuration 151
I <sup>2</sup> C Mode (MSSP)
Acknowledge Sequence Timing 340
Associated Registers
Baud Rate Generator
Bus Collision
During a Repeated Start Condition
During a Stop Condition
Clock Arbitration
Clock Stretching
•
10-Bit Slave Receive Mode (SEN = 1)
10-Bit Slave Transmit Mode
7-Bit Slave Receive Mode (SEN = 1) 326
7-Bit Slave Transmit Mode 326
Clock Synchronization and the CKP bit 327
Effects of a Reset 341
General Call Address Support
I <sup>2</sup> C Clock Rate w/BRG
Master Mode 331
Operation
Reception
Repeated Start Condition Timing
Start Condition Timing
<b>U</b>
Transmission
Multi-Master Communication, Bus Collision
and Arbitration
Multi-Master Mode 341
Operation
Read/Write Bit Information (R/W Bit)
Registers 311
Serial Clock (SCLx)
Slave Mode
Address Masking Modes
5-Bit
7-Bit
Addressing
-
Reception
Reception
Reception
Reception
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470
Reception         319           Transmission         319           Sleep Operation         341           Stop Condition Timing         340           ID Locations         423, 448           INCF         470           INCFSZ         471
Reception         319           Transmission         319           Sleep Operation         341           Stop Condition Timing         340           ID Locations         423, 448           INCF         470           INCFSZ         471           In-Circuit Debugger         448
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing and Standard PIC18 Instructions496
Reception       319         Transmission       319         Sleep Operation       341         Stop Condition Timing       340         ID Locations       423, 448         INCF       470         INCFSZ       471         In-Circuit Debugger       448         In-Circuit Serial Programming (ICSP)       423, 448         Indexed Literal Offset Addressing       and Standard PIC18 Instructions       496         Indexed Literal Offset Mode       496
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing400and Standard PIC18 Instructions496Indexed Literal Offset Mode496Indexed Literal Offset Mode496Indirect Addressing103
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing400and Standard PIC18 Instructions496Indirect Addressing103INFSNZ471
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing400and Standard PIC18 Instructions496Indirect Addressing103INFSNZ471
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing406Indexed Literal Offset Mode496Indirect Addressing103INFSNZ471Instruction Cycle88Clocking Scheme88
Reception319Transmission319Sleep Operation341Stop Condition Timing340ID Locations423, 448INCF470INCFSZ471In-Circuit Debugger448In-Circuit Serial Programming (ICSP)423, 448Indexed Literal Offset Addressing400and Standard PIC18 Instructions496Indirect Addressing103INFSNZ471

### 查询PIC18F86K90供应商 Instruction Set

truction Set	440
ADDLW	
ADDWF	
ADDWF (Indexed Literal Offset Mode)	497
ADDWFC	
ANDLW	
ANDWF	
BC	
BCF	458
BN	458
BNC	
BNN	
BNOV	
BNZ	
BOV	463
BRA	461
BSF	461
BSF (Indexed Literal Offset Mode)	
BTFSC	
BTFSS	
BTG	463
BZ	464
CALL	464
CLRF	
CLRWDT	
COMF	
CPFSEQ	466
CPFSGT	467
CPFSLT	467
DAW	
DCFSNZ	
DECF	
DECFSZ	469
Extended Instructions	
Extended Instructions	
Extended Instructions Considerations when Enabling	496
Extended Instructions Considerations when Enabling Svntax	496 491
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools	496 491 498
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO	496 491 498 451 470
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format	496 491 498 451 470
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ	496 491 498 451 470 470 471
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORWF	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORWF LFSR	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW LFSR MOVF	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW LFSR MOVF MOVF	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW LFSR MOVF	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW IORWF LFSR MOVF MOVFF MOVFF	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW IORWF LFSR MOVF MOVFF MOVFF MOVLB	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW IORWF LFSR MOVF MOVFF MOVFF MOVLB MOVLB MOVLW	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW IORWF LFSR MOVF MOVFF MOVFF MOVLB MOVLB MOVLW MOVWF	
Extended Instructions	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORLW IORWF LFSR MOVF MOVFF MOVFF MOVLB MOVLB MOVLW MOVWF	
Extended Instructions	496           491           498           451           470           471           472           473           474           475           476           477           476           477           478           478
Extended Instructions	496           491           498           451           470           471           472           473           474           475           476           477           474           475           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           478           478           479
Extended Instructions	496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           478           479           479
Extended Instructions	496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           478           479           479
Extended Instructions	496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           478           479           479           480
Extended Instructions	496           491           498           451           470           471           471           472           473           473           474           475           476           477           476           477           476           477           478           479           480
Extended Instructions	496           491           498           451           470           471           471           472           473           473           474           475           476           477           476           477           476           477           476           477           476           477           470           478           479           480           481
Extended Instructions	496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           478           479           480           481
Extended Instructions	496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           476           477           476           477           476           477           476           477           470           478           479           480           481           482

RRNCF	483
SETF	483
SETF (Indexed Literal Offset Mode)	
SLEEP	
Standard Instructions	
SUBFWB	
SUBLW	
SUBWF	
SUBWFB	
SWAPF	
TBLRD	
TBLWT	
TSTFSZ	
XORLW	
XORWF	
INTCON Register	
RBIF Bit	158
Inter-Integrated Circuit. See I <sup>2</sup> C.	
Internal Oscillator Block	47
Adjustment	
INTIO Modes	
INTOSC Frequency Drift	
INTOSC Output Frequency	
INTPLL Modes	
Internal RC Oscillator	
Use with WDT	438
Internal Voltage Regulator Specifications	400 518
Internet Address	562
Interrupt Sources	
A/D Conversion Complete	
Capture Complete (CCP)	
Capture Complete (ECCP)	
Compare Complete (CCP)	
Compare Complete (ECCP)	
Interrupt-on-Change (RB7:RB4)	
TMR0 Overflow	
TMR1 Overflow	
TMR2 to PR2 Match (PWM)	
TMRx Overflow	
TMRx to PRx Match	
TMRx to PRx Match (PWM)	
Interrupts	
Associated Registers	
During, Context Saving	
INTx Pin	
PORTB, Interrupt-on-Change	
TMR0	
Interrupts, Flag Bits	
Interrupt-on-Change (RB7:RB4) Flag	
(RBIF Bit)	158
TMR2 to PR2 Match Flag (TMR2IF Bit)	
INTOSC, INTRC. See Internal Oscillator Block.	
IORLW	472
IORWF	

#### L LCD

)		
	Associated Registers	299
	Bias Types	279
	Clock Source Selection	278
	Configuring the Module	298
	Frame Frequency	284
	Interrupts	296
	LCDCON Register	272
	LCDDATAx Registers	272
	LCDPS Register	272

### 查询PIC18F86K90供应商

LCDSEx Registers	
Multiplex Types	
Operation During Sleep	
Pixel Control	
Prescaler	278
Segment Enables	
Waveform Generation	
LCD Driver	10
LCDCON Register	272
LCDDATAx Registers	272
LCDPS Register	272
LP3:LP0 Bits	278
LCDSEx Registers	272
LFSR	473
Liquid Crystal Display (LCD) Driver	271

### м

Master Clear (MCLR)	69
Master Synchronous Serial Port (MSSP). See MSSP.	
Memory Organization	83
Data Memory	
Program Memory	83
Memory Programming Requirements	517
Microchip Internet Web Site	562
Migration From PIC18F85J90 and PIC18F87J90	
to PIC18F87K90	549
MOVF	473
MOVFF	474
MOVLB	474
MOVLW	475
MOVSF	493
MOVSS	494
MOVWF	
MPLAB ASM30 Assembler, Linker, Librarian	500
MPLAB Integrated Development Environment	
Software	
MPLAB PM3 Device Programmer	502
MPLAB REAL ICE In-Circuit Emulator System	
MPLINK Object Linker/MPLIB Object Librarian	500
MSSP	
ACK Pulse	6, 319
I <sup>2</sup> C Mode. See I <sup>2</sup> C Mode.	
Module Overview	
SPI Mode	
Associated Registers	
Bus Mode Compatibility	
Clock Speed, Interactions	
Effects of a Reset	
Enabling SPI I/O	
Master Mode	
Operation	
Operation in Power-Managed Modes	
Serial Clock	
Serial Data Out	
Slave Mode	
Slave Select	
Slave Select Synchronization	
SPI Clock	
SSPxBUF Register	
SSPxSR Register	
Typical Connection	
SPI Mode Serial Data In	
MULLW	
MULWF	476

### ...

N	
NEGF	477
NOP	477
Notable Differences Between PIC18F87K90,	
PIC18F87J90 and PIC18F85J90 Families	550
0	
On-Chip Regulator	423
On-Chip Voltage Regulator	
Enable/Disable by Hardware	440
Oscillator	
Reference Clock Output	49
Oscillator Configuration	39
EC	39
ECIO	39
HS	39
Internal Oscillator Block	47
INTIO1	39
INTIO2	39
LP	39
RC	39
RCIO	39
XT	39
Oscillator Selection	
Oscillator Start-up Timer (OST)	50
Oscillator Switching	43
Oscillator Transitions	44

#### Ρ

P1A/P1B/P1C/P1D.See Enhanced	
Capture/Compare/PWM (ECCP).	- 44
Packaging	
Details	
Marking	
Pin Functions	00.00
AVDD	,
AVss	,
	,
MCLR/RG5	,
OSC1/CLKI/RA7 OSC2/CLKO/RA6	
RA0/AN0/ULPWU	,
RA1/AN1/SEG18	,
RA2/AN2/VREF	,
RA3/AN3/REF+	
RA3/AN3/VREF+	
RA4/T0CKI/SEG14	
RA5/AN4/SEG15/T1CKI/T3G/HLVDIN	
RB0/INT0/SEG30/FLT0	,
RB0/INT0/SEG30/FLTO	
RB1/INT1/SEG8	
RB2/INT2/SEG9/CTED1	
RB3/INT3/SEG10/CTED2/ECCP2/P2A	- )
RB4/KBI0/SEG11	- )
RB5/KBI1/SEG29/T3CKI/T1G	
RB6/KBI2/PGC	
RB7/KBI3/PGD	,
RC0/SOSCO/SCKLI	- , -
RC0/SOSCO/SCLKI	
RC1/SOSCI/ECCP2/P2A/SEG32	17
RC1/SOSCI/ECCP2/SEG32/P2A	
RC2/ECCP1/P1A/SEG13	
RC3/SCK1/SCL1/SEG17	
	-

### 查询PIC18F86K90供应商

RC4/SDI1/SDA1/SEG16 17, 26
RC5/SDO1/SEG12 17, 26
RC6/TX1/CK1/SEG2717, 26
RC7/RX1/DT1/SEG28 17, 26
RD0/SEG0/CTPLS
RD1/SEG1/T5CKI/T7G
RD2/SEG2
RD3/SEG3
RD4/SEG4/SDO2
RD5/SEG5/SDI2/SDA218, 27
RD6/SEG6/SCK2/SCL218, 27
RD7/SEG7/SS2
RE0/LCDBIAS/P2D
RE0/LCDBIAS1/P2D19
RE1/LCDBIAS/P2C
RE1/LCDBIAS2/P2C
RE2/LCDBIAS3/P2B/CCP10 19, 28
RE3/COM0/P3C/CCP9/REFO 19, 28
RE4/COM1/P3B/CCP8 19, 28
RE5/COM2/P1C/CCP7 19, 28
RE6/COM3/P1B/CCP6
RE7/ECCP2/P2A/SEG31
RE7/ECCP2/SEG31/P2A
RF1/AN6/C2OUT/SEG19/CTDIN
RF2/AN7/C1OUT/SEG20
RF2/AN7/C1OUT/SEG20/CTMUI
RF3/AN8/SEG21/C2INB
RF3/AN8/SEG21/C2INB/CTMUI20
RF4/AN9/SEG22/C2INA
RF5/AN10
RF5/AN10/CVREF/SEG23/C1INB
RF6/AN11/SEG24/C1INA
DE7/ANE/001/0E/02E
RF7/AN5/SS1/SEG2520, 29
RF7/AN5/SS1/SEG2520, 29 RG0/ECCP3/P3A21, 30
RF7/AN5/SS1/SEG25
RF7/AN5/SS1/SEG2520, 29 RG0/ECCP3/P3A21, 30 RG1/TX2/CK2/AN19/C3OUT21, 30 RG2/RX2/DT2/AN18/C3INA21, 30
RF7/AN5/SS1/SEG25
RF7/AN5/SS1/SEG2520, 29 RG0/ECCP3/P3A21, 30 RG1/TX2/CK2/AN19/C3OUT21, 30 RG2/RX2/DT2/AN18/C3INA21, 30
RF7/AN5/SS1/SEG25
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31       RH1/SEG46/AN22       31
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31       RH1/SEG46/AN22       31         RH2/SEG45/AN21       31
RF7/AN5/SS1/SEG25
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33
RF7/AN5/SS1/SEG25
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ0       33         RJ1/SEG34       33         RJ3/SEG35       33         RJ4/SEG36       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         RJ7/SEG36       33         RJ7/SEG36       33         RJ7/SEG36       33         RJ7/SEG36       33         RJ7/SEG37       33         RJ7/SEG36       33         RJ7/SEG37       33         RJ7/SEG36       33         RJ7/SEG36
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH4/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ3/SEG35       33         RJ4/SEG37       33         RJ7/SEG36       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       33, 22
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       14         PIC18F6XK90       14
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         VS       33, 22         Pinout I/O Descriptions       33, 22         Pinout I/O Descriptions       14         PIC18F6XK90       14         PIC18F8XK90       22
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       14         PIC18F6XK90       14

PLL	
HSPLL and ECPLL Oscillator Modes	
Use with HF-INTOSC	
POP	478
POR. See Power-on Reset.	
PORTA	
Associated Registers	
LATA Register	
PORTA Register	
TRISA Register	155
PORTB	100
Associated Registers	
LATB Register PORTB Register	
RB7:RB4 Interrupt-on-Change Flag (RBIF Bit)	
TRISB Register	
PORTC	150
Associated Registers	163
LATC Register	
PORTC Register	
TRISC Register	
PORTD	
Associated Registers	166
LATD Register	
PORTD Register	
TRISD Register	164
PORTE	
Associated Registers	169
LATE Register	167
PORTE Register	
TRISE Register	167
PORTF	
Associated Registers	
LATF Register	
PORTF Register	
TRISF Register	170
PORTG	474
Associated Registers	
LATG Register PORTG Register	
TRISG Register	
PORTH	175
Associated Registers	177
LATH Register	
PORTH Register	
TRISH Register	
PORTJ	
Associated Registers	179
LATJ Register	
PORTJ Register	178
TRISJ Register	178
Power-Managed Modes	51
and PWM Operation	
and SPI Operation	
Clock Transitions and Status Indicators	
Entering	
Exiting Idle and Sleep Modes	
by Interrupt	
by Reset	
by WDT Time-out	
Without an Oscillator Start-up Delay	63

### 查询PIC18F86K90供应商

Idle Modes	
PRI_IDLE	
RC_IDLE	58
SEC_IDLE	
Multiple Sleep Commands	
Run Modes	52
PRI RUN	
—	
RC_RUN	53
SEC_RUN	
Selecting	
Sleep Mode	
OSC1 and OSC2 Pin States	
Summary (table)	
Power-on Reset (POR)	
Power-up Delays	
Power-up Timer (PWRT)	
Time-out Sequence	
Prescaler, Timer0	183
Prescaler, Timer2	246
PRI_IDLE Mode	
PRI_RUN Mode	
Program Counter (PC)	
PCL, PCH and PCU Registers	
PCLATH and PCLATU Registers	85
Program Memory	
Extended Instruction Set	104
Hard Memory Vectors	
Instructions	
Two-Word	89
Interrupt Vector	
Look-up Tables	87
Memory Maps	
Hard Vectors and Configuration Words	
Reset Vector	84
Program Verification	
Program Verification	445
Programming, Device Instructions	445 449
Programming, Device Instructions Pulse Steering	445 449
Programming, Device Instructions	445 449
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module).	445 449 266
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH	445 449 266 478
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions	445 
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH	445 
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL	445 
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module)	445 266 478 86 494
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers	445 266 478 86 494 247
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle	445 266 478 86 494 247 246
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers	445 266 478 86 494 247 246
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions	445 449 266 478 494 247 246 246
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period	445 266 478 478 494 494 247 246 246 246 246
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation	445 266 478 86 494 247 246 246 246 246 247
Programming, Device Instructions Pulse Steering. Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match	445 449 266 478 494 247 246 246 246 246 247 246
Programming, Device Instructions Pulse Steering. Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match	445 449 266 478 494 247 246 246 246 246 247 246
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit)	445 266 478 494 494 247 246 246 246 246 246 246 246 246 246 246 246 246 247 246 246 246 246 246 246 247 246 246 247 246 246 247 246 247 246 247 246 246 247 246 246 247 246 246 246 247 246 246 246 246 246 246 246 246 
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match	445 266 478 494 494 247 246 246 246 246 246 246 246 246 246 246 246 246 247 246 246 246 246 246 246 247 246 246 247 246 246 247 246 247 246 247 246 246 247 246 246 247 246 246 246 247 246 246 246 246 246 246 246 246 
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module)	445 449 266 478 494 494 247 246 246 246 246 246 211
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match	445 449 266 478 494 494 247 246 246 246 246 246 211
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset	445 266 266 478 494 247 246 
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes	445 266 266 478 494 247 246 246 246 246 246 211 269 269 269
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor	445 266 266 478 494 247 246 246 246 246 246 246 246 269 269 269 269 269
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering	445 266 266 478 494 247 246 246 246 246 246 246 246 269 269 269 269 269 269 269 269
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization	445 266 266 478 494 247 246 246 246 246 246 246 211 269 269 269 266 268
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization	445 266 266 478 494 247 246 246 246 246 246 246 211 269 269 269 266 268
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering	445 266 266 478 494 247 246 246 246 246 246 246 211 269 269 269 266 268
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization	445 266 266 478 494 247 246 246 246 246 246 246 211 269 269 269 266 268
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization PWM Mode. See Enhanced Capture/Compare/PWM	445 266 266 478 86 494 247 246 246 246 246 211 269 269 269 268 255
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match Flag (TMR2IF Bit) TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization PWM Mode. See Enhanced Capture/Compare/PWM	445 266 266 478 86 494 247 246 246 246 246 211 269 269 269 268 255
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match Flag (TMR2IF Bit)	445 266 266 478 86 494 247 246 246 246 246 211 269 269 269 268 255
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization PWM Mode. See Enhanced Capture/Compare/PWM	445 266 266 478 86 494 247 246 246 246 246 211 269 269 269 268 255
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization PWM Mode. See Enhanced Capture/Compare/PWM <b>Q</b> Q Clock <b>R</b>	445 266 266 478 86 494 247 246 246 246 246 211 269 269 269 268 255
Programming, Device Instructions Pulse Steering	445 266 478 266 494 247 246 246 246 246 246 269 269 269 268 255 246
Programming, Device Instructions Pulse Steering Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes Operation with Fail-Safe Clock Monitor Pulse Steering Steering Synchronization PWM Mode. See Enhanced Capture/Compare/PWM <b>Q</b> Q Clock <b>R</b>	445 266 266 478 86 494 247 246 246 246 246 269 269 269 269 268 1255 246

RC\_RUN Mode ......53

RCALL	. 479
RCON Register	
0	70
Bit Status During Initialization	
Reader Response	
Real-Time Clock and Calendar (RTCC)	. 215
Alarm	230
Configuring	
5 5	
Interrupt	
Mask Settings	. 231
Alarm Value Registers (ALRMVAL)	. 224
Clock Source	228
Control Registers	
Digit Carry Rules	. 228
Operation	. 227
Calibration	. 230
General Functionality	
Leap Year	
Register Mapping	
Register Reads/Writes, Safety Window	. 229
Write Lock	. 229
Register Interface	
Register Maps	
Registers	. 216
Reset	. 232
Device	. 232
Power-on Reset (POR)	232
RTCEN Bit Write	
Sleep Mode	
Value Registers (RTCVAL)	
Register File	92
Register File Summary	-100
Registers	
ADCON0 (A/D Control 0)	272
ADCON1 (A/D Control 1)	
ADCON2 (A/D Control 2)	. 374
ADRESH (A/D Result High Byte Left Justified,	
ADFM = 0)	. 375
ADRESH (A/D Result High Byte Right Justified,	
ADFM = 1)	376
,	. 370
ADRESL (A/D Result Low Byte Left Justified,	
ADFM = 0)	. 376
ADRESL (A/D Result Low Byte Right Justified,	
ADFM = 1)	. 376
ALRMCFG (Alarm Configuration)	219
ALRMDAY (Alarm Day Value)	
ALRMHR (Alarm Hours Value)	
ALRMMIN (Alarm Minutes Value)	
ALRMMNTH (Alarm Month Value)	. 224
ALRMRPT (Alarm Repeat)	. 220
ALRMSEC (Alarm Seconds Value)	
ALRMWD (Alarm Weekday Value)	
ANCON0 (A/D Port Configuration 0)	
ANCON1 (A/D Port Configuration 1)	
ANCON2 (A/D Port Configuration 2)	. 378
BAUDCONx (Baud Rate Control)	
CCPRxH (CCPx Period High Byte)	
CCPRxL (CCPx Period Low Byte)	
CCPTMRS0 (CCP Timer Select 0)	
CCPTMRS1 (CCPx Timer Select 1)	
CCPTMRS2 (CCPx Timer Select 2)	
CCPxCON (CCPx Control, CCP4-CCP10)	
CCPxCON (Enhanced Capture/Compare/PWM x	
Control)	250
CMSTAT (Comparator Status)	
CMxCON (Comparator Control x)	. 388

#### 查询PIC18F86K90供应商 CONFIG1H (Configuration 1 High) ...... 426 CONFIG1L (Configuration 1 Low)...... 425 CONFIG2H (Configuration 2 High) ...... 428 CONFIG3H (Configuration 3 High) ...... 429 CONFIG4L (Configuration 4 Low)...... 430 CONFIG5H (Configuration 5 High) ...... 432 CONFIG6H (Configuration 6 High) ...... 434 CONFIG7H (Configuration 7 High) ...... 436 CONFIG7L (Configuration 7 Low)......435 CTMUCONH (CTMU Control High) ...... 406 CTMUICON (CTMU Current Control) ...... 408 CVRCON (Comparator Voltage EECON1 (Data EEPROM Control 1).....120 EECON1 (EEPROM Control 1)..... 111 HLVDCON (High/Low-Voltage Detect Control)...... 399 INTCON (Interrupt Control)..... 129 INTCON2 (Interrupt Control 2)......130 IPR1 (Peripheral Interrupt Priority 1)......143 IPR2 (Peripheral Interrupt Priority 2).....144 IPR3 (Peripheral Interrupt Priority 3).....145 IPR4 (Peripheral Interrupt Priority 4)......145 IPR5 (Peripheral Interrupt Priority 5)......146 IPR6 (Peripheral Interrupt Priority 6).....147 LCDCON (LCD Control)......272 LCDREF (LCD Reference Voltage Control)......274 LCDRL (LCD Reference Ladder Control) ...... 275 LCDSEx (LCD Segmentx Enable) ...... 276 ODCON1 (Peripheral Open-Drain Control 1)......152 ODCON2 (Peripheral Open-Drain Control 2)......153 ODCON3 (Peripheral Open-Drain Control 3).....154 OSCCON (Oscillator Control) ...... 41 OSCTUNE (Oscillator Tuning)......43 PIE1 (Peripheral Interrupt Enable 1)...... 138 PIE2 (Peripheral Interrupt Enable 2)......139 PIE3 (Peripheral Interrupt Enable 3)......140 PIE4 (Peripheral Interrupt Enable 4)......140 PIE5 (Peripheral Interrupt Enable 5)......141 PIE6 (Peripheral Interrupt Enable 6)......142 PIR2 (Peripheral Interrupt Request (Flag) 2) ...... 133 PIR3 (Peripheral Interrupt Request (Flag) 3) ...... 134 PIR4 (Peripheral Interrupt Request (Flag) 4) ...... 135 PIR5 (Peripheral Interrupt Request (Flag) 5) ...... 136 PIR6 (Peripheral Interrupt Request (Flag) 6) ...... 137 PMD0 (Peripheral Module Disable 0) ......62 PMD1 (Peripheral Module Disable 1) ......61

PMD2 (Peripheral Module Disable 2) PMD3 (Peripheral Module Disable 3)	
PSTRxCON (Pulse Steering Control)	
RCON (Reset Control)	
RCSTAx (Receive Status and Control)	
REFOCON (Reference Oscillator Control)	
Reserved	
RTCCAL (RTCC Calibration)	218
RTCCFG (RTCC Configuration)	
SECOND (Second Value)	223
SSPxCON1 (MSSPx Control 1, I <sup>2</sup> C Mode)	313
SSPxCON1 (MSSPx Control 1, SPI Mode)	
SSPxCON2 (MSSPx Control 2, I <sup>2</sup> C	
Master Mode)	314
SSPxCON2 (MSSPx Control 2, I <sup>2</sup> C Slave Mode)	315
SSPxMSK (I <sup>2</sup> C Slave Address Mask, 7-Bit)	315
SSPxSTAT (MSSPx Status, I <sup>2</sup> C Mode)	
SSPxSTAT (MSSPx Status, SPI Mode)	
STATUS	
STKPTR (Stack Pointer)	86
T0CON (Timer0 Control)	
T1CON (Timer1 Control)	185
T1GCON (Timer1 Gate Control)	
T2CON (Timer2 Control)	
TxCON (Timer3/5/7 Control)	
TxCON (Timer4/6/8/10/12 Control)	
TxGCON (Timer3/5/7 Gate Control)	
TXSTAx (Transmit Status and Control)	
WDTCON (Watchdog Timer Control)	
WEEKDAY (Weekday Value)	
YEAR (Year Value)	
RESET	
Reset	
Brown-out Reset (BOR) Configuration Mismatch (CM) Reset	
MCLR Reset, During Power-Managed Modes	
MCLR Reset, Normal Operation	
Power-on Reset (POR)	
RESET Instruction	
Stack Full Reset	
Stack Underflow Reset	
Watchdog Timer (WDT) Reset	
Resets	
Brown-out Reset (BOR)	
Oscillator Start-up Timer (OST)	
Power-on Reset (POR)	423
Power-up Timer (PWRT)	
RETFIE	
RETLW	480
RETURN	481
Return Address Stack	
Return Stack Pointer (STKPTR)	86
Revision History	
RLCF	549
	549 481
RLNCF	549 481 482
RRCF	549 481 482 482
	549 481 482 482

### S

SCKx	301
SDIx	301
SDOx	301
SEC_IDLE Mode	57
SEC_RUN Mode	52
Secondary Oscillator (SOSC)	43

### 查询PIC18F86K90供应商。

Selecting Peripheral Module Control	
Serial Clock, SCKx	
Serial Data In (SDIx)	
Serial Data Out (SDOx)	301
Serial Peripheral Interface. See SPI Mode.	
SETF	
Shoot-Through Current	
Slave Select (SSx)	
SLEEP	
Software Simulator (MPLAB SIM)	501
Special Event Trigger. See Compare (CCP Module)	
Special Event Trigger. See Compare (ECCP Mode).	
SSPOV	
SSPOV Status Flag	
SSPxSTAT Register	
R/W Bit	.316, 319
SSx	301
Stack Full/Underflow Resets	
SUBFSR	
SUBFWB	
SUBLW	
SUBULNK	
SUBWF	
SUBWFB	
SWAPF	

### Т

Table Reads/Table Writes       87         TBLRD       487         TBLWT       488         Timer0       181         Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       189         Resetting, Using the ECCP       Special Event Trigger         Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TI	Table Pointer Operations (table)	112
TBLWT       488         Timer0       181         Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TImer2       197         Associated Registers       198         Interrupt       198		
TBLWT       488         Timer0       181         Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger         Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TIMR1L Register       185         TIMEr2       198         Op	TBLRD	
Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger         Source Source Source       190         Use as a Clock Source       190         Use as a Clock Source       190         Use as a Clock Source       190         TIMR1H Register       185         Timer2       197         Associated Regist		
Operation182Overflow Interrupt183Prescaler183Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:T0PS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP185Special Event Trigger191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt198Operation197		
Overflow Interrupt183Prescaler183Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:T0PS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSDSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197	Associated Registers	183
Overflow Interrupt183Prescaler183Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:T0PS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSDSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197	Operation	182
Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:TOPS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197		
Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:TOPS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197	Prescaler	183
Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:TOPS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Prescaler Select (T0PS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (T0SE Bit)       182         Source Select (T0CS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       191         Source Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TMR1H Register       185         TImer2       197         Associated Registers       198         Interrupt.       198         Operation       197		
Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt.       198         Operation       197		
Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt198Operation197		
Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt198Operation197		
Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       187         Oscillator       185         Resetting, Using the ECCP       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       187         Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       187         Oscillator       185         Resetting, Using the ECCP       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TImer2197Associated Registers198Interrupt198Operation197		
Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TImer2197Associated Registers198Interrupt198Operation197		
Interrupt		
Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TIMEr2       197         Associated Registers       198         Interrupt       198         Operation       197		
Oscillator       185         Resetting, Using the ECCP       Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TIMEr2       197         Associated Registers       198         Interrupt       198         Operation       197	•	
Resetting, Using the ECCP       Special Event Trigger.       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197	•	
Special Event Trigger.191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TMR1L Register185Timer2197Associated Registers198Interrupt198Operation197		
SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		191
Layout Considerations		
Use as a Clock Source		
TMR1H Register       185         TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197	,	
TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Timer2		
Associated Registers		
Interrupt		
Operation		
Output 198		
PR2 Register		
TMR2 to PR2 Match Flag (TMR2IF Bit)		
TMR2 to PR2 Match Interrupt		

Timer3/5/7	199
16-Bit Read/Write Mode	204
Associated Registers	
Gates	204
Operation	
Overflow Interrupt 199	, 208
SOSC Oscillator	
Use as a Clock Source	
Special Event Trigger (ECCP)	208
TMRxH Register	
TMRxL Register	
Timer4/6/8/10/12	
Associated Registers	
Interrupt	
Operation	
Output	212
Outputs, PWM Time Base for ECCP	. 212
Postscaler. See Postscaler, Timer4/6/8/10/12.	
Prescaler. See Prescaler, Timer4/6/8/10/12.	
PRx Register	
TMRx Register	
TMRx to PRx Match Interrupt 211	, 212
Timing Diagrams	
A/D Conversion	539
Automatic Baud Rate Calculation	356
Auto-Wake-up Bit (WUE) During	
Normal Operation	
Auto-Wake-up Bit (WUE) During Sleep	
Baud Rate Generator with Clock Arbitration	
BRG Overflow Sequence	356
BRG Reset Due to SDAx Arbitration During	
Start Condition	343
Brown-out Reset (BOR)	524
Bus Collision During a Repeated Start	
Condition (Case 1)	344
Bus Collision During a Repeated Start	
Condition (Case 2)	344
Bus Collision During a Start Condition	
(SCLx = 0)	
Bus Collision During a Stop Condition (Case 1)	
Bus Collision During a Stop Condition (Case 2)	345
Bus Collision During Start Condition	
(SDAx Only)	
Bus Collision for Transmit and Acknowledge	
Capture/Compare/PWM	
CLKO and I/O	
Clock Synchronization	
Clock/Instruction Cycle	
EUSART Asynchronous Reception	
EUSART Asynchronous Transmission	358
EUSART Asynchronous Transmission	
(Back-to-Back)	
EUSART Synchronous Master Transmission	365
EUSART/AUSART Synchronous Receive	
(Master/Slave)	537
EUSART/AUSART Synchronous Transmission	
(Master/Slave)	
Example SPI Master Mode (CKE = 0)	
Example SPI Master Mode (CKE = 1)	
Example SPI Slave Mode (CKE = 0)	
Example SPI Slave Mode (CKE = 1)	
External Clock	
Fail-Safe Clock Monitor (FSCM)	
First Start Bit Timing	
Full-Bridge PWM Output	260

### 查询PIC18F86K90供应商

Half-Bridge PWM Output258,	
High-Voltage Detect Operation (VDIRMAG = 1)	
I <sup>2</sup> C Acknowledge Sequence	
I <sup>2</sup> C Bus Data	. 534
I <sup>2</sup> C Bus Start/Stop Bits	
I <sup>2</sup> C Master Mode (7 or 10-Bit Transmission)	
I <sup>2</sup> C Master Mode (7-Bit Reception)	. 339
I <sup>2</sup> C Slave Mode (10-Bit Reception, SEN = 0,	
ADMSK = 01001)	. 323
I <sup>2</sup> C Slave Mode (10-Bit Reception, SEN = 0)	
I <sup>2</sup> C Slave Mode (10-Bit Reception, SEN = 1)	. 329
I <sup>2</sup> C Slave Mode (10-Bit Transmission)	325
I <sup>2</sup> C Slave Mode (7-Bit Reception, SEN = 0,	
ADMSK = 01011)	. 321
I <sup>2</sup> C Slave Mode (7-Bit Reception, SEN = 0)	. 320
I <sup>2</sup> C Slave Mode (7-Bit Reception, SEN = 1)	
I <sup>2</sup> C Slave Mode (7-Bit Transmission)	
I <sup>2</sup> C Slave Mode General Call Address Sequence	
(7 or 10-Bit Addressing Mode)	. 330
I <sup>2</sup> C Stop Condition Receive or Transmit Mode	
LCD Interrupt Timing in Quarter	
Duty Cycle Drive	296
LCD Reference Ladder Power Mode Switching	281
LCD Sleep Entry/Exit When SLPEN = 1 or	
CS = 00	297
Low-Voltage Detect Operation (VDIRMAG = 0)	
MSSP I <sup>2</sup> C Bus Data	535
MSSF I <sup>2</sup> C Bus Start/Stop Bits	535
PWM Auto-Shutdown with	. 555
Auto-Restart Enabled	264
PWM Auto-Shutdown with Firmware Restart	
PWM Direction Change	
	. 201
PWM Direction Change at Near	
PWM Direction Change at Near 100% Duty Cycle	. 262
PWM Direction Change at Near 100% Duty Cycle PWM Output	. 262 . 246
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High)	. 262 . 246 . 256
PWM Direction Change at Near         100% Duty Cycle         PWM Output         PWM Output (Active-High)         PWM Output (Active-Low)	262 246 256 257
PWM Direction Change at Near         100% Duty Cycle         PWM Output         PWM Output (Active-High)         PWM Output (Active-Low)         Repeated Start Condition.	262 246 256 257
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up	262 246 256 257 336
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)	. 262 . 246 . 256 . 257 . 336 . 524
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> </ul>	. 262 . 246 . 256 . 257 . 336 . 524 . 364
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> <li>Slave Synchronization</li> </ul>	. 262 . 246 . 256 . 257 . 336 . 524 . 364
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) Send Break Character Sequence Slave Synchronization Slow Rise Time (MCLR Tied to VDD,	262 246 256 257 336 524 364 307
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) Send Break Character Sequence Slave Synchronization Slow Rise Time (MCLR Tied to VDD, VDD Rise > TPWRT)	. 262 . 246 . 256 . 257 . 336 . 524 . 364 . 307 71
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) Send Break Character Sequence Slave Synchronization Slow Rise Time (MCLR Tied to VDD, VDD Rise > TPWRT) SPI Mode (Master Mode)	. 262 . 246 . 256 . 257 . 336 . 524 . 364 . 307 71 . 306
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) Send Break Character Sequence Slave Synchronization Slow Rise Time (MCLR Tied to VDD, VDD Rise > TPWRT) SPI Mode (Master Mode) SPI Mode (Slave Mode, CKE = 0)	. 262 . 246 . 256 . 257 . 336 . 524 . 307 71 . 306 . 308
PWM Direction Change at Near 100% Duty Cycle PWM Output PWM Output (Active-High) PWM Output (Active-Low) Repeated Start Condition Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) Send Break Character Sequence Slave Synchronization Slow Rise Time (MCLR Tied to VDD, VDD Rise > TPWRT) SPI Mode (Master Mode) SPI Mode (Slave Mode, CKE = 0) SPI Mode (Slave Mode, CKE = 1)	. 262 . 246 . 256 . 257 . 336 . 524 . 307 71 . 306 . 308
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> <li>Slave Synchronization</li> <li>Slow Rise Time (MCLR Tied to VDD, VDD Rise &gt; TPWRT)</li> <li>SPI Mode (Master Mode)</li> <li>SPI Mode (Slave Mode, CKE = 0)</li> <li>SPI Mode (Slave Mode, CKE = 1)</li> <li>Steering Event at Beginning of Instruction</li> </ul>	. 262 . 246 . 257 . 336 . 524 . 364 . 307 71 . 306 . 308 . 308
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition.</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> <li>Slave Synchronization</li> <li>Slow Rise Time (MCLR Tied to VDD, VDD Rise &gt; TPWRT)</li> <li>SPI Mode (Master Mode).</li> <li>SPI Mode (Slave Mode, CKE = 0)</li> <li>SPI Mode (Slave Mode, CKE = 1)</li> <li>Steering Event at Beginning of Instruction (STRSYNC = 1)</li> </ul>	. 262 . 246 . 257 . 336 . 524 . 364 . 307 71 . 306 . 308 . 308
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition.</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> <li>Slave Synchronization</li> <li>Slow Rise Time (MCLR Tied to VDD, VDD Rise &gt; TPWRT)</li> <li>SPI Mode (Master Mode)</li> <li>SPI Mode (Slave Mode, CKE = 0)</li> <li>SPI Mode (Slave Mode, CKE = 1)</li> <li>Steering Event at Beginning of Instruction (STRSYNC = 1)</li> <li>Steering Event at End of Instruction</li> </ul>	262 246 257 336 524 307 71 306 308 308 308
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li></ul>	262 246 257 336 524 307 71 306 308 308 308
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition.</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> <li>Slave Synchronization</li> <li>Slow Rise Time (MCLR Tied to VDD, VDD Rise &gt; TPWRT)</li> <li>SPI Mode (Master Mode).</li> <li>SPI Mode (Slave Mode, CKE = 0)</li> <li>SPI Mode (Slave Mode, CKE = 1)</li> <li>Steering Event at Beginning of Instruction (STRSYNC = 1)</li> <li>Steering Event at End of Instruction (STRSYNC = 0)</li> <li>Synchronous Master Transmission</li> </ul>	262 246 256 257 336 524 364 307 71 306 308 308 268 268
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition.</li> <li>Reset, Watchdog Timer (WDT), Oscillator Start-up Timer (OST) and Power-up Timer (PWRT)</li> <li>Send Break Character Sequence</li> <li>Slave Synchronization</li> <li>Slow Rise Time (MCLR Tied to VDD, VDD Rise &gt; TPWRT)</li> <li>SPI Mode (Master Mode).</li> <li>SPI Mode (Slave Mode, CKE = 0)</li> <li>SPI Mode (Slave Mode, CKE = 1)</li> <li>Steering Event at Beginning of Instruction (STRSYNC = 1)</li> <li>Steering Event at End of Instruction (STRSYNC = 0)</li> <li>Synchronous Master Transmission (Through TXEN)</li> </ul>	262 246 256 257 336 524 364 307 71 306 308 308 268 268 268 366
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li> <li>PWM Output (Active-High)</li> <li>PWM Output (Active-Low)</li> <li>Repeated Start Condition</li></ul>	262 246 256 257 336 524 364 307 71 306 308 308 268 268 268 366
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 256 257 336 524 307 71 306 308 308 268 268 366 367
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 256 257 336 524 307 71 306 308 308 268 268 366 367
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 257 336 524 307 71 306 308 308 268 268 366 367 71
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 257 336 524 307 71 306 308 308 268 268 366 367 71
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 257 336 524 364 307 71 306 308 308 268 268 366 367 71 71
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 257 336 524 307 71 306 308 308 268 .268 .366 .367 71 71 71 71
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 257 336 524 364 307 71 306 308 308 268 268 366 367 71 71 71 71
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 257 336 524 364 307 71 306 308 308 268 268 366 367 71 71 71 71 71
<ul> <li>PWM Direction Change at Near 100% Duty Cycle</li></ul>	262 246 256 257 336 524 364 307 71 306 308 308 268 366 367 71 71 71 71 71 232 527 .192

Timer1 Gate Single Pulse/Toggle	
Combined Mode	195
Timer1 Gate Toggle Mode	
Timer3/5/7 Gate Count Enable Mode	
Timer3/5/7 Gate Single Pulse Mode	206
Timer3/5/7 Gate Single Pulse/Toggle	
Combined Mode	207
Timer3/5/7 Gate Toggle Mode	205
Transition for Entry to Idle Mode	57
Transition for Entry to SEC_RUN Mode	53
Transition for Entry to Sleep Mode	56
Transition for Two-Speed Start-up	
(INTOSC to HSPLL)	
Transition for Wake from Idle to Run Mode	
Transition for Wake from Sleep (HSPLL)	56
Transition from RC_RUN Mode to	
PRI_RUN Mode	55
Transition from SEC_RUN Mode to	
PRI_RUN Mode (HSPLL)	
Transition to RC_RUN Mode	
Type-A in 1/2 MUX, 1/2 Bias Drive	
Type-A in 1/2 MUX, 1/3 Bias Drive	
Type-A in 1/3 MUX, 1/2 Bias Drive	
Type-A in 1/3 MUX, 1/3 Bias Drive	
Type-A in 1/4 MUX, 1/3 Bias Drive	
Type-A/Type-B in Static Drive	285
Type-B in 1/2 MUX, 1/2 Bias Drive	287
Type-B in 1/2 MUX, 1/3 Bias Drive Type-B in 1/3 MUX, 1/2 Bias Drive	
Type-B in 1/3 MUX, 1/3 Bias Drive	
Type-B in 1/4 MUX, 1/3 Bias Drive	
Timing Diagrams and Specifications	235
Capture/Compare/PWM Requirements	528
CLKO and I/O Requirements	
EUSART/AUSART Synchronous Receive	
Requirements	537
EUSART/AUSART Synchronous Transmission	
Requirements	537
Example SPI Mode Requirements	
(Master Mode, CKE = 0)	529
Example SPI Mode Requirements	
(Master Mode, CKE = 1)	530
Example SPI Mode Requirements	
(Slave Mode, CKE = 0)	531
Example SPI Slave Mode Requirements	
(CKE = 1)	
External Clock Requirements	
High/Low-Voltage Detect Characteristics	
I <sup>2</sup> C Bus Data Requirements (Slave Mode)	534
I <sup>2</sup> C Bus Start/Stop Bits Requirements	
(Slave Mode)	
Internal RC Accuracy (INTOSC)	
MSSP I <sup>2</sup> C Bus Data Requirements	
MSSP I <sup>2</sup> C Bus Start/Stop Bits Requirements	
PLL Clock	522
Reset, Watchdog Timer, Oscillator Start-up Timer,	
Power-up Timer and Brown-out	
Reset Requirements	525
Timer0 and Timer1 External Clock	507
Requirements	
Ultra Low-Power Wake-up Top-of-Stack (TOS) Access	ບ3/ ຊະ
TSTFSZ	
· · · · · · · · · · · · · · · · · · ·	-03

### 查询PIC18F86K90供应商

Two-Speed Start-up	2
	2
IESO (CONFIG1H), Internal/External	_
Oscillator Switchover Bit42	26
Two-Word Instructions	
Example Cases	9
TXSTAx Register	
BRGH Bit	51
U	
Ultra Low-Power	
Regulator	1
Regulator In Sleep44	1
Regulator In Sleep44 Ultra Low-Power Wake-up	
Regulator In Sleep44 Ultra Low-Power Wake-up Exit Delay (table)6	5
Regulator In Sleep44 Ultra Low-Power Wake-up	5
Regulator In Sleep44 Ultra Low-Power Wake-up Exit Delay (table)6	5

#### W

Watchdog Timer (WDT)	
Associated Registers	
Control Register	
During Oscillator Failure	
Programming Considerations	
WCOL	335, 336, 337, 340
WCOL Status Flag	335, 336, 337, 340
WWW Address	
WWW, On-Line Support	
Х	
XORLW	
XORWF	

#### 查询PIC18F86K90供应商 THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

## CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com, click on Customer Change Notification and follow the registration instructions.

### **CUSTOMER SUPPORT**

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support
- Development Systems Information Line

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

#### 查询PIC18F86K90供应商 READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

To:	Technical Publications Manager	Total Pages Sent				
RE:	Reader Response					
From	Name					
	Address					
	City / State / ZIP / Country					
	Telephone: ()	FAX: ()				
Application (optional):						
Would you like a reply?YN						
Devic	e: PIC18F87K90 Family	Literature Number: DS39957B				
Ques	tions:					
1. W	1. What are the best features of this document?					
2. H	ow does this document meet your h	nardware and software development needs?				
_						
3. D	<ol> <li>Do you find the organization of this document easy to follow? If not, why?</li> </ol>					
_						
_						
4. W	/hat additions to the document do y	ou think would enhance the structure and subject?				
_						
_						
5. V	. What deletions from the document could be made without affecting the overall usefulness?					
_						
6. Is	6. Is there any incorrect or misleading information (what and where)?					
_						
7. H	ow would you improve this docume	ent?				
_						
_						

### 查询PIC18F86K90供应商 PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. Device	X /XX XXX       Temperature Package Pattern Range	Examples: a) PIC18F87K90-I/PT 301 = Industrial temperature, TQFP package, QTP pattern #301. b) PIC18F87K90T-I/PT = Tape and reel, Industrial
Device <sup>(1,2)</sup>	PIC18F65K90, PIC18F65K90T PIC18F66K90, PIC18F66K90T PIC18F67K90, PIC18F67K90T PIC18F85K90, PIC18F85K90T PIC18F86K90, PIC18F86K90T PIC18F87K90, PIC18F87K90T	temperature, TQFP package.
Temperature Range	I = -40°C to +85°C (Industrial)	
Package	PT = TQFP (Plastic Thin Quad Flatpack) MR = QFN (Plastic Quad Flat)	Note 1: F = Standard Voltage Range
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)	<ul> <li>2: T = In tape and reel</li> <li>3: RSL = Silicon revision A3</li> </ul>



### WORLDWIDE SALES AND SERVICE

#### AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://support.microchip.com Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

**Cleveland** Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Kokomo Kokomo, IN Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

**Santa Clara** Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto Mississauga, Ontario, Canada Tel: 905-673-0699 Fax: 905-673-6509

#### ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

**China - Beijing** Tel: 86-10-8528-2100 Fax: 86-10-8528-2104

**China - Chengdu** Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

**China - Chongqing** Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

**China - Hong Kong SAR** Tel: 852-2401-1200 Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460

Fax: 86-25-8473-2470 China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

**China - Shanghai** Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

**China - Shenyang** Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

**China - Wuhan** Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

**China - Xian** Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

**China - Xiamen** Tel: 86-592-2388138 Fax: 86-592-2388130

**China - Zhuhai** Tel: 86-756-3210040 Fax: 86-756-3210049

#### ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

**India - New Delhi** Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

**Japan - Yokohama** Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

**Malaysia - Penang** Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

**Taiwan - Hsin Chu** Tel: 886-3-6578-300 Fax: 886-3-6578-370

**Taiwan - Kaohsiung** Tel: 886-7-536-4818 Fax: 886-7-536-4803

Taiwan - Taipei Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

#### EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

**UK - Wokingham** Tel: 44-118-921-5869 Fax: 44-118-921-5820

01/05/10